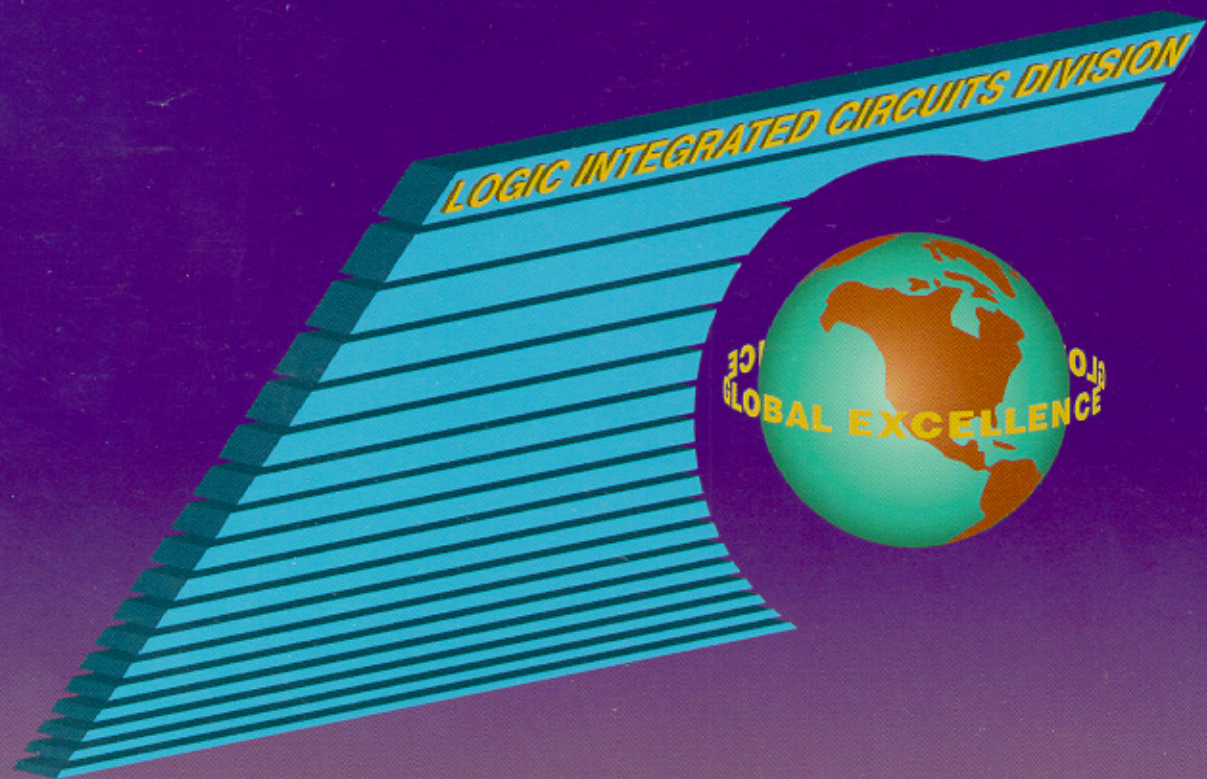




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MECL Data



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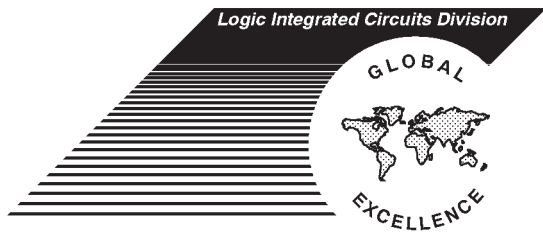
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MECL Data



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MECL Data

This book presents technical data for a broad line of MECL integrated circuits. Complete specifications for the individual circuits are provided in the form of data sheets. In addition, selector guides are included to simplify the task of choosing the best combination of circuits for optimum system architecture.

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WHAT'S NEW!

DATA SHEETS DELETED

MC10H118	MC10119	MC1672	MC4044
MC10H119	MC10128	MC1690	MC4316
MC10H423	MC10130	MC4016	MC4324
MC10100	MC10132	MC4018	MC4344
MC10118	MC10190	MC4024	

WHERE ARE THE PHASE-LOCKED LOOP ICs?

To better serve our customers, we have moved all of the MECL Phase-Locked Loop ICs to our High Performance Frequency Control Products (Hipercomm) publication. The Hipercomm book (BR1334/D) can be ordered from the Motorola Literature Distribution Center. Additionally, all of the PLL data sheets can be accessed via Internet or through the Motorola *MFax*[™] fax-back systems. See a full listing of Motorola's PLLs on page 1-30 of this book.

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MECL Data



General Information

1

SECTION 1 — HIGH-SPEED LOGIC

High speed logic is used whenever improved system performance would increase a product's market value. For a given system design, high-speed logic is the most direct way to improve system performance and Emitter-Coupled Logic (ECL) is one of today's fastest forms of digital logic. Emitter-coupled logic offers both the logic speed and logic features to meet the market demands for higher performance systems.

MECL PRODUCTS

Motorola introduced the original monolithic emitter-coupled logic family with MECL I (1962) and followed this with MECL II (1966). These two families are now obsolete and have given way to the MECL III (MC1600 series), MECL 10K, PLL (MC12000 series) and the new MECL 10H families.

Chronologically the third family introduced, MECL III (1968) is a higher power, higher speed logic. Typical 1 ns edge speeds and propagation delays along with greater than 500 MHz flip-flop toggle rates, make MECL III useful for high-speed test and communications equipment. Also, this family is used in the high-speed sections and critical timing delays of larger systems. For more general purpose applications, however, trends in large high-speed systems showed the need for an easy-to-use logic family with propagation delays on the order of 2 ns. To match this requirement, the MECL 10,000 Series was introduced in 1971.

An important feature of MECL 10K is its compatibility with MECL III to facilitate using both families in the same system. A second important feature is its significant power economy — MECL 10K gates use less than one-half the power of MECL III.

Motorola introduced the MECL 10H product family in 1981. This latest MECL family features 100% improvements in propagation delay and clock speeds while maintaining power supply currents equal to MECL 10K. MECL 10H is voltage compensated allowing guaranteed dc and switching parameters over a $\pm 5\%$ power supply range. Noise margins have been improved by 75% over the MECL 10K series.

Compatibility with MECL 10K and MECL III is a key element in allowing users to enhance existing systems by increasing the speed in critical timing areas. Also, many MECL 10H devices are pin out/functional duplications of the MECL 10K series devices. The emphasis of this family will be placed on more powerful logic functions having more complexity and greater performance. With 1.0 ns propagation delays and 25 mW per gate, MECL 10H is one of the best speed-power families of any ECL logic family available today.

MECL at +5V(PECL)

Any single supply ECL device is also a PECL device, making the PECL portfolio as large as the existing ECL one. (Note: The dual supply translator devices cannot operate at +5V and ground and cannot be considered PECL devices.)

ECL devices in the PECL mode, must have the input/output DC specifications adjusted for proper operation. ECL levels (DC) are referenced from the V_{CC} level. To calculate the PECL DC specifications, ECL levels are added to the new V_{CC} .

EXAMPLE:

PECL $V_{OH} = \text{New } V_{CC} + \text{ECL } V_{OH}, 5.0V + (-0.81V) = 4.190V$ and is the max V_{OH} level at 25°C for a PECL device. Follow the same procedure to calculate all input/output DC specifications for a device used in a PECL mode. The V_{TT} supply used to sink the parallel termination currents is also referenced from the V_{CC} supply and is $V_{CC} - 2.0V$. The PECL V_{TT} supply = $+5V - 2V = +3.0V$ and should track the V_{CC} supply one-to-one for specified operation.

Since ECL is referenced from the V_{CC} rail, any noise on the V_{CC} supply will be reflected on the output waveshape at a one-to-one ratio. Therefore, noise should be kept as low as possible for best operation. Devices in a PECL system cannot have V_{CC} vary more than 5% to assure proper AC operation. See Motorola Application Note AN1406/D "Designing With PECL (ECL at +5.0V)" for more details.

AC performance in the PECL mode is equal to the AC performance in the ECL mode, if the pitfalls set forth in Application Note (AN1406/D) are avoided.

MECL FAMILY COMPARISONS

Feature	MECL 10H	MECL 10K		MECL III
		10,100 Series	10,200 Series	
1. Gate Propagation Delay	1.0 ns	2.0 ns	1.5 ns	1.0 ns
2. Output Edge Speed*	1.0 ns	3.5 ns	2.5 ns	1.0 ns
3. Flip-Flop Toggle Speed	250 MHz min	125 MHz min	200 MHz min	300–500 MHz min
4. Gate Power	25 mW	25 mW	25 mW	60 mW
5. Speed Power Product	25 pJ	50 pJ	37 pJ	60 pJ

*Output edge speed: MECL 10K/10H measured 20% to 80%, MECL III measured 10% to 90% of E out.

Figure 1 — GENERAL CHARACTERISTICS

Ambient Temperature Range	MECL 10H	MECL 10K	MECL III	PLL
0° to 75°C	MC10H100 Series			MC12000 Series
-30°C to +85°C		MC10100 Series MC10200 Series	MC1600 Series	MC12000 Series

Figure 2 — OPERATING TEMPERATURE RANGE

MECL IN PERSPECTIVE

In evaluating any logic line, speed and power requirements are the obvious primary considerations. Figure 1 and Figure 2 provide the basic parameters of the MECL 10H, MECL 10K, and MECL III families. But these provide only the start of any comparative analysis, as there are a number of other important features that make MECL highly desirable for system implementation. Among these:

Complementary Outputs cause a function and its complement to appear simultaneously at the device outputs, without the use of external inverters. It reduces package count by eliminating the need for associated invert functions and, at the same time, cuts system power requirements and reduces timing differential problems arising from the time delays introduced by inverters.

High Input Impedance and Low Output Impedance permit large fan out and versatile drive characteristics.

Insignificant Power Supply Noise Generation, due to differential amplifier design which eliminates current spikes even during signal transition period.

Nearly Constant Power Supply Current Drain simplifies power-supply design and reduces costs.

Low Cross-Talk due to low-current switching in signal path and small (typically 850 mV) voltage swing, and to relatively long rise and fall times.

Wide Variety of Functions, including complex functions facilitated by low power dissipation (particularly in MECL 10H and MECL 10K series). A basic MECL 10K gate consumes less than 8 mW in on-chip power in some complex functions.

Wide Performance Flexibility due to differential amplifier design which permits MECL circuits to be used as linear as well as digital circuits.

Transmission Line Drive Capability is afforded by the open emitter outputs of MECL devices. No "Line Drivers" are listed in MECL families, because every device is a line driver.

Wire-ORing reduces the number of logic devices required in a design by producing additional OR gate functions with only an interconnection.

Twisted Pair Drive Capability permits MECL circuits to drive twisted-pair transmission lines as long as 1000 feet.

Wire-Wrap Capability is possible with the MECL 10K family because of the slow rise and fall time characteristic of the circuits.

Open Emitter-Follower Outputs are used for MECL outputs to simplify signal line drive. The outputs match any line impedance and the absence of internal pulldown resistors saves power.

Input Pulldown Resistors of approximately 50 kΩ permit unused inputs to remain unconnected for easier circuit board layout.

MECL APPLICATIONS

Motorola's MECL product lines are designed for a wide range of systems needs. Within the computer market, MECL 10K is used in systems ranging from special purpose peripheral controllers to large mainframe computers. Big growth areas in this market include disk and communication channel controllers for larger systems and high performance minicomputers.

The industrial market primarily uses MECL for high performance test systems such as IC or PC board testers. However, the high bandwidths of MECL 10H, MECL 10K, MECL III, and MC12,000 are required for many frequency synthesizer systems using high speed phase lock loop networks. MECL has continued to grow in the industrial market through complex medical electronic products and high performance process control systems.

BASIC CONSIDERATIONS FOR HIGH-SPEED LOGIC DESIGN

High-speed operation involves only four considerations that differ significantly from operation at low and medium speeds:

1. Time delays through interconnect wiring, which may have been ignored in medium-speed systems, become highly important at state-of-the-art speeds.
2. The possibility of distorted waveforms due to reflections on signal lines increases with edge speed.
3. The possibility of "crosstalk" between adjacent signal leads is proportionately increased in high-speed systems.
4. Electrical noise generation and pick-up are more detrimental at higher speeds.

In general, these four characteristics are speed- and frequency-dependent, and are virtually independent of the type of logic employed. The merit of a particular logic family is measured by how well it compensates for these deleterious effects in system applications.

The interconnect-wiring time delays can be reduced only by reducing the length of the interconnecting lines. At logic speeds of two nanoseconds, an equivalent "gate delay" is introduced by every foot of interconnecting wiring. Obviously, for functions interconnected within a single monolithic chip, the time delays of signals travelling from one function to another are insignificant. But for a great many externally interconnected parts, this can soon add up to an appreciable delay time. Hence, the greater the number of functions per chip, the higher the system speed. *MECL circuits, particularly those of the MECL 10K and MECL 10H Series are designed with a propensity toward complex functions to enhance overall system speed.*

1

Waveform distortion due to line reflections also becomes troublesome principally at state-of-the-art speeds. At slow and medium speeds, reflections on interconnecting lines are not usually a serious problem. At higher speeds, however, line lengths can approach the wavelength of the signal and improperly terminated lines can result in reflections that will cause false triggering (see Figure 3 and Figure 4). The solution, as in RF technology, is to employ "transmission-line" practices and properly terminate each signal line with its characteristic impedance at the end of its run. *The low-impedance, emitter-follower outputs of MECL circuits facilitate transmission-line practices without upsetting the voltage levels of the system.*

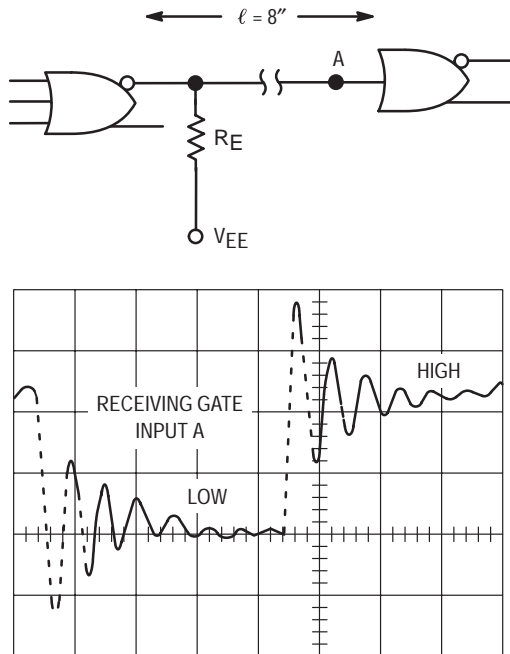


Figure 3 — UNTERMINATED TRANSMISSION LINE (No Ground Plane Used)

The increased affinity for crosstalk in high-speed circuits is the result of very steep leading and trailing edges (fast rise and fall times) of the high-speed signal. These steep wavefronts are rich in harmonics that couple readily to adjacent circuits. *In the design of MECL 10K and MECL 10H, the rise and fall times have been deliberately slowed. This reduces the affinity for crosstalk without compromising other important performance parameters.*

From the above, it is evident that the MECL logic line is not simply capable of operating at high speed, but has been specifically designed to reduce the problems that are normally associated with high-speed operation.

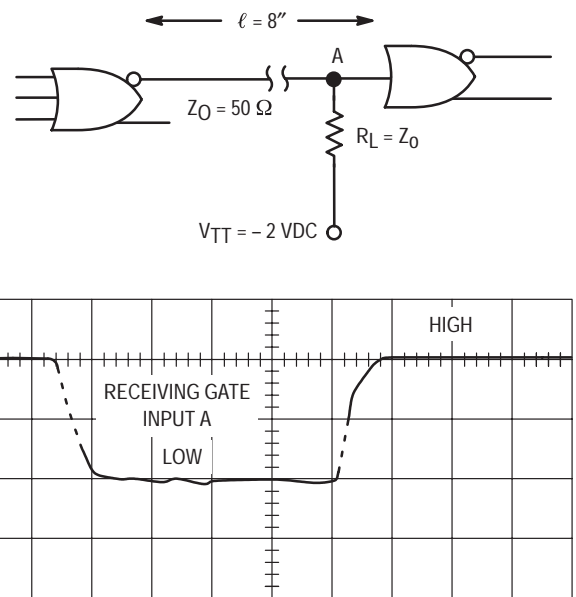


Figure 4 — PROPERLY TERMINATED TRANSMISSION LINE (Ground Plane Added)

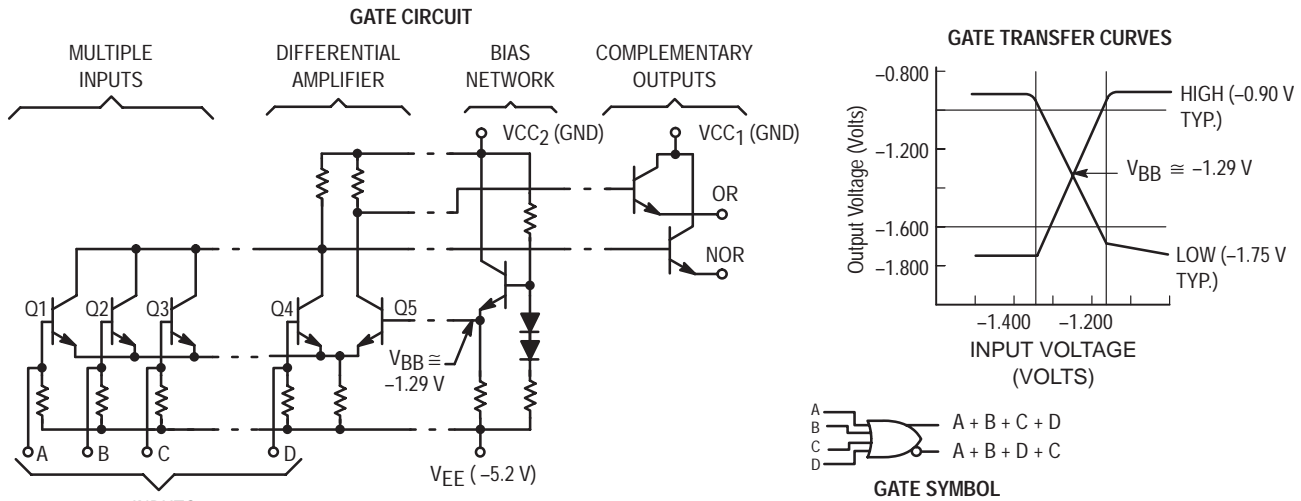


Figure 5 — MECL 10K GATE STRUCTURE AND SWITCHING BEHAVIOR

CIRCUIT DESCRIPTION

The typical MECL 10K circuit, Figure 5, consists of a differential-amplifier input circuit, a temperature and voltage compensated bias network, and emitter-follower outputs to restore dc levels and provide buffering for transmission line driving. High fan-out operation is possible because of the high input impedance of the differential amplifier input and the low output impedance of the emitter follower outputs. Power-supply noise is virtually eliminated by the nearly constant current drain of the differential amplifier, even during the transition period. Basic gate design provides for simultaneous output of both the OR function and its complement, the NOR function. The design of the MECL 10H gate is unchanged, with two exceptions. The bias network has been replaced with a voltage regulator, and the differential amplifier source resistor has been replaced with a constant current source. (See section 2 for additional MECL 10H information.)

Power-Supply Connections — Any of the power supply levels, V_{TT} , V_{CC} , or V_{EE} may be used as ground; however, the use of the V_{CC} node as ground results in best noise immunity. In such a case: $V_{CC} = 0$, $V_{TT} = -2.0$ V, $V_{EE} = -5.2$ V.

System Logic Specifications — The output logic swing of 0.85 V, as shown by the typical transfer characteristics curve, varies from a LOW state of $V_{OL} = -1.75$ V to a HIGH state of $V_{OH} = -0.9$ V with respect to ground.

Positive logic is used when reference is made to logical “0’s” or “1’s.” Then

- “0” = -1.75 V = LOW
 - “1” = -0.9 V = HIGH
- typical

Circuit Operation — Beginning with all logic inputs LOW (nominal -1.75 V), assume that Q1 through Q4 are cut off because their P-N base-emitter junctions are not conducting, and the forward-biased Q5 is conducting. Under these conditions, with the base of Q5 held at -1.29 V by the V_{BB} network, its emitter will be one diode drop (0.8 V) more negative than its base, or -2.09 V. (The 0.8 V differential is a characteristic of this P-N junction.) The base-to-emitter differential across Q1 — Q4 is then the difference between the common emitter voltage (-2.09 V) and the LOW logic level (-1.75 V) or 0.34 V. This is less than the threshold voltage of Q1 through Q4 so that these transistors will remain cut off.

When any one (or all) of the logic inputs are shifted upward from the -1.75 V LOW state to the -0.9 V HIGH state, the base voltage of that transistor increases beyond the threshold point and the transistor turns on. When this happens, the voltage at the common-emitter point rises from -2.09 V to -1.7 (one diode drop below the -0.9 V base voltage of the input transistor), and since the base voltage of the fixed-bias transistor (Q5) is held at -1.29 V, the base-emitter voltage Q5 cannot sustain conduction. Hence, this transistor is cut off.

This action is reversible, so that when the input signal(s) return to the LOW state, Q1 — Q4 are again turned off and Q5 again becomes forward biased. The collector voltages resulting from the switching action of Q1 — Q4 and Q5 are transferred through the output emitter-follower to the output terminal. Note that the differential action of the switching transistors (one section being off when the other is on) furnishes simultaneous complementary signals at the output. This action also maintains constant power supply current drain.

DEFINITIONS OF LETTER SYMBOLS AND ABBREVIATIONS

Current:

1	I_{CC}	Total power supply current drawn from the positive supply by a MECL unit under test.	V_{CC1}	Most positive power supply voltage (output devices). (Usually ground for MECL devices.)
	I_{CBO}	Leakage current from input transistor on MECL devices without pulldown resistors when test voltage is applied.	V_{CC2}	Most positive power supply voltage (current switches and bias driver). (Usually ground for MECL devices.)
	I_{CCH}	Current drain from V_{CC} power supply with all inputs at logic HIGH level.	V_{EE}	Most negative power supply voltage for a circuit (usually -5.2 V for MECL devices).
	I_{CCL}	Current drain from V_{CC} power supply with all inputs at logic LOW level.	V_F	Input voltage for measuring I_F on TTL interface circuits.
	I_E	Total power supply current drawn from a MECL test unit by the negative power supply.	V_{IH}	Input logic HIGH voltage level (nominal value).
	I_F	Forward diode current drawn from an input of a saturated logic-to-MECL translator when that input is at 0.4 V.	$V_{IH\ max}$	Maximum HIGH level input voltage: The most positive (least negative) value of high-level input voltage, for which operation of the logic element within specification limits is guaranteed.
	I_{in}	Current into the input of the test unit when a maximum logic HIGH ($V_{IH\ max}$) is applied at that input.	V_{IHA}	Input logic HIGH threshold voltage level.
	I_{INH}	HIGH level input current into a node with a specified HIGH level ($V_{IH\ max}$) logic voltage applied to that node. (Same as I_{in} for positive logic.)	$V_{IHA\ min}$	Minimum input logic HIGH level (threshold) voltage for which performance is specified.
	I_{INL}	LOW level input current, into a node with a specified LOW level ($V_{IL\ min}$) logic voltage applied to that node.	$V_{IH\ min}$	Minimum HIGH level input voltage: The least positive (most negative) value of HIGH level input voltage for which operation of the logic element within specification limits is guaranteed.
	I_L	Load current that is drawn from a MECL circuit output when measuring the output HIGH level voltage.	V_{IL}	Input logic LOW voltage level (nominal value).
	I_{OH}	HIGH level output current: the current flowing into the output, at a specified HIGH level output voltage.	$V_{IL\ max}$	Maximum LOW level input voltage: The most positive (least negative) value of LOW level input voltage for which operation of the logic element within specification limits is guaranteed.
	I_{OL}	LOW level output current: the current flowing into the output, at a specified LOW level output voltage.	V_{ILA}	Input logic LOW threshold voltage level.
	I_{OS}	Output short circuit current.	$V_{ILA\ max}$	Maximum input logic LOW level (threshold) voltage for which performance is specified.
	I_{out}	Output current (from a device or circuit, under such conditions mentioned in context).	$V_{IL\ min}$	Minimum LOW level input voltage: The least positive (most negative) value of LOW level input voltage for which operation of the logic element within specification limits is guaranteed.
	I_R	Reverse current drawn from a transistor input of a test unit when V_{EE} is applied to that input.	V_{in}	Input voltage (to a circuit or device).
	$I_{R'}$	Reverse current leakage into an input of a saturated logic MECL/PECL translator when that input is at V_{CC} .	V_{max}	Maximum (most positive) supply voltage, permitted under a specified set of conditions.
	I_{SC}	Short-circuit current drawn from a translator saturating output when that output is at ground potential.	V_{OH}	Output logic HIGH voltage level: The voltage level at an output terminal for a specified output current, with the specified conditions applied to establish a HIGH level at the output.
			V_{OHA}	Output logic HIGH threshold voltage level.
			$V_{OHA\ min}$	Minimum output HIGH threshold voltage level for which performance is specified.
			$V_{OH\ max}$	Maximum output HIGH or high-level voltage for given inputs.
			$V_{OH\ min}$	Minimum output HIGH or high-level voltage for given inputs.
			V_{OL}	Output logic LOW voltage level: The voltage level at the output terminal for a specified output current, with the specified conditions applied to establish a LOW level at the output.
			V_{OLA}	Output logic LOW threshold voltage level.
			$V_{OLA\ max}$	Maximum output LOW threshold voltage level for which performance is specified.

Voltage:

V_{BB}	Reference bias supply voltage.
V_{BE}	Base-to-emitter voltage drop of a transistor at specified collector and base currents.
V_{CB}	Collector-to-base voltage drop of a transistor at specified collector and base currents.
V_{CC}	General term for the most positive power supply voltage to a MECL device (usually ground, except for translator and interface circuits).

Voltage (cont.):

$V_{OL\ max}$	Maximum output LOW level voltage for given inputs.
$V_{OL\ min}$	Minimum output LOW level voltage for given inputs.
V_{TT}	Line load–resistor terminating voltage for outputs from a MECL device.

Time Parameters:

t_+	Waveform rise time (LOW to HIGH), 10% to 90%, or 20% to 80%, as specified.
t_-	Waveform fall time (HIGH to LOW), 90% to 10%, or 80% to 20%, as specified.
t_r	Same as t_+
t_f	Same as t_-
t_{+-}	Propagation Delay, see Figure 12 on page 1–13.
t_{-+}	Propagation Delay, see Figure 12 on page 1–13.
t_{pd}	Propagation delay, input to output from the 50% point of the input waveform at pin x (falling edge noted by – or rising edge noted by +) to the 50% point of the output waveform at pin y (falling edge noted by – or rising edge noted by +). (Cf Figure 12 on page 1–13.)
$t_{x\pm y\pm}$	
t_{x+}	Output waveform rise time as measured from 10% to 90% or 20% to 80% points on waveform (whichever is specified) at pin x with input conditions as specified.
t_{x-}	Output waveform fall time as measured from 90% to 10% or 80% to 20% points on waveform (whichever is specified) at pin x, with input conditions as specified.
f_{Tog}	Toggle frequency of a flip–flop or counter device.
f_{shift}	Shift rate for a shift register.

Read Mode (Memories)

t_{ACS}	Chip Select Access Time
t_{RCS}	Chip Select Recovery Time
t_{AA}	Address Access Time

Write Mode (Memories)

t_W	Write Pulse Width
t_{WSD}	Data Setup Time Prior to Write
t_{WHD}	Data Hold Time After Write

t_{WSA}	Address setup time prior to write
t_{WHA}	Address hold time after write
t_{WSCS}	Chip select setup time prior to write
t_{WHCS}	Chip select hold time after write
t_{WS}	Write disable time
t_{WR}	Write recovery time

Temperature:

T_{stg}	Maximum temperature at which device may be stored without damage or performance degradation.
T_J	Junction (or die) temperature of an integrated circuit device.
T_A	Ambient (environment) temperature existing in the immediate vicinity of an integrated circuit device package.
θ_{JA}	Thermal resistance of an IC package, junction to ambient.
θ_{JC}	Thermal resistance of an IC package, junction to case.
lfpm	Linear feet per minute.
θ_{CA}	Thermal resistance of an IC package, case to ambient.

Miscellaneous:

e_g	Signal generator inputs to a test circuit.
TP_{in}	Test point at input of unit under test.
TP_{out}	Test point at output of unit under test.
D.U.T.	Device under test.
C_{in}	Input capacitance.
C_{out}	Output capacitance.
Z_{out}	Output impedance.
P_D	The total dc power applied to a device, not including any power delivered from the device to a load.
R_L	Load Resistance.
R_T	Terminating (load) resistor.
R_p	An input pull–down resistor (i.e., connected to the most negative voltage).
P.U.T.	Pin under test.

1

MECL POSITIVE AND NEGATIVE LOGIC

INTRODUCTION

The increasing popularity and use of emitter coupled logic has created a dilemma for some logic designers. Saturated logic families such as TTL have traditionally been designed with the NAND function as the basic logic function, however, the basic ECL logic function is the NOR function (positive logic). Therefore, the designer may either design ECL systems with positive logic using the NOR, or design with

negative logic using the NAND. Which is the more convenient? On the one hand the designer is familiar with positive logic levels and definitions, and on the other hand, he is familiar with implementing systems using NAND functions. Perhaps a presentation of the basic definitions and characteristics of positive and negative logic will clarify the situation and eliminate misunderstanding.

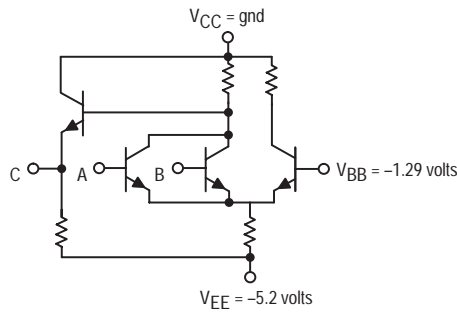


Table 1

INPUTS		OUTPUT
A	B	C
LO	LO	HI
LO	HI	LO
HI	LO	LO
HI	HI	LO

Table 2

NEGATIVE LOGIC

INPUTS		OUTPUT
A	B	C
1	1	0
1	0	1
0	1	1
0	0	1

$$C = A \bullet B$$



HI = -0.9 volts
LO = -1.7 volts

Table 3

POSITIVE LOGIC

INPUTS		OUTPUT
A	B	C
0	0	1
0	1	0
1	0	0
1	1	0

$$C = A + B$$



Figure 6 — Basic MECL Gate Circuit and Logic Function In Positive and Negative Nomenclature.

Circuit diagrams external to Motorola products are included as a means of illustrating typical semiconductor applications; consequently, complete information sufficient for construction purposes is not necessarily given. The information in this Application Note has been carefully checked and is believed to be entirely reliable. However, no responsibility is assumed for inaccuracies. Furthermore, such information does not convey to the purchaser of the semiconductor devices described any license under the patent rights of Motorola Inc. or others.

LOGIC EQUIVALENCIES

Binary logic must have two states to represent the binary 1 and 0. With ECL the typical states are a high level of -0.9 volts and a low level of -1.7 volts. Two choices are possible then to represent the binary 1 and 0. Positive logic defines the 1 or "true" state as the most positive voltage level, whereas negative logic defines the most negative voltage level as the 1 or "true" state. Because of the difference in definition of states, the basic ECL gate is a NOR function in positive logic and is a NAND function in negative logic.













Figure 6 more clearly shows the above comparison of functions. Table 1 lists the output voltage level as a function of input voltage levels of the MECL gate circuit shown. Table 2 translates the voltage levels into the appropriate negative logic levels which show the function to be $C = A \cdot B$; that is, the

circuit performs the NAND function. Table 3 translates the equivalent positive logic function into $C = A + B$, the NOR function.

Similar comparisons could be made for other positive logic functions. As an example, the positive OR function translates to the negative AND function. Figure 7 shows a comparison of several common logic functions.

Any function available in a logic family may be expressed in terms of positive or negative logic, bearing in mind the definition of logic levels. The choice of logic definition, as previously stated, is dependent on the designer. Motorola provides both positive and negative logic symbols on data sheets for the popular MECL 10,000 logic series.

Figure 7 — Comparative Positive and Negative Logic Functions.

INPUTS		POSITIVE LOGIC					
							
A	B	AND	OR	NAND	NOR	EXOR	COIN*
LO	LO	LO	LO	HI	HI	LO	HI
LO	HI	LO	HI	HI	LO	HI	LO
HI	LO	LO	HI	HI	LO	HI	LO
HI	HI	HI	HI	LO	LO	LO	HI
A	B	OR	AND	NOR	NAND	COIN*	EXOR
INPUTS							
NEGATIVE LOGIC							

*Coincidence

SUMMARY

Conversion from one logic form to another or the use of a particular logic form need not be a complicated process. If the designer uses the logic form with which he is familiar and bears in mind the previously mentioned definition of levels, problems arising from definition of logic functions should be minimized.

REFERENCE

Y. Chu, Digital Computer Design Fundamentals
New York, McGraw-Hill, 1962

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SECTION II — TECHNICAL DATA

GENERAL CHARACTERISTICS AND SPECIFICATIONS

(See pages 1–6 through 1–7 for definitions of symbols and abbreviations.)

In subsequent sections of this Data Book, the important MECL parameters are identified and characterized, and complete data provided for each of the functions. To make this data as useful as possible, and to avoid a great deal of repetition, the data that is common to all functional blocks in a line is not repeated on each individual sheet. Rather, these common characteristics, as well as the application information that applies to each family, are discussed in this section.

In general, the common characteristics of major importance are:

Maximum Ratings, including both dc and ac characteristics and temperature limits;

Transfer Characteristics, which define logic levels and switching thresholds;

DC Parameters, such as output levels, threshold levels, and forcing functions.

AC Parameters, such as propagation delays, rise and fall times and other time dependent characteristics.

In addition, this section will discuss general layout and design guides that will help the designer in building and testing systems with MECL circuits.

LETTER SYMBOLS AND ABBREVIATIONS

Throughout this section, and in the subsequent data sheets, letter symbols and abbreviations will be used in discussing electrical characteristics and specifications. The symbols used in this book, and their definitions, are listed on the preceding pages.

MAXIMUM RATINGS

The limit parameters beyond which the life of the devices may be impaired are given in Table 4. In addition, Table 5 provides certain limits which, if exceeded, will not damage the devices, but could degrade the performance below that of the guaranteed specifications.

Table 4 — LIMITS BEYOND WHICH DEVICE LIFE MAY BE IMPAIRED

Characteristic	Symbol	Unit	MECL 10H	MECL 10K	MECL III
Power Supply	V_{EE}	Vdc	–8.0 to 0	–8.0 to 0	–8.0 to 0
Input Voltage ($V_{CC} = 0$)	V_{in}	Vdc	0 to V_{EE}	0 to V_{EE}	0 to V_{EE}
Output Source Current Continuous	I_{out}	mAdc	50	50	40
Output Source Current Surge	I_{out}	mAdc	100	100	—
Storage Temperature	T_{stg}	°C	–65 to +150	–65 to +150	–65 to +150
Junction Temperature Ceramic Package ^①	T_J	°C	165	165	165 ^②
Junction Temperature Plastic Package ^③	T_J	°C	140	140	140

NOTES: 1. Maximum T_J may be exceeded ($\leq 250^\circ\text{C}$) for short periods of time (≤ 240 hours) without significant reduction in device life.

2. Except MC1670 which has a maximum junction temperature = 145°C .

3. For long term (≥ 10 yrs.) max T_J of 110°C required. Max T_J may be exceeded ($\leq 175^\circ\text{C}$) for short periods of time (≤ 240 hours) without significant reduction in device life.

Table 5 — LIMITS BEYOND WHICH PERFORMANCE MAY BE DEGRADED

Characteristics	Symbol	Unit	MECL 10H	MECL 10K	MECL III
Operating Temperature Range Commercial ^①	T_A	°C	0 to +75	–30 to +85	–30 to +85
Supply Voltage ($V_{CC} = 0$)	V_{EE}	Vdc	–4.94 to –5.46	–4.68 to –5.72 ^{②⑤}	–4.68 to –5.72 ^②
Output Drive Commercial	—	Ω	50 Ω to –2.0 Vdc	50 Ω to –2.0 Vdc	50 Ω to –2.0 Vdc ^④

NOTES: 1. With airflow ≥ 500 lfpm.

2. Functionality only. Data sheet limits are specified for $-5.2\text{ V} \pm 0.010\text{ V}$.

3. Except MC1648 which has an internal output pulldown resistor.

4. Functional and Data sheet limits.

5. MC10137 has a guaranteed supply voltage of -5.2 V to -5.72 V @ -30°C .

MECL TRANSFER CURVES and SPECIFICATION TEST POINTS

Figure 8 – MECL 10K

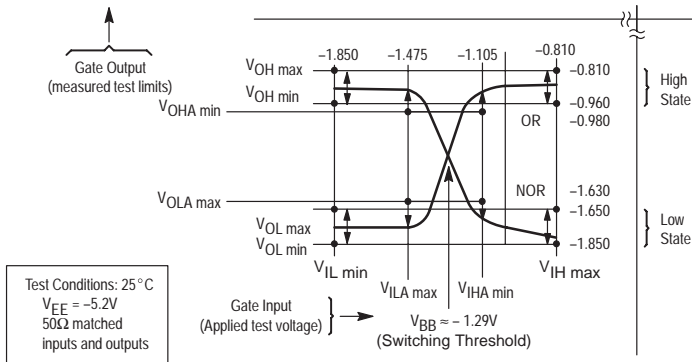
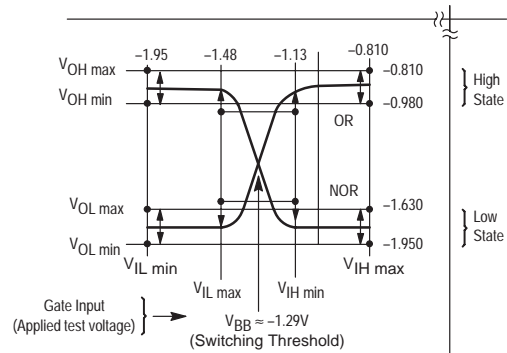


Figure 9 – MECL 10H



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MECL TRANSFER CURVES

For MECL logic gates, the dual (complementary) outputs must be represented by two transfer curves: one to describe the OR switching action and one to describe the NOR switching action. Typical transfer curves and associated data for the MECL 10K/10H family are shown in Figure 8 and Figure 9, respectively.

It is not necessary to measure transfer curves at all points of the curves. To guarantee correct operation it is sufficient merely to measure two sets of min/max logic level parameters.

The first set is obtained for 10K by applying test voltages, $V_{IL\ min}$ and $V_{IH\ max}$ (sequentially) to the gate inputs, and measuring the OR and NOR output levels to make sure they are between $V_{OL\ max}$ and $V_{OL\ min}$, and $V_{OH\ max}$ and $V_{OH\ min}$ specifications.

The second set of logic level parameters relates to the switching thresholds. This set of data is distinguished by an "A" in symbol subscripts. A test voltage, $V_{ILA\ max}$, is applied to the gate and the NOR and OR outputs are measured to see that they are above the $V_{OHA\ min}$ and below the $V_{OLA\ max}$ levels, respectively. Similar checks are made using the test input voltage $V_{IHA\ min}$.

The result of these specifications insures that:

- (a) The switching threshold ($\approx V_{BB}$) falls within the darkest rectangle; i.e. switching does not begin outside this rectangle;
- (b) Quiescent logic levels fall in the lightest shaded ranges;
- (c) Guaranteed noise immunity is met.

As shown in Figure 10, MECL 10K outputs rise with increasing ambient temperature. All circuits in each family have the same worst-case output level specifications

regardless of power dissipation or junction temperature differences to reduce loss of noise margin due to thermal differences.

All of these specifications assume $-5.2\ V$ power supply operation. Operation at other power-supply voltages is possible, but will result in further transfer curve changes. Table 6 gives rate of change of output voltages as a function of power supply.

Figure 10 — TYPICAL TRANSFER CHARACTERISTICS AS A FUNCTION OF TEMPERATURE (MECL 10K)

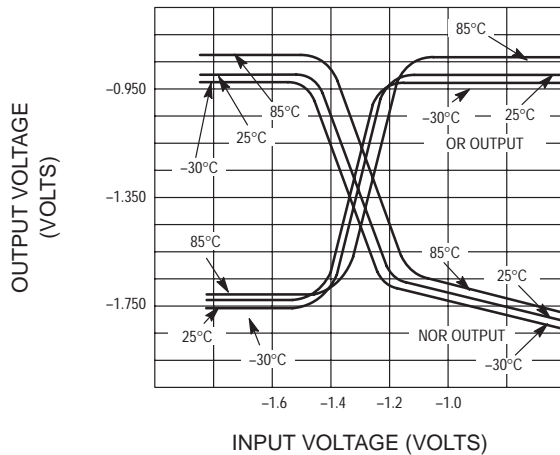


Table 6 — TYPICAL LEVEL CHANGE RATES / 1V

Voltage	MECL 10H	MECL 10K	MECL III
$\Delta V_{OH} / \Delta V_{EE}$	0.008	0.016	0.033
$\Delta V_{OL} / \Delta V_{EE}$	0.020	0.250	0.270
$\Delta V_{BB} / \Delta V_{EE}$	0.010	0.148	0.140

NOISE MARGIN

“Noise margin” is a measure of logic circuit’s resistance to undesired switching. MECL noise margin is defined in terms of the specification points surrounding the switching threshold. The critical parameters of interest here are those designated with the “A” subscript ($V_{OHA\ min}$, $V_{OLA\ max}$, $V_{IHA\ min}$, $V_{ILA\ max}$) in the transfer characteristic curves. MECL 10H is specified and tested with:

$$\begin{aligned} V_{OHA\ min} &= V_{OH\ min} \\ V_{OLA\ max} &= V_{OL\ max} \\ V_{IHA\ min} &= V_{IH\ min} \\ \text{and} \\ V_{ILA\ max} &= V_{IL\ max} \end{aligned}$$

Guaranteed noise margin (NM) is defined as follows:

$$\begin{aligned} NM_{HIGH\ LEVEL} &= V_{OHA\ min} - V_{IHA\ min} \\ NM_{LOW\ LEVEL} &= V_{ILA\ max} - V_{OLA\ max} \end{aligned}$$

To see how noise margin is computed, assume a MECL gate drives a similar MECL gate, Figure 11.

At a gate input (point B) equal to $V_{ILA\ max}$, MECL gate #2 can begin to enter the shaded transition region.

This is a “worst case” condition, since the $V_{OLA\ max}$ specification point guarantees that no device can enter the transition region before an input equal to $V_{ILA\ max}$ is reached. Clearly then, $V_{ILA\ max}$ is one critical point for noise margin computation, since it is the edge of the transition region.

To find the other critical voltage, consider the output from MECL gate #1 (point A). What is the most positive value possible for this voltage (considering worst case specifications)? From Figure 11 it can be observed that the $V_{OLA\ max}$ specification insures that the LOW state OR output from gate #1 can be no greater than $V_{OLA\ max}$.

Note that $V_{OLA\ max}$ is more negative than $V_{ILA\ max}$. Thus, with $V_{OLA\ max}$ at the input to gate #2, the transition region is not yet reached. (The input voltage to gate #2 is still to the left of $V_{ILA\ max}$ on the transfer curve.)

In order to ever run the chance of switching gate #2, we

would need an additional voltage, to move the input from $V_{OLA\ max}$ to $V_{ILA\ max}$. This constitutes the “safety factor” known as noise margin. It can be calculated as the magnitude of the difference between the two specification voltages, or for the MECL 10K levels shown:

$$\begin{aligned} NM_{LOW} &= V_{ILA\ max} - V_{OLA\ max} \\ &= -1.475\ V - (-1.630\ V) \\ &= 155\ mV. \end{aligned}$$

Similarly, for the HIGH state:

$$\begin{aligned} NM_{HIGH} &= V_{OHA\ min} - V_{IHA\ min} \\ &= -0.980\ V - (-1.105\ V) \\ &= 125\ mV \end{aligned}$$

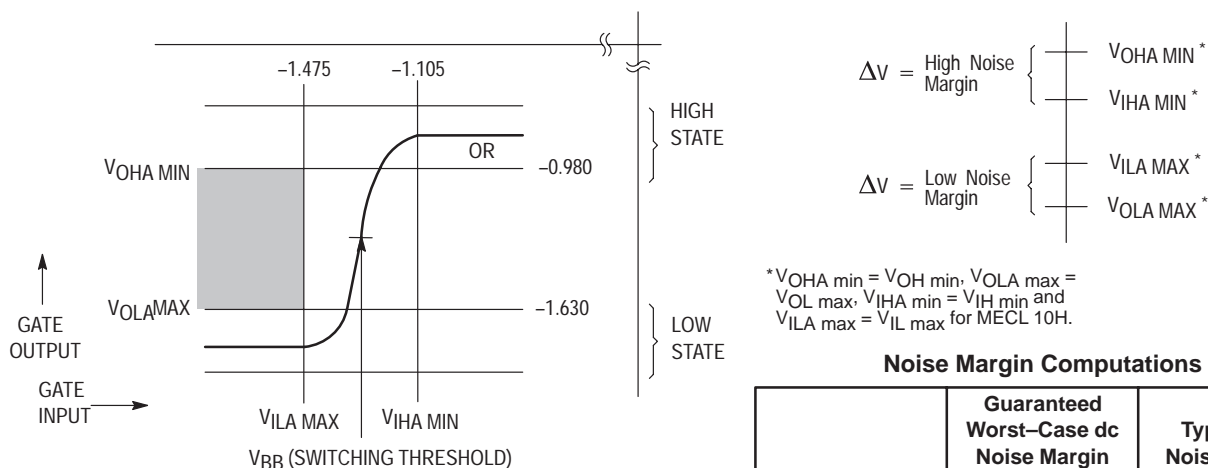
Analogous results are obtained when considering the “NOR” transfer data.

Note that these noise margins are absolute worst case conditions. The lesser of the two noise margins is that for the HIGH state, 125 mV. This then, constitutes the guaranteed margin against signal undershoot, and power or thermal disturbances.

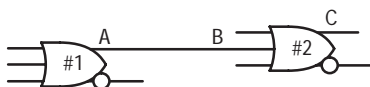
As shown in the table, typical noise margins are usually better than guaranteed — by about 75 mV. For MECL 10H the “noise margin” is 150 mV for NM low and NM high. (See Section 3 for details.)

Noise margin is a dc specification that can be calculated, since it is defined by specification points tabulated on MECL data sheets. However, by itself, this specification does not give a complete picture regarding the noise immunity of a system built with a particular set of circuits. Overall system noise immunity involves not only noise–margin specifications, but also other circuit–related factors that determine how difficult it is to apply a noise signal of sufficient magnitude and duration to cause the circuit to propagate a false logic state. In general, then, noise immunity involves line impedances, circuit output impedances, and propagation delay in addition to noise–margin specifications. This subject to be discussed in greater detail in the MECL System Design Handbook, HB205.

Figure 11 — MECL Noise Margin Data



Specification Points for Determining Noise Margin



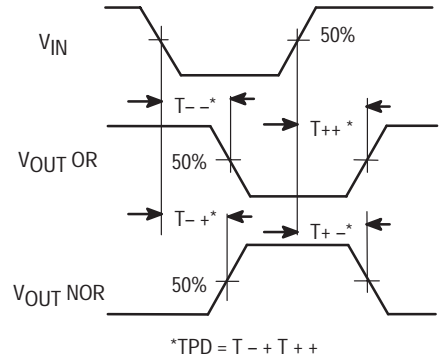
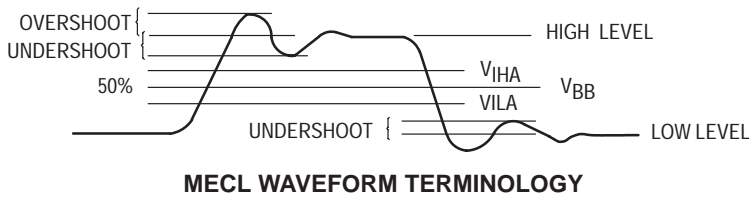
AC OR SWITCHING PARAMETERS

Family	Guaranteed Worst-Case dc Noise Margin (V)	Typical dc Noise Margin (V)
MECL 10H	0.150	0.270
MECL 10K	0.125	0.210
MECL III	0.115	0.200

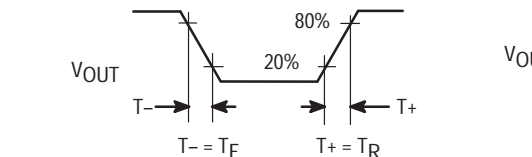
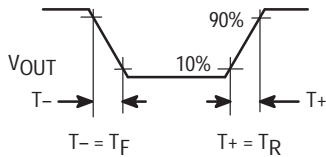
Time-dependent specifications are those that define the effects of the circuit on a specified input signal, as it travels through the circuit. They include the time delay involved in changing the output level from one logic state to another. In addition, they include the time required for the output of a circuit to respond to the input signal, designated as propagation delay, MECL waveform and propagation delay

terminologies are depicted in Figure 12. Specific rise, fall, and propagation delay times are given on the data sheet for each specific functional block, but like the transfer characteristics, ac parameters are temperature and voltage dependent. Typical variations for MECL 10K are given in the curves of Figure 13 through Figure 16.

Figure 12 — TYPICAL LOGIC WAVEFORMS



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MECL Propagation Delay

Figure 13 — TYPICAL PROPAGATION DELAY t_{-} versus V_{EE} AND TEMPERATURE (MECL 10K)

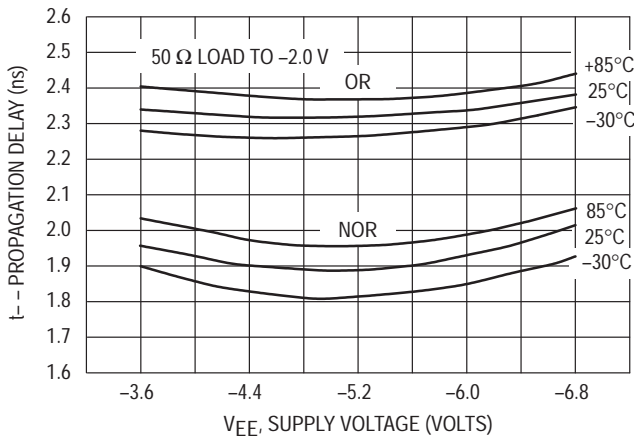


Figure 14 — TYPICAL PROPAGATION DELAY t_{+} versus V_{EE} AND TEMPERATURE (MECL 10K)

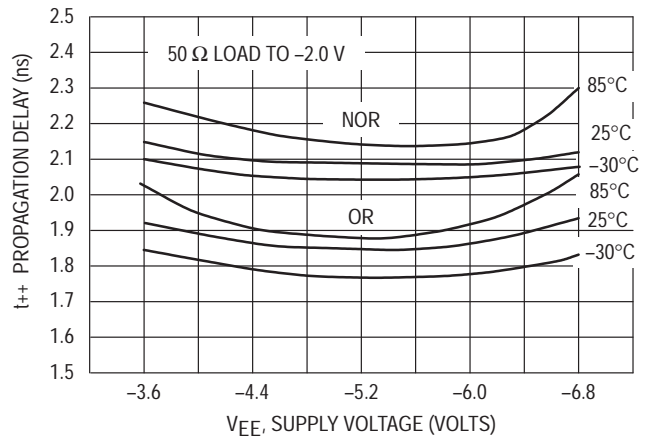


Figure 15 — TYPICAL FALL TIME (90% to 10%) versus TEMPERATURE AND SUPPLY VOLTAGE (MECL 10K)

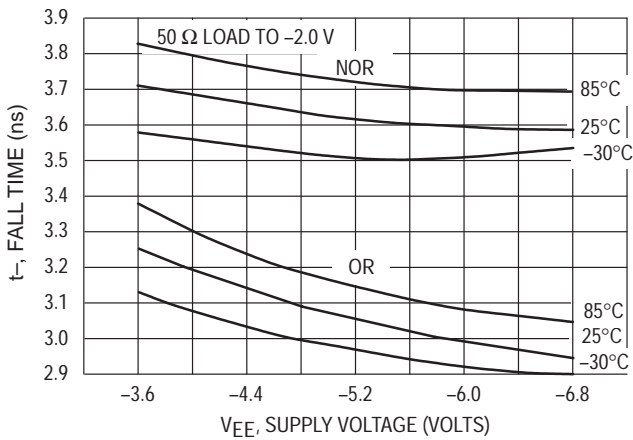
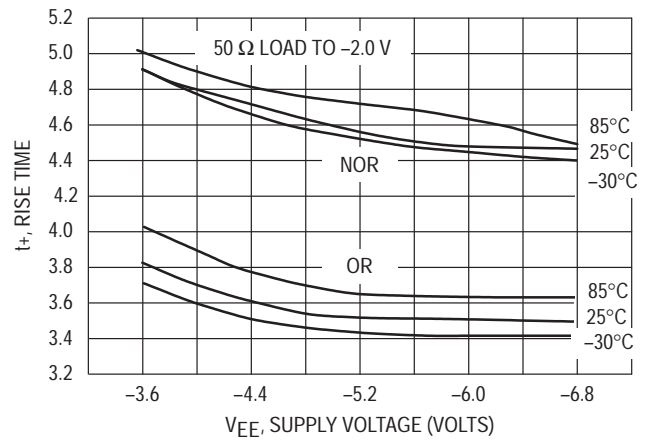


Figure 16 — TYPICAL FALL TIME (10% to 90%) versus TEMPERATURE AND SUPPLY VOLTAGE (MECL 10K)

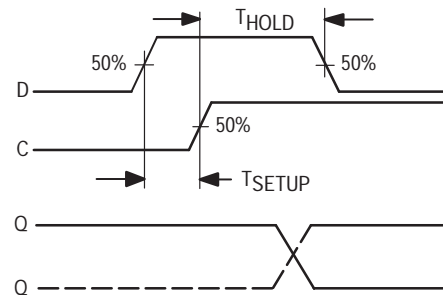


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SETUP AND HOLD TIMES

Setup and hold times are two ac parameters which can easily be confused unless clearly defined. For MECL logic devices, t_{setup} is the minimum time (50% – 50%) before the positive transition of the clock pulse (C) that information must be present at the Data input (D) to insure proper operation of the device. The t_{hold} is defined similarly as the minimum time after the positive transition of the clock pulse (C) that the information must remain unchanged at the Data input (D) to insure proper operation. Setup and hold waveforms for logic devices are shown in Figure 17.

Figure 17 — SETUP AND HOLD WAVEFORMS FOR MECL LOGIC DEVICES



TESTING MECL 10H, MECL 10K AND MECL III

To obtain results correlating with Motorola circuit specifications certain test techniques must be used. A schematic of a typical gate test circuit is shown in Figure 18. This test circuit is the standard ac test configuration for most MECL devices. (Exceptions are shown with device specification.)

A solid ground plane is used in the test setup, and capacitors bypass V_{CC1} , V_{CC2} , and V_{EE} pins to ground. All power leads and signal leads are kept as short as possible.

The sampling scope interface runs directly to the 50-ohm inputs of Channel A and B via 50-ohm coaxial cable. Equal-length coaxial cables must be used between the test set and the A and B scope inputs. A 50-ohm coax cable such as RG58/U or RG188A/U, is recommended.

Interconnect fittings should be 50-ohm GR, BNC, Sealectro Conhex, or equivalent. Wire length should be $< \frac{1}{4}$ inch from TP_{in} to input pin and TP_{out} to output pin.

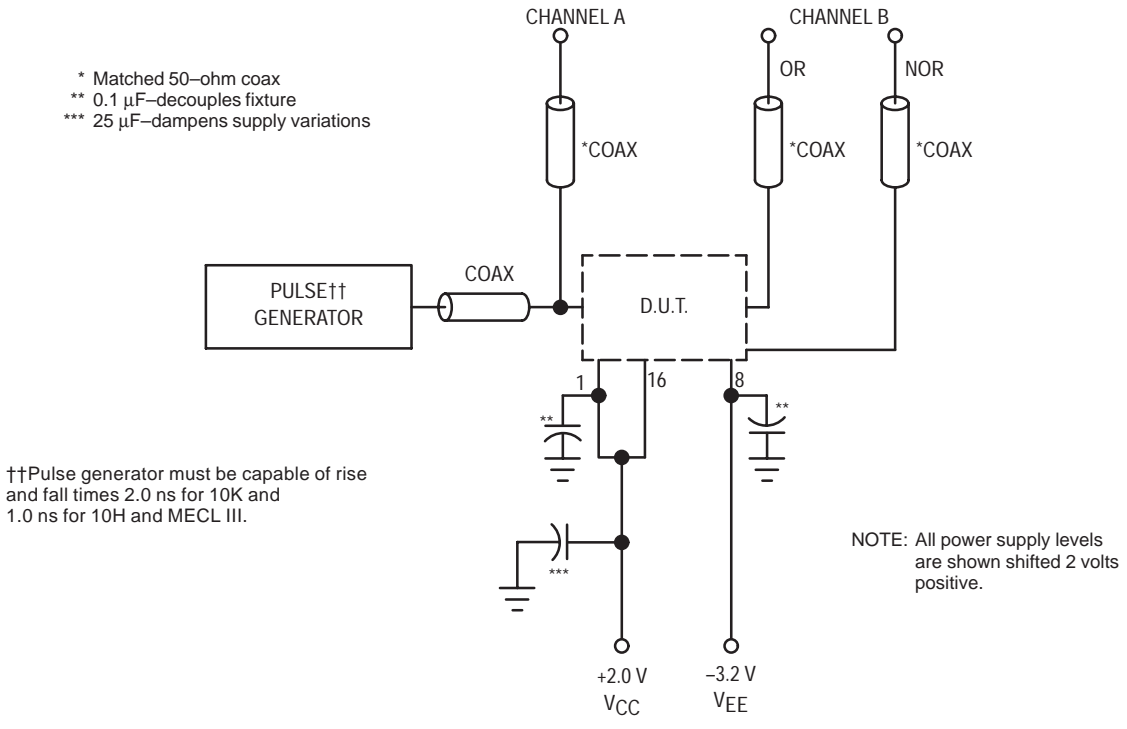
The pulse generator must be capable of 2.0 ns rise and

fall times for MECL 10K and 1.5 ns for MECL 10H and MECL III. In addition, the generator voltage must have an offset to give MECL signal swings of $\approx \pm 400$ mV about a threshold of $\approx +0.7$ V when $V_{CC} = +2.0$ and $V_{EE} = -3.2$ V for ac testing of logic devices.

The power supplies are shifted +2.0 V, so that the device under test has only one resistor value to load into the precision 50-ohm input impedance of the sampling oscilloscope. Use of this technique yields a close correlation between Motorola and customer testing. Unused outputs are loaded with a 50-ohm resistor (100-ohm for MC105XX devices) to ground. The positive supply (V_{CC}) should be decoupled from the test board by RF type 25 μ F capacitors to ground. The V_{CC} pins are bypassed to ground with 0.1 μ F, as is the V_{EE} pin.

Additional information on testing MECL 10K and understanding data sheets is found in Application Note AN701 and the MECL System Design Handbook, HB205.

Figure 18 — MECL LOGIC SWITCHING TIME TEST SETUP



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SECTION III — OPERATIONAL DATA

POWER SUPPLY CONSIDERATIONS

MECL circuits are characterized with the V_{CC} point at ground potential and the V_{EE} point at -5.2 V. While this MECL convention is not necessarily mandatory, it does result in maximum noise immunity. This is so because any noise induced on the V_{EE} line is applied to the circuit as a common-mode signal which is rejected by the differential action of the MECL input circuit. Noise induced into the V_{CC} line is not cancelled out in this fashion. Hence, a good system ground at the V_{CC} bus is required for best noise immunity. Also, MECL 10H circuits may be operated with V_{EE} at -4.5 V with a negligible loss of noise immunity.

Power supply regulation which will achieve 10% regulation or better at the device level is recommended. The -5.2 V power supply potential will result in best circuit speed. Other values for V_{EE} may be used. A more negative voltage will increase noise margins at a cost of increased power dissipation. A less negative voltage will have just the opposite effect. (Noise margins and performance specifications of MECL 10H are unaffected by variations in V_{EE} because of the internal voltage regulation.)

On logic cards, a ground plane or ground bus system should be used. A bus system should be wide enough to prevent significant voltage drops between supply and device and to produce a low source inductance.

Although little power supply noise is generated by MECL logic, power supply bypass capacitors are recommended to handle switching currents caused by stray capacitance and asymmetric circuit loading. A parallel combination of a 1.0 μ F and a 100 pF capacitor at the power entrance to the board, and a 0.01 μ F low-inductance capacitor between ground and the -5.2 V line every four to six packages, are recommended.

Most MECL 10H, MECL 10K and MECL III circuits have two V_{CC} leads. V_{CC1} supplies current to the output transistors and V_{CC2} is connected to the circuit logic transistors. The separate V_{CC} pins reduce cross-coupling between individual circuits within a package when the outputs are driving heavy loads. Circuits with large drive capability, similar to the MC10110, have two V_{CC1} pins. All V_{CC} pins should be connected to the ground plane or ground bus as close to the package as possible.

For further discussion of MECL power supply considerations to be made in system designing, see MECL System Design Handbook, HB205.

POWER DISSIPATION

The power dissipation of MECL functional blocks is specified on their respective data sheets. This specification does not include power dissipated in the output devices due to output termination. The omission of internal output pulldown resistors permits the use of external terminations designed to yield best system performance. To obtain total operating power dissipation of a particular functional block in a system, the dissipation of the output transistor, under load, must be added to the circuit power dissipation.

Table 7 lists the power dissipation in the output transistors plus that in the external terminating resistors, for the more

commonly used termination values and circuit configurations. To obtain true package power dissipation, one output-transistor power-dissipation value must be added to the specified package power dissipation for each external termination resistor used in conjunction with that package. To obtain system power dissipation, the stated dissipation in the external terminating resistors must be added as well. Unused outputs draw no power and may be ignored.

Table 7 — AVERAGE POWER DISSIPATION IN OUTPUT CIRCUIT WITH EXTERNAL TERMINATING RESISTORS

Terminating Resistor Value	Output Transistor Power Dissipation (mW)	Terminating Resistor Power Dissipation (mW)
150 ohms to -2.0 Vdc	5.0	4.3
100 ohms to -2.0 Vdc	7.5	6.5
75 ohms to -2.0 Vdc	10	8.7
50 ohms to -2.0 Vdc	15	13
2.0 k ohms to V_{EE}	2.5	7.7
1.0 k ohm to V_{EE}	4.9	15.4
680 ohms to V_{EE}	7.2	22.6
510 ohms to V_{EE}	9.7	30.2
270 ohms to V_{EE}	18.3	57.2
82 ohms to V_{CC} and 130 ohms to V_{EE}	15	140

LOADING CHARACTERISTICS

The differential input to MECL circuits offers several advantages. Its common-mode-rejection feature offers immunity against power-supply noise injection, and its relatively high input impedance makes it possible for any circuit to drive a relatively large number of inputs without deterioration of the guaranteed noise margin. Hence, dc fanout with MECL circuits does not normally present a design problem.

Graphs showing typical output voltage levels as a function of load current for MECL 10H, MECL 10K and MECL III shown in Figure 19. These graphs can be used to determine the actual output voltages for loads exceeding normal operation.

While dc loading causes a change in output voltage levels, thereby tending to affect noise margins, ac loading increases the capacitances associated with the circuit and, therefore, affects circuit speed, primarily rise and fall times.

MECL circuits typically have a 7 ohm output impedance and a relatively unaffected by capacitive loading on a positive-going output signal. However, the negative-going edge is dependent on the output pulldown or termination resistor. Loading close to a MECL output pin will cause an additional propagation delay of 0.1 ns per fanout load with a 50 ohm resistor to -2.0 Vdc or 270 ohms to -5.2 Vdc. A 100

ohm resistor to -2.0 Vdc or 510 ohms to -5.2 Vdc results in an additional 0.2 ns propagation delay per fanout load.

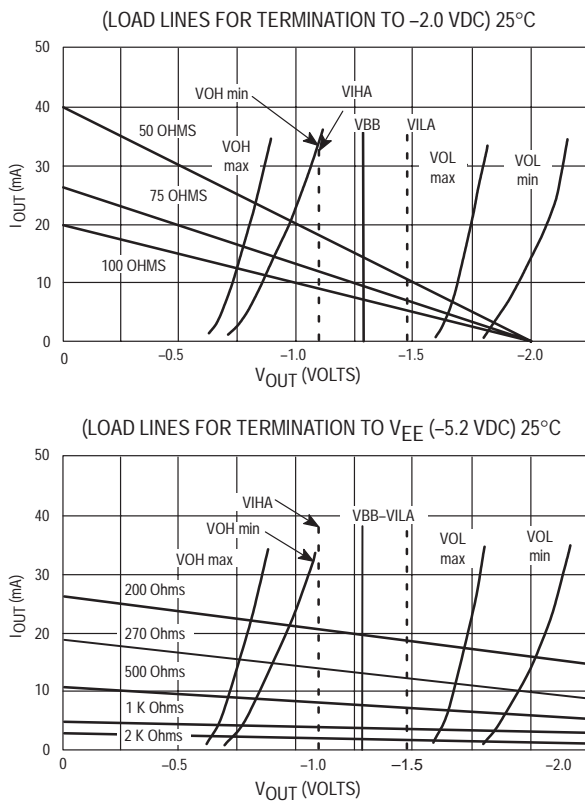
Terminated transmission line signal interconnections are used for best system performance. The propagation delay and rise time of a driving gate are affected very little by capacitance loading along a matched parallel-terminated transmission line. However, the delay and characteristic impedance of the transmission line itself are affected by the distributed capacitance. Signal propagation down the line will be increased by a factor, $\sqrt{1 + C_d/C_o}$. Here C_o is the normal intrinsic line

capacitance, and C_d is the distributed capacitance due to loading and stubs off the line.

Maximum allowable stub lengths for loading off of a MECL 10K transmission line vary with the line impedance. For example, with $Z_o = 50$ ohms, maximum stub length would be 4.5 inches (1.8 in. for MECL III). But when $Z_o = 100$ ohms, the maximum allowable stub length is decreased to 2.8 inches (1.0 in. for MECL III).

The input loading capacitance of a MECL 10H and MECL 10K gate is about 2.9 pF and 3.3 pF for MECL III. To allow for the IC connector or solder connection and a short stub length, 5 to 7 pF is commonly used in loading calculations.

Figure 19 — OUTPUT VOLTAGE LEVELS versus DC LOADING



UNUSED MECL INPUTS

The input impedance of a differential amplifier, as used in the typical MECL input circuit, is very high when the applied signal level is low. Under low-signal conditions, therefore, any leakage to the input capacitance of the gate could cause a gradual buildup of voltage on the input lead, thereby adversely affecting the switching characteristics at low repetition rates.

All single-ended input MECL logic circuits contain input pulldown resistors between the input transistor bases and V_{EE} . As a result, unused inputs may be left unconnected (the resistor provides a sink for I_{CBO} leakage currents, and inputs are held sufficiently negative that circuits will not trigger due to noise coupled into such inputs). Input pulldown resistor values are typically 50 kΩ and are not to be used as pulldown resistors for preceding open-emitter outputs.

Some MECL devices do not have input pulldowns. Examples are the differential line receivers. If a single differential receiver within a package is unused, one input of that receiver must be tied to the V_{BB} pin provided, and the other input goes to V_{EE} or is left open.

MECL circuits do not operate properly when inputs are connected to V_{CC} for a HIGH logic level. Proper design practice is to set a HIGH level about -0.9 volts below V_{CC} with a resistor divider, a diode drop, or an unused gate output.

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SECTION IV — SYSTEM DESIGN CONSIDERATIONS

THERMAL MANAGEMENT

Circuit performance and long-term circuit reliability are affected by die temperature. Normally, both are improved by keeping the IC junction temperatures low.

Electrical power dissipated in any integrated circuit is a source of heat. This heat source increases the temperature of the die relative to some reference point, normally the ambient temperature of 25°C in still air. The temperature increase, then, depends on the amount of power dissipated in the circuit and on the net thermal resistance between the heat source and the reference point.

The temperature at the junction is a function of the packaging and mounting system's ability to remove heat generated in the circuit — from the junction region to the ambient environment. The basic formula (a) for converting power dissipation to estimated junction temperature is:

$$T_J = T_A + P_D(\bar{\theta}_{JC} + \bar{\theta}_{CA}) \quad (1)$$

or

$$T_J = T_A + P_D\bar{\theta}_{JA} \quad (2)$$

where

T_J = maximum junction temperature
 T_A = maximum ambient temperature

P_D = calculated maximum power dissipation including effects of external loads (see Power Dissipation in section III).

$\bar{\theta}_{JC}$ = average thermal resistance, junction to case

$\bar{\theta}_{CA}$ = average thermal resistance, case to ambient

$\bar{\theta}_{JA}$ = average thermal resistance, junction to ambient

This Motorola recommended formula has been approved by RADC and DESC for calculating a "practical" maximum operating junction temperature for MIL-M-38510 (JAN) MECL 10K devices.

Only two terms on the right side of equation (1) can be varied by the user — the ambient temperature, and the device case-to-ambient thermal resistance, $\bar{\theta}_{CA}$. (To some extent the device power dissipation can be also controlled, but under recommended use the V_{EE} supply and loading dictate a fixed power dissipation.) Both system air flow and the package mounting technique affect the $\bar{\theta}_{CA}$ thermal resistance term. $\bar{\theta}_{JC}$ is essentially independent of air flow and external mounting method, but is sensitive to package material, die bonding method, and die area.

Table 8 — THERMAL RESISTANCE VALUES FOR STANDARD MECL I/C PACKAGES

Thermal Resistance in Still Air										
Package Description							$\bar{\theta}_{JA}$ (°C/Watt)		$\bar{\theta}_{JC}$ (°C/Watt)	
No. Leads	Body Style	Body Material	Body WxL	Die Bond	Die Area (Sq. Mils)	Flag Area (Sq. Mils)	Avg.	Max.	Avg.	Max.
8	DIL	EPOXY	1/4"×3/8"	EPOXY	2496	8100	102	133	50	80
8	DIL	ALUMINA	1/4"×3/8"	SILVER/GLASS	2496	N/A	140	182	35	56
14	DIL	EPOXY	1/4"×3/4"	EPOXY	4096	6400	84	109	38	61
14	DIL	ALUMINA	1/4"×3/4"	SILVER/GLASS	4096	N/A	100	130	25	40
16	DIL	EPOXY	1/4"×3/4"	EPOXY	4096	12100	70	91	34	54
16	DIL	ALUMINA	1/4"×3/4"	SILVER/GLASS	4096	N/A	100	130	25	40
20	PLCC	EPOXY	0.35"×0.35"	EPOXY	4096	14,400	74	82	N/A (6)	N/A (6)
24	DIL (4)	EPOXY	1/2"×1-1/4"	EPOXY	8192	22500	67	87	31	50
24	DIL (5)	ALUMINA	1/2"×1-1/4"	SILVER/GLASS	8192	N/A	50	65	10	16
28	PLCC	EPOXY	0.45"×0.45"	EPOXY	7134	28,900	65	68	N/A (6)	N/A (6)

NOTES:

- All plastic packages use copper lead frames — ceramic packages use alloy 42 frames.
- Body style DIL is "Dual-In-Line."
- Standard Mounting Methods:
 - Dual-In-Line In Socket or P/C board with no contact between bottom of package and socket or P/C board.
 - PLCC packages solder attached to traces on 2.24" × 2.24" × 0.062" FR4 type glass epoxy board with 1 oz./S.F. copper (solder coated) mounted to tester with 3 leads of 24 gauge copper wire.
- Case Outline 649
- Case Outline 623

$$6. \bar{\theta}_{JC} = \bar{\theta}_{JA} - \left(\frac{T_C - T_A}{P_D} \right)$$

T_C = Case Temperature (determined by thermocouple)

For applications where the case is held at essentially a fixed temperature by mounting on a large or temperature-controlled heatsink, the estimated junction temperature is calculated by:

$$T_J = T_C + P_D (\bar{\theta}_{JC}) \quad (3)$$

where T_C = maximum case temperature and the other parameters are as previously defined.

The maximum and average thermal resistance values for standard MECL IC packages are given in Table 8. In , this basic data is converted into graphs showing the maximum power dissipation allowable at various ambient temperatures (still air) for circuits mounted in the different packages, taking into account the maximum permissible operating junction temperature for long term life ($\geq 100,000$ hours for ceramic packages).

AIR FLOW

The effect of air flow over the packages on $\bar{\theta}_{JA}$ (due to a decrease in θ_{CA}) is illustrated in the graphs of Figure 20 through Figure 22. This air flow reduces the thermal resistance of the package, therefore permitting a corresponding increase in power dissipation without exceeding the maximum permissible operating junction temperature.

As an example of the use of the information above, the maximum junction temperature for a 16 lead ceramic dual-in-line packaged MECL 10K quad OR/NOR gate (MC10101L) loaded with four 50 ohm loads can be calculated. Maximum total power dissipation (including 4 output loads) for this quad gate is 195 mW. Assume for this thermal study that air flow is 500 linear feet per minute. From Figure 23, θ_{JA} is $50^\circ\text{C}/\text{W}$. With T_A (air flow temperature at the device) equal to 25°C , the following maximum junction temperature results:

$$T_J = P_D (\bar{\theta}_{JA}) + T_A$$

$$T_J = (0.195 \text{ W}) (50^\circ\text{C}/\text{W}) + 25^\circ\text{C} = 34.8^\circ\text{C}$$

Under the above operating conditions, the MECL 10K quad gate has its junction elevated above ambient temperature by only 9.8°C .

Even though different device types mounted on a printed circuit board may each have different power dissipations, all will have the same input and output levels provided that each is subject to identical air flow and the same ambient air temperature. This eases design, since the only change in levels between devices is due to the increase in ambient temperatures as the air passes over the devices, or differences in ambient temperature between two devices.

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Figure 20 — AMBIENT TEMPERATURE DERATING CURVES (CERAMIC DUAL-IN-LINE PACKAGE)

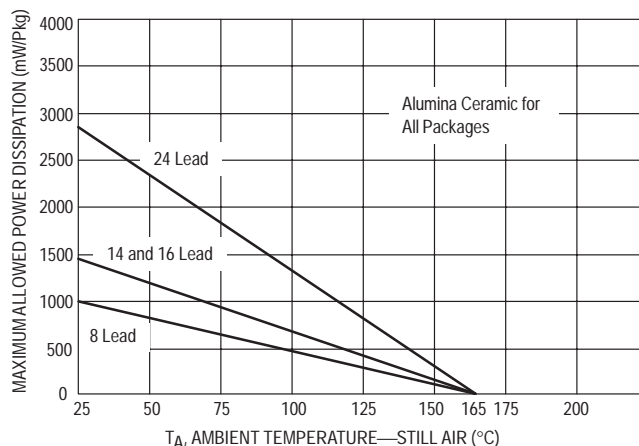


Figure 21 — AMBIENT TEMPERATURE DERATING CURVES (PLASTIC DUAL-IN-LINE PACKAGE)

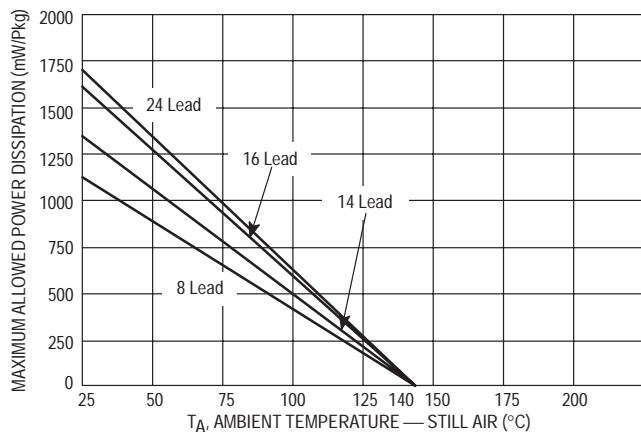


Figure 22 — AMBIENT TEMPERATURE DERATING CURVES (PLCC PACKAGE)

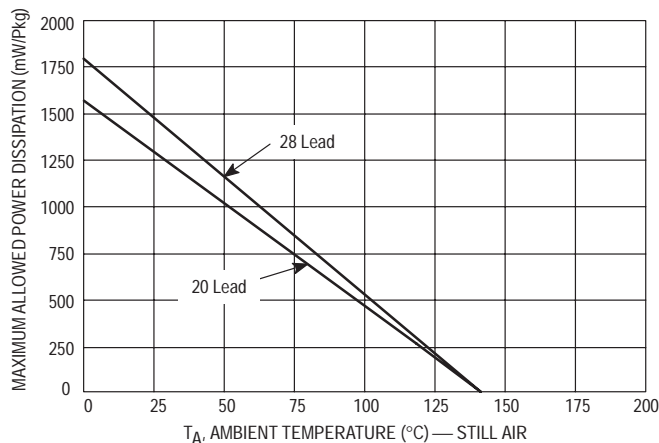


Figure 23 — AIRFLOW versus THERMAL RESISTANCE (CERAMIC DUAL-IN-LINE PACKAGE)

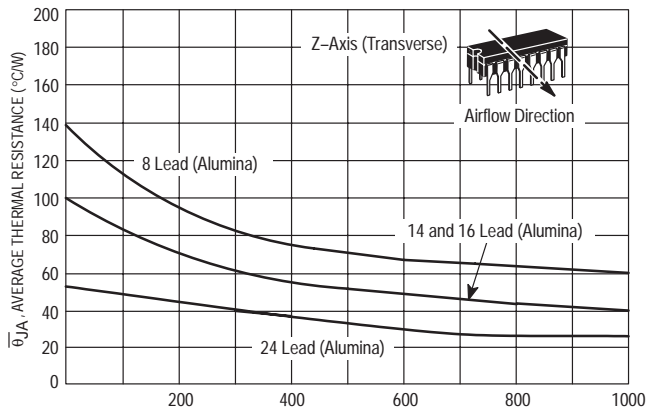


Figure 24 — AIRFLOW versus THERMAL RESISTANCE (PLASTIC DUAL-IN-LINE PACKAGE)

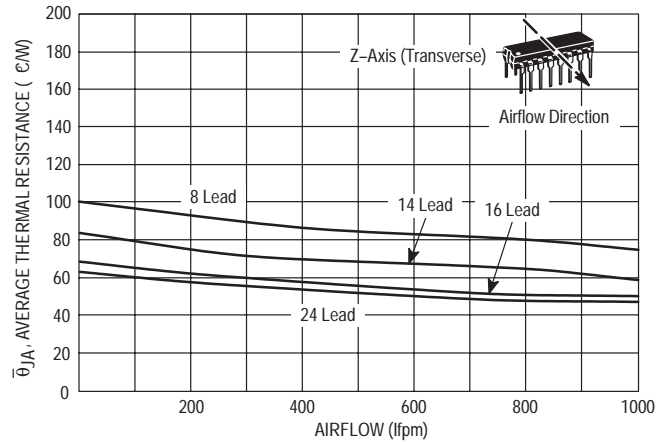


Figure 25 — AIRFLOW versus THERMAL RESISTANCE (PLCC PACKAGE)

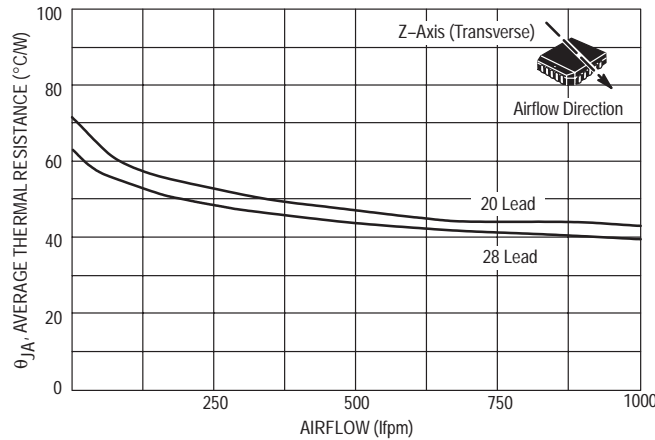


Table 9 — THERMAL GRADIENT OF JUNCTION TEMPERATURE (16-Pin MECL Dual-In-Line Package)

Power Dissipation (mW)	Junction Temperature Gradient (°C/Package)
200	0.4
250	0.5
300	0.63
400	0.88

Devices mounted on 0.062" PC board with Z axis spacing 0.5". Air flow is 500 lfpm along the Z axis.

The majority of MECL 10H, MECL 10K, and MECL III users employ some form of air-flow cooling. As air passes over each device on a printed circuit board, it absorbs heat from each package. This heat gradient from the first package to the last package is a function of the air flow rate and individual package dissipations. Table 9 provides gradient data at power levels of 200 mW, 250 mW, 300 mW, and 400 mW with an air flow rate of 500 lfpm. These figures show the proportionate

increase in the junction temperature of each dual-in-line package as the air passes over each device. For higher rates of air flow the change in junction temperature from package to package down the airstream will be lower due to greater cooling.

OPTIMIZING THE LONG TERM RELIABILITY OF PLASTIC PACKAGES

Today's plastic integrated circuit packages are as reliable as ceramic packages under most environmental conditions. However when the ultimate in system reliability is required, thermal management must be considered as a prime system design goal.

Modern plastic package assembly technology utilizes gold wire bonded to aluminum bonding pads throughout the electronics industry. When exposed to high temperatures for protracted periods of time an intermetallic compound can form in the bond area resulting in high impedance contacts and degradation of device performance. Since the formation of intermetallic compounds is directly related to device junction temperature, it is incumbent on the designer to determine that the device junction temperatures are consistent with system reliability goals.

Predicting Bond Failure Time:

Based on the results of almost ten (10) years of +125°C operating life testing, a special arrhenius equation has been developed to show the relationship between junction temperature and reliability.

$$(1) T = (6.376 \times 10^{-9})e^{\left[\frac{11554.267}{273.15 + T_J} \right]}$$

Where: T = Time in hours to 0.1% bond failure (1 failure per 1,000 bonds).

T_J = Device junction temperature, °C.

And:

$$(2) T_J = T_A + P_D \theta_{JA} = T_A + \Delta T_J$$

Where: T_J = Device junction temperature, °C.

T_A = Ambient temperature, °C.

P_D = Device power dissipation in watts.

θ_{JA} = Device thermal resistance, junction to air, °C/Watt.

ΔT_J = Increase in junction temperature due to on-chip power dissipation.

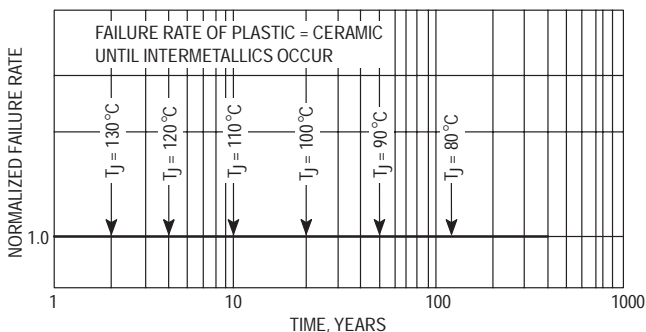
Table 10 shows the relationship between junction temperature, and continuous operating time to 0.1% bond failure, (1 failure per 1,000 bonds).

Table 10 — DEVICE JUNCTION TEMPERATURE versus TIME TO 0.1% BOND FAILURES

Junction Temperature °C	Time, Hours	Time, Years
80	1,032,200	117.8
90	419,300	47.9
100	178,700	20.4
110	79,600	9.4
120	37,000	4.2
130	17,800	2.0
140	8,900	1.0

Table 10 is graphically illustrated in Figure 26 which shows that the reliability for plastic and ceramic devices are the same until elevated junction temperatures induces intermetallic failures in plastic devices. Early and mid-life failure rates of plastic devices are not effected by this intermetallic mechanism.

Figure 26. FAILURE RATE versus TIME JUNCTION TEMPERATURE



MECL Junction Temperatures:

Power levels have been calculated for a number of MECL 10K and MECL 10H devices in 20 pin plastic leaded chip carriers and translated to the resulting increase of junction temperature (ΔT_J) for still air and moving air at 500 LFPM using equation 2 and are shown in Table 11.

Table 11 — INCREASE IN JUNCTION TEMPERATURE DUE TO I/C POWER DISSIPATION. 20 PIN PLASTIC LEADED CHIP CARRIER

MECL 10K Device Type	ΔT _J , °C		MECL 10H Device Type	ΔT _J , °C	
	Still Air	500 LFPM Air		Still Air	500 LFPM Air
MC10101	21.8	14.1	MC10H016	48.0	30.0
MC10102	17.6	11.4	MC10H100	16.6	10.8
MC10103	17.6	11.4	MC10H101	22.1	14.5
MC10104	20.8	13.4	MC10H102	18.0	11.8
MC10105	17.2	11.2	MC10H103	18.0	11.8
MC10106	13.0	8.4	MC10H104	21.0	13.5
MC10107	19.8	12.8	MC10H105	17.8	11.7
MC10109	11.7	7.7	MC10H106	13.2	8.7
MC10110	24.7	16.1	MC10H107	20.0	12.9
MC10111	24.7	16.1	MC10H109	11.9	7.8
MC10113	22.2	14.3	MC10H113	22.8	14.8
MC10114	22.6	14.6	MC10H115	16.7	10.9
MC10115	16.7	10.9	MC10H116	17.8	11.7
MC10116	17.2	11.1	MC10H117	16.7	11.0
MC10117	16.2	10.5	MC10H121	13.9	9.1
MC10121	13.5	8.5	MC10H123	23.1	15.0
MC10123	37.6	24.0	MC10H124	44.2	28.4
MC10124	42.9	27.3	MC10H125	—	—
MC10125	—	—	MC10H130	28.2	18.2
MC10131	26.9	17.1	MC10H135	33.2	21.4
MC10133	34.4	21.9	MC10H136	61.7	38.5
MC10134	27.0	17.2	MC10H141	44.3	28.0
MC10135	31.9	20.3	MC10H145	59.4	36.9
MC10136	52.3	32.6	MC10H158	25.3	16.4
MC10138	37.0	23.2	MC10H159	27.3	17.7
MC10141	42.7	26.7	MC10H160	32.1	20.5
MC10153	34.4	21.9	MC10H161	41.5	26.7
MC10158	23.9	15.2	MC10H162	41.5	26.7
MC10159	25.8	16.4	MC10H164	31.9	20.6
MC10160	32.0	20.4	MC10H165	56.3	35.8
MC10161	40.7	26.0	MC10H166	44.4	28.3
MC10162	40.7	26.0	MC10H171	41.9	26.9
MC10164	31.3	20.1	MC10H172	41.9	26.9
MC10165	53.7	33.6	MC10H173	32.6	21.1
MC10166	43.5	27.6	MC10H174	32.5	21.0
MC10168	34.4	21.9	MC10H175	45.9	29.6
MC10170	29.9	18.9	MC10H176	50.9	32.3
MC10171	41.1	26.2	MC10H179	35.0	22.6
MC10172	41.1	26.2	MC10H180	42.4	27.2
MC10173	30.5	19.3	MC10H181 ⁴	64.4	38.6
MC10174	31.9	20.5	MC10H186	50.2	31.8
MC10175	43.7	27.6	MC10H188	25.8	16.7
MC10176	49.6	31.3	MC10H189	25.8	16.7
MC10178	38.1	23.9	MC10H209	18.9	12.5
MC10186	49.6	31.1	MC10H210	25.0	16.4
MC10188	25.4	16.4	MC10H211	25.0	16.4
MC10189	24.6	15.9	MC10H330 ⁴	65.8	36.1
MC10192	67.0	43.0	MC10H332	52.2	33.5
MC10195	46.7	29.9	MC10H334	77.8	49.3
MC10197	27.7	17.7	MC10H350	—	—
MC10198	21.2	13.4	MC10H351	27.2	18.1
MC10210	24.5	16.0	MC10H352	27.2	18.1
MC10211	24.6	16.0	MC10H424	37.7	24.3
MC10212	24.3	15.8			
MC10216	24.1	15.6			
MC10231	30.6	19.5			

NOTES:

- (1) All ECL outputs are loaded with a 50 Ω resistor and assumed operating at 50% duty cycle.
- (2) ΔT_J for ECL to TTL translators are excluded since the supply current to the TTL section is dependent on frequency, duty cycle and loading.
- (3) Thermal Resistance (θ_{JA}) measured with PLCC packages solder attached to traces on 2.24" x 2.24" x 0.062" FR4 type glass epoxy board with 1 oz./sq. ft. copper (solder-coated) mounted to tester with 3 leads of 24 gauge copper wire.
- (4) 28 lead PLCC.

1

Case Example:

After the desired system failure rate has been established for failure mechanisms other than intermetallics, each plastic device in the system should be evaluated for maximum junction temperature using Table 11. Knowing the maximum junction temperature refer to Table 10 or Equation 1 to determine the continuous operating time required to 0.1% bond failures due to intermetallic formation. At this time, system reliability departs from the desired value as indicated in Figure 26.

To illustrate, assume that system ambient air temperature is 55°C (an accepted industry standard for evaluating system failure rates). Reference is made to Table 11 to determine the maximum junction temperature for each device for still air and transverse air flow of 500 LFPM.

Adding the 55°C ambient to the highest, ΔT_J listed, 77.8°C (for the MC10H334 with no air flow), gives a maximum junction temperature of 132.8°C. Reference to Table 10 indicates a departure from the desired failure rate after about 2 years of constant exposure to this junction temperature. If 500 LFPM of air flow is utilized, maximum junction temperature for this device is reduced to 104.3°C for which Table 10 indicates an increased failure rate in about 15 years.

Air flow is one method of thermal management which should be considered for system longevity. Other commonly used methods include heat sinks for higher powered devices, refrigerated air flow and lower density board stuffing.

The material presented here emphasizes the need to consider thermal management as an integral part of system design and also the tools to determine if the management methods being considered are adequate to produce the desired system reliability.

THERMAL EFFECTS ON NOISE MARGIN

The data sheet dc specifications for standard MECL 10K and MECL III devices are given for an operating temperature range from -30°C to +85°C (0° to +75°C for MECL 10H and memories). These values are based on having an airflow of 500 lfpm over socket or P/C board mounted packages with no special heatsinking (i.e., dual-in-line package mounted on lead seating plane with no contact between bottom of package and socket or P/C board and flat package mounted with bottom in direct contact with non-metalized area of P/C board).

The designer may want to use MECL devices under conditions other than those given above. The majority of the low-power device types may be used without air and with higher θ_{JA} . However, the designer must bear in mind that junction temperatures will be higher for higher θ_{JA} , even though the ambient temperature is the same. Higher junction temperatures will cause logic levels to shift.

As an example, a 300 mW 16 lead dual-in-line ceramic device operated at $\theta_{JA} = 100^\circ\text{C}/\text{W}$ (in still air) shows a HIGH logic level shift of about 21 mV above the HIGH logic level when operated with 500 lfpm air flow and a $\theta_{JA} = 50^\circ\text{C}/\text{W}$. (Level shift = $\Delta T_J \times 1.4 \text{ mV}/^\circ\text{C}$).

If logic levels of individual devices shift by different amounts (depending on P_D and θ_{JA}), noise margins are somewhat

reduced. Therefore, the system designer must lay out his system bearing in mind that the mounting procedures to be used should minimize thermal effects on noise margin.

The following sections on package mounting and heatsinking are intended to provide the designer with sufficient information to insure good noise margins and high reliability in MECL system use.

MOUNTING AND HEATSINK SUGGESTIONS

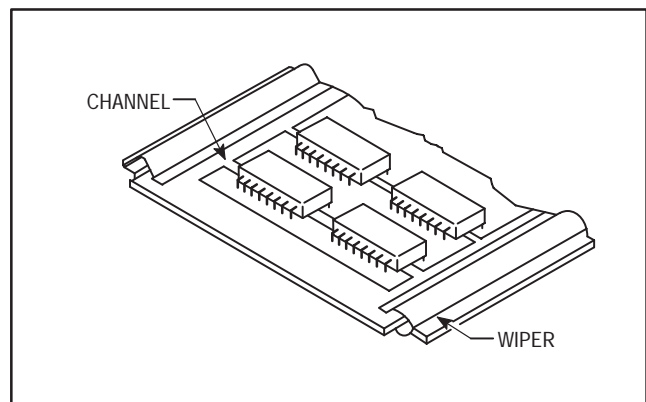
With large high-speed logic systems, the use of multilayer printed circuit boards is recommended to provide both a better ground plane and a good thermal path for heat dissipation. Also, a multilayer board allows the use of microstrip line techniques to provide transmission line interconnections.

Two-sided printed circuit boards may be used where board dimensions and package count are small. If possible, the V_{CC} ground plane should face the bottom of the package to form the thermal conduction plane. If signal lines must be placed on both sides of the board, the V_{EE} plane may be used as the thermal plane, and at the same time may be used as a pseudo ground plane. The pseudo ground plane becomes the ac ground reference under the signal lines placed on the same side as the V_{CC} ground plane (now on the opposite side of the board from the packages), thus maintaining a microstrip signal line environment.

Two-ounce copper P/C board is recommended for thermal conduction and mechanical strength. Also, mounting holes for low power devices may be countersunk to allow the package bottom to contact the heat plane. This technique used along with thermal paste will provide good thermal conduction.

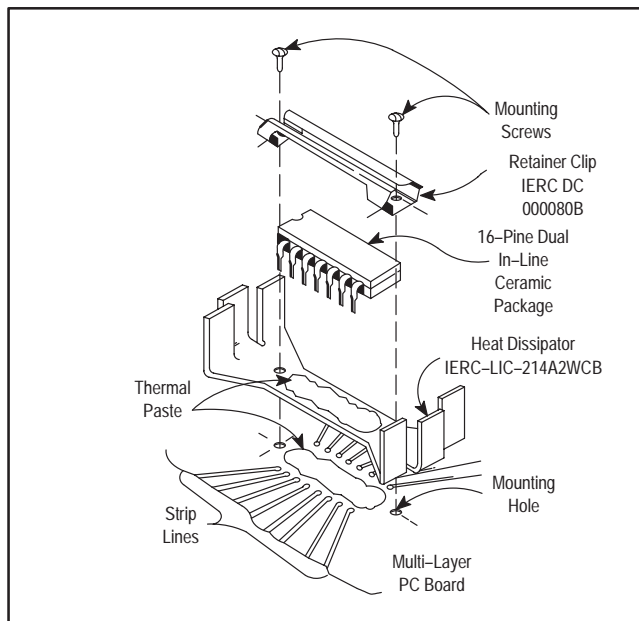
Printed channeling is a useful technique for conduction of heat away from the packages when the devices are soldered into a printed circuit board. As illustrated in Figure 27, this heat dissipation method could also serve as V_{EE} voltage distribution or as a ground bus. The channels should terminate into channel strips at each side or the rear of a plug-in type printed circuit board. The heat can then be removed from the circuit board, or board slide rack, by means of wipers that come into thermal contact with the edge channels.

Figure 27 — CHANNEL/WIPER HEATSINKING ON DOUBLE LAYER BOARD



For operating some of the higher power device types* in 16 lead dual-in-line packages in still air, requiring $\theta_{JA} < 100^\circ\text{C/W}$, a suitable heatsink is the IERC LIC-214A2WCB shown in Figure 28. This sink reduces the still air θ_{JA} to around 55°C/W . By mounting this heatsink directly on a copper ground plane (using silicone paste) and passing 500 lfm air over the packages, θ_{JA} is reduced to approximately 35°C/W , permitting use at higher ambient temperatures than $+85^\circ\text{C}$ ($+75^\circ\text{C}$ for MECL 10H memories) or in lowering T_J for improved reliability.

Figure 28 — MECL HIGH-POWER DUAL-IN-LINE PACKAGE MOUNTING METHOD



It should be noted that the use of a heatsink on the top surface of the dual-in-line package is not very effective in lowering the θ_{JA} . This is due to the location of the die near the bottom surface of the package. Also, very little ($< 10\%$) of the internal heat is withdrawn through the package leads due to the isolation from the ceramic by the solder glass seals and the limited heat conduction from the die through 1.0 to 1.5 mil aluminum bonding wires.

INTERFACING MECL TO SLOWER LOGIC TYPES

MECL circuits are interfaceable with most other logic forms. For MECL/TTL/DTL interfaces, when MECL is operated at the recommended -5.2 volts and TTL/DTL at $+5.0$ V supply, currently available translator circuits, such as the MC10124 and MC10125, may be used.

For systems where a dual supply (-5.2 V and $+5$ V) is not practical, the MC10H350 includes four single supply MECL to TTL translators, or a discrete component translator can be designed. For details, see MECL System Design Handbook (HB205). Such circuits can easily be made fast enough for any available TTL.

* 10129, 10136, 10H136, and 10137, Max $P_D > 800$ mW.

MECL also interfaces readily with MOS. With CMOS operating at $+5$ V, any of the MECL to TTL translators works very well.

Specific circuitry for use in interfacing MECL families to other logic types is given in detail in the MECL System Design Handbook.

Complex MECL 10K devices are presently available for interfacing MECL with MOS logic, MOS memories, TTL three-state circuits, and IBM bus logic levels. See Application Note AN-720 for additional interfacing information.

CIRCUIT INTERCONNECTIONS

Though not necessarily essential, the use of multilayer printed circuit boards offers a number of advantages in the development of high-speed logic cards. Not only do multilayer boards achieve a much higher package density, interconnecting leads are kept shorter, thus minimizing propagation delay between packages. This is particularly beneficial with MECL III which has relatively fast (1 ns) rise and fall times. Moreover, the unbroken ground planes made possible with multilayer boards permit much more precise control of transmission line impedances when these are used for interconnecting purposes. Thus multilayer boards are recommended for MECL III layouts and are justified when operating MECL 10H and MECL 10K at top circuit speed, when high-density package is a requirement, or when transmission line interconnects are used.

Point-to-point back-plane wiring without matched line terminations may be employed for MECL interconnections if line runs are kept short. At MECL 10K speeds, this applies to line runs up to 6 inches, for MECL 10H and MECL III up to 1 inch (Maximum open wire lengths for less than 100 mV undershoot). But, because of the open-emitter outputs of MECL 10H, MECL 10K and MECL III circuits, pull-down resistors are always required. Several ways of connecting such pull-down resistors are shown in Figure 29 through Figure 31.

Resistor values for the connection in Figure 29 may range from 270 ohms to $k\Omega$ depending on power and load requirements. (See MECL System Design Handbook.) Power may be saved by connecting pull-down resistors in the range of 50 ohms to 150 ohms, to -2.0 Vdc, as shown in Figure 30. Use of a series damping resistor, Figure 31, will extend permissible lengths of unmatched-impedance interconnections, with some loss of edge speed.

With proper choice of the series damping resistor, line lengths can be extended to any length,** while limiting overshoot and undershoot to a predetermined amount. Damping resistors usually range in value from 10 ohms to 100 ohms, depending on the line length, fanout, and line impedance, the open emitter-follower outputs of MECL 10H, MECL III and MECL 10K give the system designer all possible line driving options.

One major advantage of MECL over saturated logic is its capability for driving matched-impedance transmission lines. Use of transmission lines retains signal integrity over long distances. The MECL 10H and MECL 10K emitter-follower output transistors will drive a 50-ohm transmission line terminated to -2.0 Vdc. This is the equivalent current load of 22 mA in the HIGH logic state and 6 mA in the LOW state.

** Limited only by line attenuation and band-width characteristics.

1

Parallel termination of transmission lines can be done in two ways. One, as shown in Figure 32, uses a single resistor whose value is equal to the impedance (Z_0) of the line. A terminating voltage (V_{TT}) of -2.0 Vdc must be supplied to the terminating resistor.

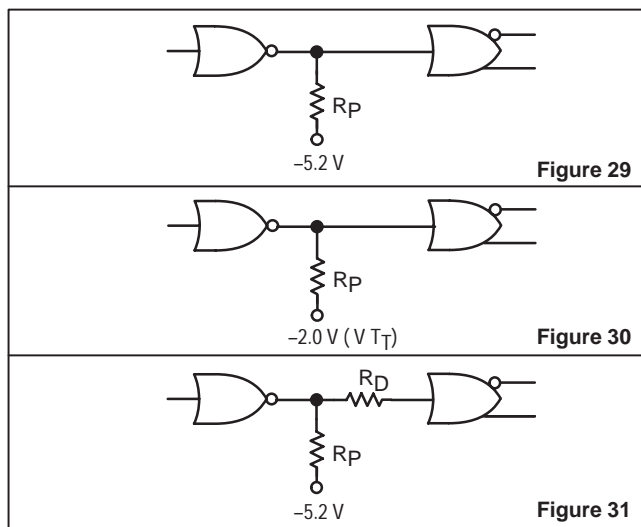
Another method of parallel termination uses a pair of resistors, R1 and R2. Figure 33 illustrates this method. The following two equations are used to calculate the values of R1 and R2:

$$R1 = 1.6 Z_0$$

$$R2 = 2.6 Z_0$$

Another popular approach is the series-terminated transmission line (see Figure 32 and Figure 33). This differs from parallel termination in that only one-half the logic swing is propagated through the lines. The logic swing doubles at the end of the transmission line due to reflection on an open line, again establishing a full logic swing.

PULL-DOWN RESISTOR TECHNIQUES



To maintain clean wave fronts, the input impedance of the driven gate must be much greater than the characteristic impedance of the transmission line. This condition is satisfied by MECL circuits which have high impedance inputs. Using the appropriate terminating resistor (R_S) at point A (Figure 34), the reflections in the transmission line will be terminated.

Figure 32 — PARALLEL TERMINATED LINE

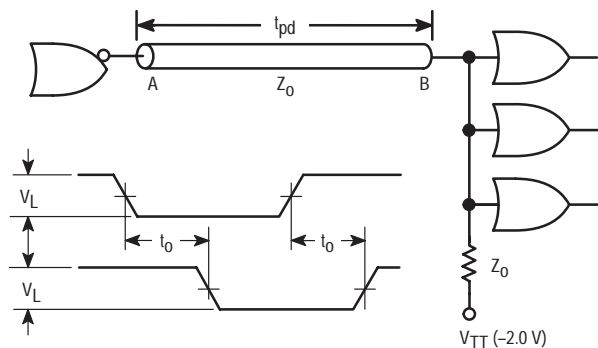


Figure 33 — PARALLEL TERMINATION — THEVENIN EQUIVALENT

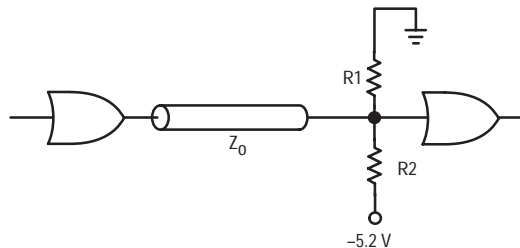
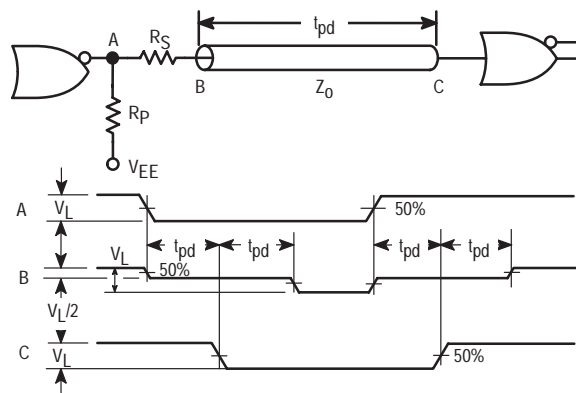


Figure 34 — SERIES TERMINATED LINE



The advantages of series termination include ease of driving multiple series-terminated lines, low power consumption, and low cross talk between adjacent lines. The disadvantage of this system is that loads may not be distributed along the transmission line due to the one-half logic swing present at intermediate points.

For board-to-board interconnections, coaxial cable may be used for signal conductors. The termination techniques just discussed also apply when using coax. Coaxial cable has the advantages of good noise immunity and low attenuation at high frequencies.

Twisted pair lines are one of the most popular methods of interconnecting cards or panels. The complementary outputs of any MECL function may be connected to one end of the twisted pair line, and any MECL differential line receiver to the other as shown in the example, Figure 35. R_T is used to terminate the twisted pair line. The 1 to 1.5 V common-mode noise rejection of the line receiver ignores common-mode cross talk, permitting multiple twisted pair lines to be tied into cables. MECL signals may be sent very long distances (> 1000 feet) on twisted pair, although line attenuation will limit bandwidth, degrading edge speeds when long line runs are made.

If timing is critical, parallel signals paths (shown in Figure 36) should be used when fanout to several cards is required. This will eliminate distortion caused by long stub lengths off a signal path.

Wire-wrapped connections can be used with MECL 10K. For MECL III and MECL 10H, the fast edge speeds (1 ns) create a mismatch at the wire-wrap connections which can cause reflections, thus reducing noise immunity. The mismatch occurs also with MECL 10K, but the distance

between the wire-wrap connections and the end of the line is generally short enough so the reflections cause no problem.

Series damping resistors may be used with wire-wrapped lines to extend permissible backplane wiring lengths. Twisted pair lines may be used for even longer distances across large wire-wrapped cards. The twisted pair gives a more defined characteristic impedance (than a single wire), and can be connected either single-ended, or differentially using a line receiver.

The recommended wire-wrapped circuit cards have a ground plane on one side and a voltage plane on the other side to insure a good ground and a stable voltage source for the circuits. In addition, the ground plane near the wire-wrapped lines lowers the impedance of those lines and facilitates terminating the line. Finally, the ground plane serves to minimize cross talk between parallel paths in the signal lines. Point-to-point wire routing is recommended because cross talk will be minimized and line lengths will be shortest. Commercial wire-wrap boards designed for MECL 10K are available from several vendors.

Figure 35 — TWISTED PAIR LINE DRIVER/RECEIVER

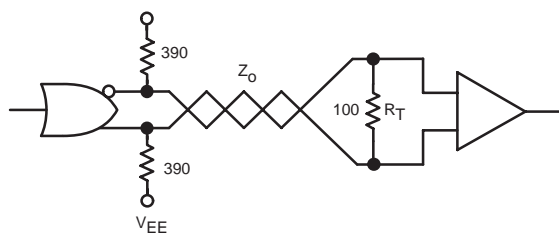
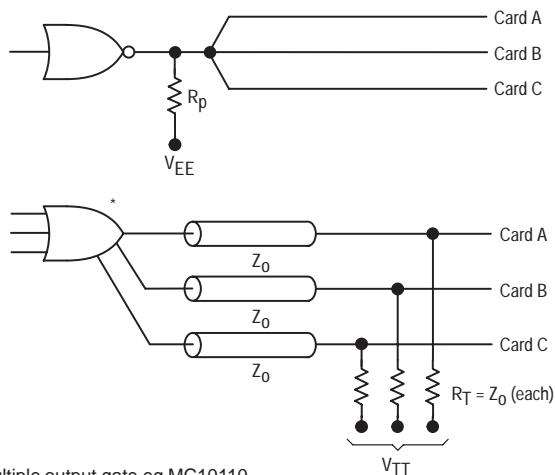


Figure 36 — PARALLEL FANOUT TECHNIQUES

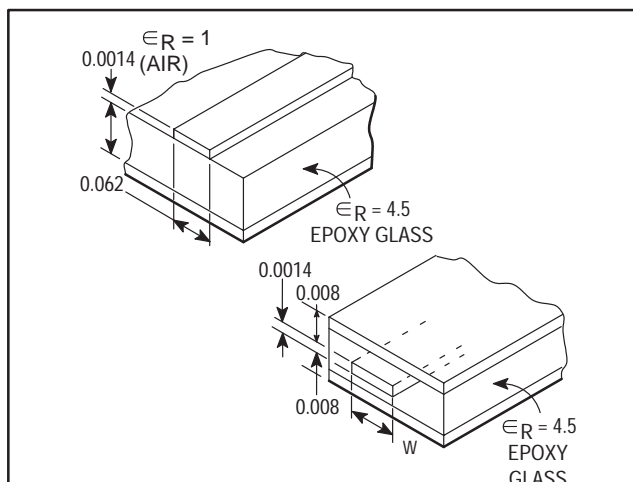


*Multiple output gate eg MC10110

Microstrip and Stripline

Microstrip and stripline techniques are used with printed circuit boards to form transmission lines. Microstrip consists of a constant-width conductor on one side of a circuit board, with a ground plane on the other side (shown in Figure 37). The characteristic impedance is determined by the width and thickness of the conductor, the thickness of the circuit board, and the dielectric constant of the circuit board material.

Figure 37 — PC INTERCONNECTION LINES FOR USE WITH MECL



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Stripline is used with multilayer circuit boards as shown in Figure 37. Stripline consists of a constant-width conductor between two ground planes.

Refer to MECL System Design Handbook for a full discussion of the properties and use of these.

CLOCK DISTRIBUTION

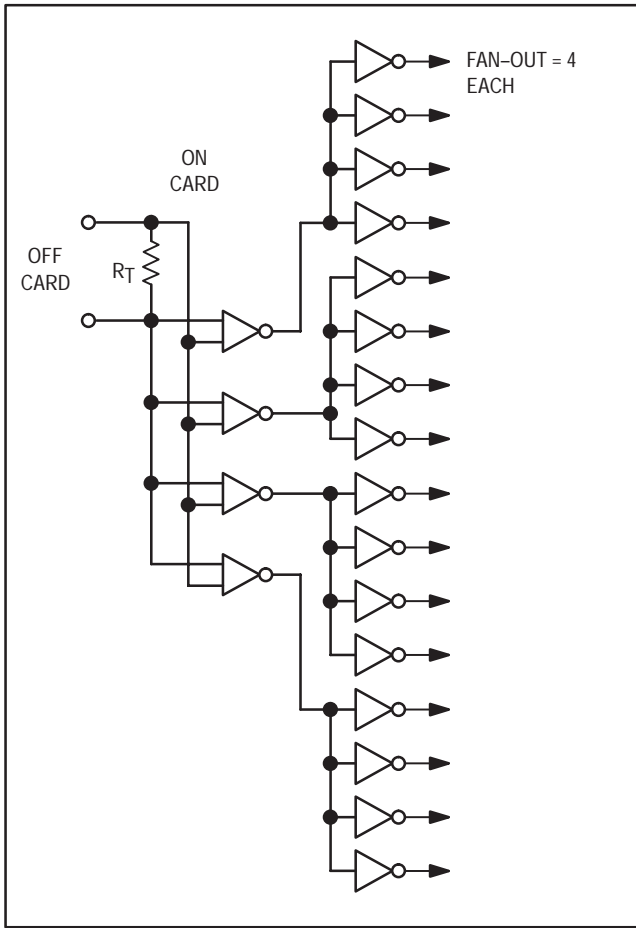
Clock distribution can be a system problem. At MECL 10K speeds, either coaxial cable or twisted pair line (using the MC10101 and MC10115) can be used to distribute clock signals throughout a system. Clock line lengths should be controlled and matched when timing could be critical. Once the clocking signals arrive on card, a tree distribution should be used for large-fanouts at high frequency. An example of the application of the technique is shown in Figure 38.

Because of the very high clock rates encountered in MECL III systems, rules for clocking are more rigorous than in slower systems.

The following guidelines should be followed for best results:
A. On-card Synchronous Clock Distribution via Transmission Line

1. Use the NOR output in developing clock chains or trees. Do not mix OR and NOR outputs in the chain.
2. Use balanced fanouts on the clock drivers.
3. Overshoot can be reduced by using two parallel drive lines in place of one drive line with twice the lumped load.

**Figure 38 — 64 FANOUT CLOCK DISTRIBUTION
(PROPER TERMINATION REQUIRED)**



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4. To minimize clock skewing problems on synchronous sections of the system, line delays should be matched to within 1 ns.

5. Parallel drive gates should be used when clocking repetition rates are high, or when high capacitance loads occur. The bandwidth of a MECL III gate may be extended by paralleling both halves of a dual gate. Approximately 40 or 50 MHz bandwidth can be gained by paralleling two or three clock driver gates.

6. Fanout limits should be applied to clock distribution drivers. Four to six loads should be the maximum load per driver for best high speed performance. Avoid large lumped loads at the end of lines greater than 3 inches. A lumped load, if used, should be four or fewer loads.

7. For wire-OR (emitter dotting), two-way lines (busses) are recommended. To produce such lines, both ends of a transmission line are terminated with 100-ohm impedance. This method should be used when wire-OR connections exceed 1 inch apart on a drive line.

B. Off-Card Clock Distribution

1. The OR/NOR outputs of an MC1660 may be used to drive into twisted pair lines or into flat, fixed-impedance ribbon cable. At the far end of the twisted pair on MC1692 differential line receiver is used. The line should be terminated as shown in Figure 35. This method not only provides high speed, board-to-board clock distribution, but also provides system noise margin advantages. Since the line receiver operates independently of the V_{BB} reference voltage (differential inputs) the noise margin from board to board is also independent of temperature differentials.

LOGIC SHORTCUTS

MECL circuitry offers several logic design conveniences. Among these are:

1. **Wire-OR** (can be produced by wiring MECL output emitters together outside packages).

2. **Complementary Logic Outputs** (both OR and NOR are brought out to package pins in most cases).

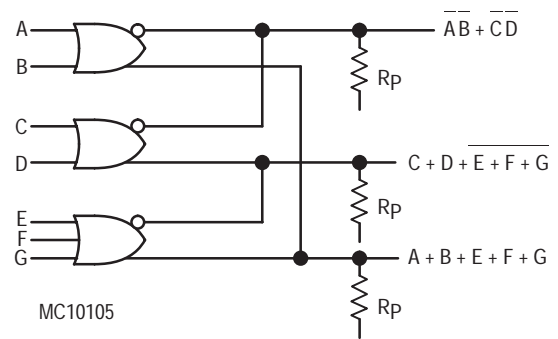
An example of the use of these two features to reduce gate and package count is shown in Figure 39.

The connection shown saves several gate circuits over performing the same functions with non-ECL type logic. Also, the logic functions in Figure 39 are all accomplished with one gate propagation delay time for best system speed. Wire-ORing permits direct connections of MECL circuits to busses. (MECL System Design Handbook and Application Note AN-726).

Propagation delay is increased approximately 50 ps per wire-OR connection. In general, wire-OR should be limited to 6 MECL outputs to maintain a proper LOW logic level. The MC10123 is an exception to this rule because it has a special V_{OL} level that allows very high fanout on a bus or wire-OR line. The use of a single output pull-down resistor is recommended per wire-OR, to economize on power dissipation. However, two pull-down resistors per wired-OR can improve fall times and be used for double termination of busses.

Wire-OR should be done between gates in a package or nearby packages to avoid spikes due to line propagation delay. This does not apply to bus lines which activate only one driver at a time.

**Figure 39 — USE OF WIRE-OR AND
COMPLEMENTARY OUTPUTS**



SYSTEM CONSIDERATIONS — A SUMMARY OF RECOMMENDATIONS

	MECL 10H	MECL 10K	MECL III
Power Supply Regulation	±5% (1)	10% (2)	10% (2)
On-Card Temperature Gradient	20°C	Less Than 25°C	Less Than 25°C
Maximum Non-Transmission Line Length (No Damping Resistor)	1"	8"	1"
Unused Inputs	Leave Open (3)	Leave Open (3)	Leave Open (3)
PC Board	Multilayer	Standard 2-Sided or Multilayer	Multilayer
Cooling Requirements	500 lfpm Air	500 lfpm Air	500 lfpm Air
Bus Connection Capability	Yes (Wire-OR)	Yes (Wire-OR)	Yes (Wire-OR)
Maximum Twisted Pair Length (Differential Drive)	Limited By Cable Response Only, Usually >1000'	Limited by Cable Response Only, Usually >1000'	Limited by Cable Response Only, Usually >1000'
The Ground Plane to Occupy Percent Area of Card	>75%	>50%	>75%
Wire Wrap may be used	Not Recommended	Yes	Not Recommended
Compatible with MECL 10,000	Yes	—	Yes

(1) All dc and ac parameters guaranteed for $V_{EE} = -5.2 \text{ V} \pm 5\%$.

(2) At the devices (functional only).

(3) Except special functions without input pull-down resistors.

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APPLICATIONS ASSISTANCE FORM

In the event that you have any questions or concerns about the performance of any Motorola device listed in this catalog, please contact your local Motorola sales office or the Motorola Help line for assistance. If further information is required, you can request direct factory assistance.

Please fill out as much of the form as is possible if you are contacting Motorola for assistance or are sending devices back to Motorola for analysis. Your information can greatly improve the accuracy of analysis and can dramatically improve the correlation response and resolution time.

Items 4 thru 8 of the following form contain important questions that can be invaluable in analyzing application or device problems. It can be used as a self-help diagnostic guideline or for a baseline of information gathering to begin a dialog with Motorola representatives.

MOTOROLA Device Correlation/Component Analysis Request Form

—Please fill out entire form and return with devices to MOTOROLA INC., R&QA DEPT., 2501 S. Price Rd., Chandler, AZ 85248.

1) Name of Person Requesting Correlation: _____

Phone No: _____ Job Title: _____ Company: _____

2) Alternate Contact: _____ Phone/Position: _____

3) Device Type (user part number): _____

4) Industry Generic Device Type: _____

5) # of devices tested/sampled: _____

of devices in question*: _____

returned for correlation: _____

* In the event of 100% failure, does Customer have other date codes of Motorola devices that pass inspection?

Yes _____ No _____ Please specify passing date code(s) if applicable _____

If none, does customer have viable alternate vendor(s) for device type?

Yes _____ No _____ Alternate vendor's name _____

6) Date code(s) and Serial Number(s) of devices returned for correlation — If possible, please provide one or two "good" units (Motorola's and/or other vendor) for comparison: _____

7) Describe USER process that device(s) are questionable in:

_____ Incoming component inspection {test system = ?}: _____

_____ Design prototyping: _____

_____ Board test/burn-in: _____

_____ Other (please describe): _____

8) Please describe the device correlation operating parameters as completely as possible for device(s) in question:

> Describe all pin conditions (e.g. floating, high, low, under test, stimulated but not under test, whatever ...), including any input or output loading conditions (resistors, caps, clamps, driving devices or devices being driven ...). Potentially critical information includes:

_____ Input waveform timing relationships

_____ Input edge rates

_____ Input Overshoot or Undershoot — Magnitude and Duration

_____ Output Overshoot or Undershoot — Magnitude and Duration

> Photographs, plots or sketches of relevant inputs and outputs with voltages and time divisions clearly identified for all waveforms are greatly desirable.

> V_{CC} and Ground waveforms should be carefully described as these characteristics vary greatly between applications and test systems. Dynamic characteristics of Ground and V_{CC} during device switching can dramatically effect input and internal operating levels. Ground & V_{CC} measurements should be made as physically close to the device in question as possible.

> Are there specific circumstances that seem to make the questionable unit(s) worse? Better?

_____ Temperature _____

_____ V_{CC} _____

_____ Input rise/fall time _____

_____ Output loading (current/capacitance) _____

_____ Others _____

> ATE functional data should include pattern with decoding key and critical parameters such as V_{CC} , input voltages, Func step rate, voltage expected, time to measure.

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SECTION V — MOTOROLA'S PHASE-LOCKED LOOP

WHERE ARE THE PHASE-LOCKED LOOP ICs?

To better serve our customers, we have moved all of the MECL Phase-Locked Loop ICs to our High Performance Frequency Control Products (Hipercomm) publication. The Hipercomm book (BR1334/D) can be ordered from the Motorola Literature Distribution Center. Additionally, all of the PLL data sheets can be accessed via Internet or through the Motorola MFax™ fax-back systems. See a full listing of Motorola's PLLs on page 1-30 of this book.

Motorola SPS World MFax System

Mfax Access:

Email: RMFAX0@email.sps.mot.com
Telephone: TOUCH-TONE (602) 244-6609 or 1-800-774-1848
WWW: <http://Design-NET.com> → select the Mfax Icon.

A fax of complete, easy-to-use instructions can be obtained with a first-time phone call into the system, entering your FAX number and then, pressing 1.

Motorola SPS World Marketing Internet Server

Motorola SPS's Electronic Data Delivery organization has set up a World Wide Web Server to deliver Motorola SPS's technical data to the global Internet community. Technical data such as the complete Master Selection Guide along with the OEM North American price book are available on the Internet server with full search capabilities. Other data on the server include abstracts of data books, application notes, selector guides, and textbooks. All have easy text search capability. Ordering literature from the Literature Distribution Center is available on line. Other features of Motorola SPS's Internet server include the availability of a searchable press release database, technical training information, with on-line registration capabilities, complete on-line access to the Mfax system for ordering technical literature faxes, an on-line technical support form to send technical questions and receive answers through email, information on product groups, full search capabilities of device models, a listing of the Domestic and International sales offices, and links directly to other Motorola world wide web servers. *For more information on Motorola SPS's Internet server you can request **BR1307/D** from Mfax or LDC.*

After accessing the Internet, use the following URL:

<http://Design-NET.com>

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Motorola's Phase-Locked Loop ICs Available in BR1334/D – Hipercomm

Device	Function	Pins	DIP	SM	Temperature Range
Counters					
MC12014	Counter Control Logic	16	P,L	–	0 to +75°C
Detectors					
MC12002	Analog Mixer	14	P,L	–	–30 to +85°C
MC12040	Phase-Frequency Detector	14,20	P,L	FN	0 to +75°C
MCH/K12140	Phase-Frequency Detector	8	–	D	–40 to +70°C
Multivibrators					
MC1658	Voltage Controlled Multivibrator	16	P,L	D, FN	–30 to +85°C
MC12100	200MHz Voltage Controlled Multivibrator	20	P	DW, M, FN	0 to +75°C
MC12101	130MHz Voltage Controlled Multivibrator	20	P	DW, M, FN	0 to +75°C
Oscillators					
MC1648	Voltage Controlled Oscillator	14	P,L	D, FN	–30 to +85°C
MC12061	Crystal Oscillator	16	P,L	FN	0 to +75°C
MC12147	Low Power Voltage Controlled Oscillator Buffer	8	–	D, SD	–40 to +85°C
MC12148	Low Power Voltage Controlled Oscillator	8	–	D, SD	–40 to +85°C
MC12149	Ultra Low Power Voltage Controlled Oscillator	8	–	D, SD	–40 to +85°C
Prescalers					
MC12009	480MHz $\pm 5/6$ Dual Modulus Prescaler	16	P,L	FN	–30 to +85°C
MC12011	550MHz $\pm 8/9$ Dual Modulus Prescaler	16	P,L	FN	–30 to +85°C
MC12013	550MHz $\pm 10/11$ Dual Modulus Prescaler	16	P,L	FN	–30 to +85°C
MC12015	225MHz $\pm 32/33$ Dual Modulus Prescaler	8	P	D	–40 to +85°C
MC12016	225MHz $\pm P40/41$ Dual Modulus Prescaler	8	P	D	–40 to +85°C
MC12017	225MHz $\pm 64/65$ Dual Modulus Prescaler	8	P	D	–40 to +85°C
MC12018	520MHz $\pm 128/129$ Dual Modulus Prescaler	8	P	D	–40 to +85°C
MC12019	225MHz $\pm 20/21$ Dual Modulus Prescaler	8	P	D	–40 to +85°C
MC12022A	1.1GHz $\pm 64/65, \pm 128/129$ Dual Modulus Prescaler	8	P	D	–40 to +85°C
MC12022B	1.1GHz $\pm 64/65, \pm 128/129$ Dual Modulus Prescaler	8	P	D	–40 to +85°C
MC12022LVA	1.1GHz $\pm 64/65, \pm 128/129$ Low Voltage Dual Modulus Prescaler	8	P	D	–40 to +85°C
MC12022LVB	1.1GHz $\pm 64/65, \pm 128/129$ Low Voltage Dual Modulus Prescaler	8	P	D	–40 to +85°C
MC12022SLA	1.1GHz $\pm 64/65, \pm 128/129$ Low Power Dual Modulus Prescaler	8	P	D	–40 to +85°C
MC12022SLB	1.1GHz $\pm 64/65, \pm 128/129$ Low Power Dual Modulus Prescaler	8	P	D	–40 to +85°C
MC12022TSA	1.1GHz $\pm 64/65, \pm 128/129$ Low Power Dual Modulus Prescaler With On-Chip Output Termination	8	P	D	–40 to +85°C
MC12022TSB	1.1GHz $\pm 64/65, \pm 128/129$ Low Power Dual Modulus Prescaler With On-Chip Output Termination	8	P	D	–40 to +85°C
MC12022TVA	1.1GHz $\pm 64/65, \pm 128/129$ Low Voltage, Low Power Dual Modulus Prescaler With On-Chip Output Termination	8	P	D	–40 to +85°C
MC12022TVB	1.1GHz $\pm 64/65, \pm 128/129$ Low Voltage, Low Power Dual Modulus Prescaler With On-Chip Output Termination	8	P	D	–40 to +85°C

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Motorola's Phase-Locked Loop ICs Available in BR1334/D – Hipercomm (continued)

Device	Function	Pins	DIP	SM	Temperature Range
Prescalers					
MC12023	225MHz ± 64 Prescaler	8	P	D	0 to +70°C
MC12025	520MHz $\pm 64/65$ Dual Modulus Prescaler	8	P	D	-40 to +85°C
MC12026A	1.1GHz $\pm 8/9, \pm 16/17$ Dual Modulus Prescaler	8	P	D	-40 to +85°C
MC12026B	1.1GHz $\pm 8/9, \pm 16/17$ Dual Modulus Prescaler	8	P	D	-40 to +85°C
MC12028A	1.1GHz $\pm 32/33, \pm 64/65$ Dual Modulus Prescaler	8	P	D	-40 to +85°C
MC12028B	1.1GHz $\pm 32/33, \pm 64/65$ Dual Modulus Prescaler	8	P	D	-40 to +85°C
MC12031A	2.0GHz $\pm 64/65, \pm 128/129$ Low Voltage Dual Modulus Prescaler	8	P	D	-40 to +85°C
MC12031B	2.0GHz $\pm 64/65, \pm 128/129$ Low Voltage Dual Modulus Prescaler	8	P	D	-40 to +85°C
MC12032A	2.0GHz $\pm 64/65, \pm 128/129$ Dual Modulus Prescaler	8	P	D	-40 to +85°C
MC12032B	2.0GHz $\pm 64/65, \pm 128/129$ Dual Modulus Prescaler	8	P	D	-40 to +85°C
MC12033A	2.0GHz $\pm 32/33, \pm 64/65$ Low Voltage Dual Modulus Prescaler	8	P	D	-40 to +85°C
MC12033B	2.0GHz $\pm 32/33, \pm 64/65$ Low Voltage Dual Modulus Prescaler	8	P	D	-40 to +85°C
MC12034A	2.0GHz $\pm 32/33, \pm 64/65$ Dual Modulus Prescaler	8	P	D	-40 to +85°C
MC12034B	2.0GHz $\pm 32/33, \pm 64/65$ Dual Modulus Prescaler	8	P	D	-40 to +85°C
MC12036A	1.1GHz $\pm 64/65, \pm 128/129$ Dual Modulus Prescaler With Stand-By Mode	8	P	D	-40 to +85°C
MC12036B	1.1GHz $\pm 64/65, \pm 128/129$ Dual Modulus Prescaler With Stand-By Mode	8	P	D	-40 to +85°C
MC12038A	1.1GHz $\pm 64/65, \pm 127/128, \pm 255/256$ Low Power Dual Modulus Prescaler	8	P	D	-40 to +85°C
MC12052A	1.1GHz $\pm 64/65, \pm 128/129$ Super Low Power Dual Modulus Prescaler	8	-	D, SD	-40 to +85°C
MC12053A	1.1GHz $\pm 64/65, \pm 128/129$ Super Low Power Dual Modulus Prescaler With Stand-By Mode	8	-	D, SD	-40 to +85°C
MC12054A	2.0GHz $\pm 64/65, \pm 128/129$ Super Low Power Dual Modulus Prescaler	8	-	D, SD	-40 to +85°C
MC12058	1.1GHz $\pm 126/128, \pm 254/256$ Low Power Dual Modulus Prescaler	8	-	D, SD	-40 to +85°C
MC12066	1.3GHz $\pm 64/256$ Prescaler	8	-	D	-40 to +85°C
MC12073	1.1GHz ± 64 Prescaler	8	P	D	0 to +70°C
MC12074	1.1GHz ± 256 Low-Power Prescaler	8	P	D	0 to +70°C
MC12075	1.3GHz ± 64 Prescaler	8	P	D	0 to +85°C
MC12076	1.3GHz ± 256 Prescaler	8	P	D	0 to +85°C
MC12078	1.3GHz ± 256 Prescaler	8	P	D	0 to +85°C
MC12079	2.8GHz $\pm 64/128/256$ Prescaler	8	P	D	-40 to +85°C
MC12080	1.1GHz $\pm 10/20/40/80$ Prescaler	8	P	D	-40 to +85°C
MC12083	1.1GHz ± 2 Low Power Prescaler With Stand-By Mode	8	P	D	-40 to +85°C
MC12089	2.8GHz $\pm 64/128$ Prescaler	8	P	D	-40 to +85°C
MC12090	750MHz ± 2 UHF Prescaler <i>(Not Recommended for New Designs)</i>	16	P,L	-	0 to +75°C
MC12093	1.1GHz $\pm 2/4/8$ Low Power Prescaler With Stand-By Mode	8	-	D, SD	-40 to +85°C
MC12095	2.5GHz $\pm 2/4$ Low Power Prescaler With Stand-By Mode	8	-	D, SD	-40 to +85°C
MC12098	2.5GHz ± 8192 Prescaler	8	-	D	-40 to +85°C

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Motorola's Phase-Locked Loop ICs Available in BR1334/D – Hipercomm (continued)

Device	Function	Pins	DIP	SM	Temperature Range
Synthesizers					
MC12179	500–2800MHz Single Channel Frequency Synthesizer	8	–	D	–40 to +85°C
MC12181	125–1000MHz Frequency Synthesizer	16	–	D	–40 to +85°C
MC12202	1.1GHz Serial Input Synthesizer	16,20	–	D, DT	–40 to +85°C
MC12206	2.0GHz Serial Input Synthesizer	16,20	–	D, DT	–40 to +85°C
MC12207	2.0GHz Serial Input Synthesizer	16,20	–	M, DT	–40 to +85°C
MC12210	2.5GHz Serial Input Synthesizer	16,20	–	D, DT	–40 to +85°C

1

MECL Data



MECL 10H

2

MECL 10H

INTEGRATED CIRCUITS

MC10H100 SERIES

0 TO 75°C

Function Selection — (0 to +75°C)

Function	Device	Case
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NOR Gate

Quad 2-Input with Strobe	MC10H100	620, 648, 775
Quad 2-Input	MC10H102	620, 648, 775
Triple 4-3-3 Input	MC10H106	620, 648, 775
Dual 3-Input 3-Output	MC10H211	620, 648, 775

OR Gate

Quad 2-Input	MC10H103	620, 648, 775
Dual 3-Input 3-Output	MC10H210	620, 648, 775

AND Gates

Quad AND	MC10H104	620, 648, 775
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Complex Gates

Quad OR/NOR	MC10H101	620, 648, 775
Triple 2-3-2 Input OR/NOR	MC10H105	620, 648, 775
Triple Exclusive OR/NOR	MC10H107	620, 648, 775
Dual 4-5 Input OR/NOR	MC10H109	620, 648, 775
Quad Exclusive OR	MC10H113	620, 648, 775
Dual 2-Wide OR-AND/OR-AND INVERT	MC10H117	620, 648, 775
4-Wide OR-AND/OR-AND INVERT	MC10H121	620, 648, 775
Hex Buffer w/Enable	MC10H188	620, 648, 775
Hex Inverter w/Enable	MC10H189	620, 648, 775

Translators

Quad TTL to MECL	MC10H124	620, 648, 775
Quad MECL to TTL	MC10H125	620, 648, 775
Quad MECL-to-TTL Translator, Single Power Supply (-5.2 V or +5.0 V)	MC10H350	620, 648, 775
Quad TTL/NMOS to MECL Translator	MC10H351	732, 738, 775
Quad CMOS to MECL Translator	MC10H352	732, 738, 775
Quad TTL to MECL, ECL Strobe	MC10H424	620, 648, 775
9-Bit TTL-ECL Translator	MC10H/100H600	776
9-Bit ECL-TTL Translator	MC10H/100H601	776
9-Bit Latch/TTL-ECL Translator	MC10H/100H602	776
9-Bit Latch/ECL-TTL Translator	MC10H/100H603	776
Registered Hex TTL-ECL Translator	MC10H/100H604	776
Registered Hex ECL-TTL Translator	MC10H/100H605	776
Registered Hex TTL-PECL Translator	MC10H/100H606	776
Registered Hex PECL-TTL Translator	MC10H/100H607	776

Receivers

Quad Line Receiver	MC10H115	620, 648, 775
Triple Line Receiver	MC10H116	620, 648, 751B, 775

Flip-Flop Latches

Dual D Latch	MC10H130	620, 648, 775
Dual D Master Slave Flip-Flop	MC10H131	620, 648, 775
Dual J-K Master Slave Flip-Flop	MC10H135	620, 648, 775
Hex D Flip-Flop	MC10H176	620, 648, 775
Quint Latch	MC10H175	620, 648, 775
Hex D Flip-Flop w/Common Reset	MC10H186	620, 648, 775

Encoders Decoders

Binary to 1-8 (Low)	MC10H161	620, 648, 775
Binary to 1-8 (High)	MC10H162	620, 648, 775
Dual Binary to 1-4 (Low)	MC10H171	620, 648, 775
Dual Binary to 1-4 (High)	MC10H172	620, 648, 775
8-Input Priority Encoder	MC10H165	620, 648, 775

Parity Checker

12-Bit Parity Generator/Checker	MC10H160	620, 648, 775
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Function	Device	Case
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Transceivers

4-Bit Differential ECL Bus to TTL Bus Transceiver	MC10/10H680	776
Hex ECL-TTL Transceiver w/Latches	MC10/10H681	776

Data Selector Multiplexer

Quad Bus Driver/Receiver with 2-to-1 Output Multiplexers	MC10H330	758, 724, 776
Quad 2-Input Multiplexers (Noninverting)	MC10H158	620, 648, 775
Quad 2-Input Multiplexers (Inverting)	MC10H159	620, 648, 775
8-Line Multiplexer	MC10H164	620, 648, 775
Quad 2-Input Multiplexer Latch	MC10H173	620, 648, 775
Dual 4-1 Multiplexer	MC10H174	620, 648, 775

Counters

Universal Hexadecimal	MC10H136	620, 648, 775
Binary Counter	MC10H016	620, 648, 775

Arithmetic Functions

Look Ahead Carry Block	MC10H179	620, 648, 775
Dual High Speed Adder/Subtractor	MC10H180	620, 648, 775
4-Bit ALU	MC10H181	724, 758, 776

Special Function

4-Bit Universal Shift Register	MC10H141	620, 648, 775
16 x 4 Bit Register File	MC10H145	620, 648, 775
5-Bit Magnitude Comparator	MC10H166	620, 648, 775
Quad Bus Driver/Receiver with Transmit and Receiver Latches	MC10H334	732, 738, 775
4-Bit ECL-TTL Load Reducing DRAM Driver	MC10H/100H660	776

Memories

16 x 4 Bit Register File	MC10H145	620, 648, 775
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Bus Driver (25 ohm outputs)

Triple 4-3-3 Input Bus Driver (25 Ohms)	MC10H123	620, 648, 775
Quad Bus Driver/Receiver with 2-to-1 Output Multiplexers	MC10H330	724, 758, 776
Dual Bus Driver/Receiver with 4-to-1 Output Multiplexers	MC10H332	732, 738, 775
Quad Bus Driver/Receiver with Transmit and Receiver Latches	MC10H334	732, 738, 775

OR/NOR Gate

Dual 4-5 Input OR/NOR Gate	MC10H209	620, 648, 775
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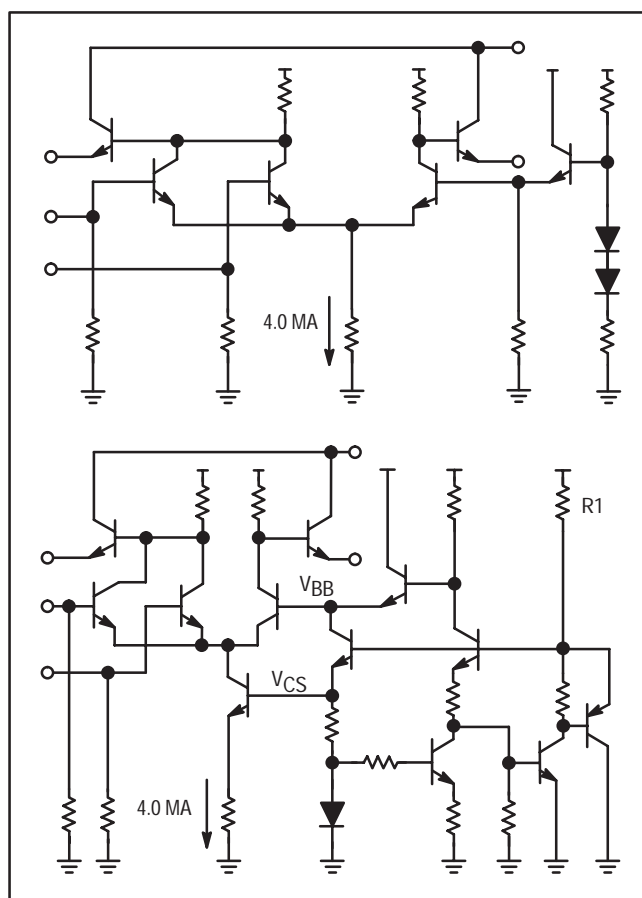
Clock Drivers

68030/40 ECL-TTL Clock Driver	MC10/100H640	776
Single Supply PECL-ECL 1:9 Clock Distribution	MC10/100H641	776
68030/40 ECL-TTL Clock Driver	MC10/100H642	776
Dual Supply ECT-TTL 1:8 Clock Driver	MC10/100H643	776
68030/40 PECL-TTL Clock Driver	MC10/100H644	775
1:9 TTL Clock Driver	MC10H645	776
PCL-TTL-TTL 1:8 Clock Distribution Chip	MC10/100H646	776

MECL 10H INTRODUCTION

Motorola's MECL 10H family features 100% improvement in propagation delay and clock speeds while maintaining power supply current equal to MECL 10K. This MECL family is voltage compensated which allows guaranteed dc and switching parameters over a $\pm 5\%$ power supply range. Noise margins of MECL 10H are 75% better than the MECL 10K series over the $\pm 5\%$ power supply range. MECL 10H is compatible with MECL 10K and MECL III, a key element in allowing users to enhance existing systems by increasing the speed in critical timing areas. Also, many MECL 10H devices are pinout/functional duplications of the MECL 10K series devices.

FIGURE 1 — MECL 10K versus MECL 10H GATE DESIGN



The schematics in Figure 1 compare the basic gate structure of the MECL 10H to that of MECL 10K devices. The gate switch current is established with a current source in the MECL 10H family as compared to a resistor source in MECL 10K. The bias generator in the MECL 10K device has been replaced with a voltage regulator in the MECL 10H series. The advantages of these design changes are: current-sources permit-matched collector resistors that yield correspondingly better matched delays, less variation in the output-voltage level with power supply changes, and matched output-tracking rates with temperature. These circuit changes

increase complexity at the gate level; however, the added performance more than compensates.

The MECL 10H family is being fabricated using Motorola's MOSAIC I (Motorola Oxide Self Assigned Implanted Circuits). The switching transistor's geometries obtained in the MOSAIC I process show a two-fold improvement in f_T , a reduction of more than 50% in parasitic capacitance and a decrease in device area of almost 76%.

FIGURE 2 — MOSAIC versus MECL 10K SWITCHING TRANSISTOR GEOMETRY

With improved geometry, the MECL10H switching transistors (left) are one-seventh the size of the older MECL 10K transistors (right). Along with the smaller area comes an improved f_T and reduced parasitic capacitances.

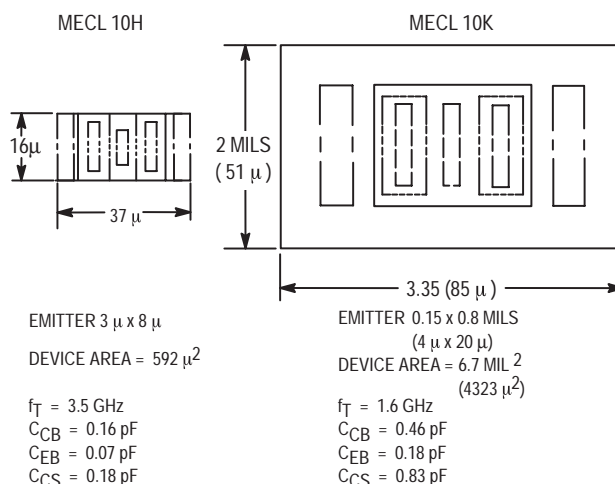


Figure 2 illustrates the relative size difference between the junction isolated transistor of MECL 10K and the MOSAIC I transistor of MECL 10H. This suggests that performance could be improved twofold at lower power levels. However, at the gate level, the power of the output transistor cannot be reduced without sacrificing output characteristics because of the 50 ohm drive requirements of MECL. In more complex functions, where part of the delay is associated with internal gates, MECL 10H devices use less power than the equivalent MECL 10K devices and provide an even more significant improvement in ac performance.

Table 1. — TYPICAL FAMILY CHARACTERISTICS FOR 10K AND 10H CIRCUITS

	10K	10H
Propagation delay (ns)	2.0	1.0
Power (mW)	25	25
Power-speed product (pJ)	50	25
Rise/fall times (ns) (20–80%)	2.0	1.0
Temperature range ($^{\circ}\text{C}$)	-30 to +85	0 to +75
Voltage regulated	No	Yes
Technology	Junction isolated	Oxide isolated
$V_{EE} = -5.2 \text{ V}$		

Supply & Temperature Variation

MECL 10H temperature and voltage compensation is designed to guarantee compatibility with MECL 10K, MECL III, MECL Memories and the MC10900 and Macrocell Array products. Table 1 summarizes some performance characteristics of the MECL 10K and 10H logic families in a 16-pin DIP. The MECL 10H devices offer typical propagation delays of 1.0 ns at 25 mW per gate when operated from a V_{EE} of -5.2 V. The resulting speed-power product of 25 picojoules is one of the best of any ECL logic family available today.

The operating temperature range is changed from -30°C to $+85^{\circ}\text{C}$ of the MECL 10K family to the narrower range of 0°C to 75°C for MECL 10H. This change matches the constraints established by the memory and array products. Operation at -30°C would require compromises in performance and power. With few exceptions, commercial applications are satisfied by 0°C min.

Table 2. — MECL 10H AC SPECIFICATIONS AND TRACKING

Parameter	0°C		25°C		75°C		Units
	Min	Typ Max	Min	Typ Max	Min	Typ Max	
t_{PD}	0.4	1.0 1.5	0.4	1.0 1.6	0.4	1.0 1.7	ns
t_R (20–80%)	Min	Max	Min	Max	Min	Max	ns
	0.5	1.5	0.5	1.6	0.5	1.7	
t_F (20–80%)	0.5	1.5	0.5	1.6	0.5	1.7	ns
$V_{EE} = -5.2 \text{ V} \pm 5\%$							
Parameter	Propagation delay (ns)*		Delay variation vs temp (ps/°C)		Delay variation vs supply (ps/V)		
	Typ	Max	Typ	Max	Typ	Max	
t_{PD}	10K	2.0 2.9	2.0	7.0	80		
	10H	1.0 1.5	0.5	4.0	0	0	

* $V_{EE} = -5.2 \text{ V}$, Temp = 25°C

AC specifications of MECL 10H products appear in Table 2. In the MECL 10H family, all ac specifications have guaranteed minimums and maximums for extremes of both temperature and supply — a first in ECL logic. In addition, flip flops, latches and counters will have guaranteed limits for setup time, hold time, and clock pulse width. The limits in Table 2 are guaranteed for a power supply variation of $\pm 5\%$. MECL 10K typically has a propagation delay (t_{PD}) variation of 80 ps/V with no guaranteed maximum. The typical variation in t_{PD} for MECL 10H circuits is only 38 ps typically over the entire specified temperature range and power-supply tolerance, and is guaranteed not to exceed 300 ps.

The improved performance in temperature over MECL 10K are a result of the internal voltage regulator. The primary difference being the flatter tracking rate of the output “0” level voltage (V_{OL}). This difference does not affect the compatibility with existing MECL families.

Changes in output “1” level voltages (V_{OH}) with supply variations are 10 mV/V less for the MECL 10H family. V_{OH} varies with the supply, primarily because of changes in chip temperature caused by the changes in power dissipation. However, the current in the MECL 10H circuits remains almost constant with supply changes, since the circuits are voltage compensated and use current sources for all internal emitter followers. Threshold voltage (V_{BB}) and output “0” level

Table 3. — LOGIC LEVEL DC TRACKING RATE FOR 10K AND 10H CIRCUITS

	Min	Typ	Max
$\Delta V_{OH}/\Delta T$ 10H (mV/°C) 10K	1.2	1.3	1.5
	1.2	1.3	1.5
$\Delta V_{BB}/\Delta T$ 10H (mV/°C) 10K	0.8	1.0	1.2
	0.8	1.0	1.2
$\Delta V_{OL}/\Delta T$ 10H (mV/°C) 10K	0	0.4	0.6
	0.35	0.5	0.75
	0.75	1.0	1.55
$\Delta V_{OH}/\Delta V_{EE}$ 10H (mV/V) 10K	-20		0
	-30		0
$\Delta V_{BB}/\Delta V_{EE}$ 10H (mV/V) 10K	0	10	25
	110	150	190
$\Delta V_{OL}/\Delta V_{EE}$ 10H (mV/V) 10K	0	20	50
	200	250	320

voltage (V_{OL}) variations are shown with respect to MECL 10K in Table 3. In both cases voltage compensation has reduced the variations significantly.

Noise Margin Considerations

Specification of input voltage levels (V_{IHA} , V_{ILA}) are changed from those of MECL 10K resulting in improved noise margins for MECL 10H.

The MECL 10K circuits have two sets of output voltage specifications (V_{OH} , V_{OHA} , and V_{OL} , V_{OLA}). The first output voltage specification in each set (V_{OH} and V_{OL}) are guaranteed maximum and minimum output levels for typical input levels. The second specification in each set (V_{OHA} and V_{OLA}) is the guaranteed worst-case output level for input threshold voltages. System analysis for worst-case noise margin considers V_{OHA} and V_{OLA} only. The MECL 10H family has only one set of output voltages (V_{OH} and V_{OL}) with minimum and maximum values specified. The minimum value of V_{OH} and the maximum value for V_{OL} of the MECL 10H family is synonymous with the V_{OHA} and V_{OLA} specifications of MECL 10K family.

The V_{OH} values for the MECL 10H circuits are equal to or better than the MECL 10K levels at all temperatures. Input threshold voltages (V_{IHA} and V_{ILA} , which are synonymous with V_{IH} min and V_{IL} max for 10H) are also improved and

Table 4. — NOISE MARGIN versus POWER-SUPPLY CONDITIONS

Parameter		$V_{EE} -10\%$		$V_{EE} -5\%$		V_{EE}		$V_{EE} +5\%$	
		Typ	Min	Typ	Min	Typ	Min	Typ	Min
Noise Margin High	10H	224	150	227	150	230	150	233	150
V_{NH} (mV)	10K	127	47	166	86	205	125	241	164
Noise Margin Low	10H	264	150	267	150	270	150	273	150
V_{NL} (mV)	10K	223	103	249	129	275	155	301	181

*Temp = 0 to 75°C

guaranteed V_{IHA} has been decreased by 25 mV over the entire operating temperature range, resulting in a "1" level noise margin of 150 mV (compared to 125 mV for MECL 10K circuits). V_{ILA} has been decreased by 5.0 mV, providing a "0" level noise margin equal to the "1" level noise margin. The V_{OL} minimum of the MECL 10H is more negative than for MECL 10K (-1950 mV instead of -1850 mV). The V_{OL} level for the MECL 10K family was selected to ensure that the gate would not saturate at high temperatures and high supply voltages. The reduction in operating temperature range for the MECL 10H family and the improvement in tracking rate allow the lower V_{OL} level. The change in this level does not affect system noise margins. Although some of the interface levels change with temperature, the changes in voltage levels are well within the tolerance ranges that would keep the families compatible. Table 4 lists some noise margins for V_{EE} supply variations.

The compatibility of MECL 10H with MECL 10K may be demonstrated by applying the tracking rates in Table 3 to the dc specifications. The method for determining compatibility is to show acceptable noise margins for MECL 10H, MECL 10K and mixed MECL 10K/MECL 10H systems. The assumption is that the families are compatible if the noise margin for a mixed system is equal to or better than the same system using

only the MECL 10K series.

Using an all MECL 10K system as a reference, three possible logic mixes must be considered: MECL 10K driving MECL 10H; MECL 10H driving MECL 10K; and MECL 10H driving MECL 10H. The system noise margin for the three configurations can now be calculated for the following cases (See Figure 3):

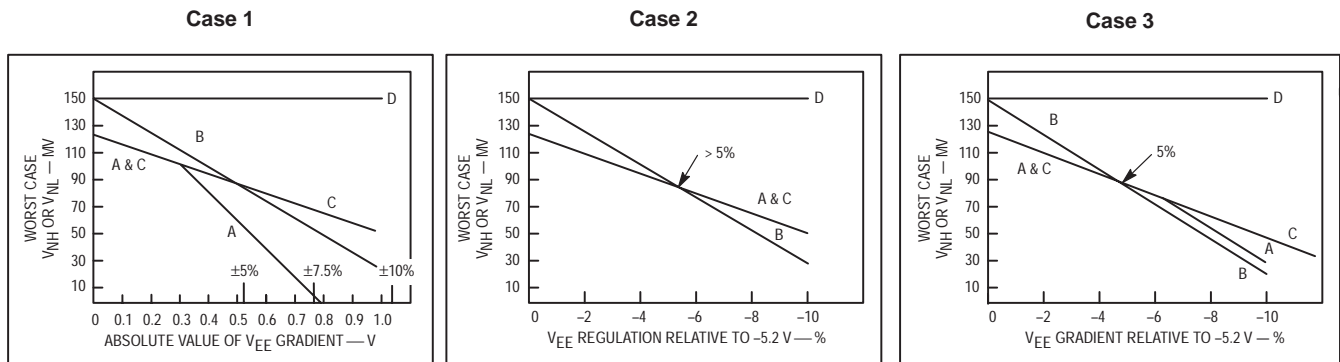
In Case 1, the system uses multiple power supplies, each independently voltage regulated to some percentage tolerance. Worst-case is where one device is at the plus extreme and the other device is at the minus extreme of the supply tolerance.

In Case 2, a system operates on a single supply or several supplies slaved to a master supply. The entire system can drift, but all devices are at the same supply voltage.

In Case 3, a system has excessive supply drops throughout. Supply gradients are due to resistive drops in V_{EE} bus.

The analysis indicates that the noise margins for a MECL 10K/10H system equal or exceed the margins for an all 10K system for supply tolerance up to $\pm 5\%$. The results of the analysis are shown in Figure 3.

FIGURE 3 — NOISE MARGIN versus POWER-SUPPLY VARIATION



A. MECL 10K DRIVING MECL 10K B. MECL 10K DRIVING MECL 10H C. MECL 10H DRIVING MECL 10K D. MECL 10H DRIVING MECL 10H

4-Bit Binary Counter

The MC10H016 is a high-speed synchronous, presettable, cascadable 4-bit binary counter. It is useful for a large number of conversion, counting and digital integration applications.

- Counting Frequency, 200 MHz Minimum
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible
- Positive Edge Triggered

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	126	—	115	—	126	mA
Input Current High All Except MR Pin 12 MR	I_{inH}	—	450 1190	—	265 700	—	265 700	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

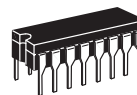
AC PARAMETERS

Propagation Delay Clock to Q_n Clock to TC MR to Q_n	t_{pd}	1.0 0.7 0.7	2.4 2.4 2.4	1.0 0.7 0.7	2.5 2.5 2.5	1.0 0.7 0.7	2.7 2.6 2.6	ns
Set-up Time P_n to Clock CE or PE to Clock	t_{set}	2.0 2.5	— —	2.0 2.5	— —	2.0 2.5	— —	ns
Hold Time Clock to P_n — Clock to CE or PE	t_{hold}	1.0 0.5	— —	1.0 0.5	— —	1.0 0.5	— —	ns
Counting Frequency	f_{count}	200	—	200	—	200	—	MHz
Rise Time	t_r	0.5	2.0	0.5	2.1	0.5	2.2	ns
Fall Time	t_f	0.5	2.0	0.5	2.1	0.5	2.2	ns

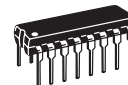
NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

MC10H016



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

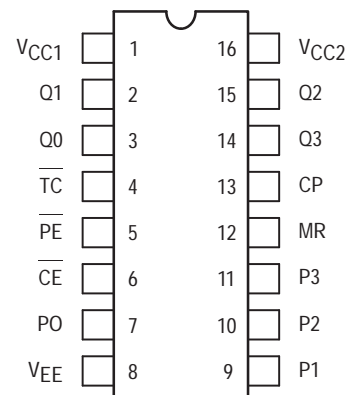


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6-11.

TRUTH TABLE

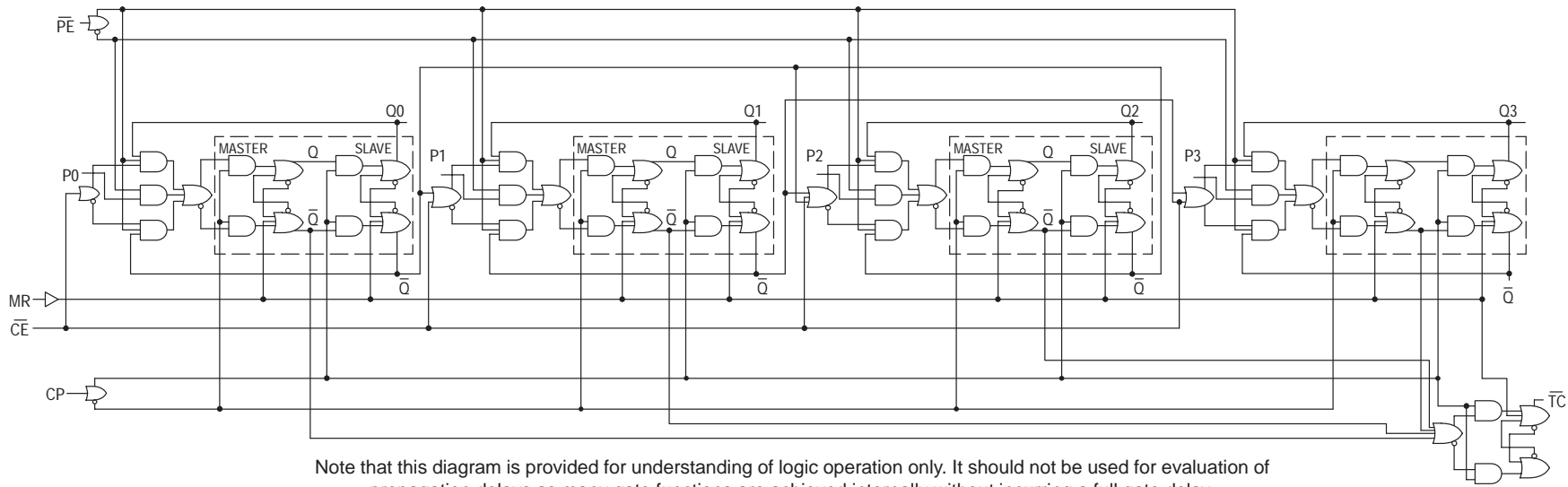
CE	PE	MR	CP	Function
L	L	L	Z	Load Parallel (P_n to Q_n)
H	L	L	Z	Load Parallel (P_n to Q_n)
L	H	L	Z	Count
H	H	L	Z	Hold
X	X	L	ZZ	Masters Respond; Slaves Hold
X	X	H	X	Reset ($Q_n = \text{LOW}$, $T_C = \text{HIGH}$)

Z = Clock Pulse (Low to High); ZZ = Clock Pulse (High to Low)

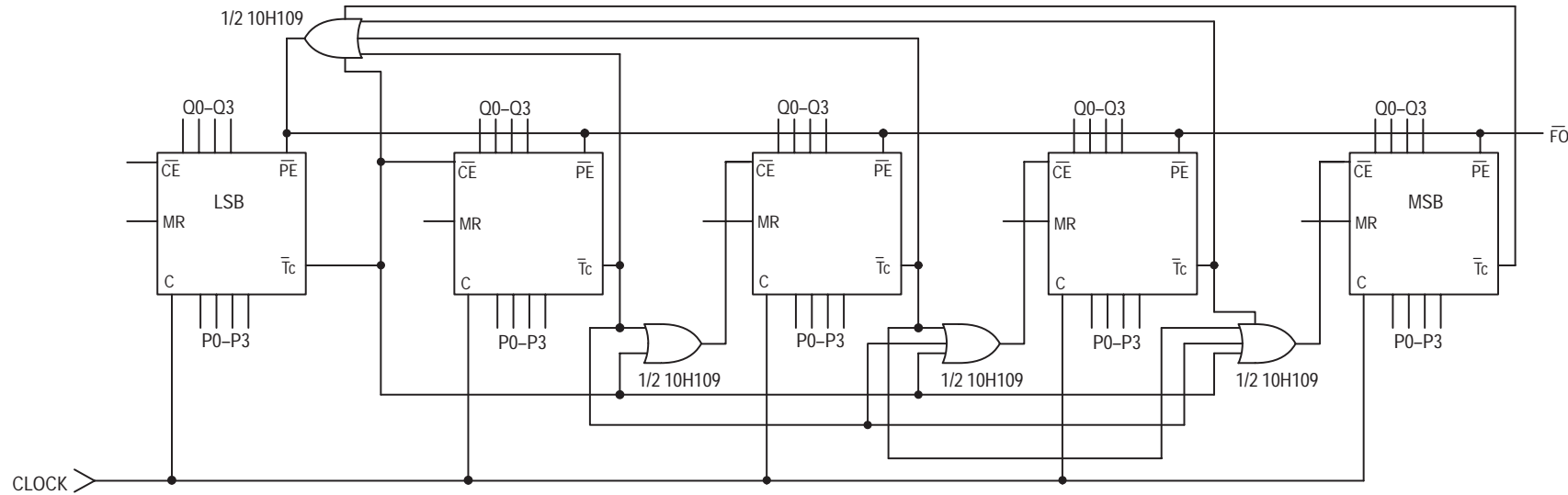
Features include assertion inputs and outputs on each of the four master/slave counting flip-flops. Terminal count is generated internally in a manner that allows synchronous loading at nearly the speed of the basic counter.



4-Bit Binary Counter Logic Diagram



Note that this diagram is provided for understanding of logic operation only. It should not be used for evaluation of propagation delays as many gate functions are achieved internally without incurring a full gate delay.



÷N Counter 1 to 16⁵
MC10H016 Cascaded for 5 Stage Presettable Counter
 Max freq. is only OR gate delay below max when counting alone.

Quad 2-Input NOR Gate With Strobe

The MC10H100 is a quad NOR gate. Each gate has 3 inputs, two of which are independent and one of which is tied common to all four gates.

- Propagation Delay, 1.0 ns Typical
- 25 mW Typ/Gate (No Load)
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	29	—	26	—	29	mA
Input Current High Pin 9 All Other Inputs	I_{inH}	—	900	—	560	—	560	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

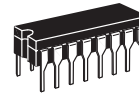
AC PARAMETERS

Characteristic	Symbol	0°	25°	75°	Unit			
Propagation Delay Pin 9 Only Exclude Pin 9	t_{pd}	0.65 0.4	1.6 1.3	0.7 0.45	1.7 1.35	0.7 0.5	1.8 1.5	ns
Rise Time	t_r	0.5	2.0	0.5	2.1	0.5	2.2	ns
Fall Time	t_f	0.5	2.0	0.5	2.1	0.5	2.2	ns

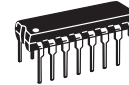
NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

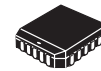
MC10H100



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

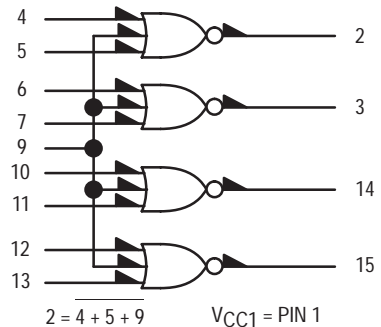


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



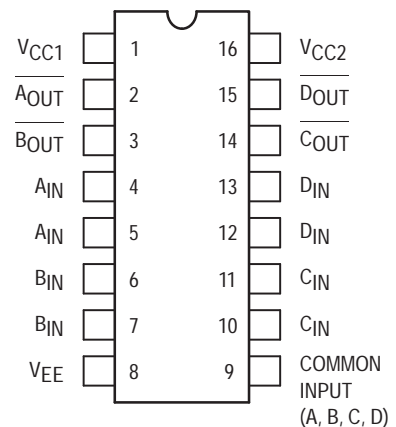
FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM



$V_{CC1} = \text{PIN 1}$
 $V_{CC2} = \text{PIN 16}$
 $V_{EE} = \text{PIN 8}$

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6-11.



Quad OR/NOR Gate

The MC10H101 is a quad 2-input OR/NOR gate with one input from each gate common to pin 12. This MECL 10H part is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in propagation delay, and no increases in power-supply current.

- Propagation Delay, 1.0 ns Typical
- Power Dissipation 25 mW/Gate (same as MECL 10K)
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C °C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	29	—	26	—	29	mA
Input Current High (Pin 12 only)	I_{inH}	—	425 850	—	265 535	—	265 535	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

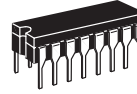
AC PARAMETERS

Propagation Delay	t_{pd}	0.5	1.6	0.5	1.6	0.5	1.7	ns
Pin 12 Only		0.5	1.45	0.5	1.5	0.5	1.6	
Exclude Pin 12								
Rise Time	t_r	0.5	2.1	0.5	2.2	0.5	2.3	ns
Fall Time	t_f	0.5	2.1	0.5	2.2	0.5	2.3	ns

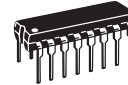
NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

MC10H101



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

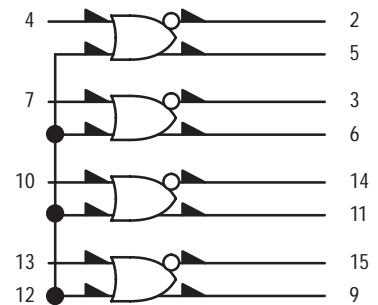


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



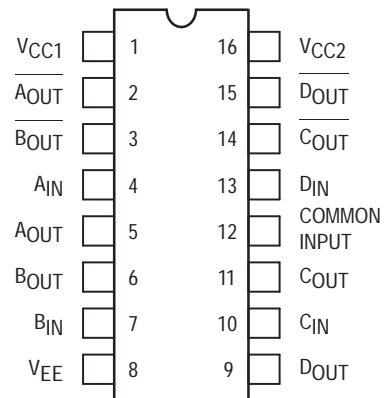
FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM



$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



Quad 2-Input NOR Gate

The MC10H102 is a quad 2-input NOR gate. The MC10H102 provides one gate with OR/NOR outputs. This MECL 10H part is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in propagation delay, and no increases in power—supply current.

- Propagation Delay, 1.0 ns Typical
- Power Dissipation 25 mW/Gate (same as MECL 10K)
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C °C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	29	—	26	—	29	mA
Input Current High	I_{inH}	—	425	—	265	—	265	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

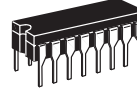
AC PARAMETERS

Characteristic	Symbol	0.4	1.25	0.4	1.25	0.4	1.4	ns
Propagation Delay	t_{pd}							
Rise Time	t_r	0.5	1.5	0.5	1.6	0.55	1.7	ns
Fall Time	t_f	0.5	1.5	0.5	1.6	0.55	1.7	ns

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

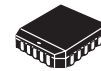
MC10H102



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

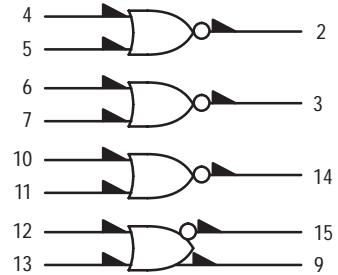


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



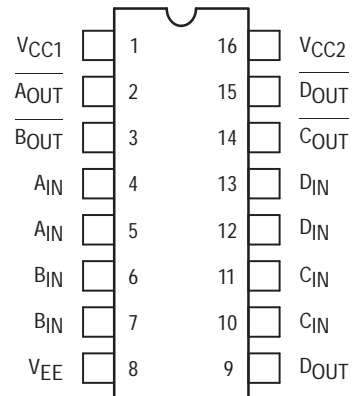
FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM



$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6-11.



Quad 2-Input OR Gate

The MC10H103 is a quad 2-input OR gate. The MC10H103 provides one gate with OR/NOR outputs. This MECL 10H part is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in propagation delay, and no increases in power– supply current.

- Propagation Delay, 1.0 ns Typical
- Power Dissipation 25 mW/Gate (same as MECL 10K)
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K–Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	–8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	–55 to +150 –55 to +165	°C °C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	29	—	26	—	29	mA
Input Current High	I_{inH}	—	425	—	265	—	265	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	–1.02	–0.84	–0.98	–0.81	–0.92	–0.735	Vdc
Low Output Voltage	V_{OL}	–1.95	–1.63	–1.95	–1.63	–1.95	–1.60	Vdc
High Input Voltage	V_{IH}	–1.17	–0.84	–1.13	–0.81	–1.07	–0.735	Vdc
Low Input Voltage	V_{IL}	–1.95	–1.48	–1.95	–1.48	–1.95	–1.45	Vdc

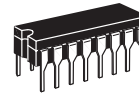
AC PARAMETERS

Propagation Delay	t_{pd}	0.4	1.3	0.4	1.3	0.45	1.45	ns
Rise Time	t_r	0.5	1.7	0.5	1.8	0.5	1.9	ns
Fall Time	t_f	0.5	1.7	0.5	1.8	0.5	1.9	ns

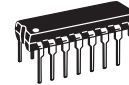
NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfm is maintained. Outputs are terminated through a 50–ohm resistor to –2.0 volts.

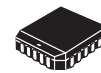
MC10H103



L SUFFIX
CERAMIC PACKAGE
CASE 620–10

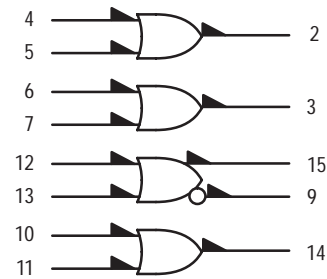


P SUFFIX
PLASTIC PACKAGE
CASE 648–08



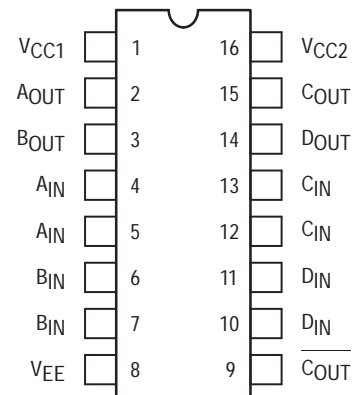
FN SUFFIX
PLCC
CASE 775–02

LOGIC DIAGRAM



$V_{CC1} = \text{PIN 1}$
 $V_{CC2} = \text{PIN 16}$
 $V_{EE} = \text{PIN 8}$

DIP PIN ASSIGNMENT



Pin assignment is for Dual–in–Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6–11.



Quad 2-Input AND Gate

The MC10H104 is a quad 2-input AND gate. One of the gates has both AND/NAND outputs available. This MECL 10H part is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in propagation delay, and no increase in power-supply current.

- Propagation Delay, 1.0 ns Typical
- Power Dissipation 25 mW/Gate (same as MECL 10K)
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C °C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	39	—	35	—	39	mA
Input Current High	I_{inH}	—	425	—	265	—	265	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

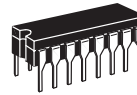
AC PARAMETERS

Propagation Delay	t_{pd}	0.4	1.6	0.45	1.75	0.45	1.9	ns
Rise Time	t_r	0.5	1.6	0.5	1.7	0.5	1.8	ns
Fall Time	t_f	0.5	1.6	0.5	1.7	0.5	1.8	ns

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

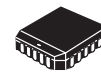
MC10H104



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

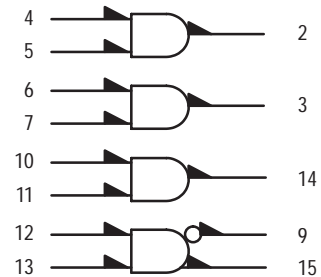


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



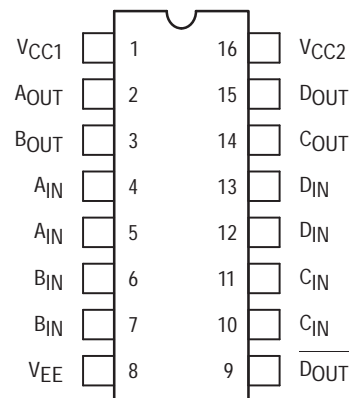
FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM



$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6-11.



Triple 2-3-2-Input OR/NOR Gate

The MC10H105 is a triple 2–3–2–input OR/NOR gate. This MECL 10H part is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in propagation delay, and no increases in power–supply current.

- Propagation Delay, 1.0 ns Typical
- Power Dissipation 25 mW/Gate (same as MECL 10K)
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K–Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C °C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2\text{ V} \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	23	—	21	—	23	mA
Input Current High	I_{inH}	—	425	—	265	—	265	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

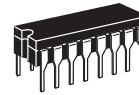
AC PARAMETERS

Characteristic	Symbol	0.4	1.2	0.4	1.2	0.4	1.3	ns
Propagation Delay	t_{pd}							
Rise Time	t_r	0.5	1.5	0.5	1.6	0.5	1.7	ns
Fall Time	t_f	0.5	1.5	0.5	1.6	0.5	1.7	ns

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

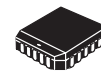
MC10H105



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

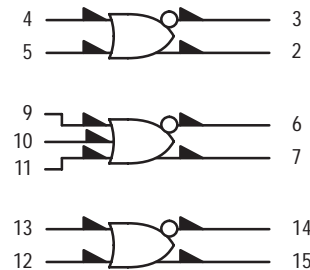


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



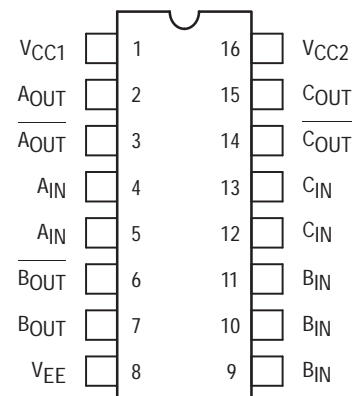
FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM



$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



Triple 4-3-3-Input NOR Gate

The MC10H106 is a triple 4–3–3 input NOR gate. This 10H part is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in propagation delay and no increase in power– supply current.

- Propagation Delay, 1.0 ns Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K–Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	–8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	–55 to +150 –55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	23	—	21	—	23	mA
Input Current High	I_{inH}	—	500	—	310	—	310	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	–1.02	–0.84	–0.98	–0.81	–0.92	–0.735	Vdc
Low Output Voltage	V_{OL}	–1.95	–1.63	–1.95	–1.63	–1.95	–1.60	Vdc
High Input Voltage	V_{IH}	–1.17	–0.84	–1.13	–0.81	–1.07	–0.735	Vdc
Low Input Voltage	V_{IL}	–1.95	–1.48	–1.95	–1.48	–1.95	–1.45	Vdc

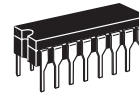
AC PARAMETERS

Characteristic	Symbol	0.5	1.3	0.5	1.5	0.55	1.55	ns
Propagation Delay	t_{pd}							
Rise Time	t_r	0.5	1.7	0.5	1.8	0.55	1.9	ns
Fall Time	t_f	0.5	1.7	0.5	1.8	0.55	1.9	ns

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50–ohm resistor to –2.0 volts.

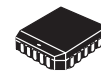
MC10H106



L SUFFIX
CERAMIC PACKAGE
CASE 620–10

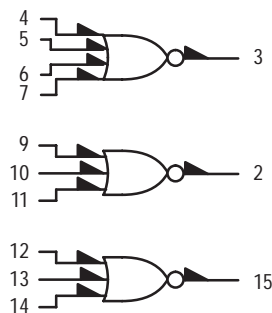


P SUFFIX
PLASTIC PACKAGE
CASE 648–08



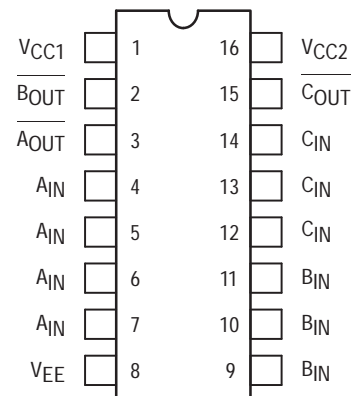
FN SUFFIX
PLCC
CASE 775–02

LOGIC DIAGRAM



$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

DIP PIN ASSIGNMENT



Pin assignment is for Dual–In–Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6–11.



Triple 2-Input Exclusive OR/ Exclusive NOR Gate

The MC10H107 is a triple 2-input exclusive OR/NOR gate. This MECL 10H part is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in propagation delay, and no increase in power-supply current.

- Propagation Delay, 1.0 ns Typical
- Power Dissipation 35 mW/Gate Typical (same as MECL 10K)
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current— Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range— Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	31	—	28	—	31	mA
Input Current High	I_{inH}	—	425	—	265	—	265	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

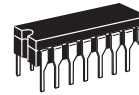
AC PARAMETERS

Characteristic	Symbol	0.4	1.5	0.4	1.6	0.4	1.7	ns
Propagation Delay	t_{pd}							
Rise Time	t_r	0.5	1.5	0.5	1.6	0.5	1.7	ns
Fall Time	t_f	0.5	1.5	0.5	1.6	0.5	1.7	ns

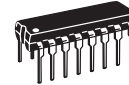
NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

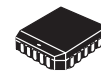
MC10H107



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

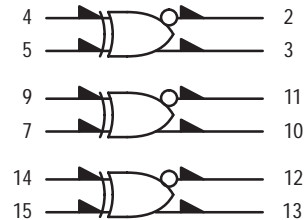


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



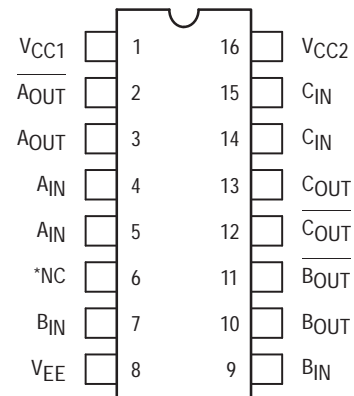
FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM



$V_{CC1} = \text{PIN 1}$
 $V_{CC2} = \text{PIN 16}$
 $V_{EE} = \text{PIN 8}$

DIP PIN ASSIGNMENT



*NC = No Connection

Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6-11.



Dual 4-5-Input OR/NOR Gate

The MC10H109 is a dual 4–5–input OR/NOR gate. This MECL 10H part is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in propagation delay, and no increase in power–supply current.

- Propagation Delay, 1.0 ns Typical
- Power Dissipation 35 mW/Gate Typical (same as MECL 10K)
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K–Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	–8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	–55 to +150 –55 to +165	°C °C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2\text{ V} \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	15	—	14	—	15	mA
Input Current High	I_{inH}	—	425	—	265	—	265	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	–1.02	–0.84	–0.98	–0.81	–0.92	–0.735	Vdc
Low Output Voltage	V_{OL}	–1.95	–1.63	–1.95	–1.63	–1.95	–1.60	Vdc
High Input Voltage	V_{IH}	–1.17	–0.84	–1.13	–0.81	–1.07	–0.735	Vdc
Low Input Voltage	V_{IL}	–1.95	–1.48	–1.95	–1.48	–1.95	–1.45	Vdc

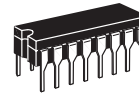
AC PARAMETERS

Characteristic	Symbol	0°	25°	75°	Unit
Propagation Delay	t_{pd}	0.4	1.3	0.45	1.45 ns
Rise Time	t_r	0.5	2.0	0.5	2.2 ns
Fall Time	t_f	0.5	2.0	0.5	2.2 ns

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50–ohm resistor to –2.0 volts.

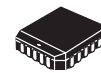
MC10H109



L SUFFIX
CERAMIC PACKAGE
CASE 620–10

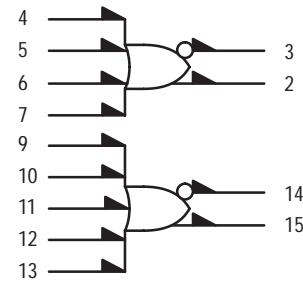


P SUFFIX
PLASTIC PACKAGE
CASE 648–08



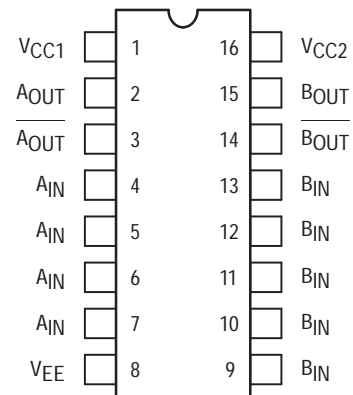
FN SUFFIX
PLCC
CASE 775–02

LOGIC DIAGRAM



$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

DIP PIN ASSIGNMENT



Pin assignment is for Dual–in–Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6–11.



Quad Exclusive OR Gate

The MC10H113 is a Quad Exclusive OR Gate with an enable common to all four gates. The outputs may be wire-ORed together to perform a 4-bit comparison function ($A = B$). The enable is active LOW.

- Propagation Delay, 1.3 ns Typical
- Power Dissipation 175 mW Typ/Pkg (No Load)
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C °C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	46	—	42	—	46	mA
Input Current High Pins 5, 7, 11, 13 Pins 4, 6, 10, 12 Pin 9	I_{inH}	—	430	—	270	—	270	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

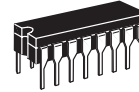
AC PARAMETERS

Propagation Delay Data Enable	t_{pd}	0.4	1.7	0.4	1.8	0.5	1.9	ns
Rise Time	t_r	0.5	1.8	0.6	1.9	0.6	2.0	ns
Fall Time	t_f	0.5	1.8	0.6	1.9	0.6	2.0	ns

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

MC10H113



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

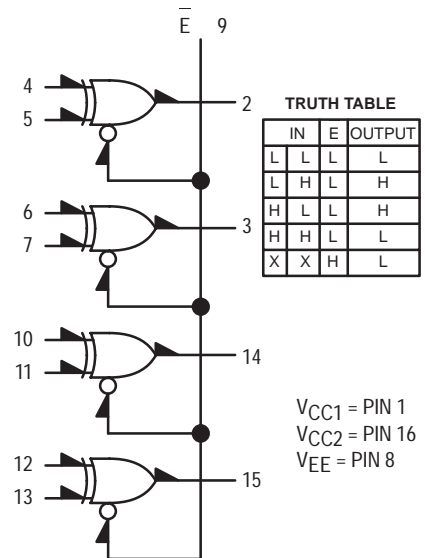


P SUFFIX
PLASTIC PACKAGE
CASE 648-08

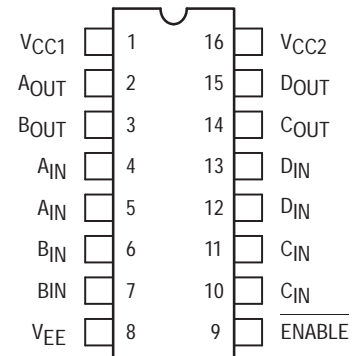


FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM



DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6-11.



Quad Line Receiver

The MC10H115 is a quad differential amplifier designed for use in sensing differential signals over long lines. This 10H part is a functional/ pinout duplication of the standard MECL 10K family part, with 100% improvement in counting frequency and no increase in power-supply current.

The base bias supply (V_{BB}) is made available at Pin 9 to make the device useful as a Schmitt trigger, or in other applications where a stable reference voltage is necessary. Active current sources provide the MC10H115 with excellent common mode rejection. If any amplifier in a package is not used, one input of that amplifier must be connected to V_{BB} (Pin 9) to prevent upsetting the current source bias network.

- Propagation Delay, 1.0 ns Typical
- Power Dissipation 110 mW Typ/Pkg (No Load)
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (2)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	29	—	26	—	29	mA
Input Current High	I_{inH}	—	150	—	95	—	95	μA
Input Leakage Current	I_{CBO}	—	1.5	—	1.0	—	1.0	μA
Reference Voltage	V_{BB}	-1.38	-1.27	-1.35	-1.25	-1.31	-1.19	Vdc
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage (1)	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage (1)	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc
Common Mode Range (3)	V_{CMR}	—	—	-2.85 to -0.8	—	—	—	Vdc
Input Sensitivity (4)	V_{PP}	—	—	150 typ	—	—	—	mV _{pp}

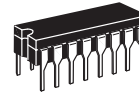
AC PARAMETERS

Characteristic	Symbol	0.4	1.3	0.4	1.3	0.45	1.45	ns
Propagation Delay	t_{pd}	0.4	1.3	0.4	1.3	0.45	1.45	ns
Rise Time	t_r	0.5	1.4	0.5	1.5	0.5	1.6	ns
Fall Time	t_f	0.5	1.4	0.5	1.5	0.5	1.6	ns

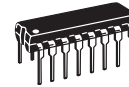
NOTES:

1. When V_{BB} is used as the reference voltage.
2. Each MECL 10H series circuit has been designed to meet the specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.
3. Differential input not to exceed 1.0 Vdc.
4. 150 mV_{p-p} differential input required to obtain full logic swing on output.

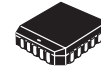
MC10H115



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

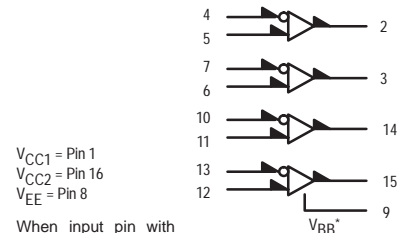


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM



When input pin with bubble goes positive its respective output pin with bubble goes positive.

* V_{BB} to be used to supply bias to the MC10H115 only and bypassed (when used) with 0.01 μF to 0.1 μF capacitor to ground (0 V). V_{BB} can source < 1.0 mA.

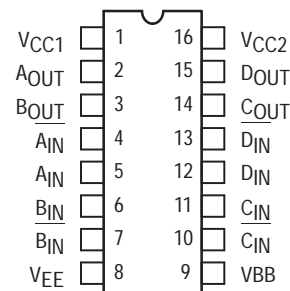
The MC10H115 is designed to be used in sensing differential signals over long lines. The bias supply (V_{BB}) is made available to make the device useful as a Schmitt trigger, or in other applications where a stable reference voltage is necessary.

Active current sources provide these receivers with excellent common-mode noise rejection. If any amplifier in a package is not used, one input of that amplifier must be connected to V_{BB} to prevent unbalancing the current-source bias network.

The MC10H115 does not have internal-input pull-down resistors. This provides high impedance to the amplifier input and facilitates differential connections.

- Applications:
- Low Level Receiver
 - Voltage Level Interface
 - Schmitt Trigger

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



Triple Line Receiver

The MC10H116 is a functional/pinout duplication of the MC10116, with 100% improvement in propagation delay and no increase in power— supply current.

- Propagation Delay, 1.0 ns Typical
- Power Dissipation 85 mW Typ/Pkg (same as MECL 10K)
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K—Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (2)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	23	—	21	—	23	mA
Input Current High	I_{inH}	—	150	—	95	—	95	μA
Input Leakage Current	I_{CBO}	—	1.5	—	1.0	—	1.0	μA
Reference Voltage	V_{BB}	-1.38	-1.27	-1.35	-1.25	-1.31	-1.19	Vdc
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage (1)	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage (1)	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc
Common Mode Range (3)	V_{CMR}	—	—	-2.85 to -0.8		—	—	Vdc
Input Sensitivity (4)	V_{PP}	—	—	150 typ		—	—	mV _{PP}

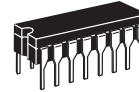
AC PARAMETERS

Propagation Delay	t_{pd}	0.4	1.3	0.4	1.3	0.45	1.45	ns
Rise Time	t_r	0.5	1.5	0.5	1.6	0.5	1.7	ns
Fall Time	t_f	0.5	1.5	0.5	1.6	0.5	1.7	ns

NOTES:

1. When V_{BB} is used as the reference voltage.
2. Each MECL 10H series circuit has been designed to meet the specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.
3. Differential input not to exceed 1.0 Vdc.
4. 150 mV_{p-p} differential input required to obtain full logic swing on output.

MC10H116



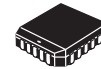
L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08

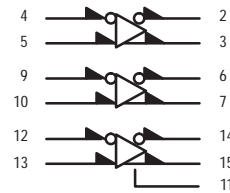


D SUFFIX
PLASTIC SOIC
CASE 751B-05



FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM



V_{CC1} = Pin 1
 V_{CC2} = Pin 16
 V_{EE} = Pin 8

When input pin with bubble goes positive it's respective output pin with bubble goes positive.

* V_{BB} to be used to supply bias to the MC10H116 only and bypassed (when used) with 0.01 μF to 0.1 μF capacitor to ground (0 V). V_{BB} can source < 1.0 mA.

The MC10H116 is designed to be used in sensing differential signals over long lines. The bias supply (V_{BB}) is made available to make the device useful as a Schmitt trigger, or in other applications where a stable reference voltage is necessary.

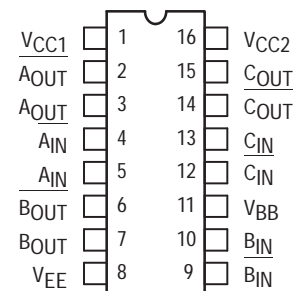
Active current sources provide these receivers with excellent common-mode noise rejection. If any amplifier in a package is not used, one input of that amplifier must be connected to V_{BB} to prevent unbalancing the current-source bias network.

The MC10H116 does not have internal-input pull-down resistors. This provides high impedance to the amplifier input and facilitates differential connections.

Applications:

- Low Level Receiver
- Schmitt Trigger
- Voltage Level Interface

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



Dual 2-Wide 2-3-Input OR-AND/OR-AND Gate

The MC10H117 dual 2-wide 2-3-input OR-AND/OR-AND-Invert gate is a general purpose logic element designed for use in data control, such as digital multiplexing or data distribution. Pin 9 is common to both gates. This MECL 10H part is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in propagation delay, and no increase in power-supply current.

- Propagation Delay, 1.0 ns Typical
- Power Dissipation 100 mW/Gate Typical (same as MECL 10K)
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current— Continuous	I_{out}	50	mA
— Surge		100	
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range— Plastic	T_{stg}	-55 to +150	°C
— Ceramic		-55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	29	—	26	—	29	mA
Input Current High	I_{inH}	—	465	—	275	—	275	μA
Pins 4, 5, 12, 13		—	545	—	320	—	320	
Pins 6, 7, 10, 11		—	710	—	415	—	415	
Pin 9		—	710	—	415	—	415	
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

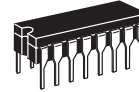
AC PARAMETERS

Propagation Delay	t_{pd}	0.45	1.35	0.45	1.35	0.5	1.5	ns
Rise Time	t_r	0.5	1.5	0.5	1.6	0.5	1.7	ns
Fall Time	t_f	0.5	1.5	0.5	1.6	0.5	1.7	ns

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

MC10H117



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

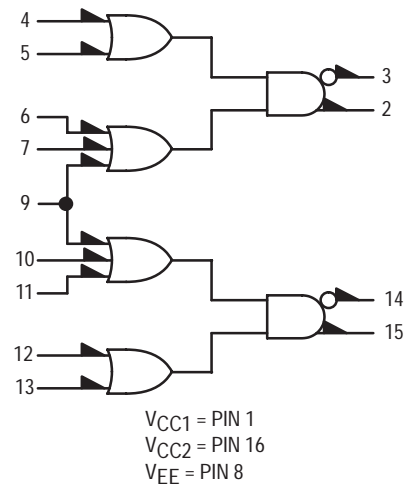


P SUFFIX
PLASTIC PACKAGE
CASE 648-08

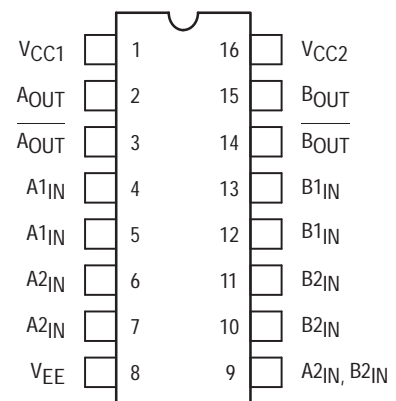


FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM



DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



4-Wide OR-AND/OR-AND Gate

The MC10H121 is a basic logic building block providing the simultaneous OR-AND/OR-AND-Invert function, useful in data control and digital multiplexing applications. This MECL 10H part is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in propagation delay, and no increase in power-supply current.

- Propagation Delay, 1.0 ns Typical
- Power Dissipation 100 mW/Gate Typical (same as MECL 10K)
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous	I_{out}	50	mA
— Surge		100	
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic	T_{stg}	-55 to +150	°C
— Ceramic		-55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	29	—	26	—	29	mA
Input Current High Pins 3, 4, 5, 6, 7, 9 11, 12, 13, 14, 15 Pin 10	I_{inH}	—	500	—	295	—	295	μA
		—	610	—	360	—	360	
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

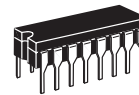
AC PARAMETERS

Propagation Delay Pin 10 Only Exclude Pin 10	t_{pd}	0.45	1.8	0.45	1.8	0.55	2.2	ns
		0.55	1.95	0.6	2.0	0.7	2.4	
Rise Time	t_r	0.5	1.7	0.5	1.8	0.5	1.9	ns
Fall Time	t_f	0.5	1.7	0.5	1.8	0.5	1.9	ns

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

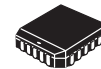
MC10H121



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

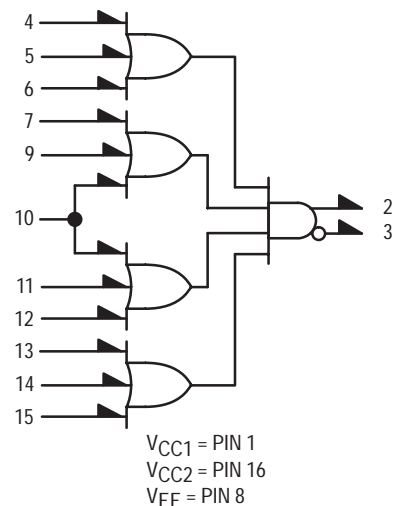


P SUFFIX
PLASTIC PACKAGE
CASE 648-08

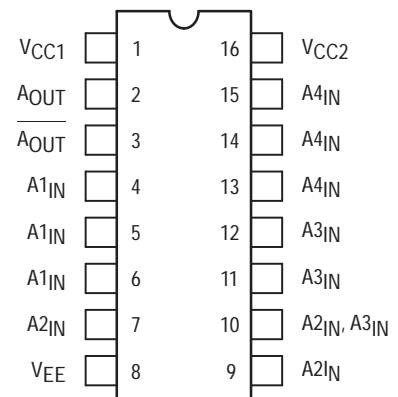


FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM



DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6-11.



Triple 4-3-3-Input Bus Driver

The MC10H123 is a triple 4-3-3-Input Bus Driver.

The MC10H123 consists of three NOR gates designed for bus driving applications on card or between cards. Output low logic levels are specified with $V_{OL} = -2.1$ Vdc so that the bus may be terminated to -2.0 Vdc. The gate output, when low, appears as a high impedance to the bus, because the output emitter-followers of the MC10H123 are "turned-off." This eliminates discontinuities in the characteristic impedance of the bus.

The V_{OH} level is specified when driving a 25-ohm load terminated to -2.0 Vdc, the equivalent of a 50-ohm bus terminated at both ends. Although 25 ohms is the lowest characteristic impedance that can be driven by the MC10H123, higher impedance values may be used with this part. A typical 50-ohm bus is shown in Figure 1.

- Propagation Delay, 1.5 ns Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current— Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range— Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2$ V $\pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	60	—	56	—	60	mA
Input Current High	I_{inH}	—	495	—	310	—	310	μ A
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μ A
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-2.1	-2.03	-2.1	-2.03	-2.1	-2.03	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

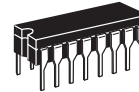
AC PARAMETERS

Characteristic	Symbol	0.7	1.5	0.7	1.6	0.7	1.7	ns
Propagation Delay	t_{pd}							
Rise Time	t_r	0.7	1.6	0.7	1.7	0.7	1.8	ns
Fall Time	t_f	0.7	1.6	0.7	1.7	0.7	1.8	ns

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfm is maintained. Outputs are terminated through a 50-ohm resistor to -2.1 volts.

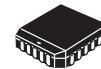
MC10H123



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

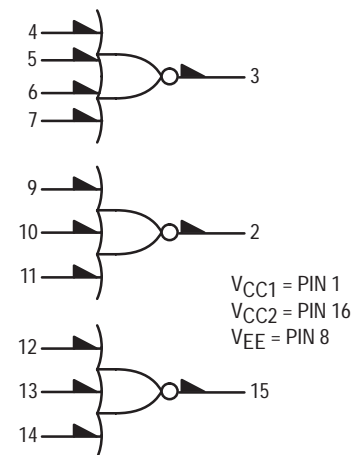


P SUFFIX
PLASTIC PACKAGE
CASE 648-08

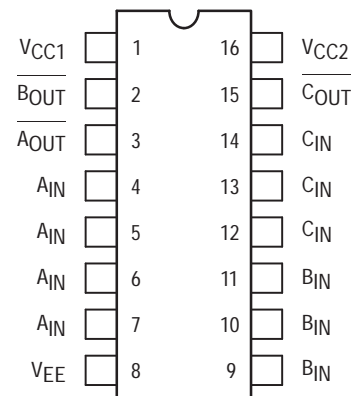


FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM



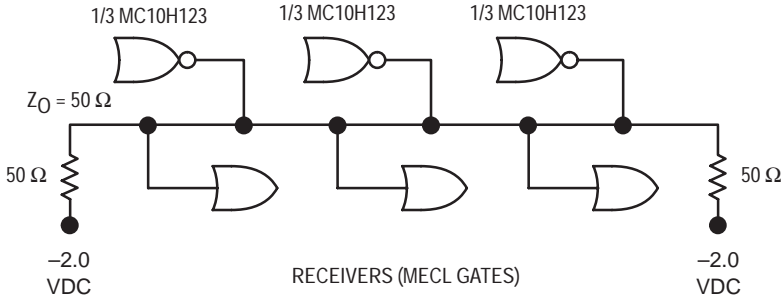
DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



FIGURE 1 — 50-OHM BUS DRIVER (25-OHM LOAD)



Quad TTL-to-MECL Translator With TTL Strobe Input

The MC10H124 is a quad translator for interfacing data and control signals between a saturated logic section and the MECL section of digital systems. The 10H part is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in propagation delay, and no increase in power-supply current.

- Propagation Delay, 1.5 ns Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 5.0\text{ V}$)	V_{EE}	-8.0 to 0	Vdc
Power Supply ($V_{EE} = -5.2\text{ V}$)	V_{CC}	0 to +7.0	Vdc
Input Voltage ($V_{CC} = 5.0\text{ V}$) TTL	V_I	0 to V_{CC}	Vdc
Output Current — Continuous	I_{out}	50	mA
— Surge		100	
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic	T_{stg}	-55 to +150	°C
— Ceramic		-55 to +165	

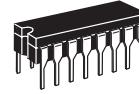
ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2\text{ V} \pm 5\%$, $V_{CC} = 5.0\text{ V} \pm 5.0\%$)

Characteristic	Symbol	0°		25°		75°		Unit	
		Min	Max	Min	Max	Min	Max		
Negative Power Supply Drain Current	I_E	—	72	—	66	—	72	mA	
Positive Power Supply Drain Current	I_{CCH}	—	16	—	16	—	18	mA	
	I_{CCL}	—	25	—	25	—	25	mA	
Reverse Current	I_R	Pin 6	—	200	—	200	—	200	μA
		Pin 7	—	50	—	50	—	50	
Forward Current	I_F	Pin 6	—	-12.8	—	-12.8	—	-12.8	mA
		Pin 7	—	-3.2	—	-3.2	—	-3.2	
Input Breakdown Voltage	$V_{(BR)in}$	5.5	—	5.5	—	5.5	—	Vdc	
Input Clamp Voltage	V_I	—	-1.5	—	-1.5	—	-1.5	Vdc	
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc	
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc	
High Input Voltage	V_{IH}	2.0	—	2.0	—	2.0	—	Vdc	
Low Input Voltage	V_{IL}	—	0.8	—	0.8	—	0.8	Vdc	

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

MC10H124



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

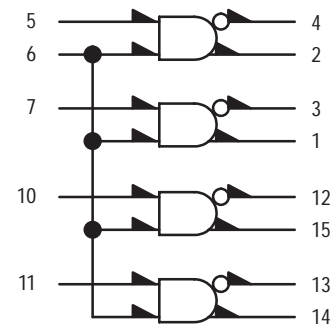


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



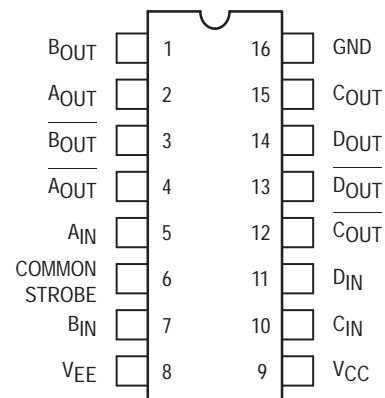
FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM



GND = PIN 16
 V_{CC} (+5.0 VDC) = PIN 9
 V_{EE} (-5.2 VDC) = PIN 8

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 \text{ V} \pm 5\%$, $V_{CC} = 5.0 \text{ V} \pm 5.0\%$)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	

AC PARAMETERS

Propagation Delay	t_{pd}	0.55	2.25	0.55	2.4	0.85	2.95	ns
Rise Time	t_r	0.5	1.5	0.5	1.6	0.5	1.7	ns
Fall Time	t_f	0.5	1.5	0.5	1.6	0.5	1.7	ns

APPLICATIONS INFORMATION

The MC10H124 has TTL-compatible inputs and MECL complementary open-emitter outputs that allow use as an inverting/non-inverting translator or as a differential line driver. When the common strobe input is at the low-logic level, it forces all true outputs to a MECL low-logic state and all inverting outputs to a MECL high-logic state.

An advantage of this device is that TTL-level information can be transmitted differentially, via balanced twisted pair lines, to MECL equipment, where the signal can be received by the MC10H115 or MC10H116 differential line receivers. The power supply requirements are ground, +5.0 volts, and -5.2 volts.

Quad MECL-to-TTL Translator

The MC10H125 is a quad translator for interfacing data and control signals between the MECL section and saturated logic section of digital systems. The 10H part is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in propagation delay, and no increase in power-supply current.

Outputs of unused translators will go to low state when their inputs are left open.

- Propagation Delay, 2.5 ns Typical
- Voltage Compensated
- Improved Noise Margin 150 mV
- MECL 10K-Compatible (Over Operating Voltage and Temperature Range)

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 5.0\text{ V}$)	V_{EE}	-8.0 to 0	Vdc
Power Supply ($V_{EE} = -5.2\text{ V}$)	V_{CC}	0 to +7.0	Vdc
Input Voltage ($V_{CC} = 5.0\text{ V}$)	V_I	0 to V_{EE}	Vdc
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C °C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2\text{ V} \pm 5\%$; $V_{CC} = 5.0\text{ V} \pm 5.0\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Negative Power Supply Drain Current	I_E	—	44	—	40	—	44	mA
Positive Power Supply Drain Current	I_{CCH}	—	63	—	63	—	63	mA
	I_{CCL}	—	40	—	40	—	40	mA
Input Current	I_{inH}	—	225	—	145	—	145	μA
Input Leakage Current	I_{CBO}	—	1.5	—	1.0	—	1.0	μA
High Output Voltage $I_{OH} = -1.0\text{ mA}$	V_{OH}	2.5	—	2.5	—	2.5	—	Vdc
Low Output Voltage $I_{OL} = +20\text{ mA}$	V_{OL}	—	0.5	—	0.5	—	0.5	Vdc
High Input Voltage(1)	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage(1)	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc
Short Circuit Current	I_{OS}	60	150	60	150	50	150	mA
Reference Voltage	V_{BB}	-1.38	-1.27	-1.35	-1.25	-1.31	-1.19	Vdc
Common Mode Range (3)	V_{CMR}	—	—	-2.85 to +0.3		—	—	V
Typical								
Input Sensitivity (4)	V_{PP}	150						mV

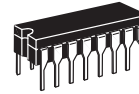
AC PARAMETERS

Propagation Delay	t_{pd}	0.8	3.3	0.85	3.35	0.9	3.4	ns
Rise Time(5)	t_r	0.3	1.2	0.3	1.2	0.3	1.2	ns
Fall Time(5)	t_f	0.3	1.2	0.3	1.2	0.3	1.2	ns

NOTES:

- When V_{BB} is used as the reference voltage.
- Each MECL 10H series circuit has been designed to meet the specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained.
- Differential input not to exceed 1.0 Vdc.
- 150 mV_{P-P} differential input required to obtain full logic swing on output.
- 1.0 V to 2.0 V w/25 pF into 500 Ω.

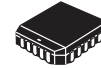
MC10H125



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

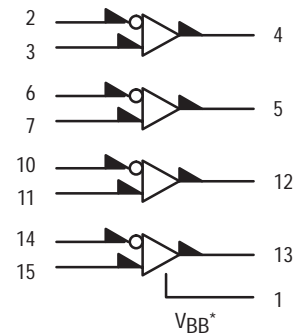


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

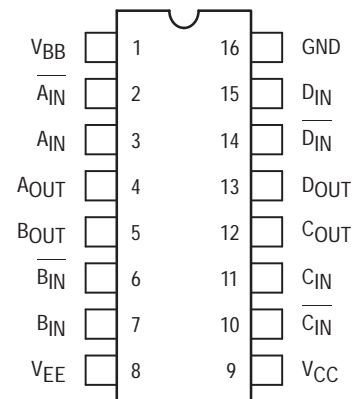
LOGIC DIAGRAM



GND = PIN 16
 V_{CC} (+5.0 VDC) = PIN 9
 V_{EE} (-5.2 VDC) = PIN 8

* V_{BB} to be used to supply bias to the MC10H125 only and bypassed (when used) with 0.01 μF to 0.1 μF capacitor to ground (0 V). V_{BB} can source < 1.0 mA.

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



APPLICATION INFORMATION

The MC10H125 incorporates differential inputs and Schottky TTL "totem pole" outputs. Differential inputs allow for use as an inverting/non-inverting translator or as a differential line receiver. The V_{BB} reference voltage is available on Pin 1 for use in single-ended input biasing. The outputs of the MC10H125 go to a low-logic level whenever the inputs are left floating, and a high-logic

output level is achieved with a minimum input level of 150 mV_{p-p}.

An advantage of this device is that MECL-level information can be received, via balanced twisted pair lines, in the TTL equipment. This isolates the MECL-logic from the noisy TTL environment. Power supply requirements are ground, +5.0 volts and -5.2 volts.

Dual Latch

The MC10H130 is a MECL 10H part which is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in clock speed and propagation delay and no increase in power-supply current.

- Propagation Delay, 1.0 ns Typical
- Power Dissipation, 155 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	38	—	35	—	38	mA
Input Current High Pins 6, 11 Pins 7, 9, 10 Pins 4, 5, 12, 13	I_{inH}	—	468 545 434	—	275 320 255	—	275 320 255	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

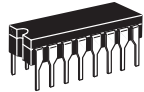
AC PARAMETERS

Parameter	Symbol	0°	25°	75°	Unit			
Propagation Delay Data Set, Reset Clock, CE	t_{pd}	0.4 0.6 0.5	1.6 1.7 1.6	0.4 0.7 0.5	1.7 1.8 1.7	0.4 0.8 0.6	1.8 1.9 1.8	ns
Rise Time	t_r	0.5	1.6	0.5	1.7	0.5	1.8	ns
Fall Time	t_f	0.5	1.6	0.5	1.7	0.5	1.8	ns
Set-up Time	t_{set}	2.2	—	2.2	—	2.2	—	ns
Hold Time	t_{hold}	0.7	—	0.7	—	0.7	—	ns

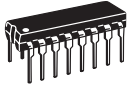
NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

MC10H130



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

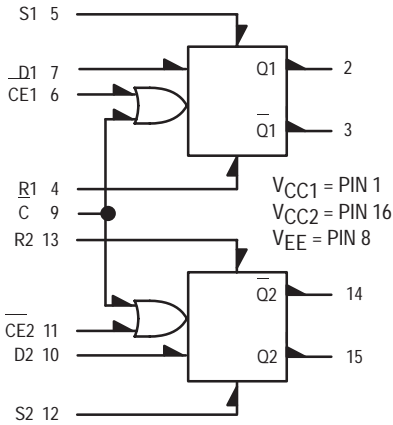


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM

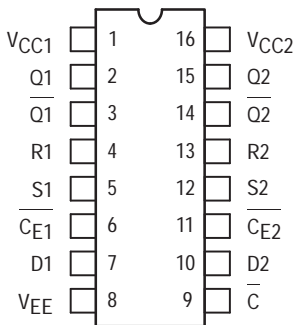


TRUTH TABLE

D	C	CE	Q_{n+1}
L	L	L	L
H	L	L	H
X	L	H	Q_n
X	H	L	Q_n
X	H	H	Q_n

DIP

PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



APPLICATION INFORMATION

The MC10H130 is a clocked dual D type latch. Each latch may be clocked separately by holding the common clock in the low state, and using the clock enable inputs for the clocking function. If the common clock is to be used to clock the latch, the clock enable (CE) inputs must be in the low state. In this mode, the enable inputs perform the function of controlling the common clock (C).

Any change at the D input will be reflected at the output

while the clock is low. The outputs are latched on the positive transition of the clock. While the clock is in the high state, a change in the information present at the data inputs will not affect the output information.

The set and reset inputs do not override the clock and D inputs. They are effective only when either C or CE or both are high.

Dual D Type Master-Slave Flip-Flop

The MC10H131 is a MECL 10H part which is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in clock speed and propagation delay and no increase in power-supply current.

- Propagation Delay, 1.0 ns Typical
- Power Dissipation, 235 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	62	—	56	—	62	mA
Input Current High Pins 6, 11 Pin 9 Pins 7, 10 Pins 4, 5, 12, 13	I_{inH}	—	530	—	310	—	310	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

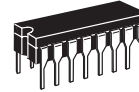
AC PARAMETERS

Characteristic	Symbol	0°	25°	75°	Unit			
Propagation Delay Clock, CE Set, Reset	t_{pd}	0.8 0.6	1.6 1.6	0.8 0.7	1.7 1.7	0.8 0.7	1.8 1.8	ns
Rise Time	t_r	0.6	2.0	0.6	2.0	0.6	2.2	ns
Fall Time	t_f	0.6	2.0	0.6	2.0	0.6	2.2	ns
Set-up Time	t_{set}	0.7	—	0.7	—	0.7	—	ns
Hold Time	t_{hold}	0.8	—	0.8	—	0.8	—	ns
Toggle Frequency	f_{tog}	250	—	250	—	250	—	MHz

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

MC10H131



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

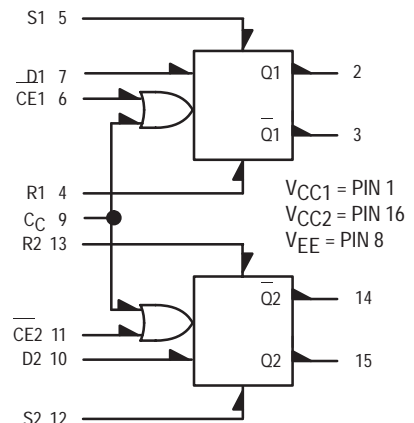


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM



RS TRUTH TABLE

R	S	Q_{n+1}
L	L	Q_n
L	H	H
H	L	L
H	H	N.D.

CLOCKED TRUTH TABLE

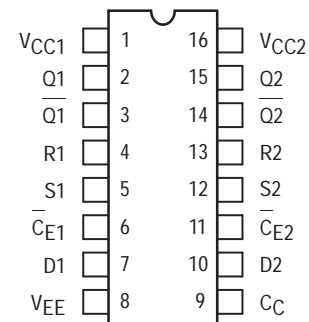
C	D	Q_{n+1}
L	X	Q_n
H	L	L
H	H	H

$C = CE + C_C$

N.D. = Not Defined

A clock H is a clock transition from a low to a high state.

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



APPLICATION INFORMATION

The MC10H131 is a dual master–slave type D flip–flop. Asynchronous Set (\overline{S}) and Reset (\overline{R}) override Clock ($\overline{C\overline{C}}$) and Clock Enable (\overline{CE}) inputs. Each flip–flop may be clocked separately by holding the common clock in the new low state and using the enable inputs for the clocking function. If the common clock is to be used to clock the flip–flop, the Clock Enable inputs must be in the low state.

In this case, the enable inputs perform the function of controlling the common clock.

The output states of the flip–flop change on the positive transition of the clock. A change in the information present at the data (D) input will not affect the output information at any other time due to master slave construction.

Dual J-K Master-Slave Flip-Flop

The MC10H135 is a dual J-K master-slave flip-flop. The device is provided with an asynchronous set(s) and reset(R). These set and reset inputs override the clock.

A common clock is provided with separate \bar{J} - \bar{K} inputs. When the clock is static, the JK inputs do not effect the output. The output states of the flip flop change on the positive transition of the clock.

- Propagation delay, 1.5 ns Typical
- Power Dissipation, 280 mW Typical/Pkg. (No Load)
- f_{tog} 250 MHz Max
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	75	—	68	—	75	mA
Input Current High Pins 6, 7, 10, 11 Pins 4, 5, 12, 13 Pin 9	I_{inH}	—	460	—	285	—	285	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

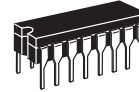
AC PARAMETERS

Parameter	Symbol	0°	25°	75°	Unit	
Propagation Delay Set, Reset, Clock	t_{pd}	0.7	2.6	0.7	2.6	ns
Rise Time	t_r	0.7	2.2	0.7	2.2	ns
Fall Time	t_f	0.7	2.2	0.7	2.2	ns
Set-up Time	t_{set}	1.5	—	1.5	—	ns
Hold Time	t_{hold}	1.0	—	1.0	—	ns
Toggle Frequency	f_{tog}	250	—	250	—	MHz

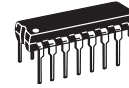
NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

MC10H135



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

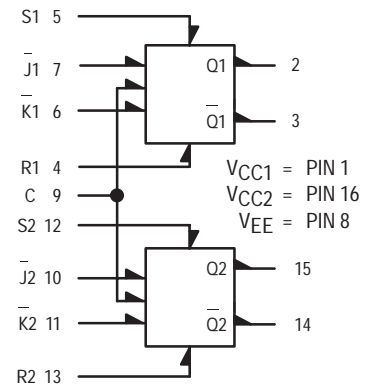


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM



RS TRUTH TABLE

R	S	Q_{n+1}
L	L	Q_n
L	H	H
H	L	L
H	H	N.D.

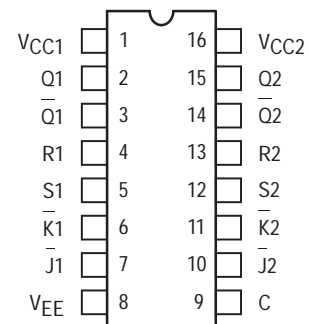
N.D. = Not Defined

CLOCK J-K TRUTH TABLE*

J	K	Q_{n+1}
L	L	Q_n
H	L	L
L	H	H
H	H	Q_n

*Output states change on positive transition of clock for J-K input condition present.

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.

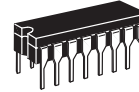


Universal Hexadecimal Counter

The MC10H136 is a high speed synchronous hexadecimal counter. This 10H part is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in counting frequency and no increase in power-supply current.

- Counting Frequency, 250 MHz Minimum
- Power Dissipation, 625 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MC10H136



L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C °C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	165	—	150	—	165	mA
Input Current High Pins 5, 6, 11, 12, 13 Pin 9 Pin 7 Pin 10	I_{inH}	—	430 670 535 380	—	275 420 335 240	—	275 420 335 240	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

AC PARAMETERS

Propagation Delay Clock to Q Clock to Carry Out Carry in to Carry Out	t_{pd}	0.7 1.0 0.7	2.3 4.8 2.5	0.7 1.0 0.7	2.4 4.9 2.6	0.7 1.0 0.7	2.5 5.0 2.7	ns
Set-up Time Data (D0 to C) Select (S to C) Carry In (C_{in} to C) (C to C_{in})	t_{set}	2.0 3.5 2.0 0	— — — —	2.0 3.5 2.0 0	— — — —	2.0 3.5 2.0 0	— — — —	ns
Hold Time Data (C to D0) Select (C to S) Carry In (C to C_{in}) (C_{in} to C)	t_{hold}	0 -0.5 0 2.2	— — — —	0 -0.5 0 2.2	— — — —	0 -0.5 0 2.2	— — — —	ns
Counting Frequency	f_{count}	250	—	250	—	250	—	MHz
Rise Time	t_r	0.5	2.3	0.5	2.4	0.5	2.5	ns
Fall Time	t_f	0.5	2.3	0.5	2.4	0.5	2.5	ns

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

FUNCTION SELECT TABLE

CIN	S1	S2	Operating Mode
X	L	L	Preset (Program)
L	L	H	Increment (Count Up)
H	L	H	Hold Count
L	H	L	Decrement (Count Down)
H	H	L	Hold Count
X	H	H	Hold (Stop Count)

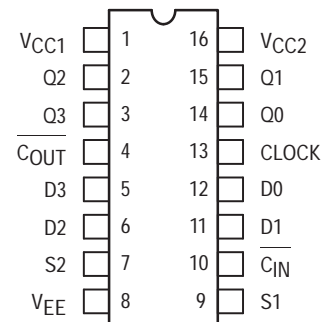
SEQUENTIAL TRUTH TABLE *

INPUTS								OUTPUTS				
S1	S2	D0	D1	D2	D3	Carry In	Clock **	Q0	Q1	Q2	Q3	Carry Out
L	L	L	L	H	H	X	H	L	L	H	H	L
L	L	L	L	X	X	X	L	H	L	H	H	L
L	L	L	X	X	X	X	L	H	L	H	H	L
L	L	X	X	X	X	X	L	H	H	H	H	L
L	H	X	X	X	X	X	H	L	H	H	H	H
L	H	X	X	X	X	X	H	H	H	H	H	H
H	L	X	X	X	X	X	X	H	H	H	H	H
L	L	H	H	L	L	L	X	H	H	H	L	L
H	L	X	X	X	X	X	L	H	L	L	L	H
H	L	X	X	X	X	X	L	H	L	L	L	L
H	L	X	X	X	X	X	L	H	H	H	H	H

* Truth table shows logic states assuming inputs vary in sequence shown from top to bottom.

** A clock H is defined as a clock input transition from a low to a high logic level.

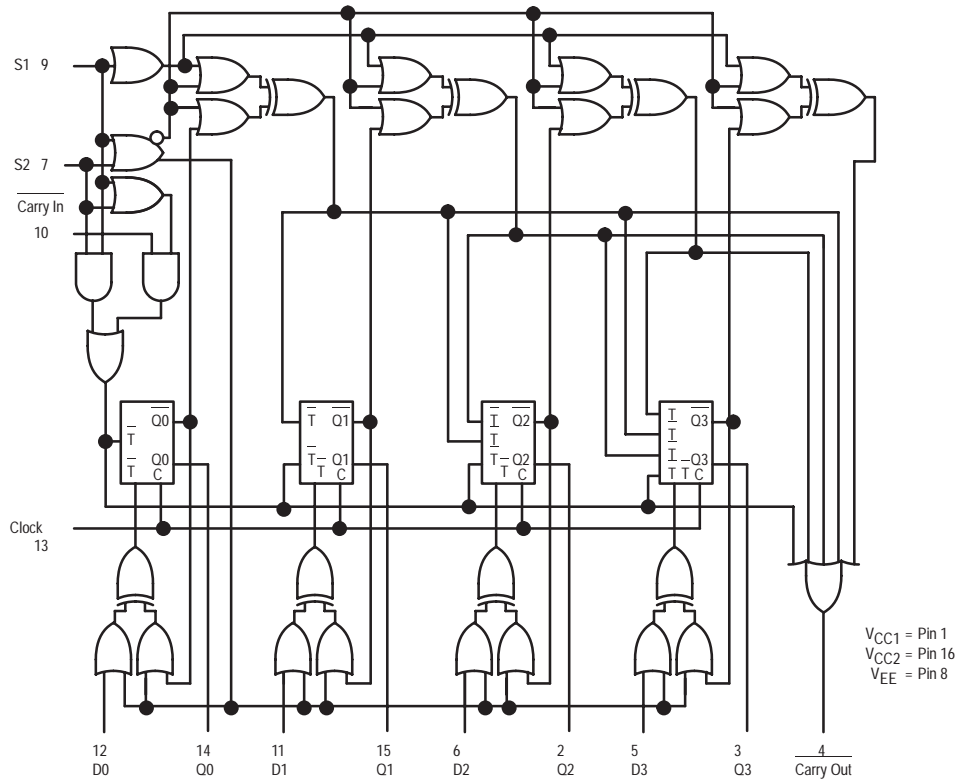
DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



LOGIC DIAGRAM



NOTE: FLIP-FLOPS WILL TOGGLE WHEN ALL \bar{T} INPUTS ARE LOW.

APPLICATION INFORMATION

The MC10H136 is a high speed synchronous counter that operates at 250 MHz. Counter operating modes include count up, count down, pre-set and hold count. This device allows the designer to use one basic counter for many applications.

The S1, S2, control lines determine the operating modes of the counter. In the pre-set mode, a clock pulse is necessary to load the counter with the information present on the data inputs (D0, D1, D2, and D3). Carry out goes low on the terminal count or when the counter is being pre-set.

Four-Bit Universal Shift Register

The MC10H141 is a four-bit universal shift register. This device is a functional/pinout duplication of the standard MECL 10K part with 100% improvement in propagation delay and operation frequency and no increase in power supply current.

- Shift frequency, 250 MHz Min
- Power Dissipation, 425 mW Typical
- Improved Noise Margin 150 mV (over operating voltage and temperature range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C °C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	112	—	102	—	112	mA
Input Current High Pins 5,6,9,11,12,13 Pins 7,10 Pin 4	I_{inH}	—	405 416 510	—	255 260 320	—	255 260 320	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

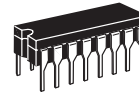
AC PARAMETERS

Propagation Delay	t_{pd}	1.0	2.0	1.0	2.0	1.1	2.1	ns
Hold Time — Data, Select	t_{hold}	1.0	—	1.0	—	1.0	—	ns
Set-up Time Data Select	t_{set}	1.5 3.0	—	1.5 3.0	—	1.5 3.0	—	ns
Rise Time	t_r	0.5	2.4	0.5	2.4	0.5	2.4	ns
Fall Time	t_f	0.5	2.4	0.5	2.4	0.5	2.4	ns
Shift Frequency	f_{shift}	250	—	250	—	250	—	MHz

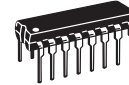
NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50 ohm resistor to -2.0 volts.

MC10H141



L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08



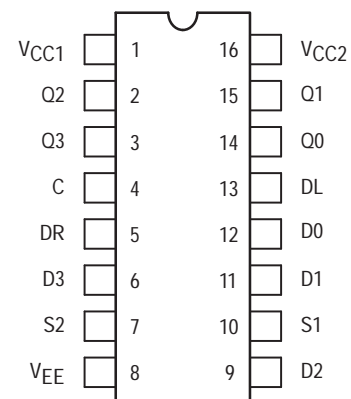
FN SUFFIX
PLCC
CASE 775-02

TRUTH TABLE

SELECT		OPERATING MODE	OUTPUTS			
S1	S2		Q_{0n+1}	Q_{1n+1}	Q_{2n+1}	Q_{3n+1}
L	L	Parallel Entry	D0	D1	D2	D3
L	H	Shift Right*	Q_{1n}	Q_{2n}	Q_{3n}	DR
H	L	Shift Left*	DL	Q_{0n}	Q_{1n}	Q_{2n}
H	H	Stop Shift	Q_{0n}	Q_{1n}	Q_{2n}	Q_{3n}

* Outputs as exist after pulse appears at "C" input with input conditions as shown (Pulse Positive transition of clock input).

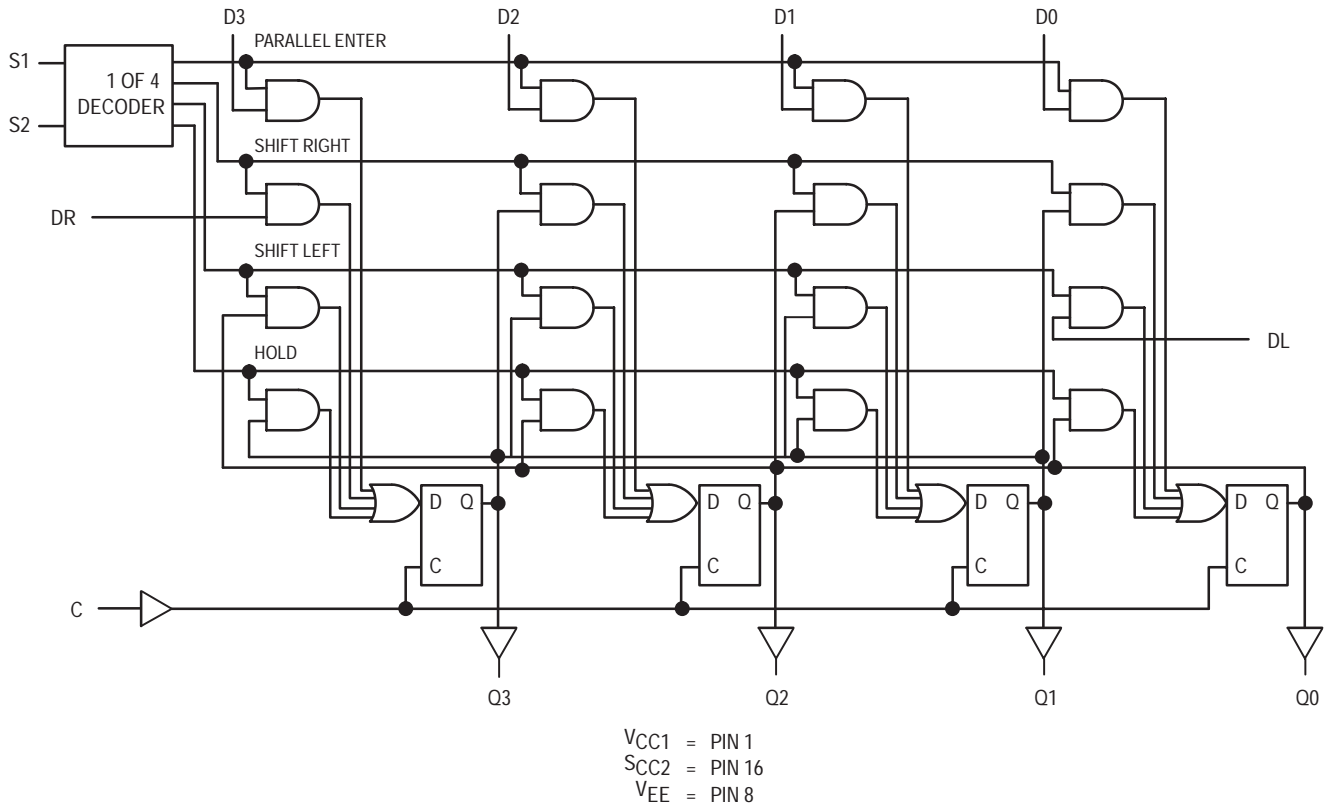
DIP PIN ASSIGNMENT



Pin assignment is for Dual-In-Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



LOGIC DIAGRAM



APPLICATION INFORMATION

The MC10H141 is a four-bit universal shift register which performs shift left, or shift right, serial/parallel in, and serial/parallel out operations with no external gating. Inputs S1 and S2 control the four possible operations of the register without external gating of the clock. The flip-flops shift

information on the positive edge of the clock. The four operations are stop shift, shift left, shift right, and parallel entry of data. The other six inputs are all data type inputs; four for parallel entry data, and one for shifting in from the left (DL) and one for shifting in from the right (DR).

16 x 4 Bit Register File (RAM)

The MC10H145 is a 16 x 4 bit register file. The active-low chip select allows easy expansion.

The operating mode of the register file is controlled by the \overline{WE} input. When \overline{WE} is "low" the device is in the write mode, the outputs are "low" and the data present at D_n input is stored at the selected address, when \overline{WE} is "high," the device is in the read mode — the data state at the selected location is present at the Q_n outputs.

- Address Access Time, 4.5 ns Typical
- Power Dissipation, 700 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C

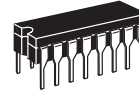
ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2\text{ V} \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	160	—	163	—	165	mA
Input Current High	I_{inH}	—	375	—	220	—	220	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

MC10H145



L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08



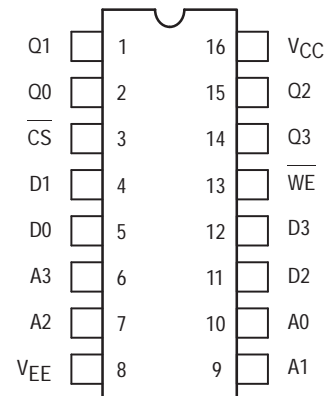
FN SUFFIX
PLCC
CASE 775-02

TRUTH TABLE

MODE	INPUT			OUTPUT
	CS	WE	D_n	Q_n
Write "0"	L	L	L	L
Write "1"	L	L	H	L
Read	L	H	X	Q
Disabled	H	X	X	L

Q-State of Addressed Cell

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.

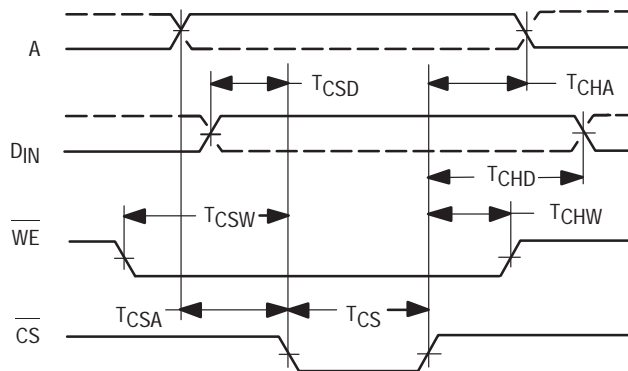


AC PARAMETERS

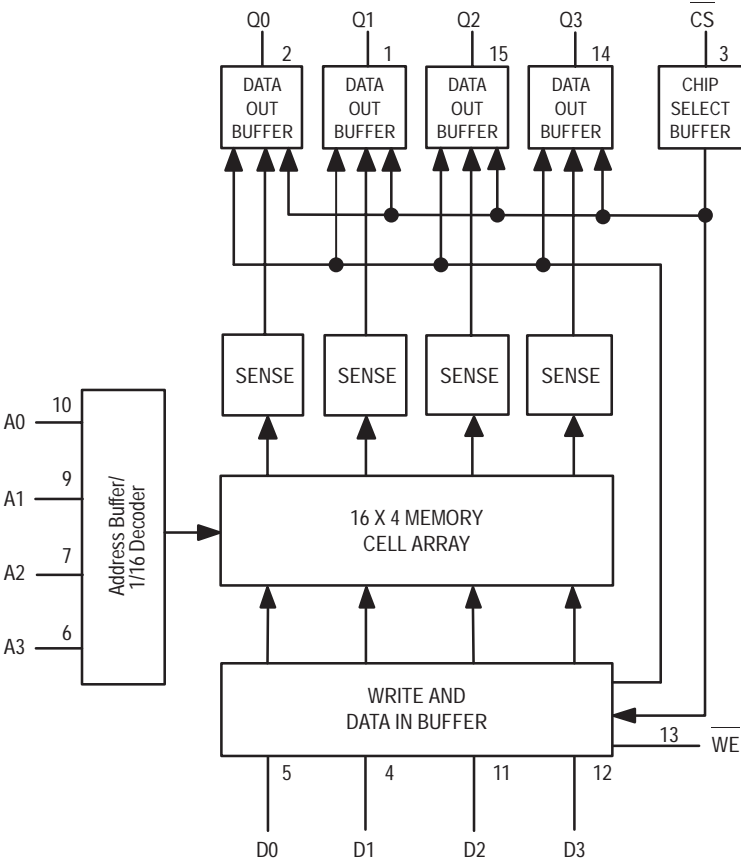
Characteristics	Symbol	MC10H145 T _A = 0 to +75°C, V _{EE} = -5.2 Vdc ±5%		Unit	Conditions
		Min	Max		
Read Mode Chip Select Access Time Chip Select Recovery Time Address Access Time	t _{ACS} t _{RCS} t _{AA}	0 0 0	4.0 4.0 6.0	ns	Measured from 50% of input to 50% of output. See Note 2.
Write Mode Write Pulse Width Data Setup Time Prior to Write Data Hold Time After Write Address Setup Time Prior to Write Address Hold Time After Write Chip Select Setup Time Prior to Write Chip Select Hold Time After Write Write Disable Time Write Recovery Time	t _W t _{WSD} t _{WHD} t _{WSA} t _{WHA} t _{WSCS} t _{WHCS} t _{WS} t _{WR}	6.0 0 1.5 3.5 1.5 0 1.5 1.0 1.0	— — — — — — — 4.0 4.0	ns	t _{WSA} = 3.5 ns Measured at 50% of input to 50% of output. t _W = 6.0 ns.
Chip Enable Strobe Mode Data Setup Prior to Chip Select Write Enable Setup Prior to Chip Select Address Setup Prior to Chip Select Data Hold Time After Chip Select Write Enable Hold Time After Chip Select Address Hold Time After Chip Select Chip Select Minimum Pulse Width	t _{CSD} t _{CSW} t _{CSA} t _{CHD} t _{CHW} t _{CHA} t _{CS}	0 0 0 1.0 0 2.0 4.0	— — — — — — —	ns	Guaranteed but not tested on standard product. See Figure 1.
Rise and Fall Time Address to Output CS to Output	t _r , t _f	0.6 0.6	2.5 2.5	ns	Measured between 20% and 80% points.
Capacitance Input Capacitance Output Capacitance	C _{in} C _{out}	— —	6.0 8.0	pF	Measured with a pulse technique.

- NOTES: 1. Test circuit characteristics: R_T = 50 Ω, MC10H145. C_L ≤ 5.0 pF (including jig and Stray Capacitance). Delay should be derated 30 ps/pF for capacitive loads up to 50 pF.
 2. The maximum Address Access Time is guaranteed to be the worst-case bit in the memory.
 3. For proper use of MECL in a system environment, consult MECL System Design Handbook.

FIGURE 1 — CHIP ENABLE STROBE MODE



BLOCK DIAGRAM



Quad 2-Input Multiplexer (Non-Inverting)

The MC10H158 is a quad two channel multiplexer with common input select. A “high” level select enables input D00, D10, D20 and D30 and a “low” level select enables input D01, D11, D21 and D31. This MECL 10H part is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in propagation delay and no increase in power-supply current.

- Propagation Delay, 1.5 ns Typical
- Power Dissipation, 197 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current— Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range— Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C °C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2\text{ V} \pm 5\%$)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	53	—	48	—	53	mA
Input Current High Pin 9 Pins 3-6 and 10-13	I_{inH}	—	475 515	—	295 320	—	295 320	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

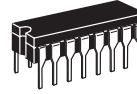
AC PARAMETERS

Propagation Delay Data Select	t_{pd}	0.5	1.9	0.5	1.9	0.5	2.0	ns
		1.0	2.9	1.0	2.9	1.0	2.9	
Rise Time	t_r	0.7	2.2	0.7	2.2	0.7	2.2	ns
Fall Time	t_f	0.7	2.2	0.7	2.2	0.7	2.2	ns

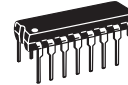
NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

MC10H158



L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08

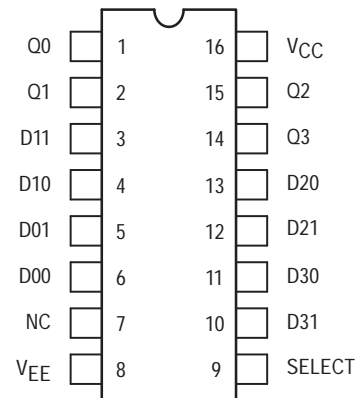


FN SUFFIX
PLCC
CASE 775-02

TRUTH TABLE

Select	D0	D1	Q
L	X	L	L
L	X	H	H
H	L	X	L
H	H	X	H

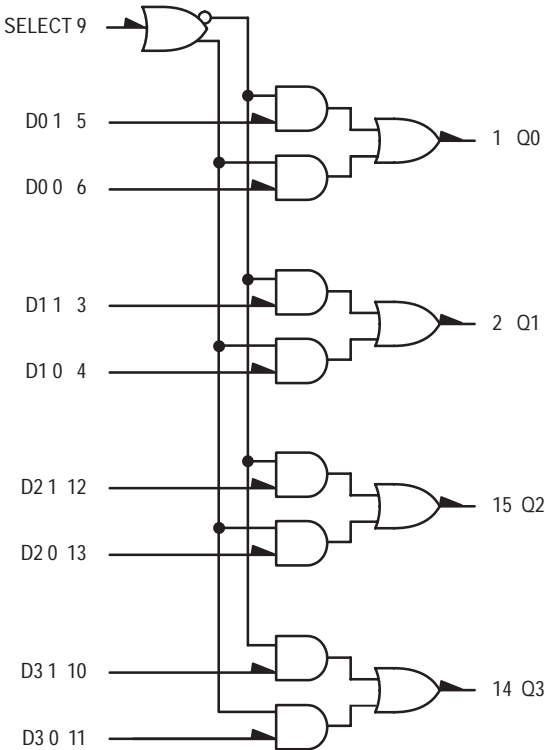
DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6-11.



LOGIC DIAGRAM



VCC = PIN 16
VEE = PIN 8

Quad 2-Input Multiplexer (Inverting)

The MC10H159 is a quad 2-input multiplexer with enable. This MECL 10H part is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in propagation delay and no increase in power-supply current.

- Propagation Delay, 1.5 ns Typical
- Power Dissipation, 218 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C °C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	58	—	53	—	58	mA
Input Current High Pin 9 Pins 3-7 and 10-13	I_{inH}	—	475 515	—	295 320	—	295 320	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

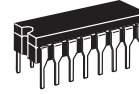
AC PARAMETERS

Characteristic	Symbol	0.5	2.2	0.5	2.2	0.5	2.2	ns
Propagation Delay Data Select Enable	t_{pd}	0.5	2.2	0.5	2.2	0.5	2.2	ns
Rise Time	t_r	0.5	2.2	0.5	2.2	0.5	2.2	ns
Fall Time	t_f	0.5	2.2	0.5	2.2	0.5	2.2	ns

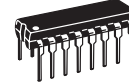
NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

MC10H159



L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08

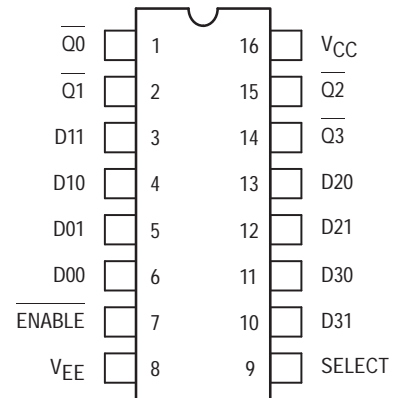


FN SUFFIX
PLCC
CASE 775-02

TRUTH TABLE

Enable	Select	D0	D1	Q
L	L	X	L	H
L	L	X	H	L
L	H	L	X	H
L	H	H	X	L
H	X	X	X	L

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6-11.

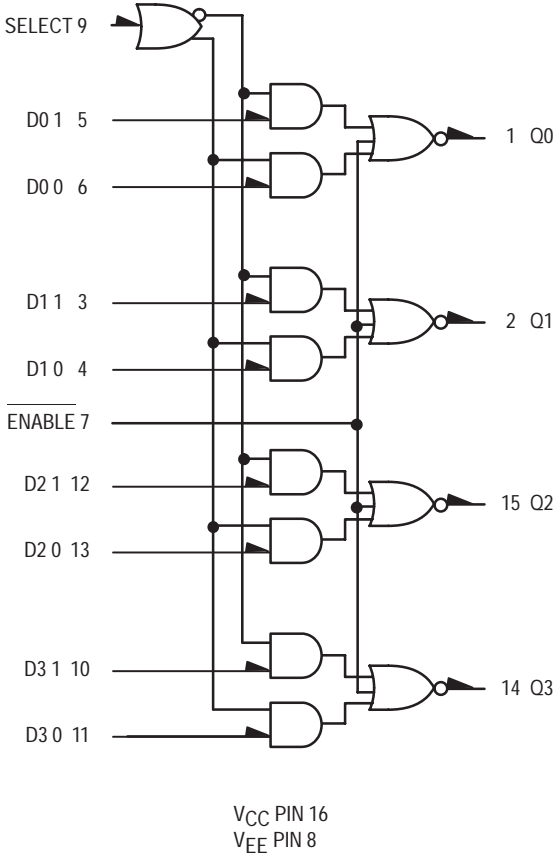


APPLICATION INFORMATION

The MC10H159 is a quad two channel multiplexer with enable. It incorporates common enable and common data select inputs. The select input determines which data inputs are enabled. A high (H) level enables data

inputs D0 0, D1 0, D2 0, and D3 0. A low (L) level enables data inputs D0 1, D1 1, D2 1, and D3 1. Any change on the data inputs will be reflected at the outputs while the enable is low. Input levels are inverted at the output.

LOGIC DIAGRAM



12-Bit Parity Generator-Checker

The MC10H160 is a 12-bit parity generator-checker. The output goes high when an odd number of inputs are high providing the odd parity function. Unconnected inputs are pulled to a logic low allowing parity detection and generation for less than 12 bits. The MC10H160 is a functional pin duplication of the standard 10K family part with 100% improvement in propagation delay and no increase in power-supply current.

- Propagation Delay, 2.5 ns Typical
- Power Dissipation, 320 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current— Continuous	I_{out}	50	mA
— Surge		100	
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range— Plastic	T_{stg}	-55 to +150	°C
— Ceramic		-55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	88	—	78	—	88	mA
Input Current High Pins 3,5,7,10,12,14 Pins 4,6,9,11,13,15	I_{inH}	—	391 457	—	246 285	—	246 285	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

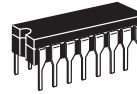
AC PARAMETERS

Propagation Delay	t_{pd}	1.1	3.1	1.1	3.3	1.2	3.5	ns
Rise Time	t_r	0.55	1.5	0.55	1.6	0.75	1.7	ns
Fall Time	t_f	0.55	1.5	0.55	1.6	0.75	1.7	ns

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

MC10H160



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

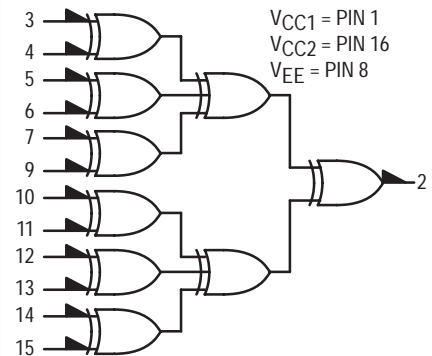


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

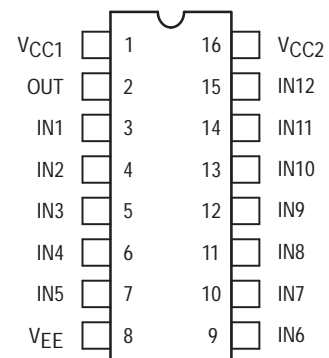
LOGIC DIAGRAM



TRUTH TABLE

INPUT	OUTPUT
Sum of High Level Inputs	Pin 2
Even	Low
Odd	High

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



Binary to 1-8 Decoder (Low)

The MC10H161 provides parallel decoding of a three bit binary word to one of eight lines. The MC10H161 is useful in high-speed multiplexer/demultiplexer applications.

The MC10H161 is designed to decode a three bit input word to one of eight output lines. The MC10H161 output will be low when selected while all other output are high. The enable inputs, when either or both are high, force all outputs high.

The MC10H161 is a true parallel decoder. This eliminates unequal parallel path delay times found in other decoder designs. These devices are ideally suited for multiplexer/demultiplexer applications.

- Propagation Delay, 1.0 ns Typical
- Power Dissipation, 315 mW Typical (same as MECL 10K)
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current— Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range— Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	84	—	76	—	84	mA
Input Current High	I_{inH}	—	465	—	275	—	275	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

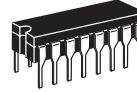
AC PARAMETERS

Propagation Delay	t_{pd}	0.6	2.0	0.65	2.1	0.7	2.2	ns
Data								
Enable		0.8	2.3	0.8	2.4	0.9	2.5	
Rise Time	t_r	0.55	1.7	0.65	1.8	0.7	1.9	ns
Fall Time	t_f	0.55	1.7	0.65	1.8	0.7	1.9	ns

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

MC10H161



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

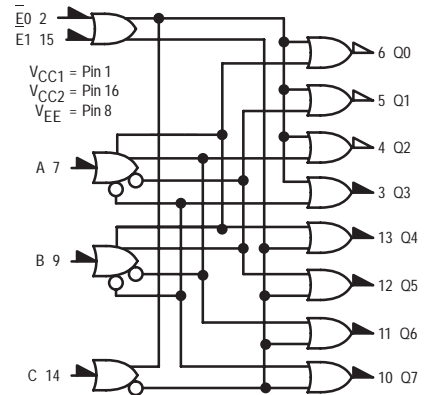


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

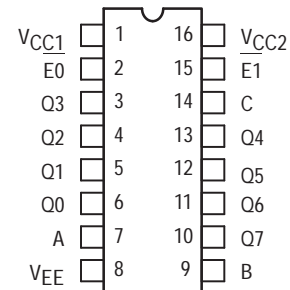
LOGIC DIAGRAM



TRUTH TABLE

ENABLE INPUTS		INPUTS			OUTPUTS							
E1	E0	C	B	A	Q0	Q1	Q2	Q3	Q4	Q5	Q6	Q7
L	L	L	L	L	L	H	H	H	H	H	H	H
L	L	L	L	H	L	H	H	L	H	H	H	H
L	L	L	L	H	H	H	H	L	H	H	H	H
L	L	L	H	L	L	H	H	H	L	H	H	H
L	L	L	H	H	L	H	H	H	H	L	H	H
L	L	L	H	H	H	L	H	H	H	H	L	H
L	L	H	L	L	L	H	H	H	H	H	H	L
L	L	H	L	H	L	H	H	H	H	H	H	L
L	L	H	H	L	L	H	H	H	H	H	H	L
L	L	H	H	H	L	H	H	H	H	H	H	L
H	X	X	X	X	H	H	H	H	H	H	H	H
X	H	X	X	X	H	H	H	H	H	H	H	H

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



TYPICAL APPLICATIONS

FIGURE 1 — HIGH SPEED 16-BIT MULTIPLEXER/DEMULTIPLEXER

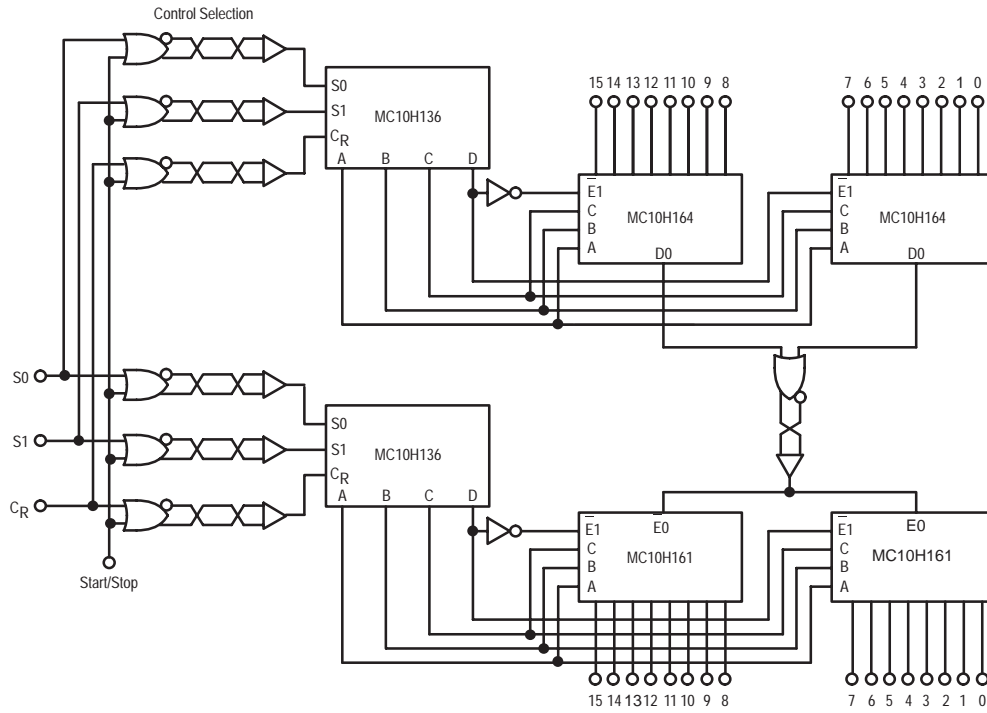
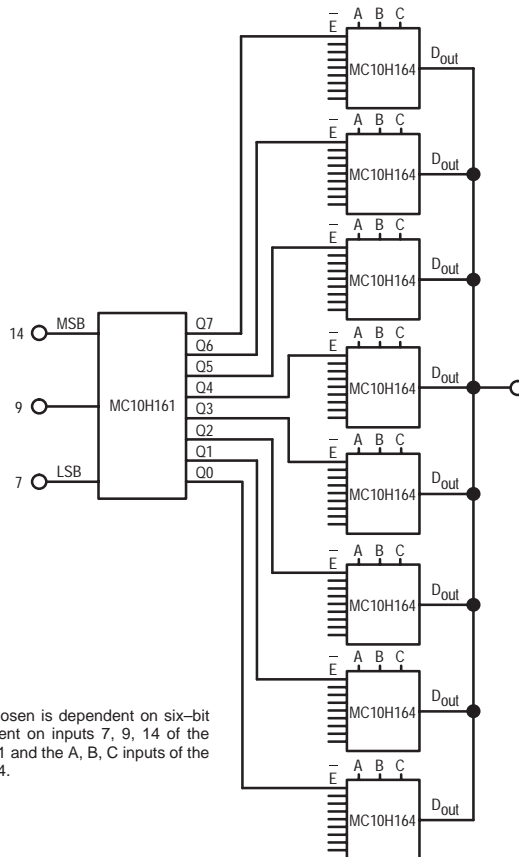


FIGURE 2 — 1-OF-64 LINE MULTIPLEXER



The Bit chosen is dependent on six-bit code present on inputs 7, 9, 14 of the MC10H161 and the A, B, C inputs of the MC10H164.

Binary to 1-8 Decoder (High)

The MC10H162 provides parallel decoding of a three bit binary word to one of eight lines. The MC10H162 is useful in high-speed multiplexer/ demultiplexer applications.

The MC10H162 is designed to decode a three bit input word to one of eight output lines. The MC10H162 output will be high when selected while all other output are low. The enable inputs, when either or both are high, force all outputs low.

The MC10H162 is a true parallel decoder. This eliminates unequal parallel path delay times found in other decoder designs. These devices are ideally suited for multiplexer/demultiplexer applications.

- Propagation Delay, 1.0 ns Typical
- Power Dissipation, 315 mW Typical (same as MECL 10K)
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	84	—	76	—	84	mA
Input Current High	I_{inH}	—	465	—	275	—	275	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

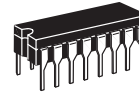
AC PARAMETERS

Propagation Delay Pins 7, 9, 14 Only Pins 2, 15 Only	t_{pd}	0.7	2.0	0.7	2.1	0.8	2.5	ns
Rise Time	t_r	0.6	1.8	0.6	1.9	0.6	2.0	ns
Fall Time	t_f	0.6	1.8	0.6	1.9	0.6	2.0	ns

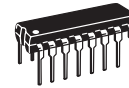
NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

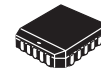
MC10H162



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

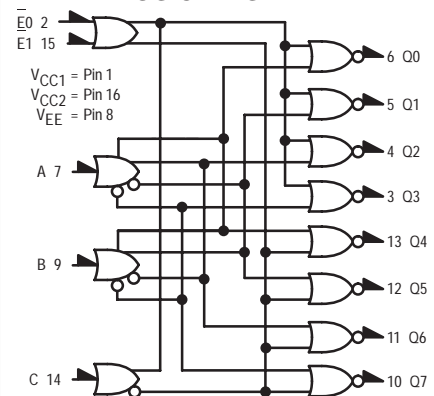


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

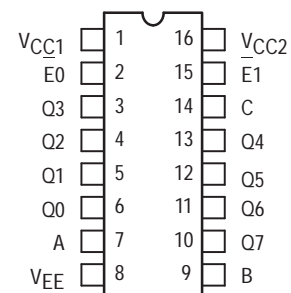
LOGIC DIAGRAM



TRUTH TABLE

INPUTS				OUTPUTS								
E0	E1	C	B	A	Q0	Q1	Q2	Q3	Q4	Q5	Q6	Q7
L	L	L	L	L	L	L	L	L	L	L	L	L
L	L	L	L	H	L	L	L	L	L	L	L	L
L	L	L	L	H	H	L	L	L	L	L	L	L
L	L	L	H	L	L	L	L	L	L	L	L	L
L	L	L	H	H	L	L	L	L	L	L	L	L
L	L	H	L	L	L	L	L	L	L	L	H	L
L	L	H	H	L	L	L	L	L	L	L	L	H
L	L	H	H	H	L	L	L	L	L	L	L	H
H	X	X	X	X	L	L	L	L	L	L	L	L
X	H	X	X	X	L	L	L	L	L	L	L	L

DIP PIN ASSIGNMENT

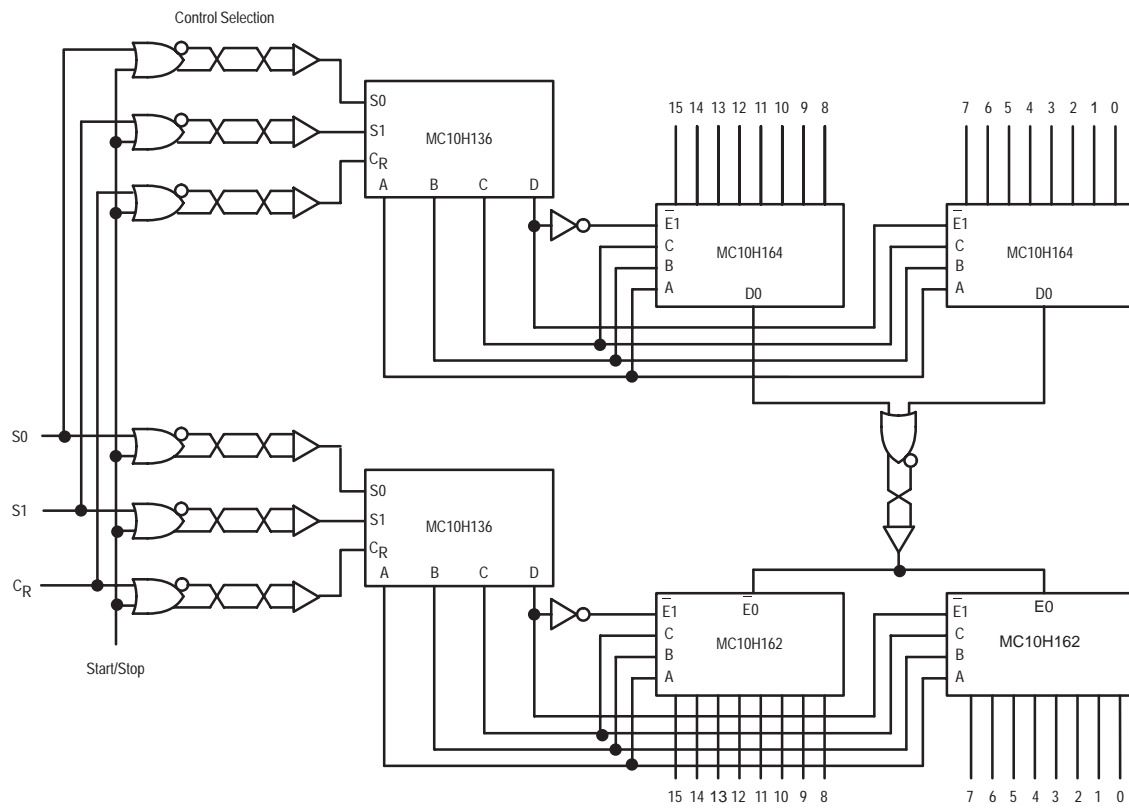


Pin assignment is for Dual-in-Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



TYPICAL APPLICATIONS

FIGURE 1 — HIGH SPEED 16-BIT MULTIPLEXER/DEMULTIPLEXER



8-Line Multiplexer

The MC10H164 is a MECL 10H part which is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in propagation delay, and no increase in power supply current.

The MC10H164 is designed to be used in data multiplexing and parallel to serial conversion applications. Full parallel gating provides equal delays through any data path. The MC10H164 incorporates an output buffer, eight inputs and an enable. A high on the enable forces the output low. The open emitter output allows the MC10H164 to be connected directly to a data bus. The enable line allows an easy means of expanding to more than 8 lines using additional MC10H164's.

- Propagation Delay, 1.0 ns Typical
- Power Dissipation, 310 mW Typical (same as MECL 10K)
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current— Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range— Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	83	—	75	—	83	mA
Input Current High	I_{inH}	—	512	—	320	—	320	μA
Input Current Low	I_{inL}	0.7	—	0.7	—	0.7	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

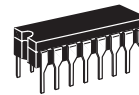
AC PARAMETERS

Propagation Delay	t_{pd}	0.4	1.45	0.4	1.5	0.5	1.7	ns
Enable								
Data		0.7	2.4	0.8	2.5	0.9	2.6	
Address		1.0	2.8	1.1	2.9	1.2	3.2	
Rise Time	t_r	0.5	1.5	0.5	1.6	0.5	1.7	ns
Fall Time	t_f	0.5	1.5	0.5	1.6	0.5	1.7	ns

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

MC10H164



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

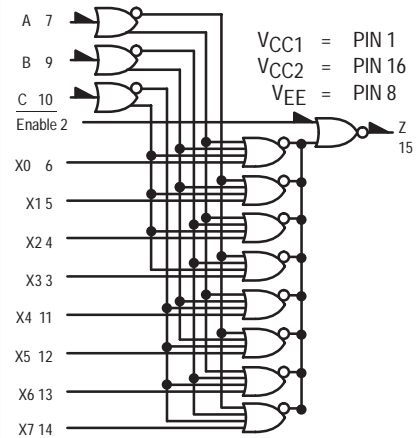


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

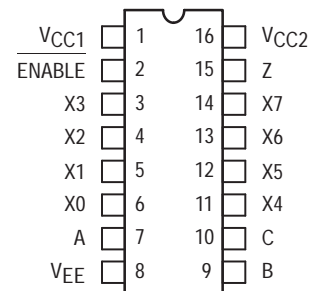
LOGIC DIAGRAM



TRUTH TABLE

ENABLE	ADDRESS INPUTS			Z
	C	B	A	
L	L	L	L	X0
L	L	L	H	X1
L	L	H	L	X2
L	L	H	H	X3
L	H	L	L	X4
L	H	L	H	X5
L	H	H	L	X6
L	H	H	H	X7
H	X	X	X	L

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



TYPICAL APPLICATIONS
FIGURE 1 — HIGH SPEED 16-BIT
MULTIPLEXER/DEMULTIPLEXER

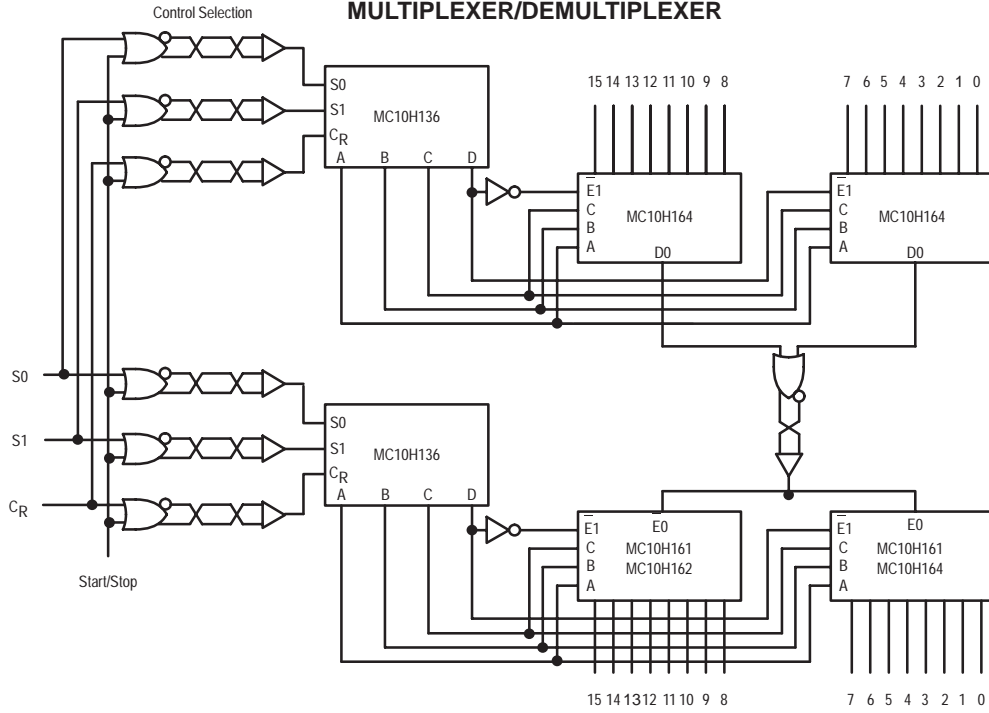
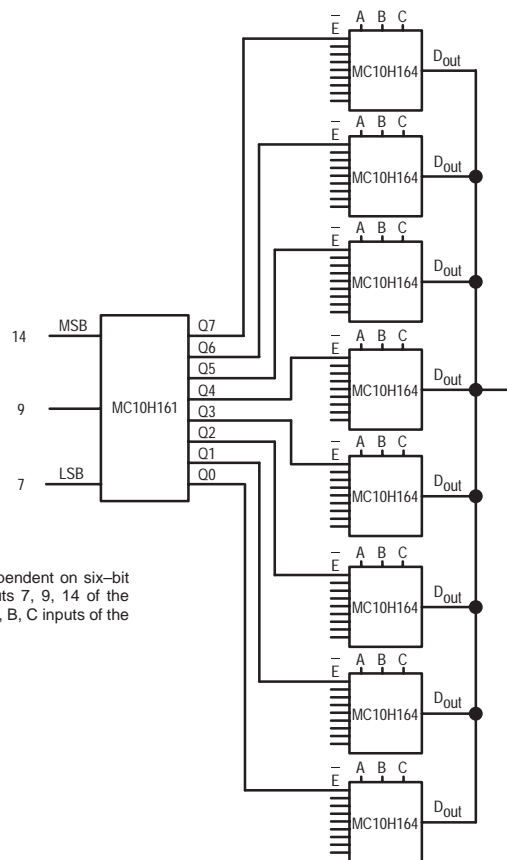


FIGURE 2 — 1-OF-64 LINE MULTIPLEXER



The Bit chosen is dependent on six-bit code present on inputs 7, 9, 14 of the MC10H161 and the A, B, C inputs of the MC10H164.

8-Input Priority Encoder

The MC10H165 is an 8-Input Priority Encoder. This 10H part is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in propagation delay, and no increases in power-current.

- Propagation Delay, Data-to-Output, 2.2 ns Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	144	—	131	—	144	mA
Input Current High Pin 4 Data Inputs	I_{inH}	—	510 600	—	320 370	—	320 370	μ Adc
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μ A
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

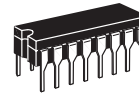
AC PARAMETERS

Propagation Delay Data Input → Output Clock Input → Output	t_{pd}	0.7	3.4	0.7	3.4	0.7	3.4	ns
Set-up Time	t_{set}	3.0	—	3.0	—	3.0	—	ns
Hold Time	t_{hold}	0.5	—	0.5	—	0.5	—	ns
Rise Time	t_r	0.5	2.4	0.5	2.4	0.5	2.4	ns
Fall Time	t_f	0.5	2.4	0.5	2.4	0.5	2.4	ns

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

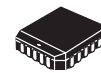
MC10H165



L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08

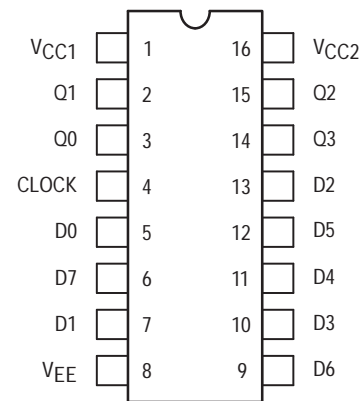


FN SUFFIX
PLCC
CASE 775-02

TRUTH TABLE

DATA INPUTS							OUTPUTS				
D0	D1	D2	D3	D4	D5	D6	D7	Q3	Q2	Q1	Q0
H	X	X	X	X	X	X	X	H	L	L	L
L	H	X	X	X	X	X	X	L	L	L	H
L	L	H	X	X	X	X	X	L	L	H	L
L	L	L	H	X	X	X	X	L	L	H	L
L	L	L	L	H	X	X	X	L	L	H	L
L	L	L	L	L	H	X	X	L	L	H	L
L	L	L	L	L	L	H	X	L	H	H	L
L	L	L	L	L	L	L	H	L	H	H	L
L	L	L	L	L	L	L	L	L	H	H	L
L	L	L	L	L	L	L	L	L	L	H	L
L	L	L	L	L	L	L	L	L	L	L	H

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.

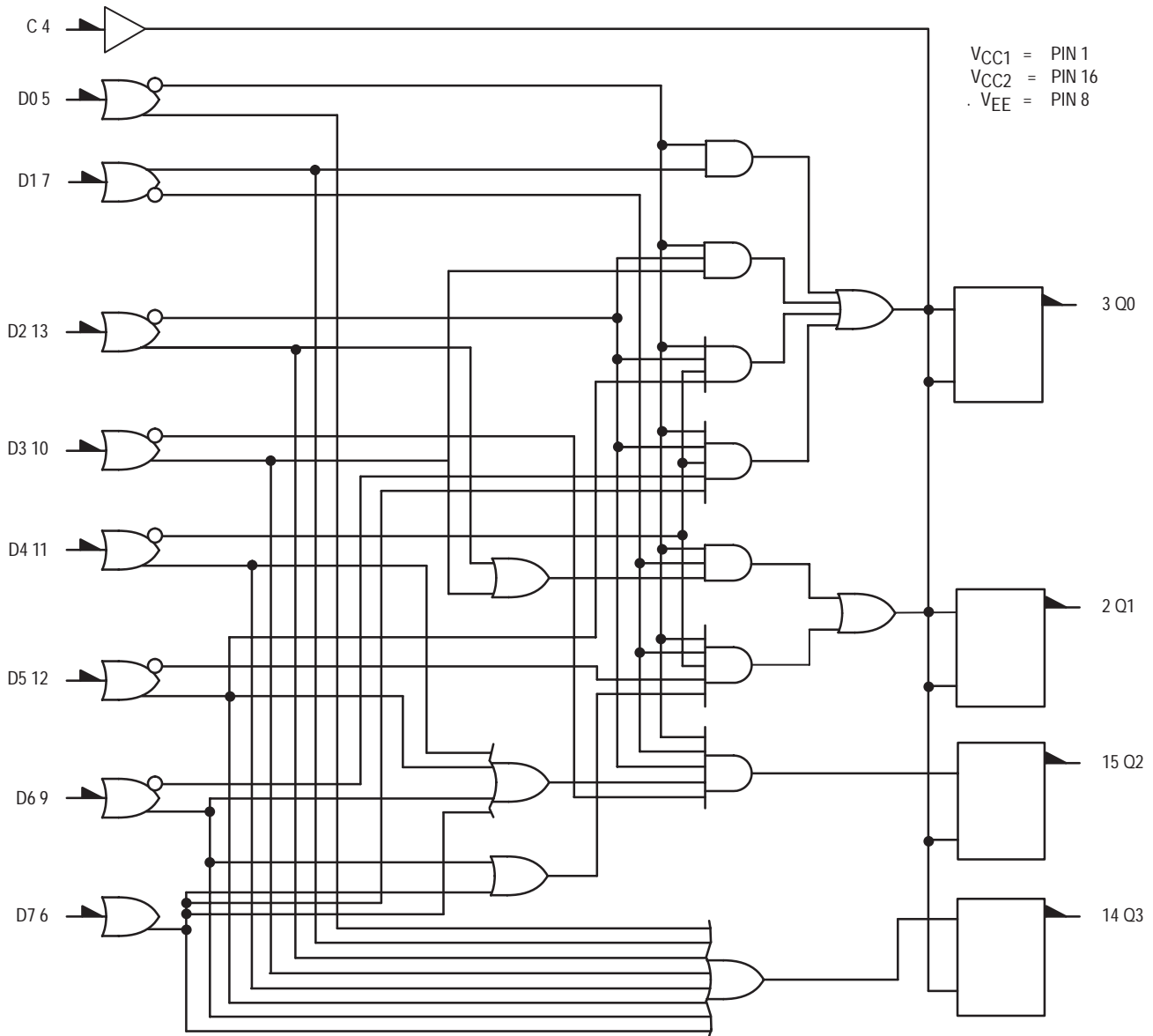


8-INPUT PRIORITY ENCODER

The MC10H165 is a device designed to encode eight inputs to a binary coded output. The output code is that of the highest order input. Any input of lower priority is ignored. Each output incorporates a latch allowing synchronous operation. When the clock is low the outputs follow the inputs and latch when the clock goes high. This device is very useful for a variety of applications in checking system status in control processors, peripheral

controllers, and testing systems. The input is active when high, (e.g., the three binary outputs are low when input D0 is high). The Q3 output is high when any input is high. This allows direct extension into another priority encoder when more than eight inputs are necessary. The MC10H165 can also be used to develop binary codes from random logic inputs, for addressing ROMs, RAMs, or for multiplexing data.

LOGIC DIAGRAM



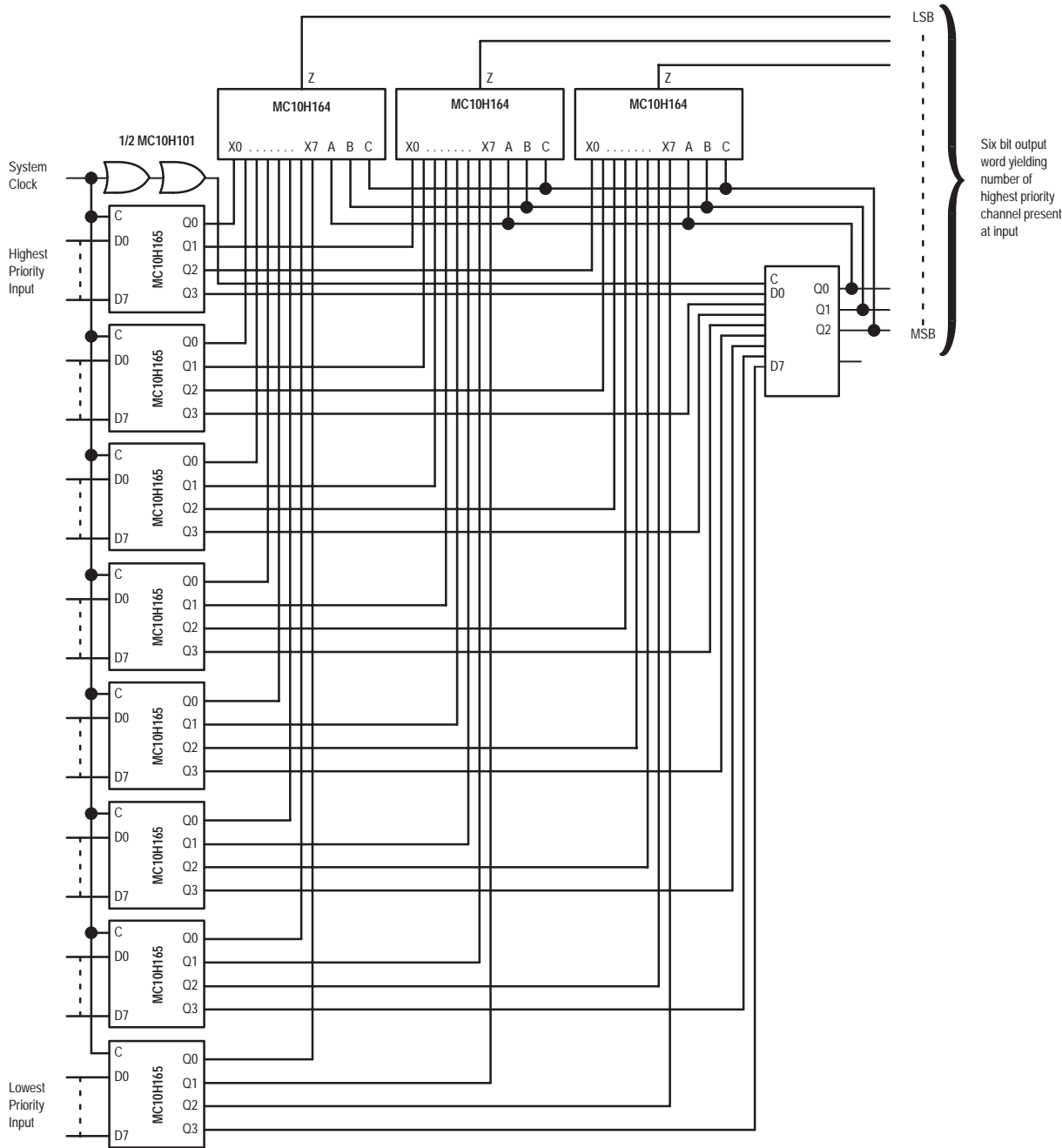
Numbers at ends of terminals denote pin numbers for L and P packages.

APPLICATION INFORMATION

A typical application of the MC10H165 is the decoding of system status on a priority basis. A 64-line priority encoder is shown in the figure below. System status lines are connected to this encoder such that, when a given condition exists, the respective input will be at a logic high level. This scheme will select the one of 64 different

system conditions, as represented at the encoder inputs, which has priority in determining the next system operation to be performed. The binary code showing the address of the highest priority input present will appear at the encoder outputs to control other system logic functions.

64-LINE PRIORITY ENCODER



5-Bit Magnitude Comparator

The MC10H166 is a 5-Bit Magnitude Comparator and is a functional/ pinout duplication of the standard MECL 10K part with 100% improvement in propagation delay and no increase in power-supply current.

The MC10H166 is a high-speed expandable 5-bit comparator for comparing the magnitude of two binary words. Two outputs are provided: A<B and A>B. The A = B function can be obtained by wire-ORing these outputs (a low level indicates A = B) or by wire-NORing the outputs (a high level indicates A = B). A high level on the enable function forces both outputs low.

- Propagation Delay, Data-to-Output, 2.0 ns Typical
- Power Dissipation 440 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C °C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	117	—	106	—	117	mA
Input Current High	I_{inH}	—	350	—	220	—	220	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

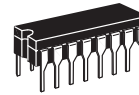
AC PARAMETERS

Propagation Delay Data-to-Output Enable-to-Output	t_{pd}	1.1	3.5	1.1	3.7	1.2	4.1	ns
		0.6	1.7	0.7	1.7	0.7	1.8	
Rise Time	t_r	0.6	1.5	0.6	1.6	0.6	1.7	ns
Fall Time	t_f	0.6	1.5	0.6	1.6	0.6	1.7	ns

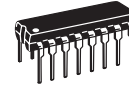
NOTES:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

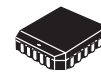
MC10H166



L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08

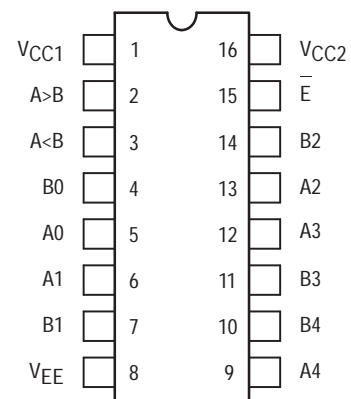


FN SUFFIX
PLCC
CASE 775-02

TRUTH TABLE

Inputs			Outputs	
E	A	B	A < B	A > B
H	X	X	L	L
L	WORD A = WORD B		L	L
L	WORD A > WORD B		L	H
L	WORD A < WORD B		H	L

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6-11.



LOGIC DIAGRAM

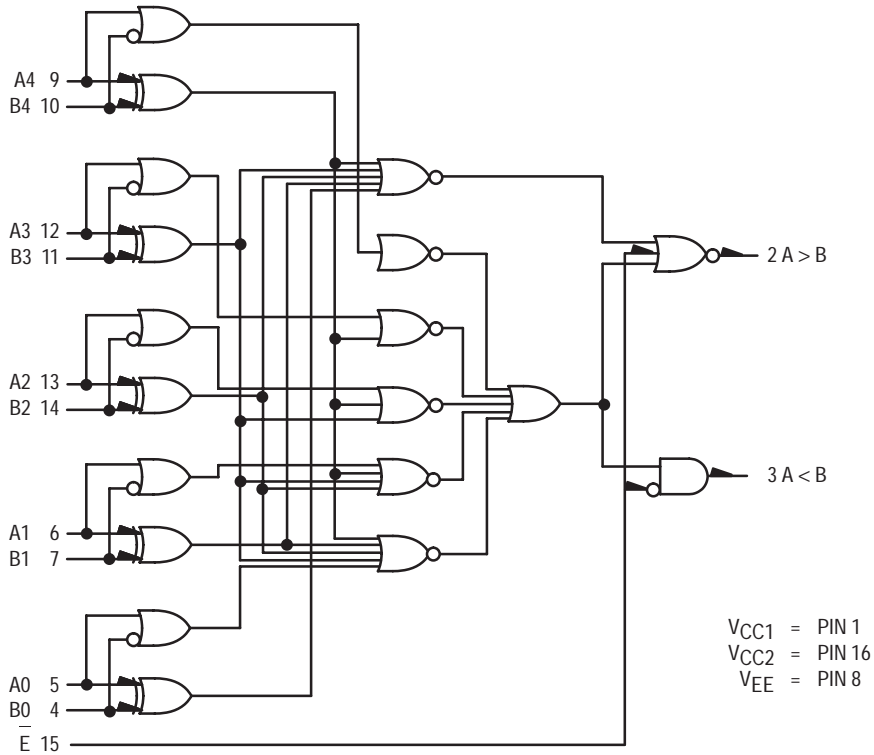
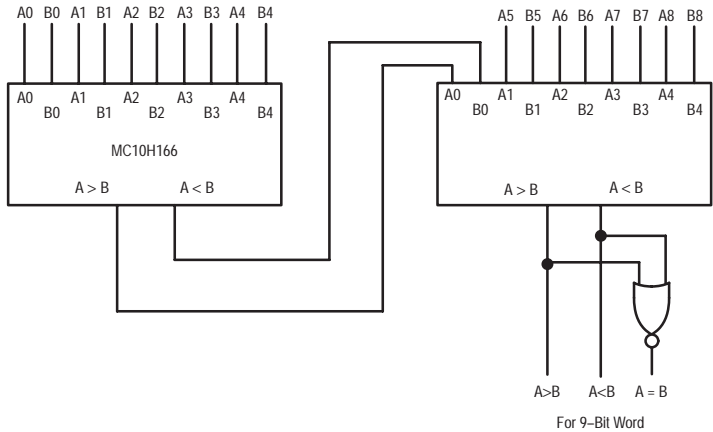


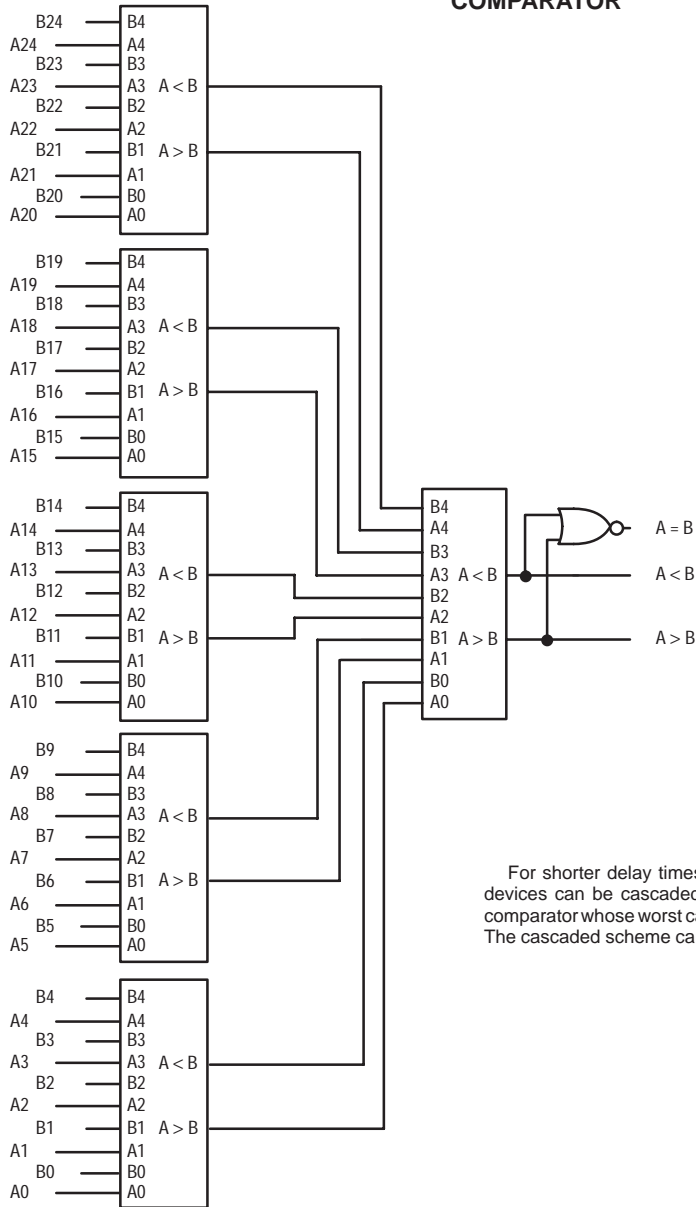
FIGURE 1 — 9-BIT MAGNITUDE COMPARATOR



For longer word lengths, the MC10H166 can be serially expanded or cascaded. Figure 1 shows two devices in a serial expansion for a 9-bit word length. The A > B and A < B outputs are fed to the A0 and B0 inputs respectively

of the next device. The connection for an A = B output is also shown. The worst case delay time of serial expansion is equal to the number of comparators times the data-to-output delay.

FIGURE 2 — 25-BIT MAGNITUDE COMPARATOR



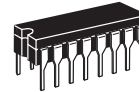
For shorter delay times than possible with serial expansion, devices can be cascaded. Figure 2 shows a 25-bit cascaded comparator whose worst case delay is two data-to-output delays. The cascaded scheme can be extended to longer word lengths.

Dual Binary to 1-4 Decoder (Low)

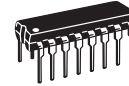
The MC10H171 is a binary coded 2 line to dual 4 line decoder with selected outputs low. With either E0 or E1 high, the corresponding selected 4 outputs are high. The common enable E, when high, forces all outputs high.

- Propagation Delay, 2 ns Typical
- Power Dissipation 325 mW Typical (same as MECL 10K)
- Improved Noise Margin 150 mV (over operating voltage and temperature range)
- Voltage Compensated
- MECL 10K-Compatible

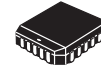
MC10H171



L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current— Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range— Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	85	—	77	—	85	mA
Input Current High	I_{inH}	—	425	—	265	—	265	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

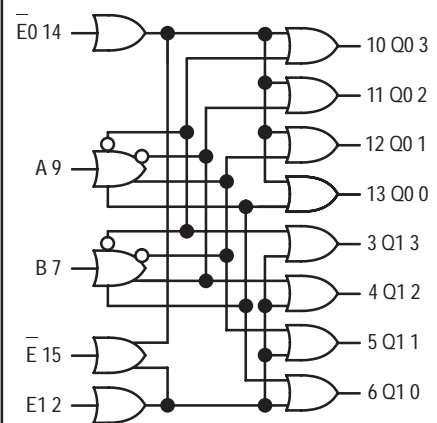
AC PARAMETERS

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Propagation Delay Data Select	t_{pd}	0.5	2.0	0.5	2.1	0.5	2.2	ns
Rise Time	t_r	0.5	1.7	0.5	1.8	0.5	1.9	ns
Fall Time	t_f	0.5	1.7	0.5	1.8	0.5	1.9	ns

NOTE:

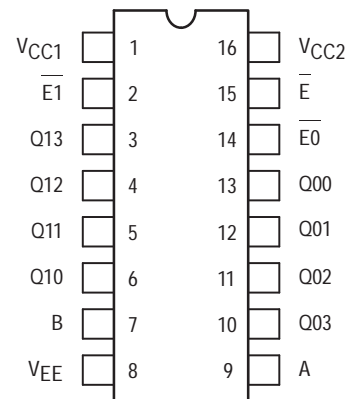
Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

LOGIC DIAGRAM



$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



TRUTH TABLE

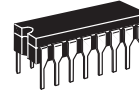
Enable Inputs			Inputs		Outputs							
\bar{E}	$\bar{E0}$	$\bar{E1}$	A	B	Q10	Q11	Q12	Q13	Q00	Q01	Q02	Q03
L	L	L	L	L	L	H	H	H	L	H	H	H
L	L	L	L	H	H	L	H	H	H	L	H	H
L	L	L	H	L	H	H	L	H	H	H	L	H
L	L	L	H	H	H	H	H	L	H	H	H	L
L	L	H	L	L	H	H	H	H	L	H	H	H
L	H	L	L	L	L	H	H	H	H	H	H	H
H	X	X	X	X	H	H	H	H	H	H	H	H

Dual Binary to 1-4-Decoder (High)

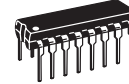
The MC10H172 is a binary coded 2 line to dual 4 line decoder with selected outputs high. With either E₀ or E₁ low, the corresponding selected 4 outputs are low. The common enable E, when high, forces all outputs low.

- Propagation Delay, 2 ns Typical
- Power Dissipation 325 mW Typical (same as MECL 10K)
- Improved Noise Margin 150 mV (over operating voltage and temperature range)
- Voltage Compensated
- MECL 10K-Compatible

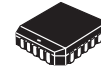
MC10H172



L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply (V _{CC} = 0)	V _{EE}	-8 to 0	Vdc
Input Voltage (V _{CC} = 0)	V _I	0 to V _{EE}	Vdc
Output Current— Continuous — Surge	I _{out}	50 100	mA
Operating Temperature Range	T _A	0 to +75	°C
Storage Temperature Range— Plastic — Ceramic	T _{stg}	-55 to +150 -55 to +165	°C

ELECTRICAL CHARACTERISTICS (V_{EE} = -5.2 V ±5%) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I _E	—	85	—	77	—	85	mA
Input Current High	I _{inH}	—	425	—	265	—	265	μA
Input Current Low	I _{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V _{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V _{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V _{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V _{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

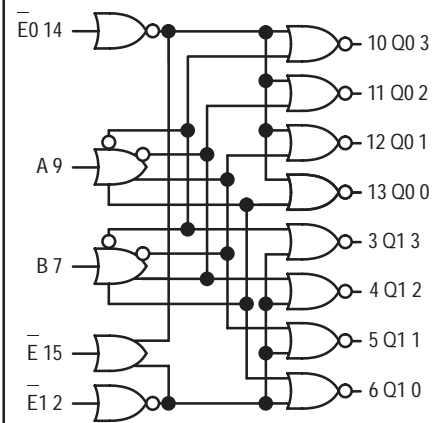
AC PARAMETERS

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Propagation Delay Data Select	t _{pd}	0.5	2.0	0.5	2.1	0.5	2.2	ns
Rise Time	t _r	0.5	1.7	0.5	1.8	0.5	1.9	ns
Fall Time	t _f	0.5	1.7	0.5	1.8	0.5	1.9	ns

NOTE:

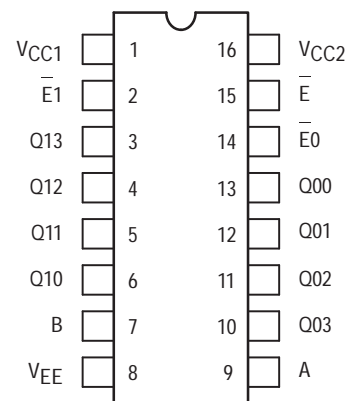
Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

LOGIC DIAGRAM



V_{CC1} = PIN 1
V_{CC2} = PIN 16
V_{EE} = PIN 8

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



TRUTH TABLE

Enable Inputs			Inputs		Outputs							
\bar{E}	$\bar{E1}$	$\bar{E0}$	A	B	Q1 0	Q1 1	Q1 2	Q1 3	Q0 0	Q0 1	Q0 2	Q0 3
L	H	H	L	L	H	L	L	L	H	L	L	L
L	H	H	L	H	L	H	L	L	L	H	L	L
L	H	H	H	L	L	L	H	L	L	L	H	L
L	H	H	H	H	L	L	L	H	L	L	L	H
L	L	H	L	L	L	L	L	L	H	L	L	L
L	H	L	L	L	H	L	L	L	L	L	L	L
H	X	X	X	X	L	L	L	L	L	L	L	L

X = Don't Care

Quad 2-Input Multiplexer/ Latch

The MC10H173 is a quad 2-input multiplexer with latch. This device is a functional/pinout duplication of the standard MECL 10K part, with 100% improvement in propagation delay and no increase in power supply current.

- Data Propagation Delay, 1.5 ns Typical
- Power Dissipation, 275 mW Typical
- Improved Noise Margin 150 mV (over operating voltage and temperature range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous	I_{out}	50	mA
— Surge		100	
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic	T_{stg}	-55 to +150	°C
— Ceramic		-55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	73	—	66	—	73	mA
Input Current High Pins 3-7 & 10-13 Pin 9	I_{inH}	—	510	—	320	—	320	μA
		—	475	—	300	—	300	
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

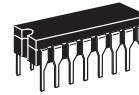
AC PARAMETERS

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Propagation Delay Data	t_{pd}	0.7	2.3	0.7	2.3	0.7	2.3	ns
Clock		1.0	3.7	1.0	3.7	1.0	3.7	
Select		1.0	3.6	1.0	3.6	1.0	3.6	
Set-up Time Data	t_{set}	0.7	—	0.7	—	0.7	—	ns
Select		1.0	—	1.0	—	1.0	—	
Hold Time Data	t_{hold}	0.7	—	0.7	—	0.7	—	ns
Select		1.0	—	1.0	—	1.0	—	
Rise Time	t_r	0.7	2.4	0.7	2.4	0.7	2.4	ns
Fall Time	t_f	0.7	2.4	0.7	2.4	0.7	2.4	ns

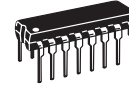
NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

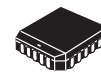
MC10H173



L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08

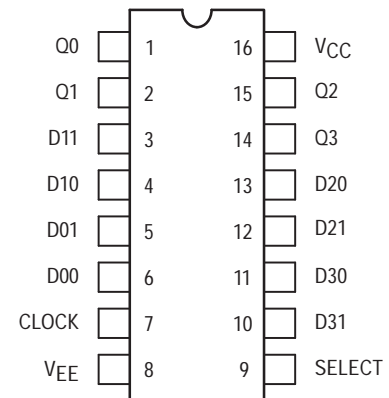


FN SUFFIX
PLCC
CASE 775-02

TRUTH TABLE

SELECT	CLOCK	$Q0_n + 1$
H	L	D00
L	L	D01
X	H	$Q0_n$

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6-11.

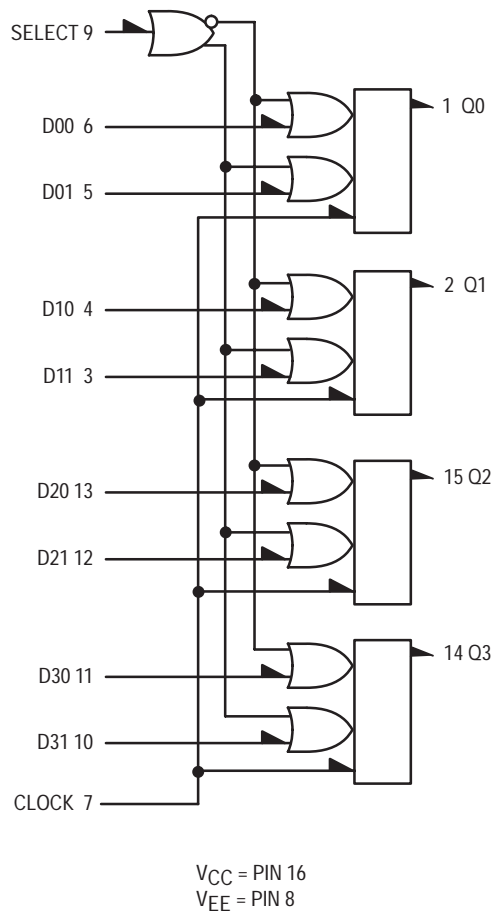


APPLICATION INFORMATION

The MC10H173 is a quad two-channel multiplexer with latch. It incorporates common clock and common data select inputs. The select input determines which data input is enabled. A high (H) level enables data inputs D00, D10, D20, and D30 and a low (L) level enables data inputs D01, D11, D21, D31. Any change on the data input

will be reflected at the outputs while the clock is low. The outputs are latched on the positive transition of the clock. While the clock is in the high state, a change in the information present at the data inputs will not affect the output information.

LOGIC DIAGRAM

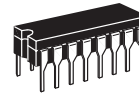


Dual 4 to 1 Multiplexer

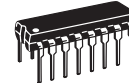
The MC10H174 is a Dual 4-to-1 Multiplexer. This device is a functional/pinout duplication of the standard MECL 10K part, with 100% improvement in propagation delay and no increase in power supply current.

- Propagation Delay, 1.5 ns Typical
- Power Dissipation, 305 mW Typical
- Improved Noise Margin 150 mV (over operating voltage and temperature range)
- Voltage Compensated
- MECL 10K-Compatible

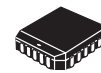
MC10H174



L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C °C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2\text{ V} \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	80	—	73	—	80	mA
Input Current High Pins 3-7 & 9-13 Pin 14	I_{inH}	—	475 670	—	300 420	—	300 420	μA dc
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

AC PARAMETERS

Characteristic	Symbol	0.7	2.4	0.8	2.5	0.9	2.6	ns
Propagation Delay Data	t_{pd}	0.7	2.4	0.8	2.5	0.9	2.6	ns
Select (A, B)		1.0	2.8	1.1	2.9	1.2	3.2	
Enable		0.4	1.45	0.4	1.5	0.5	1.7	
Rise Time	t_r	0.5	1.5	0.5	1.6	0.5	1.7	ns
Fall Time	t_f	0.5	1.5	0.5	1.6	0.5	1.7	ns

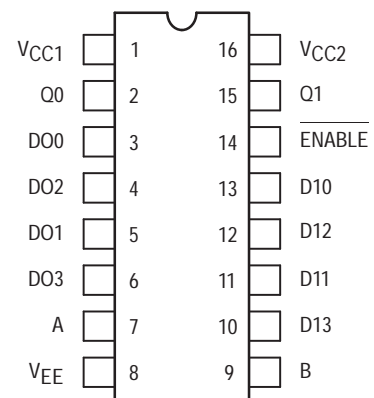
NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

TRUTH TABLE

ENABLE	ADDRESS INPUTS		OUTPUTS	
\bar{E}	B	A	Z	W
H	X	X	L	L
L	L	L	X0	Y0
L	L	H	X1	Y1
L	H	L	X2	Y2
L	H	H	X3	Y3

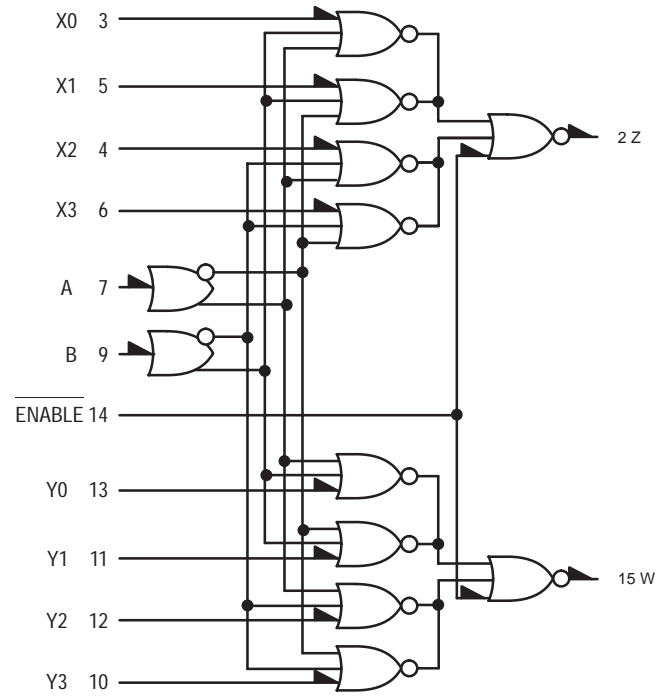
DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6-11.



LOGIC DIAGRAM



V_{CC1} = PIN 1
 V_{CC2} = PIN 16
 V_{EE} = PIN 8

Quint Latch

The MC10H175 is a quint D type latch with common reset and clock lines. This MECL 10KH part is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in propagation delay and no increase in power-supply current.

- Propagation Delay, 1.2 ns Typical
- Power Dissipation, 400 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current— Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range— Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C °C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	107	—	97	—	107	mA
Input Current High Pins 5,6,7,9,10,12,13 Pin 11	I_{inH}	—	565 1120	—	335 660	—	335 660	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

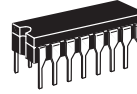
AC PARAMETERS

Propagation Delay	t_{pd}	0.6		1.6		0.6		1.7		ns
		0.6	1.6	0.6	1.6	0.6	1.7			
Data		0.6	1.6	0.6	1.6	0.6	1.7			
Clock		0.7	1.9	0.7	2.0	0.8	2.1			
Reset		1.0	2.2	1.0	2.3	1.0	2.4			
Set-up Time	t_{set}	1.5	—	1.5	—	1.5	—		ns	
Hold Time	t_{hold}	0.8	—	0.8	—	0.8	—		ns	
Rise Time	t_r	0.5	1.8	0.5	1.9	0.5	2.0		ns	
Fall Time	t_f	0.5	1.8	0.5	1.9	0.5	2.0		ns	

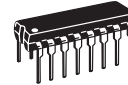
NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

MC10H175



L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08

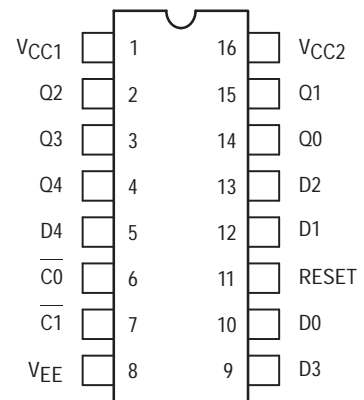


FN SUFFIX
PLCC
CASE 775-02

TRUTH TABLE

D	$\overline{C0}$	$\overline{C1}$	Reset	Q_{n+1}
L	L	L	X	L
H	L	L	X	H
X	H	X	L	Q_n
X	X	H	L	Q_n
X	H	X	H	L
X	X	H	H	L

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



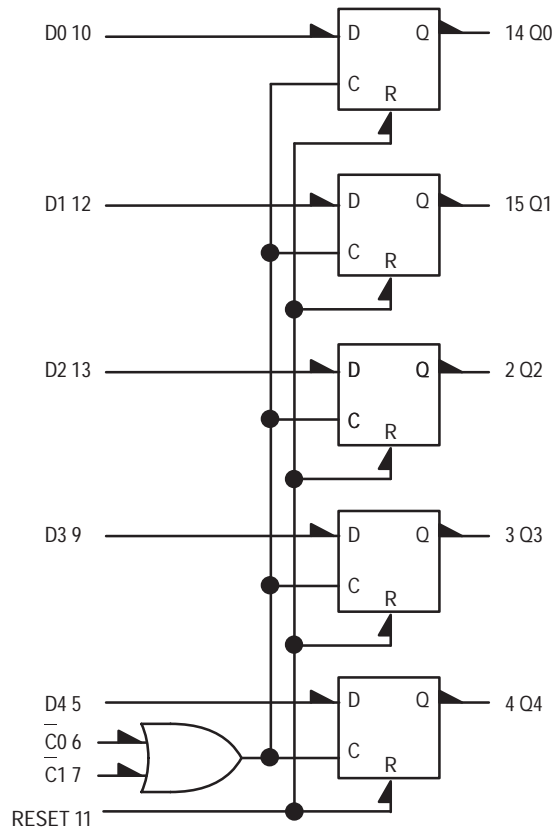
APPLICATION INFORMATION

The MC10H175 is a high speed, low power quint latch. It features five D type latches with common reset and a common two-input clock. Data is transferred on the negative edge of the clock and latched on the positive edge. The two clock inputs are "OR"ed together.

Any change on the data input will be reflected at the

outputs while the clock is low. The outputs are latched on the positive transition of the clock. While the clock is in the high state, a change in the information present at the data inputs will not affect the output information. **THE RESET INPUT IS ENABLED ONLY WHEN THE CLOCK IS IN THE HIGH STATE.**

LOGIC DIAGRAM



V_{CC1} = PIN 1
 V_{CC2} = PIN 16
 V_{EE} = PIN 8

Hex D Master-Slave Flip-Flop

The MC10H176 contains six master slave type D flip-flops with a common clock. This MECL 10H part is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in clock frequency and propagation delay and no increase in power-supply current.

- Propagation Delay, 1.7 ns Typical
- Power Dissipation, 460 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current— Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range— Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	123	—	112	—	123	mA
Input Current High Pins 5,6,7,10,11,12 Pin 9	I_{inH}	—	425 670	—	265 420	—	265 420	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

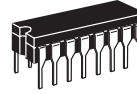
AC PARAMETERS

Propagation Delay	t_{pd}	0.9	2.1	0.9	2.2	1.0	2.4	ns
Set-up Time	t_{set}	1.5	—	1.5	—	1.5	—	ns
Hold Time	t_{hold}	0.9	—	0.9	—	1.0	—	ns
Rise Time	t_r	0.5	1.8	0.5	1.9	0.5	2.0	ns
Fall Time	t_f	0.5	1.8	0.5	1.9	0.5	2.0	ns
Toggle Frequency	f_{tog}	250	—	250	—	250	—	MHz

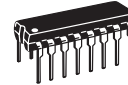
NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

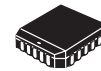
MC10H176



L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08



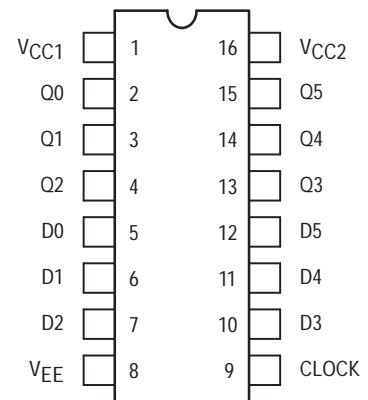
FN SUFFIX
PLCC
CASE 775-02

CLOCKED TRUTH TABLE

C	Q	Q_{n+1}
L	X	Q_n
H*	L	L
H*	H	H

* A clock H is a clock transition from a low to a high state.

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.

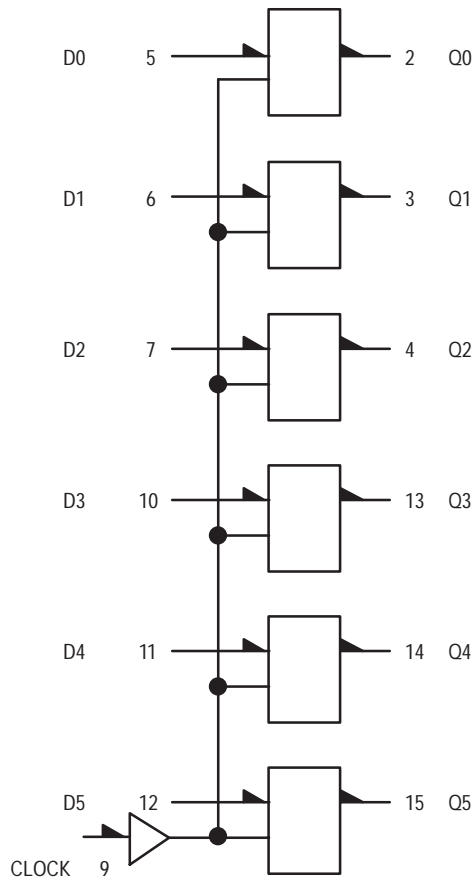


APPLICATION INFORMATION

The MC10H176 contains six high-speed, master slave type "D" flip-flops. Data is entered into the master when the clock is low. Master-to-slave data transfer takes place on the positive-going Clock transition. Thus,

outputs may change only on a positive-going Clock transition. A change in the information present at the data (D) input will not affect the output information any other time due to the master-slave construction of this device.

LOGIC DIAGRAM



V_{CC1} = PIN 1
 V_{CC2} = PIN 16
 V_{EE} = PIN 8

Look-Ahead Carry Block

The MC10H179 is a functional/pinout duplication of the standard MECL 10K part, with 100% improvement in propagation delay and no increase in power supply current.

- Power Dissipation, 300 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C °C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	79	—	72	—	79	mA
Input Current High Pins 5 and 9 Pins 4, 7 and 11 Pin 14 Pin 12 Pins 10 and 13	I_{inH}	—	465 545 705 790 870	—	275 320 415 465 510	—	275 320 415 465 510	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

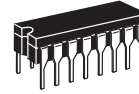
AC PARAMETERS

Propagation Delay P to P _G G, P, C _n to C _n or G _G	t_{pd}	0.4	1.4	0.4	1.5	0.5	1.7	ns
Rise Time	t_r	0.5	1.7	0.5	1.8	0.5	1.9	ns
Fall Time	t_f	0.5	1.7	0.5	1.8	0.5	1.9	ns

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

MC10H179



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

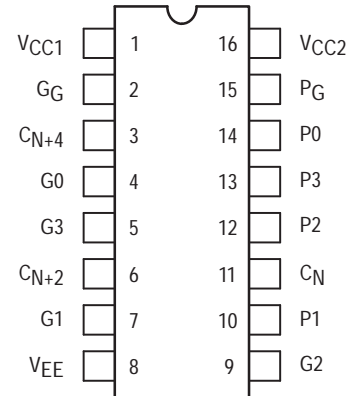


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



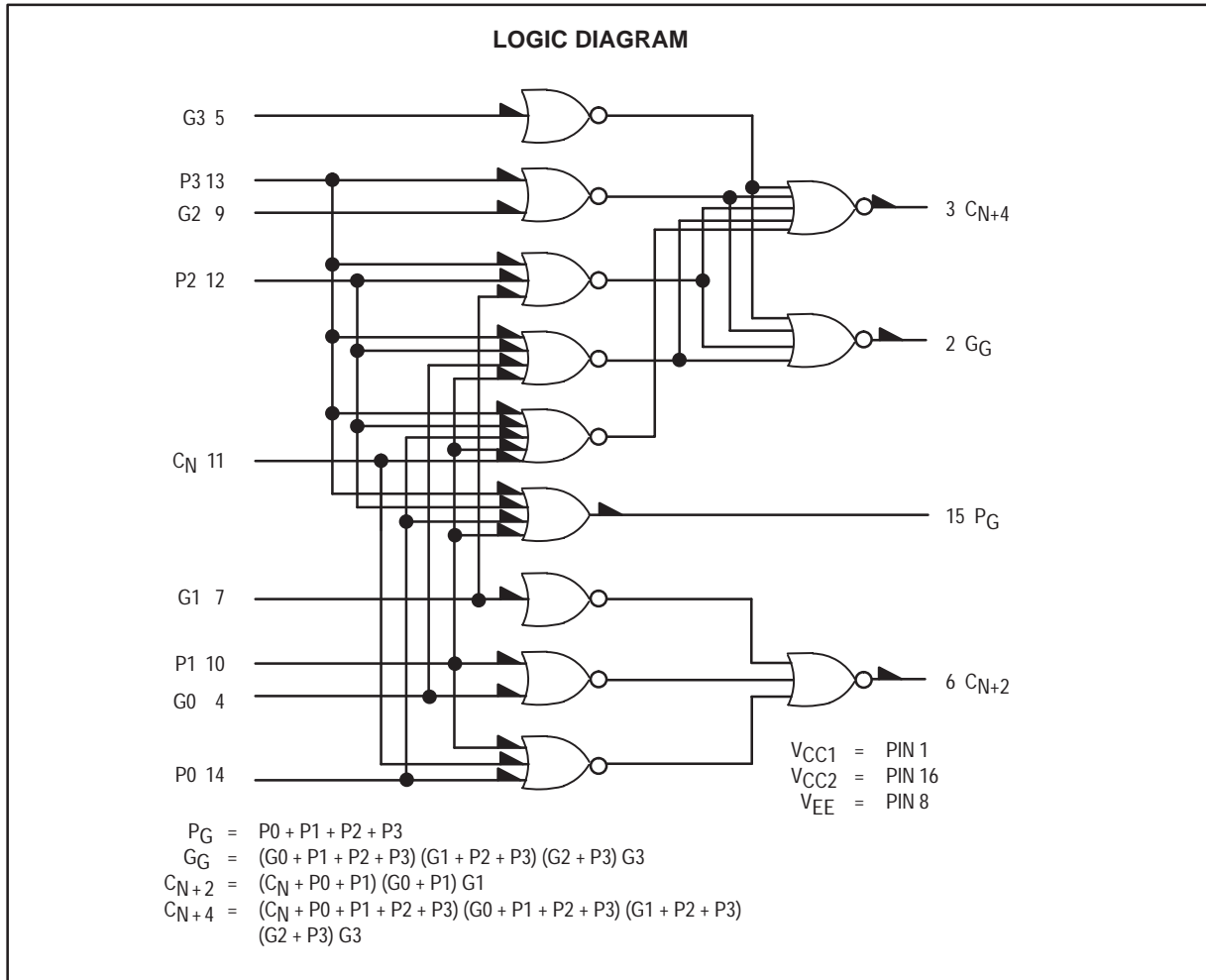
FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6-11.





TYPICAL APPLICATIONS

The MC10H179 is a high-speed, low-power, standard MECL complex function that is designed to perform the look-ahead carry function. This device can be used with the MC10H181 4-bit ALU directly, or with the MC10H180 dual arithmetic unit in any computer, instrumentation or digital communication application requiring high speed arithmetic operation on long words.

When used with the MC10H181, the MC10H179 performs a second order or higher look-ahead. Figure 2

shows a 16-bit look-ahead carry arithmetic unit. Second order carry is valuable for longer binary words. As an example, addition of two 32-bit words is improved from 30 nanoseconds with ripple-carry techniques. A block diagram of a 32-bit ALU is shown in Figure 1. The MC10H179 may also be used in many other applications. It can, for example, reduce system package count when used to generate functions of several variables.

FIGURE 1 — 32-BIT ALU WITH CARRY LOOK-AHEAD

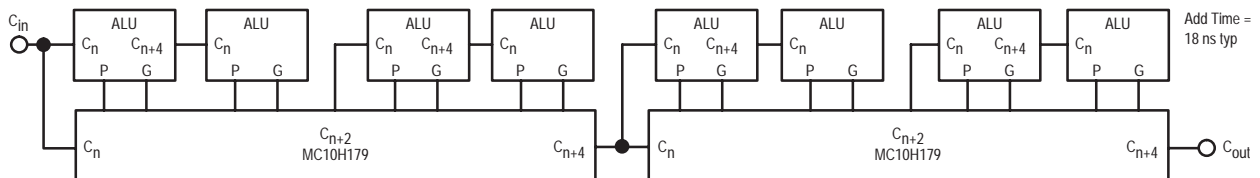
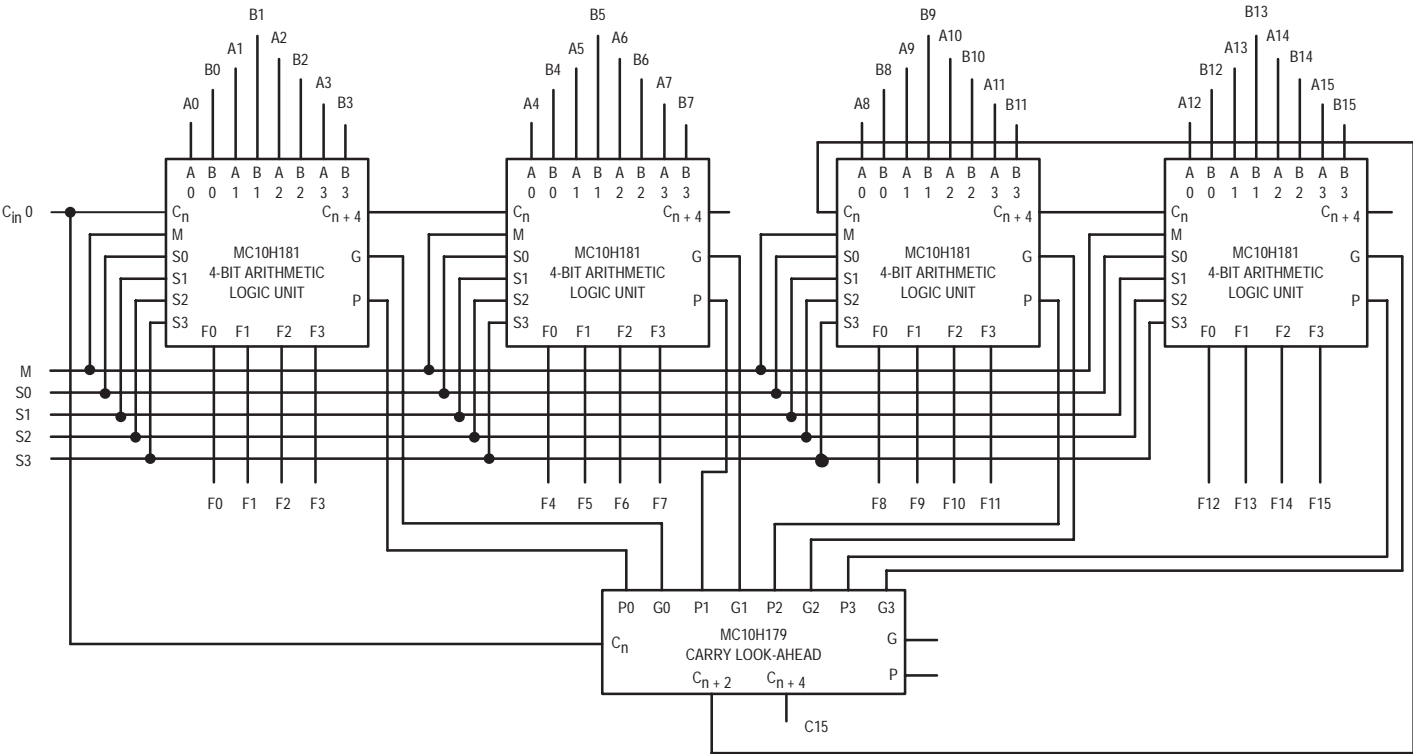


FIGURE 2 — 16-BIT FULL LOOK-AHEAD CARRY ARITHMETIC LOGIC UNIT



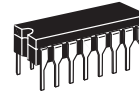
Dual 2-Bit Adder/Subtractor

The MC10H180 is a high-speed, low-power, general-purpose adder/subtractor. It is designed to be used in special purpose adders/subtractors or in high-speed multiplier arrays.

Inputs for each adder are Carry-in, Operand A, and Operand B; outputs are Sum, Sum and Carry-out. The common select inputs serve as a control line to Invert A for subtract, and a control line to Invert B.

- Propagation Delay, 1.8 ns Typical, Operand and Select to Output
- Power Dissipation, 360 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

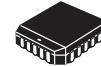
MC10H180



L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	95	—	86	—	95	mA
Input Current High Pins 4, 12	I_{inH}	—	665	—	417	—	417	μA
Input Current High Pins 7, 9		—	515	—	320	—	320	
Input Current High Pins 5, 6, 10, 11		—	410	—	255	—	255	
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage (1)	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage (1)	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

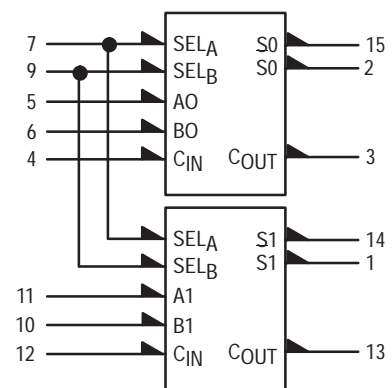
AC PARAMETERS

Propagation Delay	t_{pd}	0°	25°	75°	ns
Operand to Output		0.6	2.4	0.7	2.5
Select to Output		0.6	2.2	0.7	2.3
Carry-in to Output		0.4	1.6	0.4	1.7
Rise Time	t_r	0.5	2.0	0.5	2.1
Fall Time	t_f	0.5	2.0	0.5	2.2

NOTES:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

LOGIC DIAGRAM



$V_{CC} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

POSITIVE LOGIC ONLY

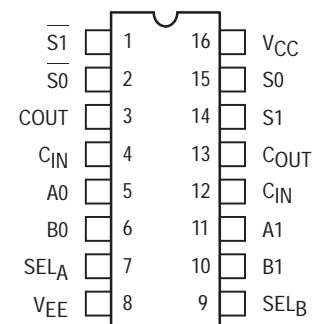
$$A' = A \oplus \text{SELA} = A \odot \text{SELA}$$

$$B' = B \oplus \text{SELB} = B \odot \text{SELB}$$

$$S = C_{IN} (A' B' + A' B) + C_{IN} (A' B' + A' B')$$

$$C_{OUT} = C_{IN} A' + C_{IN} B' + A' B'$$

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



FUNCTION SELECT TABLE

Sel _A	Sel _B	Function
H	H	S = A plus B
H	L	S = A minus B
L	H	S = B minus A
L	L	S = 0 minus A minus B

TRUTH TABLE

FUNCTION	INPUTS							C _{out}
	Sel _A	Sel _B	A ₀	B ₀	C _{in}	S ₀	$\overline{S_0}$	
ADD	H	H	L	L	L	L	H	L
	H	H	L	L	L	L	H	L
	H	H	L	L	H	L	H	L
	H	H	L	H	L	L	H	L
	H	H	L	H	H	L	H	L
	H	H	H	L	L	L	H	L
	H	H	H	L	H	L	H	L
	H	H	H	H	H	L	H	L
SUBTRACT	H	L	L	L	L	H	L	L
	H	L	L	L	L	L	H	L
	H	L	L	L	H	L	H	L
	H	L	L	L	H	L	H	L
	H	L	L	H	L	L	H	L
	H	L	L	H	H	L	H	L
	H	L	H	L	L	L	H	L
	H	L	H	H	H	L	H	L
REVERSE SUBTRACT	L	H	L	L	L	L	H	L
	L	H	L	L	L	L	L	H
	L	H	L	L	H	L	L	H
	L	H	L	L	H	L	L	H
	L	H	L	H	L	L	L	H
	L	H	L	H	H	L	L	H
	L	H	H	L	L	L	L	H
	L	H	H	L	L	L	L	H
	L	H	H	L	H	L	L	H
	L	H	H	H	L	L	L	H
	L	H	H	H	H	L	L	H
	L	L	L	L	L	L	H	L
	L	L	L	L	L	L	L	H
	L	L	L	L	H	L	L	L
	L	L	L	L	H	L	L	L
	L	L	L	H	L	L	L	L

4-Bit Arithmetic Logic Unit/ Function Generator

The MC10H181 is a high-speed arithmetic logic unit capable of performing 16 logic operations and 16 arithmetic operations on two four-bit words. Full internal carry is incorporated for ripple through operation.

Arithmetic logic operations are selected by applying the appropriate binary word to the select inputs (S0 through S3) as indicated in the tables of arithmetic/logic functions. Group carry propagate (PG) and carry generate (GG) are provided to allow fast operations on very long words using a second order look-ahead. The internal carry is enabled by applying a low level voltage to the mode control input (M).

When used with the MC10H179, full-carry look-ahead, as a second order look-ahead block, the MC10H181 provides high-speed arithmetic operations on very long words.

This 10H part is a functional/pinout duplication of the standard MECL 10K family part with 100% improvement in propagation delay and no increase in power supply current.

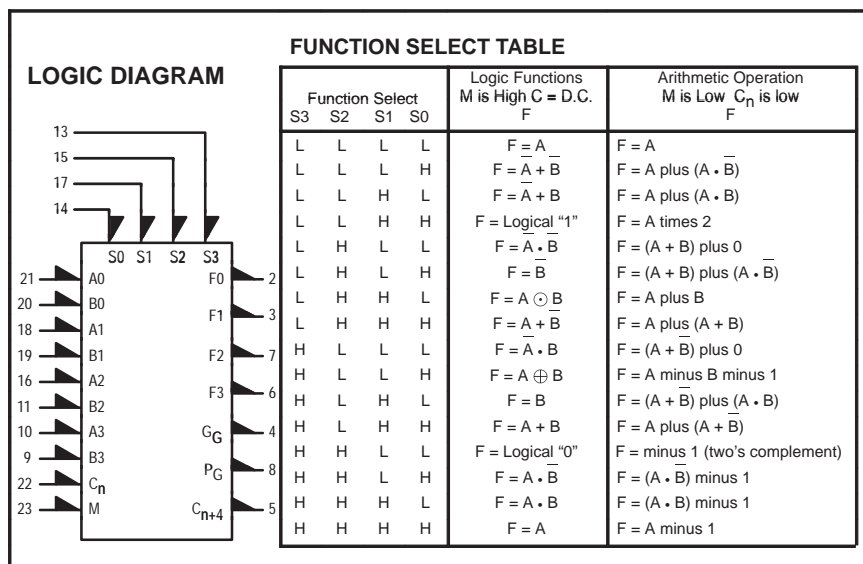
- Improved Noise Margin, 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K – Compatible

MAXIMUM RATINGS

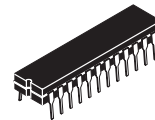
Characteristic	Symbol	Rating	Unit
Power Supply (V _{CC} = 0)	V _{EE}	-8.0 to 0	Vdc
Input Voltage (V _{CC} = 0)	V _I	0 to V _{EE}	Vdc
Output Current — Continuous	I _{out}	50	mA
— Surge		100	
Operating Temperature Range	T _A	0 to +75	°C
Storage Temperature Range — Plastic	T _{stg}	-55 to +150	°C
— Ceramic		-55 to +165	°C

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.



MC10H181



L SUFFIX
CERAMIC PACKAGE
CASE 758-02

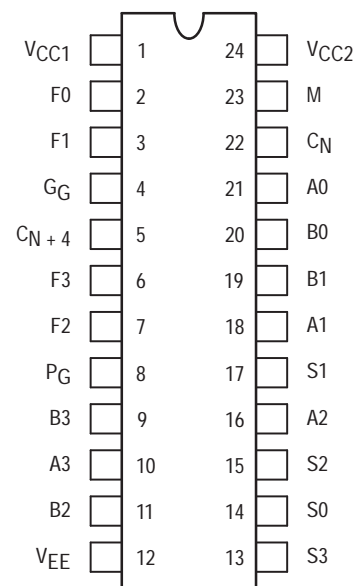


P SUFFIX
PLASTIC PACKAGE
CASE 724-03



FN SUFFIX
PLCC
CASE 776-02

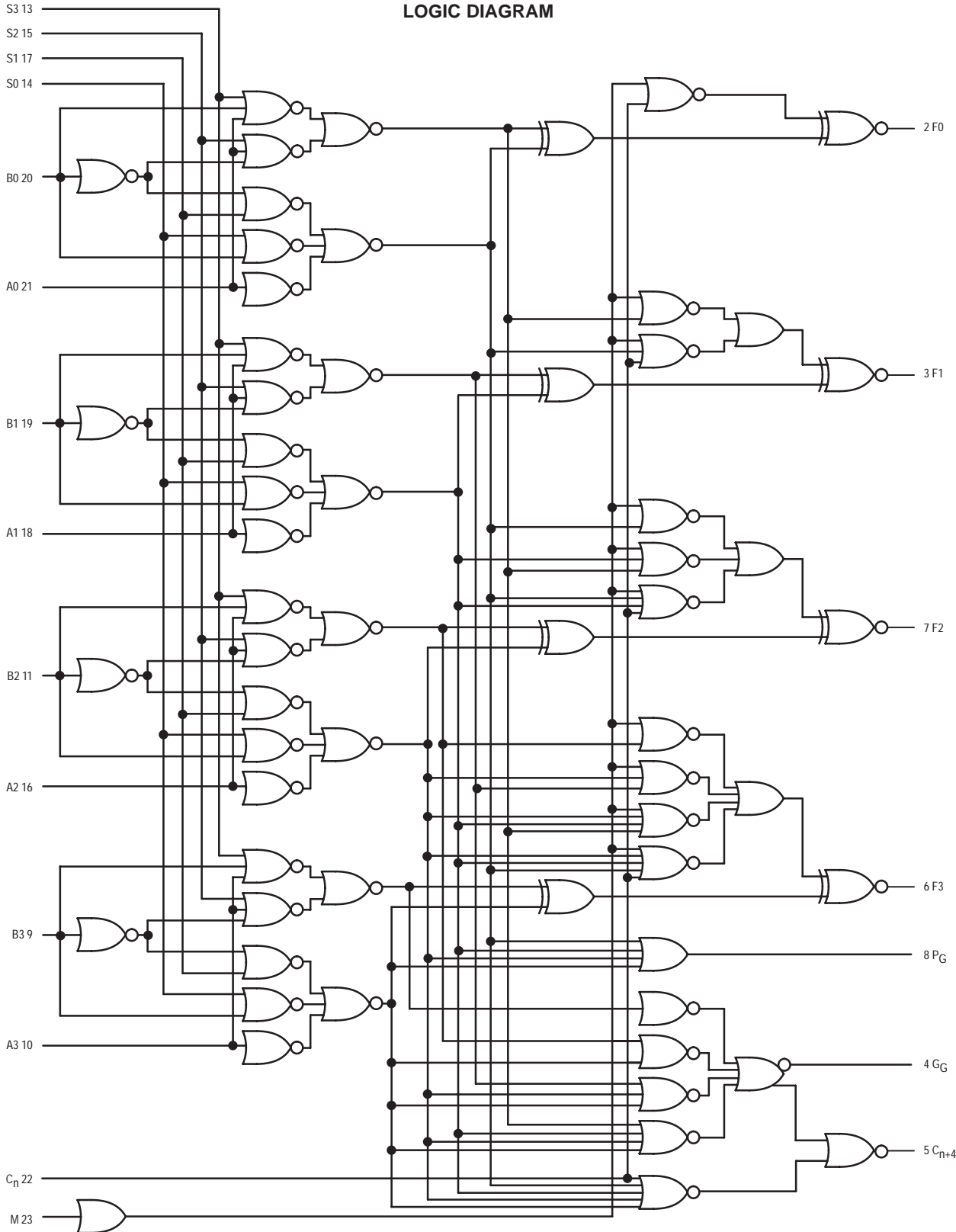
DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6-11.



LOGIC DIAGRAM



V_{CC1} = Pin 1
V_{CC2} = Pin 24
V_{EE} = Pin 12

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2\text{ V} \pm 5.0\%$) (See Note)

Characteristic	Symbol	0°		+25°		+75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	159	—	145	—	159	mA
Input Current High Pin 22 Pins 14,23 Pins 13,15,17 Pins 10,16,18,21 Pins 9,11,19,20	I_{inH}	—	720 405 515 475 465	—	450 255 320 300 275	—	450 255 320 300 275	μA
Input Current Low Pins 9–11, 13–22	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

AC PARAMETERS

Characteristic	Symbol	Input	Output	Conditions †	AC Switching Characteristics						Unit
					0°C		+25°C		+75°C		
					Min	Max	Min	Max	Min	Max	
Propagation Delay Rise Time, Fall Time	t_{+}, t_{-} t_{+}, t_{-}	C_n C_n	C_{n+4} C_{n+4}	A0,A1,A2,A3 A0,A1,A2,A3	0.7 0.6	2.0 2.0	0.7 0.6	2.0 2.0	0.7 0.7	2.2 2.2	ns ns
Propagation Delay Rise Time, Fall Time	t_{+}, t_{+}, t_{-} t_{-}, t_{-}, t_{-} t_{+}, t_{-}	C_n C_n C_n	F1 F1 F1	A0	1.0 0.7	3.0 2.2	1.0 0.7	3.0 2.2	1.2 0.7	3.3 2.4	ns
Propagation Delay Rise Time, Fall Time	t_{+}, t_{+}, t_{-} t_{-}, t_{-}, t_{-} t_{+}, t_{-}	A1 A1 A1	F1 F1 F1		1.5 0.7	3.7 2.0	1.5 0.7	3.7 2.0	1.6 0.7	4.0 2.2	ns
Propagation Delay Rise Time, Fall Time	t_{+}, t_{-} t_{+}, t_{-}	A1 A1	P_G P_G	S0,S3 S0,S3	1.5 0.9	3.7 2.4	1.5 0.9	3.7 2.4	1.6 0.9	4.0 2.6	ns ns
Propagation Delay Rise Time, Fall Time	t_{+}, t_{-} t_{+}, t_{-}	A1 A1	G_G G_G	A0,A2,A3, C_n A0,A2,A3, C_n	1.5 0.7	3.7 2.2	1.5 0.7	3.7 2.2	1.6 0.7	3.9 2.4	ns ns
Propagation Delay Rise Time, Fall Time	t_{-}, t_{+} t_{+}, t_{-}	A1 A1	C_{n+4} C_{n+4}	A0,A2,A3, C_n A0,A2,A3, C_n	1.5 0.5	3.6 2.0	1.5 0.5	3.6 2.0	1.6 0.5	3.9 2.2	ns ns
Propagation Delay Rise Time, Fall Time	t_{+}, t_{+} t_{+}, t_{-}	B1 B1	F1 F	S3, C_n S3, C_n	2.0 0.7	4.5 2.3	2.0 0.7	4.5 2.3	2.1 0.7	4.8 2.5	ns ns
Propagation Delay Rise Time, Fall Time	t_{+}, t_{-} t_{+}, t_{-}	B1 B1	P_G P_G	S0,A1 S0,A1	1.5 0.7	3.8 2.2	1.5 0.7	3.8 2.2	1.6 0.7	4.0 2.4	ns ns
Propagation Delay Rise Time, Fall Time	t_{+}, t_{-} t_{+}, t_{-}	B1 B1	G_G G_G	S3, C_n S3, C_n	1.5 0.7	3.7 2.2	1.5 0.7	3.7 2.2	1.6 0.7	4.0 2.4	ns ns
Propagation Delay Rise Time, Fall Time	t_{-}, t_{+} t_{+}, t_{-}	B1 B1	C_{n+4} C_{n+4}	S3, C_n S3, C_n	2.0 0.5	4.0 2.0	2.0 0.5	4.0 2.2	2.1 0.5	4.3 2.2	ns ns
Propagation Delay Rise Time, Fall Time	t_{+}, t_{+} t_{+}, t_{-}	M M	F1 F1	— —	1.5 0.8	4.2 2.3	1.5 0.8	4.2 2.3	1.6 0.8	4.5 2.5	ns ns
Propagation Delay Rise Time, Fall Time	t_{-}, t_{+} t_{+}, t_{-}	S1 S1	F1 F1	A1,B1 A1,B1	1.5 0.7	4.5 2.0	1.5 0.7	4.5 2.0	1.6 0.7	4.8 2.2	ns ns
Propagation Delay Rise Time, Fall Time	t_{-}, t_{+} t_{+}, t_{-}	S1 S1	P_G P_G	A3,B3 A3,B3	1.5 0.7	4.0 2.0	1.5 0.7	4.0 2.2	1.6 0.7	4.3 2.4	ns ns
Propagation Delay Rise Time, Fall Time	t_{-}, t_{+} t_{+}, t_{-}	S1 S1	C_{n+4} C_{n+4}	A3,B3 A3,B3	1.5 0.7	4.1 2.2	1.5 0.7	4.1 2.2	1.6 0.7	4.4 2.4	ns ns
Propagation Delay Rise Time, Fall Time	t_{-}, t_{+} t_{+}, t_{-}	S1 S1	G_G G_G	A3,B3 A3,B3	1.3 0.5	4.5 3.2	1.3 0.5	4.5 3.2	1.4 0.5	4.8 3.4	ns ns

† Logic high level (+1.11 Vdc) applied to pins listed. All other input pins are left floating or tied to +0.31 Vdc.
 $V_{CC1} = V_{CC2} = +2.0\text{ Vdc}$, $V_{EE} = -3.2\text{ Vdc}$

Hex D Master-Slave Flip-Flop with Reset

The MC10H186 is a hex D type flip-flop with common reset and clock lines. This MECL 10H part is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in clock toggle frequency and propagation delay and no increase in power-supply current.

- Propagation Delay, 1.7 ns Typical
- Power Dissipation, 460 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C °C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	121	—	110	—	121	mA
Input Current High Pins 5,6,7,10,11,12 Pin 9 Pin 1	I_{inH}	—	430 670 1250	—	265 420 765	—	265 420 765	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

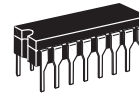
AC PARAMETERS

Characteristic	Symbol	0.7	3.0	0.7	3.0	0.7	3.0	ns
Propagation Delay	t_{pd}	0.7	3.0	0.7	3.0	0.7	3.0	ns
Set-up Time	t_{set}	1.5	—	1.5	—	1.5	—	ns
Hold Time	t_{hold}	1.0	—	1.0	—	1.0	—	ns
Rise Time	t_r	0.7	2.6	0.7	2.6	0.7	2.6	ns
Fall Time	t_f	0.7	2.6	0.7	2.6	0.7	2.6	ns
Toggle Frequency	f_{tog}	250	—	250	—	250	—	MHz
Reset Recovery Time (t_{1-9+})	t_{rr}	3.0	—	3.0	—	3.0	—	ns

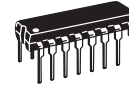
NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

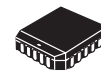
MC10H186



L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08



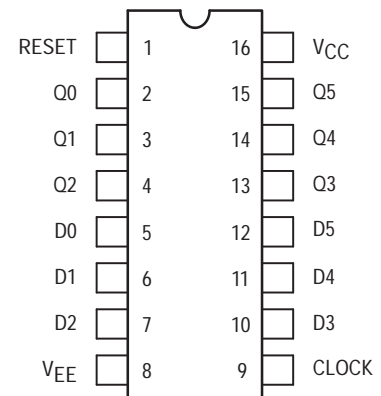
FN SUFFIX
PLCC
CASE 775-02

CLOCKED TRUTH TABLE

R	C	D	Qn+1
L	L	X	Qn
L	H*	L	L
L	H*	H	H
H	L	X	L

* A clock H is a clock transition from a low to a high state.

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.

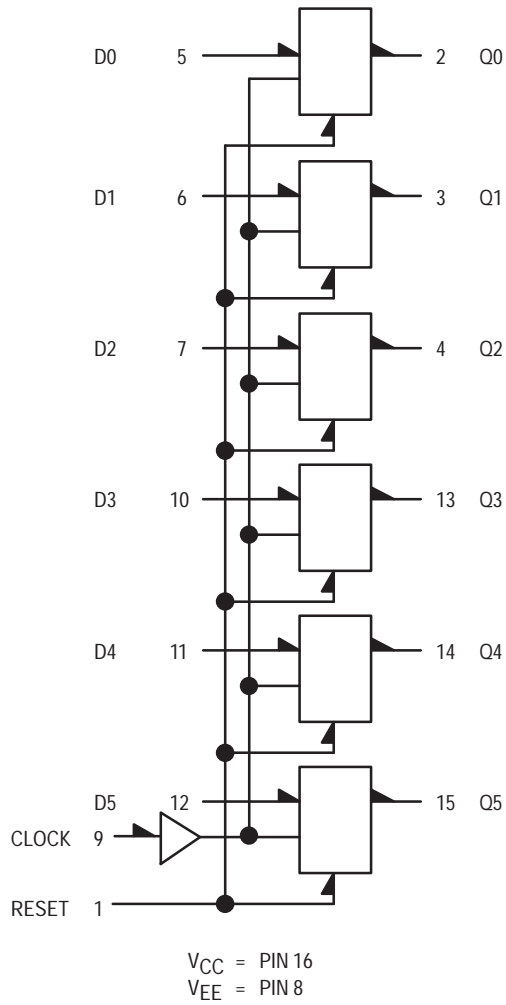


APPLICATION INFORMATION

The MC10H186 contains six high-speed, master slave type "D" flip-flops. Data is entered into the master when the clock is low. Master-to-slave data transfer takes place on the positive-going Clock transition. Thus outputs may change only on a positive-going Clock

transition. A change in the information present at the data (D) input will not affect the output information any other time due to the master-slave construction of this device. A common Reset is included in this circuit. **THE RESET ONLY FUNCTIONS WHEN THE CLOCK IS LOW.**

LOGIC DIAGRAM



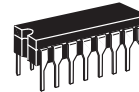
Hex Buffer with Enable

The MC10H188 is a high-speed Hex Buffer with a common Enable input. When Enable is in the high-state, all outputs are in the low-state. When Enable is in the low-state, the outputs take the same state as the inputs.

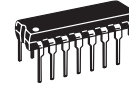
This MECL 10H part is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in propagation delay and no increase in power-supply current.

- Propagation Delay, 1.3 ns Typical Data-to-Output
- Power Dissipation 180 mW Typ/Pkg (No Load)
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MC10H188



L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	46	—	42	—	46	mA
Input Current High	I_{inH}	—	495	—	310	—	310	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

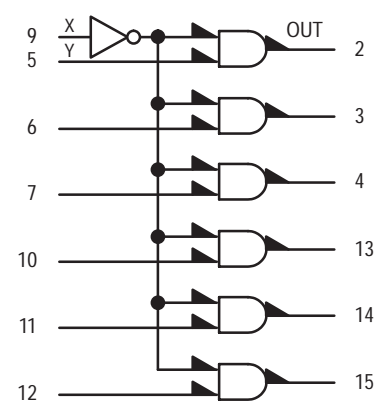
AC PARAMETERS

Propagation Delay	t_{pd}	0.7	2.2	0.7	2.2	0.7	2.2	ns
Enable		0.7	2.2	0.7	2.2	0.7	2.2	
Data		0.7	1.9	0.7	1.9	0.7	1.9	
Rise Time	t_r	0.7	2.4	0.7	2.4	0.7	2.4	ns
Fall Time	t_f	0.7	2.4	0.7	2.4	0.7	2.4	ns

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

LOGIC DIAGRAM

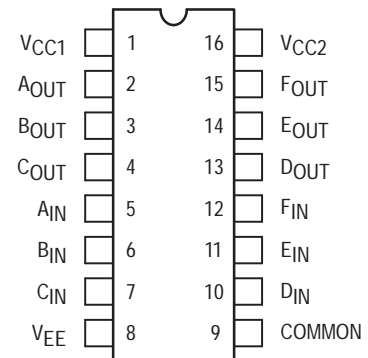


TRUTH TABLE

Inputs	Output	
X	Y	OUT
L	L	L
L	H	H
H	L	L
H	H	L

$V_{CC1} = \text{Pin } 1$
 $V_{CC2} = \text{Pin } 16$
 $V_{EE} = \text{Pin } 8$

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



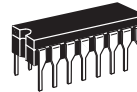
Hex Inverter with Enable

The MC10H189 is a Hex Inverter with a common Enable input. The hex inverting function is provided when Enable is in the low-state. When Enable is in the high-state, all outputs are low.

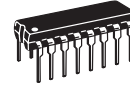
This MECL 10H part is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in propagation delay and no increase in power-supply current.

- Propagation Delay, 1.3 ns Typical Data-to-Output
- Power Dissipation 180 mW Typ/Pkg (No Load)
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MC10H189



L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C °C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	46	—	42	—	46	mA
Input Current High	I_{inH}	—	495	—	310	—	310	µA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	µA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

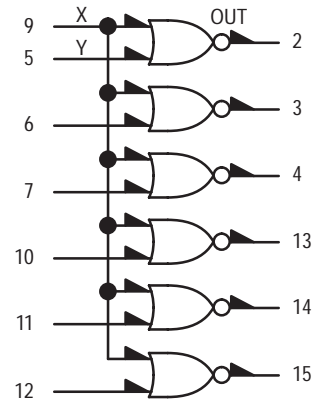
AC PARAMETERS

Characteristic	Symbol	0°	25°	75°	Unit
Propagation Delay Enable Data	t_{pd}	0.7	2.2	0.7	2.3
		0.7	1.9	0.7	1.9
Rise Time	t_r	0.7	2.4	0.7	2.4
Fall Time	t_f	0.7	2.4	0.7	2.4

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

LOGIC DIAGRAM

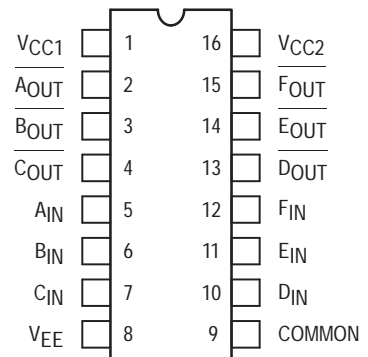


TRUTH TABLE

Inputs		Output
X	Y	OUT
L	L	H
L	H	L
H	L	L
H	H	L

$V_{CC1} = \text{Pin } 1$
 $V_{CC2} = \text{Pin } 16$
 $V_{EE} = \text{Pin } 8$

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6-11.

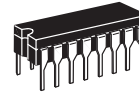


Dual 4-5-Input OR/NOR Gate

The MC10H209 is a Dual 4–5–input OR/NOR gate. This MECL part is a functional/pinout duplication of the MECL III part MC1688.

- Propagation Delay Average, 0.75 ns Typical
- Power Dissipation 125 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K–Compatible

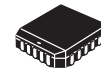
MC10H209



L SUFFIX
CERAMIC PACKAGE
CASE 620–10



P SUFFIX
PLASTIC PACKAGE
CASE 648–08



FN SUFFIX
PLCC
CASE 775–02

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	–8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	–55 to +150 –55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2\text{ V} \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	—	—	30	—	—	mA
Input Current High	I_{inH}	—	640	—	400	—	400	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	–1.02	–0.84	–0.98	–0.81	–0.92	–0.735	Vdc
Low Output Voltage	V_{OL}	–1.95	–1.63	–1.95	–1.63	–1.95	–1.60	Vdc
High Input Voltage	V_{IH}	–1.17	–0.84	–1.13	–0.81	–1.07	–0.735	Vdc
Low Input Voltage	V_{IL}	–1.95	–1.48	–1.95	–1.48	–1.95	–1.45	Vdc

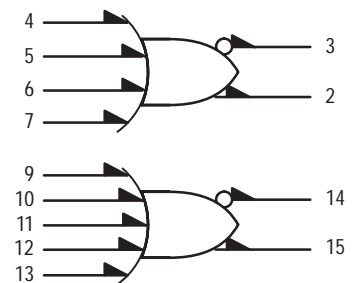
AC PARAMETERS

Characteristic	Symbol	0.4	1.15	0.4	1.15	0.4	1.15	ns
Propagation Delay	t_{pd}							
Rise Time	t_r							
Fall Time	t_f							

NOTE:

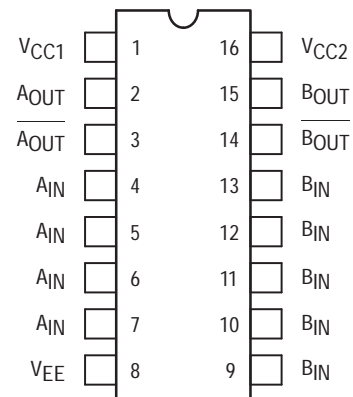
Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfm is maintained. Outputs are terminated through a 50–ohm resistor to –2.0 volts.

LOGIC DIAGRAM



$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

DIP PIN ASSIGNMENT



Pin assignment is for Dual–in–Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6–11.



Dual 3-Input 3-Output OR Gate

The MC10H210 is designed to drive up to six transmission lines simultaneously. The multiple outputs of this device also allow the wire "OR"-ing of several levels of gating for minimization of gate and package count.

The ability to control three parallel lines with minimum propagation delay from a single point makes the MC10H210 particularly useful in clock distribution applications where minimum clock skew is desired.

- Propagation Delay Average, 1.0 ns Typical
- Power Dissipation, 160 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current— Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range— Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	42	—	38	—	42	mA
Input Current High	I_{inH}	—	720	—	450	—	450	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

AC PARAMETERS

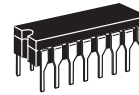
Propagation Delay	t_{pd}	0.5	1.55	0.55	1.55	0.6	1.7	ns
Rise Time	t_r	0.75	1.8	0.75	1.9	0.8	2.0	ns
Fall Time	t_f	0.75	1.8	0.75	1.9	0.8	2.0	ns

NOTE:

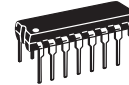
Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

Note: If crosstalk is present, double bypass capacitor to 0.2 μF.

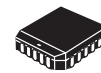
MC10H210



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

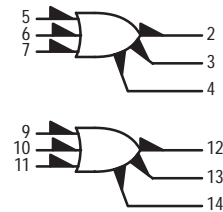


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



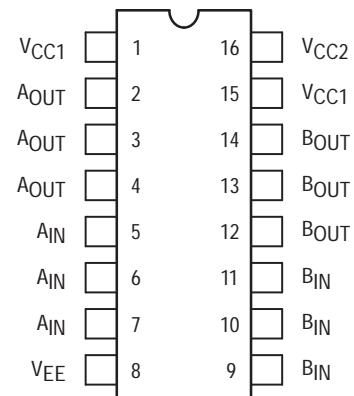
FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM



$V_{CC1} = \text{PINS } 1, 15$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6-11.



Dual 3-Input 3-Output NOR Gate

The MC10H211 is designed to drive up to six transmission lines simultaneously. The multiple outputs of this device also allow the wire "OR"-ing of several levels of gating for minimization of gate and package count.

The ability to control three parallel lines with minimum propagation delay from a single point makes the MC10H211 particularly useful in clock distribution applications where minimum clock skew is desired.

- Propagation Delay, 1.0 ns Typical
- Power Dissipation, 160 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current— Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range— Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	42	—	38	—	42	mA
Input Current High	I_{inH}	—	720	—	450	—	450	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

AC PARAMETERS

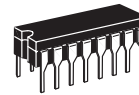
Characteristic	Symbol	0.7	1.6	0.7	1.6	0.7	1.7	ns
Propagation Delay	t_{pd}							
Rise Time	t_r	0.9	2.0	0.9	2.2	0.9	2.4	ns
Fall Time	t_f	0.9	2.0	0.9	2.2	0.9	2.4	ns

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

Note: If crosstalk is present, double bypass capacitor to 0.2 μF .

MC10H211



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

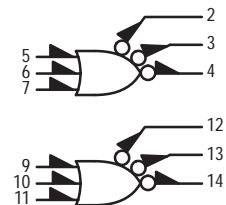


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



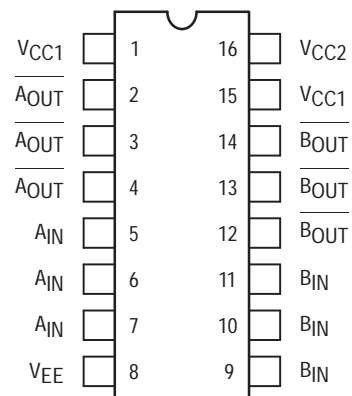
FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM



$V_{CC1} = \text{PINS } 1, 15$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



Quad Bus Driver/Receiver with 2-to-1 Output Multiplexers

The MC10H330 is a Quad Bus Driver/Receiver with two-to-one output multiplexers. These multiplexers have a common select and output enable. When disabled, (OE = high) the bus outputs go to -2.0 V. Their output can be brought to a low state (V_{OL}) by applying a high level to the receiver enable (RE = High). The parameters specified are with $25\ \Omega$ loading on the bus drivers and $50\ \Omega$ loads on the receivers.

- Propagation Delay, 1.5 ns Typical Data-to-Output
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C °C

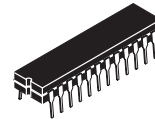
ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2\text{ V} \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	157	—	143	—	157	mA
Input Current High Pins 5-8, 17-20 Pins 16, 21 Pin 9	I_{inH}	—	667 514 475	—	417 321 297	—	417 321 297	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

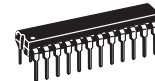
AC PARAMETERS

Characteristic	Symbol	1.8	5.3	1.8	5.3	1.8	5.3	Unit
Propagation Delay Select-to-Input	t_{pd}	1.8	5.3	1.8	5.3	1.8	5.3	ns
Data-to-Bus Output Select-to-Bus _Output		0.5	2.0	0.5	2.0	0.5	2.0	
OE-to-Bus Output		1.0	3.2	1.0	3.2	1.0	3.2	
Bus-to-Input		0.8	2.2	0.8	2.2	0.8	2.2	
RE-to-Input		0.8	2.1	0.8	2.1	0.8	2.4	
Data-to-Receiver Input		0.5	2.2	0.5	2.2	0.5	2.2	
Rise Time	t_r	1.3	4.0	1.3	4.0	1.3	4.0	ns
Fall Time	t_f	0.5	2.0	0.5	2.0	0.5	2.0	ns

MC10H330



L SUFFIX
CERAMIC PACKAGE
CASE 758-02

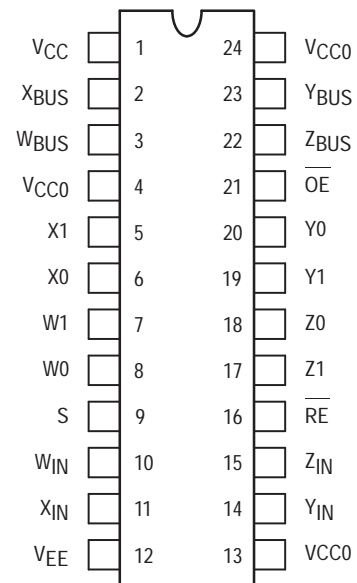


P SUFFIX
PLASTIC PACKAGE
CASE 724-03



FN SUFFIX
PLCC
CASE 776-02

DIP PIN ASSIGNMENT



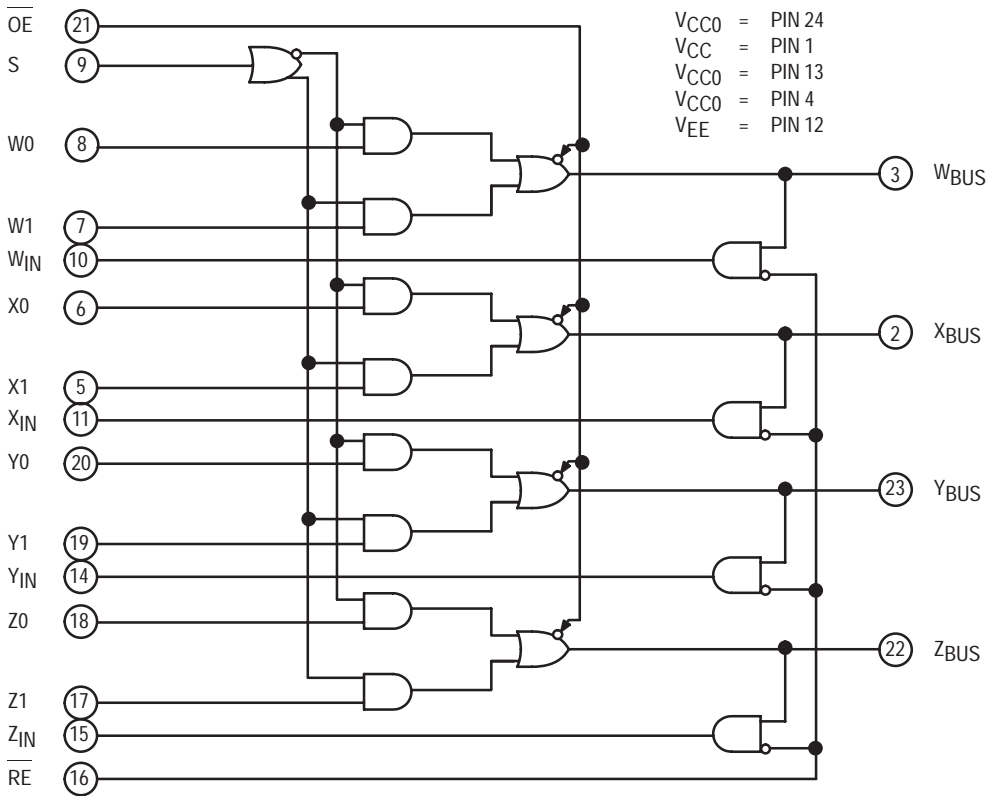
Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6-11.

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lpm is maintained. Receiver outputs are terminated through a 50-ohm resistor to -2.0 volts dc. Bus outputs are terminated through a 25-ohm resistor to -2.0 volts dc.



LOGIC DIAGRAM



MULTIPLEXER TRUTH TABLE

OE	S	W _{Bus}	X _{Bus}	Y _{Bus}	Z _{Bus}
H	X	-2.0 V	-2.0 V	-2.0 V	-2.0 V
L	L	W ₀	X ₀	Y ₀	Z ₀
L	H	W ₁	X ₁	Y ₁	Z ₁

RECEIVER TRUTH TABLE

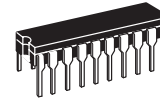
RE	W _{in}	X _{in}	Y _{in}	Z _{in}
H	L	L	L	L
L	W _{Bus}	X _{Bus}	Y _{Bus}	Z _{Bus}

Dual Bus Driver/Receiver with 4-to-1 Output Multiplexers

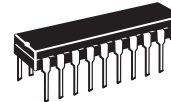
MC10H332

The MC10H332 is a Dual Bus Driver/Receiver with four-to-one output multiplexers. These multiplexers have common selects and output enable. When disabled, (OE = high) the bus outputs go to -2.0 V. The parameters specified are with 25 Ω loading on the bus drivers and 50 Ω loads on the receivers.

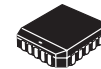
- Propagation Delay, 1.5 ns Typical Data-to-Output
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible



L SUFFIX
CERAMIC PACKAGE
CASE 732-03



P SUFFIX
PLASTIC PACKAGE
CASE 738-03



FN SUFFIX
PLCC
CASE 775-02

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C °C

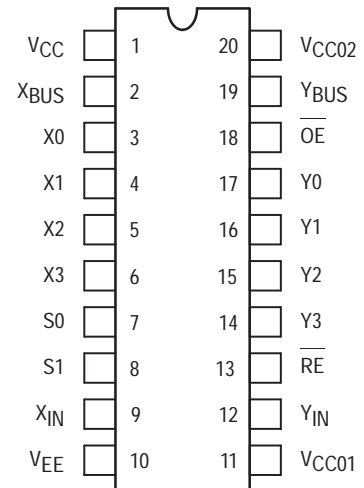
ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	115	—	110	—	115	mA
Input Current High Pins 3,4,5,6,14, 15,16,17 Pins 7,8 Pins 13, 18	I_{inH}	—	667 437 456	—	417 273 285	—	417 273 285	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

AC PARAMETERS

Characteristic	Symbol	0°	25°	75°	Unit			
Propagation Delay Data-to-Bus Output Select-to-Bus _Output	t_{pd}	0.8	3.0	0.8	3.0	0.8	3.2	ns
OE-to-Bus Output		0.8	3.4	0.8	3.4	0.8	3.8	
Bus-to-Receiver		0.8	2.4	0.8	2.4	0.8	2.6	
Select-to-Receiver		0.8	2.1	0.8	2.1	0.8	2.4	
RE-to-Receiver		1.8	4.5	1.8	4.5	1.8	5.0	
Data-to-Receiver		0.8	2.2	0.8	2.2	0.8	2.5	
		1.3	4.0	1.3	4.0	1.3	4.5	
Rise Time	t_r	0.5	2.0	0.5	2.0	0.5	2.1	ns
Fall Time	t_f	0.5	2.0	0.5	2.0	0.5	2.1	ns

DIP & PLCC PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6-11.

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lpm is maintained. Receiver outputs are terminated through a 50-ohm resistor to -2.0 volts dc. Bus outputs are terminated through a 25-ohm resistor to -2.0 volts dc.



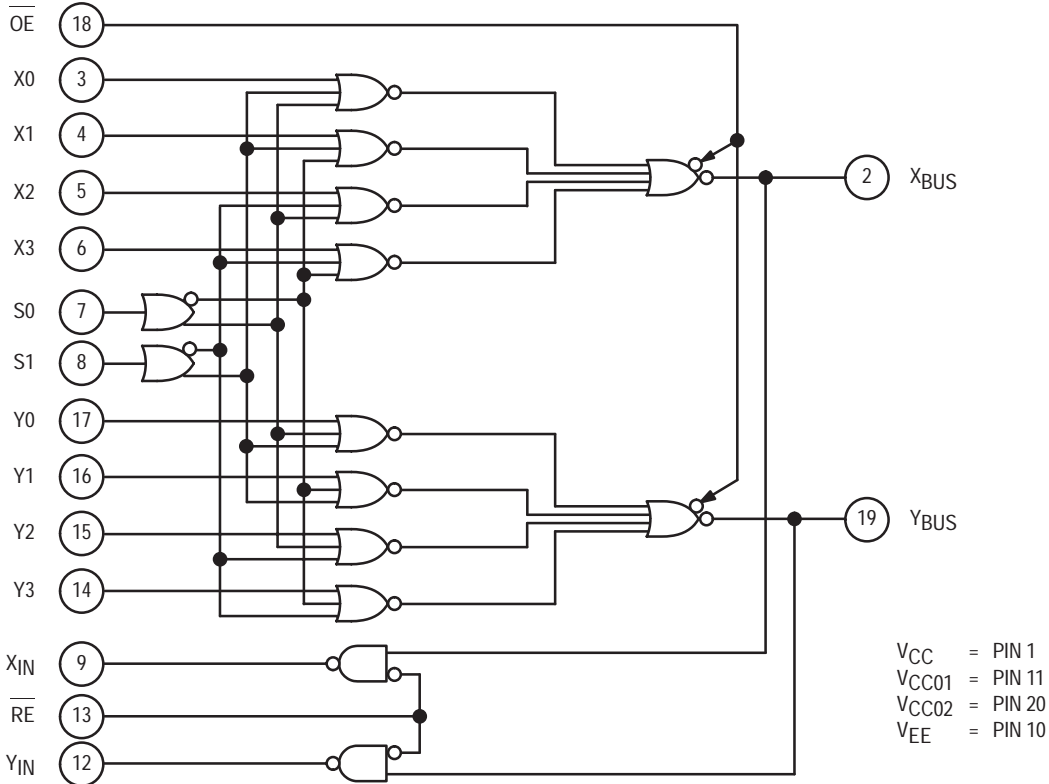
MULTIPLEXER TRUTH TABLE

OE	S1	S0	X _{Bus}	Y _{Bus}
H	X	X	-2.0V	-2.0V
L	L	L	X0	Y0
L	L	H	X1	Y1
L	H	L	X2	Y2
L	H	H	X3	Y3

RECEIVER TRUTH TABLE

RE	X _{in}	Y _{in}
H	L	L
L	X _{Bus}	Y _{Bus}

LOGIC DIAGRAM

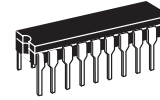


Quad Bus Driver/Receiver with Transmit and Receiver Latches

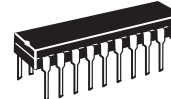
MC10H334

The MC10H334 is a Quad Bus Driver/Receiver with transmit and receiver latches. When disabled, (OE = high) the bus outputs will fall to -2.0 V. Data to be transmitted or received is passed through its respective latch when the respective latch enable (DLE and RLE) is at a low level. Information is latched on the positive transition of DLE and RLE. The parameters specified are with 25 Ω loading on the bus drivers and 50 Ω loads on the receivers.

- Propagation Delay, 1.6 ns Typical Data-to-Output
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible



L SUFFIX
CERAMIC PACKAGE
CASE 732-03



P SUFFIX
PLASTIC PACKAGE
CASE 738-03



FN SUFFIX
PLCC
CASE 775-02

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current— Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range— Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C

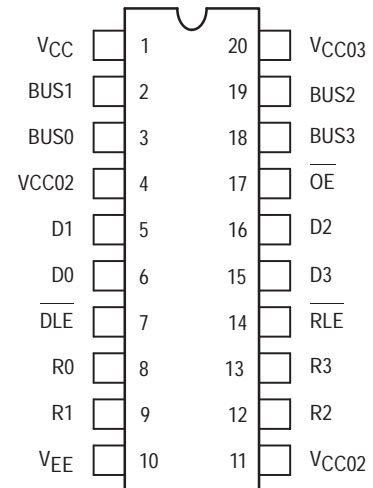
ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 V \pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	161	—	161	—	161	mA
Input Current High Pins 5,6,15,16 Pins 7,14 Pin 17	I_{inH}	—	397 460 520	—	273 297 357	—	273 297 357	μA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μA
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

AC PARAMETERS

Characteristic	Symbol	0.5	2.5	0.5	2.5	0.5	2.5	ns
Propagation Delay Data-to-Bus Output DLE-to-Bus Output OE-to-Bus Output Bus-to-R0 RLE-to-R0 Data-to-Receiver R0	t_{pd}	0.5	2.5	0.5	2.5	0.5	2.5	ns
Rise Time	t_r	0.5	2.2	0.5	2.2	0.5	2.2	
Fall Time	t_f	0.5	2.2	0.5	2.2	0.5	2.2	

DIP & PLCC PIN ASSIGNMENT



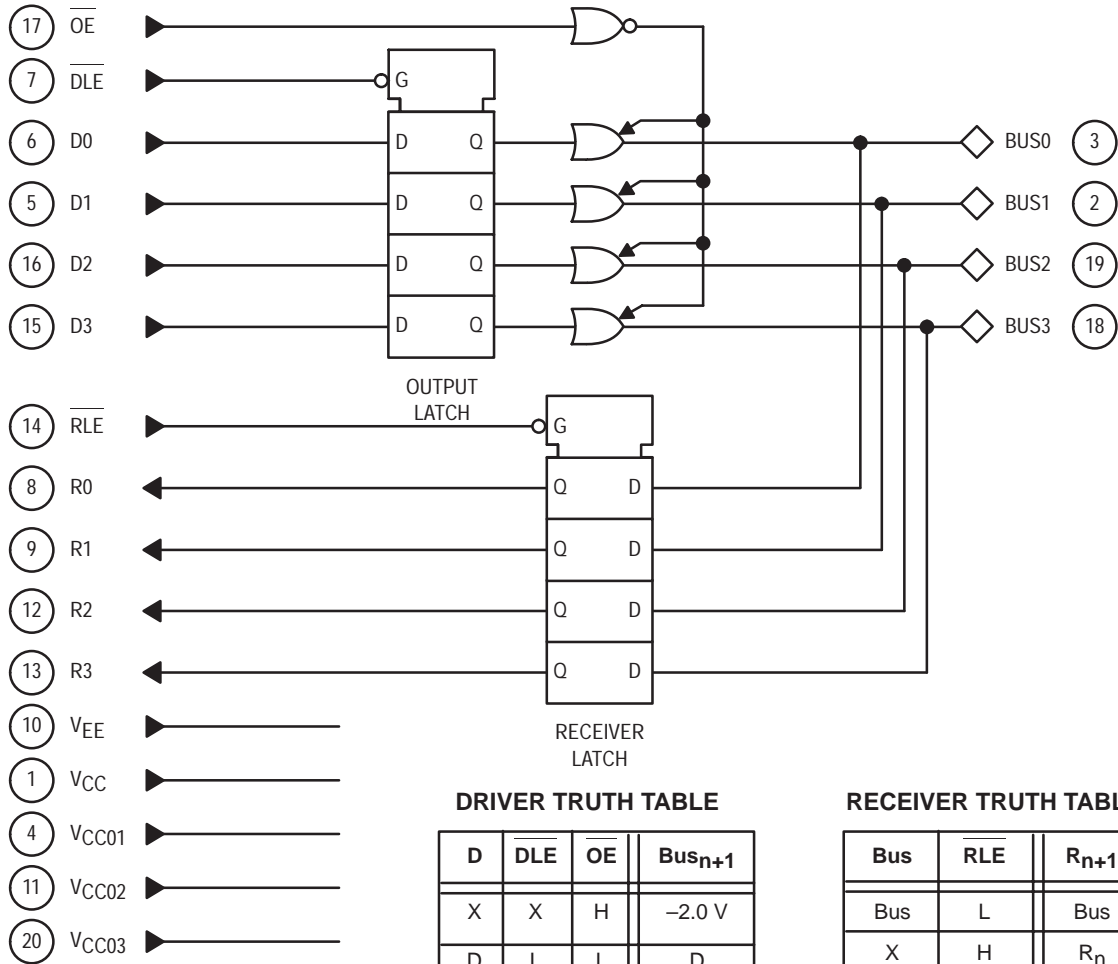
Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6-11.

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lpm is maintained. Receiver outputs are terminated through a 50-ohm resistor to -2.0 volts dc. Bus outputs are terminated through a 25-ohm resistor to -2.0 volts dc.



LOGIC DIAGRAM



DRIVER TRUTH TABLE

D	DLE	OE	Bus _{n+1}
X	X	H	-2.0 V
D	L	L	D
X	H	L	Bus _n

RECEIVER TRUTH TABLE

Bus	RLE	R _{n+1}
Bus	L	Bus
X	H	R _n

PECL* to TTL Translator (+5 Vdc Power Supply Only)

The MC10H350 is a member of Motorola's 10H family of high performance ECL logic. It consists of 4 translators with differential inputs and TTL outputs. The 3-state outputs can be disabled by applying a HIGH TTL logic level on the common OE input.

The MC10H350 is designed to be used primarily in systems incorporating both ECL and TTL logic operating off a common power supply. The separate V_{CC} power pins are not connected internally and thus isolate the noisy TTL V_{CC} runs from the relatively quiet ECL V_{CC} runs on the printed circuit board. The differential inputs allow the H350 to be used as an inverting or noninverting translator, or a differential line receiver. The H350 can also drive CMOS with the addition of a pullup resistor.

- Propagation Delay, 3.5 ns Typical
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{EE} = \text{Gnd}$)	V_{CC}	7.0	Vdc
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic	T_{stg}	-55 to +150	°C
— Ceramic		-55 to +165	°C

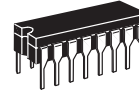
ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.0 \text{ V} \pm 5\%$) (See Note 1)

Characteristic	Symbol	$T_A = 0^\circ\text{C to } 75^\circ\text{C}$		Unit
		Min	Max	
Power Supply Current TTL ECL	I_{CC}	—	20 12	mA
Input Current High	Pin 9 I_{IH} Others I_{INH}	—	20 50	μA
Input Current Low	Pin 9 I_{IL} Others I_{INL}	—	-0.6 50	mA μA
Input Voltage High	Pin 9 V_{IH}	2.0	—	Vdc
Input Voltage Low	Pin 9 V_{IL}	—	0.8	Vdc
Differential Input Voltage (1) Pins 3-6, 11-14 (1)	V_{DIFF}	350	—	mV
Voltage Common Mode Pins 3-6, 11-14	V_{CM}	2.8	V_{CC}	Vdc
Output Voltage High $I_{OH} = 3.0 \text{ mA}$	V_{OH}	2.7	—	Vdc
Output Voltage Low $I_{OL} = 20 \text{ mA}$	V_{OL}	—	0.5	Vdc
Short Circuit Current $V_{OUT} = 0 \text{ V}$	I_{OS}	-60	-150	mA
Output Disable Current High $V_{OUT} = 2.7 \text{ V}$	I_{OZH}	—	50	μA
Output Disable Current Low $V_{OUT} = 0.5 \text{ V}$	I_{OZL}	—	-50	μA

- (1) Common mode input voltage to pins 3-4, 5-6, 11-12, 13-14 must be between the values of 2.8 V and 5.0 V. This common mode input voltage range includes the differential input swing.
- (2) For single ended use, apply 3.75 V (V_{BB}) to either input depending on output polarity required. Signal level range to other input is 3.3 V to 4.2 V.
- (3) Any unused gates should have the inverting inputs tied to V_{CC} and the non-inverting inputs tied to ground to prevent output glitching.
- (4) 1.0 V to 2.0 V w/50 pF into 500 ohms.

*Positive Emitter Coupled Logic

MC10H350



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

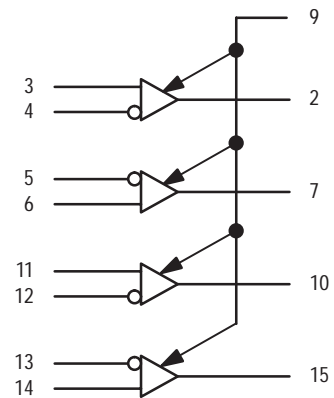


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



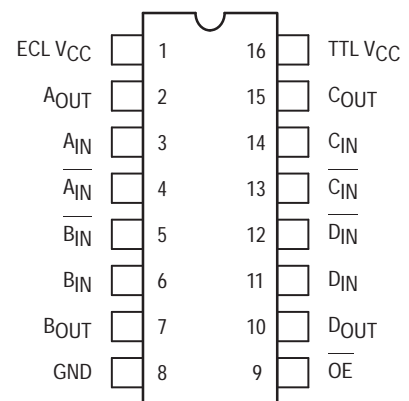
FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM



$V_{CC} (+5.0 \text{ VDC}) = \text{PINS 1 AND 16}$
 $\text{GND} = \text{PIN 8}$

DIP PIN ASSIGNMENT



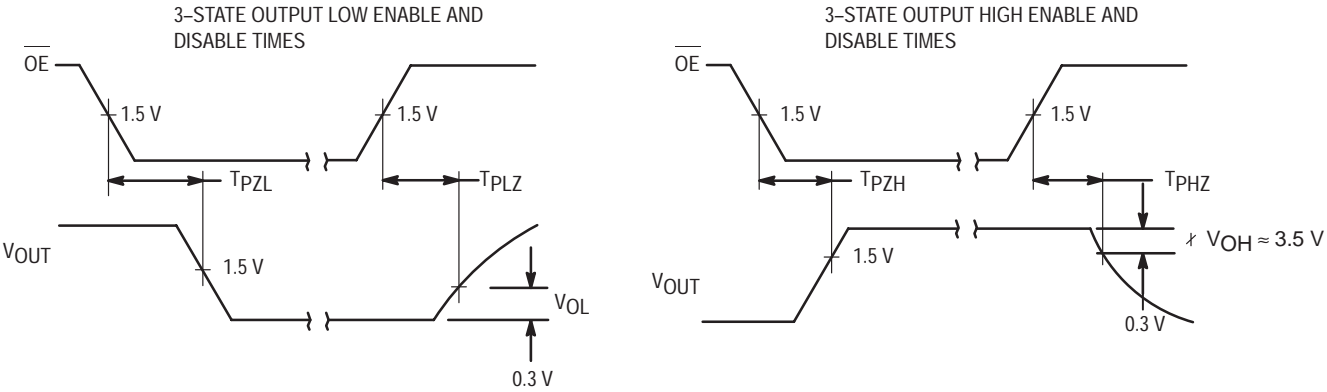
Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6-11.



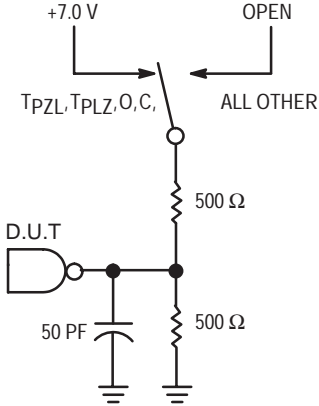
ELECTRICAL CHARACTERISTICS ($V_{CC} = 5.0\text{ V} \pm 5\%$) (See Notes 1 & 4)

Characteristic	Symbol	$T_A = 0^\circ\text{C to } 75^\circ\text{C}$		Unit
		Min	Max	
AC PARAMETERS ($C_L = 50\text{ pF}$) ($V_{CC} = 5.0 \pm 5\%$) ($T_A = 0^\circ\text{C to } 75^\circ\text{C}$)				
Propagation Delay Data	t_{pd}	1.5	5.0	ns
Rise Time	t_r	0.3	1.6	ns
Fall Time	t_f	0.3	1.6	ns
Output Disable Time	t_{pdLZ}	2.0	6.0	ns
	t_{pdHZ}	2.0	6.0	ns
Output Enable Time	t_{pdZL}	2.0	8.0	ns
	t_{pdZH}	2.0	8.0	ns

3-STATE SWITCHING WAVEFORMS



TEST LOAD



*INCLUDES JIG AND PROBE CAPACITANCE

Application Note: Pin 9 is an OE and the 10H350 is disabled when OE is at V_{IH} or higher.

Quad TTL/NMOS to PECL* Translator

The MC10H351 is a quad translator for interfacing data between a saturated logic section and the PECL section of digital systems when only a +5.0 Vdc power supply is available. The MC10H351 has TTL/NMOS compatible inputs and PECL complementary open-emitter outputs that allow use as an inverting/non-inverting translator or as a differential line driver. When the common strobe input is at a low logic level, it forces all true outputs to the PECL low logic state ($\approx +3.2$ V) and all inverting outputs to the PECL high logic state ($\approx +4.1$ V).

The MC10H351 can also be used with the MC10H350 to transmit and receive TTL/NMOS information differentially via balanced twisted pair lines.

- Single +5.0 Power Supply
- All V_{CC} Pins Isolated On Chip
- Differentially Drive Balanced Lines
- t_{pd} = 1.3 nsec Typical

MAXIMUM RATINGS

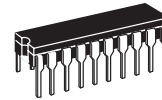
Characteristic	Symbol	Rating	Unit
Power Supply	V _{CC}	0 to +7.0	Vdc
Input Voltage (V _{CC} = 5.0 V)	V _I	0 to V _{CC}	Vdc
Output Current — Continuous — Surge	I _{out}	50 100	mA
Operating Temperature Range	T _A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T _{stg}	-55 to +150 -55 to +165	°C

ELECTRICAL CHARACTERISTICS (V_{CC} = V_{CC1} = V_{CC2} = 5.0 V ± 5.0%)

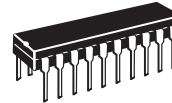
Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	ECL	—	50	—	45	—	50	mA
	TTL	—	20	—	15	—	20	mA
Reverse Current Pins 7, 8, 12, 14 Pin 9	I _R	—	25	—	20	—	25	μA
	I _{INH}	—	100	—	80	—	100	
Forward Current Pins 7, 8, 12, 14 Pin 9	I _F	—	-0.8	—	-0.6	—	-0.8	mA
	I _{INL}	—	-3.2	—	-2.4	—	-3.2	
Input Breakdown Voltage	V _{(BR)in}	5.5	—	5.5	—	5.5	—	Vdc
Input Clamp Voltage (I _{in} = -18 mA)	V _I	—	-1.5	—	-1.5	—	-1.5	Vdc
High Output Voltage (1)	V _{OH}	3.98	4.16	4.02	4.19	4.08	4.27	Vdc
Low Output Voltage (1)	V _{OL}	3.05	3.37	3.05	3.37	3.05	3.37	Vdc
High Input Voltage	V _{IH}	2.0	—	2.0	—	2.0	—	Vdc
Low Input Voltage	V _{IL}	—	0.8	—	0.8	—	0.8	Vdc

(1) With V_{CC} at 5.0 V. V_{OH}/V_{OL} change 1:1 with V_{CC}.
*Positive Emitter Coupled Logic

MC10H351



L SUFFIX
CERAMIC PACKAGE
CASE 732-03

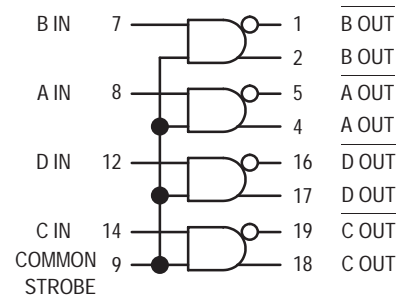


P SUFFIX
PLASTIC PACKAGE
CASE 738-03



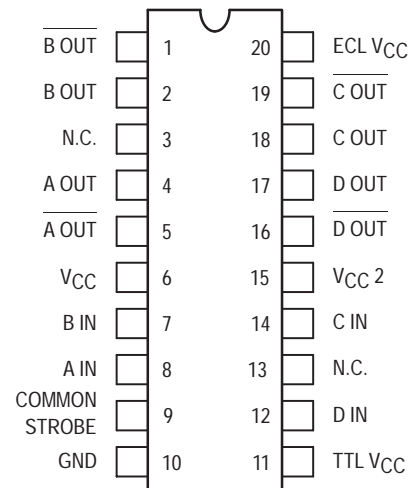
FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM



V_{CC} (+5.0 VDC) = PINS 6, 11, 15, 20
GND = PIN 10

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



AC PARAMETERS

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Propagation Delay (1)	t_{pd}	0.4	2.2	0.4	2.2	0.4	2.1	ns
Rise Time (20% to 80%)	t_r	0.4	1.9	0.4	2.0	0.4	2.1	ns
Fall Time (80% to 20%)	t_f	0.4	1.9	0.4	2.0	0.4	2.1	ns
Maximum Operating Frequency	f_{max}	150	—	150	—	150	—	MHz

(1) Propagation delay is measured on this circuit from +1.5 volts on the input waveform to the 50% point on the output waveform.

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50-ohm resistor to $V_{CC} - 2.0$ Vdc.

Quad CMOS to PECL* Translator

The MC10H352 is a quad translator for interfacing data between a CMOS logic section and the PECL section of digital systems when only a +5.0 Vdc power supply is available. The MC10H352 has CMOS compatible inputs and PECL complementary open-emitter outputs that allow use as an inverting/non-inverting translator or as a differential line driver. When the common strobe input is at a low logic level, it forces all true outputs to the PECL low logic state ($\approx +3.2$ V) and all inverting outputs to the PECL high logic state ($\approx +4.1$ V).

The MC10H352 can also be used with the MC10H350 to transmit and receive CMOS information differentially via balanced twisted pair lines.

- Single +5.0 V Power Supply
- All V_{CC} Pins Isolated On Chip
- Differentially Drive Balanced Lines
- $t_{pd} = 1.3$ nsec Typical

MAXIMUM RATINGS

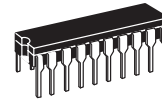
Characteristic	Symbol	Rating	Unit
Power Supply	V_{CC}	0 to +7.0	Vdc
Input Voltage ($V_{CC} = 5.0$ V)	V_I	0 to V_{CC}	Vdc
Output Current— Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range— Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C

ELECTRICAL CHARACTERISTICS ($V_{CC} = V_{CC1} = V_{CC2} = 5.0$ V \pm 5.0%)

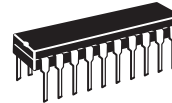
Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	ECL	—	50	—	45	—	50	mA
	TTL	—	20	—	15	—	20	mA
Reverse Current Pins 7, 8, 12, 14 Pin 9	I_R	—	25	—	20	—	25	μ A
		—	100	—	80	—	100	
Forward Current Pins 7, 8, 12, 14 Pin 9	I_F	—	-0.8	—	-0.6	—	-0.8	mA
		—	-3.2	—	-2.4	—	-3.2	
Input Voltage Breakdown	$V_{(BR)in}$	5.5	—	5.5	—	5.5	—	Vdc
Input Clamp Voltage ($I_{in} = -18$ mA)	V_I	—	-1.5	—	-1.5	—	-1.5	Vdc
High Output Voltage (1)	V_{OH}	3.98	4.16	4.02	4.19	4.08	4.27	Vdc
Low Output Voltage (1)	V_{OL}	3.05	3.37	3.05	3.37	3.05	3.37	Vdc
High Input Voltage	V_{IH}	3.15	—	3.15	—	3.15	—	Vdc
Low Input Voltage	V_{IL}	—	1.5	—	1.5	—	1.5	Vdc

(1) With V_{CC} at 5.0 V. V_{OH}/V_{OL} change 1:1 with V_{CC} .
*Positive Emitter Coupled Logic

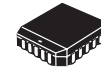
MC10H352



L SUFFIX
CERAMIC PACKAGE
CASE 732-03

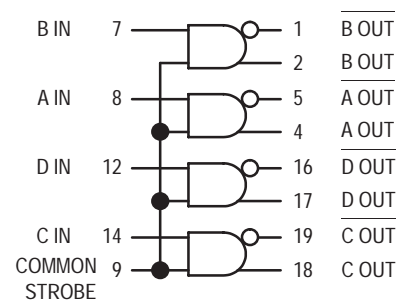


P SUFFIX
PLASTIC PACKAGE
CASE 738-03



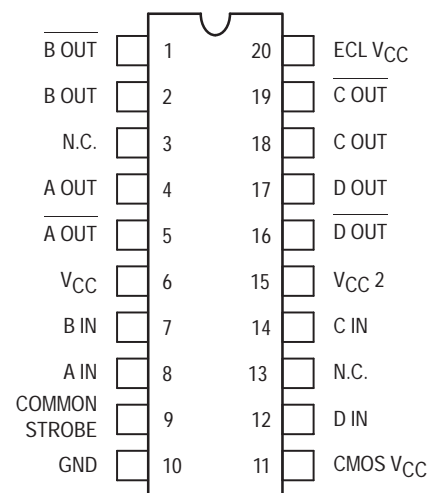
FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM



V_{CC} (+5.0 VDC) = PINS 6, 11, 15, 20
GND = PIN 10

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



AC PARAMETERS

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Propagation Delay (1)	t_{pd}	0.4	1.9	0.4	2.0	0.4	2.1	ns
Rise Time (20% to 80%)	t_r	0.4	1.9	0.4	2.0	0.4	2.1	ns
Fall Time (80% to 20%)	t_f	0.4	1.9	0.4	2.0	0.4	2.1	ns
Maximum Operating Frequency	f_{max}	150	—	150	—	150	—	MHz

(1) Propagation delay is measured on this circuit from $V_{CC}/2$ on the input waveform to the 50% point on the output waveform.

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50-ohm resistor to $V_{CC} - 2.0$ Vdc.

Quad TTL-to-ECL Translator with ECL Strobe

The MC10H424 is a Quad TTL-to-ECL translator with an ECL strobe. Power supply requirements are ground, +5.0 volts, and -5.2 volts.

- Propagation Delay, 1.5 ns Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K — Compatible

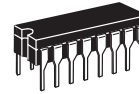
MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 5.0\text{ V}$)	V_{EE}	-8.0 to 0	Vdc
Power Supply ($V_{EE} = -5.2\text{ V}$)	V_{CC}	0 to +7.0	Vdc
Input Voltage (ECL)	V_I	0 to V_{EE}	Vdc
Input Voltage (TTL)	V_I	0 to V_{CC}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C

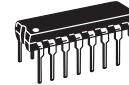
ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2\text{ V} \pm 5\%$, $V_{CC} = 5.0\text{ V} \pm 5.0\%$)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Negative Power Supply Drain Current	I_E	—	72	—	66	—	72	mAdc
Positive Power Supply Drain Current	I_{CCH}	—	16	—	16	—	18	mAdc
	I_{CCL}	—	25	—	25	—	25	mAdc
Reverse Current Pin 5,7,10,11	I_R	—	50	—	50	—	50	μ Adc
Forward Current Pin 5,7,10,11	I_F	—	-3.2	—	-3.2	—	-3.2	mAdc
Input HIGH Current Pin 6	I_{inH}	—	450	—	310	—	310	μ Adc
Input LOW Current Pin 6	I_{inL}	0.5	—	0.5	—	0.3	—	μ Adc
Input Breakdown Voltage	$V_{(BR)in}$	5.5	—	5.5	—	5.5	—	Vdc
Input Clamp Voltage	V_I	—	-1.5	—	-1.5	—	-1.5	Vdc
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
High Input Voltage Pin 5,7,10,11	V_{IH}	2.0	—	2.0	—	+2.0	—	Vdc
Low Input Voltage Pin 5,7,10,11	V_{IL}	—	0.8	—	0.8	—	0.8	Vdc
High Input Voltage Pin 6	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage Pin 6	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

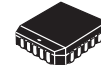
MC10H424



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

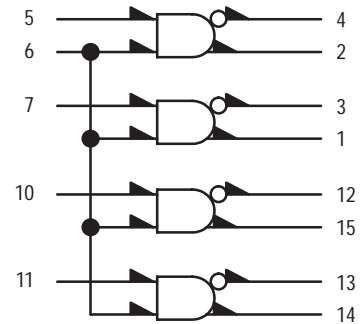


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



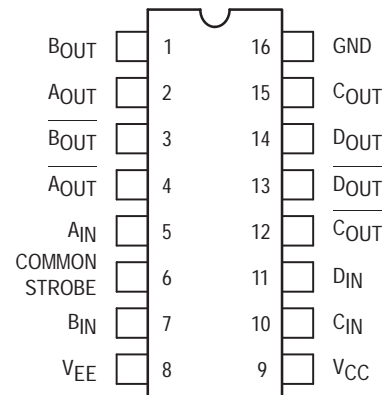
FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM



GND = PIN 16
 V_{CC} (+5.0 VDC) = PIN 9
 V_{EE} (-5.2 VDC) = PIN 8

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



AC PARAMETERS

Propaga- tion Delay	t_{pd}							ns
Data		0.5	2.2	0.5	2.3	0.5	2.4	
Strobe		0.5	2.2	0.5	2.3	0.5	2.4	
Rise Time	t_r	0.5	2.0	0.5	2.0	0.5	2.2	ns
Fall Time	t_f	0.5	2.0	0.5	2.0	0.5	2.2	ns

NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.1 volts.

APPLICATIONS INFORMATION

The MC10H424 has TTL-compatible inputs, an ECL strobe and MECL complementary open-emitter outputs that allow use as an inverting/non-inverting translator or as a differential line driver. When the common strobe input is at the low-logic level, it forces all true outputs to a MECL low-logic state and

all inverting outputs to a MECL high-logic state.

An advantage of this device is that TTL-level information can be transmitted differentially, via balanced twisted pair lines, to MECL equipment, where the signal can be received by the MC10H115 or MC10H116 differential line receivers.

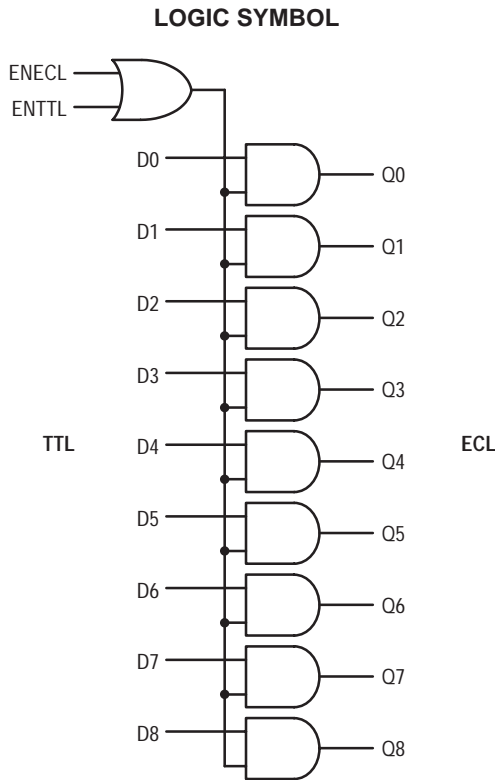
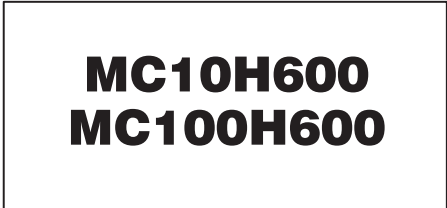
9-Bit TTL/ECL Translator

The MC10H/100H600 is a 9-bit, dual supply TTL to ECL translator. Devices in the Motorola 9-bit translator series utilize the 28-lead PLCC for optimal power pinning, signal flow-through and electrical performance.

The H600 features both ECL and TTL logic enable controls for maximum flexibility.

The 10H version is compatible with MECL 10H ECL logic levels. The 100H version is compatible with 100K levels.

- 9-Bit Ideal for Byte-Parity Applications
- Flow-Through Configuration
- Extra TTL and ECL Power/Ground Pins to Minimize Switching Noise
- ECL and TTL Enable Inputs
- Dual Supply
- 3.5 ns Max D to Q
- PNP TTL Inputs for Low Loading
- Choice of ECL Compatibility: MECL 10H (10Hxxx) or 100K (100Hxxx)



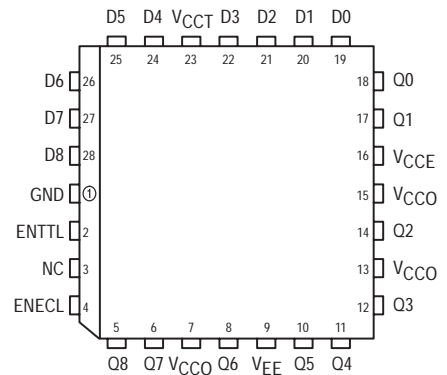
PIN NAMES

PIN	FUNCTION
GND	TTL Ground (0 V)
V _{CCE}	ECL V _{CC} (0 V)
V _{CCO}	ECL V _{CC} (0 V) — Outputs
V _{CCT}	TTL Supply (+5.0 V)
V _{EE}	ECL Supply (−5.2/−4.5 V)
D0–D8	Data Inputs (TTL)
Q0–Q8	Data Outputs (ECL)
ENECL	Enable Control (ECL)
ENTTL	Enable Control (TTL)

TRUTH TABLE

ENECL	ENTTL	D	Q
H	X	H	H
H	X	L	L
X	H	H	H
X	H	L	L
L	L	X	L

Pinout: 28-Lead PLCC (Top View)



DC CHARACTERISTICS: $V_{CC} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -5.2\text{ V} \pm 5\%$ (10H version); $V_{EE} = -4.2\text{ V}$ to -5.5 V (100H version)

Symbol	Parameter		0°C		25°C		75°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
	Power Supply Current									
I_{EE}	ECL	10H 100H		-125 -122		-125 -123		-125 -132	mA	
I_{CCH} I_{CCL}	TTL			48 50		48 50		48 50	mA	

AC CHARACTERISTICS: $V_{CC} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -5.2\text{ V} \pm 5\%$ (10H version); $V_{EE} = -4.2\text{ V}$ to -5.5 V (100H version)

Symbol	Parameter		0°C		25°C		75°C		Unit	Condition	
			Min	Max	Min	Max	Min	Max			
t_{PLH} t_{PHL}	Propagation Delay to Output		D	1.4	3.0	1.5	3.2	1.7	3.5	ns	50 Ω to -2.0 V
			ENECL/ ENTTL	1.8	3.7	1.9	3.9	2.0	4.1	ns	50 Ω to -2.0 V
t_R t_F	Output Rise/Fall Time 20%–80%		0.5	1.5	0.5	1.5	0.5	1.5	ns	50 Ω to -2.0 V	

10H ECL DC CHARACTERISTICS: $V_{CC} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -5.2\text{ V} \pm 5\%$

Symbol	Parameter		0°C		25°C		75°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
I_{IH} I_{IL}	Input HIGH Current Input LOW Current		0.5	225	0.5	145	0.5	145	μA μA	
V_{IH} V_{IL}	Input HIGH Voltage Input LOW Voltage		-1170 -1950	-840 -1480	-1130 -1950	-810 -1480	-1070 -1950	-735 -1450	mV	
V_{OH} V_{OL}	Output HIGH Voltage Output LOW Voltage		-1020 -1950	-840 -1630	-980 -1950	-810 -1630	-920 -1950	-735 -1600	mV	50 Ω to -2.0 V

100H ECL DC CHARACTERISTICS: $V_{CC} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -4.2\text{ V}$ to -5.5 V

Symbol	Parameter		0°C		25°C		75°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
I_{IH} I_{IL}	Input HIGH Current Input LOW Current		0.5	225	0.5	145	0.5	145	μA μA	
V_{IH} V_{IL}	Input HIGH Voltage Input LOW Voltage		-1165 -1810	-880 -1475	-1165 -1810	-880 -1475	-1165 -1810	-880 -1475	mV	
V_{OH} V_{OL}	Output HIGH Voltage Output LOW Voltage		-1025 -1810	-880 -1620	-1025 -1810	-880 -1620	-1025 -1810	-880 -1620	mV	50 Ω to -2.0 V

TTL DC CHARACTERISTICS: $V_{CC} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -5.2\text{ V} \pm 5\%$ (10H version); $V_{EE} = -4.2\text{ V}$ to -5.5 V (100H version)

Symbol	Parameter		0°C		25°C		75°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
V_{IH} V_{IL}	Input HIGH Voltage Input LOW Voltage		2.0	0.8	2.0	0.8	2.0	0.8	V V	
I_{IH}	Input HIGH Current			20 100		20 100		20 100	μA	$V_{IN} = 2.7\text{ V}$ $V_{IN} = 7.0\text{ V}$
I_{IL}	Input LOW Current			-0.6		-0.6		-0.6	mA	$V_{IN} = 0.5\text{ V}$
V_{IK}	Input Clamp Voltage			-1.2		-1.2		-1.2	V	$I_{IN} = -18\text{ mA}$

9-Bit ECL/TTL Translator

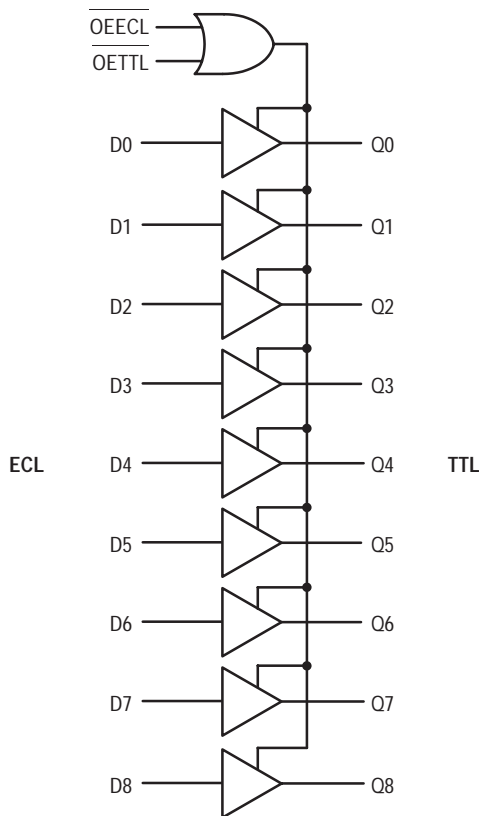
The MC10H/100H601 is a 9-bit, dual supply ECL to TTL translator. Devices in the Motorola 9-bit translator series utilize the 28-lead PLCC for optimal power pinning, signal flow-through and electrical performance.

The devices feature a 48 mA TTL output stage, and AC performance is specified into both a 50 pF and 200 pF load capacitance. For the 3-state output disable, both ECL and TTL control inputs are provided, allowing maximum design flexibility.

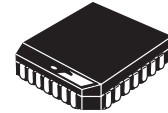
The 10H version is compatible with MECL 10H ECL logic levels. The 100H version is compatible with 100K levels.

- 9-Bit Ideal for Byte-Parity Applications
- 3-State TTL Outputs
- Flow-Through Configuration
- Extra TTL and ECL Power Pins to Minimize Switching Noise
- ECL and TTL 3-State Control Inputs
- Dual Supply
- 4.8 ns Max Delay into 50 pF, 9.6 ns into 200 pF (all outputs switching)
- PNP TTL Inputs for Low Loading

LOGIC SYMBOL



MC10H601 MC100H601



FN SUFFIX
PLASTIC PACKAGE
CASE 776-02

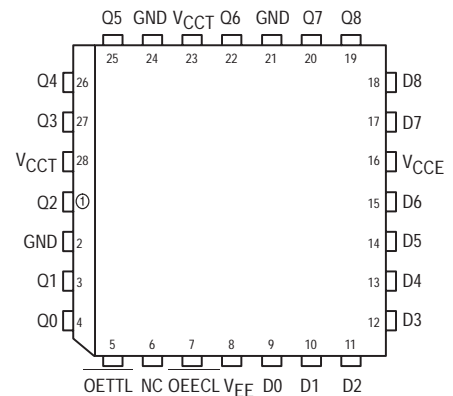
PIN NAMES

PIN	FUNCTION
GND	TTL Ground (0 V)
V _{CCE}	ECL V _{CC} (0 V)
V _{CCT}	TTL Supply (+5.0 V)
V _{EE}	ECL Supply (-5.2/-4.5 V)
D0-D8	Data Inputs (ECL)
Q0-Q8	Data Outputs (TTL)
OE ECL	3-State Control (ECL)
OE TTL	3-State Control (TTL)

TRUTH TABLE

OE ECL	OE TTL	D	Q
L	L	L	L
L	L	H	H
H	H	X	Z
X	X	X	Z

Pinout: 28-Lead PLCC (Top View)



MC10H601

DC CHARACTERISTICS: $V_{CCT} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -5.2\text{ V} \pm 5\%$ (10H version); $V_{EE} = -4.2\text{ V}$ to -5.5 V (100H version)

Symbol	Parameter		0°C		25°C		75°C		Unit	Condition	
			Min	Max	Min	Max	Min	Max			
I_{EE}	Power Supply Current	ECL		-51		-51		-51	mA		
I_{CCH}		TTL		110		110		110			
I_{CCL}				110		110		110			
I_{CCZ}				105		105		105			
I_{OS}	Output Short Circuit Current		-100	-225	-100	-225	-100	-225	mA	$V_{OUT} = 0\text{ V}$	
I_{OZH}	Output Disable Current	HIGH		50		50		50		μA	$V_{OUT} = 2.7\text{ V}$
I_{OZL}		LOW		-50		-50		-50		μA	$V_{OUT} = 0.5\text{ V}$

AC CHARACTERISTICS: $V_{CCT} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -5.2\text{ V} \pm 5\%$ (10H version); $V_{EE} = -4.2\text{ V}$ to -5.5 V (100H version)

Symbol	Parameter		0°C		25°C		75°C		Unit	Condition	
			Min	Max	Min	Max	Min	Max			
t_{PLH}	Propagation Delay to Output		1.7	4.8	1.7	4.8	1.7	4.8	ns	$C_L = 50\text{ pF}$	
t_{PHL}			$C_L = 200\text{ pF}$								
t_{PLZ}	Output Disable Time		OEECL	3.7	6.5	3.7	6.5	3.7	6.5	ns	$C_L = 50\text{ pF}$
t_{PHZ}				5.4	13	5.4	13	5.4	13		$C_L = 200\text{ pF}$
t_{PLZ}			OETTL	4.3	7.5	4.3	7.5	4.3	7.5	ns	$C_L = 50\text{ pF}$
t_{PHZ}				7.0	15	7.0	15	7.0	15		$C_L = 200\text{ pF}$
t_{PZL}	Output Enable Time		OEECL	3.5	6.0	3.5	6.0	3.5	6.0	ns	$C_L = 50\text{ pF}$
t_{PZH}				5.0	12	5.0	12	5.0	12		$C_L = 200\text{ pF}$
t_{PZL}			OETTL	4.2	7.0	4.2	7.0	4.2	7.0	ns	$C_L = 50\text{ pF}$
t_{PZH}				6.0	14	6.0	14	6.0	14		$C_L = 200\text{ pF}$
t_R	Output Rise/Fall Time 1.0 V–2.0 V			1.2		1.2		1.2	ns	$C_L = 50\text{ pF}$	
t_F				3.0		3.0		3.0		$C_L = 200\text{ pF}$	

10H ECL DC CHARACTERISTICS: $V_{CCT} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -5.2\text{ V} \pm 5\%$

Symbol	Parameter		0°C		25°C		75°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
I_{IH}	Input HIGH Current Input LOW Current			225		145		145	μA	
I_{IL}			0.5		0.5		0.5			
V_{IH}	Input HIGH Voltage Input LOW Voltage		-1170	-840	-1130	-810	-1070	-735	mV	
V_{IL}			-1950	-1480	-1950	-1480	-1950	-1450		

100H ECL DC CHARACTERISTICS: $V_{CCT} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -4.2\text{ V}$ to -5.5 V

Symbol	Parameter		0°C		25°C		75°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
I_{IH}	Input HIGH Current Input LOW Current			225		145		145	μA	
I_{IL}			0.5		0.5		0.5			
V_{IH}	Input HIGH Voltage Input LOW Voltage		-1165	-880	-1165	-880	-1165	-880	mV	
V_{IL}			-1810	-1475	-1810	-1475	-1810	-1475		

TTL DC CHARACTERISTICS: $V_{CCT} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -5.2\text{ V} \pm 5\%$ (10H version); $V_{EE} = -4.2\text{ V}$ to -5.5 V (100H version)

Symbol	Parameter		0°C		25°C		75°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
V_{IH}	Input HIGH Voltage Input LOW Voltage		2.0		2.0		2.0		V	
V_{IL}				0.8		0.8		0.8		
I_{IH}	Input HIGH Current			20		20		20	μA	$V_{IN} = 2.7\text{ V}$
I_{IL}				100		100		100		$V_{IN} = 7.0\text{ V}$
I_{IL}	Input LOW Current			-0.6		-0.6		-0.6	mA	$V_{IN} = 0.5\text{ V}$
V_{IK}	Input Clamp Voltage			-1.2		-1.2		-1.2	V	$I_{IN} = -18\text{ mA}$
V_{OH}	Output HIGH Voltage		2.5		2.5		2.5		V	$I_{OH} = -3.0\text{ mA}$
V_{OL}				2.0		2.0		2.0		$I_{OH} = -15\text{ mA}$
V_{OL}	Output LOW Voltage			0.55		0.55		0.55	V	$I_{OL} = 48\text{ mA}$

9-Bit Latch TTL/ECL Translator

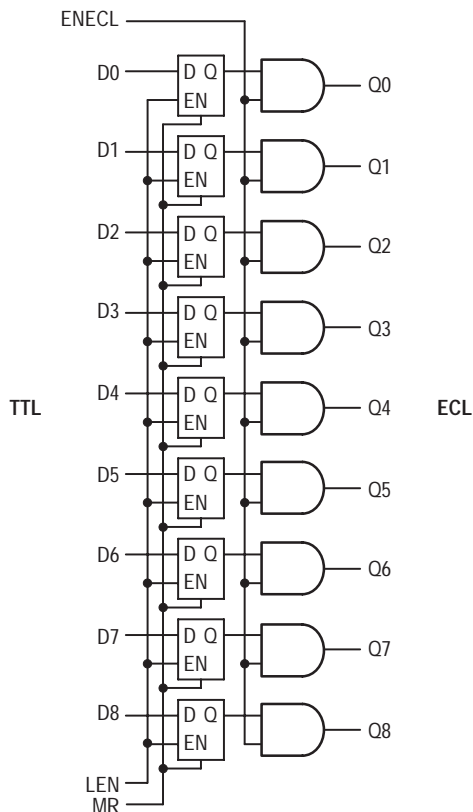
The MC10H/100H602 is a 9-bit, dual supply TTL to ECL translator with latch. Devices in the Motorola 9-bit translator series utilize the 28-lead PLCC for optimal power pinning, signal flow-through and electrical performance.

The H602 features D-type latches. Latching is controlled by Latch Enable (LEN), while the Master Reset input resets the latches. A post-latch logic enable is also provided (ENECL), allowing control of the output state without destroying latch data. All control inputs are ECL level.

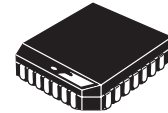
The 10H version is compatible with MECL 10H ECL logic levels. The 100H version is compatible with 100K levels.

- 9-Bit Ideal for Byte-Parity Applications
- Flow-Through Configuration
- Extra TTL and ECL Power/Ground Pins to Minimize Switching Noise
- Dual Supply
- 3.5 ns Max D to Q
- PNP TTL Inputs for Low Loading

LOGIC SYMBOL



MC10H602 MC100H602



FN SUFFIX
PLASTIC PACKAGE
CASE 776-02

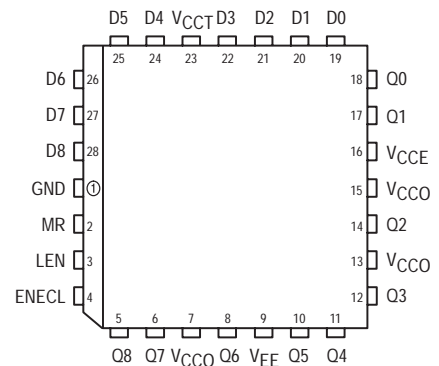
PIN NAMES

PIN	FUNCTION
GND	TTL Ground (0 V)
V _{CCE}	ECL V _{CC} (0 V)
V _{CCO}	ECL V _{CC} (0 V) — Outputs
V _{CCT}	TTL Supply (+5.0 V)
V _{EE}	ECL Supply (-5.2/-4.5 V)
D0-D8	Data Inputs (TTL)
Q0-Q8	Data Outputs (ECL)
ENECL	Enable Control (ECL)
LEN	Latch Enable (ECL)
MR	Master Reset (ECL)

TRUTH TABLE

D	LEN	MR	ENECL	Q
L	L	L	H	L
H	L	L	H	H
X	H	L	H	Q ₀
X	X	H	H	L
X	X	X	L	L

Pinout: 28-Lead PLCC (Top View)



MC10H602 MC100H602

DC CHARACTERISTICS: $V_{CCT} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -5.2\text{ V} \pm 5\%$ (10H version); $V_{EE} = -4.2\text{ V to } -5.5\text{ V}$ (100H version)

Symbol	Parameter		0°C		25°C		75°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
	Power Supply Current									
I_{EE}	ECL	10H 100H		-125 -122		-125 -123		-125 -132	mA	
I_{CCH} I_{CCL}	TTL			48 50		48 50		48 50	mA	

AC CHARACTERISTICS: $V_{CCT} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -5.2\text{ V} \pm 5\%$ (10H version); $V_{EE} = -4.2\text{ V to } -5.5\text{ V}$ (100H version)

Symbol	Parameter		0°C		25°C		75°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
t_{PLH} t_{PHL}	Propagation Delay to Output	D	1.4	3.0	1.5	3.2	1.7	3.5	ns	
		LEN	2.0	3.4	2.1	3.5	2.4	3.7		
		MR	2.0	3.4	2.1	3.5	2.5	3.9		
		ENECL	1.6	3.2	1.7	3.3	1.8	3.7		
t_s	Set-Up Time, D to LEN		2.0		2.0		2.0		ns	
t_h	Hold Time, D to LEN		1.0		1.0		1.0		ns	
$t_{w(L)}$	LEN Pulse Width, LOW		2.0		2.0		2.0		ns	
t_R t_F	Output Rise/Fall Time 20%–80%		0.5	1.5	0.5	1.5	0.5	1.5	ns	

10H ECL DC CHARACTERISTICS: $V_{CCT} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -5.2\text{ V} \pm 5\%$

Symbol	Parameter		0°C		25°C		75°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
I_{IH} I_{IL}	Input HIGH Current Input LOW Current		0.5	225	0.5	145	0.5	145	μA μA	
V_{IH} V_{IL}	Input HIGH Voltage Input LOW Voltage		-1170 -1950	-840 -1480	-1130 -1950	-810 -1480	-1070 -1950	-735 -1450	mV	
V_{OH} V_{OL}	Output HIGH Voltage Output LOW Voltage		-1020 -1950	-840 -1630	-980 -1950	-810 -1630	-920 -1950	-735 -1600	mV	50 Ω to -2.0 V

100H ECL DC CHARACTERISTICS: $V_{CCT} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -4.2\text{ V to } -5.5\text{ V}$

Symbol	Parameter		0°C		25°C		75°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
I_{IH} I_{IL}	Input HIGH Current Input LOW Current		0.5	225	0.5	145	0.5	145	μA μA	
V_{IH} V_{IL}	Input HIGH Voltage Input LOW Voltage		-1165 -1810	-880 -1475	-1165 -1810	-880 -1475	-1165 -1810	-880 -1475	mV	
V_{OH} V_{OL}	Output HIGH Voltage Output LOW Voltage		-1025 -1810	-880 -1620	-1025 -1810	-880 -1620	-1025 -1810	-880 -1620	mV	50 Ω to -2.0 V

TTL DC CHARACTERISTICS: $V_{CCT} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -5.2\text{ V} \pm 5\%$ (10H version); $V_{EE} = -4.2\text{ V to } -5.5\text{ V}$ (100H version)

Symbol	Parameter		0°C		25°C		75°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
V_{IH} V_{IL}	Input HIGH Voltage Input LOW Voltage		2.0	0.8	2.0	0.8	2.0	0.8	V V	
I_{IH}	Input HIGH Current			20 100		20 100		20 100	μA	$V_{IN} = 2.7\text{ V}$ $V_{IN} = 7.0\text{ V}$
I_{IL}	Input LOW Current			-0.6		-0.6		-0.6	mA	$V_{IN} = 0.5\text{ V}$
V_{IK}	Input Clamp Voltage			-1.2		-1.2		-1.2	V	$I_{IN} = -18\text{ mA}$

9-Bit Latch ECL/TTL Translator

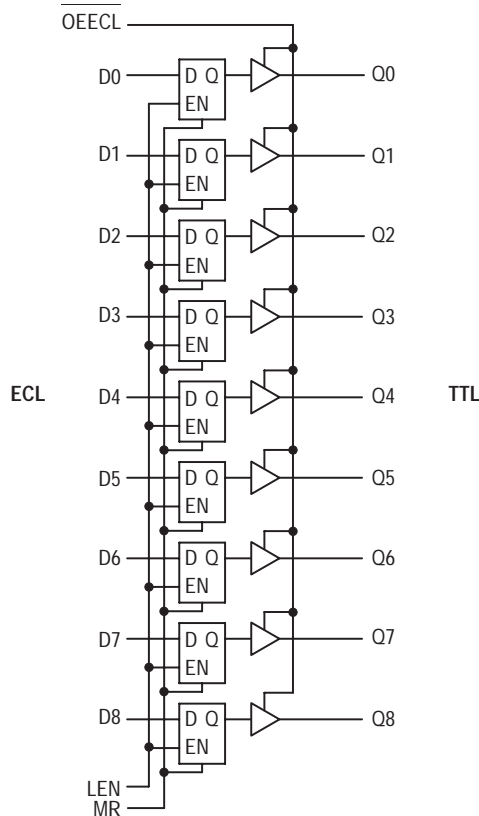
The MC10H/100H603 is a 9-bit, dual supply ECL to TTL translator. Devices in the Motorola 9-bit translator series utilize the 28-lead PLCC for optimal power pinning, signal flow-through and electrical performance.

The devices feature a 48 mA TTL output stage, and AC performance is specified into both a 50 pF and 200 pF load capacitance. Latching is controlled by Latch Enable (LEN), and Master Reset (MR) resets the latches. A HIGH on OEECL sends the outputs into the high impedance state. All control inputs are ECL level.

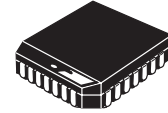
The 10H version is compatible with MECL 10H ECL logic levels. The 100H version is compatible with 100K levels.

- 9-Bit Ideal for Byte-Parity Applications
- 3-State TTL Outputs
- Flow-Through Configuration
- Extra TTL and ECL Power Pins to Minimize Switching Noise
- Dual Supply
- 6.0 ns Max Delay into 50 pF, 12 ns into 200 pF (all outputs switching)
- PNP TTL Inputs for Low Loading

LOGIC SYMBOL



MC10H603 MC100H603



FN SUFFIX
PLASTIC PACKAGE
CASE 776-02

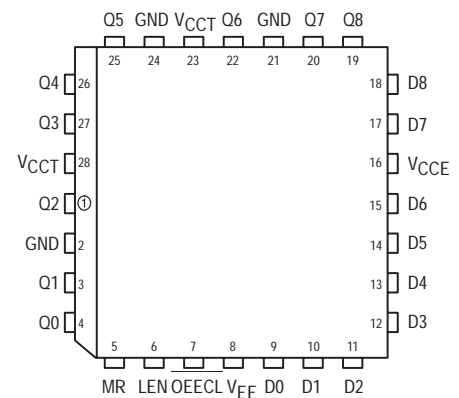
PIN NAMES

PIN	FUNCTION
GND	TTL Ground (0 V)
V _{CCE}	ECL V _{CC} (0 V)
V _{CCT}	TTL Supply (+5.0 V)
V _{EE}	ECL Supply (-5.2/-4.5 V)
D0-D8	Data Inputs (ECL)
Q0-Q8	Data Outputs (TTL)
OEECL	3-State Control (ECL)
LEN	Latch Enable (ECL)
MR	Master Reset (ECL)

TRUTH TABLE

D	LEN	MR	OEECL	Q
L	L	L	L	L
H	L	L	L	H
X	H	L	L	Q ₀
X	X	H	L	L
X	X	X	H	Z

Pinout: 28-Lead PLCC (Top View)



MC10H603 MC100H603

DC CHARACTERISTICS: $V_{CCT} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -5.2\text{ V} \pm 5\%$ (10H version); $V_{EE} = -4.2\text{ V to } -5.5\text{ V}$ (100H version)

Symbol	Parameter		0°C		25°C		75°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
I _{EE}	Power Supply Current	ECL	-45	-63	-45	-64	-45	-68	mA	
I _{CCH}		TTL	80	110	80	110	80	110	mA	
I _{CCL}			80	110	80	110	80	110	mA	
I _{CCZ}			80	110	80	110	80	110	mA	
I _{OS}	Output Short Circuit Current		-100	-225	-100	-225	-100	-225	mA	V _{OUT} = 0 V
I _{OZH}	Output Disable Current	HIGH		50		50		50	μA	V _{OUT} = 2.7 V
I _{OZL}		LOW		-50		-50		-50	μA	V _{OUT} = 0.5 V

AC CHARACTERISTICS: $V_{CCT} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -5.2\text{ V} \pm 5\%$ (10H version); $V_{EE} = -4.2\text{ V to } -5.5\text{ V}$ (100H version)

Symbol	Parameter		0°C		25°C		75°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
t _{PLH} t _{PHL}	Propagation Delay to Output	D	3.0	6.0	3.0	6.0	3.0	6.0	ns	C _L = 50 pF
			6.4	12	6.4	12	6.4	12	ns	C _L = 200 pF
LEN		3.5	6.5	3.5	6.5	3.5	6.5	ns	C _L = 50 pF	
		7.0	13	7.0	13	7.0	13	ns	C _L = 200 pF	
MR		3.0	6.0	3.0	6.0	3.0	6.0	ns	C _L = 50 pF	
		6.0	12	6.0	12	6.0	12	ns	C _L = 200 pF	
t _s t _h t _{w(L)}	Set-Up Time, D to LEN Hold Time, D to LEN LEN Pulse Width, LOW	1.5		1.5		1.5		ns		
t _{PLZ} t _{PHZ}	Output Disable Time	2.5	6.5	2.5	6.5	2.5	6.5	ns	C _L = 50 pF C _L = 200 pF	
t _{PZL} t _{PZH}	Output Enable Time	2.0	5.0	2.0	5.0	2.0	5.0	ns	C _L = 50 pF C _L = 200 pF	
t _R t _F	Output Rise/Fall Time 1.0 V–2.0 V	0.2	1.2	0.2	1.2	0.2	1.2	ns	C _L = 50 pF C _L = 200 pF	

10H ECL DC CHARACTERISTICS: $V_{CCT} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -5.2\text{ V} \pm 5\%$

Symbol	Parameter	0°C		25°C		75°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
I_{IH} I_{IL}	Input HIGH Current Input LOW Current	0.5	225	0.5	145	0.5	145	μA μA	
V_{IH} V_{IL}	Input HIGH Voltage Input LOW Voltage	-1170 -1950	-840 -1480	-1130 -1950	-810 -1480	-1070 -1950	-735 -1450	mV	

100H ECL DC CHARACTERISTICS: $V_{CCT} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -4.2\text{ V}$ to -5.5 V

Symbol	Parameter	0°C		25°C		75°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
I_{IH} I_{IL}	Input HIGH Current Input LOW Current	0.5	225	0.5	145	0.5	145	μA μA	
V_{IH} V_{IL}	Input HIGH Voltage Input LOW Voltage	-1165 -1810	-880 -1475	-1165 -1810	-880 -1475	-1165 -1810	-880 -1475	mV	

TTL DC CHARACTERISTICS: $V_{CCT} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -5.2\text{ V} \pm 5\%$ (10H version); $V_{EE} = -4.2\text{ V}$ to -5.5 V (100H version)

Symbol	Parameter	0°C		25°C		75°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
V_{IH} V_{IL}	Input HIGH Voltage Input LOW Voltage	2.0	0.8	2.0	0.8	2.0	0.8	V V	
I_{IH}	Input HIGH Current		20 100		20 100		20 100	μA	$V_{IN} = 2.7\text{ V}$ $V_{IN} = 7.0\text{ V}$
I_{IL}	Input LOW Current		-0.6		-0.6		-0.6	mA	$V_{IN} = 0.5\text{ V}$
V_{IK}	Input Clamp Voltage		-1.2		-1.2		-1.2	V	$I_{IN} = -18\text{ mA}$
V_{OH}	Output HIGH Voltage	2.5 2.0		2.5 2.0		2.5 2.0		V V	$I_{OH} = -3.0\text{ mA}$ $I_{OH} = -15\text{ mA}$
V_{OL}	Output LOW Voltage		0.55		0.55		0.55	V	$I_{OL} = 48\text{ mA}$

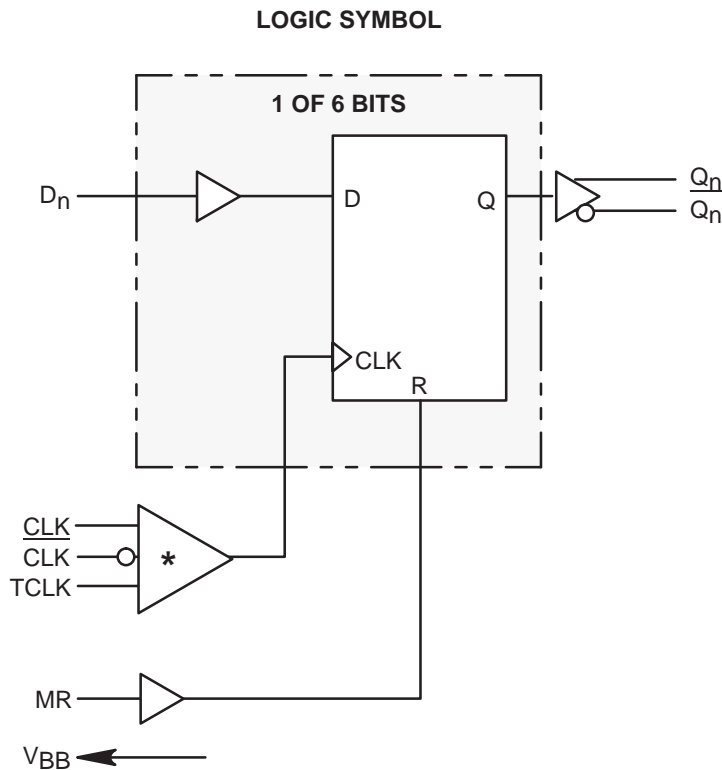
Registered Hex TTL/ECL Translator

The MC10H/100H604 is a 6-bit, registered, dual supply TTL to ECL translator. The device features differential ECL outputs as well as a choice between either a differential ECL clock input or a TTL clock input. The asynchronous master reset control is an ECL level input.

With its differential ECL outputs and TTL inputs the H604 device is ideally suited for the transmit function of a HPPI bus type board-to-board interface application. The on chip registers simplify the task of synchronizing the data between the two boards.

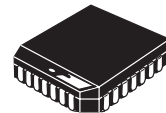
The device is available in either ECL standard: the 10H device is compatible with MECL 10KH logic levels while the 100H device is compatible with 100K logic levels.

- Differential 50Ω ECL Outputs
- Choice Between Differential ECL or TTL Clock Input
- Dual Power Supply
- Multiple Power and Ground Pins to Minimize Noise
- Specified Within-Device Skew



- * 1. When using MECL inputs, TCLK must be tied to ground (0V).
 2. When using only one MECL input, the unused MECL input must be tied to V_{BB}, and TCLK must be tied to ground (0V).
 3. When using TCLK, both MECL inputs must be tied to V_{EE} (-5.2V).

MC10H604 MC100H604



FN SUFFIX
PLASTIC PACKAGE
CASE 776-02

PIN NAMES

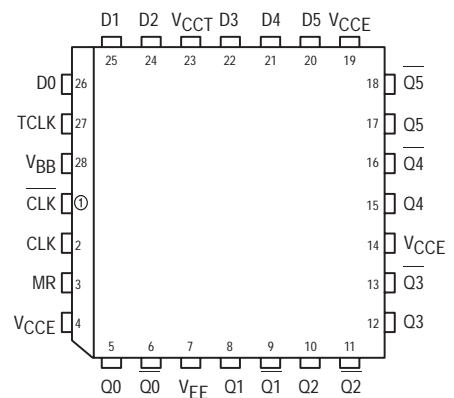
PIN	FUNCTION
D0-D5	TTL Data Inputs
CLK, CLK	Differential ECL Clock Input
TCLK	TTL Clock Input
MR	ECL Master Reset Input
Q0-Q5	True ECL Outputs
Q0-Q5	Inverted ECL Outputs
V _{CCE}	ECL V _{CC} (0V)
V _{CCT}	TTL V _{CC} (+5.0V)
V _{EE}	ECL V _{EE} (-5.2V)

TRUTH TABLE

D _n	MR	TCLK/CLK	Q _{n+1}
L	L	Z	L
H	L	Z	H
X	H	X	L

Z = LOW to HIGH Transition

Pinout: 28-Lead PLCC (Top View)



DC CHARACTERISTICS: $V_{EE} = V_{EE}(\text{Min})$ to $V_{EE}(\text{Max})$; $V_{CC} = \text{GND}$; $V_{CC} = 5.0\text{V} \pm 10\%$

Symbol	Parameter	0°C		25°C		85°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
I_{EE}	ECL Power Supply Current	10H	130		130		130	mA	
		100H	130		140		150		
I_{CCH} I_{CCL}	TTL Power Supply Current		35 45		35 45		35 45	mA	

10H ECL DC CHARACTERISTICS: $V_{CC} = +5.0\text{V} \pm 10\%$; $V_{EE} = -5.20\text{V} \pm 5\%$

Symbol	Parameter	0°C		25°C		85°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
I_{IH} I_{IL}	Input HIGH Current Input LOW Current		225		145		145	μA μA	
		0.5		0.5		0.5			
V_{IH} V_{IL}	Input HIGH Voltage Input LOW Voltage	-1170	-840	-1130	-810	-1060	-720	mV	
		-1950	-1480	-1950	-1480	-1950	-1480		
V_{BB}	Output Bias Voltage	-1400	-1290	-1370	-1270	-1330	-1210	mV	
V_{OH} V_{OL}	Output HIGH Voltage Output LOW Voltage	-1020	-840	-980	-810	-910	-720	mV	50 Ω to -2.0 V
		-1950	-1630	-1950	-1630	-1950	-1595		

100H ECL DC CHARACTERISTICS: $V_{CC} = 5.0\text{V} \pm 10\%$; $V_{EE} = -4.2\text{V}$ to -5.5V

Symbol	Parameter	0°C		25°C		85°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
I_{IH} I_{IL}	Input HIGH Current Input LOW Current		225		145		145	μA μA	
		0.5		0.5		0.5			
V_{IH} V_{IL}	Input HIGH Voltage Input LOW Voltage	-1165	-880	-1165	-880	-1165	-880	mV	
		-1810	-1475	-1810	-1475	-1810	-1475		
V_{BB}	Output Bias Voltage	-1400	-1280	-1400	-1280	-1400	-1280	mV	
V_{OH} V_{OL}	Output HIGH Voltage Output LOW Voltage	-1025	-880	-1025	-880	-1025	-880	mV	50 Ω to -2.0 V
		-1810	-1620	-1810	-1620	-1810	-1620		

TTL DC CHARACTERISTICS: $V_{CC} = 5.0\text{V} \pm 10\%$; $V_{EE} = -5.2\text{V} \pm 5\%$ (10H version); $V_{EE} = -4.2\text{V}$ to -5.5V (100H version)

Symbol	Parameter	0°C		25°C		85°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
V_{IH} V_{IL}	Input HIGH Voltage Input LOW Voltage	2.0		2.0		2.0		V V	
			0.8		0.8		0.8		
I_{IH}	Input HIGH Current		20 100		20 100		20 100	μA	$V_{IN} = 2.7\text{V}$ $V_{IN} = 7.0\text{V}$
I_{IL}	Input LOW Current		-0.6		-0.6		-0.6	mA	$V_{IN} = 0.5\text{V}$
V_{IK}	Input Clamp Voltage		-1.2		-1.2		-1.2	V	$I_{IN} = -18\text{mA}$

AC CHARACTERISTICS: $V_{CC} = 5.0\text{V} \pm 10\%$; $V_{EE} = -5.2\text{V} \pm 5\%$ (10H version); $V_{EE} = -4.2\text{V}$ to -5.5V (100H version)

Symbol	Parameter	0°C			25°C			85°C			Unit	Condition	
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max			
t_{PLH} t_{PHL}	Propagation Delay to Output	CLK to Q	1.5		3.5	1.5		3.5	1.5		3.5	ns	$C_L = 50\text{pF}$
		TCLK to Q	2.0		4.0	2.0		4.0	2.0		4.0		
		MR to Q	1.5		4.0	1.5		4.0	1.5		4.0		
t_s	Setup Time	1.5	0.5		1.5	0.5		1.5	0.5		ns	$C_L = 50\text{pF}$	
t_H	Hold Time	1.5	0.5		1.5	0.5		1.5	0.5		ns	$C_L = 50\text{pF}$	
t_{PW}	Minimum Pulse Width CLK, MR		1.0			1.0			1.0		ns	$C_L = 50\text{pF}$	
V_{PP}	Minimum Input Swing					150					mV		
t_r t_f	Rise/Fall Times	0.3	1.0	2.0	0.3	1.0	2.0	0.3	1.0	2.0	ns	20% – 80%	

Registered Hex ECL/TTL Translator

The MC10/100H605 is a 6-bit, registered, dual supply ECL to TTL translator. The device features differential ECL inputs for both data and clock. The TTL outputs feature balanced 24mA sink/source capabilities for driving transmission lines.

With its differential ECL inputs and TTL outputs the H605 device is ideally suited for the receive function of a HPPI bus type board-to-board interface application. The on chip registers simplify the task of synchronizing the data between the two boards.

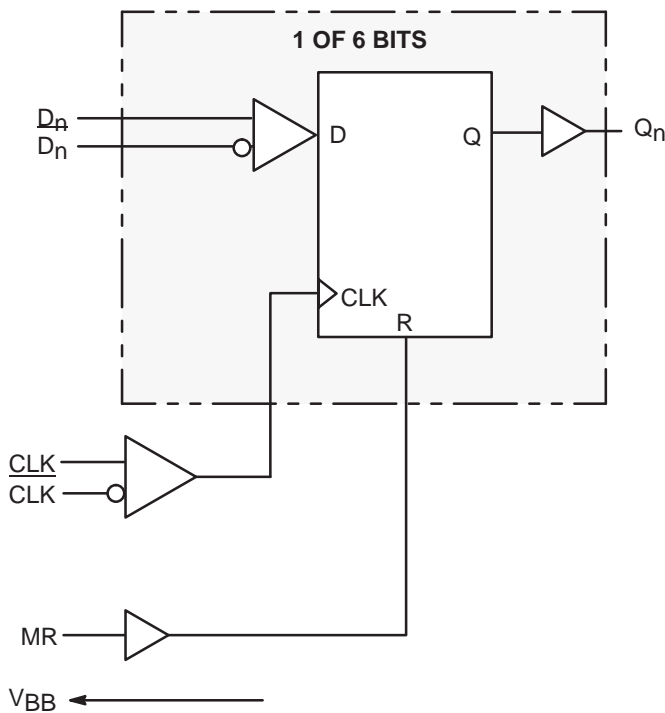
A V_{BB} reference voltage is supplied for use with single-ended data or clock. For single-ended applications the V_{BB} output should be connected to the "bar" inputs ($\overline{D_n}$ or \overline{CLK}) and bypassed to ground via a 0.01 μ F capacitor. To minimize the skew of the device differential clocks should be used.

The ECL level Master Reset pin is asynchronous and common to all flip-flops. A "HIGH" on the Master Reset forces the Q outputs "LOW".

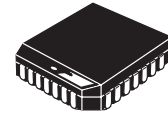
The device is available in either ECL standard: the 10H device is compatible with MECL 10H™ logic levels while the 100H device is compatible with 100K logic levels.

- Differential ECL Data and Clock Inputs
- 24mA Sink, 24mA Source TTL Outputs
- Dual Power Supply
- Multiple Power and Ground Pins to Minimize Noise
- 2.0ns Part-to-Part Skew

LOGIC SYMBOL



MC10H605 MC100H605



FN SUFFIX
PLASTIC PACKAGE
CASE 776-02

PIN NAMES

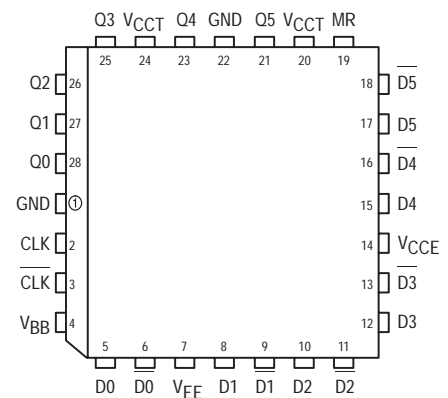
PIN	FUNCTION
$\overline{D_0}$ – $\overline{D_5}$	True ECL Data Inputs
D_0 – D_5	Inverted ECL Data Inputs
\overline{CLK} , CLK	Differential ECL Clock Input
MR	ECL Master Reset Input
Q_0 – Q_5	TTL Outputs
V_{CCE}	ECL V_{CC}
V_{CCT}	TTL V_{CC}
GND	TTL Ground
V_{EE}	ECL V_{EE}

TRUTH TABLE

$\overline{D_n}$	MR	\overline{CLK}/CLK	Q_{n+1}
L	L	Z	L
H	L	Z	H
X	H	X	L

Z = LOW to HIGH Transition

Pinout: 28-Lead PLCC (Top View)



MECL 10H is a trademark of Motorola, Inc.



10H ECL DC CHARACTERISTICS ($V_{CCT} = +5.0V \pm 5\%$; $V_{EE} = -5.20V \pm 5\%$)

Symbol	Characteristic	0°C			25°C			85°C			Unit	Condition
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
I_{EE}	Supply Current		63	75		63	75		61	75	mA	
I_{IH}	Input High Current			225			145			145	μA	
I_{IL}	Input Low Current	0.5			0.5			0.5			μA	
V_{IH}	Input High Voltage	-1170		-840	-1130		-810	-1060		-720	mV	
V_{IL}	Input Low Voltage	-1950		-1480	-1950		-1480	-1950		-1480	mV	
V_{BB}	Output Bias Voltage	-1400		-1280	-1370		-1270	-1330		-1210	mV	
V_{Diff}	Input Differential Voltage	150			150			150			mV	
V_{max} CMRR	Input Common Mode Reject Range			0			0			0	mV	
V_{min} CMRR	Input Common Mode Reject Range	-2800 -3000 -3300			-2800 -3000 -3300			-2800 -3000 -3300			mV	$V_{EE} = -4.94$ $V_{EE} = -5.20$ $V_{EE} = -5.46$

100H ECL DC CHARACTERISTICS ($V_{CCT} = +5.0V \pm 5\%$; $V_{EE} = -4.5V \pm 0.3V$)

Symbol	Characteristic	0°C			25°C			85°C			Unit	Condition
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
I_{EE}	Supply Current		65	75		65	75		70	85	mA	
I_{IH}	Input High Current			225			145			145	μA	
I_{IL}	Input Low Current	0.5			0.5			0.5			μA	
V_{IH}	Input High Voltage	-1165		-880	-1165		-880	-1165		-880	mV	
V_{IL}	Input Low Voltage	-1810		-1475	-1810		-1475	-1810		-1475	mV	
V_{BB}	Output Bias Voltage	-1400		-1280	-1400		-1280	-1400		-1200	mV	
V_{Diff}	Input Differential Voltage	150			150			150			mV	
V_{max} CMRR	Input Common Mode Reject Range			0			0			0	mV	
V_{min} CMRR	Input Common Mode Reject Range	-2000 -2200 -2400			-2000 -2200 -2400			-2000 -2200 -2400			mV	$V_{EE} = -4.20$ $V_{EE} = -4.50$ $V_{EE} = -4.80$

* NOTE: DO NOT short the ECL inputs to the TTL V_{CC} .

MC10H605 MC100H605

TTL DC CHARACTERISTICS ($V_{CC} = +5.0V \pm 5\%$; $V_{EE} = -5.2V \pm 5\%$ (10H); $V_{EE} = -4.5V \pm 0.3V$ (100H))

Symbol	Characteristic	0°C			25°C			85°C			Unit	Condition
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
I _{CCL}	Supply Current		65	75		65	75		65	75	mA	Outputs Low
I _{CCH}	Supply Current		65	75		65	75		65	75	mA	Outputs High
V _{OL}	Output Low Voltage			0.5			0.5			0.5	mV	I _{OL} = 24mA
V _{OH}	Output High Voltage	2.5			2.5			2.5			mV	I _{OH} = 24mA
I _{OS}	Output Short Circuit Current	100		225	100		225	100		225	mA	V _{OUT} = 0V

AC TEST LIMITS ($V_{CC} = +5.0V \pm 5\%$; $V_{EE} = -5.2V \pm 5\%$ (10H); $V_{EE} = -4.5V \pm 0.3V$ (100H))

Symbol	Characteristic	0°C			25°C			85°C			Unit	Condition
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
t _{PLH}	Propagation Delay CLK to Q (Diff) CLK to Q (SE)	4.5 4.3	5.3 5.3	6.5 6.7	4.5 4.3	5.4 5.4	6.5 6.7	4.5 4.3	5.6 5.6	6.5 6.7	ns	Across P.S. and Temp C _L = 50pF
t _{PHL}	Propagation Delay CLK to Q (Diff) CLK to Q (SE)	4.0 3.8	5.0 5.0	6.0 6.2	4.0 3.8	5.1 5.1	6.0 6.2	4.0 3.8	5.5 5.5	6.0 6.2	ns	Across P.S. and Temp C _L = 50pF
t _{PHL}	Propagation Delay MR to Q	2.5	4.9	7.0	2.5	5.2	7.0	3.0	5.8	7.5	ns	Across P.S. and Temp C _L = 50pF
t _{SKEW}	Device Skew Part-to-Part (Diff) Within-Device		1.0 0.3	2.0 0.7		1.0 0.3	2.0 0.7		1.0 0.3	2.0 0.7	ns	C _L = 50pF
t _S	Setup Time	1.5			1.5			1.5			ns	
t _H	Hold Time	1.5			1.5			1.5			ns	
t _{PW}	Minimum Pulse Width CLK	1.0			1.0			1.0			ns	
t _{PW}	Minimum Pulse Width MR	1.0			1.0			1.0			ns	
V _{PP}	Minimum Input Swing	150			150			150			mV	Peak-to-Peak
t _r	Rise Time	0.7	1.0	1.5	0.7	1.0	1.5	0.7	1.0	1.5	ns	1V to 2V
t _f	Fall Time	0.5	0.7	1.2	0.5	0.7	1.2	0.5	0.7	1.2	ns	1V to 2V
t _{RR}	Reset/Recovery Time	2.5			2.5			2.5			ns	

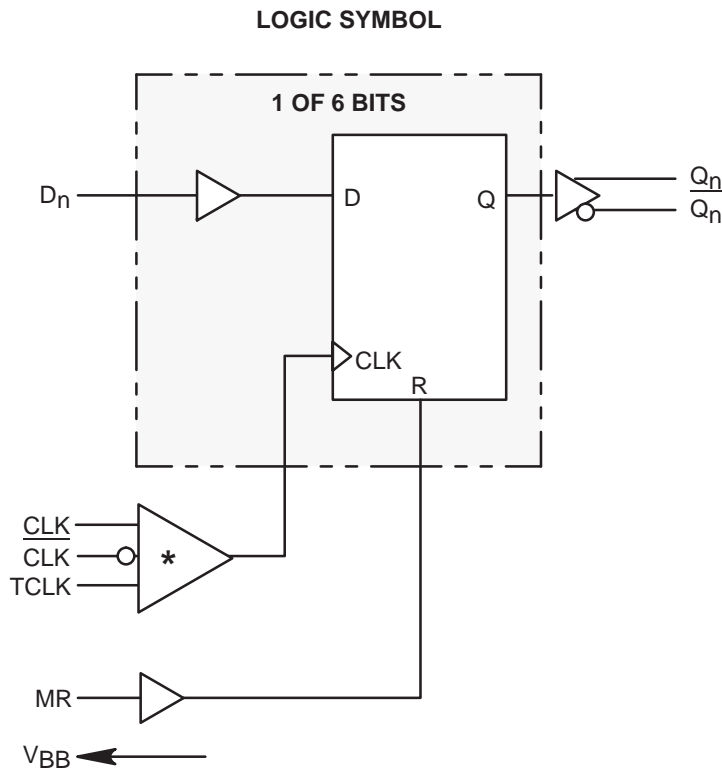
Registered Hex TTL/PECL Translator

The MC10/100H606 is a 6-bit, registered, single supply TTL to PECL translator. The device features differential PECL outputs as well as a choice between either a differential PECL clock input or a TTL clock input. The asynchronous master reset control is a PECL level input.

With its differential PECL outputs and TTL inputs the H606 device is ideally suited for the transmit function of a HPPI bus type board-to-board interface application. The on chip registers simplify the task of synchronizing the data between the two boards.

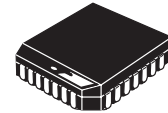
The device is available in either ECL standard: the MECL™ 10H device is compatible with MECL 10KH logic levels, with a V_{CC} of +5 volts; while the 100H device is compatible with 100K logic levels, with a V_{CC} of +5 volts.

- Differential 50Ω ECL Outputs
- Choice Between Differential PECL or TTL Clock Input
- Single Power Supply
- Multiple Power and Ground Pins to Minimize Noise



- * 1. When using PECL inputs, TCLK must be tied to ground (0V).
 2. When using only one PECL input, the unused PECL input must be tied to V_{BB}, and TCLK must be tied to ground (0V).
 3. When using TCLK, both PECL inputs must be tied to ground (0V).

MC10H606 MC100H606



FN SUFFIX
PLASTIC PACKAGE
CASE 776-02

PIN NAMES

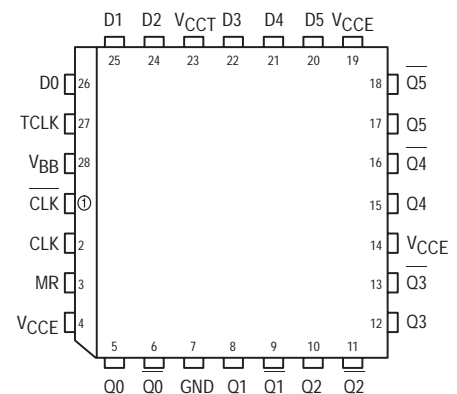
PIN	FUNCTION
D0–D5	TTL Data Inputs
CLK, CLK _̄	Differential PECL Clock Input
TCLK	TTL Clock Input
MR	PECL Master Reset Input
Q0–Q5	True PECL Outputs
Q0–Q5	Inverted PECL Outputs
V _{CCE}	PECL V _{CC} (+5.0V)
V _{CCT}	TTL V _{CC} (+5.0V)
GND	TTL/PECL Ground

TRUTH TABLE

D _n	MR	TCLK/CLK	Q _{n+1}
L	L	Z	L
H	L	Z	H
X	H	X	L

Z = LOW to HIGH Transition

Pinout: 28-Lead PLCC (Top View)



MECL 10H is a trademark of Motorola, Inc.



MC10H606 MC100H606

DC CHARACTERISTICS ($V_{CCT} = V_{CCE} = 5.0V \pm 5\%$)

Symbol	Characteristic	$T_A = 0^\circ C$			$T_A = +25^\circ C$			$T_A = +85^\circ C$			Unit	Condition
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
I_{CCTL}	Supply Current		18	30		18	30		18	30	mA	Outputs LOW
I_{CCTH}	Supply Current		13	25		13	25		13	25	mA	Outputs HIGH
I_{GND}	Supply Current		75	90		75	90		75	95	mA	

TTL DC CHARACTERISTICS ($V_{CCT} = V_{CCE} = 5.0V \pm 5\%$)

Symbol	Characteristic	$T_A = 0^\circ C$		$T_A = 25^\circ C$		$T_A = 85^\circ C$		Unit	Condition
		Min	Max	Min	Max	Min	Max		
V_{IH}	Input HIGH Voltage	2.0		2.0		2.0		V	
V_{IL}	Input LOW Voltage		0.8		0.8		0.8	V	
V_{IK}	Input Clamp Voltage		-1.2		-1.2		-1.2	V	$I_{IN} = -18mA$
I_{IH}	Input HIGH Current		20 100		20 100		20 100	V	$V_{IN} = 2.7V$ $V_{IN} = 7.0V$
I_{IL}	Input LOW Current		-0.6		-0.6		-0.6	mA	$V_{IN} = 0.5V$

10H PECL DC CHARACTERISTICS ($V_{CCT} = V_{CCE} = 5.0V \pm 5\%$)

Symbol	Characteristic	$T_A = 0^\circ C$		$T_A = 25^\circ C$		$T_A = 85^\circ C$		Unit	Condition
		Min	Max	Min	Max	Min	Max		
I_{INH}	Input HIGH Current		255		145		145	μA	
I_{INL}	Input LOW Current		0.5		0.5		0.5	μA	
V_{IH}	Input HIGH Voltage (Note 1.)	3830	4160	3870	4190	3930	4280	mV	$V_{CCT} = 5.0V$
V_{IL}	Input LOW Voltage (Note 1.)	3050	3520	3050	3520	3050	3555	mV	$V_{CCT} = 5.0V$
V_{OH}	Output HIGH Voltage (Note 1.)	3980	4160	4020	4190	4080	4270	mV	$V_{CCT} = 5.0V$
V_{OL}	Output LOW Voltage (Note 1.)	3050	3370	3050	3370	3050	3400	mV	$V_{CCT} = 5.0V$
V_{BB}	Output Bias Voltage (Note 1.)	3600	3710	3630	3730	3670	3790	mV	$V_{CCT} = 5.0V$

1. PECL V_{IL} , V_{IH} , V_{OL} , V_{OH} , V_{BB} are given for $V_{CCT} = V_{CCE} = 5.0V$ and will vary 1:1 with the power supply.

100H PECL DC CHARACTERISTICS ($V_{CCT} = V_{CCE} = 5.0V \pm 5\%$)

Symbol	Characteristic	$T_A = 0^\circ C$		$T_A = 25^\circ C$		$T_A = 85^\circ C$		Unit	Condition
		Min	Max	Min	Max	Min	Max		
I_{INH}	Input HIGH Current		255		145		145	μA	
I_{INL}	Input LOW Current		0.5		0.5		0.5	μA	
V_{IH}	Input HIGH Voltage (Note 1.)	3835	4120	3835	4120	3835	4120	mV	$V_{CCT} = 5.0V$
V_{IL}	Input LOW Voltage (Note 1.)	3190	3525	3190	3525	3190	3525	mV	$V_{CCT} = 5.0V$
V_{OH}	Output HIGH Voltage (Note 1.)	3975	4120	3975	4120	3975	4120	mV	$V_{CCT} = 5.0V$
V_{OL}	Output LOW Voltage (Note 1.)	3190	3380	3190	3380	3190	3380	mV	$V_{CCT} = 5.0V$
V_{BB}	Output Bias Voltage (Note 1.)	3600	3720	3600	3720	3600	3720	mV	$V_{CCT} = 5.0V$

1. PECL V_{IL} , V_{IH} , V_{OL} , V_{OH} , V_{BB} are given for $V_{CCT} = V_{CCE} = 5.0V$ and will vary 1:1 with the power supply.

AC CHARACTERISTICS ($V_{CCT} = V_{CCE} = 5.0V \pm 5\%$)

Symbol	Characteristic	$T_A = 0^\circ\text{C}$			$T_A = +25^\circ\text{C}$			$T_A = +85^\circ\text{C}$			Unit	Condition
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
t_{PD}	Propagation Delay TCLK++	1.75		3.75	1.75	3.00	3.75	1.75		3.75	ns	CL = 50pF
t_{PD}	Propagation Delay TCLK+-	1.75		3.75	1.75	3.00	3.75	1.75		3.75	ns	CL = 50pF
t_{PD}	Propagation Delay CLK++	1.50		3.50	1.50	2.50	3.50	1.50		3.50	ns	CL = 50pF
t_{PD}	Propagation Delay CLK+-	1.50		3.50	1.50	2.50	3.50	1.50		3.50	ns	CL = 50pF
t_{PD}	Propagation Delay MR+-	1.50		3.50	1.50	2.50	3.50	1.75		3.75	ns	CL = 50pF
t_{SKEW}	Device Skew Part-to-Part Within Device			2.0 0.5		1.0 0.3	2.0 0.5			2.0 0.5	ns	CL = 50pF
t_S	Setup Time	1.5	0.5		1.5	0.5		1.5	0.5		ns	CL = 50pF
t_H	Hold Time	1.5	0.5		1.5	0.5		1.5	0.5		ns	CL = 50pF
t_{PW}	Minimum Pulse Width CLK	1.5			1.5	1.0		1.5			ns	CL = 50pF
t_{PW}	Minimum Pulse Width MR	1.5			1.5			1.5			ns	CL = 50pF
t_r	Rise Time			2.0		1.0	2.0			2.0	ns	CL = 50pF
t_f	Fall Time			2.0		1.0	2.0			2.0	ns	CL = 50pF
$t_{RES/REC}$	Reset/Recovery Time	2.5	2.0		2.5	2.0		2.5	2.0		ns	CL = 50pF

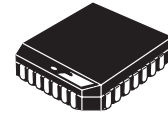
Registered Hex PECL/TTL Translator

MC10H607
MC100H607

The MC10H/100H607 is a 6-bit, registered PECL to TTL translator. The device features differential PECL inputs for both data and clock. The TTL outputs feature 48mA sink, 24mA source drive capability for driving high fanout loads or transmission lines. The asynchronous master reset control is an ECL level input.

With its differential PECL inputs and TTL outputs the H607 device is ideally suited for the receive function of a HPPI bus type board-to-board interface application. The on chip registers simplify the task of synchronizing the data between the two boards.

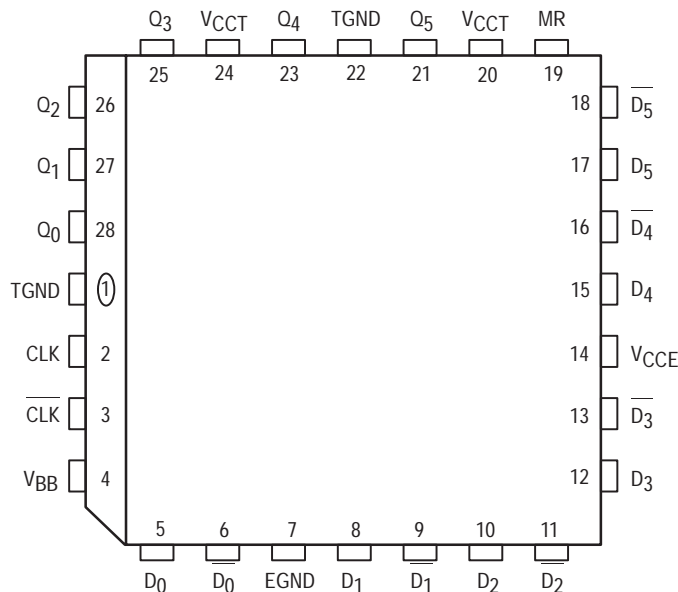
The device is available in either ECL standard: the 10H device is compatible with MECL 10H™ logic levels, with a V_{CC} of +5.0 volts, while the 100H device is compatible with 100K logic levels, with a V_{CC} of +5.0 volts.



FN SUFFIX
PLASTIC PACKAGE
CASE 776-02

- Differential ECL Data and Clock Inputs
- 48mA Sink, 15mA Source TTL Outputs
- Single Power Supply
- Multiple Power and Ground Pins to Minimize Noise

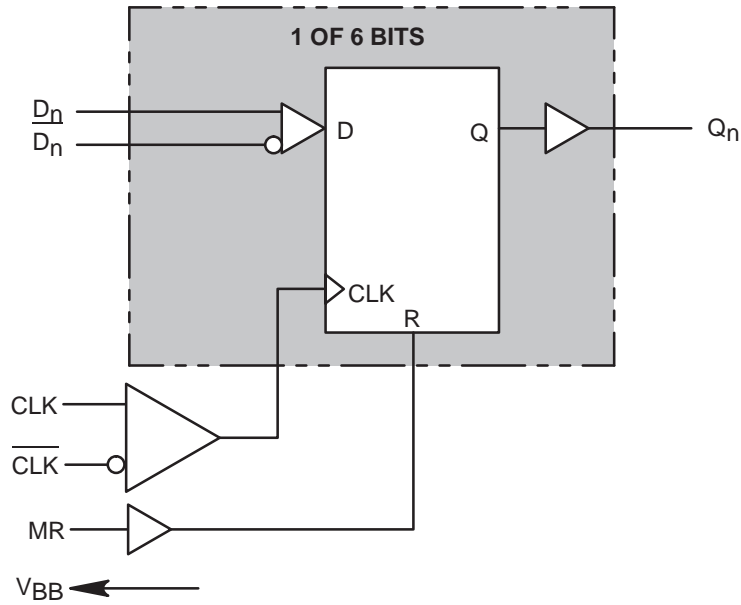
Pinout: 28-Lead PLCC (Top View)



MECL 10H is a trademark of Motorola, Inc.



LOGIC DIAGRAM



PIN NAMES

Pin	Function
$D_0 - D_5$	True PECL Data Inputs
$\overline{D_0} - \overline{D_5}$	Inverted PECL Data Inputs
CLK, $\overline{\text{CLK}}$	Differential PECL Clock Input
MR	PECL Master Reset Input
$Q_0 - Q_5$	TTL Outputs
V_{CCE}	PECL V_{CC}
V_{CCT}	TTL V_{CC}
TGND	TTL Ground
EGND	PECL Ground

TRUTH TABLE

D_n	MR	TCLK/CLK	Q_{n+1}
L	L	Z	L
H	L	Z	H
X	H	X	L

Z = LOW to HIGH Transition

DC CHARACTERISTICS ($V_{CCT} = V_{CCE} = 5.0V \pm 5\%$)

Symbol	Characteristic	$T_A = 0^\circ C$			$T_A = +25^\circ C$			$T_A = +85^\circ C$			Unit	Condition
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
I_{EE}	ECL Power Supply Current 10H 100H		70 65	85 80		70 70	85 85		70 75	85 95	mA	
I_{CCL}	TTL Supply Current		100	120		100	120		100	120	mA	
I_{CCH}	TTL Supply Current		100	120		100	120		100	120	mA	

MC10H607 MC100H607

10H PECL DC CHARACTERISTICS ($V_{CCT} = V_{CCE} = 5.0V \pm 5\%$)

Symbol	Characteristic	$T_A = 0^\circ C$		$T_A = 25^\circ C$		$T_A = 85^\circ C$		Unit	Condition
		Min	Max	Min	Max	Min	Max		
I_{INH}	Input HIGH Current		255		145		145	μA	
I_{INL}	Input LOW Current		0.5		0.5		0.5	μA	
V_{IH}	Input HIGH Voltage	3830	4160	3870	4190	3930	4280	mV	$V_{CCT} = 5.0V$
V_{IL}	Input LOW Voltage	3050	3520	3050	3520	3050	3555	mV	$V_{CCT} = 5.0V$
V_{BB}	Output Bias Voltage	3600	3710	3630	3730	3670	3790	mV	$V_{CCT} = 5.0V$

NOTE: PECL V_{IL} , V_{IH} , V_{OL} , V_{OH} , V_{BB} are given for $V_{CCT} = V_{CCE} = 5.0V$ and will vary 1:1 with power supply.

100H PECL DC CHARACTERISTICS ($V_{CCT} = V_{CCE} = 5.0V \pm 5\%$)

Symbol	Characteristic	$T_A = 0^\circ C$		$T_A = 25^\circ C$		$T_A = 85^\circ C$		Unit	Condition
		Min	Max	Min	Max	Min	Max		
I_{IH}	Input HIGH Current		255		145		145	μA	
I_{IL}	Input LOW Current		0.5		0.5		0.5	μA	
V_{IH}	Input HIGH Voltage	3835	4120	3835	4120	3835	4120	mV	$V_{CCT} = 5.0V$
V_{IL}	Input LOW Voltage	3190	3525	3190	3525	3190	3525	mV	$V_{CCT} = 5.0V$
V_{BB}	Output Bias Voltage	3600	3720	3600	3720	3600	3720	mV	$V_{CCT} = 5.0V$

NOTE: PECL V_{IL} , V_{IH} , V_{OL} , V_{OH} , V_{BB} are given for $V_{CCT} = V_{CCE} = 5.0V$ and will vary 1:1 with power supply.

10H/100H TTL DC CHARACTERISTICS ($V_{CCT} = V_{CCE} = 5.0V \pm 5\%$)

Symbol	Characteristic	$T_A = 0^\circ C$		$T_A = 25^\circ C$		$T_A = 85^\circ C$		Unit	Condition
		Min	Max	Min	Max	Min	Max		
V_{OH}	Output HIGH Voltage	2.5 2.0		2.5 2.0		2.5 2.0		V	$I_{OH} = -15mA$ $I_{OH} = -24mA$
V_{OL}	Output LOW Voltage		0.55		0.55		0.55	V	$I_{OL} = 48mA$

NOTE: DC levels such as V_{OH} , V_{OL} , etc., are standard for PECL and FAST devices, with the exceptions of: $I_{OL} = 48mA$ at $0.5V_{OL}$; and $I_{OH} = 24mA$ at $2.0V_{OH}$.

AC CHARACTERISTICS ($V_{CCT} = V_{CCE} = 5.0V \pm 5\%$)

Symbol	Characteristic	$T_A = 0^\circ C$		$T_A = + 25^\circ C$		$T_A = + 85^\circ C$		Unit	Condition
		Min	Max	Min	Max	Min	Max		
t_{PLH++} t_{PHH+-}	Propagation Delay to Output CLK to Q	5.5 4.6	7.7 7.7	6.0 4.9	8.2 8.3	6.7 5.9	10.0 10.0	ns	CL = 50pF
t_{PHL+-}	Propagation Delay to Output MR to Q	4.4	7.5	4.7	8.1	5.8	10.5	ns	CL = 50pF
t_{PW}	Minimum Pulse Width CLK, MR	1.0		1.0		1.0		ns	
t_r	Rise Time	0.5	2.0	0.5	2.0	0.5	2.0	ns	0.8 – 2.0V
t_f	Fall Time	0.5	2.0	0.5	2.0	0.5	2.0	ns	0.8 – 2.0V
t_S	Setup Time	1.5		1.5		1.5		ns	
t_H	Hold Time	1.5		1.5		1.5		ns	
V_{PP}	Minimum Input Swing	200		200		200		mV	

1. Numbers are for both ++ and -- delay MR to Q.

68030/040 PECL-TTL Clock Driver

The MC10H/100H640 generates the necessary clocks for the 68030, 68040 and similar microprocessors. It is guaranteed to meet the clock specifications required by the 68030 and 68040 in terms of part-to-part skew, within-part skew and also duty cycle skew.

The user has a choice of using either TTL or PECL (ECL referenced to +5.0V) for the input clock. TTL clocks are typically used in present MPU systems. However, as clock speeds increase to 50MHz and beyond, the inherent superiority of ECL (particularly differential ECL) as a means of clock signal distribution becomes increasingly evident. The H640 also uses differential PECL internally to achieve its superior skew characteristic.

The H640 includes divide-by-two and divide-by-four stages, both to achieve the necessary duty cycle skew and to generate MPU clocks as required. A typical 50MHz processor application would use an input clock running at 100MHz, thus obtaining output clocks at 50MHz and 25MHz (see Logic Symbol).

The 10H version is compatible with MECL 10H™ ECL logic levels, while the 100H version is compatible with 100K levels (referenced to +5.0V).

- Generates Clocks for 68030/040
- Meets 030/040 Skew Requirements
- TTL or PECL Input Clock
- Extra TTL and PECL Power/Ground Pins
- Asynchronous Reset
- Single +5.0V Supply

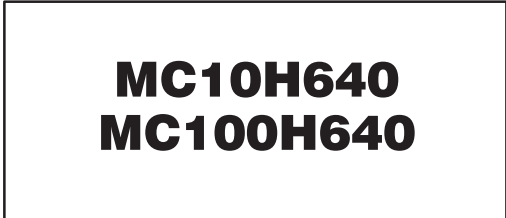
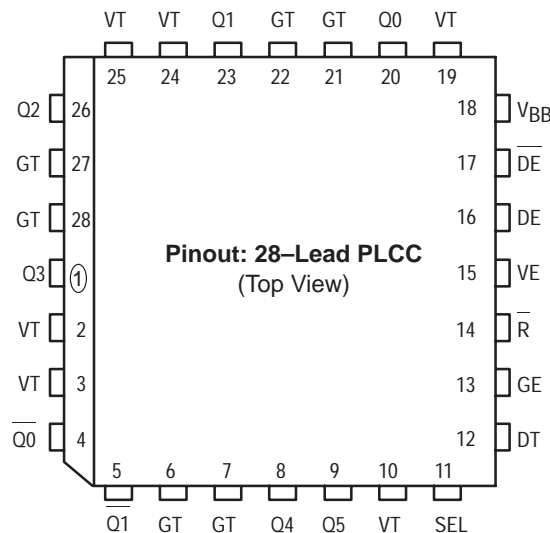
Function

Reset (R): LOW on RESET forces all Q outputs LOW and all \bar{Q} outputs HIGH.

Power-Up: The device is designed to have the POS edges of the +2 and +4 outputs synchronized at power up.

Select (SEL): LOW selects the ECL input source (DE/DE). HIGH selects the TTL input source (DT).

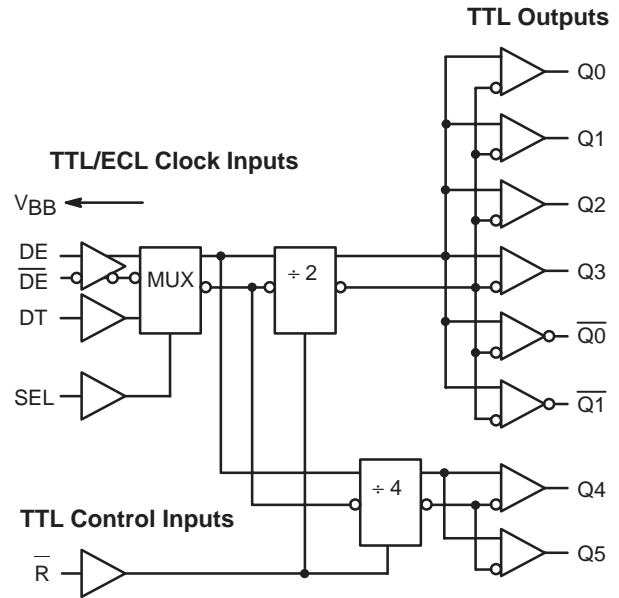
The H640 also contains circuitry to force a stable state of the ECL input differential pair, should both sides be left open. In this case, the DE side of the input is pulled LOW, and DE goes HIGH.



LOGIC DIAGRAM

PIN NAMES

PIN	FUNCTION
GT	TTL Ground (0 V)
VT	TTL V _{CC} (+5.0 V)
VE	ECL V _{CC} (+5.0 V)
GE	ECL Ground (0 V)
DE, \overline{DE}	ECL Signal Input (positive ECL)
V _{BB}	V _{BB} Reference Output
DT	TTL Signal Input
Q _n , \overline{Q}_n	Signal Outputs (TTL)
SEL	Input Select (TTL)
R	Reset (TTL)



AC CHARACTERISTICS (V_T = V_E = 5.0V ±5%)

Symbol	Characteristic		0°C		25°C		85°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
t _{PLH}	Propagation Delay ECL D to Output	Q0-Q3	4.9	5.9	4.9	5.9	5.2	6.2	ns	CL = 25pF
t _{PLH}	Propagation Delay TTL D to Output		5.0	6.0	5.0	6.0	5.3	6.3	ns	CL = 25pF
tskwd*	Within-Device Skew			0.5		0.5		0.5	ns	CL = 25pF
t _{PLH}	Propagation Delay ECL D to Output	Q0, Q1	4.9	5.9	4.9	5.9	5.2	6.2	ns	CL = 25pF
t _{PLH}	Propagation Delay TTL D to Output		5.0	6.0	5.0	6.0	5.3	6.3	ns	CL = 25pF
t _{PLH}	Propagation Delay ECL D to Output	Q4, Q5	4.9	5.9	4.9	5.9	5.2	6.2	ns	CL = 25pF
t _{PLH}	Propagation Delay TTL D to Output		5.0	6.0	5.0	6.0	5.3	6.3	ns	CL = 25pF
t _{PD}	Propagation Delay R to Output	All Outputs	4.3	6.3	4.3	6.3	5.0	7.0	ns	CL = 25pF
t _R t _F	Output Rise/Fall Time 0.8 V – 2.0 V	All Outputs		2.5 2.5		2.5 2.5		2.5 2.5	ns	CL = 25pF
f _{max}	Maximum Input Frequency		135		135		135		MHz	CL = 25pF
t _{pw}	Minimum Pulse Width		1.50		1.50		1.50		ns	
t _{rr}	Reset Recovery Time		1.25		1.25		1.25		ns	

* Within-Device Skew defined as identical transitions on similar paths through a device.

V_{CC} and CLOAD RANGES TO MEET DUTY CYCLE REQUIREMENTS ($0^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$ Output Duty Cycle Measured Relative to 1.5V)

Symbol	Characteristic		Min	Nom	Max	Unit	Condition
	Range of V _{CC} and CL to meet minimum pulse width (HIGH or LOW) = 11.5 ns at f _{out} ≤ 40 MHz	V _{CC} CL	4.75 10	5.0	5.25 50	V pF	Q0–Q3 Q0–Q1
	Range of V _{CC} and CL to meet minimum pulse width (HIGH or LOW) = 9.5 ns at 40 < f _{out} ≤ 50 MHz	V _{CC} CL	4.875 15	5.0	5.125 27	V pF	Q0–Q3

DC CHARACTERISTICS (V_T = V_E = 5.0 V ±5%)

Symbol	Characteristic	0°C		25°C		85°C		Unit	Condition	
		Min	Max	Min	Max	Min	Max			
I _{EE}	Power Supply Current	ECL		57		57		57	mA	VE Pin
I _{CCH}		TTL		30		30		30	mA	Total all VT pins
I _{CCL}				30		30		30	mA	

TTL DC CHARACTERISTICS (V_T = V_E = 5.0 V ±5%)

Symbol	Characteristic	0°C		25°C		85°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
V _{IH} V _{IL}	Input HIGH Voltage Input LOW Voltage	2.0	0.8	2.0	0.8	2.0	0.8	V	
I _{IH}	Input HIGH Current		20 100		20 100		20 100	μA	V _{IN} = 2.7V V _{IN} = 7.0V
I _{IL}	Input LOW Current		–0.6		–0.6		–0.6	mA	V _{IN} = 0.5V
V _{OH}	Output HIGH Voltage	2.5 2.0		2.5 2.0		2.5 2.0		V	I _{OH} = –3.0mA I _{OH} = –15mA
V _{OL}	Output LOW Voltage		0.5		0.5		0.5	V	I _{OL} = 24mA
V _{IK}	Input Clamp Voltage		–1.2		–1.2		–1.2	V	I _{IN} = –18mA
I _{OS}	Output Short Circuit Current	–100	–225	–100	–225	–100	–225	mA	V _{OUT} = 0V

MC10H640 MC100H640

10H PECL DC CHARACTERISTICS (VT = VE = 5.0 V ±5%)

Symbol	Characteristic	0°C		25°C		85°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
I _{IH} I _{IL}	Input HIGH Current Input LOW Current	0.5	225	0.5	175	0.5	175	μA	
V _{IH} * V _{IL} *	Input HIGH Voltage Input LOW Voltage	3.83 3.05	4.16 3.52	3.87 3.05	4.19 3.52	3.94 3.05	4.28 3.555	V	VE = 5.0V
V _{BB} *	Output Reference Voltage	3.62	3.73	3.65	3.75	3.69	3.81	V	

*NOTE: PECL levels are referenced to V_{CC} and will vary 1:1 with the power supply. The values shown are for V_{CC} = 5.0V.

100H PECL DC CHARACTERISTICS (VT = VE = 5.0 V ±5%)

Symbol	Characteristic	0°C		25°C		85°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
I _{IH} I _{IL}	Input HIGH Current Input LOW Current	0.5	225	0.5	175	0.5	175	μA	
V _{IH} * V _{IL} *	Input HIGH Voltage Input LOW Voltage	3.835 3.19	4.12 3.525	3.835 3.19	4.12 3.525	3.835 3.19	4.12 3.525	V	VE = 5.0V
V _{BB} *	Output Reference Voltage	3.62	3.74	3.62	3.74	3.62	3.74	V	

*NOTE: PECL levels are referenced to V_{CC} and will vary 1:1 with the power supply. The values shown are for V_{CC} = 5.0V.

10/100H640 DUTY CYCLE CONTROL

To maintain a duty cycle of ±5% at 50MHz, limit the load capacitance and/or power supply variation as shown in Figures 1 and 2. For a ±2.5% duty cycle limit, see Figures 3 and 4. Figures 5 and 6 show duty cycle variation with temperature. Figure 7 shows typical TPD versus load. Figure 8 shows reset recovery time. Figure 9 shows output states after power up.

Best duty cycle control is obtained with a single μP load and minimum line length.

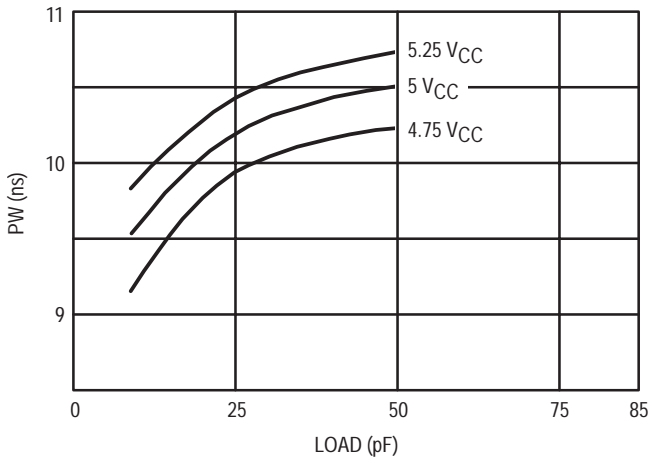


Figure 1. Positive Pulse Width at 25°C Ambient and 50 MHz Out

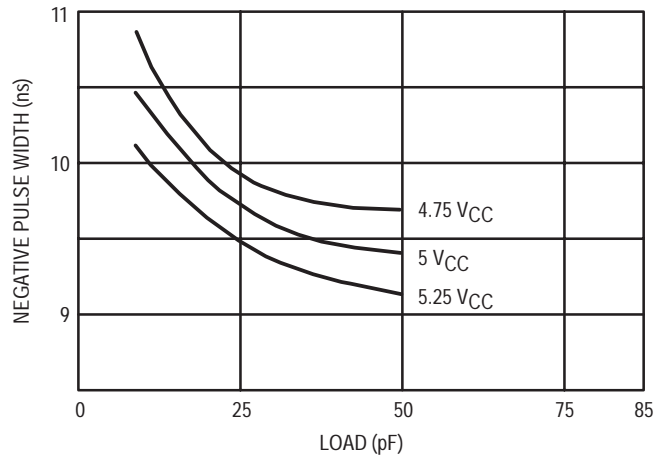


Figure 2. Negative Pulse Width @ 50 MHz Out and 25°C Ambient

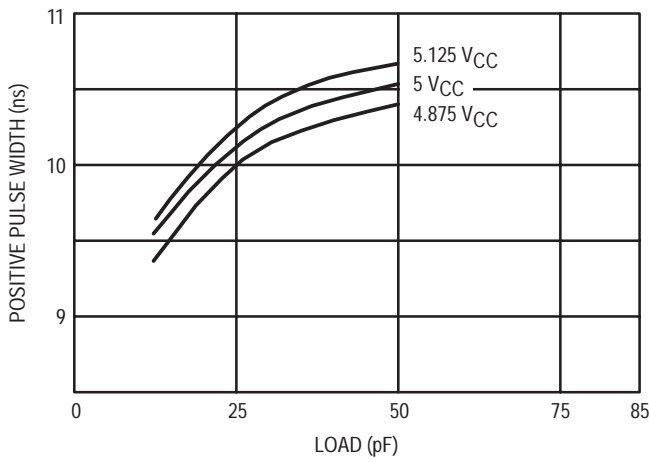


Figure 3. Positive Pulse Width at 25°C Ambient at 50 MHz Out

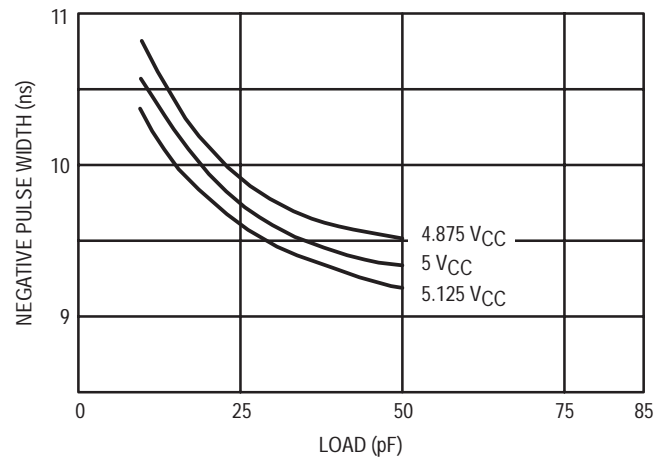


Figure 4. Negative Pulse Width @ 50 MHz Out and 25°C Ambient

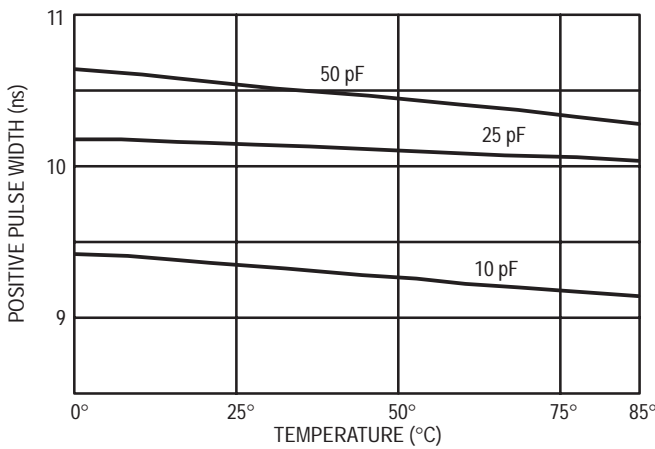


Figure 5. Temperature versus Positive Pulse Width for 100H640 at 50 MHz and +5.0 V V_{CC}

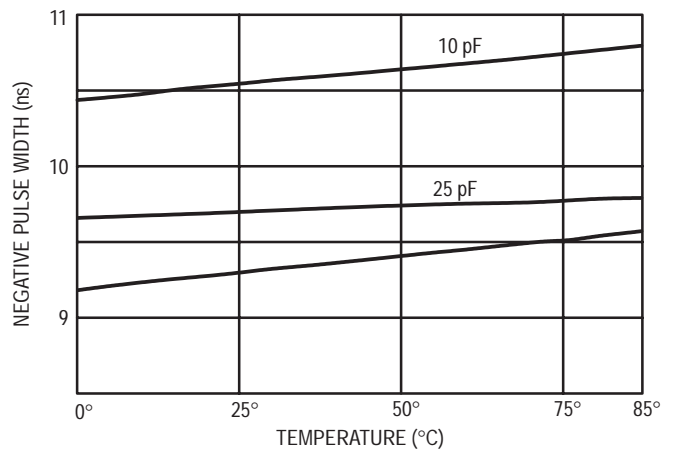


Figure 6. Temperature versus Negative Pulse Width for MC100H640 @ 50 MHz and +5.0 V V_{CC}

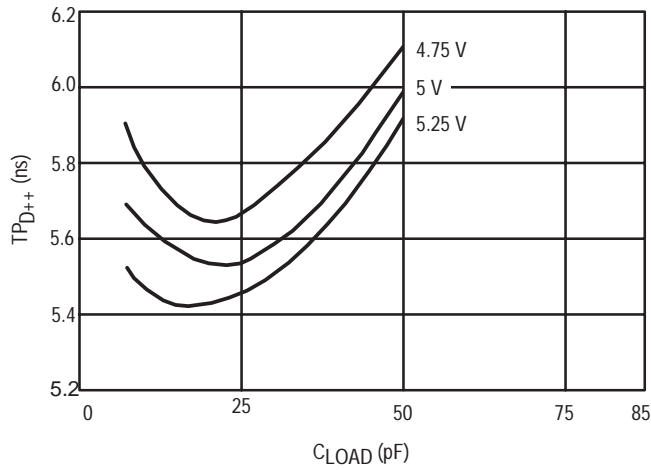


Figure 7. TP versus Load Typical at $T_A = 25^\circ\text{C}$

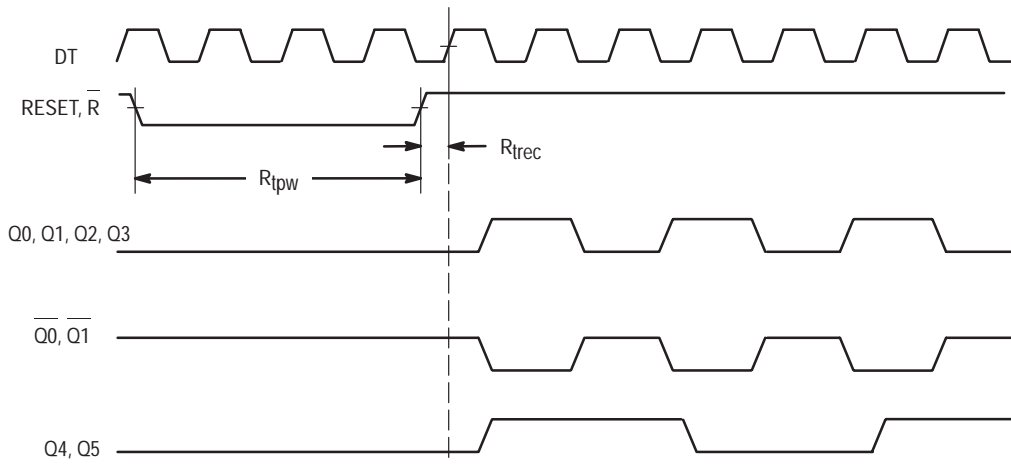
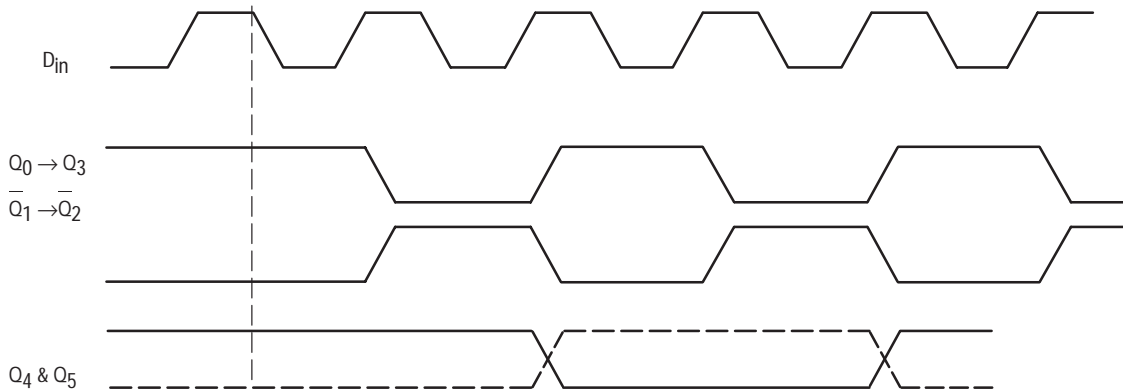


Figure 8. MC10H/100H640 Clock Phase and Reset Recovery Time After Reset Pulse



AFTER POWER UP
 OUTPUTS Q_4 & Q_5 WILL SYN WITH POSITIVE EDGES OF D_{in} & $Q_0 \rightarrow Q_3$ & NEGATIVE EDGES OF \bar{Q}_0 & \bar{Q}_1

Figure 9. Output Timing Diagram

Single Supply PECL-TTL 1:9 Clock Distribution Chip

The MC10H/100H641 is a single supply, low skew translating 1:9 clock driver. Devices in the Motorola H600 translator series utilize the 28-lead PLCC for optimal power pinning, signal flow through and electrical performance.

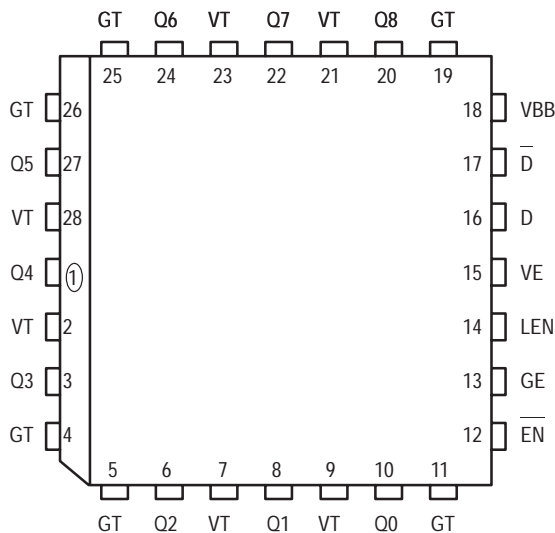
The device features a 24mA TTL output stage, with AC performance specified into a 50pF load capacitance. A latch is provided on-chip. When LEN is LOW (or left open, in which case it is pulled LOW by the internal pulldown) the latch is transparent. A HIGH on the enable pin (EN) forces all outputs LOW. Both the LEN and EN pins are positive ECL inputs.

The V_{BB} output is provided in case the user wants to drive the device with a single-ended input. For single-ended use the V_{BB} should be connected to the D input and bypassed with a 0.01 μ F capacitor.

The 10H version of the H641 is compatible with positive MECL 10H™ logic levels. The 100H version is compatible with positive 100K levels.

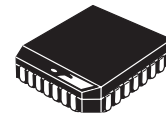
- PECL-TTL Version of Popular ECLinPS E111
- Low Skew
- Guaranteed Skew Spec
- Latched Input
- Differential ECL Internal Design
- V_{BB} Output for Single-Ended Use
- Single +5V Supply
- Logic Enable
- Extra Power and Ground Supplies
- Separate ECL and TTL Supply Pins

Pinout: 28-Lead PLCC (Top View)



MC10H641
MC100H641

SINGLE SUPPLY
PECL-TTL 1:9 CLOCK
DISTRIBUTION CHIP



FN SUFFIX
PLASTIC PACKAGE
CASE 776-02

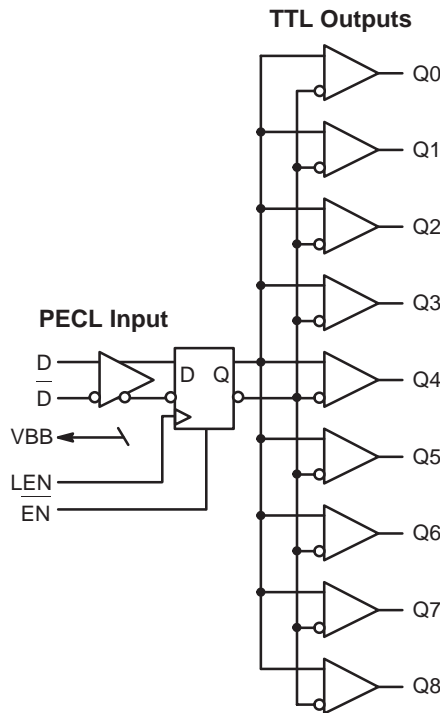
PIN NAMES

Pins	Function
GT, VT	TTL GND, TTL VCC
GE, VE	ECL GND, ECL VCC
D, D	Signal Input (Positive ECL)
V_{BB}	V_{BB} Reference Output (Positive ECL)
Q0-Q8	Signal Outputs (TTL)
EN	Enable Input (Positive ECL)
LEN	Latch Enable Input (Positive ECL)

MECL 10H is a trademark of Motorola, Inc.



LOGIC DIAGRAM



DC CHARACTERISTICS (VT = VE = 5.0V ±5%)

Symbol	Characteristic	TA = 0°C			TA = + 25°C			TA = + 85°C			Unit	Condition
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
IEE	Power Supply Current PECL		24	30		24	30		24	30	mA	
ICCH	TTL		24	30		24	30		24	30	mA	
ICCL			27	35		27	35		27	35	mA	

TTL DC CHARACTERISTICS (VT = VE = 5.0V ±5%)

Symbol	Characteristic	0°C		25°C		85°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
VOH	Output HIGH Voltage	2.5		2.5		2.5		V	I _{OH} = -15mA
VOL	Output LOW Voltage		0.5		0.5		0.5	V	I _{OL} = 24mA
I _{OS}	Output Short Circuit Current	-100	-225	-100	-225	-100	-225	mA	V _{OUT} = 0V

10H PECL DC CHARACTERISTICS

Symbol	Characteristic	0°C		25°C		85°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
I _{IH}	Input HIGH Current		225		175		175	μA	
I _{IL}	Input LOW Current	0.5		0.5		0.5		μA	
V _{IH}	Input HIGH Voltage	3.83	4.16	3.87	4.19	3.94	4.28	V	VE = 5.0V ¹
V _{IL}	Input LOW Voltage	3.05	3.52	3.05	3.52	3.05	3.55	V	VE = 5.0V ¹
V _{BB}	Output Reference Voltage	3.62	3.73	3.65	3.75	3.69	3.81	V	VE = 5.0V ¹

1. PECL V_{IH}, V_{IL}, and V_{BB} are referenced to VE and will vary 1:1 with the power supply. The levels shown are for VE = 5.0V.

100H PECL DC CHARACTERISTICS

Symbol	Characteristic	0°C		25°C		85°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
I _{IH}	Input HIGH Current		225		175		175	μA	
I _{IL}	Input LOW Current	0.5		0.5		0.5		μA	
V _{IH}	Input HIGH Voltage	3.835	4.120	3.835	4.120	3.835	4.120	V	VE = 5.0V ¹
V _{IL}	Input LOW Voltage	3.190	3.525	3.190	3.525	3.190	3.525	V	VE = 5.0V ¹
V _{BB}	Output Reference Voltage	3.62	3.74	3.62	3.74	3.62	3.74	V	VE = 5.0V ¹

1. PECL V_{IH}, V_{IL}, and V_{BB} are referenced to VE and will vary 1:1 with the power supply. The levels shown are for VE = 5.0V.

AC CHARACTERISTICS (VT = VE = 5.0V ±5%)

Symbol	Characteristic	T _J = 0°C			T _J = +25°C			T _J = +85°C			Unit	Condition
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
t _{PLH} t _{PHL}	Propagation Delay D to Q	5.00 5.36	5.50 5.86	6.00 6.36	4.86 5.27	5.36 5.77	5.86 6.27	5.08 5.43	5.58 5.93	6.08 6.43	ns	CL = 50 pF ¹
t _{skew}	Device Skew Part-to-Part Single V _{CC} Output-to-Output			1000 750 350			1000 750 350			1000 750 350	ps	CL = 50pF ² CL = 50 pF ³ CL = 50 pF ⁴
t _{PLH} t _{PHL}	Propagation Delay LEN to Q	4.9		6.9	4.9		6.9	5.0		7.0	ns	CL = 50 pF
t _{PLH} t _{PHL}	Propagation Delay EN to Q	5.0		7.0	4.9		6.9	5.0		7.0	ns	CL = 50 pF
t _r t _f	Output Rise/Fall 0.8V to 2.0V			1.7 1.6			1.7 1.6			1.7 1.6	ns	CL = 50 pF
f _{MAX}	Max Input Frequency	65			65			65			MHz	CL = 50 pF ⁵
t _{REC}	Recovery Time EN	1.25			1.25			1.25			ns	
t _S	Setup Time	0.75	0.50		0.75	0.50		0.75	0.50		ns	
t _H	Hold Time	0.75	0.50		0.75	0.50		0.75	0.50		ns	

1. Propagation delay measurement guaranteed for junction temperatures. Measurements performed at 50MHz input frequency.
2. Skew window guaranteed for a single temperature across a V_{CC} = V_T = V_E of 4.75V to 5.25V (See Application Note in this datasheet).
3. Skew window guaranteed for a single temperature and single V_{CC} = V_T = V_E
4. Output-to-output skew is specified for identical transitions through the device.
5. Frequency at which output levels will meet a 0.8V to 2.0V minimum swing.

DETERMINING SKEW FOR A SPECIFIC APPLICATION

The H641 has been designed to meet the needs of very low skew clock distribution applications. In order to optimize the device for this application special considerations are necessary in the determining of the part-to-part skew specification limits. Older standard logic devices are specified with relatively slack limits so that the device can be guaranteed over a wide range of potential environmental conditions. This range of conditions represented all of the potential applications in which the device could be used. The result was a specification limit that in the vast majority of cases was extremely conservative and thus did not allow for an optimum system design. For non-critical skew designs this practice is acceptable, however as the clock speeds of

systems increase overly conservative specification limits can kill a design.

The following will discuss how users can use the information provided in this data sheet to tailor a part-to-part skew specification limit to their application. The skew determination process may appear somewhat tedious and time consuming, however if the utmost in performance is required this procedure is necessary. For applications which do not require this level of skew performance a generic part-to-part skew limit of 2.5ns can be used. This limit is good for the entire ambient temperature range, the guaranteed V_{CC} (V_T, V_E) range and the guaranteed operating frequency range.

Temperature Dependence

A unique characteristic of the H641 data sheet is that the AC parameters are specified for a junction temperature rather than the usual ambient temperature. Because very few designs will actually utilize the entire commercial temperature range of a device a tighter propagation delay window can be established given the smaller temperature range. Because the junction temperature and not the ambient temperature is what affects the performance of the device the parameter limits are specified for junction temperature. In addition the relationship between the ambient and junction temperature will vary depending on the frequency, load and board environment of the application. Since these factors are all under the control of the user it is impossible to provide specification limits for every possible application. Therefore a baseline specification was established for specific junction temperatures and the information that follows will allow these to be tailored to specific applications.

Since the junction temperature of a device is difficult to measure directly, the first requirement is to be able to “translate” from ambient to junction temperatures. The standard method of doing this is to use the power dissipation of the device and the thermal resistance of the package. For a TTL output device the power dissipation will be a function of the load capacitance and the frequency of the output. The total power dissipation of a device can be described by the following equation:

$$P_D \text{ (watts)} = I_{CC} \text{ (no load)} * V_{CC} + V_S * V_{CC} * f * C_L * \# \text{ Outputs}$$

where:

- V_S = Output Voltage Swing = 3V
- f = Output Frequency
- C_L = Load Capacitance
- I_{CC} = I_{EE} + I_{CCH}

Figure 1 plots the I_{CC} versus Frequency of the H641 with no load capacitance on the output. Using this graph and the information specific to the application a user can determine the power dissipation of the H641.

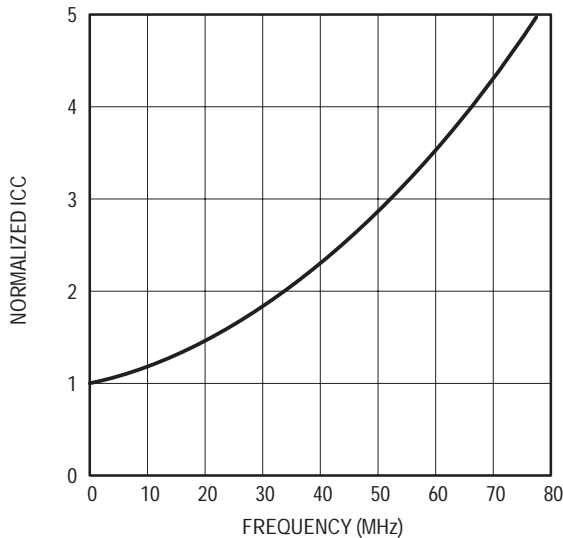


Figure 1. I_{CC} versus f (No Load)

Figure 2 illustrates the thermal resistance (in °C/W) for the 28-lead PLCC under various air flow conditions. By reading the thermal resistance from the graph and multiplying by the power dissipation calculated above the junction temperature increase above ambient of the device can be calculated.

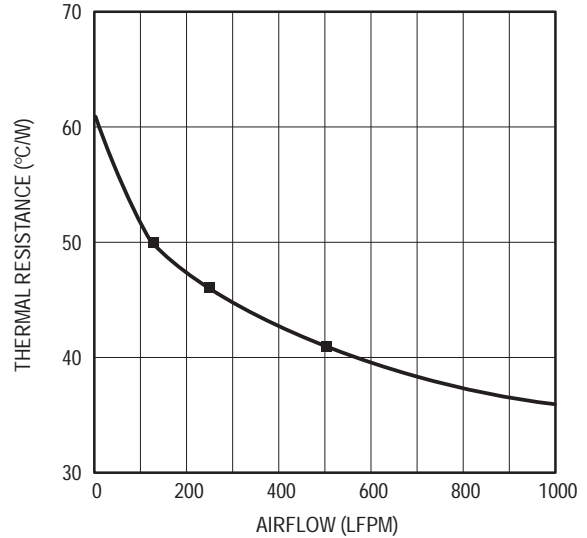


Figure 2. θ_{JA} versus Air Flow

Finally taking this value for junction temperature and applying it to Figure 3 allows the user to determine the propagation delay for the device in question. A more common use would be to establish an ambient temperature range for the H641's in the system and utilize the above methodology to determine the potential increased skew of the distribution network. Note that for this information if the T_{PD} versus Temperature curve were linear over all temperatures would not be required. If the curve were linear over all temperatures a simple temperature coefficient could be provided.

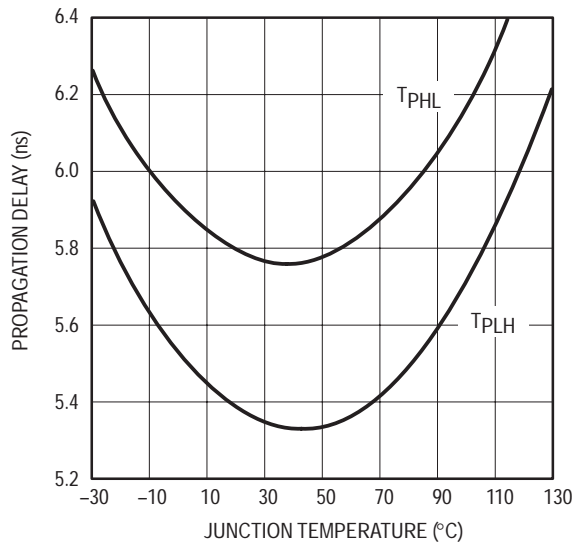


Figure 3. T_{PD} versus Junction Temperature

V_{CC} Dependence

TTL and CMOS devices show a significant propagation delay dependence with V_{CC}. Therefore the V_{CC} variation in a system will have a direct impact on the total skew of the clock distribution network. When calculating the skew between two devices on a single board it is very likely an assumption of identical V_{CC}'s can be made. In this case the number provided in the data sheet for part-to-part skew would be overly conservative. By using Figure 4 the skew given in the data sheet can be reduced to represent a smaller or zero variation in V_{CC}. The delay variation due to the specified V_{CC} variation is ≈270ps. Therefore, the 1ns window on the data sheet can be reduced by 270ps if the devices in question will always experience the same V_{CC}. The distribution of the propagation delay ranges given in the data sheet is actually a composite of three distributions whose means are separated by the fixed difference in propagation delay at the typical, minimum and maximum V_{CC}.

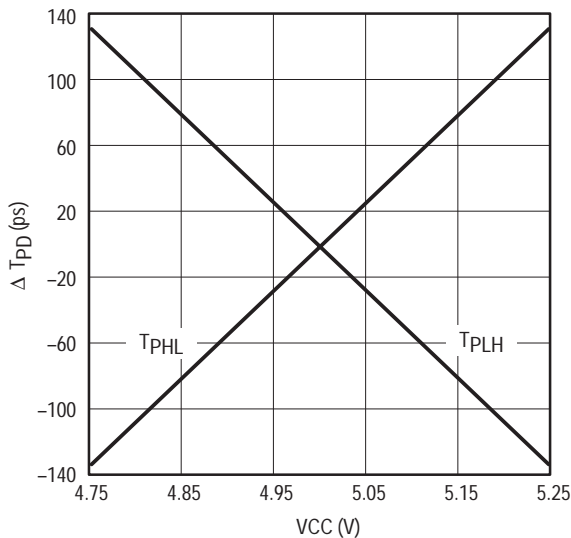


Figure 4. ΔT_{PD} versus V_{CC}

Capacitive Load Dependence

As with V_{CC} the propagation delay of a TTL output is intimately tied to variation in the load capacitance. The skew specifications given in the data sheet, of course, assume equal loading on all of the outputs. However situations could arise where this is an impossibility and it may be necessary to estimate the skew added by asymmetric loading. In addition the propagation delay numbers are provided only for 50pF loads, thus necessitating a method of determining the propagation delay for alternative loads.

Figure 5 shows the relationship between the two propagation delays with respect to the capacitive load on the output. Utilizing this graph and the 50pF limits the specification of the H641 can be mapped into a spec for either a different value load or asymmetric loads.

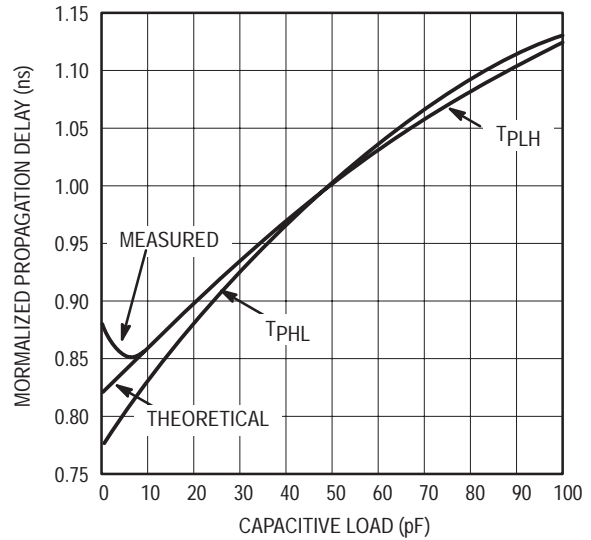


Figure 5. T_{PD} versus Load

Rise/Fall Skew Determination

The rise-to-fall skew is defined as simply the difference between the T_{PLH} and the T_{PHL} propagation delays. This skew for the H641 is dependent on the V_{CC} applied to the device. Notice from Figure 4 the opposite relationship of T_{PD} versus V_{CC} between T_{PLH} and T_{PHL}. Because of this the rise-to-fall skew will vary depending on V_{CC}. Since in all likelihood it will be impossible to establish the exact value for V_{CC}, the expected variation range for V_{CC} should be used. If this variation will be the ±5% shown in the data sheet the rise-to-fall skew could be established by simply subtracting the fastest T_{PLH} from the slowest T_{PHL}; this exercise yields 1.41ns. If a tighter V_{CC} range can be realized Figure 4 can be used to establish the rise-to-fall skew.

Specification Limit Determination Example

The situation pictured in Figure 6 will be analyzed as an example. The central clock is distributed to two different cards; on one card a single H641 is used to distribute the clock while on the second card two H641's are required to supply the needed clocks. The data sheet as well as the graphical information of this section will be used to calculate the skew between H641a and H641b as well as the skew between all three of the devices. Only the T_{PLH} will be analyzed, the T_{PHL} numbers can be found using the same technique. The following assumptions will be used:

- All outputs will be loaded with 50pF
- All outputs will toggle at 30MHz
- The V_{CC} variation between the two boards is ±3%
- The temperature variation between the three devices is ±15°C around an ambient of 45°C.
- 500LFPM air flow

The first task is to calculate the junction temperature for the devices under these conditions. Using the power equation yields:

$$\begin{aligned}
 P_D &= I_{CC} \text{ (no load)} * V_{CC} + \\
 &\quad V_{CC} * V_S * f * C_L * \# \text{ outputs} \\
 &= 1.8 * 48\text{mA} * 5\text{V} + 5\text{V} * 3\text{V} * 30\text{MHz} * \\
 &\quad 50\text{pF} * 9 \\
 &= 432\text{mW} + 203\text{mW} = 635\text{mW}
 \end{aligned}$$

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Using the thermal resistance graph of Figure 2 yields a thermal resistance of 41°C/W which yields a junction temperature of 71°C with a range of 56°C to 86°C. Using the T_{PD} versus Temperature curve of Figure 3 yields a propagation delay of 5.42ns and a variation of 0.19ns.

Since the design will not experience the full $\pm 5\%$ V_{CC} variation of the data sheet the 1ns window provided will be unnecessarily conservative. Using the curve of Figure 4 shows a delay variation due to a $\pm 3\%$ V_{CC} variation of ± 0.075 ns. Therefore the 1ns window can be reduced to $1\text{ns} - (0.27\text{ns} - 0.15\text{ns}) = 0.88\text{ns}$. Since H641a and H641b are on the same board we will assume that they will always be at the same V_{CC} ; therefore the propagation delay window will only be $1\text{ns} - 0.27\text{ns} = 0.73\text{ns}$.

Putting all of this information together leads to a skew between all devices of

$$0.19\text{ns} + 0.88\text{ns} \\ (\text{temperature} + \text{supply, and inherent device}),$$

while the skew between devices A and B will be only

$$0.19\text{ns} + 0.73\text{ns} \\ (\text{temperature} + \text{inherent device only}).$$

In both cases, the propagation delays will be centered around 5.42ns, resulting in the following t_{PLH} windows:

$$T_{PLH} = 4.92\text{ns} - 5.99\text{ns}; 1.07\text{ns window} \\ (\text{all devices})$$

$$T_{PLH} = 5.00\text{ns} - 5.92\text{ns}; 0.92\text{ns window} \\ (\text{devices a \& b})$$

Of course the output-to-output skew will be as shown in the data sheet since all outputs are equally loaded.

This process may seem cumbersome, however the delay windows, and thus skew, obtained are significantly better than

the conservative worst case limits provided at the beginning of this note. For very high performance designs, this extra information and effort can mean the difference between going ahead with prototypes or spending valuable engineering time searching for alternative approaches.

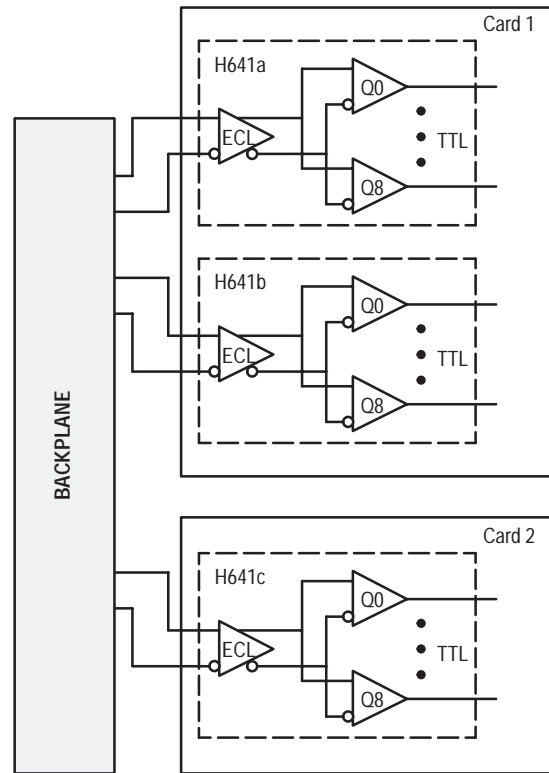


Figure 6. Example Application

68030/040 PECL-TTL Clock Driver

The MC10H/100H642 generates the necessary clocks for the 68030, 68040 and similar microprocessors. It is guaranteed to meet the clock specifications required by the 68030 and 68040 in terms of part-to-part skew, within-part skew and also duty cycle skew.

The user has a choice of using either TTL or PECL (ECL referenced to +5.0V) for the input clock. TTL clocks are typically used in present MPU systems. However, as clock speeds increase to 50MHz and beyond, the inherent superiority of ECL (particularly differential ECL) as a means of clock signal distribution becomes increasingly evident. The H642 also uses differential PECL internally to achieve its superior skew characteristic.

The H642 includes divide-by-two and divide-by-four stages, both to achieve the necessary duty cycle skew and to generate MPU clocks as required. A typical 50MHz processor application would use an input clock running at 100MHz, thus obtaining output clocks at 50MHz and 25MHz (see Logic Diagram).

The 10H version is compatible with MECL 10H™ ECL logic levels, while the 100H version is compatible with 100K levels (referenced to +5.0V).

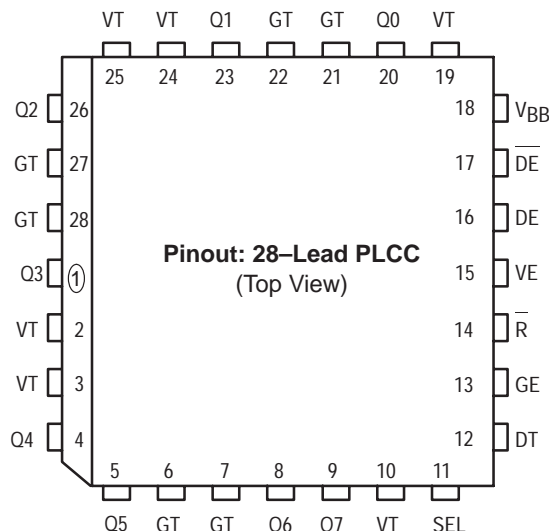
- Generates Clocks for 68030/040
- Meets 030/040 Skew Requirements
- TTL or PECL Input Clock
- Extra TTL and PECL Power/Ground Pins
- Asynchronous Reset
- Single +5.0V Supply

Function

- Reset(R)*: LOW on RESET forces all Q outputs LOW.
- Select(SEL)*: LOW selects the ECL input source (DE/DE).
HIGH selects the TTL input source (DT).

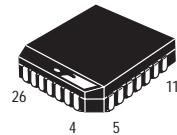
The H642 also contains circuitry to force a stable input state of the ECL differential input pair, should both sides be left open. In this Case, the DE side of the input is pulled LOW, and DE goes HIGH.

Power Up: The device is designed to have positive edges of the +2 and +4 outputs synchronized at Power Up.



MC10H642
MC100H642

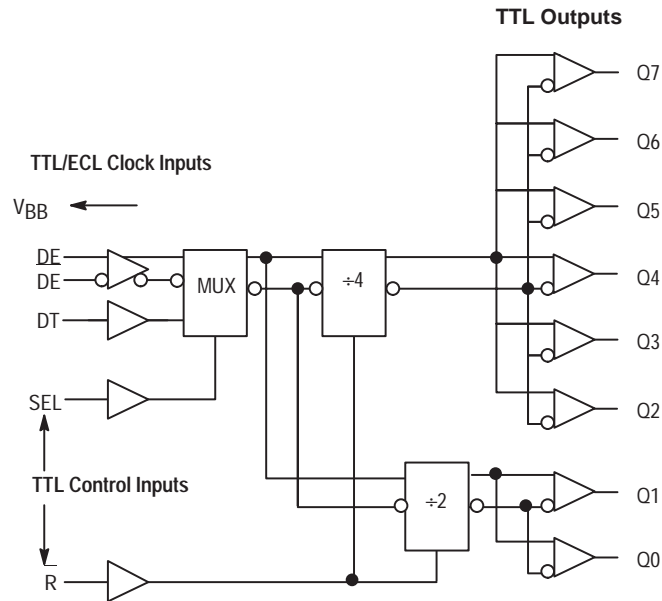
68030/040
PECL-TTL CLOCK
DRIVER



FN SUFFIX
PLASTIC PACKAGE
CASE 776-02



LOGIC DIAGRAM



PIN NAMES

Pin	Symbol	Description	Pin	Symbol	Description
1	Q3	Signal Output (TTL)**	15	VE	ECL V _{CC} (+5.0V)
2	VT	TTL V _{CC} (+5.0V)	16	DE	ECL Signal Input (Non-Inverting)
3	VT	TTL V _{CC} (+5.0V)	17	DE	ECL Signal Input (Inverting)
4	Q4	Signal Output (TTL)**	18	V _{BB}	V _{BB} Reference Output
5	Q5	Signal Output (TTL)**	19	VT	TTL V _{CC} (+5.0V)
6	GT	TTL Ground (0V)	20	Q0	Signal Output (TTL)*
7	GT	TTL Ground (0V)	21	GT	TTL Ground (0V)
8	Q6	Signal Output (TTL)**	22	GT	TTL Ground (0V)
9	Q7	Signal Output (TTL)**	23	Q1	Signal Output (TTL)*
10	VT	TTL V _{CC} (+5.0V)	24	VT	TTL V _{CC} (+5.0V)
11	SEL	Input Select (TTL)	25	VT	TTL V _{CC} (+5.0V)
12	DT	TTL Signal Input	26	Q2	Signal Output (TTL)**
13	GE	ECL Ground (0V)	27	GT	TTL Ground (0V)
14	R	Reset (TTL)	28	GT	TTL Ground (0V)

*Divide by 2

**Divide by 4

AC CHARACTERISTICS (VT = VE = 5.0V ±5%)

Symbol	Characteristic		TA = 0°C		TA = 25°C		TA = 85°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
tPLH	Propagation Delay D to Output	Q2-Q7 C ECL C TTL	4.70 4.70	5.70 5.70	4.75 4.75	5.75 5.75	4.60 4.50	5.60 5.50	ns	CL = 25pF
tskpp	Part-to-Part Skew			1.0		1.0		1.0	ns	
tskwd*	Within-Device Skew			0.5		0.5		0.5	ns	
tPLH	Propagation Delay D to Output	Q0, Q1 C ECL C TTL	4.30 4.30	5.30 5.30	4.50 4.50	5.50 5.50	4.25 4.25	5.25 5.25	ns	CL = 25pF
tskpp	Part-to-Part Skew	All Outputs		2.0		2.0		2.0	ns	CL = 25pF
tskwd	Within-Device Skew			1.0		1.0		1.0	ns	CL = 25pF
tPD	Propagation Delay R to Output	All Outputs	4.3	6.3	4.0	6.0	4.5	6.5	ns	CL = 25pF
tR tF	Output Rise/Fall Time 0.8 V to 2.0 V	All Outputs		2.5 2.5		2.5 2.5		2.5 2.5	ns	CL = 25pF
fMAX**	Maximum Input Frequency		100		100		100		MHz	CL = 25pF
RPW	Reset Pulse Width		1.5		1.5		1.5		ns	
RRT	Reset Recovery Time		1.25		1.25		1.25		ns	

* Within-Device Skew defined as identical transactions on similar paths through a device.

** NOTE: MAX Frequency is 135MHz.

10H PECL CHARACTERISTICS (VT = VE = 5.0V ±5%)

Symbol	Characteristic	TA = 0°C		TA = 25°C		TA = 85°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
I _{IH} I _{IL}	Input HIGH Current Input LOW Current	0.5	225	0.5	175	0.5	175	μA	
V _{IH} V _{IL}	* NOTE Input HIGH Voltage Input LOW Voltage	3.83 3.05	4.16 3.52	3.87 3.05	4.19 3.52	3.94 3.05	4.28 3.555	V	V _{EE} = 5.0V
V _{BB}	* NOTE Output Reference Voltage	3.62	3.73	3.65	3.75	3.69	3.81	V	

100H PECL CHARACTERISTICS (VT = VE = 5.0V ±5%)

Symbol	Characteristic	TA = 0°C		TA = 25°C		TA = 85°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
I _{IH} I _{IL}	Input HIGH Current Input LOW Current	0.5	225	0.5	175	0.5	175	μA	
V _{IH} V _{IL}	* NOTE Input HIGH Voltage Input LOW Voltage	3.835 3.190	4.120 3.525	3.835 3.190	4.120 3.525	3.835 3.190	4.120 3.525	V	V _{EE} = 5.0V
V _{BB}	* NOTE Output Reference Voltage	3.620	3.740	3.620	3.740	3.620	3.740	V	

*NOTE: PECL LEVELS are referenced to V_{CC} and will vary 1:1 with the power supply. The VALUES shown are for V_{CC} = 5.0V.

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10H/100H DC CHARACTERISTICS (VT = VE = 5.0V ±5%)

Symbol	Characteristic		TA = 0°C		TA = 25°C		TA = 85°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
I _{EE}	Power Supply Current	PECL		57		57		57	mA	VE Pin
I _{CCH}		TTL		30		30		30	mA	Total All VT Pins
I _{CCL}				30		30		30	mA	

10H/100H TTL DC CHARACTERISTICS (VT = VE = 5.0V ±5%)

Symbol	Characteristic		TA = 0°C		TA = 25°C		TA = 85°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
V _{IH} V _{IL}	Input HIGH Voltage Input LOW Voltage	2.0	0.8	2.0	0.8	2.0	0.8	V		
I _{IH}	Input HIGH Current		20 100		20 100		20 100	μA	V _{IN} = 2.7V V _{IN} = 7.0V	
I _{IL}	Input LOW Current		-0.6		-0.6		-0.6	mA	V _{IN} = 0.5V	
V _{OH}	Output HIGH Voltage	2.5 2.0		2.5 2.0		2.5 2.0		V	I _{OH} = -3.0mA I _{OH} = -15mA	
V _{OL}	Output LOW Voltage		0.5		0.5		0.5	V	I _{OL} = 24mA	
V _{IK}	Input Clamp Voltage		-1.2		-1.2		-1.2	V	I _{IN} = -18mA	
I _{OS}	Output Short Circuit Current	-100	-225	-100	-225	-100	-225	mA	V _{OUT} = 0V	

10/100H642 DUTY CYCLE CONTROL

To maintain a duty cycle of ±5% at 50 MHz, limit the load capacitance and/or power supply variation as shown in Figures 1 and 2. For a ±2.5% duty cycle limit, see Figures 3 and 4. Figures 5 and 6 show duty cycle variation with temperature. Figure 7 shows typical TPD versus load. Figure 8 shows reset recovery time. Figure 9 shows output states after power up.

Best duty cycle control is obtained with a single μP load and minimum line length.

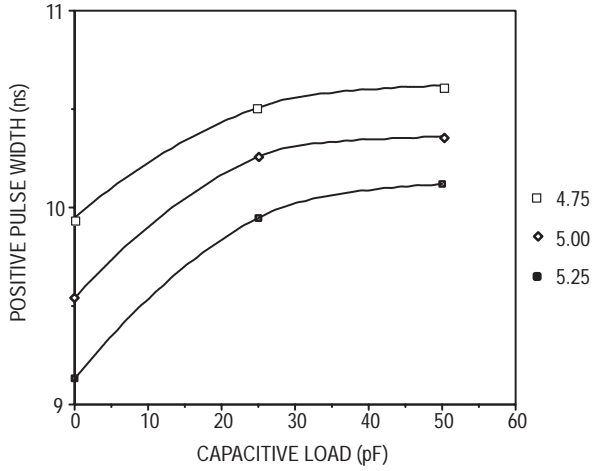


Figure 1. MC10H642 Positive PW versus Load @ ±5% V_{CC}, T_A = 25°C

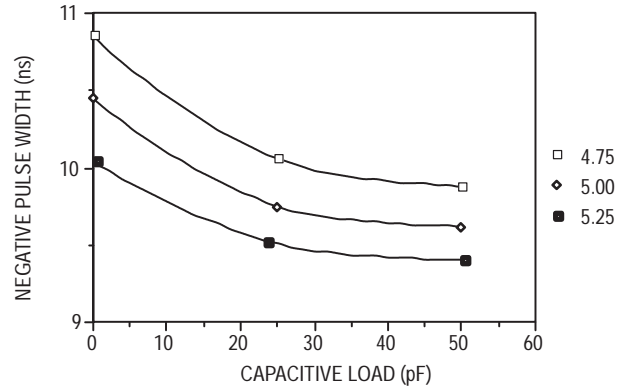


Figure 2. MC10H642 Negative PW versus Load @ ±5% V_{CC}, T_A = 25°C

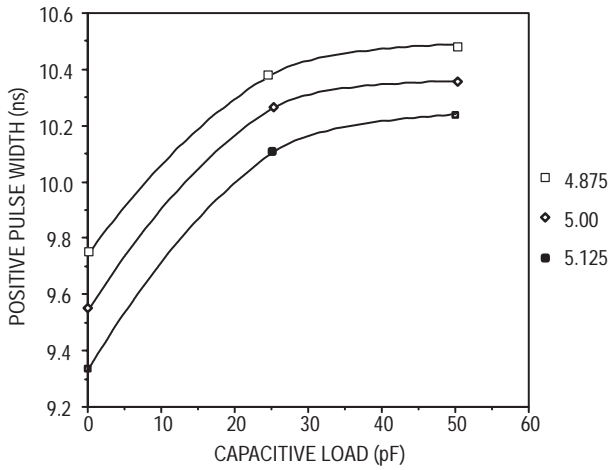


Figure 3. MC10H642 Positive PW versus Load @ ±2.5% V_{CC}, T_A = 25°C

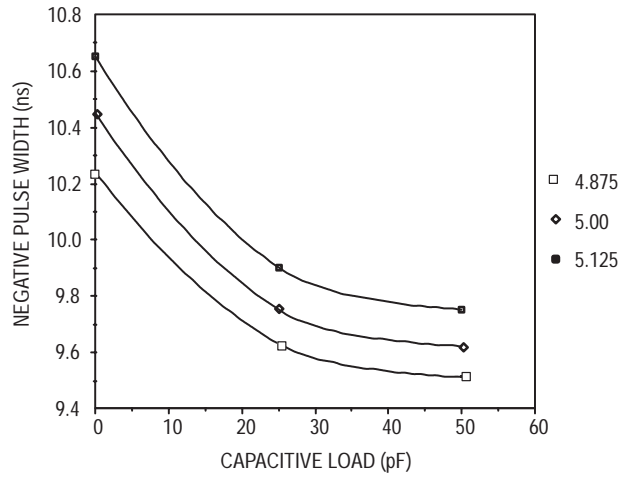


Figure 4. MC10H642 Negative PW versus Load @ ±2.5% V_{CC}, T_A = 25°C

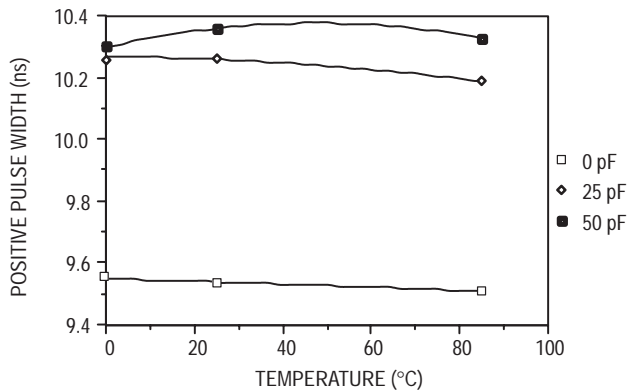


Figure 5. MC10H642 Positive PW versus Temperature, V_{CC} = 5.0V

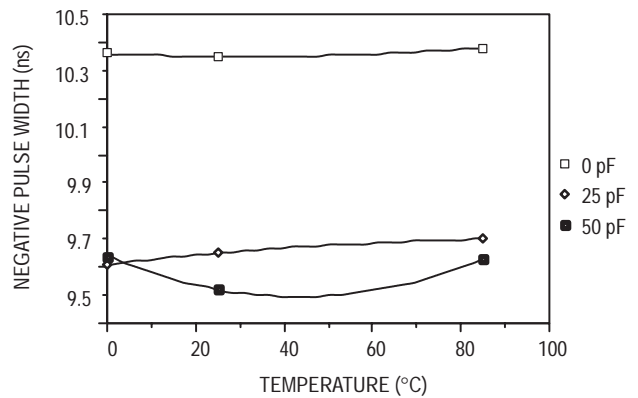


Figure 6. MC10H642 Negative PW versus Temperature, V_{CC} = 5.0V

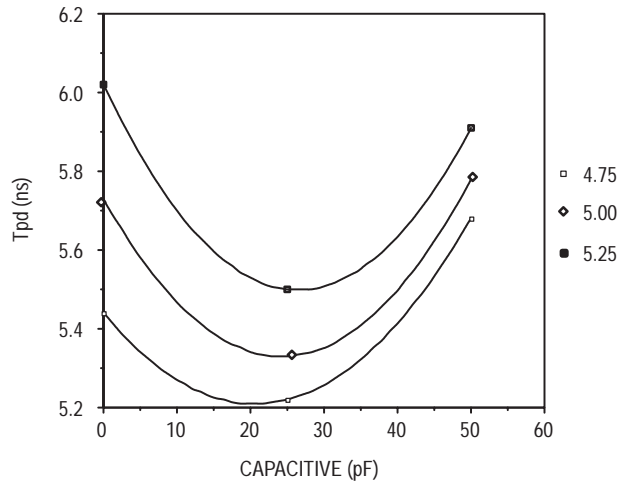


Figure 7. MC10H642 + Tpd versus Load, $V_{CC} \pm 5\%$, $T_A = 25^\circ C$
 (Overshoot at 50 MHz with no load makes graph non linear)

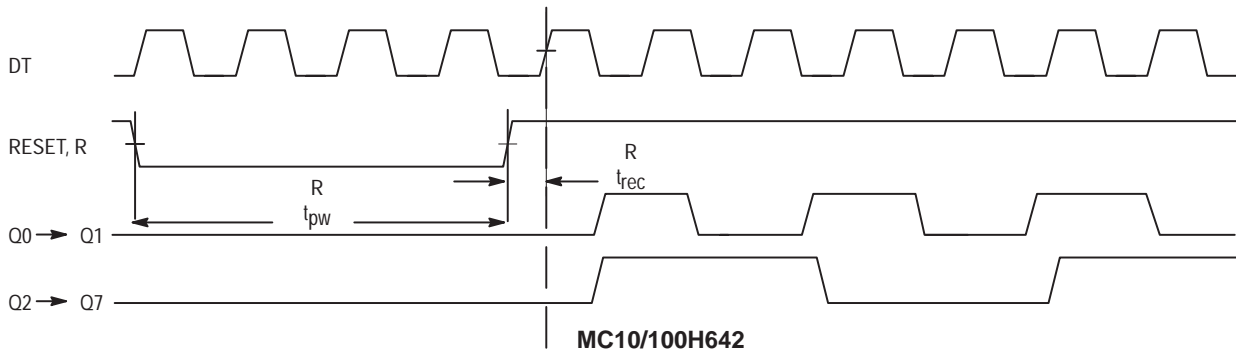


Figure 8. Clock Phase and Reset Recovery Time After Reset Pulse

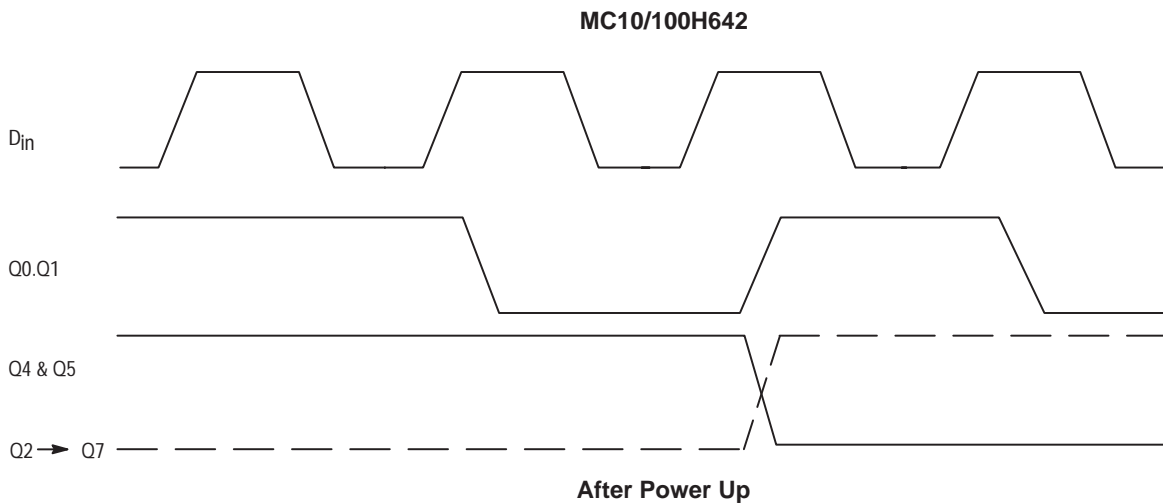
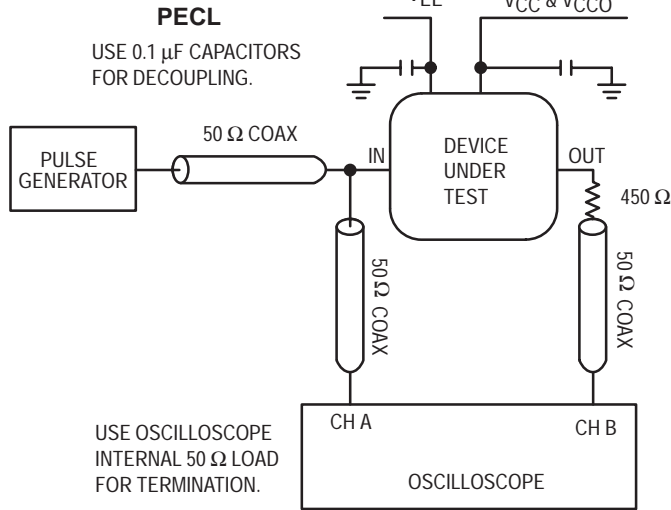


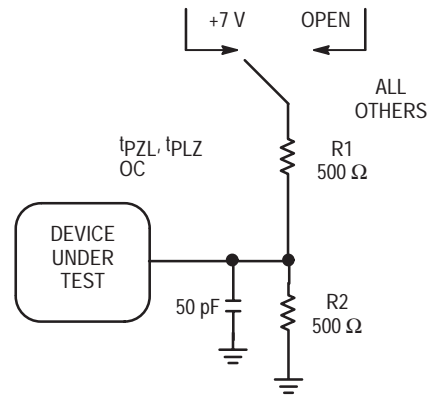
Figure 9. Outputs Q2 → Q7 will Synchronize with Pos Edges of D_{in} & Q0 → Q1

SWITCHING CIRCUIT AND WAVEFORMS

Switching Circuit PECL:



TTL



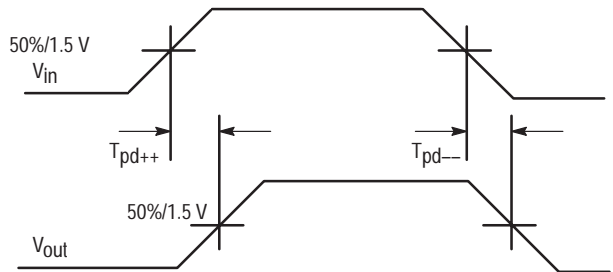
WAVEFORMS: Rise and Fall Times

PECL/TTL



Propagation Delay — Single Ended

PECL/TTL



Dual Supply ECL-TTL 1:8 Clock Driver

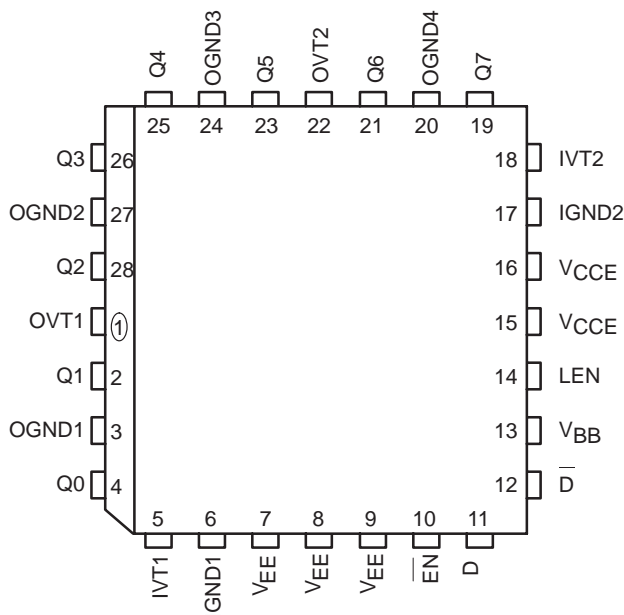
The MC10H/100H643 is a dual supply, low skew translating 1:8 clock driver. Devices in the Motorola H600 translator series utilize the 28-lead PLCC for optimal power pinning, signal flow through and electrical performance. The dual-supply H643 is similar to the H641, which is a single-supply 1:9 version of the same function.

The device features a 48mA TTL output stage, with AC performance specified into a 50pF load capacitance. A Latch is provided on-chip. When LEN is LOW (or left open, in which case it is pulled LOW by the internal pulldowns) the latch is transparent. A HIGH on the enable pin (EN) forces all outputs LOW.

The 10H version is compatible with MECL 10H™ ECL logic levels. The 100H version is compatible with 100K levels.

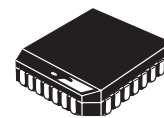
- ECL/TTL Version of Popular ECLinPS™ E111
- Low Skew Within Device 0.5ns
- Guaranteed Skew Spec Part-to-Part 1.0ns
- Latch
- Differential Internal Design
- V_{BB} Output
- Dual Supply
- Reset/Enable
- Multiple TTL and ECL Power/Ground Pins

Pinout: 28-Lead PLCC (Top View)



MC10H643
MC100H643

DUAL SUPPLY
ECL-TTL 1:8
CLOCK DRIVER



FN SUFFIX
PLASTIC PACKAGE
CASE 776-02

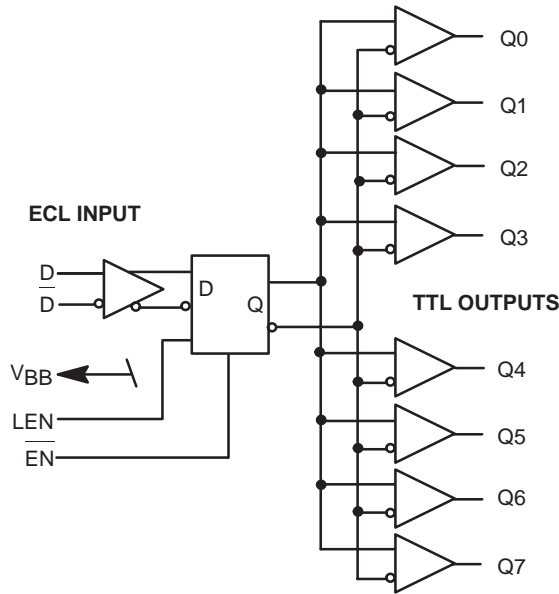
PIN NAMES

PIN	FUNCTION
OGND	TTL Output Ground (0V)
OVT	TTL Output V _{CC} (+5.0V)
IGND	Internal TTL GND (0V)
IVT	Internal TTL V _{CC} (+5.0V)
V _{EE}	ECL V _{EE} (-5.2/-4.5V)
V _{CC1}	ECL Ground (0V)
D, D	Signal Input (ECL)
V _{BB}	V _{BB} Reference Output
Q0-Q7	Signal Outputs (TTL)
EN	Enable Input (ECL)
LEN	Latch Enable Input (ECL)

ECLinPS and MECL 10H are trademarks of Motorola, Inc.



LOGIC DIAGRAM



DC CHARACTERISTICS (IVT = OVT = 5.0V ±5%; VEE = -5.2V ±5% (10H Version); VEE = -4.5V ±0.3V (100H Version))

Symbol	Characteristic	0°C		25°C		85°C		Unit	Condition	
		Min	Max	Min	Max	Min	Max			
I _{EE}	Power Supply Current	ECL	-	42	-	42	-	42	mA	V _{EE} Pins
I _{CCL}		TTL	-	106	-	106	-	106	mA	Total all OVT
I _{CCH}			-	95	-	95	-	95	mA	and IVT pins

AC CHARACTERISTICS (IVT = OVT = 5.0V ±5%; VEE = -5.2V ±10% (10H); -4.5V ±0.3V (100H); V_{CCE} = GND)

Symbol	Characteristic	0°C		25°C		85°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
t _{PLH}	Propagation Delay to Output D LEN EN	4.0 3.5 3.5	5.0 5.5 5.5	4.1 3.5 3.5	5.1 5.5 5.5	4.4 3.9 3.9	5.4 5.9 5.9	ns	CL = 50pF
t _{SKEW}	Within-Device Skew	-	0.5	-	0.5		0.5	ns	Note 1
t _w	Pulse Width Out HIGH or LOW @ f _{out} = 50MHz	9.0	11.0	9.0	11.0	9.0	11.0	ns	CL = 50pF Note 2
t _s	Setup Time D	0.75	-	0.75	-	0.75	-	ns	
t _h	Hold Time D	0.75	-	0.75	-	0.75	-	ns	
t _{RR}	Recovery Time LEN EN	1.25 1.25	- -	1.25 1.25	- -	1.25 1.25	- -	ns	
t _{pw}	Minimum Pulse Width LEN EN	1.5 1.5	- -	1.5 1.5	- -	1.5 1.5	- -	ns	
t _r t _f	Rise / Fall Times 0.8 V – 2.0 V	-	1.2	-	1.2	-	1.2	ns	CL = 50pF

1. Within-Device skew defined as identical transitions on similar paths through a device.
 2. Pulse width is defined relative to 1.5V measurement points on the output waveform.

MC10H643 MC100H643

TRUTH TABLE

D	LEN	$\overline{\text{EN}}$	Q
L	L	L	L
H	L	L	H
X	H	L	Q _O
X	X	H	L

DC CHARACTERISTICS (IVT = OVT = 5.0V ±5%; V_{EE} = -5.2V ±5% (10H Version); V_{EE} = -4.5V ±0.3V (100H Version))

Symbol	Characteristic	0°C		25°C		85°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
V _{OH}	Output HIGH Voltage	2.5 2.0	- -	2.5 2.0	- -	2.5 2.0	- -	V	I _{OH} = -3.0mA I _{OH} = -15mA
V _{OL}	Output LOW Voltage	-	0.5	-	0.5	-	0.5	V	I _{OH} = 48mA
IOS	Output Short Circuit Current	-100	-225	-100	-225	-100	-225	mA	V _{OUT} = 0V

10H DC CHARACTERISTICS (IVT = OVT = 5.0V ±5%; V_{EE} = -5.2V ±5% (10H Version); V_{EE} = -4.5V ±0.3V (100H Version))

Symbol	Characteristic	0°C		25°C		85°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
I _{IH} I _{IL}	Input HIGH Current Input LOW Current	- 0.5	225 -	- 0.5	175 -	- 0.5	175 -	μA	
V _{IH} V _{IL}	Input HIGH Voltage Input LOW Voltage	-1170 -1950	-840 -1480	-1130 -1950	-810 -1480	-1070 -1950	-735 -1450	mV	
V _{BB}	Output Reference Voltage	-1380	-1270	-1350	-1250	-1310	-1190	mV	

100H DC CHARACTERISTICS (IVT = OVT = 5.0V ±5%; V_{EE} = -5.2V ±5% (10H); V_{EE} = -4.5V ±0.3V (100H))

Symbol	Characteristic	0°C		25°C		85°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
I _{IH} I _{IL}	Input HIGH Current Input LOW Current	- 0.5	225 -	- 0.5	175 -	- 0.5	175 -	μA	
V _{IH} V _{IL}	Input HIGH Voltage Input LOW Voltage	-1165 -1810	-880 -1475	-1165 -1810	-880 -1475	-1165 -1810	-880 -1475	mV	
V _{BB}	Output Reference Voltage	-1380	-1260	-1380	-1260	-1380	-1260	mV	

68030/040 PECL-TTL Clock Driver

The MC10H/100H644 generates the necessary clocks for the 68030, 68040 and similar microprocessors. The device is functionally equivalent to the H640, but with fewer outputs in a smaller outline 20-lead PLCC package. It is guaranteed to meet the clock specifications required by the 68030 and 68040 in terms of part-to-part skew, within-part skew and also duty cycle skew.

- Generates Clocks for 68030/040
- Meets 68030/040 Skew Requirements
- TTL or PECL Input Clock
- Extra TTL and ECL Power/Ground Pins
- Within Device Skew on Similar Paths is 0.5 ns
- Asynchronous Reset
- Single +5.0V Supply

The user has a choice of using either TTL or PECL (ECL referenced to +5.0V) for the input clock. TTL clocks are typically used in present MPU systems. However, as clock speeds increase to 50MHz and beyond, the inherent superiority of ECL (particularly differential ECL) as a means of clock signal distribution becomes increasingly evident. The H644 also uses differential ECL internally to achieve its superior skew characteristic.

The H644 includes divide-by-two and divide-by-four stages, both to achieve the necessary duty cycle and skew to generate MPU clocks as required. A typical 50MHz processor application would use an input clock running at 100MHz, thus obtaining output clocks at 50MHz and 25MHz (see Logic Symbol).

The 10H version is compatible with MECL 10H™ ECL logic levels, while the 100H version is compatible with 100K levels (referenced to +5.0V).

Function

Reset (R): LOW on RESET forces all Q outputs LOW and all \bar{Q} outputs HIGH.

Synchronized Outputs: The device is designed to have the POS edges of the +2 and +4 outputs synchronized.

Select (SEL): LOW selects the ECL input source (DE/DE). HIGH selects the TTL input source (DT).

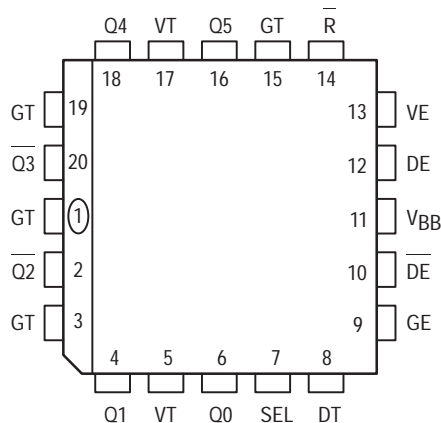
The H644 also contains circuitry to force a stable state of the ECL input differential pair, should both sides be left open. In this case, the DE side of the input is pulled LOW, and DE goes HIGH.

MC10H644
MC100H644

68030/040
PECL-TTL CLOCK
DRIVER



Pinout: 20-Lead PLCC (Top View)



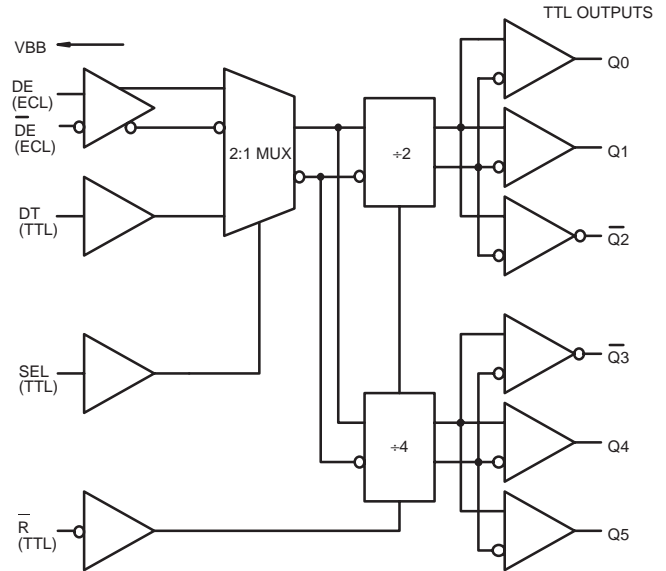
MECL 10H is a trademark of Motorola, Inc.



PIN NAMES

PIN	FUNCTION
GT	TTL Ground (0V)
VT	TTL V _{CC} (+5.0V)
VE	ECL V _{CC} (+5.0V)
GE	ECL Ground (0V)
DE, DE	ECL Signal Input (positive ECL)
V _{BB}	V _{BB} Reference Output
DT	TTL Signal Input
Qn, Qn	Signal Outputs (TTL)
SEL	Input Select (TTL)
R	Reset (TTL)

LOGIC DIAGRAM



AC CHARACTERISTICS (V_T = V_E = 5.0 V ±5%)

Symbol	Characteristic		0°C		25°C		85°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
t _{PLH}	Propagation Delay ECL D to Output	All Outputs	5.8	6.8	5.7	6.7	6.1	7.1	ns	CL = 50pF
t _{PLH}	Propagation Delay TTL D to Output		5.7	6.7	5.7	6.7	6.0	7.0	ns	CL = 50pF
t _{skwd} *	Within-Device Skew	Q0, 1, 4, 5	-	0.5	-	0.5	-	0.5	ns	CL = 50pF
t _{skwd} *	Within-Device Skew	Q2, Q3	-	0.5	-	0.5	-	0.5	ns	CL = 50pF
t _{skwd} *	Within-Device Skew	All Outputs	-	1.5	-	1.5	-	1.5	ns	CL = 50pF
t _{skp-p} *	Part-to-Part Skew	Q0, 1, 4, 5	-	1.0	-	1.0	-	1.0	ns	CL = 50pF
t _{PD}	Propagation Delay R to Output	All Outputs	4.3	7.3	4.3	7.3	4.5	7.5	ns	CL = 50pF
t _R t _F	Output Rise/Fall Time 0.8V - 2.0V	All Outputs	-	1.6	-	1.6	-	1.6	ns	CL = 50pF
f _{max}	Maximum Input Frequency		135	-	135	-	135	-	MHz	CL = 50pF
TW	Minimum Pulse Width Reset		1.5	-	1.5	-	1.5	-	ns	
t _{rr}	Reset Recovery Time		1.25	-	1.25	-	1.25	-	ns	
T _{PW}	Pulse Width Out High or Low @ f _{in} = 100 MHz and CL = 50 pf	Q0, 1	9.5	10.5	9.5	10.5	9.5	10.5	ns	CL = 50pf Relative 1.5V
TS	Setup Time SEL to DE, DT		2.0	-	2.0	-	2.0	-	ns	
TH	Hold Time SEL to DE, DT		2.0	-	2.0	-	2.0	-	ns	

* Skews are specified for Identical Edges

DC CHARACTERISTICS ($V_T = V_E = 5.0\text{ V} \pm 5\%$)

Symbol	Characteristic		0°C		25°C		85°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
I_{EE}	Power Supply Current	ECL		65		65		65	mA	V_E Pin
I_{CC}		TTL		85		85		85	mA	Total all V_T pins

TTL DC CHARACTERISTICS ($V_T = V_E = 5.0\text{ V} \pm 5\%$)

Symbol	Characteristic		0°C		25°C		85°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
V_{IH} V_{IL}	Input HIGH Voltage Input LOW Voltage	2.0	0.8	2.0	0.8	2.0	0.8	V		
I_{IH}	Input HIGH Current		20 100		20 100		20 100	μA	$V_{IN} = 2.7\text{ V}$ $V_{IN} = 7.0\text{ V}$	
I_{IL}	Input LOW Current		-0.6		-0.6		-0.6	mA	$V_{IN} = 0.5\text{ V}$	
V_{OH}	Output HIGH Voltage	2.5 2.0		2.5 2.0		2.5 2.0		V	$I_{OH} = -3.0\text{ mA}$ $I_{OH} = -24\text{ mA}$	
V_{OL}	Output LOW Voltage		0.5		0.5		0.5	V	$I_{OL} = 24\text{ mA}$	
V_{IK}	Input Clamp Voltage		-1.2		-1.2		-1.2	V	$I_{IN} = -18\text{ mA}$	
I_{OS}	Output Short Circuit Current	-100	-225	-100	-225	-100	-225	mA	$V_{OUT} = 0\text{ V}$	

10H PECL DC CHARACTERISTICS ($V_T = V_E = 5.0\text{ V} \pm 5\%$)

Symbol	Characteristic		0°C		25°C		85°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
I_{IH} I_{IL}	Input HIGH Current Input LOW Current	0.5	225	0.5	175	0.5	175	μA		
V_{IH}^* V_{IL}^*	Input HIGH Voltage Input LOW Voltage	3.83 3.05	4.16 3.52	3.87 3.05	4.19 3.52	3.94 3.05	4.28 3.55	V	$V_E = 5.0\text{ V}$	
V_{BB}^*	Output Reference Voltage	3.62	3.73	3.65	3.75	3.69	3.81	V	$V_E = 5.0\text{ V}$	

100H PECL DC CHARACTERISTICS ($V_T = V_E = 5.0\text{ V} \pm 5\%$)

Symbol	Characteristic		0°C		25°C		85°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
I_{IH} I_{IL}	Input HIGH Current Input LOW Current	0.5	225	0.5	175	0.5	175	μA		
V_{IH}^* V_{IL}^*	Input HIGH Voltage Input LOW Voltage	3.835 3.19	4.12 3.525	3.835 3.19	4.12 3.525	3.835 3.19	4.12 3.525	V	$V_E = 5.0\text{ V}$	
V_{BB}^*	Output Reference Voltage	3.62	3.74	3.62	3.74	3.62	3.74	V	$V_E = 5.0\text{ V}$	

* NOTE: PECL levels are referenced to V_{CC} and will vary 1:1 with the power supply. The values shown are for $V_{CC} = 5.0\text{ V}$. Only corresponds to ECL Clock Inputs.

1:9 TTL Clock Driver

The MC10H645 is a single supply, low skew, TTL I/O 1:9 Clock Driver. Devices in the Motorola H600 clock driver family utilize the 28-lead PLCC for optimal power and signal pin placement.

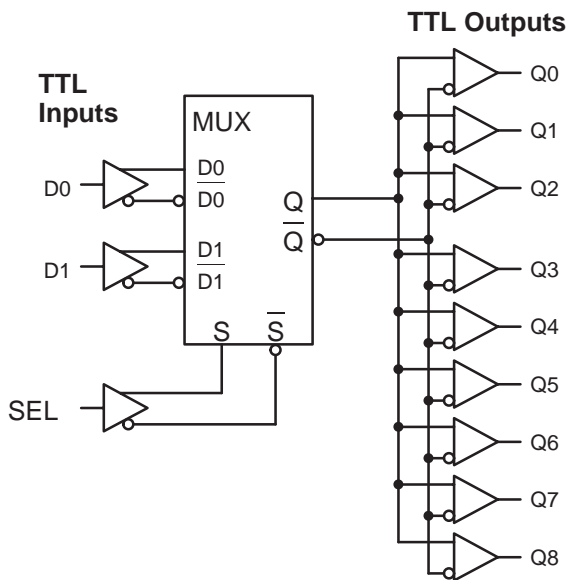
The device features a 24mA TTL output stage with AC performance specified into a 50pF load capacitance. A 2:1 input mux is provided on chip to allow for distributing both system and diagnostic clock signals or designing clock redundancy into a system. With the SEL input held LOW the D0 input will be selected, while the D1 input is selected when the SEL input is forced HIGH.

- Low Skew Typically 0.65ns Within Device
- Guaranteed Skew Spec 1.25ns Part-to-Part
- Input Clock Muxing
- Differential ECL Internal Design
- Single Supply
- Extra TTL and ECL Power/Ground Pins

PIN NAMES

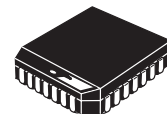
PIN	FUNCTION
GT	TTL Ground (0V)
VT	TTL V _{CC} (+5.0V)
VE	ECL V _{CC} (+5.0V)
GE	ECL Ground (0V)
Dn	TTL Signal Input
Q0 – Q8	TTL Signal Outputs
SEL	TTL Mux Select

LOGIC DIAGRAM



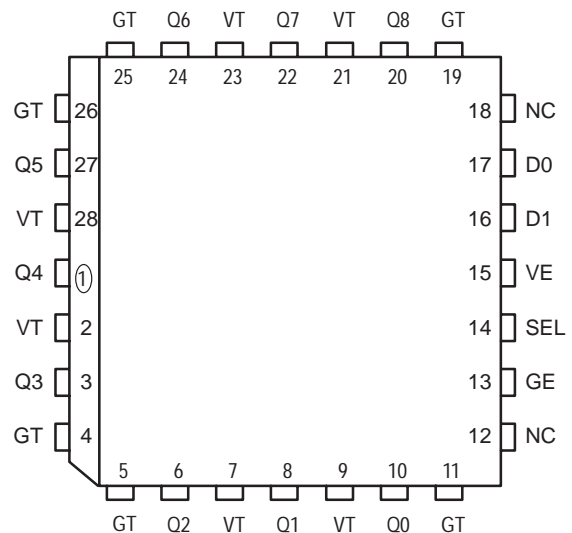
MC10H645

1:9 TTL CLOCK DRIVER



FN SUFFIX
PLASTIC PACKAGE
CASE 776-02

Pinout: 28-Lead PLCC (Top View)



PIN DESCRIPTIONS

Pin	Symbol	Description	Pin	Symbol	Description
1	Q4	Signal Output (TTL)	15	VE	ECL V _{CC} (+5.0V)
2	VT	TTL V _{CC} (+5.0V)	16	D1	Signal Input (TTL)
3	Q3	Signal Output (TTL)	17	D0	Signal Input (TTL)
4	GT	TTL Ground (0V)	18	NC	No Connection
5	GT	TTL Ground (0V)	19	GT	TTL Ground (0V)
6	Q2	Signal Output (TTL)	20	Q8	Signal Output (TTL)
7	VT	TTL V _{CC} (+5.0V)	21	VT	TTL V _{CC} (+5.0V)
8	Q1	Signal Output (TTL)	22	Q7	Signal Output (TTL)
9	VT	TTL V _{CC} (+5.0V)	23	VT	TTL V _{CC} (+5.0V)
10	Q0	Signal Output (TTL)	24	Q6	Signal Output (TTL)
11	GT	TTL Ground (0V)	25	GT	TTL Ground (0V)
12	NC	No Connection	26	GT	TTL Ground (0V)
13	GE	ECL Ground	27	Q5	Signal Output (TTL)
14	SEL	Select Input (TTL)	28	VT	TTL V _{CC} (+5.0V)

ABSOLUTE RATINGS (Do not exceed)

Symbol	Characteristic	Value	Unit
VE (ECL)	Power Supply Voltage	-0.5 to +7.0	V
VT (TTL)	Power Supply Voltage	-0.5 to +7.0	V
VI (TTL)	Input Voltage	-0.5 to +7.0	V
V _{out}	Disabled 3-State Output	0.0 to V _T	V
T _{stg}	Storage Temperature	-65 to 150	°C
T _{amb}	Operating Temperature	0.0 to +85	°C

TRUTH TABLE

D0	D1	SEL	Q
L	X	L	L
H	X	L	H
X	L	H	L
X	H	H	H

DC CHARACTERISTICS (V_T = V_E = 5.0V ±5%)

Symbol	Characteristic	0°C		25°C		85°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
I _{EE}	Power Supply Current	ECL			30		30	mA	VE Pin
I _{CCH}		TTL			30		30		
I _{CCL}				35		35		35	mA
V _{OH}	Output HIGH Voltage	2.5 2.0		2.5 2.0		2.5 2.0		V	
V _{OL}	Output LOW Voltage		0.5		0.5		0.5		V
I _{OS}	Output Short Circuit Current	-100	-225	-100	-225	-100	-225	mA	

MC10H645

TTL DC CHARACTERISTICS (VT = VE = 5.0 V ±5%)

Symbol	Characteristic	0°C		25°C		85°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
V _{IH} V _{IL}	Input HIGH Voltage Input LOW Voltage	2.0	0.8	2.0	0.8	2.0	0.8	V	
I _{IH}	Input HIGH Current		20 100		20 100		20 100	μA	V _{IN} = 2.7 V V _{IN} = 7.0 V
I _{IL}	Input LOW Current		-0.6		-0.6		-0.6	mA	V _{IN} = 0.5 V
V _{OH}	Output HIGH Voltage	2.5 2.0		2.5 2.0		2.5 2.0		V	I _{OH} = -3.0 mA I _{OH} = -24 mA
V _{OL}	Output LOW Voltage		0.5		0.5		0.5	V	I _{OL} = 24 mA
V _{IK}	Input Clamp Voltage		-1.2		-1.2		-1.2	V	I _{IN} = -18 mA
I _{OS}	Output Short Circuit Current	-100	-225	-100	-225	-100	-225	mA	V _{OUT} = 0 V

AC CHARACTERISTICS (VT = VE = 5.0V ±5%)

Symbol	Characteristic		0°C		25°C		85°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
t _{PLH}	Propagation Delay D ₀ to Output Only	Q0-Q8	4.8	5.8	4.8	5.8	5.2	6.2	ns	CL = 50pF
t _{PLH}	Propagation Delay D ₁ to Output		4.8	5.8	4.8	5.8	5.2	6.2	ns	
t _{PHL}	Propagation Delay D ₀ to Output D ₁ to Output		4.8 4.8	5.8 5.8	4.8 4.8	5.8 5.8	5.2 5.2	6.2 6.2	ns	
t _{skpp}	Part-to-Part Skew D ₀ to Output Only			1.0		1.0		1.0	ns	
t _{skwd} *	Within-Device Skew D ₀ to Output Only			0.65		0.65		0.65	ns	
t _{PLH}	Propagation Delay SEL to Q	Q0-Q8	4.5	6.5	5.0	7.0	5.2	7.2	ns	CL = 50pF
t _r t _f	Output Rise/Fall Time 0.8V to 2.0V	Q0-Q8	0.5 0.5	2.5 2.5	0.5 0.5	2.5 2.5	0.5 0.5	2.5 2.5	ns	CL = 50pF
t _S	Setup Time SEL to D		1.0		1.0		1.0		ns	

* Within-Device Skew defined as identical transitions on similar paths through a device.

DUTY CYCLE SPECIFICATIONS (0°C ≤ TA ≤ 85°C; Duty Cycle Measured Relative to 1.5V)

Symbol	Characteristic	Min	Nom	Max	Unit	Condition
PW	Range of V _{CC} and CL to Meet Min Pulse Width (HIGH or LOW) at f _{out} ≤ 50MHz	V _{CC} CL PW	4.875 5.0 9.0	5.125 5.0 11.0	V pF ns	All Outputs

PECL/TTL-TTL 1:8 Clock Distribution Chip

The MC10H/100H646 is a single supply, low skew translating 1:8 clock driver. Devices in the Motorola H600 translator series utilize the 28-lead PLCC for optimal power pinning, signal flow through and electrical performance. The single supply H646 is similar to the H643, which is a dual supply 1:8 version of the same function.

- PECL/TTL-TTL Version of Popular ECLinPS™ E111
- Low Skew
- Guaranteed Skew Spec
- Tri-State Enable
- Differential Internal Design
- V_{BB} Output
- Single Supply
- Extra TTL and ECL Power/Ground Pins
- Matched High and Low Output Impedance
- Meets Specifications Required to Drive the Pentium™ Microprocessor

The H646 was designed specifically to drive series terminated transmission lines. Special techniques were used to match the HIGH and LOW output impedances to about 7ohms. This simplifies the choice of the termination resistor for series terminated applications. To match the HIGH and LOW output impedances, it was necessary to remove the standard I_{OS} limiting resistor. As a result, the user should take care in preventing an output short to ground as the part will be permanently damaged.

The H646 device meets all of the requirements for driving the 60 and 66MHz Pentium Microprocessor. The device has no PLL components, which greatly simplifies its implementation into a digital design. The eight copies of the clock allows for point-to-point clock distribution to simplify board layout and optimize signal integrity.

The H646 provides differential PECL inputs for picking up LOW skew PECL clocks from the backplane and distributing it to TTL loads on a daughter board. When used in conjunction with the MC10/100E111, very low skew, very wide clock trees can be designed. In addition, a TTL level clock input is provided for flexibility. Note that only one of the inputs can be used on a single chip. For correct operation, the unused input pins should be left open.

The Output Enable pin forces the outputs into a high impedance state when a logic 0 is applied.

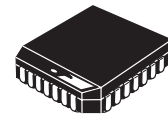
The output buffers of the H646 can drive two series terminated, 50Ω transmission lines each. This capability allows the H646 to drive up to 16 different point-to-point clock loads. Refer to the Applications section for a more detailed discussion in this area.

The 10H version is compatible with MECL 10H™ ECL logic levels. The 100H version is compatible with 100K levels.

MECL 10H and ECLinPS are trademarks of Motorola, Inc. Pentium is a trademark of Intel Corporation.

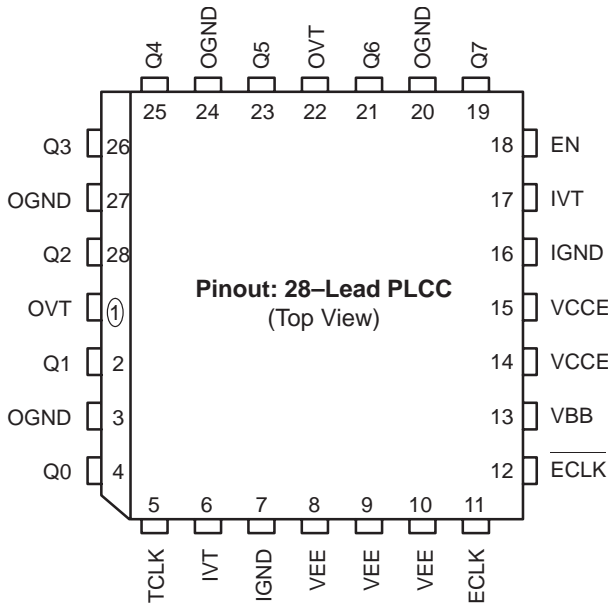
MC10H646
MC100H646

PENTIUM
MICROPROCESSOR
PECL/TTL-TTL
CLOCK DRIVER



FN SUFFIX
PLASTIC PACKAGE
CASE 776-02





PIN NAMES

PIN	FUNCTION
OGND	TTL Output Ground (0V)
OVT	TTL Output V _{CC} (+5.0V)
IGND	Internal TTL GND (0V)
IVT	Internal TTL V _{CC} (+5.0V)
VEE	ECL V _{EE} (0V)
VCCE	ECL Ground (5.0V)
ECLK, ECLK	Differential Signal Input (PECL)
VBB	V _{BB} Reference Output
Q0-Q7	Signal Outputs (TTL)
EN	Tri-State Enable Input (TTL)

LOGIC DIAGRAM

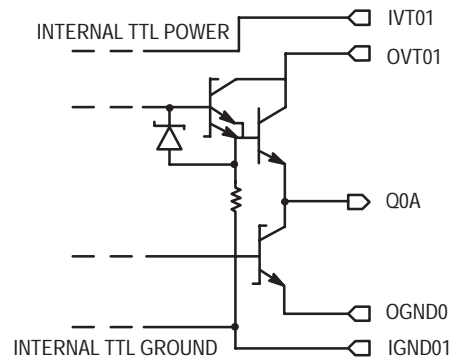
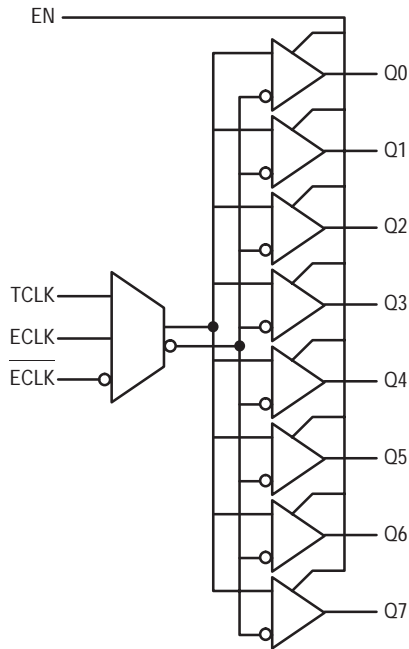


Figure 1. Output Structure

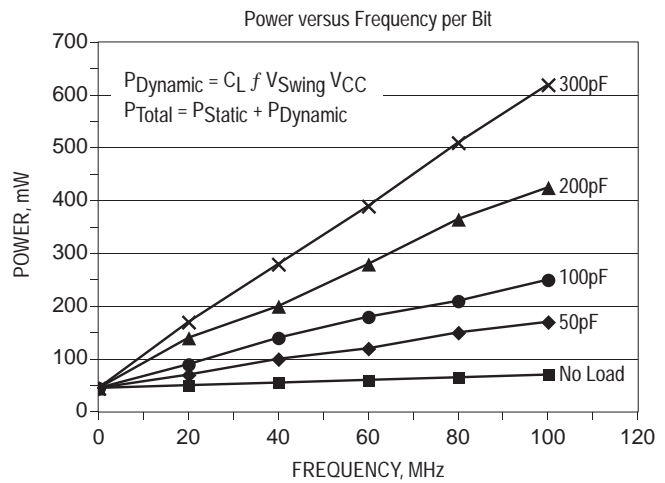


Figure 2. Power versus Frequency (Typical)

TRUTH TABLE

TCLK	ECLK	ECLK	EN	Q
GND	L	H	H	L
GND	H	L	H	H
H	GND	GND	H	H
L	GND	GND	H	L
X	X	X	L	Z

L = Low Voltage Level; H = High Voltage Level; Z = Tristate

DC CHARACTERISTICS (IVT = OVT = VCCE = 5.0V ±5%)

Symbol	Characteristic	0°C		25°C		85°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
V _{OH}	Output HIGH Voltage	2.6	–	2.6	–	2.6	–	V	I _{OH} = 24mA
V _{OL}	Output LOW Voltage	–	0.5	–	0.5	–	0.5	V	I _{OL} = 48mA
I _{OS}	Output Short Circuit Current	–	–	–	–	–	–	mA	See Note 1

1. The outputs must not be shorted to ground, as this will result in permanent damage to the device. The high drive outputs of this device do not include a limiting IOS resistor.

TTL DC CHARACTERISTICS (V_T = V_E = 5.0 V ±5%)

Symbol	Characteristic	0°C		25°C		85°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
V _{IH} V _{IL}	Input HIGH Voltage Input LOW Voltage	2.0	0.8	2.0	0.8	2.0	0.8	V	
I _{IH}	Input HIGH Current		20 100		20 100		20 100	μA	V _{IN} = 2.7 V V _{IN} = 7.0 V
I _{IL}	Input LOW Current		–0.6		–0.6		–0.6	mA	V _{IN} = 0.5 V
V _{OH}	Output HIGH Voltage	2.5 2.0		2.5 2.0		2.5 2.0		V	I _{OH} = –3.0 mA I _{OH} = –24 mA
V _{OL}	Output LOW Voltage		0.5		0.5		0.5	V	I _{OL} = 24 mA
V _{IK}	Input Clamp Voltage		–1.2		–1.2		–1.2	V	I _{IN} = –18 mA
I _{OS}	Output Short Circuit Current	–100	–225	–100	–225	–100	–225	mA	V _{OUT} = 0 V

10H PECL DC CHARACTERISTICS (IVT = OVT = VCCE = 5.0V ±5%)

Symbol	Characteristic	0°C			25°C			85°C			Unit	Notes
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
I _{IH}	Input HIGH Current			225			175			175	μA	
I _{IL}	Input LOW Current	0.5			0.5			0.5			μA	
V _{IH}	Input HIGH Voltage	3.83		4.16	3.87		4.19	3.94		4.28	V	IVT = IVO = VCCE = 5.0V (1)
V _{IL}	Input LOW Voltage	3.05		3.52	3.05		3.52	3.05		3.555	V	IVT = IVO = VCCE = 5.0V (1)
V _{BB}	Output Reference Voltage	3.62		3.73	3.65		3.75	3.69		3.81	V	IVT = IVO = VCCE = 5.0V (1)

100H PECL DC CHARACTERISTICS (IVT = OVT = VCCE = 5.0V ±5%)

Symbol	Characteristic	0°C			25°C			85°C			Unit	Notes
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
I _{IH}	Input HIGH Current			225			175			175	μA	
I _{IL}	Input LOW Current	0.5			0.5			0.5			μA	
V _{IH}	Input HIGH Voltage	3.835		4.12	3.835		4.12	3.835		3.835	V	IVT = IVO = VCCE = 5.0V (1)
V _{IL}	Input LOW Voltage	3.19		3.525	3.19		3.525	3.19		3.525	V	IVT = IVO = VCCE = 5.0V (1)
V _{BB}	Output Reference Voltage	3.62		3.74	3.62		3.74	3.62		3.74	V	IVT = IVO = VCCE = 5.0V (1)

1. ECL V_{IH}, V_{IL} and V_{BB} are referenced to VCCE and will vary 1:1 with the power supply. The levels shown are for IVT = IVO = VCCE = 5.0V

MC10H646 MC100H646

DC CHARACTERISTICS (IVT = OVT = VCCE = 5.0V ±5%)

Symbol	Characteristic	0°C		25°C			85°C		Unit	Condition
		Min	Max	Min	Typ	Max	Min	Max		
I _{CCL}	Power Supply Current		185		166	185		185	mA	Total all OVT, IVT, and VCCE pins
I _{CCH}			175		154	175		175	mA	
I _{CCZ}			210			210		210		

AC CHARACTERISTICS (IVT = OVT = VCCE = 5.0V ±5%)

Symbol	Characteristic	0°C		25°C		85°C		Unit	Condition	
		Min	Max	Min	Max	Min	Max			
t _{PLH}	Propagation Delay	ECLK to Q	4.8	5.8	5.0	6.0	5.6	6.6	ns	
		TCLK to Q	5.1	6.4	5.3	6.4	5.7	7.0		
t _{PHL}	Propagation Delay	ECLK to Q	4.4	5.4	4.4	5.4	4.8	5.8	ns	
		TCLK to Q	4.7	6.0	4.8	5.9	5.2	6.5		
t _{SK(O)}	Output Skew	Q0, Q3, Q4, Q7		350		350		350	ps	Note 1, 6
		Q1, Q2, Q5		350		350		350		
		Q0-Q7		500		500		500		
t _{SK(PR)}	Process Skew	ECLK to Q		1.0		1.0		1.0	ns	Note 2, 6
		TCLK to Q		1.3		1.1		1.3		
t _{SK(P)}	Pulse Skew	Δt _{PLH} – t _{PHL}		1.0		1.0		1.0	ns	
t _r , t _f	Rise/Fall Time		0.3	1.5	0.3	1.5	0.3	1.5	ns	
t _{PW}	Output Pulse Width	66MHz @ 2.0V	5.5		5.5		5.5		ns	Note 3, 6
		66MHz @ 0.8V	5.5		5.5		5.5			
		60MHz @ 2.0V	6.0		6.0		6.0			
		60MHz @ 0.8V	6.0		6.0		6.0			
t _{Stability}	Clock Stability		±75		±75		±75	ps	Note 4, 6	
F _{MAX}	Maximum Input Frequency		80		80		80	MHz	Note 5, 6	

1. Output skew defined for identical output transitions.
2. Process skew is valid for V_{CC} = 5.0V ±5%.
3. Parameters guaranteed by t_{SK(P)} and t_r, t_f specification limits.
4. Clock stability is the period variation between two successive rising edges.
5. For series terminated lines. See Applications section for F_{MAX} enhancement techniques.
6. All AC specifications tested driving 50Ω series terminated transmission lines at 80MHz.

4-Bit ECL/TTL Load Reducing DRAM Driver

The MC10H/100H660 is a 4-bit ECL input, translating DRAM address driver, ideally suited for driving TTL compatible DRAM inputs from an ECL system. It is designed for use in high capacity, highly interleaved DRAM memory boards, that directly interface to a high speed, pipelined ECL bus interface, where new operations may be initiated to the board at up to a 50 MHz rate.

The latch provides the capability for the memory controller to propagate new addresses to different banks without having to wait for the address timing constraints to be satisfied from a previous memory operation. The dual output fanout reduces input loading from the controller by a factor of two, thus significantly improving board etch propagation delays from the controller, without the need for additional ECL buffering.

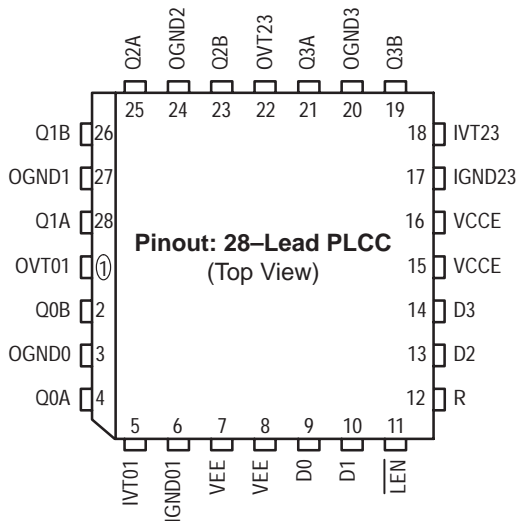
The H660 features special TTL outputs which do not have an IOS limiting resistor, therefore allowing rapid charging of the load capacitance. Output voltage levels are designed specifically for driving DRAM inputs. The output stages feature separate power and ground pins to isolate output switching noise from internal circuitry, and also to improve simultaneous switching performance.

The 10H version is compatible with MECL 10H ECL logic levels. The 100H version is compatible with 100K levels.

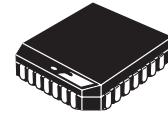
- High Capacitive Drive Outputs to Drive DRAM Address Inputs
- Extra TTL and ECL Power/Ground Pins to Minimize Switching Noise
- Dual Supply
- 10.7 ns Max. D to Q into 300 pF

PIN NAMES

PIN	FUNCTION
OGND[0:3]	Output Ground (0V)
OVT01, OVT23	Output VCCT (+5.0 V)
IGND01, IGND23	Internal TTL Ground (0V)
IVT01, IVT23	Internal TTL VCCT (+5.0 V)
VEE	ECL Neg. Supply (-5.2/ -4.5 V)
VCCE	ECL Ground (0V)
D[0:3]	Data Inputs (ECL)
Q[0:3]A, Q[0:3]B	Data Outputs (TTL levels)
LEN	Latch Enable (ECL)
R	Reset (ECL)

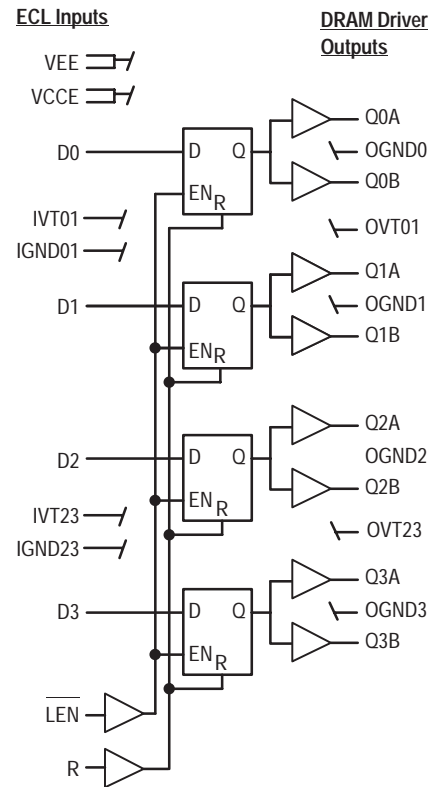


MC10H660 MC100H660



FN SUFFIX
PLASTIC PACKAGE
CASE 776-02

LOGIC SYMBOL



TRUTH TABLE

D	LEN	R	Q
L	H	L	L
H	H	L	H
X	L	L	Q ₀
X	X	H	L



MC10H660 MC100H660

DC CHARACTERISTICS: $V_{CCT} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -5.2\text{ V} \pm 5\%$ (10H version); $V_{EE} = -4.2\text{ V}$ to -5.5 V (100H version)

Symbol	Characteristic		0°C		25°C		85°C		Unit	Condition
			min	max	min	max	min	max		
I_{EE}	Power Supply Current	ECL	41.8		44.0		46.2		mA	
I_{CCH}		TTL	77.0		77.1		79.2			
I_{CCL}			94.6		95.7		96.8			

TTL CHARACTERISTICS: $V_{CCT} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -5.2\text{ V} \pm 5\%$ (10H version); $V_{EE} = -4.2\text{ V}$ to -5.5 V (100H version)

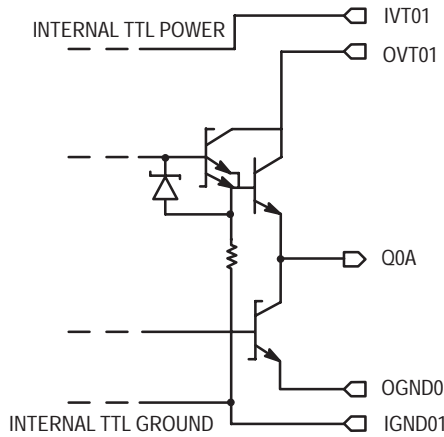
Symbol	Characteristic		0°C		25°C		85°C		Unit	Condition
			min	max	min	max	min	max		
V_{OH}	Output HIGH Voltage		2.6		2.6		2.6		V	$I_{OH} = -24\text{ mA}$
V_{OL}	Output LOW Voltage		0.50		0.50		0.50			$I_{OL} = 24\text{ mA}$
I_{OS}	Output Short Circuit Current*		*		*		*			See Note 1

- The outputs must not be shorted to ground, as this will result in permanent damage to the device. The high drive outputs of this device do not include a limiting IOS resistor. Minimum recommended load capacitance is 100 pF. Precise output performance and waveforms will depend on the exact nature of the actual load. The lumped load is of course an approximation to a real memory system load.

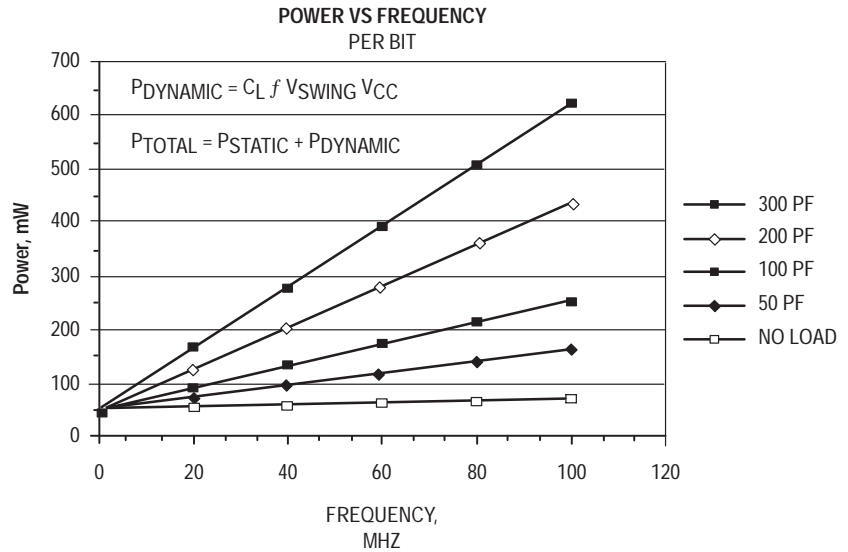
AC Characteristics: $V_{CCT} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -5.2\text{ V} \pm 5\%$ (10H version) $V_{EE} = -4.2\text{ V}$ to -5.5 V (100H version)

Symbol	Characteristic		0°C		25°C		85°C		Unit	Condition		
			min	max	min	max	min	max				
t_s	Set-up Time, D to $\overline{\text{LEN}}$		0.5		0.5		0.5		ns			
t_h	Hold Time, D to $\overline{\text{LEN}}$		1.5		1.5		1.5					
$t_{w(H)}$	LEN Pulse Width, HIGH		2.0		2.0		2.0					
t_R t_F	Output Rise/Fall Time 0.8 V – 2.0 V		0.5	2.0	0.5	2.0	0.5	2.0	ns	$C_L = 200\text{ pF}$		
t_{PLH} t_{PHL}	Propagation Delay to Output	D	3.0	6.0	3.0	6.0	3.0	6.0			ns	$C_L = 100\text{ pF}$ $C_L = 200\text{ pF}$ $C_L = 300\text{ pF}$
		50% point of ECL input to 1.5 V point of TTL output	LEN	4.3	6.9	4.3	6.9	4.3				
			4.9	8.9	4.9	8.9	4.9	8.9	ns	$C_L = 100\text{ pF}$ $C_L = 200\text{ pF}$ $C_L = 300\text{ pF}$		
		5.4	10.4	5.4	10.4	5.4	10.4					
t_{PHL}	Propagation Delay to Output	R	4.1	9.1	4.1	9.1	4.1	9.1			ns	$C_L = 100\text{ pF}$ $C_L = 200\text{ pF}$ $C_L = 300\text{ pF}$
			4.5	8.5	4.5	8.5	4.5	8.5				
			5.0	10.0	5.0	10.0	5.0	10.0				
t_{PLH}	Propagation Delay to Output	D	3.9	5.9	3.9	5.9	4.0	6.1	ns	$C_L = 100\text{ pF}$ $C_L = 200\text{ pF}$ $C_L = 300\text{ pF}$		
		50% point of ECL input to 2.4 V point of TTL output	LEN	4.8	7.2	4.8	7.2	5.0			7.4	
	5.8			8.8	5.8	8.8	5.9	8.9				
			4.7	7.1	4.7	7.1	4.8	7.2	ns	$C_L = 100\text{ pF}$ $C_L = 200\text{ pF}$ $C_L = 300\text{ pF}$		
			5.5	8.3	5.5	8.3	5.6	8.4				
			6.3	9.5	6.3	9.5	6.4	9.6				
t_{PHL}	Propagation Delay to Output	D	4.5	6.7	4.5	6.7	4.4	6.6	ns	$C_L = 100\text{ pF}$ $C_L = 200\text{ pF}$ $C_L = 300\text{ pF}$		
		50% point of ECL input to 0.8 V point of TTL output	LEN	6.0	9.0	6.0	9.0	6.0			9.0	
	7.0			10.6	7.0	10.6	6.9	10.3				
			4.0	6.0	4.0	6.0	4.0	6.0	ns	$C_L = 100\text{ pF}$ $C_L = 200\text{ pF}$ $C_L = 300\text{ pF}$		
			4.9	7.3	4.9	7.3	4.9	7.3				
			6.0	9.0	6.0	9.0	5.9	8.9				
		R	4.3	6.5	4.3	6.5	4.3	6.5	ns	$C_L = 100\text{ pF}$ $C_L = 200\text{ pF}$ $C_L = 300\text{ pF}$		
			6.1	9.1	6.1	9.1	6.1	9.1				
			7.2	10.8	7.2	10.8	7.2	10.8				

OUTPUT STRUCTURE
 – Output Q0A Structure Shown



POWER VS FREQUENCY
 – typical



10H ECL DC Characteristics: $V_{CCT} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -5.2\text{ V} \pm 5\%$

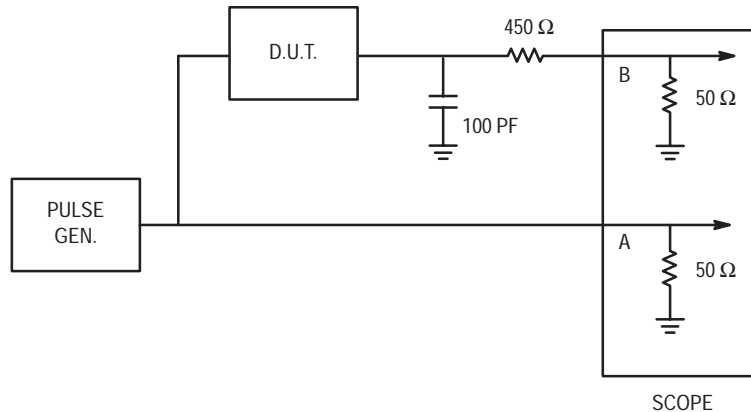
Symbol	Characteristic	0°C		25°C		85°C		Unit	Condition
		min	max	min	max	min	max		
I_{IH}	Input HIGH Current		225		145		145	μA	
I_{IL}	Input LOW Current	1.5		1.0		1.0		μA	
V_{IH}	Input HIGH Voltage	-1170	-840	-1130	-810	-1060	-720	mV	
V_{IL}	Input LOW Voltage	-1950	-1480	-1950	-1480	-1950	-1445	mV	

100H ECL DC Characteristics: $V_{CCT} = 5.0\text{ V} \pm 10\%$; $V_{EE} = -4.2\text{ V to } -5.5\text{ V}$

Symbol	Characteristic	0°C		25°C		85°C		Unit	Condition
		min	max	min	max	min	max		
I_{IH}	Input HIGH Current		225		145		145	μA	
I_{IL}	Input LOW Current	1.5		1.0		1.0		μA	
V_{IH}	Input HIGH Voltage	-1165	-880	-1165	-880	-1165	-880	mV	
V_{IL}	Input LOW Voltage	-1810	-1475	-1810	-1475	-1810	-1475	mV	

AC TEST SET-UP

$C_L = 100 \text{ pF}$

**The MC10H/100 H660 ECL-TTL DRAM Address Driver**

The MC 10H/100H660 was designed for use in high capacity, highly interleaved DRAM memory boards, that directly interface to a high speed, pipelined ECL bus interface, where new operations may be initiated to the board at a 50 MHz rate (e.g. bipolar RISC systems).

The following briefly discusses the major design features of the part over existing semiconductor devices traditionally used in interfacing DRAMs in high performance system environments.

1. ECL Translator

High performance memory systems of the past that were interfaced to ECL buses had to rely on separate ECL translators and DRAM drivers to interface to large DRAM arrays, which is acceptable if the module is not highly interleaved and the bus cycle time is comparable to the DRAM access time. This becomes inadequate as the cycle time of the interface becomes significantly faster than the address timing requirements of the RAM, and as the degree of internal board interleaving increases. These higher performance demands require that the internal address and control signals propagated to the DRAM drivers be implemented in ECL, thus requiring the integration of the driver and translator functions.

Integration of the translator/drive function also reduces access latency, as well as keeping DRAM timing parameters from being violated, due to the excessive delays encountered with separate parts.

2. MOS Drive Capacity

Outputs are specifically designed for driving large numbers of DRAMs ($\approx 300 \text{ pF}$), which reduce the number of parts and power requirements needed per board. Output voltage levels are designed specifically for driving DRAM inputs. No ECL

translator parts on the market today provide the designer with this drive capability as well as the flexibility to vary the number of DRAMs that are driven by the part.

3. Transparent Latch

The latch is added to provide the capability for a memory controller to propagate new addresses to different banks without having to wait for the address timing constraints to be satisfied from a previous memory operation. For system implementations where this is acceptable, the user has the capability to keep the latch open, thus having the part act as an address translator/buffer, with minimal performance impact due to the additional propagation delay incurred from the internal latch. The latch is controlled within an already existing DRAM timing signal.

4. 1:2 Output Fanout

This function is useful in that it reduces input loading from the controller by a factor of two, thus significantly improving board etch propagation delays from the controller to the large number of translators, without the addition of ECL glue logic parts to reduce the loading. In large memory boards, so many translators are needed that this type of organization is not a handicap.

5. Low Skew, Low Propagation Delay

Low skew of the part as well as fast propagation delay enable faster overall DRAM operation to be attained than is possible with existing parts.

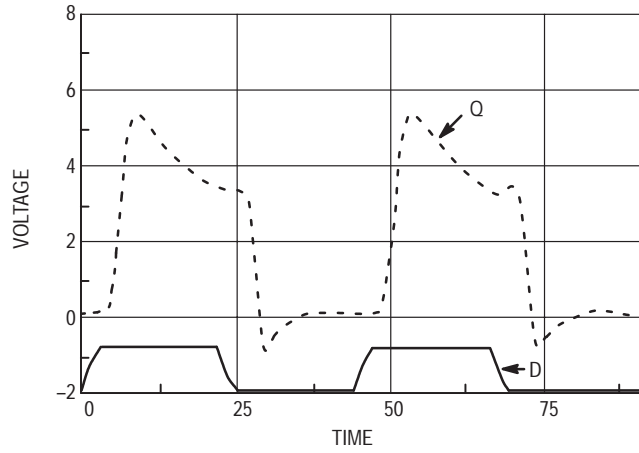
6. Power and Package Pin Layout

The H660 is specifically designed with additional power and ground pins to greatly improve simultaneous switching performance over existing driver parts.

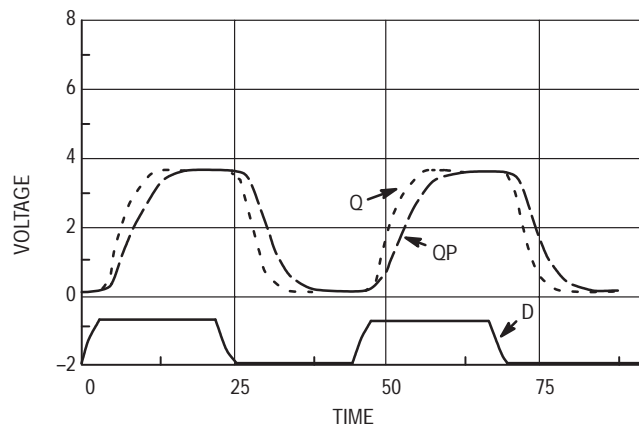
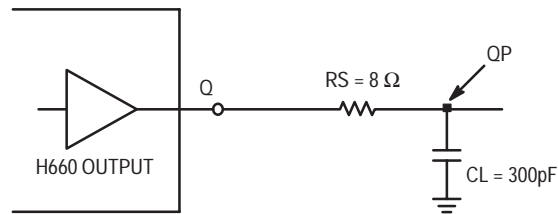
OUTPUT WAVEFORMS

simulated

Example 1. An output load consisting of just $CL = 50 \text{ pF}$ results in overshoot at the output Q:



Example 2. In a memory system application, use of an external source resistor is suggested. Simulations run with $RS = 8 \Omega$ and $CL = 300 \text{ pF}$ leads to clean waveforms both at the output, Q, and at point Qp:



4-Bit Differential ECL Bus/TTL Bus Transceiver

MC10H680
MC100H680

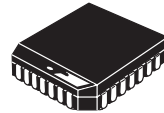
The MC10H/100H680 is a dual supply 4-bit differential ECL bus to TTL bus transceiver. It is designed to allow the system designer to no longer be limited in bus speed associated with standard TTL busses. Using a differential ECL Bus will increase the frequency of operation and increase noise immunity.

Both the TTL and the ECL ports are capable of driving a bus. The ECL outputs have the ability to drive 25 Ω, allowing both ends of the bus line to be terminated in the characteristic impedance of 50 Ω. The TTL outputs are specified to source 15 mA and sink 48 mA, allowing the ability to drive highly capacitive loads.

The ECL output levels are V_{OH} approximately equal to -1.0 V and V_{OL} cutoff equal to -2.0 V (V_{TT}). When the ECL ports are disabled both $EIOx$ and $EIOxB$ go to the V_{OL} cutoff level. The ECL input receivers have special circuitry which detects this disabled condition, prevents oscillation, and forces the TTL output to the low state. The noise margin in this disabled state is greater than 600 mV. Multiple ECL V_{CCO} pins are utilized to minimize switching noise.

The TTL ports have standard levels. The TTL input receivers have PNP input devices to significantly reduce loading. Multiple TTL power and ground pins are utilized to minimize switching noise.

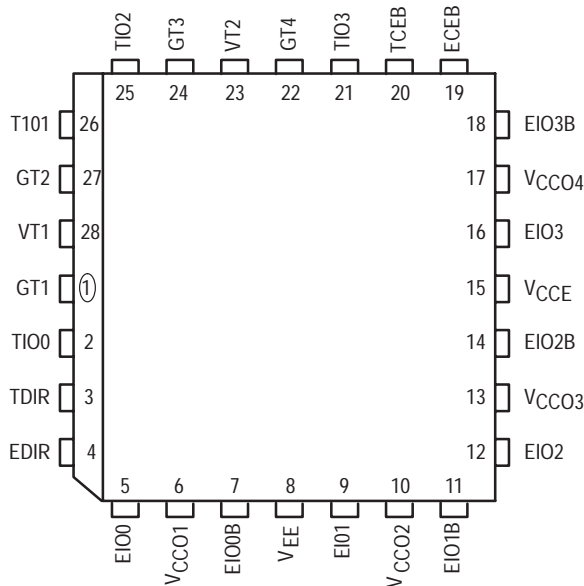
The control pins (EDIR and ECEB) of the 10H version is compatible with MECL 10H ECL logic levels. The control pins of the 100H version are compatible with 100K levels.



FN SUFFIX
PLASTIC PACKAGE
CASE 776-02

- Differential ECL Bus (25 Ω) I/O Ports
- High Drive TTL Bus I/O Ports
- Extra TTL and ECL Power/Ground Pins to Minimize Switching Noise
- Dual Supply
- Direction and Chip Enable Control Pins

Pinout: 28-Lead PLCC (Top View)



PIN DESCRIPTIONS

Pin	Symbol	Function
1	GT1	TTL Ground 1
2	TIO0	TTL I/O Bit 0
3	TDIR	TTL Direction Control
4	EDIR	ECL Direction Control
5	EIO0	ECL I/O Bit 0
6	VCCO1	ECL VCC 1 (0V) – Outputs
7	EIO0B	ECL I/O Bit 0 Bar
8	VEE	ECL Supply ($-5.2/-4.5$ V)
9	EIO1	ECL I/O Bit 1
10	VCCO2	ECL VCC 2 (0V) – Outputs
11	EIO1B	ECL I/O Bit 1 Bar
12	EIO2	ECL I/O Bit 2
13	VCCO3	ECL VCC 3 (0V) – Outputs
14	EIO2B	ECL I/O Bit 2 Bar
15	VCCE	ECL VCC (0V)
16	EIO3	ECL I/O Bit 3
17	VCCO4	ECL VCC 4 (0V) – Outputs
18	EIO3B	ECL I/O Bit 3 Bar
19	ECEB	ECL Chip Enable Bar Control
20	TCEB	TTL Chip Enable Bar Control
21	TIO3	TTL I/O Bit 3
22	GT4	TTL Ground 4
23	VT2	TTL Supply 2 (5V)
24	GT3	TTL Ground 3
25	TIO2	TTL I/O Bit 2
26	TIO1	TTL I/O Bit 1
27	GT2	TTL Ground 2
28	VT1	TTL Supply 1 (5V)



TRUTH TABLE

TDIR — Direction Control TTL Levels
 EDIR — Direction Control ECL Levels
 TCEB — Chip Enable Bar Control TTL Levels
 ECEB — Chip Enable Bar Control ECL Levels
 TIN — TTL Input
 TOUT — TTL Output
 EIN — ECL Input
 EINB — ECL Input Bar
 EOUT — ECL Output
 EOUTB — ECL Output Bar

H — HIGH
 L — LOW
 LC — ECL Low Cutoff ($V_{TT} = -2.0\text{ V}$)
 X — Don't Care
 Z — High Impedance

ECEB	TCEB	EDIR	TDIR	EIN	EINB	EOUT	EOUTB	TIN	TOUT	COMMENTS
H	X	X	X	X	X	LC	LC	X	Z	ECL and TTL Outputs Disabled
X	H	X	X	X	X	LC	LC	X	Z	ECL and TTL Outputs Disabled
L	L	H	X	H	LC			NA	H	ECL to TTL Direction
L	L	H	X	LC	H			NA	L	ECL to TTL Direction
L	L	H	X	LC	LC			NA	L	ECL to TTL Direction (L–L Cond.)
L	L	X	H	H	LC			NA	H	ECL to TTL Direction
L	L	X	H	LC	H			NA	L	ECL to TTL Direction
L	L	X	H	LC	LC			NA	L	ECL to TTL Direction (L–L Cond.)
L	L	L	L	NA	NA	H	LC	H		TTL to ECL Direction
L	L	L	L	NA	NA	LC	H	L		TTL to ECL Direction

ABSOLUTE RATINGS (Do not exceed):

Power Supply Voltage	V_{EE} (ECL)	–8.0 to 0	Vdc
Power Supply Voltage	V_{CCT} (TTL)	–0.5 to +7.0	Vdc
Input Voltage	V_I (ECL) V_I (TTL)	0.0 to V_{EE} –0.5 to +7.0	Vdc
Disabled 3–State Output	V_{out} (TTL)	0.0 to V_{CCT}	Vdc
Output Source Current Continuous	I_{out} (ECL)	100	mAdc
Output Source Current Surge	I_{out} (ECL)	200	mAdc
Storage Temperature	T_{stg}	–65 to 150	°C
Operating Temperature	T_{amb}	0.0 to +75	°C

MC10H680 MC100H680

ECL DC CHARACTERISTICS: $V_{CCT} = +5.0\text{ V} \pm 10\%$, $V_{EE} = -5.2 \pm 5\%$ (10H Version); $V_{EE} = -4.2\text{ V}$ to -5.5 V (100H Version)

Test Symbol	Parameter	$T_A = 0^\circ\text{C}$		$T_A = 25^\circ\text{C}$		$T_A = 75^\circ\text{C}$		Unit	Condition
		Min	Max	Min	Max	Min	Max		
I _{EE}	Supply Current/ECL		-110		-110		-110	mA	
I _{INH}	Input HIGH Current		225		145		145	μA	
I _{INL}	Input LOW Current	0.5		0.5		0.3		μA	
V _{OH} V _{OL}	Output HIGH Voltage Output LOW Voltage	-1100 -2.1	-840 -2.03	-1100 -2.1	-810 -2.03	-1100 -2.1	-735 -2.03	mV V	25 Ω to -2.1 V

CONTROL INPUTS ONLY

10H ECL DC CHARACTERISTICS: $V_{CCT} = +5.0 \pm 10\%$, $V_{EE} = -5.2 \pm 5\%$

Test Symbol	Parameter	$T_A = 0^\circ\text{C}$		$T_A = 25^\circ\text{C}$		$T_A = 75^\circ\text{C}$		Unit	Condition
		Min	Max	Min	Max	Min	Max		
V _{IH} V _{IL}	Input HIGH Voltage Input LOW Voltage	-1170 -1950	-840 -1480	-1130 -1950	-810 -1480	-1070 -1950	-735 -1450	mV	

CONTROL INPUTS ONLY

100H ECL DC CHARACTERISTICS: $V_{CCT} = +5.0 \pm 10\%$, $V_{EE} = -4.2\text{ V}$ to -5.5 V

Test Symbol	Parameter	$T_A = 0^\circ\text{C}$		$T_A = 25^\circ\text{C}$		$T_A = 75^\circ\text{C}$		Unit	Condition
		Min	Max	Min	Max	Min	Max		
V _{IH} V _{IL}	Input HIGH Voltage Input LOW Voltage	-1165 -1810	-880 -1475	-1165 -1810	-880 -1475	-1165 -1810	-880 -1475	mV	

TTL DC CHARACTERISTICS: $V_{CCT} = +5.0\text{ V} \pm 10\%$, $V_{EE} = -5.2 \pm 5\%$ (10H Version); $V_{EE} = -4.2\text{ V}$ to -5.5 V (100H Version)

Test Symbol	Parameter	$T_A = 0^\circ\text{C}$		$T_A = 25^\circ\text{C}$		$T_A = 75^\circ\text{C}$		Unit	Condition
		Min	Max	Min	Max	Min	Max		
V _{IH} V _{IL}	Standard Input Standard Input	2.0	0.8	2.0	0.8	2.0	0.8	V _d	
V _{IK}	Input Clamp		-1.2		-1.2		-1.2	V _d	I _{IN} = -18 mA
V _{OH} V _{OL}	Output HIGH Voltage Output HIGH Voltage	2.5 2.0		2.5 2.0		2.5 2.0		V	I _{OH} = -3.0 mA I _{OH} = -15 mA
V _{OL}	Output LOW Voltage		0.55		0.55		0.55	V	I _{OL} = 48 mA
I _{IH} * I _{IH} *	TTL (Input HIGH) TTL (Input HIGH)		20 100		20 100		20 100	μA	V _{in} = 2.7 V V _{in} = 7.0 V
I _{IL} *	TTL (Input LOW)		-0.6		-0.6		-0.6	mA	V _{in} = 0.5 V
I _{CCL}	Supply Current		75		75		75	mA	
I _{CCH}	Supply Current		70		70		70	mA	
I _{CCZ}	Supply Current		70		70		70	mA	
I _{OS}	Output Short Circuit Current	-100	-225	-100	-225	-100	-225	mA	V _{OUT} = 0 V

* NOTE: TTL Control Inputs only

TTL I/O DC CHARACTERISTICS ONLY

Test Symbol	Parameter	$T_A = 0^\circ\text{C}$		$T_A = 25^\circ\text{C}$		$T_A = 75^\circ\text{C}$		Unit	Condition
		Min	Max	Min	Max	Min	Max		
I _{IH} /I _{OZH} I _{IL} /I _{OZL}	Output Disable Current		70 200		70 200		70 200	μA	V _{OUT} = 2.7 V V _{OUT} = 0.5 V

ECL TO TTL DIRECTION / AC TEST

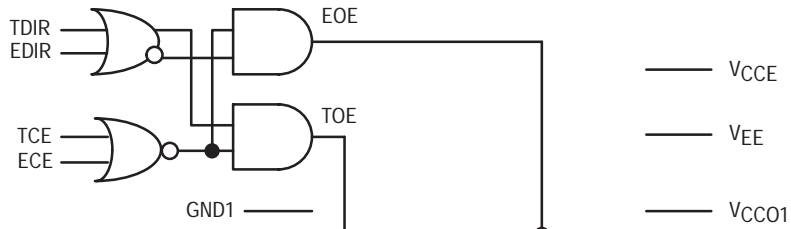
Test Symbol	Parameter	Waveforms	T _A = 0°C		T _A = 25°C		T _A = 75°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
t _{PLH} t _{PHL}	Propagation Delay to Output	2, 4	2.7	4.8	2.7	4.8	2.7	4.8	ns	C _L = 50 pF
t _{PZH} t _{PZL}	ECEB to Output Enable Time	2, 5, 6	3.5 3.5	6.5 6.0	3.5 3.5	6.5 6.0	3.7 3.7	6.7 6.4	ns	C _L = 50 pF
t _{PHZ} t _{PLZ}	ECEB to Output Disable Time	2, 5, 6	3.5 3.5	8.6 6.5	3.5 3.5	8.6 6.5	3.7 3.7	8.8 7.3	ns	C _L = 50 pF
t _{PZH} t _{PZL}	TCEB to Output Enable Time	2, 5, 6	5.7 5.4	7.7 6.9	5.7 5.4	7.7 6.9	5.9 5.9	7.9 7.4	ns	C _L = 50 pF
t _{PHZ} t _{PLZ}	TCEB to Output Disable Time	2, 5, 6	4.0 4.0	8.5 5.8	4.1 4.2	8.4 6.0	4.2 4.7	8.3 6.5	ns	C _L = 50 pF
t _r /t _f	1.0 to 2.0 Vdc	3	0.4	1.5	0.4	1.5	0.4	1.5	ns	C _L = 50 pF

TTL TO ECL DIRECTION / AC TEST

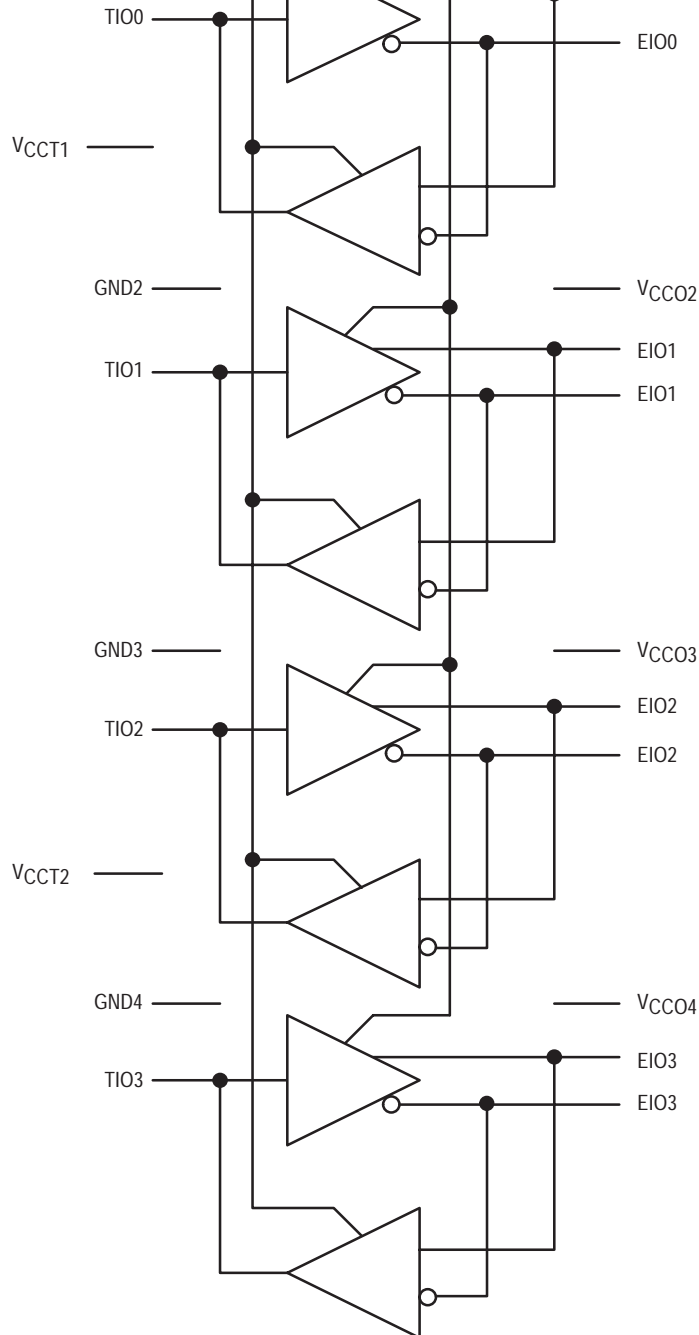
Test Symbol	Parameter	Waveforms	T _A = 0°C		T _A = 25°C		T _A = 75°C		Unit	Condition
			Min	Max	Min	Max	Min	Max		
t _{PLH} t _{PHL}	Propagation Delay to Output	1, 4	1.8	4.6	1.8	4.6	2.0	4.9	ns	25 Ω to -2.0 V
t _{PLH} t _{PHL}	ECEB to Output	1, 4	2.9	5.1	3.0	5.2	3.4	5.7	ns	25 Ω to -2.0 V
t _{PLH} t _{PHL}	TCEB to Output	1, 4	3.4	6.3	3.5	6.6	3.8	7.4	ns	25 Ω to -2.0 V
t _r /t _f	Output Rise/Fall Time 20%–80%	1, 3	1.0	3.4	1.0	3.4	1.0	3.4	ns	25 Ω to -2.0 V

BLOCK DIAGRAM

CONTROL INPUTS



TTL I/O



ECL I/O

SWITCHING CIRCUIT AND WAVEFORMS

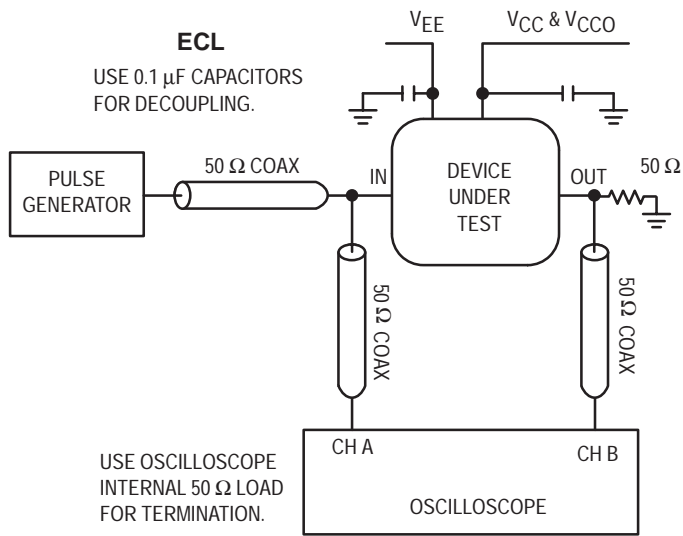


Figure 1. Switching Circuit ECL

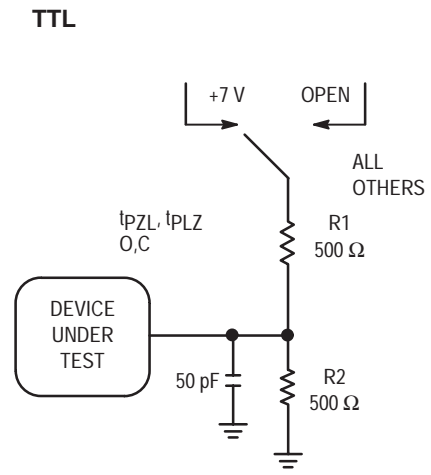


Figure 2.

ECL/TTL

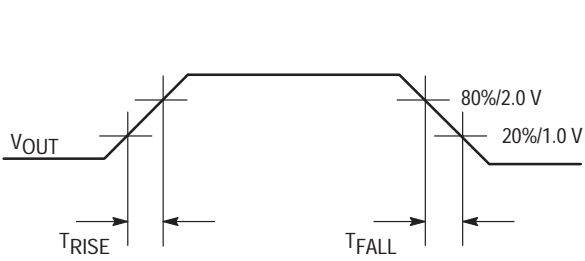


Figure 3. WAVEFORMS: Rise and Fall Times

ECL/TTL

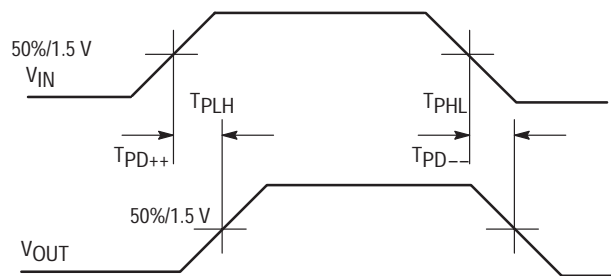


Figure 4. Propagation Delay — Single Ended

TTL

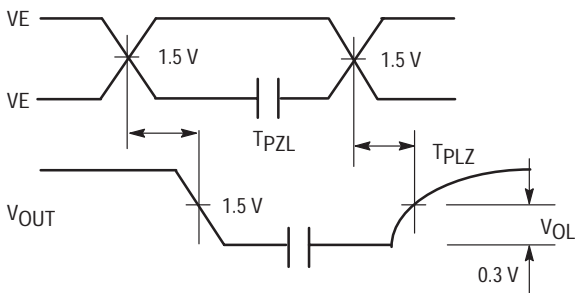


Figure 5. 3-State Output Low Enable and Disable Times

TTL

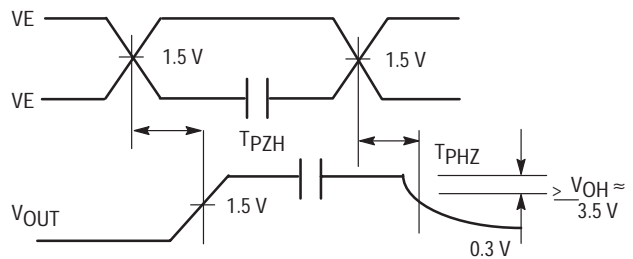


Figure 6. 3-State Output High Enable and Disable Times

Hex ECL/TTL Transceiver with Latches

MC10H681
MC100H681

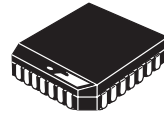
The MC10/100H681 is a dual supply Hex ECL/TTL transceiver with latches in both directions. ECL controlled Direction and Chip Enable Bar pins. There are two Latch Enable pins, one for each direction.

The ECL outputs are single ended and drive 50 Ω. The TTL outputs are specified to source 15 mA and sink 48 mA, allowing the ability to drive highly capacitive loads. The high driving ability of the TTL outputs make the device ideal for bussing applications.

The ECL output levels are standard V_{OH} and V_{OL} cutoff equal to $-2.0 V$ (V_{TT}). When the ECL ports are disabled the outputs go to the V_{OL} cutoff level. Multiple ECL V_{CCO} pins are utilized to minimize switching noise.

The TTL ports have standard levels. The TTL input receivers have PNP input devices to significantly reduce loading. Multiple TTL power and ground pins are utilized to minimize switching noise.

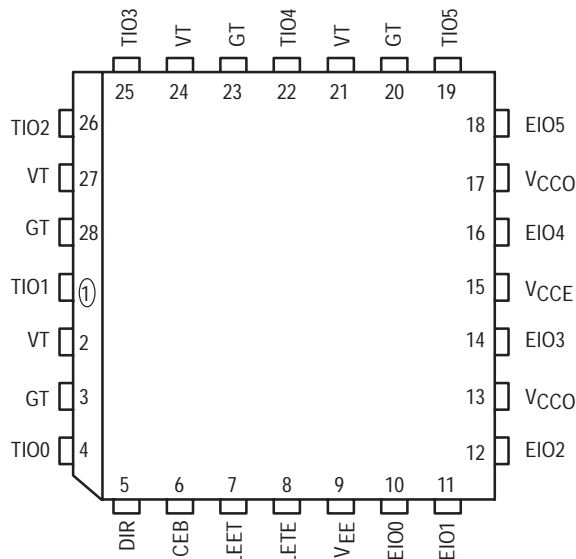
The 10H version is compatible with MECL 10H ECL logic levels. The 100H version is compatible with 100K levels.



FN SUFFIX
PLASTIC PACKAGE
CASE 776-02

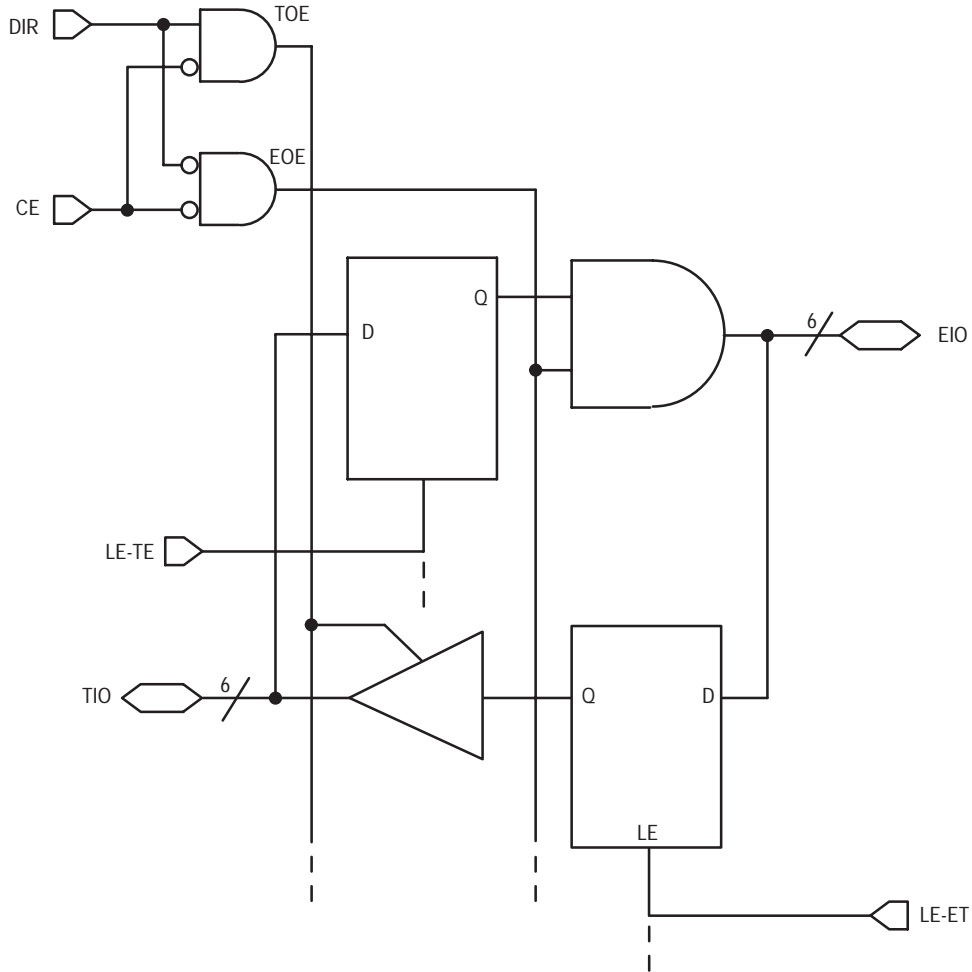
- Separate Latch Enable Controls for each Direction
- ECL Single Ended 50 Ω I/O Port
- High Drive TTL I/O Ports
- Extra TTL and ECL Power/Ground Pins to Minimize Switching Noise
- Dual Supply
- Direction and Chip Enable Control Pins

Pinout: 28-Lead PLCC (Top View)



Pin	Symbol	Description
1	TI01	TTL I/O BIT 1
2	VT	TTL V_{CC} (5.0 V)
3	GT	TTL GND (0 V)
4	TI00	TTL I/O Bit 0
5	DIR	Direction Control (ECL)
6	CEB	Chip Enable Bar Control (ECL)
7	LEET	Latch Enable ECL-TTL Control (ECL)
8	LETE	Latch Enable TTL-ECL Control (ECL)
9	V_{EE}	ECL Supply ($-5.2/-4.5 V$)
10	EIO0	ECL I/O BIT 0
11	EIO1	ECL I/O BIT 1
12	EIO2	ECL I/O BIT 2
13	V_{CCO}	ECL V_{CC} (0 V) — Outputs
14	EIO3	TTL I/O BIT 3
15	V_{CCE}	ECL V_{CC} (0 V)
16	EIO4	ECL I/O BIT 4
17	V_{CCO}	ECL V_{CC} (0 V) — Outputs
18	EIO5	ECL I/O BIT 5
19	TI05	TTL I/O BIT 5
20	GT	TTL GND (0 V)
21	VT	TTL V_{CC} (5.0 V)
22	TI04	TTL I/O BIT 4
23	GT	TTL GND (0 V)
24	VT	TTL V_{CC} (5.0 V)
25	TIO3	TTL I/O BIT 3
26	TIO2	TTL I/O BIT 2
27	VT	TTL V_{CC} (5.0 V)
28	GT	TTL V_{CC} (0 V)





TRUTH TABLE

CEB	DIR	LEET	LETE	EOUT	TOUT
H	X	X	X	Z	Z
L	H	L	L	Z	EIN
L	H	H	L	Z	Qo
L	L	L	L	TIN	Z
L	L	L	H	Qo	Z

- Hex
- Bi-Directional
- ECL/TTL Translation
- Dual Supply
- ECL Outputs, 50 Ohm S.E., V_{OH}/Cutoff
- TTL Outputs, 48 mA Sink, 15 mA Source
- Multi Power and Ground Pins
- Separate LE Controls

ECL DC CHARACTERISTICS: $V_{CCT} = +5.0\text{ V} \pm 10\%$, $V_{EE} = -5.2 \pm 5\%$ (10H Version); $V_{EE} = -4.2\text{ V}$ to -5.5 V (100H Version)

Test Symbol	Parameter	$T_A = 0^\circ\text{C}$		$T_A = 25^\circ\text{C}$		$T_A = 75^\circ\text{C}$		Unit	Condition
		Min	Max	Min	Max	Min	Max		
I_{EE}	Supply Current/ECL	—	-113	—	-113	—	-113	mA	
I_{INH}	Input HIGH Current	—	225	—	145	—	145	μA	
I_{INL}	Input LOW Current	0.5	—	0.5	—	0.3	—	μA	
V_{OH} V_{OL}	Output HIGH Voltage Output LOW Voltage	-1020 -2.1	-840 -2.03	-980 -2.1	-810 -2.03	-920 -2.1	-735 -2.03	mV V	50 Ω to -2.1 V

10H ECL DC CHARACTERISTICS: $V_{CCT} = +5.0 \pm 10\%$, $V_{EE} = -5.2 \pm 5\%$

Test Symbol	Parameter	$T_A = 0^\circ\text{C}$		$T_A = 25^\circ\text{C}$		$T_A = 75^\circ\text{C}$		Unit	Condition
		Min	Max	Min	Max	Min	Max		
V_{IH} V_{IL}	Input HIGH Voltage Input LOW Voltage	-1170 -1950	-840 -1480	-1130 -1950	-810 -1480	-1070 -1950	-735 -1450	mV	

100H ECL DC CHARACTERISTICS: $V_{CCT} = +5.0 \pm 10\%$, $V_{EE} = -4.2\text{ V}$ to -5.5 V

Test Symbol	Parameter	$T_A = 0^\circ\text{C}$		$T_A = 25^\circ\text{C}$		$T_A = 75^\circ\text{C}$		Unit	Condition
		Min	Max	Min	Max	Min	Max		
V_{IH} V_{IL}	Input HIGH Voltage Input LOW Voltage	-1165 -1810	-880 -1475	-1165 -1810	-880 -1475	-1165 -1810	-880 -1475	mV	

ABSOLUTE RATINGS (Do not exceed):

Power Supply Voltage	V_{EE} (ECL)	-8.0 to 0	Vdc
Power Supply Voltage	V_{CCT} (TTL)	-0.5 to +7.0	Vdc
Input Voltage	V_I (ECL) V_I (TTL)	0.0 to V_{EE} -0.5 to +7.0	Vdc
Disabled 3-State Output	V_{out} (TTL)	0.0 to V_{CCT}	Vdc
Output Source Current Continuous	I_{out} (ECL)	100	mAdc
Output Source Current Surge	I_{out} (ECL)	200	mAdc
Storage Temperature	T_{stg}	-65 to 150	$^\circ\text{C}$
Operating Temperature	T_{amb}	0.0 to +75	$^\circ\text{C}$

TTL DC CHARACTERISTICS: $V_{CC} = +5.0\text{ V} \pm 10\%$, $V_{EE} = -5.2 \pm 5\%$ (10H Version); $V_{EE} = -4.2\text{ V}$ to -5.5 V (100H Version)

Test Symbol	Parameter	$T_A = 0^\circ\text{C}$		$T_A = 25^\circ\text{C}$		$T_A = 75^\circ\text{C}$		Unit	Condition
		Min	Max	Min	Max	Min	Max		
V_{IH} V_{IL}	Standard Input Standard Input	2.0 —	— 0.8	2.0 —	— 0.8	2.0 —	— 0.8	Vdc	
V_{IK}	Input Clamp	—	-1.2	—	-1.2	—	-1.2	Vdc	$I_{IN} = -18\text{ mA}$
V_{OH}	Output HIGH Voltage Output HIGH Voltage	2.5 2.0	— —	2.5 2.0	— —	2.5 2.0	— —	V	$I_{OH} = -3.0\text{ mA}$ $I_{OH} = -15\text{ mA}$
V_{OL}	Output LOW Voltage	—	0.55	—	0.55	—	0.55	V	$I_{OL} = 48\text{ mA}$
I_{IH}/I_{OZH} I_{IL}/I_{OZL}	Output Disable Current	— —	70 200	— —	70 200	— —	70 200	μA	$V_{OUT} = 2.7\text{ V}$ $V_{OUT} = 0.5\text{ V}$
I_{CCL}	Supply Current	—	63	—	63	—	63	mA	
I_{CCH}	Supply Current	—	63	—	63	—	63	mA	
I_{CCZ}	Supply Current	—	63	—	63	—	63	mA	
I_{OS}	Output Short Circuit Current	-100	-225	-100	-225	-100	-225	mA	$V_{OUT} = 0\text{ V}$

ECL TO TTL DIRECTION AC CHARACTERISTICS

Test Symbol	Parameter	$T_A = 0^\circ\text{C}$		$T_A = 25^\circ\text{C}$		$T_A = 75^\circ\text{C}$		Unit	Condition
		Min	Max	Min	Max	Min	Max		
t_{PLH} t_{PHL}	Propagation Delay to Output	4.0	7.8	4.0	7.8	4.2	8.0	ns	$C_L = 50\text{ pF}$
t_{PLH} t_{PHL}	LEET to Output	5.5 5.5	8.3 7.6	5.5 5.5	8.3 7.6	5.7 5.8	8.5 8.0	ns	$C_L = 50\text{ pF}$
t_{PZH} t_{PZL}	CEB to Output Enable Time	5.5 5.3	8.3 8.3	5.5 5.3	8.3 8.3	4.7 5.4	8.5 8.4	ns	$C_L = 50\text{ pF}$
t_{PHZ} t_{PLZ}	CEB to Output Disable Time	3.5 3.5	7.2 5.3	3.5 3.5	7.2 5.3	3.7 4.1	7.3 5.8	ns	$C_L = 50\text{ pF}$
t_r/t_f	1.0 Vdc to 2.0 Vdc	0.4	2.2	0.4	2.2	0.4	2.2	ns	$C_L = 50\text{ pF}$

TTL TO ECL DIRECTION AC CHARACTERISTICS

Test Symbol	Parameter	$T_A = 0^\circ\text{C}$		$T_A = 25^\circ\text{C}$		$T_A = 75^\circ\text{C}$		Unit	Condition
		Min	Max	Min	Max	Min	Max		
t_{PLH} t_{PHL}	Propagation Delay to Output	1.9	3.9	1.9	3.9	2.2	4.4	ns	$50\ \Omega$ to -2.0 V
t_{PHL} t_{PLH}	CEB to Output	2.2 2.3	4.0 4.6	2.2 2.3	4.0 4.6	2.5 2.7	4.3 5.0	ns	$50\ \Omega$ to -2.0 V
t_{PHL} t_{PLH}	LETE to Output	2.4	3.9	2.4	3.9	2.7	4.3	ns	$50\ \Omega$ to -2.0 V
t_r/t_f	Output Rise/Fall Time 20%–80%	0.4	2.2	0.4	2.2	0.4	2.2	ns	$50\ \Omega$ to -2.0 V

TEST CIRCUITS AND WAVEFORMS

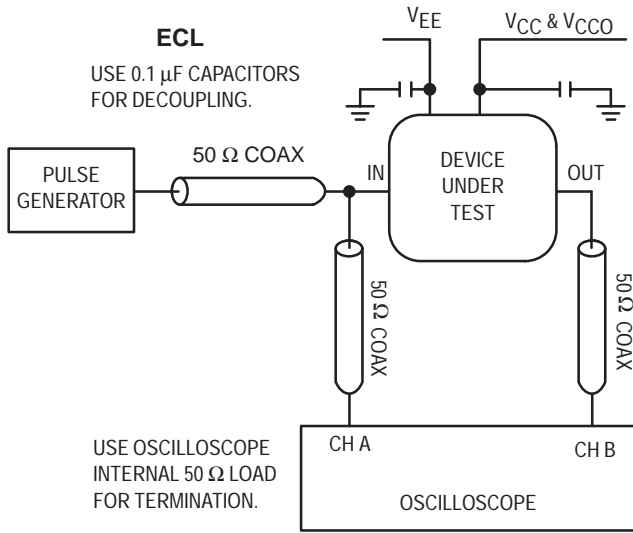


Figure 1. Test Circuit ECL

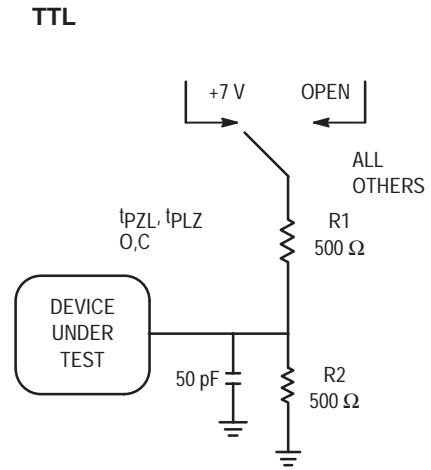


Figure 2. Test Circuit TTL

ECL/TTL

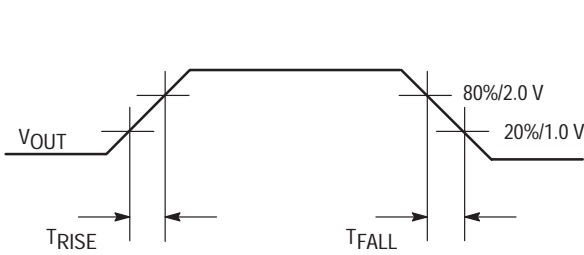


Figure 3. Rise and Fall Times

ECL/TTL

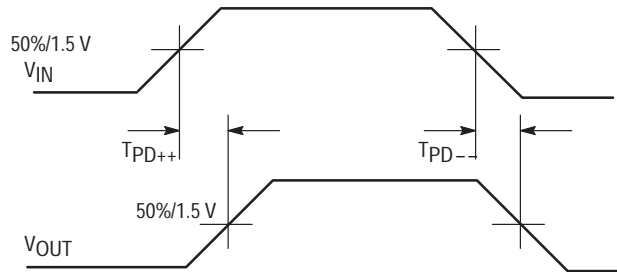


Figure 4. Propagation Delay — Single Ended

TTL

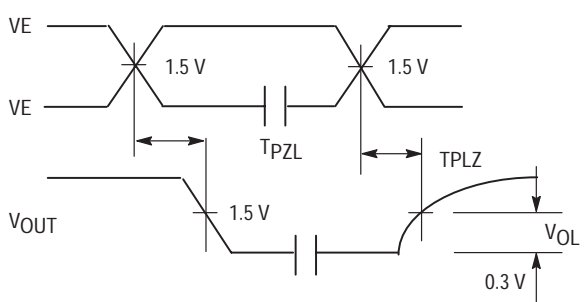


Figure 5. 3-State Output Low Enable and Disable Times

TTL

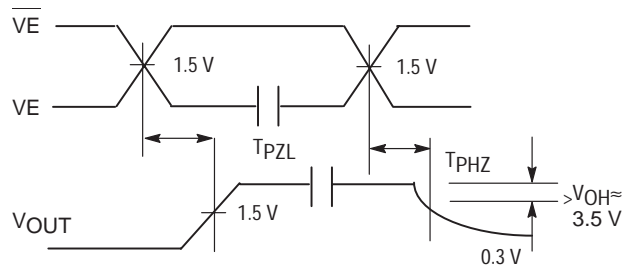


Figure 6. 3-State Output High Enable and Disable Times

MECL Data



MECL 10K **3**

MECL 10K INTEGRATED CIRCUITS

MC10,100/10,200 Series

–30 to 85°C

Function Selection — (–30° to +85°C)

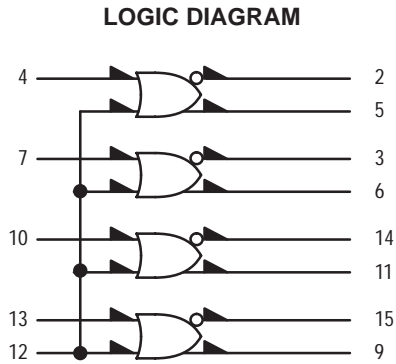
Function	Device	Case
NOR Gates		
Quad 2-Input Gate	MC10102	620, 648, 775
Triple 4-3-3 Input Gate	MC10106	620, 648, 775
Dual 3-Input 3-Output Gate	MC10111	620, 648
Dual 3-Input 3-Output Gate	MC10211	620, 648, 775
OR Gates		
Quad 2-Input Gate	MC10103	620, 648, 775
Dual 3-Input 3-Output Gate	MC10110	620, 648
Dual 3-Input 3-Output Gate	MC10210	620, 648, 775
AND Gates		
Quad 2-Input Gate	MC10104	620, 648, 775
Hex Gate	MC10197	620, 648, 775
Complex Gates		
Quad OR/NOR Gate	MC10101	620, 648, 775
Triple 2-3-2 Input OR/NOR Gate	MC10105	620, 648, 775
Dual 4-5 Input OR/NOR Gate	MC10109	620, 648, 775
Dual 3-Input 3-Output OR/NOR Gate	MC10212	648, 775
Triple 2-Input Exclusive OR/NOR Gate	MC10107	620, 648, 775
Quad 2-Input Exclusive OR/NOR Gate	MC10113	620, 648, 775
Dual 2-Wide 2-3 Input OR-AND/OR-AND INVERT	MC10117	620, 648, 775
4-Wide 3-Input OR-AND/OR-AND INVERT	MC10121	620, 648, 775
Buffers/Inverters		
Hex Buffer/Enable	MC10188	620, 648, 775
Hex Inverter/Enable	MC10189	620, 648, 775
Hex Inverter/Buffer	MC10195	620, 648, 775
Line Drivers/Line Receivers		
Triple Line Receiver	MC10114	620, 648, 775
Quad Line Receiver	MC10115	620, 648, 775
Triple Line Receiver	MC10116	620, 648, 775
Triple Bus Driver	MC10123	620, 648, 775
Quad Bus Receiver	MC10129	620
Quad Bus Driver	MC10192	620, 648, 775
Triple Line Receiver	MC10216	620, 648, 775
Translators		
Quad TTL-MECL	MC10124	620, 648, 775
Quad MECL-TTL	MC10125	620, 648, 775

Function	Device	Case
Flip-Flop/Latches		
Dual D Master Slave Flip-Flop	MC10131	620, 648, 775
Dual J-K Master Slave Flip-Flop	MC10135	620, 648, 775
Quad Latch	MC10153	620, 648, 775
Hex D Master Slave Flip-Flop	MC10176	620, 648, 775
Hex D Common Reset Flip-Flop	MC10186	620, 648, 775
Dual D Master Slave Flip-Flop	MC10231	620, 648, 775
Quad Latch	MC10133	620, 648
Quint Latch	MC10175	620, 648, 775
Quad/Common Clock Latch	MC10168	648
Encoders		
8-Input Encoder	MC10165	620, 648
Decoders		
Binary to 1-8 (Low)	MC10161	620, 648, 775
Binary to 1-8 (High)	MC10162	620, 648, 775
Dual Binary to 1-4 (Low)	MC10171	620, 648, 775
Dual Binary to 1-4 (High)	MC10172	620, 648, 775
Parity Generator/Checkers		
12-Bit Parity Generator-Checker	MC10160	620, 648
9 + 2 Bit Parity	MC10170	620, 648
Counters		
Hexadecimal	MC10136	620, 648, 775
Decade	MC10137	620, 648
Biquinary	MC10138	620, 648, 775
Binary Down Counter	MC10154	620, 648
Binary	MC10178	620, 648, 775
Arithmetic Functions		
5-Bit Magnitude Comparator	MC10166	620, 648, 775
4-Bit Arithmetic Function Gen.	MC10181	623
Shift Register		
4-Bit Universal	MC10141	620, 648, 775
Multivibrators		
Monostable Multivibrators	MC10198	620, 648, 775
Multiplexer		
Dual with Latch	MC10134	620, 648, 775
Quad 2-Input/Noninverting	MC10158	620, 648, 775
Quad 2-Input/Inverting	MC10159	620, 648, 775
8-Line	MC10164	620, 648, 775
Quad 2-Input/Latch	MC10173	620, 648, 775
Dual 4-1	MC10174	620, 648, 775

Quad OR/NOR Gate

The MC10101 is a quad 2-input OR/NOR gate with one input from each gate common to pin 12.

$P_D = 25 \text{ mW typ/gate (No Load)}$
 $t_{pd} = 2.0 \text{ ns typ}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

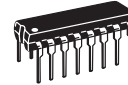


$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

MC10101



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

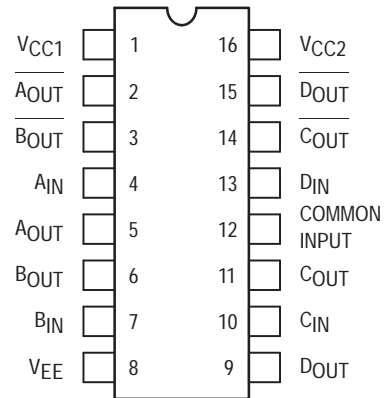


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I _E	8		29		20	26		29	mAdc
Input Current	I _{inH}	4		425			265		265	μAdc
		12		850			535		535	
Input Current	I _{inL}	4	0.5		0.5			0.3		μAdc
		12	0.5		0.5			0.3		
Output Voltage Logic 1	V _{OH}	5	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		5	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
		2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
		2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Output Voltage Logic 0	V _{OL}	5	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		5	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
		2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
		2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V _{OHA}	5	-1.080		-0.980			-0.910		Vdc
		5	-1.080		-0.980			-0.910		
		2	-1.080		-0.980			-0.910		
		2	-1.080		-0.980			-0.910		
Threshold Voltage Logic 0	V _{OLA}	5		-1.655			-1.630		-1.595	Vdc
		5		-1.655			-1.630		-1.595	
		2		-1.655			-1.630		-1.595	
		2		-1.655			-1.630		-1.595	
Switching Times (50Ω Load)									ns	
Propagation Delay	t ₄₊₂₋ t ₄₋₂₊ t ₄₊₅₊ t ₄₋₅₋	2	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
		2	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
		5	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
		5	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
Rise Time (20 to 80%)	t ₂₊ t ₅₊	2	1.1	3.6	1.1	2.0	3.3	1.1	3.7	
		5	1.1	3.6	1.1	2.0	3.3	1.1	3.7	
Fall Time (20 to 80%)	t ₂₋ t ₅₋	2	1.1	3.6	1.1	2.0	3.3	1.1	3.7	
		5	1.1	3.6	1.1	2.0	3.3	1.1	3.7	

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd	
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
Power Supply Drain Current	I _E	8					8	1, 16	
Input Current	I _{inH}	4	4				8	1, 16	
		12	12				8	1, 16	
	I _{inL}	4		4			8	1, 16	
		12		12			8	1, 16	
Output Voltage	Logic 1	V _{OH}	5	12			8	1, 16	
			5	4			8	1, 16	
			2				8	1, 16	
			2				8	1, 16	
Output Voltage	Logic 0	V _{OL}	5				8	1, 16	
			5				8	1, 16	
			2	12			8	1, 16	
			2	4			8	1, 16	
Threshold Voltage	Logic 1	V _{OHA}	5		12		8	1, 16	
			5		4		8	1, 16	
			2			12	8	1, 16	
			2			4	8	1, 16	
Threshold Voltage	Logic 0	V _{OLA}	5			12	8	1, 16	
			5			4	8	1, 16	
			2		12		8	1, 16	
			2		4		8	1, 16	
Switching Times	(50Ω Load)					Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay		t ₄₊₂₋	2			4	2	8	1, 16
		t ₄₋₂₊	2			4	2	8	1, 16
		t ₄₊₅₊	5			4	5	8	1, 16
		t ₄₋₅₋	5			4	5	8	1, 16
Rise Time	(20 to 80%)	t ₂₊	2			4	2	8	1, 16
		t ₅₊	5			4	5	8	1, 16
Fall Time	(20 to 80%)	t ₂₋	2			4	2	8	1, 16
		t ₅₋	5			4	5	8	1, 16

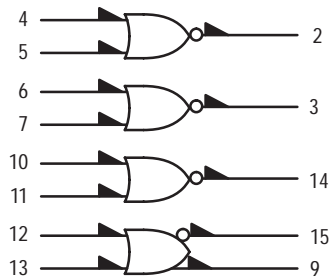
Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Quad 2-Input NOR Gate

The MC10102 is a quad 2-input NOR gate. The MC10102 provides one gate with OR/NOR outputs.

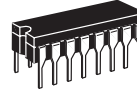
$P_D = 25 \text{ mW typ/gate (No Load)}$
 $t_{pd} = 2.0 \text{ ns typ}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

LOGIC DIAGRAM



$V_{CC1} = \text{PIN 1}$
 $V_{CC2} = \text{PIN 16}$
 $V_{EE} = \text{PIN 8}$

MC10102



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

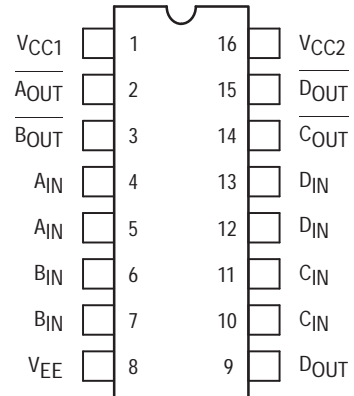


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I_E	8		29		20	26		29	mAdc
Input Current	I_{inH}	12		425			265		265	μ Adc
	I_{inL}	12	0.5		0.5			0.3		μ Adc
Output Voltage Logic 1	V_{OH}	9	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		9	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
		15	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
		15	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Output Voltage Logic 0	V_{OL}	9	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		9	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
		15	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
		15	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V_{OHA}	9	-1.080		-0.980			-0.910		Vdc
		9	-1.080		-0.980			-0.910		
		15	-1.080		-0.980			-0.910		
		15	-1.080		-0.980			-0.910		
Threshold Voltage Logic 0	V_{OLA}	9		-1.655			-1.630		-1.595	Vdc
		9		-1.655			-1.630		-1.595	
		15		-1.655			-1.630		-1.595	
		15		-1.655			-1.630		-1.595	
Switching Times (50 Ω Load)										ns
Propagation Delay	t_{12+15-}	15	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
		15	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
		9	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
		9	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
Rise Time (20 to 80%)	t_{15+}	15	1.1	3.6	1.1	2.0	3.3	1.1	3.7	
		9	1.1	3.6	1.1	2.0	3.3	1.1	3.7	
Fall Time (20 to 80%)	t_{15-}	15	1.1	3.6	1.1	2.0	3.3	1.1	3.7	
		9	1.1	3.6	1.1	2.0	3.3	1.1	3.7	

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd	
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
Power Supply Drain Current	I _E	8					8	1, 16	
Input Current	I _{inH}	12	12				8	1, 16	
	I _{inL}	12		12			8	1, 16	
Output Voltage	Logic 1	V _{OH}	9	12			8	1, 16	
			9	13			8	1, 16	
			15				8	1, 16	
			15				8	1, 16	
Output Voltage	Logic 0	V _{OL}	9				8	1, 16	
			9				8	1, 16	
			15	12			8	1, 16	
			15	13			8	1, 16	
Threshold Voltage	Logic 1	V _{OHA}	9		12		8	1, 16	
			9		13		8	1, 16	
			15			12	8	1, 16	
			15			13	8	1, 16	
Threshold Voltage	Logic 0	V _{OLA}	9			12	8	1, 16	
			9			13	8	1, 16	
			15		12		8	1, 16	
			15		13		8	1, 16	
Switching Times	(50Ω Load)				Pulse In	Pulse Out	-3.2 V	+2.0 V	
Propagation Delay	t ₁₂₊₁₅₋ t ₁₂₋₁₅₊ t ₁₂₊₉₊ t ₁₂₋₉₋	15			12	15	8	1, 16	
		15			12	15	8	1, 16	
		9			12	9	8	1, 16	
		9			12	9	8	1, 16	
Rise Time	(20 to 80%)	t ₁₅₊ t ₉₊	15			12	15	8	1, 16
			9			12	9	8	1, 16
Fall Time	(20 to 80%)	t ₁₅₋ t ₉₋	15			12	15	8	1, 16
			9			12	9	8	1, 16

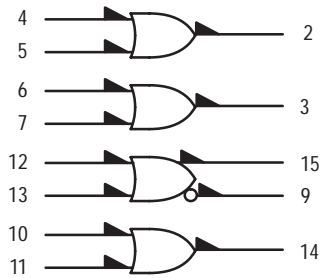
Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Quad 2-Input OR Gate

The MC10103 is a quad 2-input OR gate. The MC10103 provides one gate with OR/NOR outputs.

$P_D = 25 \text{ mW typ/gate (No Load)}$
 $t_{pd} = 2.0 \text{ ns typ}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

LOGIC DIAGRAM

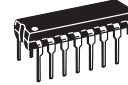


$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

MC10103



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

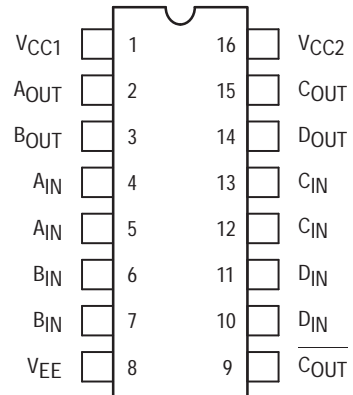


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I_E	8		29		21	26		29	mA _{dc}
Input Current	I_{inH}	4*		390			245		245	μA _{dc}
	I_{inL}	4*	0.5		0.5			0.3		μA _{dc}
Output Voltage Logic 1	V_{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	V _{dc}
		9	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Output Voltage Logic 0	V_{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	V _{dc}
		9	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V_{OHA}	2	-1.080		-0.980			-0.910		V _{dc}
		9	-1.080		-0.980			-0.910		
Threshold Voltage Logic 0	V_{OLA}	2		-1.655			-1.630		-1.595	V _{dc}
		9		-1.655			-1.630		-1.595	
Switching Times (50Ω Load)										ns
Propagation Delay	t_{4+2+}	2	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
	t_{12+9-}	9	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
Rise Time (20 to 80%)	t_{2+}	2	1.1	3.6	1.1	2.0	3.3	1.1	3.7	
Fall Time (20 to 80%)	t_{2-}	2	1.1	3.6	1.1	2.0	3.3	1.1	3.7	

* Individually test each input applying V_{IH} or V_{IL} to input under test.

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd	
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
Power Supply Drain Current	I _E	8					8	1, 16	
Input Current	I _{inH}	4*	4*				8	1, 16	
	I _{inL}	4*		4*			8	1, 16	
Output Voltage	Logic 1	V _{OH}	2 9	4.5			8	1, 16	
							8	1, 16	
Output Voltage	Logic 0	V _{OL}	2 9	12, 13			8	1, 16	
							8	1, 16	
Threshold Voltage	Logic 1	V _{OHA}	2 9			4, 5	12, 13	8	
							8	1, 16	
Threshold Voltage	Logic 0	V _{OLA}	2 9			12, 13	4, 5	8	
							8	1, 16	
Switching Times	(50Ω Load)					Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay		t ₄₊₂₊ t ₁₂₊₉₋	2 9			4 12	2 9	8	1, 16
								8	1, 16
Rise Time	(20 to 80%)	t ₂₊	2			4	2	8	1, 16
Fall Time	(20 to 80%)	t ₂₋	2			4	2	8	1, 16

* Individually test each input applying V_{IH} or V_{IL} to input under test.

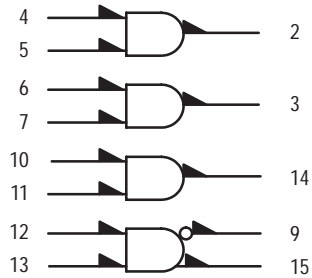
Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Quad 2-Input AND Gate

The MC10104 is a quad 2-input AND gate. One of the gates has both AND/NAND outputs available.

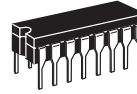
$P_D = 35 \text{ mW typ/gate (No Load)}$
 $t_{pd} = 2.7 \text{ ns typ}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

LOGIC DIAGRAM



$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

MC10104



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

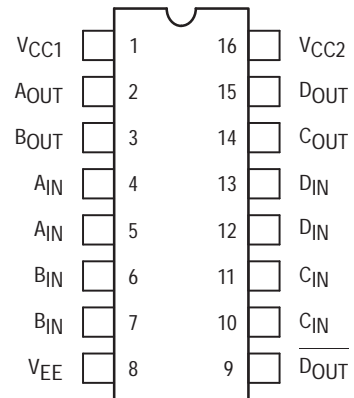


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I_E	8		39			35		39	mA _{dc}
Input Current	I_{inH}^*	12		425			265		265	μ A _{dc}
		13		350			220		220	
	I_{inL}	12	0.5		0.5			0.3		μ A _{dc}
Output Voltage Logic 1	V_{OH}	15	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	V _{dc}
		9	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Output Voltage Logic 0	V_{OL}	15	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	V _{dc}
		9	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V_{OHA}	9	-1.090		-0.980			-0.910		V _{dc}
		9	-1.090		-0.980			-0.910		
		15	-1.090		-0.980			-0.910		
		15	-1.090		-0.980			-0.910		
Threshold Voltage Logic 0	V_{OLA}	9		-1.655			-1.630		-1.595	V _{dc}
		9		-1.655			-1.630		-1.595	
		15		-1.655			-1.630		-1.595	
		15		-1.655			-1.630		-1.595	
Switching Times (50 Ω Load)									ns	
Propagation Delay	t_{12+15+}	15	1.0	4.3	1.0	2.2	4.0	1.0	4.2	
		15	1.0	4.3	1.0	2.2	4.0	1.0	4.2	
		9	1.0	4.3	1.0	2.2	4.0	1.0	4.2	
		9	1.0	4.3	1.0	2.2	4.0	1.0	4.2	
		15	1.0	4.3	1.0	2.7	4.0	1.0	4.2	
		9	1.0	4.3	1.0	2.7	4.0	1.0	4.2	
Rise Time (20 to 80%)	t_{15+}	15	1.5	3.7	1.5	2.0	3.5	1.5	3.6	
		9	1.5	3.7	1.5	2.0	3.5	1.5	3.6	
Fall Time (20 to 80%)	t_{15-}	15	1.5	3.7	1.5	2.0	3.5	1.5	3.6	
		9	1.5	3.7	1.5	2.0	3.5	1.5	3.6	

* Inputs 4, 7, 10 and 13 will behave similarly for ac and I_{inH} values.
 Inputs 5, 6, 11 and 12 will behave similarly for ac and I_{inH} values.

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					V_{CC} Gnd		
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}			
@ Test Temperature										
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2			
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2			
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2			
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW							
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}			
Power Supply Drain Current	I_E	8					8	1, 16		
Input Current	I_{inH}^*	12	12, 13				8	1, 16		
		13	13				8	1, 16		
	I_{inL}	12		12			8	1, 16		
Output Voltage	Logic 1	V_{OH}	15	12, 13				8	1, 16	
			9					8	1, 16	
Output Voltage	Logic 0	V_{OL}	15					8	1, 16	
			9	12, 13				8	1, 16	
Threshold Voltage	Logic 1	V_{OHA}	9				12	8	1, 16	
			9				13	8	1, 16	
			15	12				8	1, 16	
			15	13				8	1, 16	
Threshold Voltage	Logic 0	V_{OLA}	9	12				8	1, 16	
			9	13				8	1, 16	
			15				12	8	1, 16	
			15				13	8	1, 16	
Switching Times	(50Ω Load)			+1.11V		Pulse In	Pulse Out	-3.2 V	+2.0 V	
Propagation Delay	t_{12+15+} t_{12-15-} t_{12+9-} t_{12-9+} t_{13+15+} t_{13+9-}	15	13			12	15	8	1, 16	
		15	13			12	15	8	1, 16	
		9	13			12	9	8	1, 16	
		9	13			12	9	8	1, 16	
		15	12			13	15	8	1, 16	
		9	12			13	9	8	1, 16	
Rise Time	(20 to 80%)	t_{15+} t_{9+}	15	12			13	15	8	1, 16
			9	12			13	9	8	1, 16
Fall Time	(20 to 80%)	t_{15-} t_{9-}	15	12			13	15	8	1, 16
			9	12			13	9	8	1, 16

* Inputs 4, 7, 10 and 13 will behave similarly for ac and I_{inH} values.
 Inputs 5, 6, 11 and 12 will behave similarly for ac and I_{inH} values.

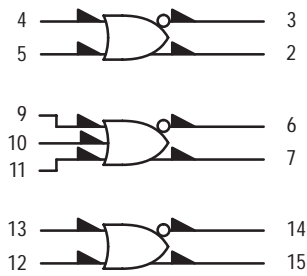
Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Triple 2-3-2-Input OR/NOR Gate

The MC10105 is a triple 2–3–2 input OR/NOR gate.

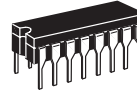
$P_D = 30 \text{ mW typ/gate (No Load)}$
 $t_{pd} = 2.0 \text{ ns typ}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

LOGIC DIAGRAM



$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

MC10105



L SUFFIX
CERAMIC PACKAGE
CASE 620–10

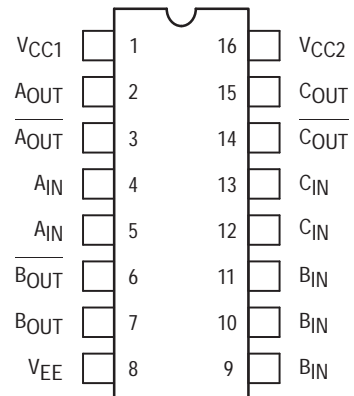


P SUFFIX
PLASTIC PACKAGE
CASE 648–08



FN SUFFIX
PLCC
CASE 775–02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6–11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I _E	8		23		17	21		23	mAdc
Input Current	I _{inH}	4		425			265		265	μAdc
	I _{inL}	4	0.5		0.5			0.3		μAdc
Output Voltage Logic 1	V _{OH}	3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Output Voltage Logic 0	V _{OL}	3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V _{OHA}	3	-1.080		-0.980			-0.910		Vdc
		2	-1.080		-0.980			-0.910		
Threshold Voltage Logic 0	V _{OLA}	3		-1.655			-1.630		-1.595	Vdc
		2		-1.655			-1.630		-1.595	
Switching Times (50Ω Load)										ns
Propagation Delay	t ₄₊₃₋	3	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
	t ₄₋₃₊	3	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
	t ₄₊₂₊	2	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
	t ₄₋₂₋	2	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
Rise Time (20 to 80%)	t ₃₊	3	1.1	3.6	1.1	2.0	3.3	1.1	3.7	
	t ₂₊	2	1.1	3.6	1.1	2.0	3.3	1.1	3.7	
Fall Time (20 to 80%)	t ₃₋	3	1.1	3.6	1.1	2.0	3.3	1.1	3.7	
	t ₂₋	2	1.1	3.6	1.1	2.0	3.3	1.1	3.7	

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd		
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}			
@ Test Temperature										
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2			
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2			
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2			
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW							
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}			
Power Supply Drain Current	I _E	8					8	1, 16		
Input Current	I _{inH}	4	4				8	1, 16		
	I _{inL}	4		4			8	1, 16		
Output Voltage	Logic 1	V _{OH}	3				8	1, 16		
			2	4			8	1, 16		
Output Voltage	Logic 0	V _{OL}	3	4			8	1, 16		
			2				8	1, 16		
Threshold Voltage	Logic 1	V _{OHA}	3			4	8	1, 16		
			2			4	8	1, 16		
Threshold Voltage	Logic 0	V _{OLA}	3			4	8	1, 16		
			2			4	8	1, 16		
Switching Times	(50Ω Load)					Pulse In	Pulse Out	-3.2 V	+2.0 V	
Propagation Delay		t ₄₊₃₋	3			4	3	8	1, 16	
		t ₄₋₃₊	3			4	3	8	1, 16	
		t ₄₊₂₊	2			4	2	8	1, 16	
		t ₄₋₂₋	2			4	2	8	1, 16	
Rise Time	(20 to 80%)		t ₃₊	3			4	3	8	1, 16
			t ₂₊	2			4	2	8	1, 16
Fall Time	(20 to 80%)		t ₃₋	3			4	3	8	1, 16
			t ₂₋	2			4	2	8	1, 16

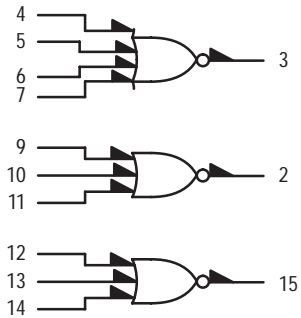
Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Triple 4-3-3-Input NOR Gate

The MC10106 is a triple 4-3-3 input NOR gate.

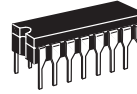
$P_D = 30 \text{ mW typ/gate (No Load)}$
 $t_{pd} = 2.0 \text{ ns typ}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

LOGIC DIAGRAM



$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

MC10106



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

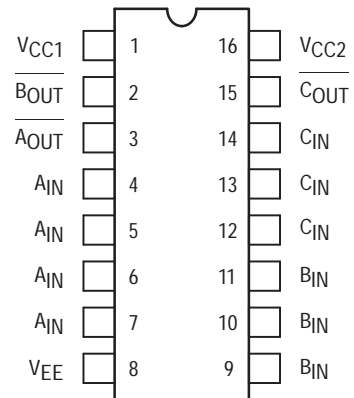


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
 For PLCC pin assignment, see the Pin Conversion
 Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits						Unit	
			-30°C		+25°C		+85°C			
			Min	Max	Min	Typ	Max	Min		Max
Power Supply Drain Current	I _E	8		23		17	21		23	mAdc
Input Current	I _{inH}	4		425			265		265	μAdc
	I _{inL}	4	0.5		0.5			0.3		μAdc
Output Voltage Logic 1	V _{OH}	3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
Output Voltage Logic 0	V _{OL}	3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
Threshold Voltage Logic 1	V _{OHA}	3	-1.080		-0.980			-0.910		Vdc
		2	-1.080		-0.980			-0.910		Vdc
Threshold Voltage Logic 0	V _{OLA}	3		-1.655			-1.630		-1.595	Vdc
		2		-1.655			-1.630		-1.595	Vdc
Switching Times (50Ω Load)										ns
Propagation Delay	t ₄₊₃₋	3	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
	t ₄₋₃₊	3	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
Rise Time (20 to 80%)	t ₃₊	3	1.1	3.6	1.1	2.0	3.3	1.1	3.7	
Fall Time (20 to 80%)	t ₃₋	3	1.1	3.6	1.1	2.0	3.3	1.1	3.7	

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)						
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
@ Test Temperature			-30°C	-0.890	-1.890	-1.205	-1.500	-5.2	
			+25°C	-0.810	-1.850	-1.105	-1.475	-5.2	
			+85°C	-0.700	-1.825	-1.035	-1.440	-5.2	
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					(V _{CC}) Gnd	
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
Power Supply Drain Current	I _E	8					8	1, 16	
Input Current	I _{inH}	4	4				8	1, 16	
	I _{inL}	4		4			8	1, 16	
Output Voltage Logic 1	V _{OH}	3					8	1, 16	
		2					8	1, 16	
Output Voltage Logic 0	V _{OL}	3	4				8	1, 16	
		2	9				8	1, 16	
Threshold Voltage Logic 1	V _{OHA}	3				4	8	1, 16	
		2				9	8	1, 16	
Threshold Voltage Logic 0	V _{OLA}	3			4		8	1, 16	
		2			9		8	1, 16	
Switching Times (50Ω Load)						Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	t ₄₊₃₋	3				4	3	8	1, 16
	t ₄₋₃₊	3				4	3	8	1, 16
Rise Time (20 to 80%)	t ₃₊	3				4	3	8	1, 16
Fall Time (20 to 80%)	t ₃₋	3				4	3	8	1, 16

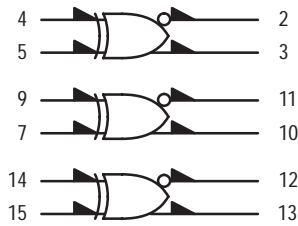
Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Triple 2-Input Exclusive OR/ Exclusive NOR Gate

The MC10107 is a triple-2 input exclusive OR/NOR gate.

$P_D = 40 \text{ mW typ/gate (No Load)}$
 $t_{pd} = 2.8 \text{ ns typ}$
 $t_r, t_f = 2.5 \text{ ns typ (20\%–80\%)}$

LOGIC DIAGRAM

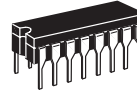


$$3 = (4 \cdot \bar{5}) + (\bar{4} \cdot 5)$$

$$2 = (4 \cdot 5) + (4 \cdot \bar{5})$$

$V_{CC1} = \text{PIN 1}$
 $V_{CC2} = \text{PIN 16}$
 $V_{EE} = \text{PIN 8}$

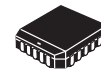
MC10107



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

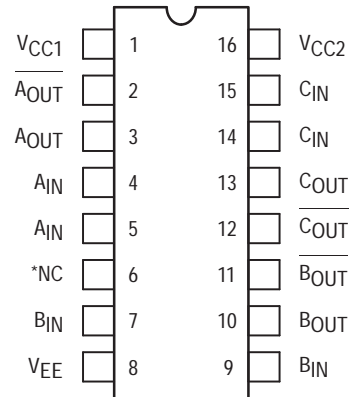


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



***NC = No Connection**

Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit																				
			-30°C		+25°C			+85°C																						
			Min	Max	Min	Typ	Max	Min	Max																					
Power Supply Drain Current	I _E	8		31			28		31	mAdc																				
Input Current	I _{inH}	4, 9, 14 5, 7, 15		425 350			265 220		265 220	μAdc																				
	I _{inL}	*	0.5		0.5			0.3		μAdc																				
Output Voltage Logic 1	V _{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc																				
		2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700																					
		3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700																					
		3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700																					
Output Voltage Logic 0	V _{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc																				
		2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615																					
		3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615																					
		3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615																					
Threshold Voltage Logic 1	V _{OHA}	2	-1.080		-0.980			-0.910		Vdc																				
		2	-1.080		-0.980			-0.910																						
		3	-1.080		-0.980			-0.910																						
		3	-1.080		-0.980			-0.910																						
Threshold Voltage Logic 0	V _{OLA}	2		-1.655			-1.630		-1.595	Vdc																				
		2		-1.655			-1.630		-1.595																					
		3		-1.655			-1.630		-1.595																					
		3		-1.655			-1.630		-1.595																					
Switching Times (50Ω Load)					Min	Typ	Max			ns																				
Propagation Delay	t ₊₊ t _{+ -} t _{- +} t ₋₋	Inputs 4,9 or 14 to either Output	-1.1 1.1 1.1 1.1	3.8 3.8 3.8 3.8	1.1 1.1 1.1 1.1	2.0 2.0 2.0 2.0	3.7 3.7 3.7 3.7	1.1 1.1 1.1 1.1	4.0 4.0 4.0 4.0																					
											t ₊₊ t _{+ -} t _{- +} t ₋₋	Inputs 5,7 or 15 to either Output	1.1 1.1 1.1 1.1	3.8 3.8 3.8 3.8	1.1 1.1 1.1 1.1	2.8 2.8 2.8 2.8	3.7 3.7 3.7 3.7	1.1 1.1 1.1 1.1	4.0 4.0 4.0 4.0											
																				t ₊	**	1.1	3.5	1.1	2.5	3.5	1.1	3.8		
																													t ₋	**
	Rise Time (20 to 80%)	t ₊	**	1.1	3.5	1.1	2.5	3.5	1.1																					
											Fall Time (20 to 80%)	t ₋	**	1.1	3.5	1.1	2.5	3.5	1.1											

* Individually test each input applying V_{IH} or V_{IL} to input under test.

** Any Output.

ELECTRICAL CHARACTERISTICS (continued)

@ Test Temperature			TEST VOLTAGE VALUES (Volts)					V_{CC} Gnd
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}	
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2	
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2	
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2	
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}	
Power Supply Drain Current	I_E	8	5, 7, 15				8	1, 16
Input Current	I_{inH}	4, 9, 14	*				8	1, 16
		5, 7, 15	*				8	1, 16
Output Voltage	Logic 1	V_{OH}	2	4, 5			8	1, 16
			2				8	1, 16
Output Voltage	Logic 0	V_{OL}	3	4			8	1, 16
			3	5			8	1, 16
Threshold Voltage	Logic 1	V_{OHA}	2	5	4		8	1, 16
			2			4	8	1, 16
			3		4		8	1, 16
			3		5		8	1, 16
Threshold Voltage	Logic 0	V_{OLA}	2		4		8	1, 16
			2		5		8	1, 16
			3	5	4		8	1, 16
			3			4	8	1, 16
Switching Times (50Ω Load)			+1.1V		Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	t ₊₊	Inputs	5, 7, 15		Input	Corresponding XOR/XNOR Outputs	8	1, 16
			4, 9 or 14	5, 7, 15			Input 4, 9 or 14	8
	t ₋₊	to either	5, 7, 15		Input	Corresponding XOR/XNOR Outputs	8	1, 16
			Output	5, 7, 15			5, 7 or 15	8
	t ₋₋	Output	4, 9, 14		Any Input	Corresponding XOR/XNOR Outputs	8	1, 16
			4, 9, 14	4, 9, 14			Any Input	8
Rise Time (20 to 80%)	t ₊	**	4, 9, 14		Any Input	Corresponding XOR/XNOR Outputs	8	1, 16
Fall Time (20 to 80%)	t ₋	**	4, 9, 14		Any Input	Corresponding XOR/XNOR Outputs	8	1, 16

* Individually test each input applying V_{IH} or V_{IL} to input under test.

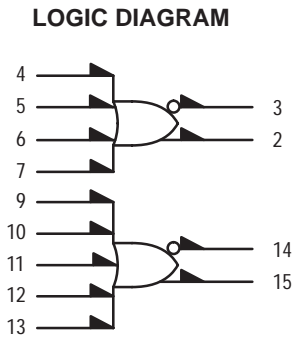
** Any Output.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Dual 4-5-Input OR/NOR Gate

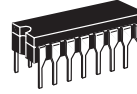
The MC10109 is a dual 4-5 input OR/NOR gate.

$P_D = 30 \text{ mW typ/gate (No Load)}$
 $t_{pd} = 2.0 \text{ ns typ}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$



$V_{CC1} = \text{PIN 1}$
 $V_{CC2} = \text{PIN 16}$
 $V_{EE} = \text{PIN 8}$

MC10109



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

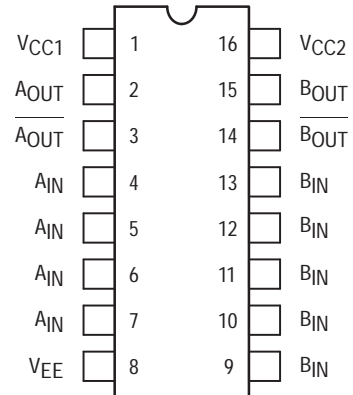


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
 For PLCC pin assignment, see the Pin Conversion
 Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I _E	8		15		11	14		15	mAdc
Input Current	I _{inH}	4		425			265		265	μAdc
	I _{inL}	4	0.5		0.5			0.3		μAdc
Output Voltage Logic 1	V _{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Output Voltage Logic 0	V _{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V _{OHA}	2	-1.080		-0.980			-0.910		Vdc
		3	-1.080		-0.980			-0.910		
Threshold Voltage Logic 0	V _{OLA}	2		-1.655			-1.630		-1.595	Vdc
		3		-1.655			-1.630		-1.595	
Switching Times (50Ω Load)										ns
Propagation Delay	t ₄₊₂₊	2	1.0	3.7	1.0	2.0	2.9	1.0	3.7	
	t ₄₋₂₋	2	1.0	3.7	1.0	2.0	2.9	1.0	3.7	
	t ₄₊₃₋	3	1.0	3.7	1.0	2.0	2.9	1.0	3.7	
	t ₄₋₃₊	3	1.0	3.7	1.0	2.0	2.9	1.0	3.7	
Rise Time (20 to 80%)	t ₂₊	2	1.1	4.0	1.1	2.0	3.3	1.1	4.0	
	t ₃₊	3	1.1	4.0	1.1	2.0	3.3	1.1	4.0	
Fall Time (20 to 80%)	t ₂₋	2	1.1	4.0	1.1	2.0	3.3	1.1	4.0	
	t ₃₋	3	1.1	4.0	1.1	2.0	3.3	1.1	4.0	

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd	
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
Power Supply Drain Current	I _E	8					8	1, 16	
Input Current	I _{inH}	4	4				8	1, 16	
	I _{inL}	4		4			8	1, 16	
Output Voltage	Logic 1	V _{OH}	2	4			8	1, 16	
			3				8	1, 16	
Output Voltage	Logic 0	V _{OL}	2				8	1, 16	
			3	4			8	1, 16	
Threshold Voltage	Logic 1	V _{OHA}	2		4		8	1, 16	
			3			4	8	1, 16	
Threshold Voltage	Logic 0	V _{OLA}	2			4	8	1, 16	
			3		4		8	1, 16	
Switching Times	(50Ω Load)					Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	t ₄₊₂₊	2				4	2	8	1, 16
	t ₄₋₂₋	2				4	2	8	1, 16
	t ₄₊₃₋	3				4	3	8	1, 16
	t ₄₋₃₊	3				4	3	8	1, 16
Rise Time	(20 to 80%)	t ₂₊	2			4	2	8	1, 16
		t ₃₊	3			4	3	8	1, 16
Fall Time	(20 to 80%)	t ₂₋	2			4	2	8	1, 16
		t ₃₋	3			4	3	8	1, 16

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

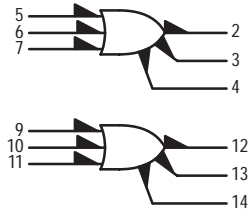
Dual 3-Input/3-Output OR Gate

The MC10110 is designed to drive up to three transmission lines simultaneously. The multiple outputs of this device also allow the wire "OR"-ing of several levels of gating for minimization of gate and package count.

The ability to control three parallel lines from a single point makes the MC10110 particularly useful in clock distribution applications where minimum clock skew is desired. Three V_{CC} pins are provided and each one should be used.

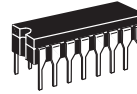
$P_D = 80 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 2.4 \text{ ns typ (All Outputs Loaded)}$
 $t_r, t_f = 2.2 \text{ ns typ (20\%–80\%)}$

LOGIC DIAGRAM

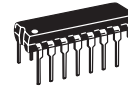


V_{CC1} = PIN 1, 15
 V_{CC2} = PIN 16
 V_{EE} = PIN 8

MC10110

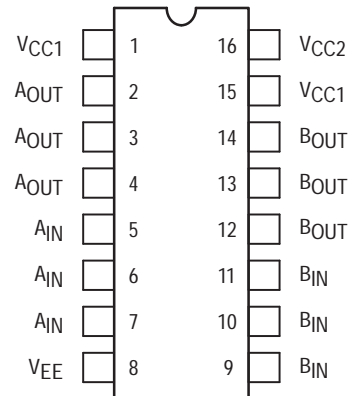


L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
 For PLCC pin assignment, see the Pin Conversion
 Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit	
			-30°C		+25°C			+85°C			
			Min	Max	Min	Typ	Max	Min	Max		
Power Supply Drain Current	I_E	8		42		30	38		42	mA _{dc}	
Input Current	I_{inH}	5, 6, 7		680			425		425	μA _{dc}	
	I_{inL}	5, 6, 7	0.5		0.5			0.3		μA _{dc}	
Output Voltage Logic 1	V_{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	V _{dc}	
		3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700		
		4	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700		
Output Voltage Logic 0	V_{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	V _{dc}	
		3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615		
		4	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615		
Threshold Voltage Logic 1	V_{OHA}	2	-1.080		-0.980			-0.910		V _{dc}	
		3	-1.080		-0.980			-0.910			
		4	-1.080		-0.980			-0.910			
Threshold Voltage Logic 0	V_{OLA}	2		-1.655			-1.630		-1.595	V _{dc}	
		3		-1.655			-1.630		-1.595		
		4		-1.655			-1.630		-1.595		
Switching Times (50Ω Load)									ns		
Propagation Delay	t_{5+2+}	2	1.4	3.5	1.4	2.4	3.5	1.5	3.8		
		t_{5-2-}	2	1.4	3.5	1.4	2.4	3.5	1.5		3.8
		t_{5+3+}	3	1.4	3.5	1.4	2.4	3.5	1.5		3.8
		t_{5-3-}	3	1.4	3.5	1.4	2.4	3.5	1.5		3.8
		t_{5+4+}	4	1.4	3.5	1.4	2.4	3.5	1.5		3.8
		t_{5-4-}	4	1.4	3.5	1.4	2.4	3.5	1.5		3.8
Rise Time (20 to 80%)	t_{2+}	2	1.0	3.5	1.1	2.2	3.5	1.2	3.8		
		t_{3+}	3	1.0	3.5	1.1	2.2	3.5	1.2		3.8
		t_{4+}	4	1.0	3.5	1.1	2.2	3.5	1.2		3.8
Fall Time (20 to 80%)	t_{2-}	2	1.0	3.5	1.1	2.2	3.5	1.2	3.8		
		t_{3-}	3	1.0	3.5	1.1	2.2	3.5	1.2		3.8
		t_{4-}	4	1.0	3.5	1.1	2.2	3.5	1.2		3.8

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd	
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
Power Supply Drain Current	I _E	8					8	1, 15, 16	
Input Current	I _{inH}	5, 6, 7	*				8	1, 15, 16	
	I _{inL}	5, 6, 7		*			8	1, 15, 16	
Output Voltage Logic 1	V _{OH}	2	5				8	1, 15, 16	
		3	6				8	1, 15, 16	
		4	7				8	1, 15, 16	
Output Voltage Logic 0	V _{OL}	2					8	1, 15, 16	
		3					8	1, 15, 16	
		4					8	1, 15, 16	
Threshold Voltage Logic 1	V _{OHA}	2			5		8	1, 15, 16	
		3			6		8	1, 15, 16	
		4			7		8	1, 15, 16	
Threshold Voltage Logic 0	V _{OLA}	2				5	8	1, 15, 16	
		3				6	8	1, 15, 16	
		4				7	8	1, 15, 16	
Switching Times (50Ω Load)					Pulse In	Pulse Out	-3.2 V	+2.0 V	
Propagation Delay	t ₅₊₂₊	2				5	2	8	1, 15, 16
	t ₅₋₂₋	2				5	2	8	1, 15, 16
	t ₅₊₃₊	3				5	3	8	1, 15, 16
	t ₅₋₃₋	3				5	3	8	1, 15, 16
	t ₅₊₄₊	4				5	4	8	1, 15, 16
	t ₅₋₄₋	4				5	4	8	1, 15, 16
Rise Time (20 to 80%)	t ₂₊	2				5	2	8	1, 15, 16
	t ₃₊	3				5	3	8	1, 15, 16
	t ₄₊	4				5	4	8	1, 15, 16
Fall Time (20 to 80%)	t ₂₋	2				5	2	8	1, 15, 16
	t ₃₋	3				5	3	8	1, 15, 16
	t ₄₋	4				5	4	8	1, 15, 16

* Individually test each input using the pin connections shown.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

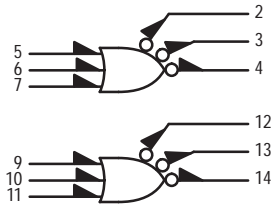
Dual 3-Input/3-Output NOR Gate

The MC10111 is designed to drive up to three transmission lines simultaneously. The multiple outputs of this device also allow the wire "OR"-ing of several levels of gating for minimization of gate and package count.

The ability to control three parallel lines from a single point makes the MC10111 particularly useful in clock distribution applications where minimum clock skew is desired. Three V_{CC} pins are provided and each one should be used.

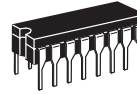
$P_D = 80 \text{ mW typ/gate (No Load)}$
 $t_{pd} = 2.4 \text{ ns typ (All Outputs Loaded)}$
 $t_r, t_f = 2.2 \text{ ns typ (20\%–80\%)}$

LOGIC DIAGRAM

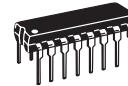


V_{CC1} = PIN 1,15
 V_{CC2} = PIN 16
 V_{EE} = PIN 8

MC10111

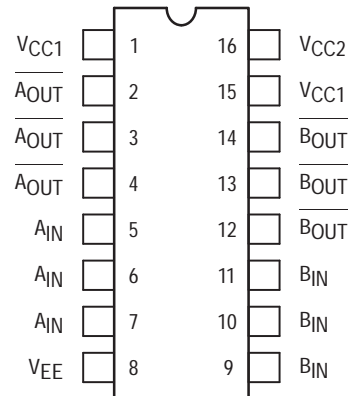


L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
 For PLCC pin assignment, see the Pin Conversion
 Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit	
			-30°C		+25°C			+85°C			
			Min	Max	Min	Typ	Max	Min	Max		
Power Supply Drain Current	I_E	8		42		30	38		42	mAdc	
Input Current	I_{inH}	5, 6, 7		680			425		425	μ Adc	
	I_{inL}	5, 6, 7	0.5		0.5			0.3		μ Adc	
Output Voltage Logic 1	V_{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc	
		3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700		
		4	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700		
Output Voltage Logic 0	V_{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc	
		3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615		
		4	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615		
Threshold Voltage Logic 1	V_{OHA}	2	-1.080		-0.980			-0.910		Vdc	
		3	-1.080		-0.980			-0.910			
		4	-1.080		-0.980			-0.910			
Threshold Voltage Logic 0	V_{OLA}	2		-1.655			-1.630		-1.595	Vdc	
		3		-1.655			-1.630		-1.595		
		4		-1.655			-1.630		-1.595		
Switching Times (50 Ω Load)										ns	
Propagation Delay	t_{5+2-}	2	1.4	3.5	1.4	2.4	3.5	1.5	3.8		
		t_{5-2+}	2	1.4	3.5	1.4	2.4	3.5	1.5		3.8
		t_{5+3-}	3	1.4	3.5	1.4	2.4	3.5	1.5		3.8
		t_{5-3+}	3	1.4	3.5	1.4	2.4	3.5	1.5		3.8
		t_{5+4-}	4	1.4	3.5	1.4	2.4	3.5	1.5		3.8
		t_{5-4+}	4	1.4	3.5	1.4	2.4	3.5	1.5		3.8
Rise Time (20 to 80%)	t_{2+}	2	1.0	3.5	1.1	2.2	3.5	1.2	3.8		
		t_{3+}	3	1.0	3.5	1.1	2.2	3.5	1.2		3.8
		t_{4+}	4	1.0	3.5	1.1	2.2	3.5	1.2		3.8
Fall Time (20 to 80%)	t_{2-}	2	1.0	3.5	1.1	2.2	3.5	1.2	3.8		
		t_{3-}	3	1.0	3.5	1.1	2.2	3.5	1.2		3.8
		t_{4-}	4	1.0	3.5	1.1	2.2	3.5	1.2		3.8

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)						
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					(V_{CC}) Gnd	
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}		
Power Supply Drain Current	I_E	8					8	1, 15, 16	
Input Current	I_{inH}	5, 6, 7	*				8	1, 15, 16	
	I_{inL}	5, 6, 7		*			8	1, 15, 16	
Output Voltage Logic 1	V_{OH}	2					8	1, 15, 16	
		3					8	1, 15, 16	
		4					8	1, 15, 16	
Output Voltage Logic 0	V_{OL}	2	5				8	1, 15, 16	
		3	6				8	1, 15, 16	
		4	7				8	1, 15, 16	
Threshold Voltage Logic 1	V_{OHA}	2				5	8	1, 15, 16	
		3				6	8	1, 15, 16	
		4				7	8	1, 15, 16	
Threshold Voltage Logic 0	V_{OLA}	2			5		8	1, 15, 16	
		3			6		8	1, 15, 16	
		4			7		8	1, 15, 16	
Switching Times (50Ω Load)						Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	t_{5+2-}	2				5	2	8	1, 15, 16
	t_{5-2+}	2				5	2	8	1, 15, 16
	t_{5+3-}	3				5	3	8	1, 15, 16
	t_{5-3+}	3				5	3	8	1, 15, 16
	t_{5+4-}	4				5	4	8	1, 15, 16
	t_{5-4+}	4				5	4	8	1, 15, 16
Rise Time (20 to 80%)	t_{2+}	2				5	2	8	1, 15, 16
	t_{3+}	3				5	3	8	1, 15, 16
	t_{4+}	4				5	4	8	1, 15, 16
Fall Time (20 to 80%)	t_{2-}	2				5	2	8	1, 15, 16
	t_{3-}	3				5	3	8	1, 15, 16
	t_{4-}	4				5	4	8	1, 15, 16

* Individually test each input using the pin connections shown.

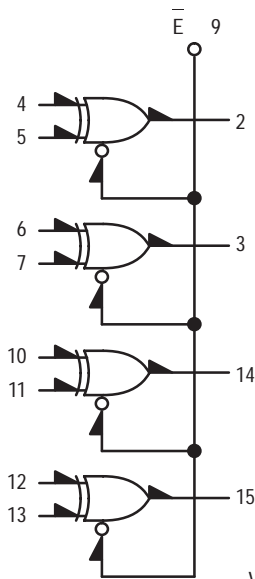
Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Quad Exclusive OR Gate

The MC10113 is a quad Exclusive OR gate, with an enable common to all four gates. The outputs may be wire-ORed together to perform a 4-bit comparison function ($A = B$). The enable is active low.

$P_D = 175 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 2.5 \text{ ns typ}$
 $t_r, t_f = 2.0 \text{ ns typ (20\% to 80\%)}$

LOGIC DIAGRAM

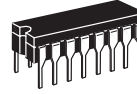


$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

TRUTH TABLE

IN		\bar{E}	OUTPUT
L	L	L	L
L	H	L	H
H	L	L	H
H	H	L	L
X	X	H	L

MC10113



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

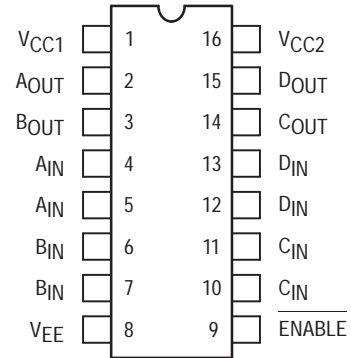


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I _E	8		46			42		46	mAdc
Input Current	I _{inH}	4,7,10,13 5,6,11,12 9		425 350 870			265 220 545		265 220 545	μAdc
	I _{inL}	*	0.5		0.5			0.3		μAdc
Output Voltage Logic 1	V _{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
		14	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
		15	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Output Voltage Logic 0	V _{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
		14	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
		15	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V _{OHA}	2	-1.080		-0.980			-0.910		Vdc
		3	-1.080		-0.980			-0.910		
		14	-1.080		-0.980			-0.910		
		15	-1.080		-0.980			-0.910		
Threshold Voltage Logic 0	V _{OLA}	2		-1.655			-1.630		-1.595	Vdc
		3		-1.655			-1.630		-1.595	
		14		-1.655			-1.630		-1.595	
		15		-1.655			-1.630		-1.595	
Switching Times (50Ω Load)					Min	Typ	Max			ns
Propagation Delay	t ₄₊₂₊	2	1.1	4.7	1.3	2.6	4.5	1.3	5.0	
	t ₄₋₂₋	2	1.1	4.7	1.3	2.6	4.5	1.3	5.0	
	t ₉₊₂₋	2	1.3	5.2	1.5	3.4	5.0	1.5	5.5	
	t ₉₋₂₊	2	1.3	5.2	1.5	3.4	5.0	1.5	5.5	
Rise Time (20 to 80%)	t ₂₊	2	1.1	4.2	1.1	2.5	3.9	1.1	4.4	
Fall Time (20 to 80%)	t ₂₋	2	1.1	4.2	1.1	2.5	3.9	1.1	4.4	

* Individually test each input applying V_{IH} or V_{IL} to input under test.

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
@ Test Temperature								
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2	
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2	
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2	
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
Power Supply Drain Current	I _E	8					8	1, 16
Input Current	I _{inH}	4,7,10,13	*				8	1, 16
		5,6,11,12	*				8	1, 16
		9	9				8	1, 16
	I _{inL}	*		*			8	1, 16
Output Voltage Logic 1	V _{OH}	2	4				8	1, 16
		3	7				8	1, 16
		14	11				8	1, 16
		15	13				8	1, 16
Output Voltage Logic 0	V _{OL}	2		4			8	1, 16
		3		7			8	1, 16
		14		11			8	1, 16
		15		13			8	1, 16
Threshold Voltage Logic 1	V _{OHA}	2			4		8	1, 16
		3			6		8	1, 16
		14			10		8	1, 16
		15			12		8	1, 16
Threshold Voltage Logic 0	V _{OLA}	2				5	8	1, 16
		3				7	8	1, 16
		14				11	8	1, 16
		15				13	8	1, 16
Switching Times (50Ω Load)			+1.11V		Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	t ₄₊₂₊ t ₄₋₂₋ t ₉₊₂₋ t ₉₋₂₊	2			4	2	8	1, 16
		2			4	2	8	1, 16
		2	4		9	2	8	1, 16
		2	4		9	2	8	1, 16
Rise Time (20 to 80%)	t ₂₊	2			4	2	8	1, 16
Fall Time (20 to 80%)	t ₂₋	2			4	2	8	1, 16

* Individually test each input applying V_{IH} or V_{IL} to input under test.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Triple Line Receiver

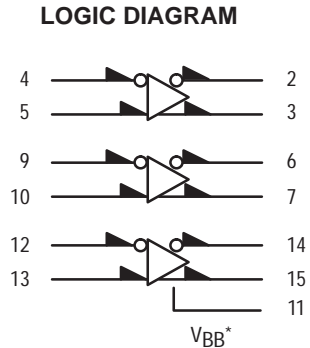
The MC10114 is a triple line receiver designed for use in sensing differential signals over long lines. An active current source and translated emitter follower inputs provide the line receiver with a common mode noise rejection limit of one volt in either the positive or the negative direction. This allows a large amount of common mode noise immunity for extra long lines.

Another feature of the MC10114 is that the OR outputs go to a logic low level whenever the inputs are left floating. The outputs are each capable of driving 50 ohm transmission lines.

This device is useful in high speed central processors, minicomputers, peripheral controllers, digital communication systems, testing and instrumentation systems. The MC10114 can also be used for MOS to MECL interfacing and it is ideal as a sense amplifier for MOS RAM's.

A V_{BB} reference is provided which is useful in making the MC10114 a Schmit trigger, allowing single-ended driving of the inputs, or other applications where a stable reference voltage is necessary. See MECL Design Handbook (HB205) pages 226 and 228.

$P_D = 145 \text{ mW typ/pkg}$
 $t_{pd} = 2.4 \text{ ns typ (Single Ended Input)}$
 $t_{pd} = 2.0 \text{ ns typ (Differential Input)}$
 $t_r, t_f = 2.1 \text{ ns typ (20\% to 80\%)}$

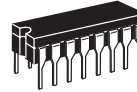


$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

* V_{BB} to be used to supply bias to the MC10114 only and bypassed (when used) with 0.01 μF to 0.1 μF capacitor to ground (0 V). V_{BB} can source < 1.0 mA.

When the input pin with the bubble goes positive, its respective output pin with bubble goes positive.

MC10114



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

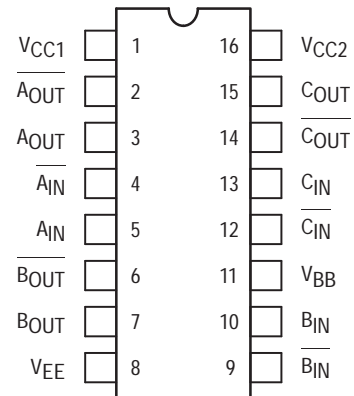


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I _E	8		39		28	35		39	mAdc
Input Current	I _{inH}	4		70			45		45	μAdc
	I _{CBO}	4		1.5			1.0		1.0	μAdc
Output Voltage Logic 1	V _{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Output Voltage Logic 0	V _{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V _{OHA}	2	-1.080		-0.980			-0.910		Vdc
		3	-1.080		-0.980			-0.910		
Threshold Voltage Logic 0	V _{OLA}	2		-1.655			-1.630		-1.595	Vdc
		3		-1.655			-1.630		-1.595	
Reference Voltage	V _{BB}	11	-1.420	-1.280	-1.350		-1.230	-1.295	-1.150	Vdc
Common Mode Rejection Test	V _{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
	V _{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Switching Times (50Ω Load)			Min	Max	Min	Typ	Max	Min	Max	ns
Propagation Delay	t ₄₊₂₊	2	1.0	4.4	1.0	2.4	4.0	0.9	4.3	
	t ₄₋₂₋	2	1.0	4.4	1.0	2.4	4.0	0.9	4.3	
	t ₄₊₃₋	3	1.0	4.4	1.0	2.4	4.0	0.9	4.3	
	t ₄₋₃₊	3	1.0	4.4	1.0	2.4	4.0	0.9	4.3	
Rise Time (20 to 80%)	t ₂₊	2	1.5	3.8	1.5	2.1	3.5	1.5	3.7	
	t ₃₊	3	1.5	3.8	1.5	2.1	3.5	1.5	3.7	
Fall Time (20 to 80%)	t ₂₋	2	1.5	3.8	1.5	2.1	3.5	1.5	3.7	
	t ₃₋	3	1.5	3.8	1.5	2.1	3.5	1.5	3.7	

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					From Pin 11	Unit
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{BB}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500			
+25°C			-0.810	-1.850	-1.105	-1.475			
+85°C			-0.700	-1.825	-1.035	-1.440			
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					Unit	
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{BB}		
Power Supply Drain Current	I _E	8		4, 9, 12			5, 10, 13	mAdc	
Input Current	I _{inH}	4	4	9, 12			5, 10, 13	μAdc	
	I _{inL}	4		9, 12			5, 10, 13	μAdc	
Output Voltage	Logic 1	V _{OH}	2	4	9, 12			5, 10, 13	Vdc
			3	9, 12	4			5, 10, 13	
Output Voltage	Logic 0	V _{OL}	2	9, 12	4			5, 10, 13	Vdc
			3	4	9, 12			5, 10, 13	
Threshold Voltage	Logic 1	V _{OHA}	2	9, 12	9, 12	4		5, 10, 13	Vdc
			3	9, 12		4	4	5, 10, 13	
Threshold Voltage	Logic 0	V _{OLA}	2	9, 12	9, 12	4		5, 10, 13	Vdc
			3	9, 12	4	4	5, 10, 13		
Reference Voltage	V _{BB}	11					5, 10, 13	Vdc	
Common Mode Rejection Test	V _{OH}	2						Vdc	
		3						Vdc	
Switching Times	(50Ω Load)					Pulse In	Pulse Out	ns	
Propagation Delay						4	2	5, 10, 13	
						4	2	5, 10, 13	
						4	3	5, 10, 13	
						4	3	5, 10, 13	
Rise Time	(20 to 80%)					4	2	5, 10, 13	
						4	3	5, 10, 13	
Fall Time	(20 to 80%)					4	2	5, 10, 13	
						4	3	5, 10, 13	

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd
			V _{IHH} *	V _{ILH} *	V _{IHL} *	V _{ILL} *	V _{EE}	
@ Test Temperature								
-30°C			+0.110	-0.890	-1.890	-2.890	-5.2	
+25°C			+0.190	-0.850	-1.810	-2.850	-5.2	
+85°C			+0.300	-0.825	-1.700	-2.825	-5.2	
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					
			V _{IHH} *	V _{ILH} *	V _{IHL} *	V _{ILL} *	V _{EE}	
Power Supply Drain Current	I _E	8					8	1, 16
Input Current	I _{inH}	4					8	1, 16
	I _{inL}	4					8, 4	1, 16
Output Voltage	Logic 1	V _{OH}	2	3			8	1, 16
								8
Output Voltage	Logic 0	V _{OL}	2	3			8	1, 16
								8
Threshold Voltage	Logic 1	V _{OHA}	2	3			8	1, 16
								8
Threshold Voltage	Logic 0	V _{OLA}	2	3			8	1, 16
								8
Reference Voltage	V _{BB}	11					8	1, 16
Common Mode Rejection Test	V _{OH}	2	4	5	5	4	8	1, 16
		3					8	1, 16
	V _{OL}	2	4	5	5	4	8	1, 16
		3					8	1, 16
Switching Times (50Ω Load)							-3.2 V	+2.0 V
Propagation Delay	t ₄₊₂₊ t ₄₋₂₋ t ₄₊₃₋ t ₄₋₃₊	2					8	1, 16
		2					8	1, 16
		3					8	1, 16
		3					8	1, 16
Rise Time (20 to 80%)	t ₂₊ t ₃₊	2					8	1, 16
		3					8	1, 16
Fall Time (20 to 80%)	t ₂₋ t ₃₋	2					8	1, 16
		3					8	1, 16

* V_{IHH} = Input Logic 1 level shifted positive one volt for common mode rejection tests
 V_{ILH} = Input Logic 0 level shifted positive one volt for common mode rejection tests
 V_{IHL} = Input Logic 1 level shifted negative one volt for common mode rejection tests
 V_{ILL} = Input Logic 0 level shifted negative one volt for common mode rejection tests

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

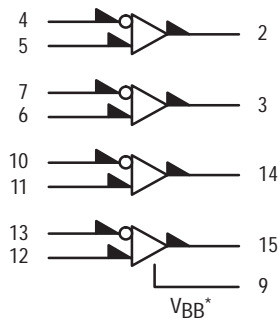
Quad Line Receiver

The MC10115 is a quad differential amplifier designed for use in sensing differential signals over long lines. The base bias supply (V_{BB}) is made available at pin 9 to make the device useful as a Schmitt trigger, or in other applications where a stable reference voltage is necessary.

Active current sources provide the MC10115 with excellent common mode noise rejection. If any amplifier in a package is not used, one input of that amplifier must be connected to V_{BB} (pin 9) to prevent upsetting the current source bias network.

$P_D = 110 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 2.0 \text{ ns typ}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

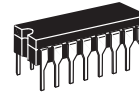
LOGIC DIAGRAM



$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

* V_{BB} to be used to supply bias to the MC10115 only and bypassed (when used) with $0.01 \mu\text{F}$ to $0.1 \mu\text{F}$ capacitor to ground (0 V). V_{BB} can source $< 1.0 \text{ mA}$.
 When the input pin with the bubble goes positive, the output goes negative.

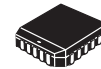
MC10115



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

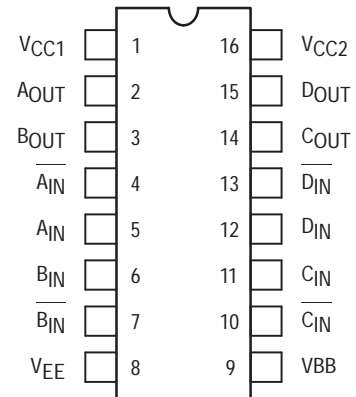


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
 For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits						Unit	
			-30°C		+25°C		+85°C			
			Min	Max	Min	Typ	Max	Min		Max
Power Supply Drain Current	I _E	8		29			26		29	mAdc
Input Current	I _{inH}	4		150			95		95	μAdc
	I _{CBO}	4		1.5			1.0		1.0	μAdc
Output Voltage Logic 1	V _{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
Output Voltage Logic 0	V _{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
Threshold Voltage Logic 1	V _{OHA}	2	-1.080		-0.980			-0.910		Vdc
Threshold Voltage Logic 0	V _{OLA}	2		-1.655			-1.630		-1.595	Vdc
Reference Voltage	V _{BB}	9	1.420	1.280	-1.350		-1.230	1.295	-1.150	Vdc
Switching Times (50Ω Load)										ns
Propagation Delay	t ₄₋₂₊	2	1.0	3.1	1.0		2.9	1.0	3.3	
	t ₄₊₂₋	2	1.0	3.1	1.0		2.9	1.0	3.3	
Rise Time (20 to 80%)	t ₂₊	2	1.1	3.6	1.1		3.3	1.1	3.7	
Fall Time (20 to 80%)	t ₂₋	2	1.1	3.6	1.1		3.3	1.1	3.7	

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)						
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{BB}	V _{VEE}	
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	From Pin 9	-5.2	
+25°C			-0.810	-1.850	-1.105	-1.475		-5.2	
+85°C			-0.700	-1.825	-1.035	-1.440		-5.2	
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						(V _{CC}) Gnd
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{BB}	V _{VEE}	
Power Supply Drain Current	I _E	8		4,7,10,13			5,6,11,12	8	1, 16
Input Current	I _{inH}	4	4	7,10,13			5,6,11,12	8	1, 16
	I _{CBO}	4		7,10,13			5,6,11,12	8,4	1, 16
Output Voltage Logic 1	V _{OH}	2	7,10,13	4			5,6,11,12	8	1, 16
Output Voltage Logic 0	V _{OL}	2	4	7,10,13			5,6,11,12	8	1, 16
Threshold Voltage Logic 1	V _{OHA}	2		7,10,13		4	5,6,11,12	8	1, 16
Threshold Voltage Logic 0	V _{OLA}	2		7,10,13	4		5,6,11,12	8	1, 16
Reference Voltage	V _{BB}	9					5,6,11,12	8	1, 16
Switching Times (50Ω Load)				Pulse In	Pulse Out			-3.2 V	+2.0 V
Propagation Delay	t ₄₋₂₊	2		4	2		5,6,11,12	8	1, 16
	t ₄₊₂₋	2		4	2		5,6,11,12	8	1, 16
Rise Time (20 to 80%)	t ₂₊	2		4	2		5,6,11,12	8	1, 16
Fall Time (20 to 80%)	t ₂₋	2		4	2		5,6,11,12	8	1, 16

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

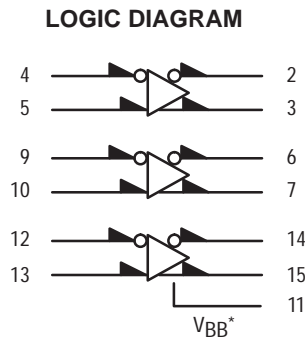
Triple Line Receiver

The MC10116 is a triple differential amplifier designed for use in sensing differential signals over long lines. The base bias supply (V_{BB}) is made available at pin 11 to make the device useful as a Schmitt trigger, or in other applications where a stable reference voltage is necessary.

Active current sources provide the MC10116 with excellent common mode noise rejection. If any amplifier in a package is not used, one input of that amplifier must be connected to V_{BB} (pin 11) to prevent upsetting the current source bias network.

Complementary outputs are provided to allow driving twisted pair lines, to enable cascading of several amplifiers in a chain, or simply to provide complement outputs of the input logic function.

$P_D = 85 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 2.0 \text{ ns typ}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

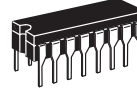


$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

* V_{BB} to be used to supply bias to the MC10116 only and bypassed (when used) with 0.01 μF to 0.1 μF capacitor to ground (0 V). V_{BB} can source < 1.0 mA.

When the input pin with the bubble goes positive, the output pin with the bubble goes positive.

MC10116



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

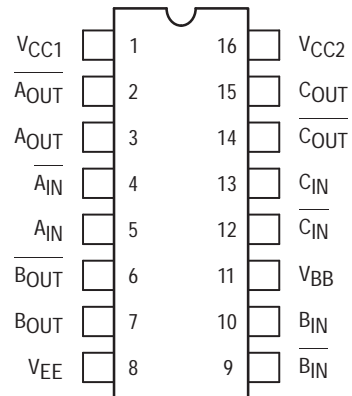


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I_E	8		23		17	21		23	mAdc
Input Current	I_{inH}	4		150			95		95	μ Adc
	I_{CBO}	4		1.5			1.0		1.0	μ Adc
Output Voltage Logic 1	V_{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Output Voltage Logic 0	V_{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V_{OHA}	2	-1.080		-0.980			-0.910		Vdc
		3	-1.080		-0.980			-0.910		
Threshold Voltage Logic 0	V_{OLA}	2		-1.655			-1.630		-1.595	Vdc
		3		-1.655			-1.630		-1.595	
Reference Voltage	V_{BB}	11	-1.420	-1.280	-1.350		-1.230	-1.295	-1.150	Vdc
Switching Times (50 Ω Load)										ns
Propagation Delay	t_{4+2+}	2	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
		2	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
		3	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
		3	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
Rise Time (20 to 80%)	t_{2+}	2	1.1	3.6	1.1	2.0	3.3	1.1	3.7	
		3	1.1	3.6	1.1	2.0	3.3	1.1	3.7	
Fall Time (20 to 80%)	t_{3-}	2	1.1	3.6	1.1	2.0	3.3	1.1	3.7	
		3	1.1	3.6	1.1	2.0	3.3	1.1	3.7	

ELECTRICAL CHARACTERISTICS (continued)

@ Test Temperature			TEST VOLTAGE VALUES (Volts)						(V _{CC}) Gnd		
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{BB}	V _{VEE}			
			-30°C	-0.890	-1.890	-1.205	-1.500	From Pin 11			-5.2
			+25°C	-0.810	-1.850	-1.105	-1.475				-5.2
+85°C	-0.700	-1.825	-1.035	-1.440	-5.2						
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						(V _{CC}) Gnd		
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{BB}	V _{VEE}			
Power Supply Drain Current	I _E	8		4, 9, 12			5, 10, 13	8	1, 16		
Input Current	I _{inH}	4	4	9, 12			5, 10, 13	8	1, 16		
	I _{CBO}	4		9, 12			5, 10, 13	8,4	1, 16		
Output Voltage Logic 1	V _{OH}	2	4	9, 12			5, 10, 13	8	1, 16		
		3	9, 12	4			5, 10, 13	8	1, 16		
Output Voltage Logic 0	V _{OL}	2	9, 12	4			5, 10, 13	8	1, 16		
		3	4	9, 12			5, 10, 13	8	1, 16		
Threshold Voltage Logic 1	V _{OHA}	2		9, 12	4		5, 10, 13	8	1, 16		
		3	9, 12		4	4	5, 10, 13	8	1, 16		
Threshold Voltage Logic 0	V _{OLA}	2		9, 12		4	5, 10, 13	8	1, 16		
		3	9, 12		4	4	5, 10, 13	8	1, 16		
Reference Voltage	V _{BB}	11					5, 10, 13	8	1, 16		
Switching Times (50Ω Load)					Pulse In	Pulse Out		-3.2 V	+2.0 V		
Propagation Delay	t ₄₊₂₊	2			4	2	5, 10, 13	8	1, 16		
	t ₄₋₂₋	2			4	2	5, 10, 13	8	1, 16		
	t ₄₊₃₋	3			4	3	5, 10, 13	8	1, 16		
	t ₄₋₃₊	3			4	3	5, 10, 13	8	1, 16		
Rise Time (20 to 80%)	t ₂₊	2			4	2	5, 10, 13	8	1, 16		
	t ₃₊	3			4	3	5, 10, 13	8	1, 16		
Fall Time (20 to 80%)	t ₂₋	2			4	2	5, 10, 13	8	1, 16		
	t ₃₋	3			4	3	5, 10, 13	8	1, 16		

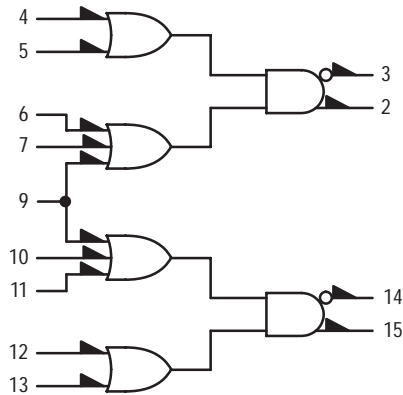
Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Dual 2-Wide 2-3-Input OR-AND/OR-AND Gate

The MC10117 is a dual 2-wide 2-3-input OR-AND/OR-AND-Invert gate. This general purpose logic element is designed for use in data control, such as digital multiplexing or data distribution. Pin 9 is common to both gates.

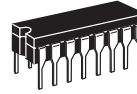
$P_D = 100 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 2.3 \text{ ns typ}$
 $t_r, t_f = 2.2 \text{ ns typ (20\%–80\%)}$

LOGIC DIAGRAM



$V_{CC1} = \text{PIN 1}$
 $V_{CC2} = \text{PIN 16}$
 $V_{EE} = \text{PIN 8}$

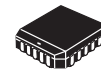
MC10117



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

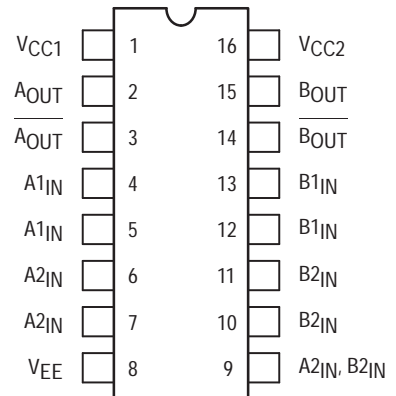


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I_E	8		29		20	26		29	mA _{dc}
Input Current	I_{inH}^*	6		425			265		265	μ A _{dc}
		9		560			350		350	
4			390			245		245		
	I_{inL}	4	0.5		0.5			0.3		μ A _{dc}
Output Voltage Logic 1	V_{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	V _{dc}
		3	-1.060	-0.780	-0.960		-0.700	-0.890	-0.590	
Output Voltage Logic 0	V_{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	V _{dc}
		3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V_{OHA}	2	-1.080		-0.980			-0.910		V _{dc}
		3	-1.080		-0.980			-0.910		
Threshold Voltage Logic 0	V_{OLA}	2		-1.655			-1.630		-1.595	V _{dc}
		3		-1.655			-1.630		-1.595	
Switching Times (50 Ω Load)										ns
Propagation Delay	t_{4+2+}	2	1.4	3.9	1.4	2.3	3.4	1.4	3.8	
	t_{4-2-}	2	1.4	3.9	1.4	2.3	3.4	1.4	3.8	
	t_{4+3-}	3	1.4	3.9	1.4	2.3	3.4	1.4	3.8	
	t_{4-3+}	3	1.4	3.9	1.4	2.3	3.4	1.4	3.8	
Rise Time (20 to 80%)	t_{2+}	2	0.9	4.1	1.1	2.2	4.0	1.1	4.6	
	t_{3+}	3	0.9	4.1	1.1	2.2	4.0	1.1	4.6	
Fall Time (20 to 80%)	t_{2-}	2	0.9	4.1	1.1	2.2	4.0	1.1	4.6	
	t_{3-}	3	0.9	4.1	1.1	2.2	4.0	1.1	4.6	

* Inputs 4, 5, 12 and 13 have same I_{inH} limit.
 Inputs 6, 7, 10 and 11 have same I_{inH} limit.

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd	
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
Power Supply Drain Current	I _E	8					8	1, 16	
Input Current	I _{inH} *	6	4				8	1, 16	
		9	9				8	1, 16	
4		4				8	1, 16		
	I _{inL}	4		9			8	1, 16	
Output Voltage	Logic 1	V _{OH}	2	4, 9			8	1, 16	
			3				8	1, 16	
Output Voltage	Logic 0	V _{OL}	2				8	1, 16	
			3	4, 9			8	1, 16	
Threshold Voltage	Logic 1	V _{OHA}	2	9		4	8	1, 16	
			3			4	8	1, 16	
Threshold Voltage	Logic 0	V _{OLA}	2			4	8	1, 16	
			3	9		4	8	1, 16	
Switching Times	(50Ω Load)		+1.11V		Pulse In	Pulse Out	-3.2 V	+2.0 V	
Propagation Delay	t ₄₊₂₊ t ₄₋₂₋ t ₄₊₃₋ t ₄₋₃₊	2	9		4	2	8	1, 16	
		2	9		4	2	8	1, 16	
		3	9		4	3	8	1, 16	
		3	9		4	3	8	1, 16	
Rise Time	(20 to 80%)	t ₂₊ t ₃₊	2	9		4	2	8	1, 16
			3	9		4	3	8	1, 16
Fall Time	(20 to 80%)	t ₂₋ t ₃₋	2	9		4	2	8	1, 16
			3	9		4	3	8	1, 16

* Inputs 4, 5, 12 and 13 have same I_{inH} limit.
Inputs 6, 7, 10 and 11 have same I_{inH} limit.

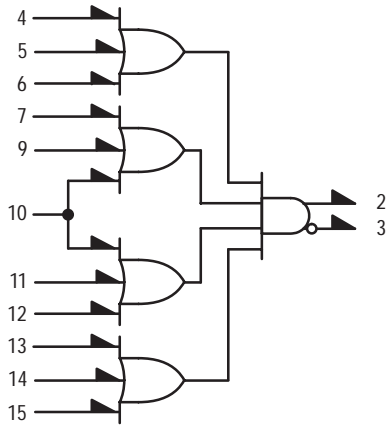
Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

4-Wide OR-AND/OR-AND Gate

The MC10121 is a basic logic building block providing the simultaneous OR-AND/OR-AND-Invert function, useful in data control and digital multiplexing applications.

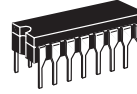
$P_D = 100 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 2.3 \text{ ns typ}$
 $t_r, t_f = 2.5 \text{ ns typ (20\%–80\%)}$

LOGIC DIAGRAM



$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

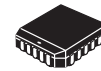
MC10121



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

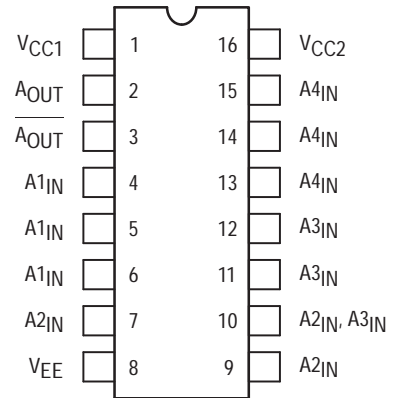


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I _E	8		29		20	26		29	mAdc
Input Current	I _{inH}	7		390			245		245	μAdc
		9		390			245		245	
		10		495			310		310	
	I _{inL}	7	0.5		0.5			0.3		μAdc
		9	0.5		0.5			0.3		
		10	0.5		0.5			0.3		
Output Voltage Logic 1	V _{OH}	3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Output Voltage Logic 0	V _{OL}	3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V _{OHA}	3	-1.080		-0.980			-0.910		Vdc
		2	-1.080		-0.980			-0.910		
Threshold Voltage Logic 0	V _{OLA}	3		-1.655			-1.630		-1.595	Vdc
		2		-1.655			-1.630		-1.595	
Switching Times (50Ω Load)										ns
Propagation Delay	t ₄₊₃₋	3	1.4	3.6	1.4	2.3	3.4	1.4	3.5	
	t ₄₋₃₊	3	1.4	3.6	1.4	2.3	3.4	1.4	3.5	
	t ₄₊₂₊	2	1.4	3.6	1.4	2.3	3.4	1.4	3.5	
	t ₄₋₂₋	2	1.4	3.6	1.4	2.3	3.4	1.4	3.5	
Rise Time (20 to 80%)	t ₃₊	3	0.9	4.1	1.1	2.5	4.0	1.1	4.6	
	t ₂₊	2	0.9	4.1	1.1	2.5	4.0	1.1	4.6	
Fall Time (20 to 80%)	t ₃₋	3	0.9	4.1	1.1	2.5	4.0	1.1	4.6	
	t ₂₋	2	0.9	4.1	1.1	2.5	4.0	1.1	4.6	

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd	
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
Power Supply Drain Current	I _E	8					8	1, 16	
Input Current	I _{inH}	7	7				8	1, 16	
		9	9				8	1, 16	
		10	10				8	1, 16	
	I _{inL}	7		7			8	1, 16	
		9		9			8	1, 16	
		10		10			8	1, 16	
Output Voltage	Logic 1	V _{OH}	3				8	1, 16	
			2	4, 10, 13			8	1, 16	
Output Voltage	Logic 0	V _{OL}	3				8	1, 16	
			2	4, 10, 13			8	1, 16	
Threshold Voltage	Logic 1	V _{OHA}	3				8	1, 16	
			2	10, 13	4	4	8	1, 16	
Threshold Voltage	Logic 0	V _{OLA}	3				8	1, 16	
			2	10, 13	4	4	8	1, 16	
Switching Times	(50Ω Load)		+1.11V		Pulse In	Pulse Out	-3.2 V	+2.0 V	
Propagation Delay	t ₄₊₃₋ t ₄₋₃₊ t ₄₊₂₊ t ₄₋₂₋	3	10, 13		4	3	8	1, 16	
		3	10, 13		4	3	8	1, 16	
		2	10, 13		4	2	8	1, 16	
		2	10, 13		4	2	8	1, 16	
Rise Time	(20 to 80%)	t ₃₊ t ₂₊	3	10, 13		4	3	8	1, 16
			2	10, 13		4	2	8	1, 16
Fall Time	(20 to 80%)	t ₃₋ t ₂₋	3	10, 13		4	3	8	1, 16
			2	10, 13		4	2	8	1, 16

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Triple 4-3-3-Input Bus Driver

The MC10123 consists of three NOR gates designed for bus driving applications on card or between cards. Output low logic levels are specified with $V_{OL} = -2.1$ Vdc so that the bus may be terminated to -2.0 Vdc. The gate output, when low, appears as a high impedance to the bus, because the output emitter-followers of the MC10123 are "turned-off." This eliminates discontinuities in the characteristic impedance of the bus.

The V_{OH} level is specified when driving a 25-ohm load terminated to -2.0 Vdc, the equivalent of a 50-ohm bus terminated at both ends. Although 25 ohms is the lowest characteristic impedance that can be driven by the MC10123, higher impedance values may be used with this part. A typical 50-ohm bus is shown in Figure 1.

$P_D = 310$ mW typ/pkg (No Load)
 $t_{pd} = 3.0$ ns typ
 $t_r, t_f = 2.5$ ns typ (20%–80%)

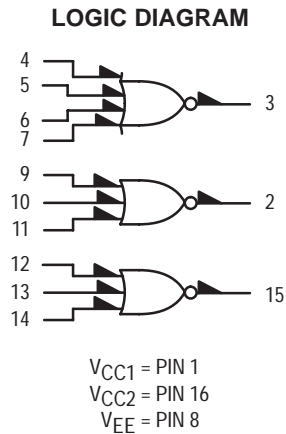
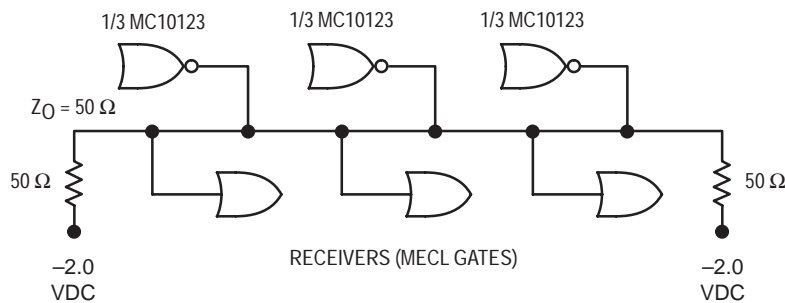
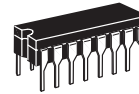


FIGURE 1 — 50-OHM BUS DRIVER (TYPICAL APPLICATION)



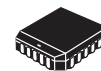
MC10123



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

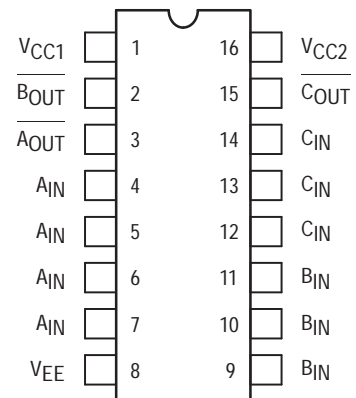


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP
PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I _E	8		82		71	75		82	mAdc
Input Current	I _{inH}	4		350			220		220	μAdc
	I _{inL}	4			0.5					μAdc
Output Voltage Logic 1	V _{OH}	3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
Output Voltage Logic 0	V _{OL}	3	-2.100	-2.030	-2.100		-2.030	-2.100	-2.030	Vdc
Threshold Voltage Logic 1	V _{OHA}	3	-1.080		-0.980			-0.910		Vdc
Threshold Voltage Logic 0	V _{OLA}	3		-2.100			-2.100		-2.100	Vdc
Switching Times (50Ω Load)										ns
Propagation Delay	t ₄₊₃₋	3	1.2	4.6	1.2	3.0	4.4	1.2	4.8	
	t ₄₋₃₊	3	1.2	4.6	1.2	3.0	4.4	1.2	4.8	
Rise Time (20 to 80%)	t ₃₊	3	1.0	3.7	1.0	2.5	3.5	1.0	3.9	
Fall Time (20 to 80%)	t ₃₋	3	1.0	3.7	1.0	2.5	3.5	1.0	3.9	

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)						
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmx}	V _{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					(V _{CC}) Gnd	
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmx}	V _{EE}		
Power Supply Drain Current	I _E	8	4,5,6,7,9 10,11,12 13,14				8	1, 16	
Input Current	I _{inH}	4	4				8	1, 16	
	I _{inL}	4		4			8	1, 16	
Output Voltage Logic 1	V _{OH}	3					8	1, 16	
Output Voltage Logic 0	V _{OL}	3	4,5,6,7 9,12				8	1, 16	
Threshold Voltage Logic 1	V _{OHA}	3				4,5,6,7	8	1, 16	
Threshold Voltage Logic 0	V _{OLA}	3	9,12		4,5,6,7		8	1, 16	
Switching Times (50Ω Load)						Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	t ₄₊₃₋	3				4	3	8	1, 16
	t ₄₋₃₊	3				4	3	8	1, 16
Rise Time (20 to 80%)	t ₃₊	3				4	3	8	1, 16
Fall Time (20 to 80%)	t ₃₋	3				4	3	8	1, 16

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

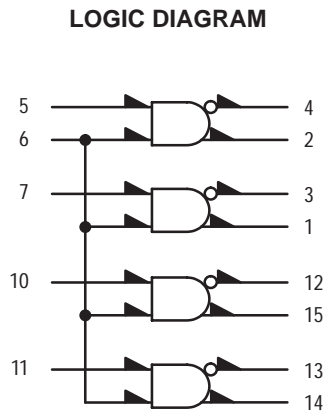
Quad TTL to MECL Translator

The MC10124 is a quad translator for interfacing data and control signals between a saturated logic section and the MECL section of digital systems. The MC10124 has TTL compatible inputs, and MECL complementary open-emitter outputs that allow use as an inverting/ non-inverting translator or as a differential line driver. When the common strobe input is at the low logic level, it forces all true outputs to a MECL low logic state and all inverting outputs to a MECL high logic state.

Power supply requirements are ground, +5.0 Volts, and -5.2 Volts. Propagation delay of the MC10124 is typically 3.5 ns. The dc levels are standard or Schottky TTL in, MECL 10,000 out.

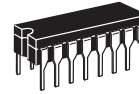
An advantage of this device is that TTL level information can be transmitted differentially, via balanced twisted pair lines, to the MECL equipment, where the signal can be received by the MC10115 or MC10116 differential line receivers. The MC10124 is useful in computers, instrumentation, peripheral controllers, test equipment, and digital communications systems.

$P_D = 380 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 3.5 \text{ ns typ (+ 1.5 Vdc in to 50% out)}$
 $t_r, t_f = 2.5 \text{ ns typ (20\%–80\%)}$



Gnd = PIN 16
 $V_{CC} (+5.0Vdc) = \text{PIN } 9$
 $V_{EE} (-5.2Vdc) = \text{PIN } 8$

MC10124



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

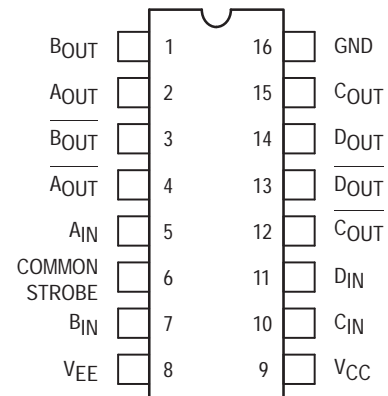


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
 For PLCC pin assignment, see the Pin Conversion
 Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits						Unit	
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min		Max
Negative Power Supply Drain Current	I _E	8		72			66		72	mAdc
Positive Power Supply Drain Current	I _{CCH}	9		16			16		18	mAdc
	I _{CCL}	9		25			25		25	mAdc
Reverse Current	I _R	6		200			200		200	μAdc
		7		50			50		50	
Forward Current	I _F	6		-12.8			-12.8		-12.8	mAdc
		7		-3.2			-3.2		-3.2	
Input Breakdown Voltage	BV _{in}	6	5.5		5.5			5.5		Vdc
		7	5.5		5.5			5.5		
Clamp Input Voltage	V _I	6		-1.5			-1.5		-1.5	Vdc
		7		-1.5			-1.5		-1.5	
High Output Voltage	V _{OH}	1	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Low Output Voltage	V _{OL}	1	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
High Threshold Voltage	V _{OHA}	1	-1.080		-0.980			-0.910		Vdc
		3	-1.080		-0.980			-0.910		
Low Threshold Voltage	V _{OLA}	1		-1.655			-1.630		-1.595	Vdc
		3		-1.655			-1.630		-1.595	
Switching Times (50Ω Load)										ns
Propagation Delay (+3.5Vdc to 50%) ¹	t ₆₊₁₊	1	1.5	6.8	1.0	3.5	6.0	1.0	6.0	
	t ₆₋₁₋	1	1.0	6.0	1.0	3.5	6.0	1.5	6.8	
	t ₇₊₁₊	1	1.5	6.8	1.0	3.5	6.0	1.0	6.0	
	t ₇₋₁₋	1	1.0	6.0	1.0	3.5	6.0	1.5	6.8	
	t ₇₊₃₋	3	1.5	6.8	1.0	3.5	6.0	1.0	6.0	
	t ₇₋₃₊	3	1.0	6.0	1.0	3.5	6.0	1.5	6.8	
Rise Time (20 to 80%)	t ₁₊	1	1.0	4.2	1.1	2.5	3.9	1.1	4.3	
Fall Time (20 to 80%)	t ₁₋	1	1.0	4.2	1.1	2.5	3.9	1.1	4.3	

1. See switching time test circuit. Propagation delay for this circuit is specified from +1.5Vdc in to the 50% point on the output waveform. The +3.5Vdc is shown here because all logic and supply levels are shifted 2 volts positive.

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					
			V _{IH}	V _{ILmax}	V _{IHA'}	V _{I LA'}	V _F	
@ Test Temperature								
-30°C			+4.0	+0.40	+2.00	+1.10	+0.40	
+25°C			+4.0	+0.40	+1.80	+1.10	+0.40	
+85°C			+4.0	+0.40	+1.80	+0.90	+0.40	
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					Gnd
			V _{IH}	V _{ILmax}	V _{IHA'}	V _{I LA'}	V _F	
Negative Power Supply Drain Current	I _E	8						16
Positive Power Supply Drain Current	I _{CCH}	9	5,6,7,10,11					16
	I _{CCL}	9						5,6,7,10,11,16
Reverse Current	I _R	6					5,7,10,11	16
		7					6	16
Forward Current	I _F	6	5,7,10,11				6	16
		7	6				7	16
Input Breakdown Voltage	BV _{in}	6						5,7,10,11,16
		7						6,16
Clamp Input Voltage	V _I	6						16
		7						16
High Output Voltage	V _{OH}	1	6,7					16
		3		6,7				16
Low Output Voltage	V _{OL}	1		6,7				16
		3	6,7					16
High Threshold Voltage	V _{OHA}	1	6		7			16
		3	6			7		16
Low Threshold Voltage	V _{OLA}	1	6			7		16
		3	6		7			16
Switching Times (50Ω Load)			+6.0 V	Pulse In	Pulse Out			+2.0 V
Propagation Delay (+3.5Vdc to 50%) ¹	t ₆₊₁₊	1	7	6	1			16
	t ₆₋₁₋	1	7	6	1			16
	t ₇₊₁₊	1	6	7	1			16
	t ₇₋₁₋	1	6	7	1			16
	t ₇₊₃₋	3	6	7	3			16
	t ₇₋₃₊	3	6	7	3			16
Rise Time (20 to 80%)	t ₁₊	1	6	7	1			16
Fall Time (20 to 80%)	t ₁₋	1	6	7	1			16

1. See switching time test circuit. Propagation delay for this circuit is specified from +1.5Vdc in to the 50% point on the output waveform. The +3.5Vdc is shown here because all logic and supply levels are shifted 2 volts positive.

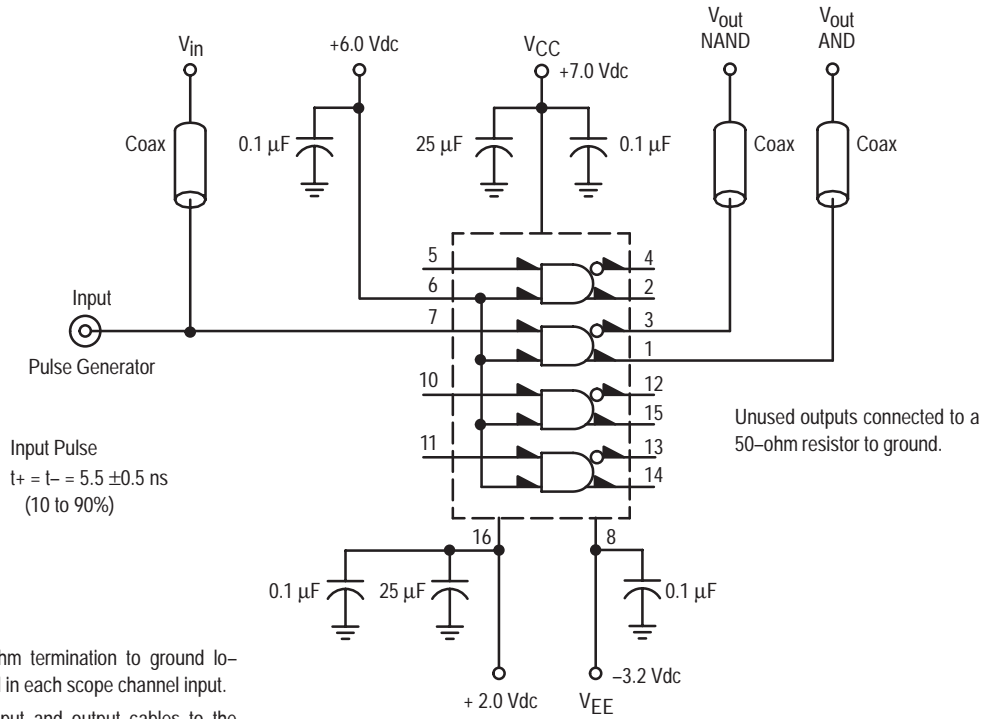
ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)			(mA)		Gnd
			V_R	V_{CC}	V_{EE}	I_I	I_{in}	
			@ Test Temperature					
			-30°C	+2.40	+5.00	-5.2	-10	
$+25^\circ\text{C}$	+2.40	+5.00	-5.2	-10	+1.0			
$+85^\circ\text{C}$	+2.40	+5.00	-5.2	-10	+1.0			
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					
			V_R	V_{CC}	V_{EE}	I_I	I_{in}	
Negative Power Supply Drain Current	I_E	8		9	8			16
Positive Power Supply Drain Current	I_{CCH}	9		9	8			16
	I_{CCL}	9		9	8			5,6,7,10,11,16
Reverse Current	I_R	6	6	9	8			16
		7	7	9	8			16
Forward Current	I_F	6		9	8			16
		7		9	8			16
Input Breakdown Voltage	BV_{in}	6		9	8		6	5,7,10,11,16
		7		9	8		7	6,16
Clamp Input Voltage	V_I	6		9	8	6		16
		7		9	8	7		16
High Output Voltage	V_{OH}	1		9	8			16
		3		9	8			16
Low Output Voltage	V_{OL}	1		9	8			16
		3		9	8			16
High Threshold Voltage	V_{OHA}	1		9	8			16
		3		9	8			16
Low Threshold Voltage	V_{OLA}	1		9	8			16
		3		9	8			16
Switching Times (50 Ω Load)				+7.0 V	-3.2 V			+2.0 V
Propagation Delay (+3.5Vdc to 50%) ¹	t_{6+1+}	1		9	8			16
	t_{6-1-}	1		9	8			16
	t_{7+1+}	1		9	8			16
	t_{7-1-}	1		9	8			16
	t_{7+3-}	3		9	8			16
	t_{7-3+}	3		9	8			16
Rise Time (20 to 80%)	t_{1+}	1		9	8			16
Fall Time (20 to 80%)	t_{1-}	1		9	8			16

1. See switching time test circuit. Propagation delay for this circuit is specified from +1.5Vdc in to the 50% point on the output waveform. The +3.5Vdc is shown here because all logic and supply levels are shifted 2 volts positive.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

SWITCHING TIME TEST CIRCUIT



50-ohm termination to ground located in each scope channel input.
 All input and output cables to the scope are equal lengths of 50-ohm coaxial cable. Wire length should be < 1/4 inch from TP_{IN} to input pin and TP_{OUT} to output pin.

NOTE: All power supply and logic levels are shown shifted 2 volts positive.

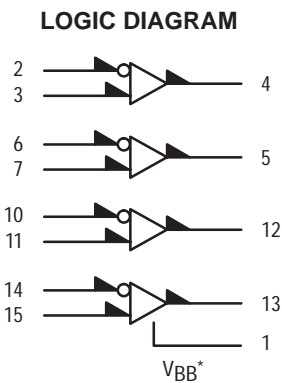
Quad MECL to TTL Translator

The MC10125 is a quad translator for interfacing data and control signals between the MECL section and saturated logic sections of digital systems. The MC10125 incorporates differential inputs and Schottky TTL "totem pole" outputs. Differential inputs allow for use as an inverting/non-inverting translator or as a differential line receiver. The V_{BB} reference voltage is available on pin 1 for use in single-ended input biasing. The outputs of the MC10125 go to a low logic level whenever the inputs are left floating.

Power supply requirements are ground, +5.0 Volts and -5.2 Volts. Propagation delay of the MC10125 is typically 4.5 ns. The MC10125 has fanout of 10 TTL loads. The dc levels are MECL 10,000 in and Schottky TTL, or TTL out. This device has an input common mode noise rejection of ± 1.0 Volt.

An advantage of this device is that MECL level information can be received, via balanced twisted pair lines, in the TTL equipment. This isolates the MECL logic from the noisy TTL environment. This device is useful in computers, instrumentation, peripheral controllers, test equipment and digital communications systems.

$P_D = 380$ mW typ/pkg (No Load)
 $t_{pd} = 4.5$ ns typ (50% to + 1.5 Vdc out)
 $t_r, t_f = 2.5$ ns typ (1.0 V to 2.0 V)

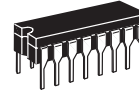


Gnd = PIN 16
 V_{CC} (+5.0Vdc) = PIN 9
 V_{EE} (-5.2Vdc) = PIN 8

* V_{BB} to be used to supply bias to the MC10125 only and bypassed (when used) with 0.01 μ F to 0.1 μ F capacitor to ground (0 V). V_{BB} can source < 1.0 mA.

When the input pin with the bubble goes positive, the output goes negative.

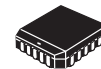
MC10125



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

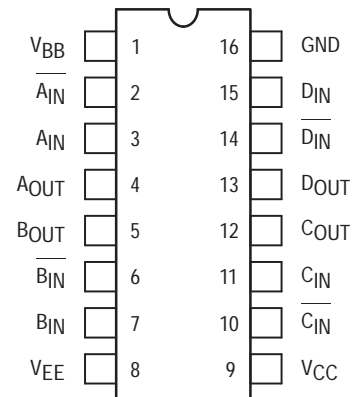


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
 For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits						Unit	
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min		Max
Negative Power Supply Drain Current	I _E	8		-44			-40		-44	mAdc
Positive Power Supply Drain Current	I _{CCH}	9		52			52		52	mAdc
	I _{CCL}	9		39			39		39	mAdc
Input Current	I _{inH} ¹	2		180			115		115	μAdc
Input Leakage Current	I _{CBO}	2		1.5			1.0		1.0	μAdc
High Output Voltage	V _{OH}	4	2.5		2.5			2.5		Vdc
Low Output Voltage	V _{OL}	4		0.5			0.5		0.5	Vdc
High Threshold Voltage	V _{OHA}	4	2.5		2.5			2.5		Vdc
Low Threshold Voltage	V _{OLA}	4		0.5			0.5		0.5	Vdc
Indeterminate Input Protection Tests	V _{OLS1}	4		0.5			0.5		0.5	Vdc
	V _{OLS2}	4		0.5			0.5		0.5	Vdc
Short Circuit Current	I _{OS}	4	40	100	40		100	40	100	mAdc
Reference Voltage	V _{BB}	1	-1.420	-1.280	-1.350		-1.230	-1.295	-1.150	Vdc
Common Mode Rejection Tests	V _{OH}	4	2.5		2.5			2.5		Vdc
		4	2.5		2.5			2.5		Vdc
V _{OL}	4		0.5				0.5		0.5	Vdc
	4		0.5				0.5		0.5	Vdc
Switching Times (50Ω Load)										ns
Propagation Delay (50% to +1.5Vdc)	t ₆₊₅₋	5	1.0	6.0	1.0	4.5	6.0	1.0	6.0	
	t ₆₋₅₊	5	1.0	6.0	1.0	4.5	6.0	1.0	6.0	
	t ₂₊₄₋	4	1.0	6.0	1.0	4.5	6.0	1.0	6.0	
	t ₂₋₄₊	4	1.0	6.0	1.0	4.5	6.0	1.0	6.0	
Rise Time (+1.0V to 2.0V)	t ₄₊	4		3.3			3.3		3.3	
Fall Time (+1.0V to 2.0V)	t ₄₋	4		3.3			3.3		3.3	

1. Individually test each output, apply V_{IHmax} to pin under test.

ELECTRICAL CHARACTERISTICS (continued)

@ Test Temperature			TEST VOLTAGE VALUES (Volts)						Gnd	Output Condition
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{IHH}	V _{ILH}		
-30°C			-0.890	-1.890	-1.205	-1.500	+0.110	-0.890		
+25°C			-0.810	-1.850	-1.105	-1.475	+0.190	-0.850		
+85°C			-0.700	-1.825	-1.035	-1.440	+0.300	-0.825		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						Gnd	Output Condition
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{IHH}	V _{ILH}		
Negative Power Supply Drain Current	I _E	8							16	
Positive Power Supply Drain Current	I _{CCH}	9	2,6,10,14						16	
	I _{CCL}	9		2,6,10,14					16	
Input Current	I _{inH} ¹	2	2,6,10,14						16	
Input Leakage Current	I _{CBO}	2							16	
High Output Voltage	V _{OH}	4		2,6,10,14					16	-2.0mA
Low Output Voltage	V _{OL}	4	2,6,10,14						16	20mA
High Threshold Voltage	V _{OHA}	4		6,10,14		2			16	-2.0mA
Low Threshold Voltage	V _{OLA}	4	6,10,14		2				16	20mA
Indeterminate Input Protection Tests	V _{OLS1}	4							16	20mA
	V _{OLS2}	4							16	20mA
Short Circuit Current	I _{OS}	4		2,6,10,14					4, 16	
Reference Voltage	V _{BB}	1		2,6,10,14						
Common Mode Rejection Tests	V _{OH}	4 4					3	2	16 16	-2.0mA -2.0mA
	V _{OL}	4 4					2	3	16 16	20mA 20mA
Switching Times (50Ω Load)			Pulse In	Pulse Out	C_L (pF)					
Propagation Delay (50% to +1.5Vdc)	t ₆₊₅₋	5	6	5	25				16	
	t ₆₋₅₊	5	6	5	25				16	
	t ₂₊₄₋	4	2	4	25				16	
	t ₂₋₄₊	4	2	4	25				16	
Rise Time (+1.0V to 2.0V)	t ₄₊	4	2	4	25				16	
Fall Time (+1.0V to 2.0V)	t ₄₋	4	2	4	25				16	

1. Individually test each output, apply V_{IHmax} to pin under test.

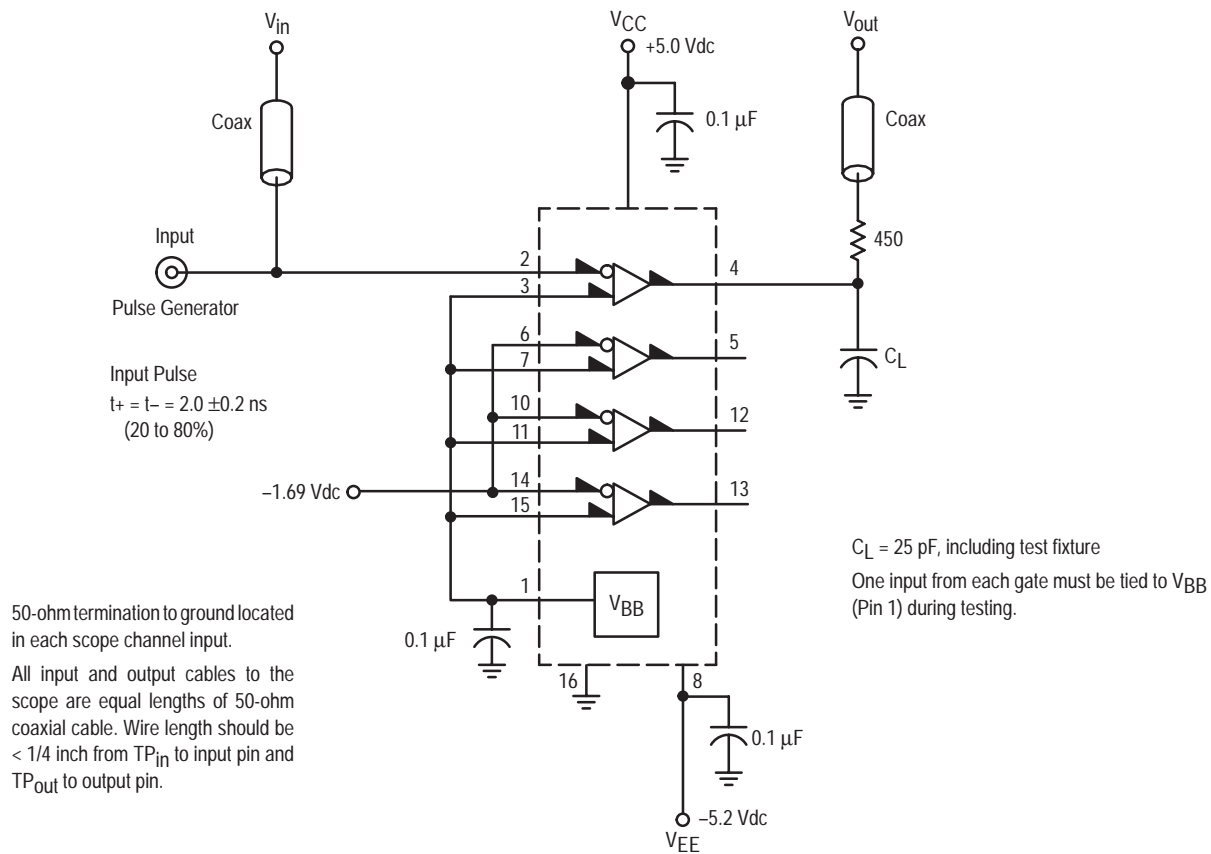
ELECTRICAL CHARACTERISTICS (continued)

@ Test Temperature -30°C +25°C +85°C			TEST VOLTAGE VALUES (Volts)					Gnd	Output Condition
			V _{IHH}	V _{ILH}	V _{BB} From Pin 1	V _{VCC}	V _{VEE}		
			-1.890	-2.890		+5.0	-5.2		
			-1.810	-2.850		+5.0	-5.2		
			+5.0	-5.2					
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					Gnd	Output Condition
			V _{IHH}	V _{ILH}	V _{BB}	V _{VCC}	V _{VEE}		
Negative Power Supply Drain Current	I _E	8			3,7,11,15	9	8	16	
Positive Power Supply Drain Current	I _{CCH}	9			3,7,11,15	9	8	16	
	I _{CCL}	9			3,7,11,15	9	8	16	
Input Current	I _{inH} ¹	2			3,7,11,15	9	8	16	
Input Leakage Current	I _{CBO}	2			3,7,11,15	9	2,6,8,10,14	16	
High Output Voltage	V _{OH}	4			3,7,11,15	9	8	16	-2.0mA
Low Output Voltage	V _{OL}	4			3,7,11,15	9	8	16	20mA
High Threshold Voltage	V _{OHA}	4			3,7,11,15	9	8	16	-2.0mA
Low Threshold Voltage	V _{OLA}	4			3,7,11,15	9	8	16	20mA
Indeterminate Input Protection Tests	V _{OLS1}	4				9	2,3,6,7,8,10,11,14,15	16	20mA
	V _{OLS2}	4				9	8	16	20mA
Short Circuit Current	I _{OS}	4			3,7,11,15	9	8	4, 16	
Reference Voltage	V _{BB}	1			3,7,11,15				
Common Mode Rejection Tests	V _{OH}	4				9	8	16	-2.0mA
		4	3	2		9	8	16	-2.0mA
	V _{OL}	4	2	3		9	8	16	20mA
		4				9	8	16	20mA
Switching Times (50Ω Load)									
Propagation Delay (50% to +1.5Vdc)	t ₆₊₅₋	5			3,7,11,15	9	8	16	
	t ₆₋₅₊	5			3,7,11,15	9	8	16	
	t ₂₊₄₋	4			3,7,11,15	9	8	16	
	t ₂₋₄₊	4			3,7,11,15	9	8	16	
Rise Time (+1.0V to 2.0V)	t ₄₊	4			3,7,11,15	9	8	16	
Fall Time (+1.0V to 2.0V)	t ₄₋	4			3,7,11,15	9	8	16	

1. Individually test each output, apply V_{IHmax} to pin under test.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

SWITCHING TIME TEST CIRCUIT



Quad Bus Receiver

The MC10129 data inputs are compatible with, and accept TTL logic levels as well as levels compatible with IBM-type buses. The clock, strobe, and reset inputs accept MECL 10,000 logic levels.

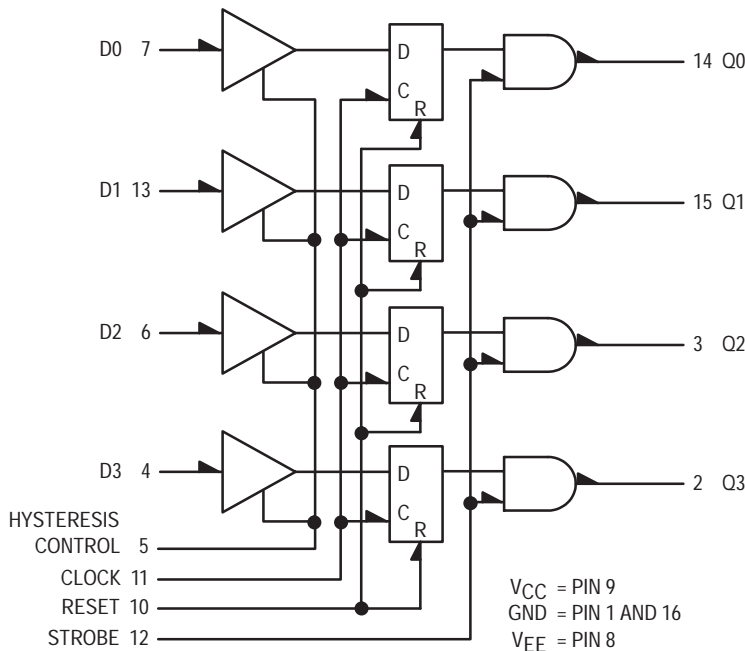
The data inputs accept the bus levels, and storage elements are provided to yield temporary latch storage of the information after receiving it from the bus. The outputs can be strobed to allow accurate synchronization of signals and/or connection to MECL 10,000 level buses. When the clock is low, and the reset input is disabled, the outputs will follow the D inputs. The latches will store the data on the rising edge of the clock. The outputs are enabled when the strobe input is high. Unused D inputs must be tied to V_{CC} or Gnd. The clock, strobe, and reset inputs each have 50 k ohm pulldown resistors to V_{EE}. They may be left floating, if not used.

The MC10129 will operate in either of two modes. The first mode is obtained by tying the hysteresis control input to V_{EE}. In this mode, the input threshold points of the D inputs are fixed. The second mode is obtained by tying the hysteresis control input to ground. In this mode, input hysteresis is achieved as shown in the test table. This hysteresis is desirable where extra noise margin is required on the D inputs. The outer input pins are unaffected by the mode of operation used.

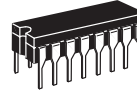
The MC10129 is especially useful in interface applications for central processors, mini-computers, and peripheral equipment.

$P_D = 750 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 10 \text{ ns typ}$
 $V_{CC} \text{ Max} = 7.0 \text{ Vdc}$

LOGIC DIAGRAM

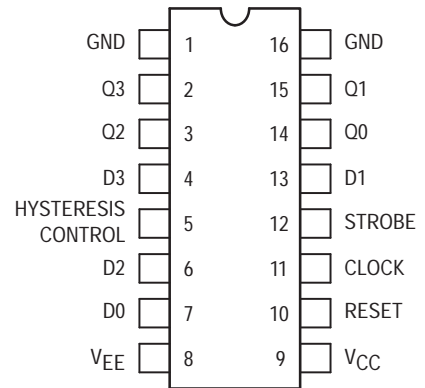


MC10129



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

PIN ASSIGNMENT



TRUTH TABLE

D	C	STROBE	RESET	Q _{n+1}
X	X	L	X	L
X	H	X	H	L
L	L	H	X	L
X	H	H	L	Q _n
H	L	H	X	H



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits						Unit	
			-30°C		+25°C		+85°C			
			Min	Max	Min	Typ	Max	Min		Max
Negative Power Supply Drain Current	I_E	8 8		167 189			152 172		167 189	mAdc
Positive Power Supply Drain Current	I_{CC}	9		8.0			8.0		8.0	mAdc
Input Current	I_{inH}	4		150			95		95	μ Adc
		6		150			95		95	
		7		150			95		95	
		10		720			450		450	
		11		390			245		245	
	12		390			245		245		
		13		150			95		95	
	$I_{CBO} (1.)$	4		1.5			-1.0		1.0	μ Adc
		6		1.5			-1.0		1.0	
		7		1.5	-1.0			-1.0	1.0	
	I_{inL}	10	0.5		0.5			0.3		μ Adc
		11	0.5		0.5			0.3		
		12	0.5		0.5			0.3		
Output Voltage Logic 1	V_{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
		2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
		3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Output Voltage Logic 0	V_{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
		2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
		3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V_{OHA}	2 (2.)	-1.080		-0.980			-0.910		Vdc
		2	-1.080		-0.980			-0.910		
		2	-1.080		-0.980			-0.910		
		2	-1.080		-0.980			-0.910		
		2 (3.)	-1.080		-0.980			-0.910		
		2 (4.)	-1.080		-0.980			-0.910		
Threshold Voltage Logic 0	V_{OLA}	2 (2.)		-1.655			-1.630		-1.595	Vdc
		2		-1.655			-1.630		-1.595	
		2 (2.)		-1.655			-1.630		-1.595	
		2		-1.655			-1.630		-1.595	
		2 (3.)		-1.655			-1.630		-1.595	
		2 (4.)		-1.655			-1.630		-1.595	
Switching Times Propagation Delay									ns	
Data Input	t_{7+14+} t_{7-14-}	14	3.7	15	3.7	10	15	3.7	30	
		14	3.7	15	3.7	10	15	3.7	40	
Clock Input	t_{11-14+} t_{11-14-}	14	2.7	11	2.7	5.0	9.0	2.7	11	
		14	2.7	11	2.7	5.0	9.0	2.7	11	
Strobe Input	t_{12+14+} t_{12-14-}	14	1.6	8.0	1.6	4.0	7.0	1.6	8.0	
		14	1.6	8.0	1.6	4.0	7.0	1.6	8.0	
Reset Input	t_{10+14-}	14	2.0	8.0	2.0	5.0	6.5	2.0	8.0	
Hysteresis Mode	t_{7+14+} t_{7-14-}	14	6.6	30	6.7	18	25	6.6	30	
		14	3.7	17	3.7	10	15	3.7	40	
Setup Time	t_{setup}	14	30		2.7	15		30		
Hold Time	t_{hold}	14	0		-2.0	15		-2.0		
Rise Time	t_+	14	1.5	5.0	1.5	2.0	4.3	1.5	5.0	
Fall Time	t_-	14	1.5	5.0	1.5	2.0	4.3	1.5	5.0	

1. Pin 5 to V_{EE} , V_{IL} to Data input one at a time.
2. Output latched to logic high state prior to test. V_{IHA}' , V_{ILA}' are standard logic 1 and logic 0 MTTL threshold voltages. V_{IHA}'' , V_{ILA}'' , V_{IHA}''' and V_{ILA}''' are logic 1 and logic 0 threshold voltages in the hysteresis mode as shown in Figure 1 on page 3-63.
3. Input level on data input taken from +0.4V up to voltage level given.
4. Input level on data input taken from +4.0V down to voltage level given.
5. Operation and limits shown also apply for $V_{CC} = +6.0V$.

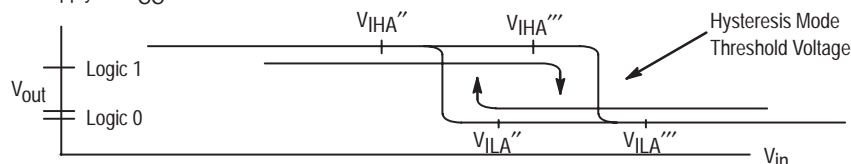


Figure 1. Hysteresis Mode Threshold Voltage

ELECTRICAL CHARACTERISTICS

@ Test Temperature -30°C +25°C +85°C			TEST VOLTAGE VALUES (Volts)								Gnd												
			MECL 10,000 INPUT LEVELS				TTL INPUT LEVELS (6.)																
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmx}	V _{IH}	V _{IL}	V _{IHA'}	V _{ILA'}													
			-0.890	-1.890	-1.155	-1.500	3.000	0.400	2.000	0.800													
			TEST VOLTAGE APPLIED TO PINS LISTED BELOW																				
Characteristic	Symbol	Pin Under Test	V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmx}	V _{IH}	V _{IL}	V _{IHA'}	V _{ILA'}	Gnd												
Negative Power Supply Drain Current	I _E	8 8	11 11	12 12							1,5,16 1,16												
Positive Power Supply Drain Current	I _{CC}	9						4,6,7,13			1,16												
Input Current	I _{inH}	4 6 7 10 11 12 13	10,11 11 12				4 6 7 13				1,16 1,16 1,16 1,16 1,16 1,16 1,16												
		I _{CBO} (1.)		4 6 7 13				4 6 7 13			1,16 1,16 1,16 1,16												
		I _{inL}		10 11 12	10 11 12						1,16 1,16 1,16												
Output Voltage Logic 1	V _{OH}	2 3 2 3	12 12 12 12	10,11 10,11 10,11 10,11			4 6 4 6				1,16 1,16 1,5,16 1,5,16												
		Output Voltage Logic 0	V _{OL}	2 3 2 3	12 12 12 12	10,11 10,11 10,11 10,11			4 6 4 6			1,16 1,16 1,5,16 1,5,16											
				Threshold Voltage Logic 1	V _{OHA}	2 (2.) 2 2 2 2 (3.) 2 (4.)	11,12 10,12 12 12 12 12	10,11 10,11 10,11 10,11 10,11 10,11	12 11	10 4 4		4		1,16 1,16 1,16 1,16 1,5,16 1,5,16									
						Threshold Voltage Logic 0	V _{OLA}	2 (2.) 2 2 (2.) 2 2 (3.) 2 (4.)	11,12 10,12 12 12 12 12	10,11 10,11 10,11 10,11 10,11 10,11	10 11	4 4 4			4	1,16 1,16 1,16 1,16 1,5,16 1,5,16							
Switching Times Propagation Delay																							
		Data Input	t ₇₊₁₄₊ t ₇₋₁₄₋														14 14	12 12	10,11 10,11	7 7	14 14		
		Clock Input	t ₁₁₋₁₄₊ t ₁₁₋₁₄₋	14 14	12 12												10 10	7,11 7,11	14 14			Figure 6 Figure 6	1,16 1,16
			Strobe Input	t ₁₂₊₁₄₊ t ₁₂₋₁₄₋	14 14		10,11 10,11										12 12	14 14	7 7		Figure 4 Figure 4	1,16 1,16	
		Reset Input		t ₁₀₊₁₄₋	14	12											10,11	14	7	7	Figure 5	1,16	
		Hysteresis Mode	t ₇₊₁₄₊ t ₇₋₁₄₋	14 14	12 12	10,11 10,11	7 7										14 14			Figure 3 Figure 3	1,5,16 1,5,16		
			Setup Time	t _{setup}	14	12	10										7,11	14			Figure 7	1,16	
		Hold Time	t _{hold}	14	12	10	7,11										14			Figure 7	1,16		
		Rise Time	t ₊	14	12	10,11	7										14			Figure 3	1,16		
		Fall Time	t ₋	14	12	10,11	7										14			Figure 3	1,16		

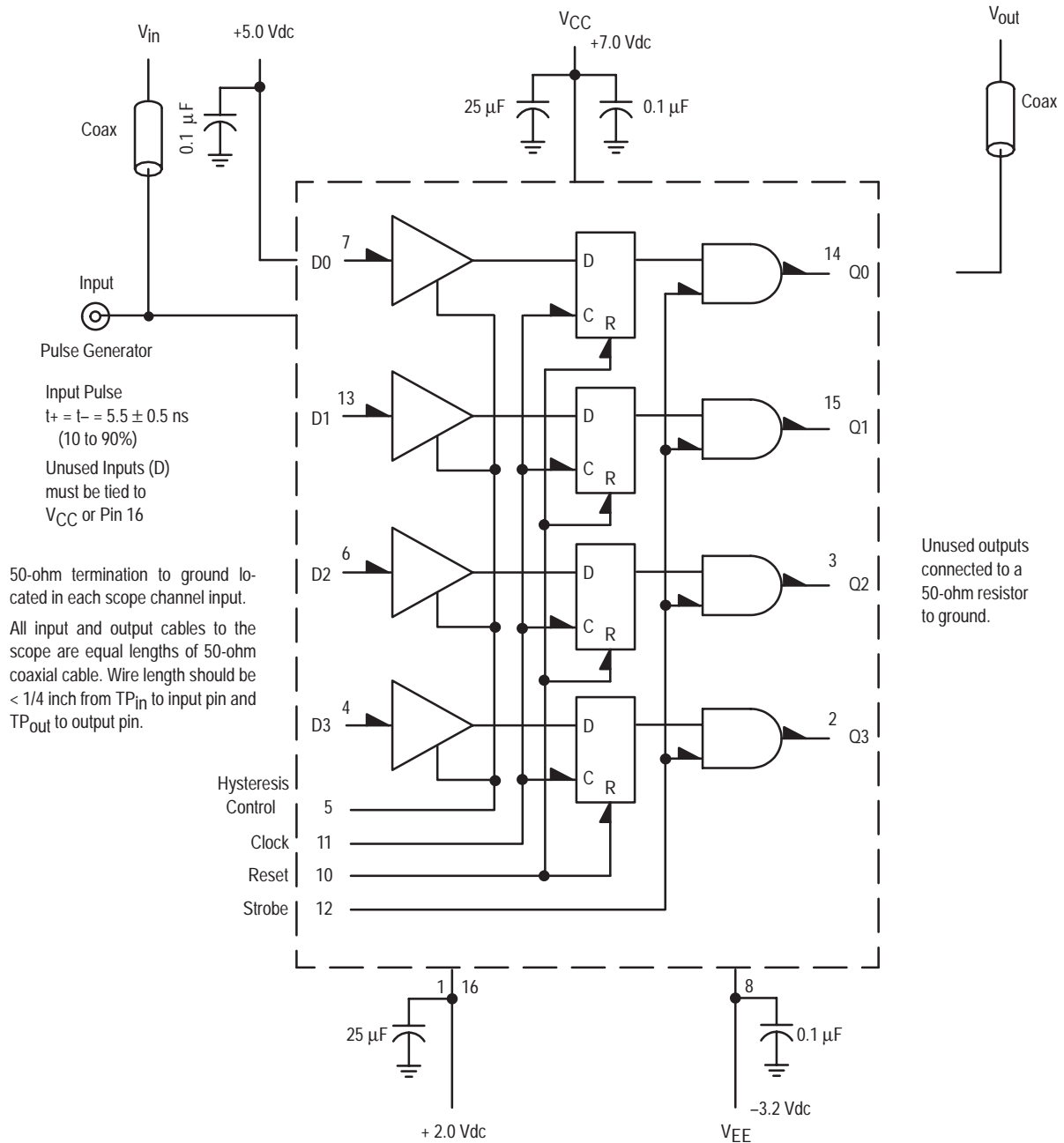
- Pin 5 to V_{EE}, V_{IL} to Data input one at a time.
- Output latched to logic high state prior to test. V_{IHA'}, V_{ILA'} are standard logic 1 and logic 0 MTTL threshold voltages. V_{IHA''}, V_{ILA''}, V_{IHA'''} and V_{ILA'''} are logic 1 and logic 0 threshold voltages in the hysteresis mode as shown in Figure 1 on page 3-63.
- Input level on data input taken from +0.4V up to voltage level given.
- Input level on data input taken from +4.0V down to voltage level given.
- Operation and limits shown also apply for V_{CC} = +6.0V.
- When testing, choose either TTL or IBM input levels.

ELECTRICAL CHARACTERISTICS

@ Test Temperature -30°C +25°C +85°C			TEST VOLTAGE VALUES (Volts)										Gnd
			IBM INPUT LEVELS (6.)				HYSTERESIS MODE				V _{CC} (5.)	V _{EE}	
			V _{IH}	V _{IL}	V _{IHA'}	V _{ILA'}	V _{IHA''}	V _{ILA''}	V _{IHA'''}	V _{ILA'''}			
			3.11	0.150			2.90	2.00	2.20	1.30	+5.0	-5.2	
			3.11	0.150	1.700	0.70	2.60	1.70	1.90	1.00	+5.0	-5.2	
			3.11	0.150			2.30	1.40	1.60	0.70	+5.0	-5.2	
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW										Gnd
			V _{IH}	V _{IL}	V _{IHA'}	V _{ILA'}	V _{IHA''}	V _{ILA''}	V _{IHA'''}	V _{ILA'''}	V _{CC} (5.)	V _{EE}	
Negative Power Supply Drain Current	I _E	8 8									9 9	8 5.8	1,5,16 1,16
Positive Power Supply Drain Current	I _{CC}	9		4,6, 7,13							9 9	5,8 5.8	1,16 1,16
Input Current	I _{inH}	4	4								9	8	1,16
		6	6								9	8	1,16
		7	7								9	8	1,16
		10									9	8	1,16
		11									9	8	1,16
		12									9	8	1,16
		13	13							9	8	1,16	
	I _{CBO} (1.)	4		4							9	8	1,16
		6		6							9	8	1,16
		7		7							9	8	1,16
		13		13							9	8	1,16
	I _{inL}	10									9	8	1,16
		11									9	8	1,16
		12									9	8	1,16
Output Voltage Logic 1	V _{OH}	2	4								9	5,8	1,16
		3	6								9	5,8	1,16
		2	4								9	8	1,5,16
		3	6								9	8	1,5,16
Output Voltage Logic 0	V _{OL}	2		4							9	5,8	1,16
		3		6							9	5,8	1,16
		2		4							9	8	1,5,16
		3		6							9	8	1,5,16
Threshold Voltage Logic 1	V _{OHA}	2 (2.)	4								9	5,8	1,16
		2	4								9	5,8	1,16
		2	4								9	5,8	1,16
		2		4			4				9	5,8	1,16
		2 (3.)						4			9	8	1,5,16
		2 (4.)							4		9	8	1,5,16
Threshold Voltage Logic 0	V _{OLA}	2 (2.)	4								9	5,8	1,16
		2	4								9	5,8	1,16
		2 (2.)	4								9	5,8	1,16
		2				4					9	5,8	1,16
		2 (3.)						4			9	8	1,5,16
		2 (4.)							4		9	8	1,5,16
Switching Times Propagation Delay			+5.0V	+2.40V	Figure						+7.0V	-3.2V	+2.0V
Data Input	t ₇₊₁₄₊ t ₇₋₁₄₋	14			Figure 3						9	5,8	1,16
		14			Figure 3						9	5,8	1,16
Clock Input	t ₁₁₋₁₄₊ t ₁₁₋₁₄₋	14			Figure 6						9	5,8	1,16
		14			Figure 6						9	5,8	1,16
Strobe Input	t ₁₂₊₁₄₊ t ₁₂₋₁₄₋	14	7		Figure 4						9	5,8	1,16
		14	7		Figure 4						9	5,8	1,16
Reset Input	t ₁₀₊₁₄₋	14	7		Figure 5						9	5,8	1,16
Hysteresis Mode	t ₇₊₁₄₊ t ₇₋₁₄₋	14			Figure 3						9	8	1,5,16
		14			Figure 3						9	8	1,5,16
Setup Time	t _{setup}	14			Figure 7						9	5,8	1,16
Hold Time	t _{hold}	14			Figure 7						9	5,8	1,16
Rise Time	t ₊	14			Figure 3						9	5,8	1,16
Fall Time	t ₋	14			Figure 3						9	5,8	1,16

- Pin 5 to V_{EE}, V_{IL} to Data input one at a time.
- Output latched to logic high state prior to test. V_{IHA'}, V_{ILA'} are standard logic 1 and logic 0 MTTL threshold voltages. V_{IHA''}, V_{ILA''}, V_{IHA'''} and V_{ILA'''} are logic 1 and logic 0 threshold voltages in the hysteresis mode as shown in Figure 1 on page 3-63.
- Input level on data input taken from +0.4V up to voltage level given.
- Input level on data input taken from +4.0V down to voltage level given.
- Operation and limits shown also apply for V_{CC} = +6.0V.
- When testing, choose either TTL or IBM input levels.

Figure 2. SWITCHING TIME TEST CIRCUIT AND WAVEFORMS @ 25°C



NOTE: All power supplies and logic levels are shifted 2 volts positive.

Figure 3 – DATA to OUTPUT
(Clock and Reset are low, Strobe is high)

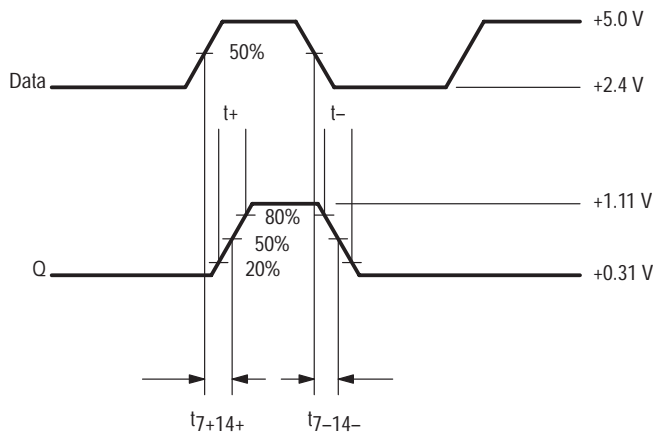


Figure 4 – STROBE to OUTPUT
(Data is high, Clock and Reset are low)

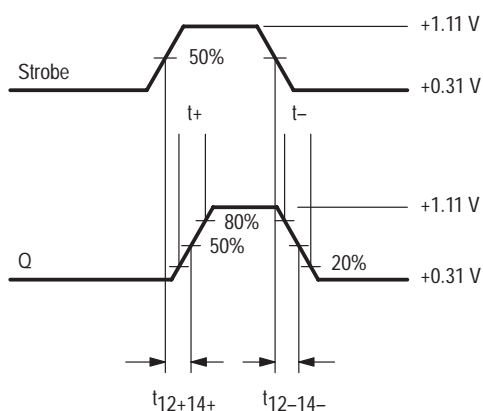


Figure 5 – RESET to OUTPUT
(Data and Strobe are high)

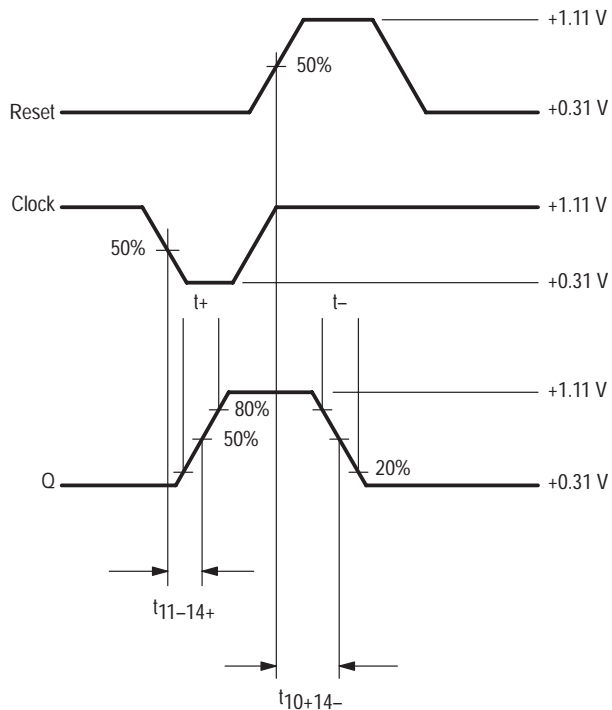


Figure 6 – CLOCK to OUTPUT
(Reset is low, Strobe is high)

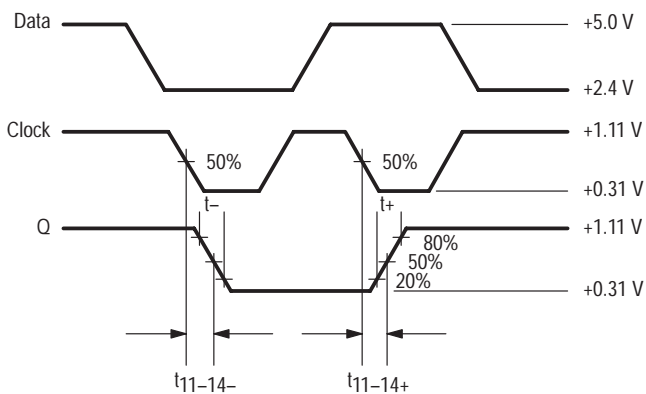
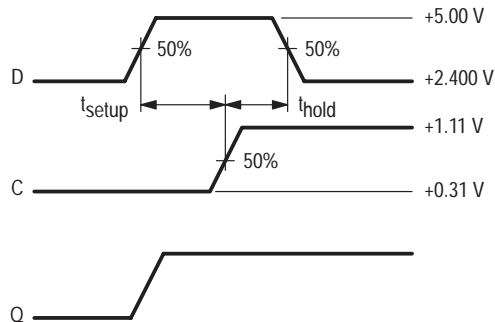


Figure 7 – TSET UP AND THOLD WAVEFORMS

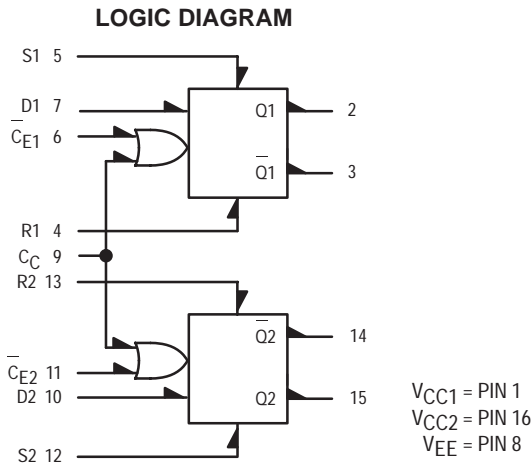


Dual Type D Master-Slave Flip-Flop

The MC10131 is a dual master-slave type D flip-flop. Asynchronous Set (S) and Reset (R) override Clock (C_C) and Clock Enable (C_E) inputs. Each flip-flop may be clocked separately by holding the common clock in the low state and using the enable inputs for the clocking function. If the common clock is to be used to clock the flip-flop, the Clock Enable inputs must be in the low state. In this case, the enable inputs perform the function of controlling the common clock.

The output states of the flip-flop change on the positive transition of the clock. A change in the information present at the data (D) input will not affect the output information at any other time due to master slave construction.

$P_D = 235 \text{ mW typ/pkg (No Load)}$
 $F_{Tog} = 160 \text{ MHz typ}$
 $t_{pd} = 3.0 \text{ ns typ}$
 $t_r, t_f = 2.5 \text{ ns typ (20\%–80\%)}$



MC10131



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

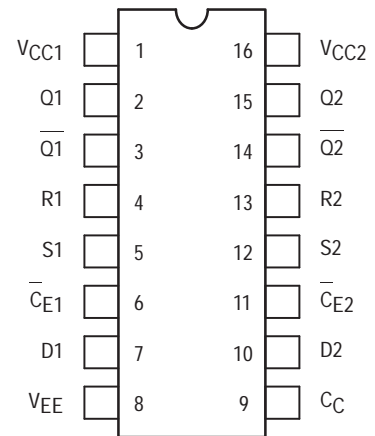


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.

CLOCKED TRUTH TABLE

C	D	Q _{n+1}
L	X	Q _n
H	L	L
H	H	H

C = C_E + C_C. A clock H is a clock transition from a low to a high state.

R-S TRUTH TABLE

R	S	Q _{n+1}
L	L	Q _n
L	H	H
H	L	L
H	H	N.D.

N.D. = Not Defined



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit	
			-30°C		+25°C			+85°C			
			Min	Max	Min	Typ	Max	Min	Max		
Power Supply Drain Current	I_E	8		62		45	56		62	mAdc	
Input Current	I_{inH}	4		525			330		330	μ Adc	
		5		525			330		330		
6			350			220		220			
7			390			245		245			
9			425			265		265			
	I_{inL}	4, 5* 6, 7, 9*	0.5 0.5		0.5 0.5			0.3 0.3		μ Adc	
Output Voltage	Logic 1	V_{OH}	2 2†	-1.060 -1.060	-0.890 -0.890	-0.960 -0.960		-0.810 -0.810	-0.890 -0.890	-0.700 -0.700	Vdc
Output Voltage	Logic 0	V_{OL}	2 3†	-1.890 -1.890	-1.675 -1.675	-1.850 -1.850		-1.650 -1.650	-1.825 -1.825	-1.615 -1.615	Vdc
Threshold Voltage	Logic 1	V_{OHA}	2 2†	-1.080 -1.080		-0.980 -0.980			-0.910 -0.910		Vdc
Threshold Voltage	Logic 0	V_{OLA}	2 3†		-1.655 -1.655			-1.630 -1.630		-1.595 -1.595	Vdc
Switching Times (50Ω Load) Clock Input											ns
Propagation Delay	t_{g+2-} t_{g+2+} t_{6+2+} t_{6+2-}	2	1.7	4.6	1.8	3.0	4.5	1.8	5.0		
		2	1.7	4.6	1.8	3.0	4.5	1.8	5.0		
		2	1.7	4.6	1.8	3.0	4.5	1.8	5.0		
		2	1.7	4.6	1.8	3.0	4.5	1.8	5.0		
Rise Time (20 to 80%)	t_{2+}	2	1.0	4.6	1.1	2.5	4.5	1.1	4.9		
Fall Time (20 to 80%)	t_{2-}	2	1.0	4.6	1.1	2.5	4.5	1.1	4.9		
Set Input											ns
Propagation Delay	t_{5+2+} t_{12+15+} t_{5+3-} t_{12+14-}	2	1.7	4.4	1.8	2.8	4.3	1.8	4.8		
		15	1.7	4.4	1.8	2.8	4.3	1.8	4.8		
		3	1.7	4.4	1.8	2.8	4.3	1.8	4.8		
		14	1.7	4.4	1.8	2.8	4.3	1.8	4.8		
Reset Input											ns
Propagation Delay	t_{4+2-} t_{13+15-} t_{4+3-} t_{13+14+}	2	1.7	4.4	1.8	2.8	4.3	1.8	4.8		
		15	1.7	4.4	1.8	2.8	4.3	1.8	4.8		
		3	1.7	4.4	1.8	2.8	4.3	1.8	4.8		
		14	1.7	4.4	1.8	2.8	4.3	1.8	4.8		
Setup Time	t_{setup}	7	2.5		2.5			2.5		ns	
Hold Time	t_{hold}	7	1.5		1.5			1.5		ns	
Toggle Frequency (Max)	f_{tog}	2	125		125	160		125		MHz	

* Individually test each input applying V_{IH} or V_{IL} to input under test.


† Output level to be measured after a clock pulse has been applied to the C_E Input (Pin 6)



ELECTRICAL CHARACTERISTICS (continued)

@ Test Temperature			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2	
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2	
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2	
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
Power Supply Drain Current	I _E	8					8	1, 16
Input Current	I _{inH}	4	4				8	1, 16
		5	5				8	1, 16
		6	6				8	1, 16
		7	7				8	1, 16
		9	9				8	1, 16
	I _{inL}	4, 5* 6, 7, 9*		*			8	1, 16
Output Voltage	Logic 1	V _{OH}	2	5			8	1, 16
			2†	7			8	1, 16
Output Voltage	Logic 0	V _{OL}	2	5			8	1, 16
			3†	7			8	1, 16
Threshold Voltage	Logic 1	V _{OHA}	2		5		8	1, 16
			2†		7	9	8	1, 16
Threshold Voltage	Logic 0	V _{OLA}	2		5		8	1, 16
			3†		7	9	8	1, 16
Switching Times (50Ω Load)			+1.11Vdc		Pulse In	Pulse Out	-3.2 V	+2.0 V
Clock Input Propagation Delay	t _{g+2-} t _{g+2+} t ₆₊₂₊ t ₆₊₂₋	2			9	2	8	1, 16
		2	7		9	2	8	1, 16
		2	7		6	2	8	1, 16
		2			6	2	8	1, 16
		2			6	2	8	1, 16
Rise Time (20 to 80%)	t ₂₊	2	7		9	2	8	1, 16
Fall Time (20 to 80%)	t ₂₋	2			9	2	8	1, 16
Set Input Propagation Delay	t ₅₊₂₊ t ₁₂₊₁₅₊ t ₅₊₃₋ t ₁₂₊₁₄₋	2			5	2	8	1, 16
		15	6		12	15	8	1, 16
		3			5	3	8	1, 16
		14	9		12	14	8	1, 16
Reset Input Propagation Delay	t ₄₊₂₋ t ₁₃₊₁₅₋ t ₄₊₃₋ t ₁₃₊₁₄₊	2			4	2	8	1, 16
		15	6		13	15	8	1, 16
		3			4	3	8	1, 16
		14	9		13	14	8	1, 16
Setup Time	t _{setup}	7			6, 7	2	8	1, 16
Hold Time	t _{hold}	7			6, 7	2	8	1, 16
Toggle Frequency (Max)	f _{tog}	2			6	2	8	1, 16

* Individually test each input applying V_{IH} or V_{IL} to input under test.

† Output level to be measured after a clock pulse has been applied to the C_E Input (Pin 6) 

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

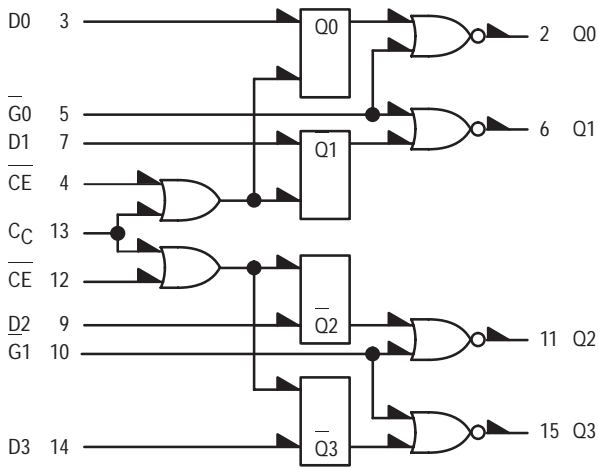
Quad Latch

The MC10133 is a high speed, low power, quad latch consisting of four bistable latch circuits with D type inputs and gated Q outputs, allowing direct wiring to a bus. When the clock is high, outputs will follow D inputs. Information is latched on the negative going transition of the clock.

The outputs are gated when the output enable (\overline{G}) is low. All four latches may be clocked at one time with the common clock (C_C), or each half may be clocked separately with its clock enable (C_E).

$P_D = 310$ mW typ/pkg (No Load)
 $t_{pd} = 4.0$ ns typ
 $t_r, t_f = 2.0$ ns typ (20%–80%)

LOGIC DIAGRAM



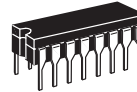
TRUTH TABLE

\overline{G}	C	D	Q_{n+1}
H	X	X	L
L	L	X	Q_n
L	H	L	L
L	H	H	H

$C = C_C + C_E$

$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

MC10133

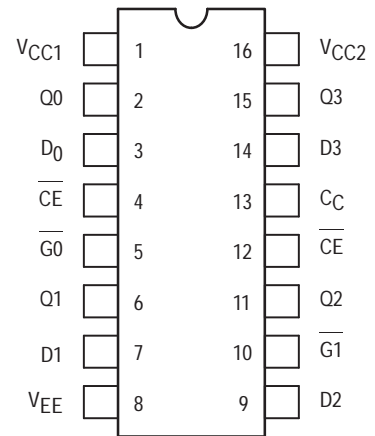


L SUFFIX
CERAMIC PACKAGE
CASE 620-10




P SUFFIX
PLASTIC PACKAGE
CASE 648-08

DIP PIN ASSIGNMENT



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit	
			-30°C		+25°C			+85°C			
			Min	Max	Min	Typ	Max	Min	Max		
Power Supply Drain Current	I _E	8		82			75		82	mAdc	
Input Current	I _{inH}	3		390			245		245	μAdc	
		4		425			265		265		
5			560			350		350			
13			560			350		350			
	I _{inL}	3	0.5		0.5			0.3		μAdc	
Output Voltage Logic 1	V _{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc	
		2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700		
Output Voltage Logic 0	V _{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc	
		2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615		
		2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615		
Threshold Voltage Logic 1	V _{OHA}	2	-1.080		-0.980			-0.910		Vdc	
		2	-1.080		-0.980			-0.910			
		2	-1.080		-0.980			-0.910			
		2†	-1.080		-0.980			-0.910			
		2‡	-1.080		-0.980			-0.910			
		2‡	-1.080		-0.980			-0.910			
		2	-1.080		-0.980			-0.910			
2	-1.080		-0.980			-0.910					
Threshold Voltage Logic 0	V _{OLA}	2		-1.655			-1.630		-1.595	Vdc	
		2		-1.655			-1.630		-1.595		
		2		-1.655			-1.630		-1.595		
		2†		-1.655			-1.630		-1.595		
		2‡		-1.655			-1.630		-1.595		
		2‡		-1.655			-1.630		-1.595		
Switching Times (50Ω Load)	Propagation Delay	t ₃₊₂₊	2	1.0	5.6	1.0	4.0	5.4	1.1	5.9	ns
		t ₄₊₂₊	2	1.0	5.4	1.0	4.0	5.4	1.2	6.0	
		t ₅₋₂₊	2	1.0	3.2	1.0	2.0	3.1	1.0	3.4	
		t _{setup}	3	2.5		2.5	0.7		2.5		
		t _{hold}	3	1.5		1.5	0.7		1.5		
		Rise Time (20 to 80%)	t ₂₊	2	1.0	3.6	1.1	2.0	3.5	1.1	
Fall Time (20 to 80%)	t ₂₋	2	1.0	3.6	1.1	2.0	3.5	1.1	3.8		

† Output level to be measured after a clock pulse has been applied to the clock input (Pin 4) 

‡ Data input at proper high/low level while clock pulse is high so that device latches at proper high/low level for test. Levels are measured after device has latched.

* Latch set to zero state before test.

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					V_{CC} Gnd								
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}									
@ Test Temperature																
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2									
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2									
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2									
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW													
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}									
Power Supply Drain Current	I_E	8		13			8	1, 16								
Input Current	I_{inH}	3	3				8	1, 16								
		4	4				8	1, 16								
5		5				8	1, 16									
13		13				8	1, 16									
	I_{inL}	3		3			8	1, 16								
Output Voltage	Logic 1	V_{OH}	2	3, 4			8	1, 16								
			2	3, 13			8	1, 16								
Output Voltage	Logic 0	V_{OL}	2	13	3		8	1, 16								
			2	3, 5, 13			8	1, 16								
			2	4	3		8	1, 16								
Threshold Voltage	Logic 1	V_{OHA}	2	3, 4			8	1, 16								
			2	4			8	1, 16								
			2	3, 4	3	5	8	1, 16								
			2†	3			8	1, 16								
			2‡				8	1, 16								
			2‡			4	8	1, 16								
			2‡	3	4		8	1, 16								
			3	13		8	1, 16									
Threshold Voltage	Logic 0	V_{OLA}	2	3, 4	5		8	1, 16								
			2	4			8	1, 16								
			2	4		3	8	1, 16								
			2†				8	1, 16								
			2‡	3			8	1, 16								
			2‡	3		13	8	1, 16								
Switching Times (50Ω Load)			+1.11V		Pulse In	Pulse Out	-3.2 V	+2.0 V								
									Propagation Delay	t_{3+2+}	2	4	3	2	8	1, 16
										t_{4+2+}	2	3*	4	2	8	1, 16
										t_{5-2+}	2		5	2	8	1, 16
										t_{setup}	3		3	2	8	1, 16
										t_{hold}	3		3	2	8	1, 16
Rise Time	(20 to 80%)	t_{2+}	2	4	3	2	8	1, 16								
Fall Time	(20 to 80%)	t_{2-}	2	4	3	2	8	1, 16								

† Output level to be measured after a clock pulse has been applied to the clock input (Pin 4)



‡ Data input at proper high/low level while clock pulse is high so that device latches at proper high/low level for test. Levels are measured after device has latched.

* Latch set to zero state before test.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Dual Multiplexer With Latch

The MC10134 is a dual multiplexer with clocked D type latches. Each latch may be clocked separately by holding the common clock in the low state, and using the clock enable inputs for the clocking function. If the common clock is to be used to clock the latch, the clock enable (CE) inputs must be in the low state. In this mode, the enable inputs perform the function of controlling the common clock (C_C).

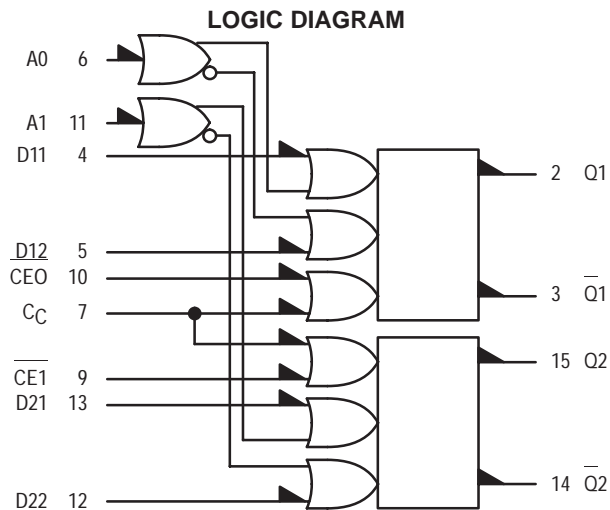
The data select inputs determine which data input is enabled. A high (H) level on the A0 input enables data input D12 and a low (L) level on the A0 input enables data input D11. A high (H) level on the A1 input enables data input D22 and a low (L) level on the A1 input enables data input D21.

Any change on the data input will be reflected at the outputs while the clock is low. The outputs are latched on the positive transition of the clock. While the clock is in the high state, a change in the information present at the data inputs will not affect the output information.

$P_D = 225 \text{ mW typ/pkg (No Load)}$

$t_{pd} = 3.0 \text{ ns typ}$

$t_r, t_f = 2.5 \text{ ns typ (20\%–80\%)}$



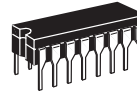
$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

TRUTH TABLE

C	A0	D11	D12	Q_{n+1}
L	L	L	X	L
L	L	H	X	H
L	H	X	L	L
L	H	X	H	H
H	X	X	X	Q_n

$C = C_E + C_C$

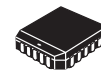
MC10134



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

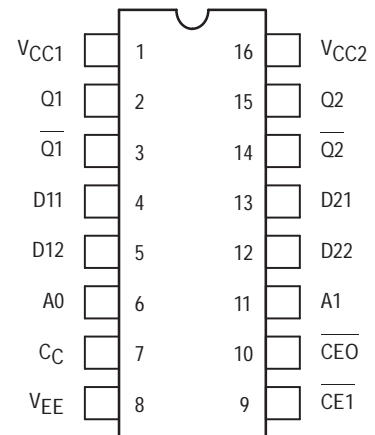


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

**DIP
PIN ASSIGNMENT**



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits						Unit		
			-30°C		+25°C			+85°C			
			Min	Max	Min	Typ	Max	Min		Max	
Power Supply Drain Current	I _E	8		60			55		60	mA _{dc}	
Input Current	I _{inH}	4		460			290		290	μA _{dc}	
		5		460			290		290		
		6		425			265		265		
		7		460			290		290		
		10		425			265		265		
	I _{inL}	4*	0.5		0.5			0.3	μA _{dc}		
Output Voltage Logic 1	V _{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	V _{dc}	
		2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700		
Output Voltage Logic 0	V _{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	V _{dc}	
		2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615		
Threshold Voltage Logic 1	V _{OHA}	2	-1.080		-0.980			-0.910		V _{dc}	
		2	-1.080		-0.980			-0.910			
Threshold Voltage Logic 0	V _{OLA}	2		-1.655			-1.630		-1.595	V _{dc}	
		2		-1.655			-1.630		-1.595		
Switching Times (50Ω Load)											
Propagation Delay	Data	t ₄₊₂₊	2	1.0	3.5	1.0		3.3	1.0	3.6	ns
	Clock	t ₁₀₋₂₊	2	1.0	6.0	1.0		5.7	1.0	6.3	
	Select	t ₆₊₂₊	2	1.0	4.8	1.0		4.6	1.0	5.0	
Setup Time	Data	t _{setup}	2	2.5		2.5			2.5		
	Select	t _{setup}	2	3.5		3.5			3.5		
Hold Time	Data	t _{hold}	2	1.5		1.5			1.5		
	Select	t _{hold}	2	1.0		1.0			1.0		
Rise Time (20 to 80%)		t ₂₊	2	1.5	3.7	1.5		3.5	1.5	3.8	
Fall Time (20 to 80%)		t ₂₋	2	1.5	3.7	1.5		3.5	1.5	3.8	

* All other inputs tested in the same manner.

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					V_{CC} Gnd	
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}		
Power Supply Drain Current	I_E	8					8	1, 16	
Input Current	I_{inH}	4	4				8	1, 16	
		5	5				8	1, 16	
		6	6				8	1, 16	
		7	7						
		10	10						
	I_{inL}	4*		4			8	1, 16	
Output Voltage	Logic 1	V_{OH}	2	4	6,7,10			8	1, 16
			2	5,6	7,10			8	1, 16
Output Voltage	Logic 0	V_{OL}	2		4,6,7,10			8	1, 16
			2	6	5,7,10			8	1, 16
Threshold Voltage	Logic 1	V_{OHA}	2		6,7,10	4		8	1, 16
			2	6	7,10	5		8	1, 16
Threshold Voltage	Logic 0	V_{OLA}	2		6,7,10		4	8	1, 16
			2	6	7,10		5	8	1, 16
Switching Times	(50Ω Load)		+1.11 V	+0.31 V	Pulse In	Pulse Out	-3.2 V	+2.0 V	
Propagation Delay	Data	t_{4+2+}	2		6,7,10	4	2	8	1, 16
	Clock	t_{10-2+}	2	4	7	10	2	8	1, 16
	Select	t_{6+2+}	2	5	7,10	6	2	8	1, 16
Setup Time	Data	t_{setup}	2		6,7	4,10	2	8	1, 16
	Select	t_{setup}	2	5	7,11	6,10	2	8	1, 16
Hold Time	Data	t_{hold}	2		6,7	4,10	2	8	1, 16
	Select	t_{hold}	2	5	7,11	6,10	2	8	1, 16
Rise Time	(20 to 80%)	t_{2+}	2		6,7,10	4	2	8	1, 16
Fall Time	(20 to 80%)	t_{2-}	2		6,7,10	4	2	8	1, 16

* All other inputs tested in the same manner.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Dual J-K Master-Slave Flip-Flop

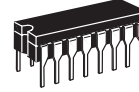
The MC10135 is a dual master-slave dc coupled J-K flip-flop. Asynchronous set (S) and reset (R) are provided. The set and reset inputs override the clock.

A common clock is provided with separate \overline{J} - \overline{K} inputs. When the clock is static, the J-K inputs do not effect the output.

The output states of the flip-flop change on the positive transition of the clock.

$P_D = 280 \text{ mW typ/pkg (No Load)}$
 $f_{Tog} = 140 \text{ MHz typ}$
 $t_{pd} = 3.0 \text{ ns typ}$
 $t_r, t_f = 2.5 \text{ ns typ (20\%–80\%)}$

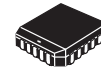
MC10135



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

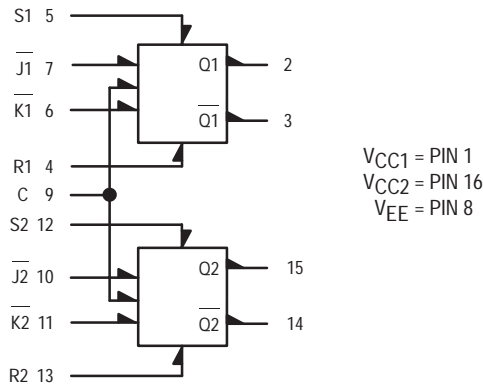


P SUFFIX
PLASTIC PACKAGE
CASE 648-08

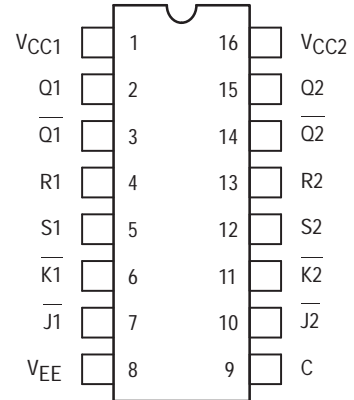


FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM



DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.

R-S TRUTH TABLE

R	S	Q_{n+1}
L	L	Q_n
L	H	H
H	L	L
H	H	N.D.

N.D. = Not Defined

CLOCK J-K TRUTH TABLE*

\overline{J}	\overline{K}	Q_{n+1}
L	L	Q_n
H	L	L
L	H	H
H	H	Q_n

*Output states change on positive transition of clock for J-K input condition present.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I_E	8		75		54	68		75	mAdc
Input Current	I_{inH}	6,7,9,10,11 4,5,12,13		425 620			265 390		265 390	μ Adc
	I_{inL}	4,5,6,7,9, 10,11,12,13	0.5 0.5		0.5 0.5			0.3 0.3		μ Adc
Output Voltage Logic 1	V_{OH}	2 2 (3.)	-1.060 -1.060	-0.890 -0.890	-0.960 -0.960		-0.810 -0.810	-0.890 -0.890	-0.700 -0.700	Vdc
Output Voltage Logic 0	V_{OL}	3 3 (3.)	-1.890 -1.890	-1.675 -1.675	-1.850 -1.850		-1.650 -1.650	-1.825 -1.825	-1.615 -1.615	Vdc
Threshold Voltage Logic 1	V_{OHA}	2 2 (4.)	-1.080 -1.080		-0.980 -0.980			-0.910 -0.910		Vdc
Threshold Voltage Logic 0	V_{OLA}	3 3 (4.)		-1.655 -1.655			-1.630 -1.630		-1.595 -1.595	Vdc
Switching Times (50 Ω Load) Clock Input										ns
Propagation Delay	t_{9+2+}	2	1.8	5.0	1.8	3.0	4.5	1.8	4.6	
	t_{9+2-}	2	1.8	5.0	1.8	3.0	4.5	1.8	4.6	
Rise Time (20 to 80%)	t_{2+}, t_{3+}	2, 3	1.1	4.8	1.1	2.0	4.5	1.1	4.7	
Fall Time (20 to 80%)	t_{2-}, t_{3-}	2, 3	1.1	4.8	1.1	2.0	4.5	1.1	4.7	
Set Input Propagation Delay	t_{5+2+}	2	1.8	5.6	1.8	3.0	5.0	1.8	5.2	
	t_{12+15+}	15	1.8	5.6	1.8	3.0	5.0		5.2	
	t_{5+3-}	3	1.8	5.6	1.8	3.0	5.0		5.2	
	t_{12+14-}	14	1.8	5.6	1.8	3.0	5.0		5.2	
Reset Input Propagation Delay	t_{4+2-}	2	1.8	5.6	1.8	3.0	5.0	1.8	5.2	
	t_{4+3-}	3	1.8	5.6	1.8	3.0	5.0	1.8	5.2	
	t_{13+15-}	15	1.8	5.6	1.8	3.0	5.0	1.8	5.2	
	t_{13+14+}	14	1.8	5.6	1.8	3.0	5.0	1.8	5.2	
Setup Time	t_{setup}	7	2.5		2.5	1.0		2.5		ns
Hold Time	t_{hold}	7	1.5		1.5	1.0		2.5		ns
Toggle Frequency (Max)	f_{tog}	2	125		125	140		125		MHz

1. Individually test each input; apply V_{IHmax} to pin under test.
2. Individually test each input; apply V_{ILmin} to pin under test.

3. Output level to be measured after a clock pulse has been applied to the $\overline{C_E}$ Input (Pin 6)



4. Output level to be measured after a clock pulse has been applied to the $\overline{C_E}$ Input (Pin 6)



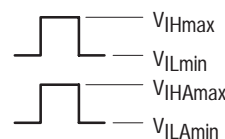
ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)						
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					(V_{CC}) Gnd	
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}		
Power Supply Drain Current	I_E	8					8	1, 16	
Input Current	I_{inH}	6,7,9,10,11 4,5,12,13	Note 1. Note 1.				8 8	1, 16 1, 16	
	I_{inL}	4,5,6,7,9, 10,11,12,13		Note 2. Note 2.			8 8	1, 16 1, 16	
Output Voltage	Logic 1	V_{OH}	2 2 (3.)	5 6			8 8	1, 16 1, 16	
Output Voltage	Logic 0	V_{OL}	3 3 (3.)	5 6			8 8	1, 16 1, 16	
Threshold Voltage	Logic 1	V_{OHA}	2 2 (4.)	6		5	8 8	1, 16 1, 16	
Threshold Voltage	Logic 0	V_{OLA}	3 3 (4.)	6		5	8 8	1, 16 1, 16	
Switching Times (50Ω Load)									
Clock Input						Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	t_{9+2+} t_{9+2-}	2 2				9	2	8	1, 16
						9	2	8	1, 16
Rise Time (20 to 80%)	t_{2+} , t_{3+}	2, 3				9	2, 3	8	1, 16
Fall Time (20 to 80%)	t_{2-} , t_{3-}	2, 3				9	2, 3	8	1, 16
Set Input									
Propagation Delay	t_{5+2+}	2				5	2	8	1, 16
	t_{12+15+}	15				12	15	8	1, 16
	t_{5+3-}	3				5	3	8	1, 16
	t_{12+14-}	14				12	14	8	1, 16
Reset Input									
Propagation Delay	t_{4+2-}	2				4	2	8	1, 16
	t_{4+3-}	3				4	3	8	1, 16
	t_{13+15-}	15				13	15	8	1, 16
	t_{13+14+}	14				13	14	8	1, 16
Setup Time	t_{setup}	7				6, 9	2	8	1, 16
Hold Time	t_{hold}	7				6, 9	2	8	1, 16
Toggle Frequency (Max)	f_{tog}	2				9	2	8	1, 16

1. Individually test each input; apply V_{IHmax} to pin under test.

2. Individually test each input; apply V_{ILmin} to pin under test.

3. Output level to be measured after a clock pulse has been applied to the C_E Input (Pin 6)



4. Output level to be measured after a clock pulse has been applied to the C_E Input (Pin 6)



Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

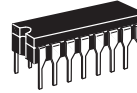
Universal Hexadecimal Counter

The MC10136 is a high speed synchronous counter that can count up, count down, preset, or stop count at frequencies exceeding 100 MHz. The flexibility of this device allows the designer to use one basic counter for most applications, and the synchronous count feature makes the MC10136 suitable for either computers or instrumentation.

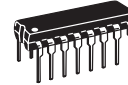
Three control lines (S1, S2, and Carry In) determine the operation mode of the counter. Lines S1 and S2 determine one of four operations; preset (program), increment (count up), decrement (count down), or hold (stop count). Note that in the preset mode a clock pulse is necessary to load the counter, and the information present on the data inputs (D0, D1, D2, and D3) will be entered into the counter. Carry Out goes low on the terminal count, or when the counter is being preset.

This device is not designed for use with gated clocks. Control is via S1 and S2.

MC10136



L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08



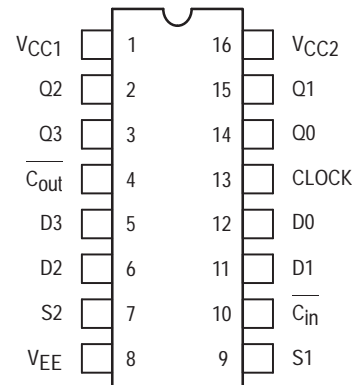
FN SUFFIX
PLCC
CASE 775-02

$P_D = 625 \text{ mW typ/pkg (No Load)}$
 $f_{\text{count}} = 150 \text{ MHz typ}$
 $t_{pd} = 3.3 \text{ ns typ (C-Q)}$
 $7.0 \text{ ns typ (C-C}_{out}\text{)}$
 $5.0 \text{ ns typ (C}_{in}\text{-C}_{out}\text{)}$

FUNCTION TABLE

C _{in}	S1	S2	Operating Mode
X	L	L	Preset (Program)
L	L	H	Increment (Count Up)
H	L	H	Hold Count
L	H	L	Decrement (Count Down)
H	H	L	Hold Count
X	H	H	Hold (Stop Count)

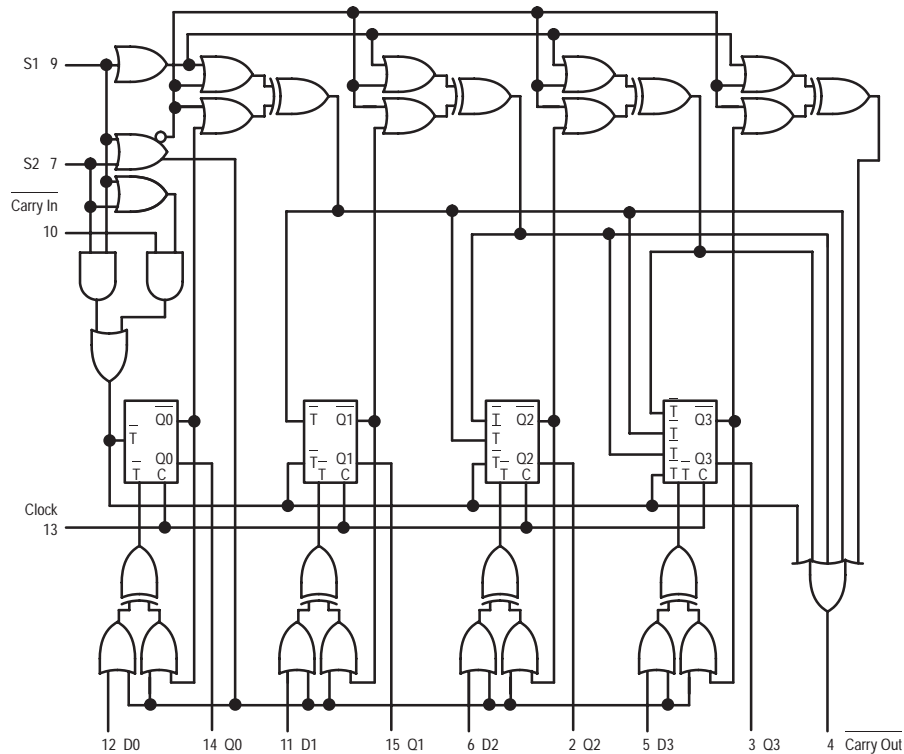
**DIP
PIN ASSIGNMENT**



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



LOGIC DIAGRAM



V_{CC1} = PIN 1
 V_{CC2} = PIN 16
 V_{EE} = PIN 8

NOTE: Flip-flops will toggle when all T inputs are low.

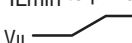
SEQUENTIAL TRUTH TABLE*

INPUTS								OUTPUTS				
S1	S2	D0	D1	D2	D3	Carry In	Clock **	Q0	Q1	Q2	Q3	Carry Out
L	L	L	L	H	H	X	H	L	L	H	H	L
L	H	X	X	X	X	L	H	H	L	H	H	H
L	H	X	X	X	X	L	H	L	H	H	H	H
L	H	X	X	X	X	L	H	H	H	H	H	L
L	H	X	X	X	X	H	L	H	H	H	H	H
L	H	X	X	X	X	H	H	H	H	H	H	H
H	H	X	X	X	X	X	H	H	H	H	H	H
L	L	H	H	L	L	X	H	H	H	L	L	L
H	L	X	X	X	X	L	H	L	H	L	L	H
H	L	X	X	X	X	L	H	H	L	L	L	H
H	L	X	X	X	X	L	H	L	L	L	L	L
H	L	X	X	X	X	L	H	H	H	H	H	H

* Truth table shows logic states assuming inputs vary in sequence shown from top to bottom.
 ** A clock H is defined as a clock input transition from a low to a high logic level.

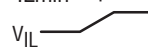
ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits						Unit		
			-30°C		+25°C		+85°C				
			Min	Max	Min	Typ	Max	Min		Max	
Power Supply Drain Current	I_E	8		138		100	125		138	mAdc	
Input Current	I_{inH}	5,6,11,12		350			220		220	μ Adc	
		7		425			265		265		
		9,10		390			245		245		
		13		460			290		290		
	I_{inL}	All	0.5		0.5			0.3		μ Adc	
Output Voltage	Logic 1	V_{OH}	14 (2.)	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
Output Voltage	Logic 0	V_{OL}	14 (2.)	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
Threshold Voltage	Logic 1	V_{OHA}	14 (2.)	-1.080		-0.980			-0.910		Vdc
Threshold Voltage	Logic 0	V_{OLA}	14 (2.)		-1.655			-1.630		-1.595	Vdc
Switching Times (50Ω Load)										ns	
Propagation Delay	Clock Input	t_{13+14+}	14	0.8	4.8	1.0	3.3	4.5	1.4	5.0	
		t_{13+14-}	14	0.8	4.8	1.0	3.3	4.5	1.4	5.0	
		t_{13+4+}	4	2.0	10.9	2.5	7.0	10.5	2.4	11.5	
		t_{13+4-}	4	2.0	10.9	2.5	7.0	10.5	2.4	11.5	
Carry In to Carry Out		t_{10-4-}	4 (3.)	1.6	7.4	1.6	5.0	6.9	1.9	7.5	
		t_{10+4+}	4	1.6	7.4	1.6	5.0	6.9	1.9	7.5	
Setup Time	Data Inputs	t_{12+13+}	14	3.5		3.5			3.5		
		t_{12-13+}	14	3.5		3.5			3.5		
	Select Inputs	t_{9+13+}	14	6.0		6.0			6.0		
		t_{7+13+}	14	6.0		6.0			6.0		
Carry In Input		t_{10-13+}	14	2.5		2.5			3.0		
		t_{10+13+}	14	1.5		1.5			1.5		
Hold Time	Data Inputs	t_{13+12+}	14	0		0			0		
		t_{13+12-}	14	0		0			0		
	Select Inputs	t_{13+9+}	14	-1.0		-1.0			-1.0		
		t_{13+7+}	14	-1.0		-1.0			-1.0		
Carry In Input		t_{13+10-}	14	0		0			0		
		t_{13+10+}	14	0		0			0		
Counting Frequency		$f_{countup}$	14	125		125	150		125		MHz
		$f_{countdown}$	14	125		125	150		125		
Rise Time (20 to 80%)		t_{4+}	4	0.9	3.3	1.1	2.0	3.3	1.1	3.5	ns
		t_{14+}	14	0.9	3.3	1.1	2.0	3.3	1.1	3.5	
Fall Time (20 to 80%)		t_{4-}	4	0.9	3.3	1.1	2.0	3.3	1.1	3.5	ns
		t_{14-}	14	0.9	3.3	1.1	2.0	3.3	1.1	3.5	

1. Individually test each input; apply V_{ILmin} to pin under test.
2. Measure output after clock pulse  V_{IH} appears at clock input (Pin 13).
3. Before test set all Q outputs to a logic high.
4. To preserve reliable performance, the MC10136 (plastic packaged device only) is to be operated in ambient temperatures above 70°C only when 500lfpm blown air or equivalent heat sinking is provided.

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V_{CC}) Gnd	
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}		
Power Supply Drain Current	I_E	8					8	1, 16	
Input Current	I_{inH}	5,6,11,12	5,6,11,12					8	1, 16
		7	7					8	1, 16
		9,10	9,10					8	1, 16
		13	13					8	1, 16
	I_{inL}	All		Note 1.				8	1, 16
Output Voltage	Logic 1	V_{OH}	14 (2.)	12	7, 9			8	1, 16
Output Voltage	Logic 0	V_{OL}	14 (2.)		7, 9			8	1, 16
Threshold Voltage	Logic 1	V_{OHA}	14 (2.)		7, 9	12		8	1, 16
Threshold Voltage	Logic 0	V_{OLA}	14 (2.)		7, 9		12	8	1, 16
Switching Times (50Ω Load)				+1.11V	+0.31V	Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	Clock Input	t_{13+14+}	14	12		13	14	8	1, 16
		t_{13+14-}	14			13	14	8	1, 16
		t_{13+4+}	4	7		13	4	8	1, 16
		t_{13+4-}	4	7		13	4	8	1, 16
Carry In to Carry Out		t_{10-4-}	4 (3.)	7	13	10	4	8	1, 16
		t_{10+4+}	4	7	13	10	4	8	1, 16
Setup Time	Data Inputs	t_{12+13+}	14		7, 9	12, 13	14	8	1, 16
		t_{12-13+}	14		7, 9	12, 13	14	8	1, 16
	Select Inputs	t_{9+13+}	14			9, 13	14	8	1, 16
		t_{7+13+}	14			7, 13	14	8	1, 16
Carry In Inputs		t_{10-13+}	14	7	9	10, 13	14	8	1, 16
		t_{10+13+}	14	7	9	10, 13	14	8	1, 16
Hold Time	Data Inputs	t_{13+12+}	14		7, 9	12, 13	14	8	1, 16
		t_{13+12-}	14		7, 9	12, 13	14	8	1, 16
	Select Inputs	t_{13+9+}	14			9, 13	14	8	1, 16
		t_{13+7+}	14			7, 13	14	8	1, 16
Carry In Inputs		t_{13+10-}	14	7	9	10, 13	14	8	1, 16
		t_{13+10+}	14	7		10, 13	14	8	1, 16
Counting Frequency		$f_{countup}$	14	7		13	14	8	1, 16
		$f_{countdown}$	14	9		13	14	8	1, 16
Rise Time (20 to 80%)		t_{4+}	4	7		13	4	8	1, 16
		t_{14+}	14	7		13	14	8	1, 16
Fall Time (20 to 80%)		t_{4-}	4	7		13	4	8	1, 16
		t_{14-}	14	7		13	14	8	1, 16

1. Individually test each input; apply V_{ILmin} to pin under test.
2. Measure output after clock pulse  V_{IH} appears at clock input (Pin 13).
3. Before test set all Q outputs to a logic high.
4. To preserve reliable performance, the MC10136 (plastic packaged device only) is to be operated in ambient temperatures above 70°C only when 500lfpm blown air or equivalent heat sinking is provided.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

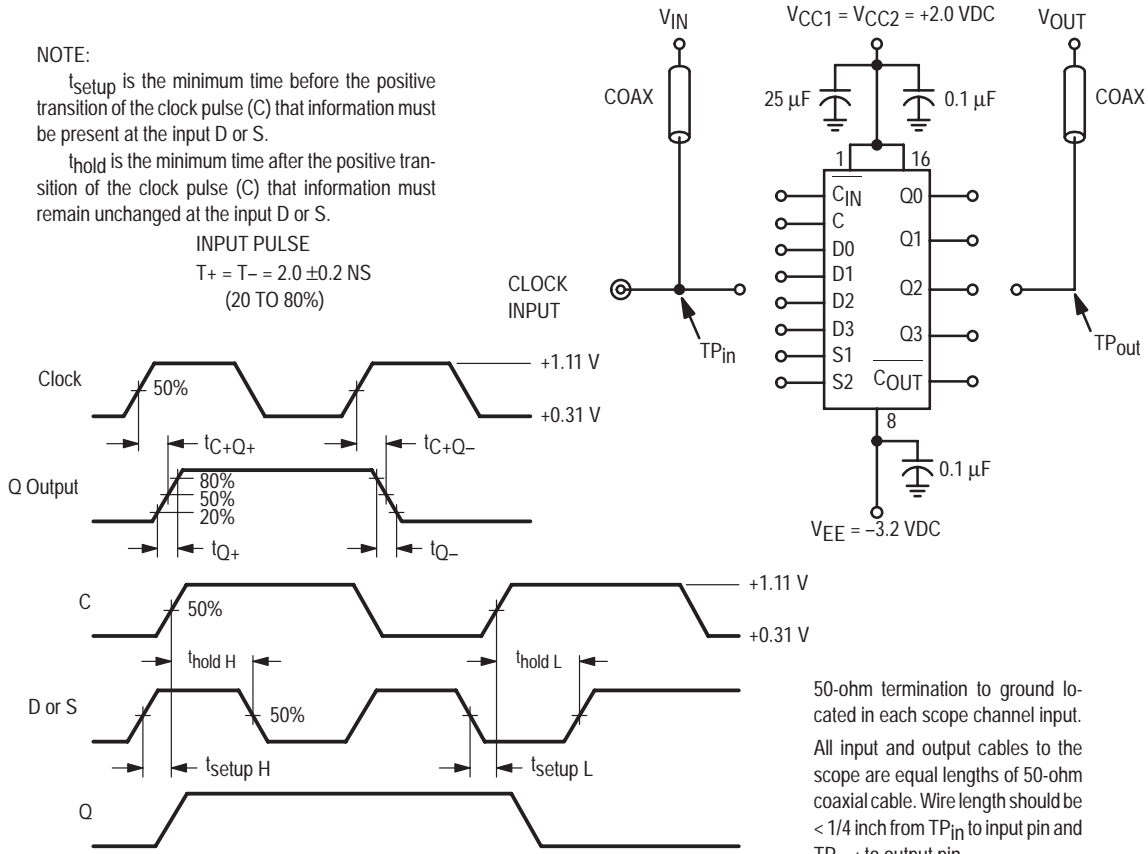
SWITCHING TIME TEST CIRCUIT AND WAVEFORMS @ 25°C

NOTE:

t_{setup} is the minimum time before the positive transition of the clock pulse (C) that information must be present at the input D or S.

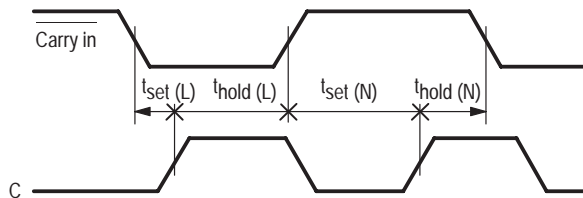
t_{hold} is the minimum time after the positive transition of the clock pulse (C) that information must remain unchanged at the input D or S.

INPUT PULSE
 $T_+ = T_- = 2.0 \pm 0.2$ NS
 (20 TO 80%)



50-ohm termination to ground located in each scope channel input. All input and output cables to the scope are equal lengths of 50-ohm coaxial cable. Wire length should be < 1/4 inch from TP_{in} to input pin and TP_{out} to output pin. Unused outputs are connected to a 50-ohm resistor to ground.

CARRY IN SET UP AND HOLD TIMES



APPLICATIONS INFORMATION

To provide more than four bits of counting capability several MC10136 counters may be cascaded. The Carry In input overrides the clock when the counter is either in the increment mode or the decrement mode of operation. This input allows several devices to be cascaded in a fully synchronous multistage counter as illustrated in Figure 1. The carry is advanced between stages as shown with no external gating. The Carry In of the first device may be left open. The system clock is common to all devices.

The various operational modes of the counter make it useful for a wide variety of applications. If used with MECL III devices, prescalers with input toggle frequencies in excess of 300 MHz are possible. Figure 2 shows such a prescaler using the MC10136 and MC1670. Use of the MC10231 in place of the MC1670 permits 200 MHz operation.

The MC10136 may also be used as a programmable counter. The configuration of Figure 3 requires no additional gates, although maximum frequency is limited to about 50 MHz. The divider modulus is equal to the program input plus one ($M = N + 1$), therefore, the counter will divide by a modulus varying from 1 to 16.

A second programmable configuration is also illustrated in Figure 4. A pulse swallowing technique is used to speed the counter operation up to 110 MHz typically. The divider modulus for this figure is equal to the program input ($M = N$). The minimum modulus is 2 because of the pulse swallowing technique, and the modulus may vary from 2 to 15. This programmable configuration requires an additional gate, such as $1/2$ MC10109 and a flip-flop such as $1/2$ MC10131.

FIGURE 1 — 12 BIT SYNCHRONOUS COUNTER

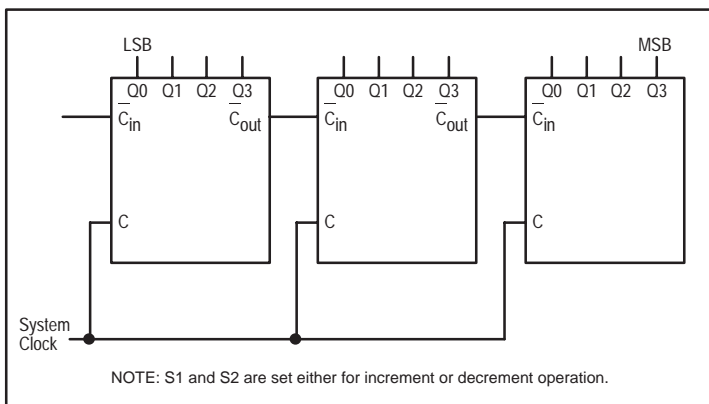


FIGURE 2 — 300 MHz PRESCALER

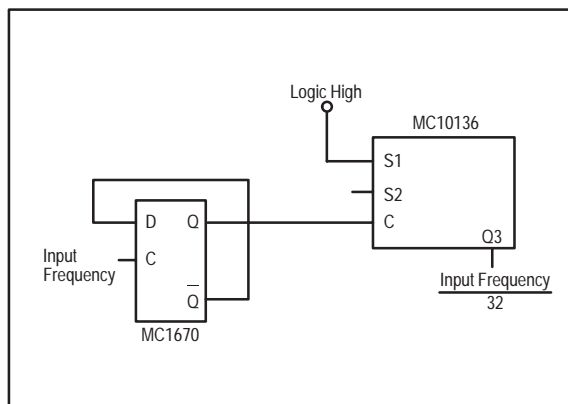


FIGURE 3 — 50 MHz PROGRAMMABLE COUNTER

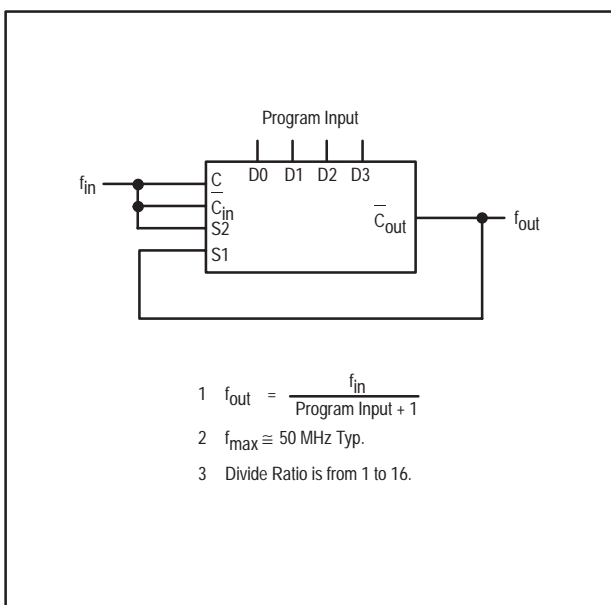
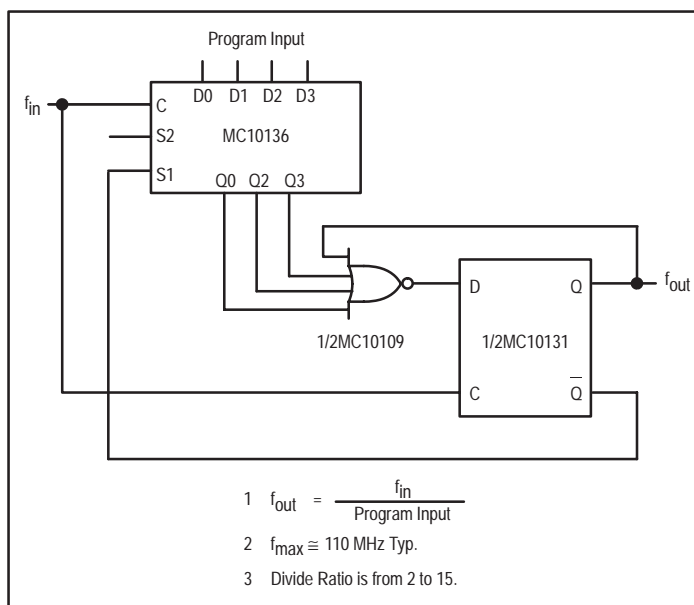


FIGURE 4 — 100 MHz PROGRAMMABLE COUNTER

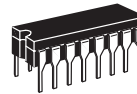


Universal Decade Counter

The MC10137 is a high speed synchronous counter that can count up, down, preset, or stop count at frequencies exceeding 100 MHz. The flexibility of this device allows the designer to use one basic counter for most applications. The synchronous count feature makes the MC10137 suitable for either computers or instrumentation.

Three control lines (S1, S2, and Carry In) determine the operation mode of the counter. Lines S1 and S2 determine one of four operations; preset (program), increment (count up), decrement (count down), or hold (stop count). Note that in the preset mode a clock pulse is necessary to load the counter, and the information present on the data inputs (D0, D1, D2, and D3) will be entered into the counter. Carry Out goes low on the terminal count. The Carry Out on the MC10137 is partially decoded from Q1 and Q2 directly, so in the preset mode the condition of the Carry Out after the Clock's positive excursion will depend on the condition of Q1 and/or Q2. The counter changes state only on the positive going edge of the clock. Any other input may change at any time except during the positive transition of the clock. The sequence for counting out of improper states is as shown in the State Diagrams.

MC10137



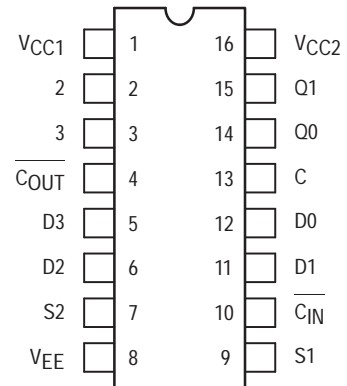
L SUFFIX
CERAMIC PACKAGE
CASE 620-10



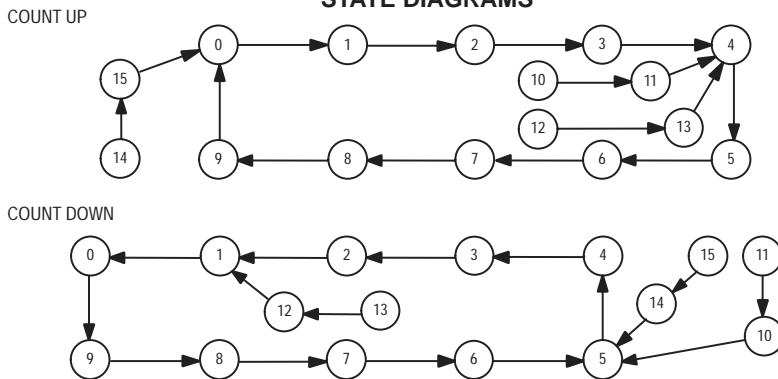
P SUFFIX
PLASTIC PACKAGE
CASE 648-08

$P_D = 625 \text{ mW typ/pkg (No Load)}$
 $f_{\text{count}} = 150 \text{ MHz typ}$
 $t_{pd} = 3.3 \text{ ns typ (C-Q)}$
 $= 7.0 \text{ ns typ (C-C}_{\text{out}})$
 $= 5.0 \text{ ns typ (C}_{\text{in}}\text{-C}_{\text{out}})$

PIN ASSIGNMENT



STATE DIAGRAMS

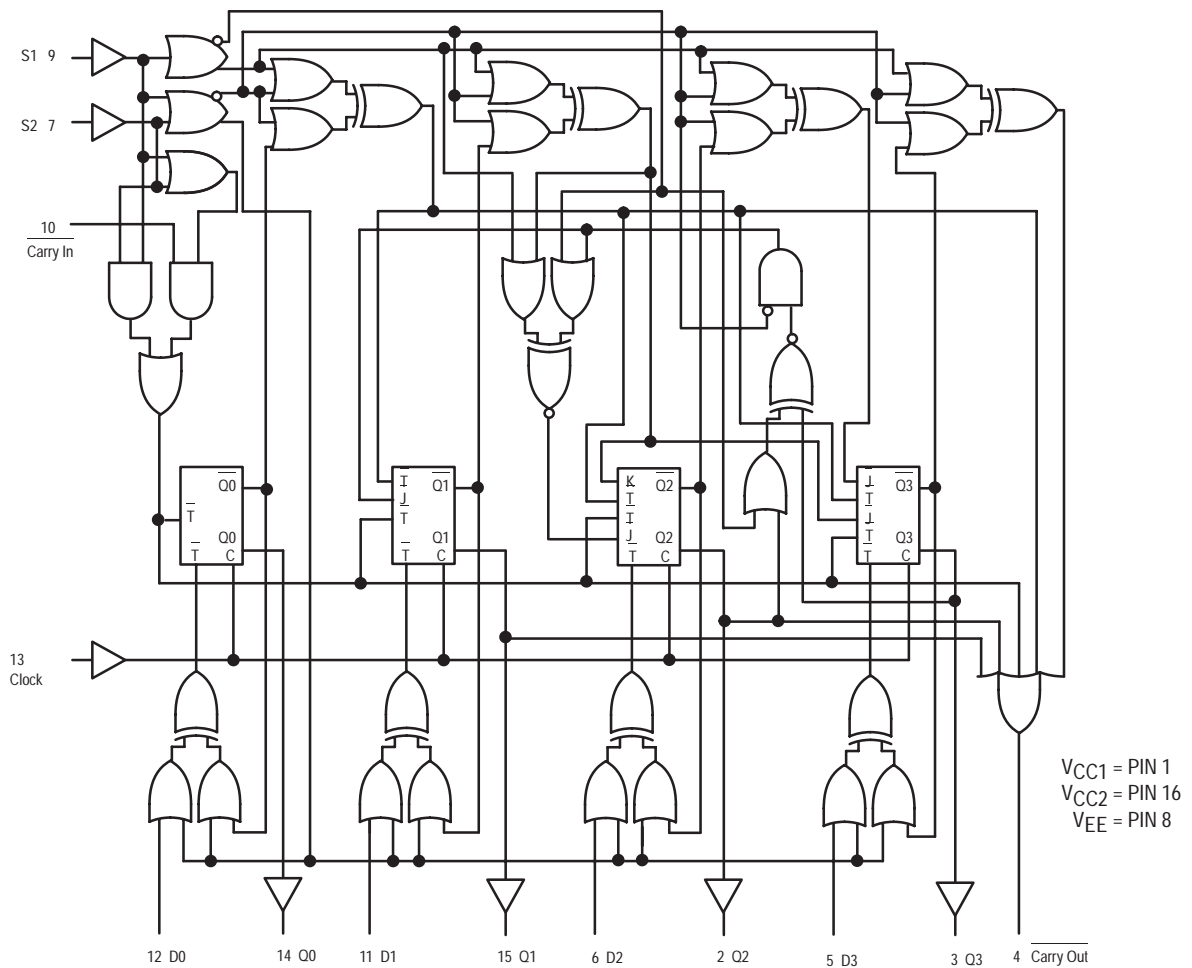


FUNCTION SELECT TABLE

S1	S2	Operating Mode
L	L	Preset (Program)
L	H	Increment (Count Up)
H	L	Decrement (Count Down)
H	H	Hold (Stop Count)



LOGIC DIAGRAM



NOTE: Flip-flops will toggle when all T inputs are low.

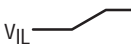
SEQUENTIAL TRUTH TABLE*

INPUTS								OUTPUTS				
S1	S2	D0	D1	D2	D3	Carry In	Clock **	Q0	Q1	Q2	Q3	Carry Out
L	L	H	H	H	L	X	H	H	H	H	L	H
L	H	X	X	X	X	L	H	L	L	L	H	H
L	H	X	X	X	X	L	H	H	L	L	H	L
L	H	X	X	X	X	L	H	L	L	L	L	H
L	H	X	X	X	X	H	L	H	L	L	L	H
L	H	X	X	X	X	H	H	H	L	L	L	H
L	H	X	X	X	X	X	H	H	L	L	L	H
L	L	H	H	L	L	X	H	H	H	L	L	H
H	L	X	X	X	X	L	H	L	H	L	L	H
H	L	X	X	X	X	L	H	H	L	L	L	H
H	L	X	X	X	X	L	H	L	L	L	L	L

* Truth table shows logic states assuming inputs vary in sequence shown from top to bottom.
** A clock H is defined as a clock input transition from a low to a high logic level.

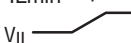
ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits						Unit		
			-30°C		+25°C		+85°C				
			Min	Max	Min	Typ	Max	Min		Max	
Power Supply Drain Current	I_E	8		165		120	150		165	mAdc	
Input Current	I_{inH}	5,6,11,12		350			220		220	μ Adc	
		7		425			265		265		
		9,10		390			245		245		
		13		460			290		290		
	I_{inL}	All	0.5		0.5			0.3		μ Adc	
Output Voltage	Logic 1	V_{OH}	14 (2.)	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
Output Voltage	Logic 0	V_{OL}	14 (2.)	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
Threshold Voltage	Logic 1	V_{OHA}	14 (2.)	-1.080		-0.980			-0.910		Vdc
Threshold Voltage	Logic 0	V_{OLA}	14 (2.)		-1.655			-1.630		-1.595	Vdc
Switching Times (50Ω Load)										ns	
Propagation Delay	Clock Input	t_{13+14+}	14	0.8	4.8	1.0	3.3	4.5	1.1	5.0	
		t_{13+14-}	14	0.8	4.8	1.0	3.3	4.5	1.1	5.0	
		t_{13+4+}	4	2.0	10.9	2.5	7.0	10.5	2.4	11.5	
		t_{13+4-}	4	2.0	10.9	2.5	7.0	10.5	2.4	11.5	
Carry In to Carry Out		t_{10-4-}	4 (3.)	1.6	7.4	1.6	5.0	6.9	1.9	7.5	
		t_{10+4+}	4	1.6	7.4	1.6	5.0	6.9	1.9	7.5	
Setup Time	Data Inputs	t_{12+13+}	14	3.5		3.5			3.5		
		t_{12-13+}	14	3.5		3.5			3.5		
	Select Inputs	t_{9+13+}	14	7.5		7.5			7.5		
		t_{7+13+}	14	7.5		7.5			7.5		
Carry In Input		t_{10-13+}	14	4.5		3.7			4.5		
		t_{13+10+}	14	-1.0		-1.0			-1.0		
Hold Time	Data Inputs	t_{13+12+}	14	0		0			0		
		t_{13+12-}	14	0		0			0		
	Select Inputs	t_{13+9+}	14	-2.5		-2.5			-2.5		
		t_{13+7+}	14	-2.5		-2.5			-2.5		
Carry In Input		t_{13+10-}	14	-1.6		-1.6			-1.6		
		t_{10+13+}	14	4.0		3.1			4.0		
Counting Frequency		$f_{countup}$	14	125		125	150		125		MHz
		$f_{countdown}$	14	125		125	150		125		
Rise Time (20 to 80%)		t_{4+}	4	0.9	3.3	1.1	2.0	3.3	1.1	3.5	ns
		t_{14+}	14	0.9	3.3	1.1	2.0	3.3	1.1	3.5	
Fall Time (20 to 80%)		t_{4-}	4	0.9	3.3	1.1	2.0	3.3	1.1	3.5	ns
		t_{14-}	14	0.9	3.3	1.1	2.0	3.3	1.1	3.5	

1. Individually apply V_{ILmin} to pin under test.
2. Measure output after clock pulse  V_{IH} appears at clock input (Pin 13).
3. Before test set Q1 and Q2 outputs to a logic low.

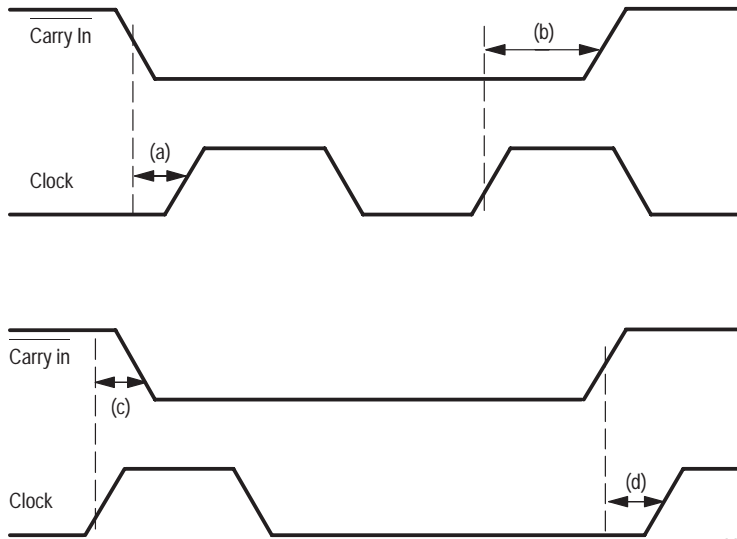
ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)						
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					(V_{CC}) Gnd	
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}		
Power Supply Drain Current	I_E	8					8	1, 16	
Input Current	I_{inH}	5,6,11,12	5,6,11,12				8	1, 16	
		7	7				8	1, 16	
9,10		9,10				8	1, 16		
13		13				8	1, 16		
	I_{inL}	All		Note 1.			8	1, 16	
Output Voltage	Logic 1	V_{OH}	14 (2.)	12	7, 9		8	1, 16	
Output Voltage	Logic 0	V_{OL}	14 (2.)		7, 9		8	1, 16	
Threshold Voltage	Logic 1	V_{OHA}	14 (2.)		7, 9	12	8	1, 16	
Threshold Voltage	Logic 0	V_{OLA}	14 (2.)		7, 9		8	1, 16	
Switching Times	(50Ω Load)			+1.11V	+0.31V	Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	Clock Input	t_{13+14+}	14	12		13	14	8	1, 16
		t_{13+14-}	14			13	14	8	1, 16
		t_{13+4+}	4	7		13	4	8	1, 16
		t_{13+4-}	4	7		13	4	8	1, 16
Carry In to Carry Out		t_{10-4-}	4 (3.)	7	13	10	4	8	1, 16
		t_{10+4+}	4	7	13	10	4	8	1, 16
Setup Time	Data Inputs	t_{12+13+}	14		7, 9	12, 13	14	8	1, 16
		t_{12-13+}	14		7, 9	12, 13	14	8	1, 16
	Select Inputs	t_{9+13+}	14			9, 13	14	8	1, 16
		t_{7+13+}	14			7, 13	14	8	1, 16
Carry In Inputs	t_{10-13+}	14	7	9	10, 13	14	8	1, 16	
	t_{13+10+}	14	7	9	10, 13	14	8	1, 16	
Hold Time	Data Inputs	t_{13+12+}	14		7, 9	12, 13	14	8	1, 16
		t_{13+12-}	14		7, 9	12, 13	14	8	1, 16
	Select Inputs	t_{13+9+}	14			9, 13	14	8	1, 16
		t_{13+7+}	14			7, 13	14	8	1, 16
Carry In Inputs	t_{13+10-}	14	7	9	10, 13	14	8	1, 16	
	t_{10+13+}	14	7	9	10, 13	14	8	1, 16	
Counting Frequency		$f_{countup}$	14	7		13	14	8	1, 16
		$f_{countdown}$	14	9		13	14	8	1, 16
Rise Time	(20 to 80%)	t_{4+}	4	7		13	4	8	1, 16
		t_{14+}	14	7		13	14	8	1, 16
Fall Time	(20 to 80%)	t_{4-}	4	7		13	4	8	1, 16
		t_{14-}	14	7		13	14	8	1, 16

1. Individually test each input; apply V_{ILmin} to pin under test.
2. Measure output after clock pulse V_{IL}  V_{IH} appears at clock input (Pin 13).
3. Before test set all Q outputs to a logic high.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

SWITCHING TIME TEST CIRCUIT AND WAVEFORMS @ 25°C



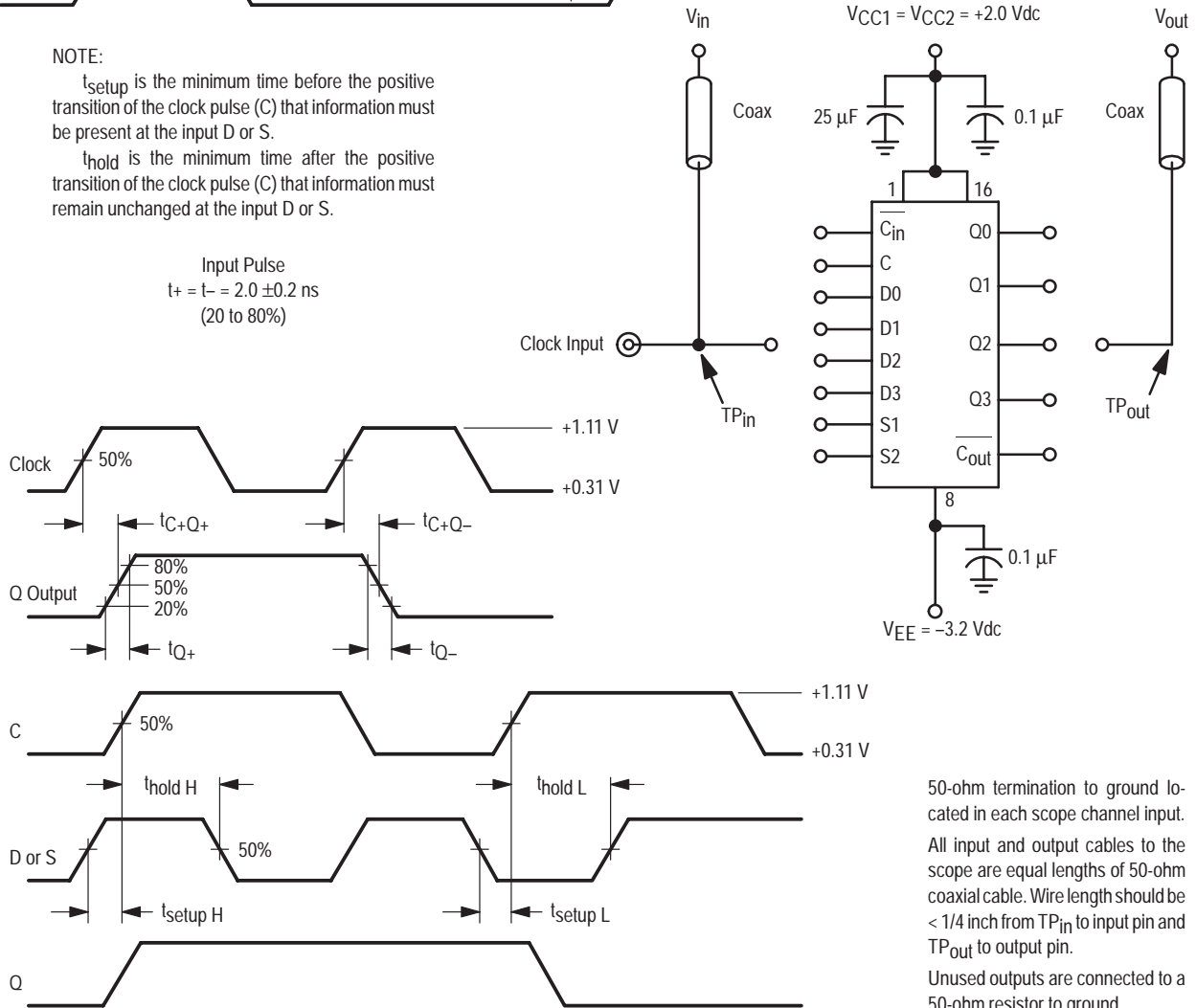
- (a) is the minimum time to wait after the counter has been enabled to clock it.
- (b) is the minimum time before the counter has been disabled that it may be clocked.
- (c) is the minimum time before the counter is enabled that a clock pulse may be applied with no effect on the state of the counter.
- (d) is the minimum time to wait after the counter is disabled that a clock pulse may be applied with no effect in the state of the counter.
- (b) and (c) may be negative numbers.

NOTE:

t_{setup} is the minimum time before the positive transition of the clock pulse (C) that information must be present at the input D or S.

t_{hold} is the minimum time after the positive transition of the clock pulse (C) that information must remain unchanged at the input D or S.

Input Pulse
 $t_+ = t_- = 2.0 \pm 0.2$ ns
 (20 to 80%)



50-ohm termination to ground located in each scope channel input. All input and output cables to the scope are equal lengths of 50-ohm coaxial cable. Wire length should be < 1/4 inch from TP_{in} to input pin and TP_{out} to output pin. Unused outputs are connected to a 50-ohm resistor to ground.

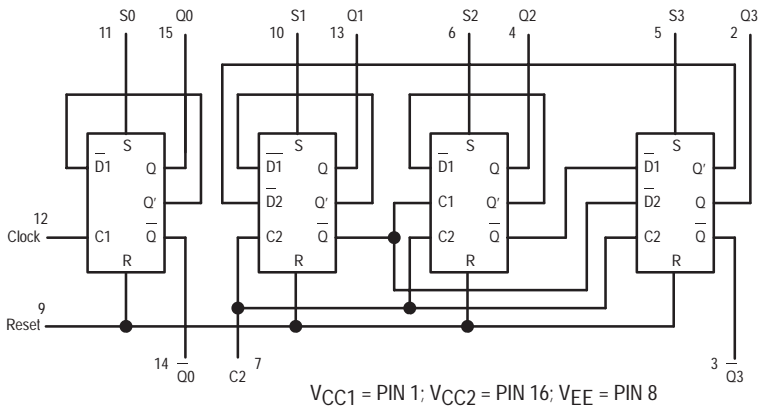
Bi-Quinary Counter

The MC10138 is a four bit counter capable of divide by two, five, or ten functions. It is composed of four set–reset master–slave flip–flops. Clock inputs trigger on the positive going edge of the clock pulse.

Set or reset input override the clock, allowing asynchronous “set” or “clear.” Individual set and common reset inputs are provided, as well as complementary outputs for the first and fourth bits.

$P_D = 370 \text{ mW typ/pkg (No Load)}$
 $f_{\text{tog}} = 150 \text{ MHz typ}$
 $t_r, t_f = 2.5 \text{ ns typ (20\%–80\%)}$

LOGIC DIAGRAM



COUNTER TRUTH TABLES

BI-QUINARY

(Clock connected to C2 and Q3 connected to C1)

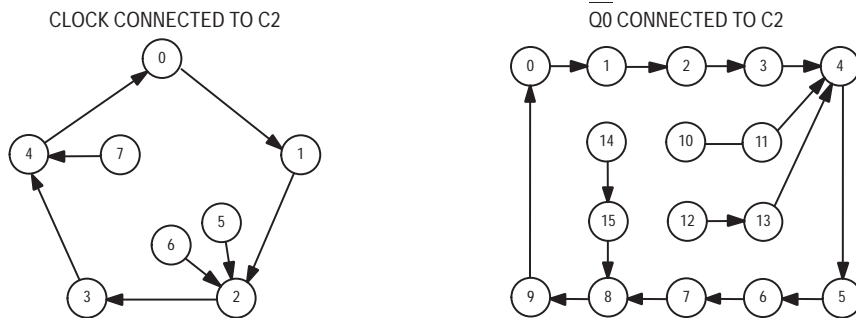
COUNT	Q1	Q2	Q3	Q0
0	L	L	L	L
1	H	L	L	L
2	L	H	L	L
3	H	H	L	L
4	L	L	H	L
5	L	L	L	H
6	H	L	L	H
7	L	H	L	H
8	H	H	L	H
9	L	L	H	H

BCD

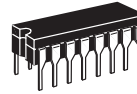
(Clock connected to C1 and Q0 connected to C2)

COUNT	Q0	Q1	Q2	Q3
0	L	L	L	L
1	H	L	L	L
2	L	H	L	L
3	H	H	L	L
4	L	L	H	L
5	H	L	H	L
6	L	L	H	L
7	H	H	H	L
8	L	L	L	H
9	H	L	L	H

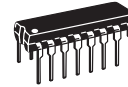
COUNTER STATE DIAGRAM — POSITIVE LOGIC



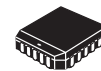
MC10138



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

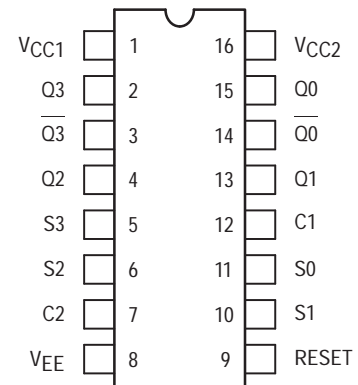


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



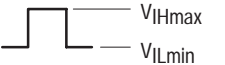
Pin assignment is for Dual-in-Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.




ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit		
			-30°C		+25°C			+85°C				
			Min	Max	Min	Typ	Max	Min	Max			
Power Supply Drain Current	I _E	8		97		70	88		97	mAdc		
Input Current	I _{inH}	12		350			220		220	μAdc		
		5,6,10,11		390			245		245			
		7		460			290		290			
		9		650			410					
	I _{inL}	All	0.5		0.5			0.3		μAdc		
Output Voltage	Logic 1	V _{OH}	3,14 (3.) 2,4,13,15 (2.)	-1.060 -1.060	-0.890 -0.890	-0.960 -0.960		-0.810 -0.810	-0.890 -0.890	-0.700 -0.700	Vdc	
Output Voltage	Logic 0	V _{OL}	3,14 (2.) 2,4,13,15 (3.)	-1.890 -1.890	-1.675 -1.675	-1.850 -1.850		-1.650 -1.650	-1.825 -1.825	-1.615 -1.615	Vdc	
Threshold Voltage	Logic 1	V _{OHA}	2,4,13,15 (2.) 3,14 (3.) 13,15 (2.)	-1.080 -1.080 -1.080		-0.980 -0.980 -0.980			-0.910 -0.910 -0.910		Vdc	
Threshold Voltage	Logic 0	V _{OLA}	2,4,13,15 (3.) 3,14 (2.) 13,15 (3.)		-1.655 -1.655 -1.655			-1.630 -1.630 -1.630		-1.595 -1.595 -1.595	Vdc	
Switching Times (50Ω Load)										ns		
Propagation Delay	Clock Delays	t ₁₂₊₁₅₊	15	1.4	5.0	1.5	3.5	4.8	1.5	5.3		
		t ₁₂₊₁₄₊	14	1.4	5.0	1.5	3.5	4.8	1.5	5.3		
		t ₇₊₁₃₊	13	1.4	5.2	1.5	3.5	5.0	1.5	5.5		
		t ₇₊₄₊	4	1.4	5.2	1.5	3.5	5.0	1.5	5.5		
		t ₇₊₂₊	2	1.4	5.2	1.5	3.5	5.0	1.5	5.5		
		t ₇₊₃₊	3	1.4	5.2	1.5	3.5	5.0	1.5	5.5		
		t ₁₂₊₁₅₋	15	1.4	5.0	1.5	3.5	4.8	1.5	5.3		
		t ₁₂₊₁₄₋	14	1.4	5.0	1.5	3.5	4.8	1.5	5.3		
		t ₇₊₁₃₋	13	1.4	5.2	1.5	3.5	5.0	1.5	5.5		
		t ₇₊₄₋	4	1.4	5.2	1.5	3.5	5.0	1.5	5.5		
		t ₇₊₂₋	2	1.4	5.2	1.5	3.5	5.0	1.5	5.5		
		t ₇₊₃₋	3	1.4	5.2	1.5	3.5	5.0	1.5	5.5		
		Set Delay	t ₁₁₊₁₅₊	15	1.4	5.2	1.5		5.0	1.5		5.5
			t ₁₁₊₁₄₋	14	1.4	5.2	1.5		5.0	1.5		5.5
Reset Delay	t ₉₊₁₄₊	14	1.4	5.2	1.5		5.0	1.5	5.5			
	t ₉₊₁₅₋	15	1.4	5.2	1.5		5.0	1.5	5.5			
Rise Time (20 to 80%)	t ₁₄₊	14	1.1	4.7	1.1	2.5	4.5	1.1	5.0			
	t ₁₅₊	15	1.1	4.7	1.1	2.5	4.5	1.1	5.0			
Fall Time (20 to 80%)	t ₁₄₋	14	1.1	4.7	1.1	2.5	4.5	1.1	5.0			
	t ₁₅₋	15	1.1	4.7	1.1	2.5	4.5	1.1	5.0			
Counting Frequency	f _{count}	2	125		125	150		125		MHz		
		15	125		125	150		125				

1. Individually test each input; apply V_{ILmin} to pin under test.


2. Set all four flip-flops by applying pulse  to pins 5, 6, 10, and 11 prior to applying test voltage indicated.

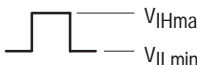
3. Reset all four flip-flops by applying pulse  to pin 9 prior to applying test voltage indicated.

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)								
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}				
NOTE: Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.			@ Test Temperature								
					-30°C	-0.890	-1.890	-1.205	-1.500	-5.2	
					+25°C	-0.810	-1.850	-1.105	-1.475	-5.2	
					+85°C	-0.700	-1.825	-1.035	-1.440	-5.2	
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					(V _{CC}) Gnd			
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}				
Power Supply Drain Current	I _E	8	9				8	1, 16			
Input Current	I _{inH}	12	12				8	1, 16			
		5,6,10,11	5,6,10,11				8	1, 16			
7		7				8	1, 16				
9		9				8	1, 16				
	I _{inL}	All		Note 1.			8	1, 16			
Output Voltage	Logic 1	V _{OH}	3,14 (3.)	9			8	1, 16			
			2,4,13,15 (2.)	5,6,10,11			8	1, 16			
Output Voltage	Logic 0	V _{OL}	3,14 (2.)	5,6,10,11			8	1, 16			
			2,4,13,15 (3.)	9			8	1, 16			
Threshold Voltage	Logic 1	V _{OHA}	2,4,13,15 (2.)			5,6,10,11	8	1, 16			
			3,14 (3.)			9	8	1, 16			
			13,15 (2.)			7,12	8	1, 16			
Threshold Voltage	Logic 0	V _{OLA}	2,4,13,15 (3.)			5,6,10,11	8	1, 16			
			3,14 (2.)			9	8	1, 16			
			13,15 (3.)			7,12	8	1, 16			
Switching Times (50Ω Load)						Pulse In	Pulse Out	-3.2 V	+2.0 V		
Propagation Delay	Clock Delays	t ₁₂₊₁₅₊	15				12	15	8	1, 16	
		t ₁₂₊₁₄₊	14				12	14	8	1, 16	
		t ₇₊₁₃₊	13				7	13	8	1, 16	
		t ₇₊₄₊	4				7	4	8	1, 16	
		t ₇₊₂₊	2				7	2	8	1, 16	
		t ₇₊₃₊	3				7	3	8	1, 16	
		t ₁₂₊₁₅₋	15				12	15	8	1, 16	
		t ₁₂₊₁₄₋	14				12	14	8	1, 16	
		t ₇₊₁₃₋	13				7	13	8	1, 16	
		t ₇₊₄₋	4				7	4	8	1, 16	
		t ₇₊₂₋	2				7	2	8	1, 16	
		t ₇₊₃₋	3				7	3	8	1, 16	
		Set Delay	t ₁₁₊₁₅₊	15				11	15	8	1, 16
			t ₁₁₊₁₄₋	14				11	14	8	1, 16
Reset Delay	t ₉₊₁₄₊	14				9	14	8	1, 16		
	t ₉₊₁₅₋	15				9	15	8	1, 16		
Rise Time (20 to 80%)	t ₁₄₊	14				11	14	8	1, 16		
	t ₁₅₊	15				11	15	8	1, 16		
Fall Time (20 to 80%)	t ₁₄₋	14				9	14	8	1, 16		
	t ₁₅₋	15				9	15	8	1, 16		
Counting Frequency	f _{count}	2				7	2	8	1, 16		
		15				12	15	8	1, 16		

1. Individually test each input; apply V_{ILmin} to pin under test.

2. Set all four flip-flops by applying pulse  to pins 5, 6, 10, and 11 prior to applying test voltage indicated.

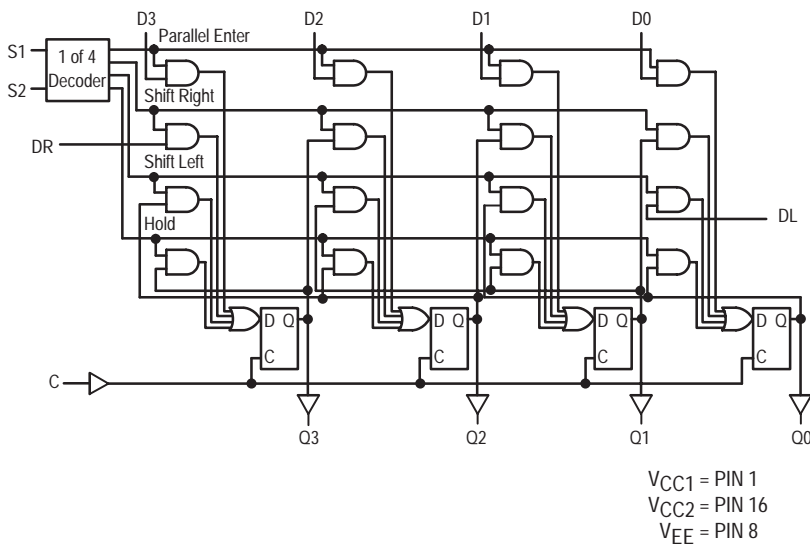
3. Reset all four flip-flops by applying pulse  to pin 9 prior to applying test voltage indicated.

Four Bit Universal Shift Register

The MC10141 is a four-bit universal shift register which performs shift left, or shift right, serial/parallel in, and serial/parallel out operations with no external gating. Inputs S1 and S2 control the four possible operations of the register without external gating of the clock. The flip-flops shift information on the positive edge of the clock. The four operations are stop shift, shift left, shift right, and parallel entry of data. The other six inputs are all data type inputs; four for parallel entry data, and one for shifting in from the left (DL) and one for shifting in from the right (DR).

$P_D = 425 \text{ mW typ/pkg (No Load)}$
 $f_{\text{Shift}} = 200 \text{ MHz typ}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

LOGIC DIAGRAM

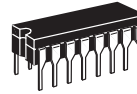


TRUTH TABLE

SELECT		OPERATING MODE	OUTPUTS			
S1	S2		Q0 _{n+1}	Q1 _{n+1}	Q2 _{n+1}	Q3 _{n+1}
L	L	Parallel Entry	D0	D1	D2	D3
L	H	Shift Right*	Q1 _n	Q2 _n	Q3 _n	DR
H	L	Shift Left*	DL	Q0 _n	Q1 _n	Q2 _n
H	H	Stop Shift	Q0 _n	Q1 _n	Q2 _n	Q3 _n

*Outputs as exist after pulse appears at "C" input with input conditions as shown. (Pulse = Positive transition of clock input).

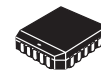
MC10141



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

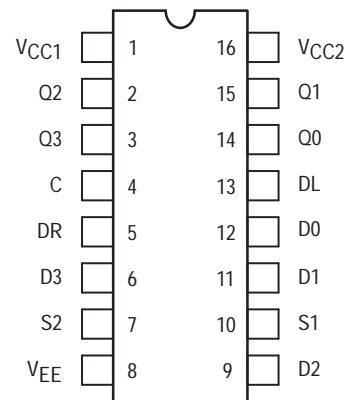


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

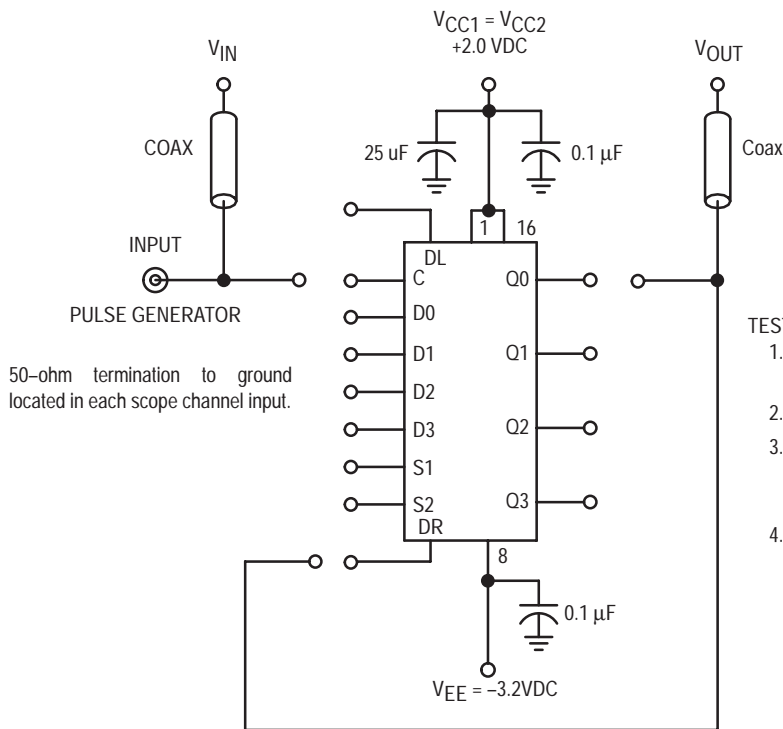
DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.




SHIFT FREQUENCY TEST CIRCUIT



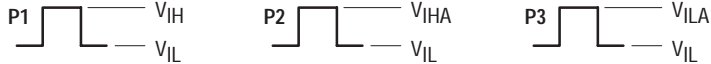
All input and output cables to the scope are equal lengths of 50-ohm coaxial cable. Wire length should be < 1/4 inch from TP_{in} to input pin and TP_{out} to output pin.

TEST PROCEDURES:

1. SET D1, D2, D3 = +0.31 VDC (LOGIC L)
D0 = +1.11 VDC (LOGIC H)
2. APPLY CLOCK PULSE  TO SET Q0 HIGH.
3. MAINTAIN CLOCK LOW.
SET S1 = +0.31 VDC (LOGIC L)
S2 = +1.11 VDC (LOGIC H)
4. TEST SHIFT FREQUENCY

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit	
			-30°C		+25°C			+85°C			
			Min	Max	Min	Typ	Max	Min	Max		
Power Supply Drain Current	I_E	8		112		82	102		112	mAdc	
Input Current	I_{inH}	5		350			220		220	μ Adc	
		6		350			220		220		
7			390			245		245			
4			425			265		265			
	I_{inL}	12	0.5		0.5			0.3		μ Adc	
Output Voltage	Logic 1	V_{OH}	3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
Output Voltage	Logic 0	V_{OL}	3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
Threshold Voltage	Logic 1	V_{OHA} (Note 1.)	3	-1.080		-0.980			-0.910		Vdc
			3	-1.080		-0.980			-0.910		
			3	-1.080		-0.980			-0.910		
			3	-1.080		-0.980			-0.910		
Threshold Voltage	Logic 0	V_{OLA} (Note 1.)	3		-1.655			-1.630		-1.595	Vdc
			3		-1.655			-1.630		-1.595	
			3		-1.655			-1.630		-1.595	
			3		-1.655			-1.630		-1.595	
Switching Times (50 Ω Load)										ns	
Propagation Delay	t_{4+3+}	3	1.7	3.9	1.8	2.9	3.8	2.0	4.2		
Setup Time (t_{setup})	t_{12+4+}	14	2.5		2.5			2.5			
	t_{10+4+}	14	5.5		5.0			5.5			
Hold Time (t_{hold})	t_{4+12+}	14	1.5		1.5			1.5			
	Rise Time (20 to 80%)	t_{3+}	3	1.0	3.4	1.1	2.0	3.3	1.1	3.6	
Fall Time (20 to 80%)	t_{3-}	3	1.0	3.4	1.1	2.0	3.3	1.1	3.6		
Shift Frequency	f_{shift}		150		150	200		150		MHz	

- These tests to be performed in sequence as shown. 
- See shift frequency test circuit for test procedures.
- Reset to zero before performing test.
- Reset to one before performing test.

ELECTRICAL CHARACTERISTICS (continued)

@ Test Temperature			TEST VOLTAGE VALUES (Volts)					P1	P2	P3	(V _{CC}) Gnd	
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmx}	V _{EE}					
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2					
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2					
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2					
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					P1	P2	P3	(V _{CC}) Gnd	
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmx}	V _{EE}					
Power Supply Drain Current	I _E	8					8				1, 16	
Input Current	I _{inH}	5	5				8				1, 16	
		6	6				8				1, 16	
7		7				8				1, 16		
4		4				8					1, 16	
	I _{inL}	12	4,5,6,7,9, 10,11,13	12			8				1, 16	
Output Voltage	Logic 1	V _{OH}	3	6			8	4			1, 16	
Output Voltage	Logic 0	V _{OL}	3				8	4			1, 16	
Threshold Voltage	Logic 1	V _{OHA} (Note 1.)	3			6	7	8	4			1, 16
			3	6	Note 3.			8	4			1, 16
			3	6	Note 3.			8		4		1, 16
			3					8			4	
Threshold Voltage	Logic 0	V _{OLA} (Note 1.)	3				6	8	4			1, 16
			3		Note 4.		7	8	4			1, 16
			3		Note 4.			8		4		1, 16
			3	6				8			4	
Switching Times (50Ω Load)							-3.2 V				+2.0 V	
Propagation Delay	t ₄₊₃₊	3					8				1, 16	
Setup Time (t _{setup})	t ₁₂₊₄₊	14					8				1, 16	
	t ₁₀₊₄₊	14					8				1, 16	
	t ₄₊₁₂₊	14					8				1, 16	
Hold Time (t _{hold})	t ₄₊₁₂₊	14					8				1, 16	
Rise Time (20 to 80%)	t ₃₊	3					8				1, 16	
Fall Time (20 to 80%)	t ₃₋	3					8				1, 16	
Shift Frequency	f _{shift}		Note 2.				8				1, 16	

1. These tests to be performed in sequence as shown. 

2. See shift frequency test circuit for test procedures.
3. Reset to zero before performing test.
4. Reset to one before performing test.

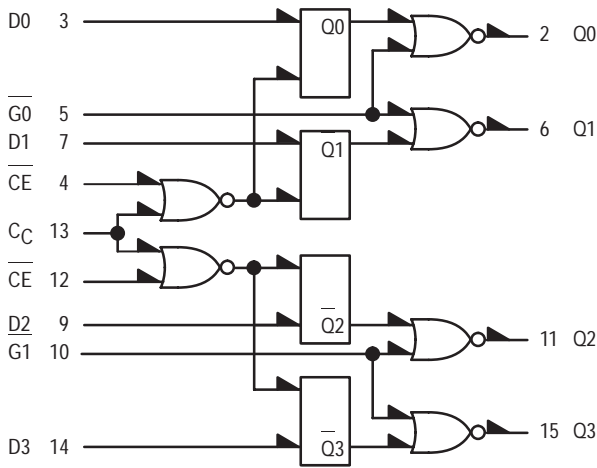
Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Quad Latch

The MC10153 is a high speed, low power, MECL quad latch consisting of four bistable latch circuits with D type inputs and gated Q outputs. Open emitters allow a large number of outputs to be wire-ORed together. Latch outputs are gated, allowing direct wiring to a bus. When the clock is low, outputs will follow D inputs. Information is latched on positive going transition of the clock. The MC10153 provides the same logic function as the MC10133, except for inversion of the clock.

$P_D = 310 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 4.0 \text{ ns typ}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

LOGIC DIAGRAM



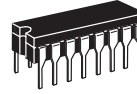
$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

TRUTH TABLE

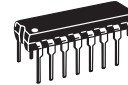
\bar{G}	C	D	Q_{n+1}
H	X	X	L
L	H	X	Q_n
L	L	L	L
L	L	H	H

$C = C_C + CE$

MC10153



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

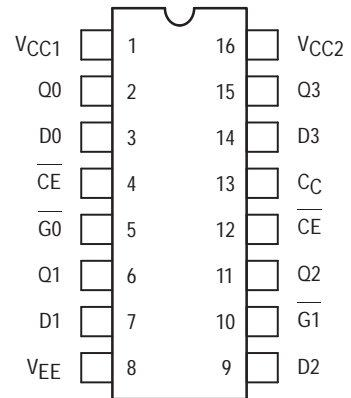


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT




Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit	
			-30°C		+25°C			+85°C			
			Min	Max	Min	Typ	Max	Min	Max		
Power Supply Drain Current	I_E	8		83			75		83	mAdc	
Input Current	I_{inH}	3		390			245		245	μ Adc	
		4		390			245		245		
5			560			350		350			
13			460			290		290			
	I_{inL}	3	0.5		0.5			0.3		μ Adc	
Output Voltage Logic 1	V_{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc	
		2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700		
Output Voltage Logic 0	V_{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc	
		2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615		
		2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615		
Threshold Voltage Logic 1	V_{OHA}	2	-1.080		-0.980			-0.910		Vdc	
		2	-1.080		-0.980			-0.910			
		2	-1.080		-0.980			-0.910			
		2†	-1.080		-0.980			-0.910			
		2‡	-1.080		-0.980			-0.910			
		2‡	-1.080		-0.980			-0.910			
		2	-1.080		-0.980			-0.910			
2	-1.080		-0.980			-0.910					
Threshold Voltage Logic 0	V_{OLA}	2		-1.655			-1.630		-1.595	Vdc	
		2		-1.655			-1.630		-1.595		
		2		-1.655			-1.630		-1.595		
		2†		-1.655			-1.630		-1.595		
		2‡		-1.655			-1.630		-1.595		
		2‡		-1.655			-1.630		-1.595		
Switching Times (50Ω Load)	Propagation Delay	t_{3+2+}	2	1.0	5.6	1.0	4.0	5.4	1.1	5.9	ns
		t_{4-2+}	2	1.0	5.6	1.0	4.0	5.6	1.2	6.2	
		t_{5-2+}	2	1.0	3.2	1.0	2.0	3.1	1.0	3.4	
		t_{setup}	3	2.5		2.5	0.7		2.5		
		t_{hold}	3	1.5		1.5	0.7		1.5		
		Rise Time (20 to 80%)	t_{2+}	2	1.0	3.6	1.1	2.0	3.5	1.1	
Fall Time (20 to 80%)	t_{2-}	2	1.0	3.6	1.1	2.0	3.5	1.1	3.8		


† Output level to be measured after a clock pulse has been applied to the clock input (Pin 4) 

‡ Data input at proper high/low level while clock pulse is high so that device latches at proper high/low level for test. Levels are measured after device has latched.

* Latch set to zero state before test.

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					V_{CC} Gnd
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}	
@ Test Temperature								
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2	
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2	
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2	
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}	
Power Supply Drain Current	I_E	8		13			8	1, 16
Input Current	I_{inH}	3	3				8	1, 16
		4	4				8	1, 16
		5	5				8	1, 16
		13	13				8	1, 16
	I_{inL}	3		3			8	1, 16
Output Voltage Logic 1	V_{OH}	2	3	4			8	1, 16
		2	3	13			8	1, 16
Output Voltage Logic 0	V_{OL}	2		3,13			8	1, 16
		2	3,5	13			8	1, 16
		2		3,4			8	1, 16
Threshold Voltage Logic 1	V_{OHA}	2	3	4		5	8	1, 16
		2		4	3		8	1, 16
		2	3	4			8	1, 16
		2†	3				8	1, 16
		2‡					8	1, 16
		2‡					8	1, 16
		2	3			4	8	1, 16
2	3			13	8	1, 16		
Threshold Voltage Logic 0	V_{OLA}	2	3	4	5		8	1, 16
		2		4		3	8	1, 16
		2		4			8	1, 16
		2†					8	1, 16
		2‡	3				8	1, 16
		2‡	3			13	8	1, 16
Switching Times (50Ω Load)			+1.11 V		Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	t_{3+2+}	2			3	2	8	1, 16
	t_{4-2+}	2	3*		4	2	8	1, 16
	t_{5-2+}	2			5	2	8	1, 16
	t_{setup}	3			3	2	8	1, 16
	t_{hold}	3			3	2	8	1, 16
Rise Time (20 to 80%)	t_{2+}	2			3	2	8	1, 16
Fall Time (20 to 80%)	t_{2-}	2			3	2	8	1, 16

† Output level to be measured after a clock pulse has been applied to the clock input (Pin 4) 

‡ Data input at proper high/low level while clock pulse is high so that device latches at proper high/low level for test. Levels are measured after device has latched.

* Latch set to zero state before test.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

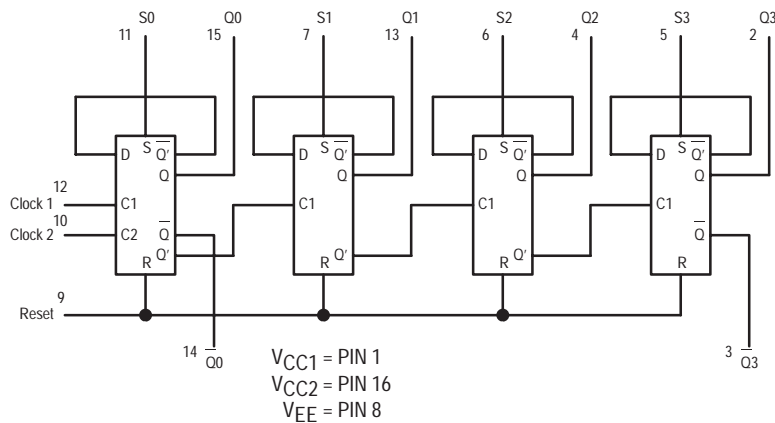
Binary Counter

The MC10154 is a four-bit counter capable of divide-by-two, divide-by-four, divide-by-eight or a divide-by-sixteen function.

Clock inputs trigger on the positive going edge of the clock pulse. Set and Reset inputs override the clock, allowing asynchronous "set" or "clear." Individual Set and common Reset inputs are provided, as well as complementary outputs for the first and fourth bits. True outputs are available at all bits.

$P_D = 370 \text{ mW typ/pkg (No Load)}$
 $f_{\text{toggle}} = 150 \text{ MHz (typ)}$
 $t_{pd} = 3.5 \text{ ns typ (C to } Q_0)$
 $t_{pd} = 11 \text{ ns typ (C to } Q_3)$

LOGIC DIAGRAM

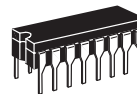


TRUTH TABLE

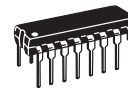
INPUTS							OUTPUTS			
R	S0	S1	S2	S3	C1	C2	Q0	Q1	Q2	Q3
H	L	L	L	L	X	X	L	L	L	L
L	H	H	H	H	X	X	H	H	H	H
L	L	L	L	L	H	X	No Count			
L	L	L	L	L	X	H	No Count			
L	L	L	L	L	*	*	H	H	H	H
L	L	L	L	L	*	*	L	H	H	H
L	L	L	L	L	*	*	H	L	H	H
L	L	L	L	L	*	*	L	L	H	H
L	L	L	L	L	*	*	H	H	L	H
L	L	L	L	L	*	*	L	H	L	H
L	L	L	L	L	*	*	H	L	L	H
L	L	L	L	L	*	*	L	L	L	H
L	L	L	L	L	*	*	H	H	H	L
L	L	L	L	L	*	*	L	H	H	L
L	L	L	L	L	*	*	H	L	H	L
L	L	L	L	L	*	*	L	L	L	L
L	L	L	L	L	*	*	H	H	L	L
L	L	L	L	L	*	*	L	L	L	L
L	L	L	L	L	*	*	H	L	L	L
L	L	L	L	L	*	*	L	L	L	L
L	L	L	L	L	*	*	H	L	L	L
L	L	L	L	L	*	*	L	L	L	L

* Clock transitions from V_{IL} to V_{IH} may be applied to C1 or C2 or both for same effect.

MC10154

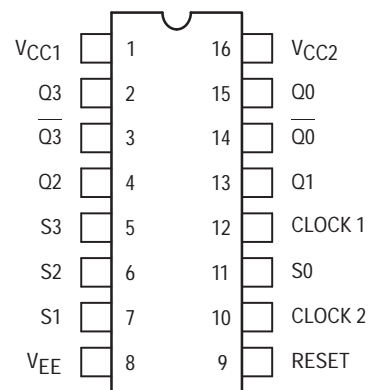


L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08

PIN ASSIGNMENT



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I _E	8		97			88		97	mAdc
Input Current	I _{inH}	12		390			245		245	μAdc
		11		350			220		220	
		9		650			410		410	
	I _{inL}	*	0.5		0.5			0.3		μAdc
Output Voltage Logic 1	V _{OH}	14	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		15	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Output Voltage Logic 0	V _{OL}	14	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		15	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V _{OHA}	3	-1.080		-0.980			-0.910		Vdc
		14	-1.080		-0.980			-0.910		
		15	-1.080		-0.980			-0.910		
Threshold Voltage Logic 0	V _{OLA}	3		-1.655			-1.630		-1.595	Vdc
		14		-1.655			-1.630		-1.595	
		15		-1.655			-1.630		-1.595	
Switching Times (50Ω Load)										ns
Clock Input Propagation Delay	t ₁₂₊₁₅₊ t ₁₂₋₁₃₋ t ₁₂₊₄₋ t ₁₂₋₃₊	15	1.4	5.0	1.5	3.5	4.8	1.5	5.3	
		13	1.9	9.4	2.0	6.0	9.2	2.0	9.8	
		4	2.9	12.3	3.0	8.5	12.0	3.0	12.8	
		3	3.9	14.9	4.0	11.0	14.5	4.0	15.5	
Rise Time (20 to 80%)	t ₁₅₊	15	1.1	4.7	1.1	2.5	4.5	1.1	5.0	
Fall Time (20 to 80%)	t ₁₅₋	15	1.1	4.7	1.1	2.5	4.5	1.1	5.0	
Set Input	t ₁₁₋₁₅₊	15	1.4	5.2	1.5		5.0	1.5	5.5	
Reset Input	t ₉₋₁₅₊	15	1.4	5.2	1.5		5.0	1.5	5.5	
Counting Frequency	f _{count}	15	125		125	150		125		MHz

* Individually test each input applying V_{IL} to input under test.

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					V_{CC} Gnd			
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}				
@ Test Temperature											
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2				
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2				
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2				
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW								
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}				
Power Supply Drain Current	I_E	8	9				8	1, 16			
Input Current	I_{inH}	12	12				8	1, 16			
		11	11				8	1, 16			
9		9				8	1, 16				
	I_{inL}	*		*			8	1, 16			
Output Voltage	Logic 1	V_{OH}	14	9				8	1, 16		
			15	11				8	1, 16		
Output Voltage	Logic 0	V_{OL}	14	11				8	1, 16		
			15	9				8	1, 16		
Threshold Voltage	Logic 1	V_{OHA}	3			5		8	1, 16		
			14			11		8	1, 16		
			15			9		8	1, 16		
Threshold Voltage	Logic 0	V_{OLA}	3				5	8	1, 16		
			14				11	8	1, 16		
			15				9	8	1, 16		
Switching Times (50Ω Load)											
Clock Input Propagation Delay						Pulse In	Pulse Out	-3.2 V	+2.0V		
						t_{12+15+}	15	12	15	8	1, 16
						t_{12-13-}	13	12	13	8	1, 16
						t_{12+4-}	4	12	4	8	1, 16
						t_{12-3+}	3	12	3	8	1, 16
Rise Time (20 to 80%)											
t_{15+}	15	12	15	8	1, 16						
Fall Time (20 to 80%)											
t_{15-}	15	12	15	8	1, 16						
Set Input											
t_{11-15+}	15	11	15	8	1, 16						
Reset Input											
t_{9-15+}	15	9	15	8	1, 16						
Counting Frequency											
f_{count}	15	12	15	8	1, 16						

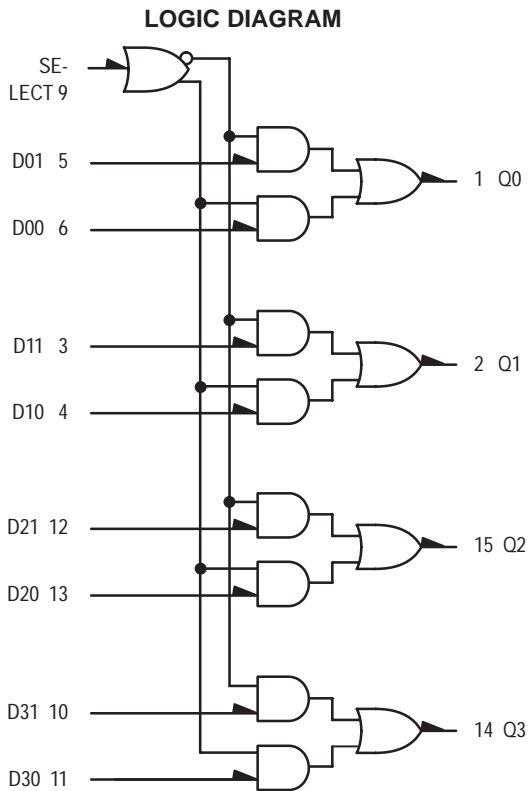
* Individually test each input applying V_{IL} to input under test.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Quad 2-Input Multiplexer (Non-Inverting)

The MC10158 is a quad two channel multiplexer. A common select input determines which data inputs are enabled. A high (H) level enables data inputs D00, D10, D20, and D30 and a low (L) level enables data inputs D01, D11, D21, and D31.

$P_D = 197 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 2.5 \text{ ns typ (Data to Q)}$
 $3.2 \text{ ns typ (Select to Q)}$
 $t_r, t_f = 2.5 \text{ ns typ (20\%–80\%)}$

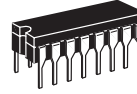


$V_{CC} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

TRUTH TABLE

Select	D0	D1	Q
L	X	L	L
L	X	H	H
H	L	X	L
H	H	X	H

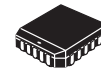
MC10158



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

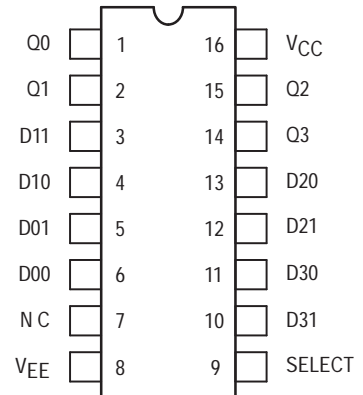


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

**DIP
PIN ASSIGNMENT**



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits						Unit		
			-30°C		+25°C			+85°C			
			Min	Max	Min	Typ	Max	Min		Max	
Power Supply Drain Current	I _E	8		53		38	48		53	mAdc	
Input Current	I _{inH}	9		360			225		225	μAdc	
		5		400			250		250		
	I _{inL}	5	0.5		0.5			0.3		μAdc	
Output Voltage	Logic 1	V _{OH}	1	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
Output Voltage	Logic 0	V _{OL}	1	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
Threshold Voltage	Logic 1	V _{OHA}	1	-1.080		-0.980			-0.910		Vdc
Threshold Voltage	Logic 0	V _{OLA}	1		-1.655			-1.630		-1.595	Vdc
Switching Times (50Ω Load)										ns	
Propagation Delay	Data Input	t ₅₋₁₋	1	1.3	3.1	1.2	2.5	3.0	1.3	3.2	
	Select Input	t ₉₊₁₊	1	2.5	4.8	2.4	3.2	4.5	2.5	4.8	
Rise Time (20 to 80%)		t ₁₊	1	1.6	3.4	1.5	2.5	3.3	1.6	3.4	
Fall Time (20 to 80%)		t ₁₋	1	1.6	3.4	1.5	2.5	3.3	1.6	3.4	

ELECTRICAL CHARACTERISTICS (continued)

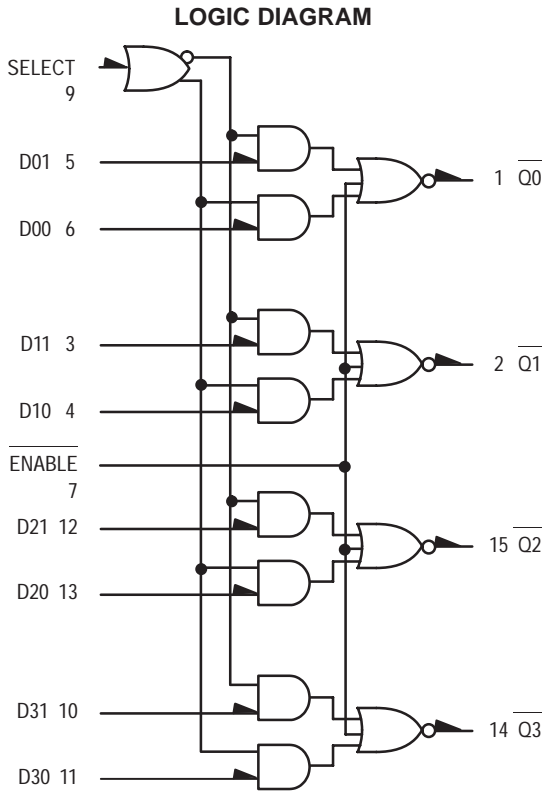
			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd	
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmx}	V _{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmx}	V _{EE}		
Power Supply Drain Current	I _E	8					8	16	
Input Current	I _{inH}	9	9				8	16	
		5	5				8	16	
	I _{inL}	5		5			8	16	
Output Voltage	Logic 1	V _{OH}	1	5			8	16	
Output Voltage	Logic 0	V _{OL}	1				8	16	
Threshold Voltage	Logic 1	V _{OHA}	1			5	8	16	
Threshold Voltage	Logic 0	V _{OLA}	1				5	8	16
Switching Times (50Ω Load)				+1.11V	+0.31V	Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	Data Input	t ₅₋₁₋	1			5	1	8	16
	Select Input	t ₉₊₁₊	1	6		9	1	8	16
Rise Time (20 to 80%)		t ₁₊	1			5	1	8	16
Fall Time (20 to 80%)		t ₁₋	1			5	1	8	16

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Quad 2-Input Multiplexer (Inverting)

The MC10159 is a quad two channel multiplexer with enable. It incorporates common enable and common data select inputs. The select input determines which data inputs are enabled. A high (H) level enables data inputs D00, D10, D20, and D30. A low (L) level enables data inputs D01, D11, D21, and D31. Any change on the data inputs will be reflected at the outputs while the enable is low. Input levels are inverted at the output.

$P_D = 218 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 2.5 \text{ ns typ (Data to Q)}$
 $3.2 \text{ ns typ (Select to Q)}$
 $t_r, t_f = 2.5 \text{ ns typ (20\%–80\%)}$

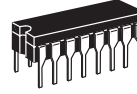


TRUTH TABLE

Enable	Select	D0	D1	Q
L	L	X	L	H
L	L	X	H	L
L	H	L	X	H
L	H	H	X	L
H	X	X	X	L

$V_{CC} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

MC10159



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

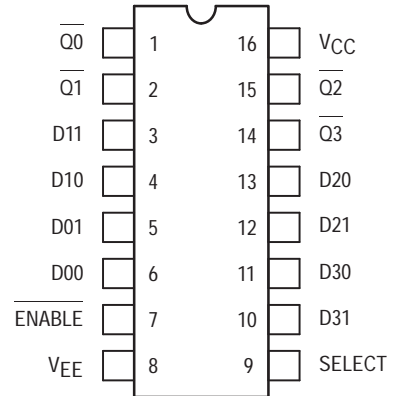


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

**DIP
PIN ASSIGNMENT**



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits						Unit		
			-30°C		+25°C		+85°C				
			Min	Max	Min	Typ	Max	Min		Max	
Power Supply Drain Current	I _E	8		58		42	53		58	mAdc	
Input Current	I _{inH}	9		360			225		225	μAdc	
		5		400			250		250		
	I _{inL}	5	0.5		0.5			0.3		μAdc	
Output Voltage	Logic 1	V _{OH}	1	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
Output Voltage	Logic 0	V _{OL}	1	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
Threshold Voltage	Logic 1	V _{OHA}	1	-1.080		-0.980			-0.910		Vdc
Threshold Voltage	Logic 0	V _{OLA}	1		-1.655			-1.630		-1.595	Vdc
Switching Times (50Ω Load)										ns	
Propagation Delay	Data Input	t ₅₊₁₋	1	1.1	3.8	1.2	2.5	3.3	1.1	3.8	
	Select Input	t ₉₊₁₋	1	1.5	5.3	1.5	3.2	5.0	1.5	5.3	
	Enable Input	t ₇₊₁₋	1	1.4	5.3	1.5	2.5	5.0	1.4	5.3	
Rise Time (20 to 80%)		t ₁₊	1	1.0	3.7	1.1	2.5	3.5	1.0	3.7	
Fall Time (20 to 80%)		t ₁₋	1	1.0	3.7	1.1	2.5	3.5	1.0	3.7	

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd	
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmx}	V _{VEE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmx}	V _{VEE}		
Power Supply Drain Current	I _E	8					8	16	
Input Current	I _{inH}	9	9				8	16	
		5	5				8	16	
	I _{inL}	5		5			8	16	
Output Voltage	Logic 1	V _{OH}	1				8	16	
Output Voltage	Logic 0	V _{OL}	1	5			8	16	
Threshold Voltage	Logic 1	V _{OHA}	1	9		6	8	16	
Threshold Voltage	Logic 0	V _{OLA}	1	9		6	8	16	
Switching Times (50Ω Load)									
Propagation Delay	Data Input	t ₅₊₁₋	1	+1.11V	+0.31V	Pulse In	Pulse Out	-3.2 V	+2.0 V
	Select Input	t ₉₊₁₋	1			5	1	8	16
	Enable Input	t ₇₊₁₋	1			9	1	8	16
Rise Time (20 to 80%)		t ₁₊	1	3, 12		7	1	8	16
Fall Time (20 to 80%)		t ₁₋	1	9		5	1	8	16

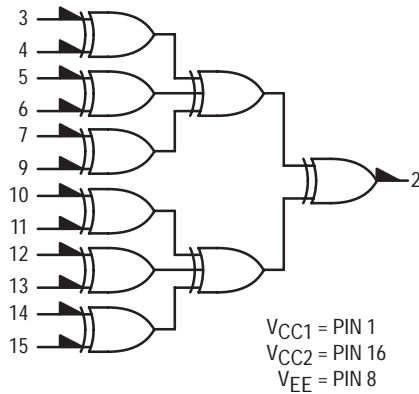
Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

12-Bit Parity Generator-Checker

The MC10160 consists of nine Exclusive-OR gates in a single package, internally connected to provide odd parity checking or generation. Output goes high when an odd number of inputs are high. Unconnected inputs are pulled to low logic levels allowing parity detection and generation for less than 12 bits.

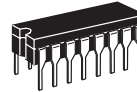
$P_D = 320 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 5.0 \text{ ns typ}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

LOGIC DIAGRAM



INPUT	OUTPUT
Sum of High Level Inputs	Pin 2
Even	Low
Odd	High

MC10160

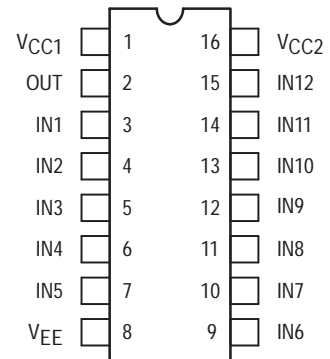


L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08

PIN ASSIGNMENT



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits						Unit		
			-30°C		+25°C			+85°C			
			Min	Max	Min	Typ	Max	Min		Max	
Power Supply Drain Current	I_E	8		86		62	78		86	mAdc	
Input Current	I_{inH} (Note 1.)	3		425			265		265	μ Adc	
		4		350			220		220	μ Adc	
	I_{inL}	3	0.5		0.5			0.3		μ Adc	
Output Voltage	Logic 1	V_{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
Output Voltage	Logic 0	V_{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
Threshold Voltage	Logic 1	V_{OHA}	2	-1.080		-0.980			-0.910		Vdc
Threshold Voltage	Logic 0	V_{OLA}	2		-1.655			-1.630		-1.595	Vdc
Switching Times (50 Ω Load)										ns	
Propagation Delay	t_{3+2+}	2	1.8	8.1	2.0	5.0	7.5	2.0	8.0		
	t_{3+2-}	2	1.8	8.1	2.0	5.0	7.5	2.0	8.0		
	t_{3-2-}	2	1.8	8.1	2.0	5.0	7.5	2.0	8.0		
	t_{3-2+}	2	1.8	8.1	2.0	5.0	7.5	2.0	8.0		
	t_{4+2+}	2	1.8	8.1	2.0	5.0	7.5	2.0	8.0		
	t_{4+2-}	2	1.8	8.1	2.0	5.0	7.5	2.0	8.0		
	t_{4-2-}	2	1.8	8.1	2.0	5.0	7.5	2.0	8.0		
	t_{4-2+}	2	1.8	8.1	2.0	5.0	7.5	2.0	8.0		
Rise Time (20 to 80%)	t_{2+}	2	1.1	3.5	1.1	2.0	3.3	1.0	3.5		
Fall Time (20 to 80%)	t_{2-}	2	1.1	3.5	1.1	2.0	3.3	1.0	3.5		

1. Pins 3, 6, 7, 11, 12, 15 are similar. Pins 4, 5, 9, 10, 13, 14 are similar.

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)						
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					(V _{CC}) Gnd	
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
Power Supply Drain Current	I _E	8	4,5,9,10,13,14				8	1,16	
Input Current	I _{inH} (Note 1.)	3	3				8	1,16	
		4	4				8	1,16	
	I _{inL}	3		3			8	1,16	
Output Voltage	Logic 1	V _{OH}	2	3	4,5,6,7,9,10,11,12,13,14,15			8	1,16
Output Voltage	Logic 0	V _{OL}	2		3,4,5,6,7,9,10,11,12,13,14,15			8	1,16
Threshold Voltage	Logic 1	V _{OHA}	2		4,5,6,7,9,10,11,12,13,14,15	3		8	1,16
Threshold Voltage	Logic 0	V _{OLA}	2		3,5,6,7,9,10,11,12,13,14,15		4	8	1,16
Switching Times (50Ω Load)				+1.11V		Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	t ₃₊₂₊	2				3	2	8	1,16
	t ₃₊₂₋	2		4		3	2	8	1,16
	t ₃₋₂₋	2				3	2	8	1,16
	t ₃₋₂₊	2		4		3	2	8	1,16
	t ₄₊₂₊	2				4	2	8	1,16
	t ₄₊₂₋	2		3		4	2	8	1,16
	t ₄₋₂₋	2				4	2	8	1,16
	t ₄₋₂₊	2		3		4	2	8	1,16
Rise Time (20 to 80%)	t ₂₊	2				3	2	8	1,16
Fall Time (20 to 80%)	t ₂₋	2				3	2	8	1,16

1. Pins 3, 6, 7, 11, 12, 15 are similar. Pins 4, 5, 9, 10, 13, 14 are similar.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

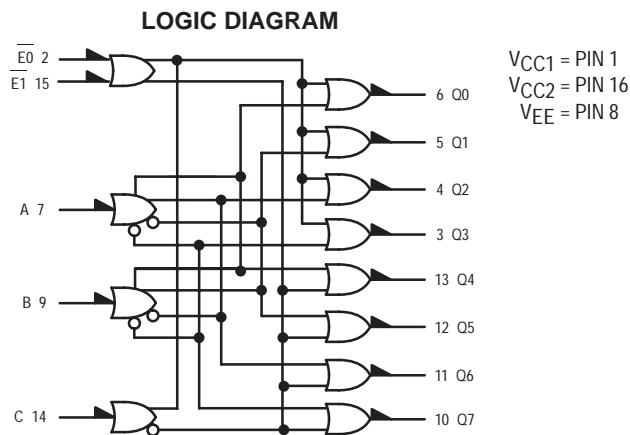
Binary to 1-8 Decoder (Low)

The MC10161 is designed to decode a three bit input word to a one of eight line output. The selected output will be low while all other outputs will be high. The enable inputs, when either or both are high, force all outputs high.

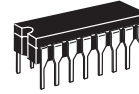
The MC10161 is a true parallel decoder. No series gating is used internally, eliminating unequal delay times found in other decoders. This design provides the identical 4 ns delay from any address or enable input to any output.

A complete mux/demux operation on 16 bits for data distribution is illustrated in Figure 1. This system, using the MC10136 control counters, has the capability of incrementing, decrementing or holding data channels. When both S0 and S1 are low, the index counters reset, thus initializing both the mux and demux units. The four binary outputs of the counter are buffered by the MC10101s to send twisted-pair select data to the multiplexer/demultiplexer to units.

$P_D = 315 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 4.0 \text{ ns typ}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$



MC10161



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

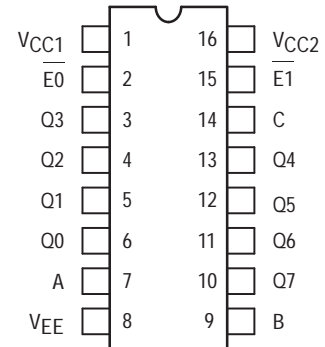


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.

TRUTH TABLE

ENABLE INPUTS		INPUTS			OUTPUTS							
E1	E0	C	B	A	Q0	Q1	Q2	Q3	Q4	Q5	Q6	Q7
L	L	L	L	L	L	H	H	H	H	H	H	H
L	L	L	L	H	H	L	H	H	H	H	H	H
L	L	L	H	L	H	H	L	H	H	H	H	H
L	L	L	H	H	H	H	H	L	H	H	H	H
L	L	H	L	L	H	H	H	H	L	H	H	H
L	L	H	L	H	H	H	H	H	H	L	H	H
L	L	H	H	L	H	H	H	H	H	H	L	H
L	L	H	H	H	H	H	H	H	H	H	H	L
H	X	X	X	X	H	H	H	H	H	H	H	H
X	H	X	X	X	H	H	H	H	H	H	H	H



ELECTRICAL CHARACTERISTICS

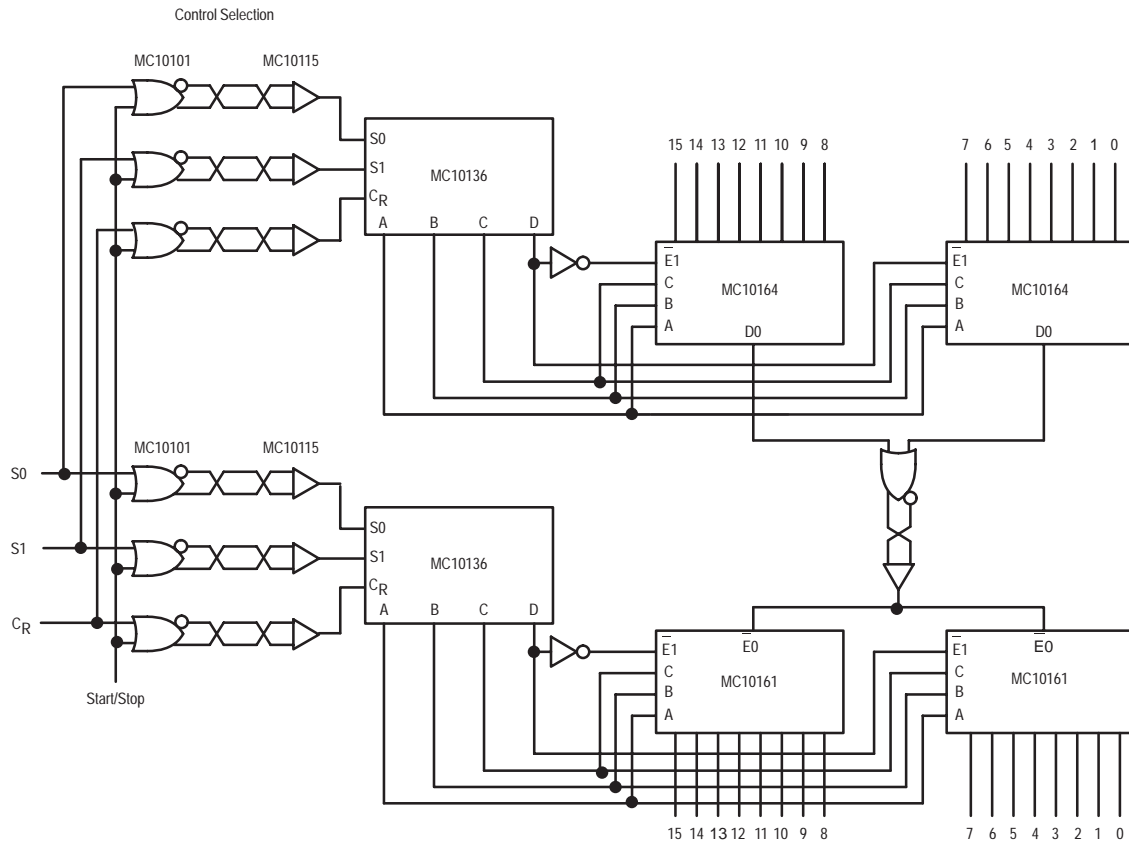
Characteristic	Symbol	Pin Under Test	Test Limits						Unit	
			-30°C		+25°C		+85°C			
			Min	Max	Min	Typ	Max	Min		Max
Power Supply Drain Current	I _E	8		84		61	76		84	mAdc
Input Current	I _{inH}	14		350			220		220	μAdc
	I _{inL}	14	0.5		0.5			0.3		μAdc
Output Voltage Logic 1	V _{OH}	13	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		13	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
Output Voltage Logic 0	V _{OL}	13	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
Threshold Voltage Logic 1	V _{OHA}	13	-1.080		-0.980			-0.910		Vdc
		13	-1.080		-0.980			-0.910		Vdc
Threshold Voltage Logic 0	V _{OLA}	13		-1.655			-1.630		-1.595	Vdc
Switching Times (50Ω Load)										ns
Propagation Delay	t ₁₄₊₁₃₋ t ₁₄₋₁₃₊	13	1.5	6.2	1.5	4.0	6.0	1.5	6.4	
		13	1.5	6.2	1.5	4.0	6.0	1.5	6.4	
Rise Time (20 to 80%)	t ₁₃₊	13	1.0	3.3	1.1	2.0	3.3	1.1	3.5	
Fall Time (20 to 80%)	t ₁₃₋	13	1.0	3.3	1.1	2.0	3.3	1.1	3.5	

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
@ Test Temperature								
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2	
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2	
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2	
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
Power Supply Drain Current	I _E	8	2,7,9,14,15				8	1,16
Input Current	I _{inH}	14	14				8	1,16
	I _{inL}	14		14			8	1,16
Output Voltage Logic 1	V _{OH}	13	2				8	1,16
		13	15				8	1,16
Output Voltage Logic 0	V _{OL}	13	14				8	1,16
Threshold Voltage Logic 1	V _{OHA}	13			2		8	1,16
		13			15		8	1,16
Threshold Voltage Logic 0	V _{OLA}	13			14		8	1,16
Switching Times (50Ω Load)					Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	t ₁₄₊₁₃₋ t ₁₄₋₁₃₊	13			14	13	8	1,16
		13			14	13	8	1,16
Rise Time (20 to 80%)	t ₁₃₊	13			14	13	8	1,16
Fall Time (20 to 80%)	t ₁₃₋	13			14	13	8	1,16

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

FIGURE 1 — HIGH SPEED 16-BIT MULTIPLEXER/DEMULTIPLEXER



Binary to 1-8 Decoder (High)

The MC10162 is designed to convert three lines of input data to a one-of-eight output. The selected output will be high while all other outputs are low. The enable inputs, when either or both are high, force all outputs low.

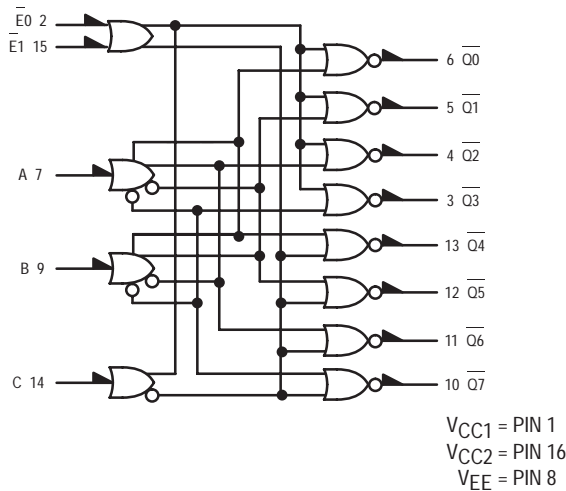
The MC10162 is a true parallel decoder. No series gating is used internally, eliminating unequal delay times found in other decoders.

This device is ideally suited for demultiplexer applications. One of the two enable inputs is used as the data input, while the other is used as a data enable input.

A complete mux/demux operation on 16 bits for data distribution is illustrated in Figure 1 of the MC10161 data sheet.

$P_D = 315 \text{ ns typ/pkg (No Load)}$
 $t_{pd} = 4.0 \text{ ns typ}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

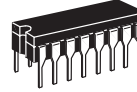
LOGIC DIAGRAM



TRUTH TABLE

INPUTS					OUTPUTS							
$\overline{E0}$	$\overline{E1}$	C	B	A	$\overline{Q0}$	$\overline{Q1}$	$\overline{Q2}$	$\overline{Q3}$	$\overline{Q4}$	$\overline{Q5}$	$\overline{Q6}$	$\overline{Q7}$
L	L	L	L	L	H	L	L	L	L	L	L	L
L	L	L	L	H	L	H	L	L	L	L	L	L
L	L	L	H	L	L	L	H	L	L	L	L	L
L	L	L	H	H	L	L	L	H	L	L	L	L
L	L	H	L	L	L	L	L	L	H	L	L	L
L	L	H	L	H	L	L	L	L	L	H	L	L
L	L	H	H	L	L	L	L	L	L	L	H	L
L	L	H	H	H	L	L	L	L	L	L	L	H
H	X	X	X	X	L	L	L	L	L	L	L	L
X	H	X	X	X	L	L	L	L	L	L	L	L

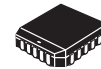
MC10162



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

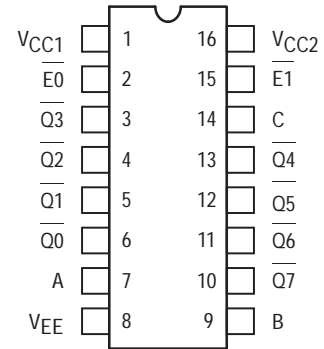


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I_E	8		84		61	76		84	mAdc
Input Current	I_{inH}	14		350			220		220	μ Adc
	I_{inL}	14	0.5		0.5			0.3		μ Adc
Output Voltage Logic 1	V_{OH}	13	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
Output Voltage Logic 0	V_{OL}	13	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		13	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
Threshold Voltage Logic 1	V_{OHA}	13	-1.080		-0.980			-0.910		Vdc
Threshold Voltage Logic 0	V_{OLA}	13		-1.655			-1.630		-1.595	Vdc
		13		-1.655			-1.630		-1.595	Vdc
Switching Times (50 Ω Load)										ns
Propagation Delay	t_{14+13-} t_{14-13+}	13	1.5	6.2	1.5	4.0	6.0	1.5	6.4	
		13	1.5	6.2	1.5	4.0	6.0	1.5	6.4	
Rise Time (20 to 80%)	t_{13+}	13	1.0	3.3	1.1	2.0	3.3	1.1	3.5	
Fall Time (20 to 80%)	t_{13-}	13	1.0	3.3	1.1	2.0	3.3	1.1	3.5	

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
@ Test Temperature								
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2	
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2	
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2	
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
Power Supply Drain Current	I_E	8					8	1,16
Input Current	I_{inH}	14	14				8	1,16
	I_{inL}	14		14			8	1,16
Output Voltage Logic 1	V_{OH}	13	14				8	1,16
Output Voltage Logic 0	V_{OL}	13	2				8	1,16
		13	15				8	1,16
Threshold Voltage Logic 1	V_{OHA}	13			14		8	1,16
Threshold Voltage Logic 0	V_{OLA}	13			2		8	1,16
		13			15		8	1,16
Switching Times (50 Ω Load)					Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	t_{14+13+} t_{14-13-}	13			14	13	8	1,16
		13			14	13	8	1,16
Rise Time (20 to 80%)	t_+	13			14	13	8	1,16
Fall Time (20 to 80%)	t_-	13			14	13	8	1,16

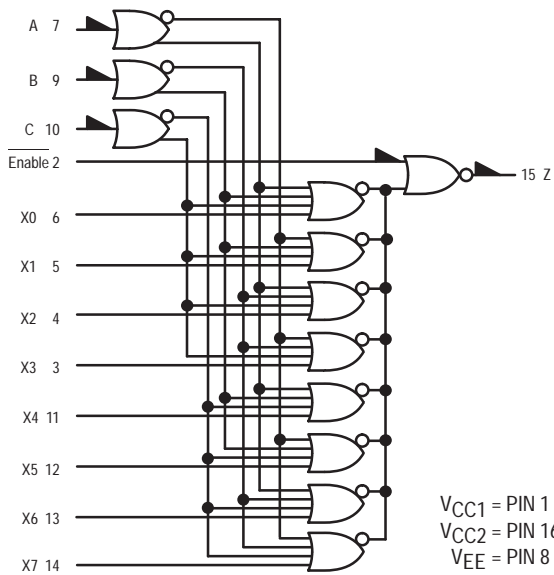
Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

8-Line Multiplexer

The MC10164 is a high speed, low power eight-channel data selector which routes data present at one-of-eight inputs to the output. The data is routed according to the three bit code present on the address inputs. An enable input is provided for easy bit expansion.

$P_D = 310 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 3.0 \text{ ns typ (Data to Output)}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

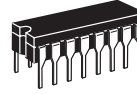
LOGIC DIAGRAM



TRUTH TABLE

ENABLE	ADDRESS INPUTS			Z
	C	B	A	
L	L	L	L	X0
L	L	L	H	X1
L	L	H	L	X2
L	L	H	H	X3
L	H	L	L	X4
L	H	L	H	X5
L	H	H	L	X6
L	H	H	H	X7
H	X	X	X	L

MC10164



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

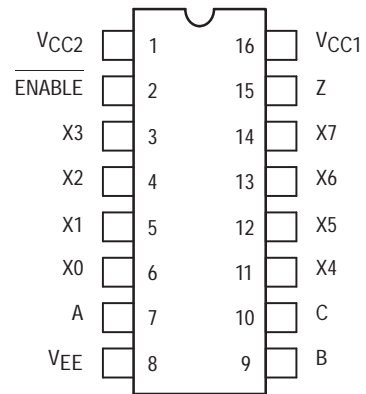


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits						Unit	
			-30°C		+25°C		+85°C			
			Min	Max	Min	Typ	Max	Min		Max
Power Supply Drain Current	I _E	8		83		60	75		83	mAdc
Input Current	I _{inH}	2		425			265		265	μAdc
	I _{inL}	4	0.5		0.5			0.3		μAdc
Output Voltage Logic 1	V _{OH}	15	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
Output Voltage Logic 0	V _{OL}	15	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
Threshold Voltage Logic 1	V _{OHA}	15	-1.080		-0.980			-0.910		Vdc
Threshold Voltage Logic 0	V _{OLA}	15		-1.655			-1.630		-1.595	Vdc
Switching Times (50Ω Load)										ns
Propagation Delay	t ₄₊₁₅₊	15	1.5	4.9	1.5	3.0	4.7	1.6	5.0	
	t ₄₋₁₅₋	15	1.5	4.9	1.5	3.0	4.7	1.6	5.0	
	t ₇₊₁₅₊	15	1.9	6.5	2.0	4.0	6.2	2.2	6.7	
	t ₇₋₁₅₋	15	1.9	6.5	2.0	4.0	6.2	2.2	6.7	
	t ₂₊₁₅₋	15	0.9	3.5	1.0	2.0	3.1	1.0	3.3	
	t ₂₋₁₅₊	15	0.9	3.5	1.0	2.0	3.1	1.0	3.3	
Rise Time (20 to 80%)	t ₊	15	0.9	3.3	1.1	2.0	3.3	1.2	3.6	
Fall Time (20 to 80%)	t ₋	15	0.9	3.3	1.1	2.0	3.3	1.2	3.6	

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd	
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
Power Supply Drain Current	I _E	8					8	1,16	
Input Current	I _{inH}	2	4				8	1,16	
	I _{inL}	4		4			8	1,16	
Output Voltage Logic 1	V _{OH}	15	4,9				8	1,16	
Output Voltage Logic 0	V _{OL}	15	9				8	1,16	
Threshold Voltage Logic 1	V _{OHA}	15	4,9			2	8	1,16	
Threshold Voltage Logic 0	V _{OLA}	15	9			2	8	1,16	
Switching Times (50Ω Load)			+1.11V			Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	t ₄₊₁₅₊	15	9			4	15	8	1,16
	t ₄₋₁₅₋	15	9			4	15	8	1,16
	t ₇₊₁₅₊	15	5			7	15	8	1,16
	t ₇₋₁₅₋	15	5			7	15	8	1,16
	t ₂₊₁₅₋	15	7,5			2	15	8	1,16
	t ₂₋₁₅₊	15	7,5			2	15	8	1,16
Rise Time (20 to 80%)	t ₊	15	9			4	15	8	1,16
Fall Time (20 to 80%)	t ₋	15	9			4	15	8	1,16

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

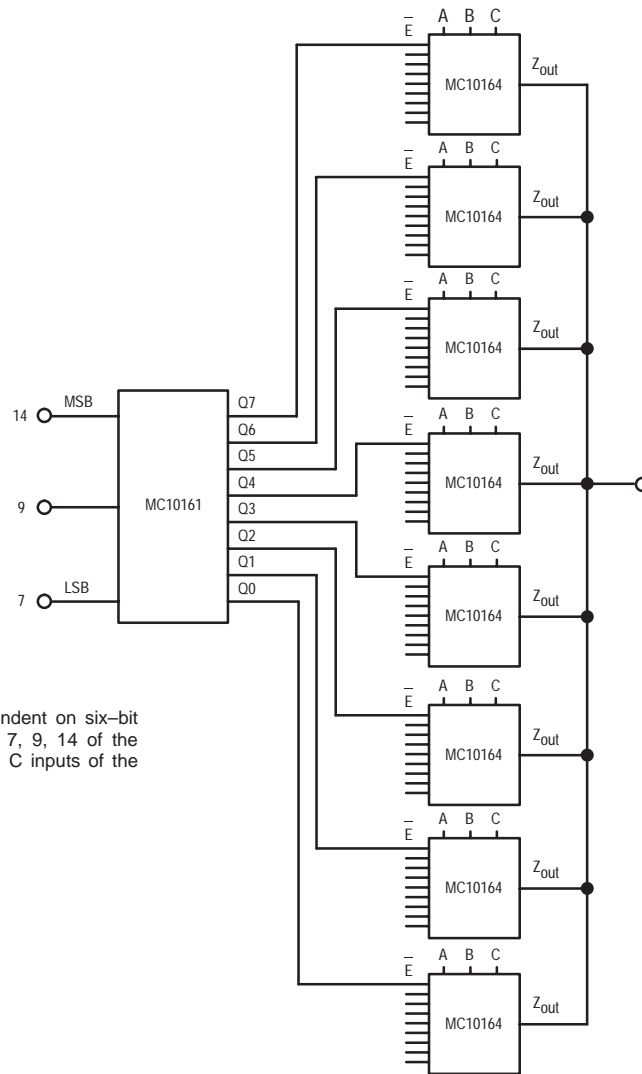
APPLICATION INFORMATION

The MC10164 can be used wherever data multiplexing or parallel to serial conversion is desirable. Full parallel gating permits equal delays through any data path. The output of the MC10164 incorporates a buffer gate with eight data inputs and an enable. A high level on the enable forces the output low. The MC10164 can be connected directly to a data bus, due to its open emitter output and

output enable.

Figure one illustrates how a 1-of-64 line multiplexer can be built with eight MC10164's wire ORed at their outputs and one MC10161 to drive the enables on each multiplexer, without speed degradation over a single MC10164 being experienced.

FIGURE 1 — 1-OF-64 LINE MULTIPLEXER



The Bit chosen is dependent on six-bit code present on inputs 7, 9, 14 of the MC10161 and the A, B, C inputs of the MC10164.

8-Input Priority Encoder

The MC10165 is a device designed to encode eight inputs to a binary coded output. The output code is that of the highest order input. Any input of lower priority is ignored. Each output incorporates a latch allowing synchronous operation. When the clock is low the outputs follow the inputs and latch when the clock goes high. This device is very useful for a variety of applications in checking system status in control processors, peripheral controllers, and testing systems.

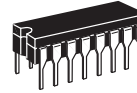
The input is active when high, (e.g., the three binary outputs are low when input D0 is high). The Q3 output is high when any input is high. This allows direct extension into another priority encoder when more than eight inputs are necessary. The MC10165 can also be used to develop binary codes from random logic inputs, for addressing ROMs, RAMs, or for multiplexing data.

$P_D = 545 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 4.5 \text{ ns typ (Data to Output)}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

TRUTH TABLE

DATA INPUTS								OUTPUTS			
D0	D1	D2	D3	D4	D5	D6	D7	Q3	Q2	Q1	Q0
H	X	X	X	X	X	X	X	H	L	L	L
L	H	X	X	X	X	X	X	H	L	L	H
L	L	H	X	X	X	X	X	H	L	H	L
L	L	L	H	X	X	X	X	H	L	H	H
L	L	L	L	H	X	X	X	H	H	L	L
L	L	L	L	L	H	X	X	H	H	L	H
L	L	L	L	L	L	H	X	H	H	H	L
L	L	L	L	L	L	L	H	H	H	H	H
L	L	L	L	L	L	L	L	L	L	L	L

MC10165

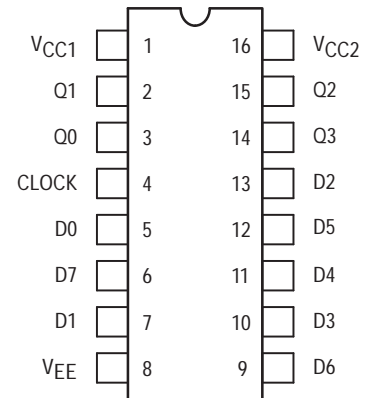


L SUFFIX
CERAMIC PACKAGE
CASE 620-10

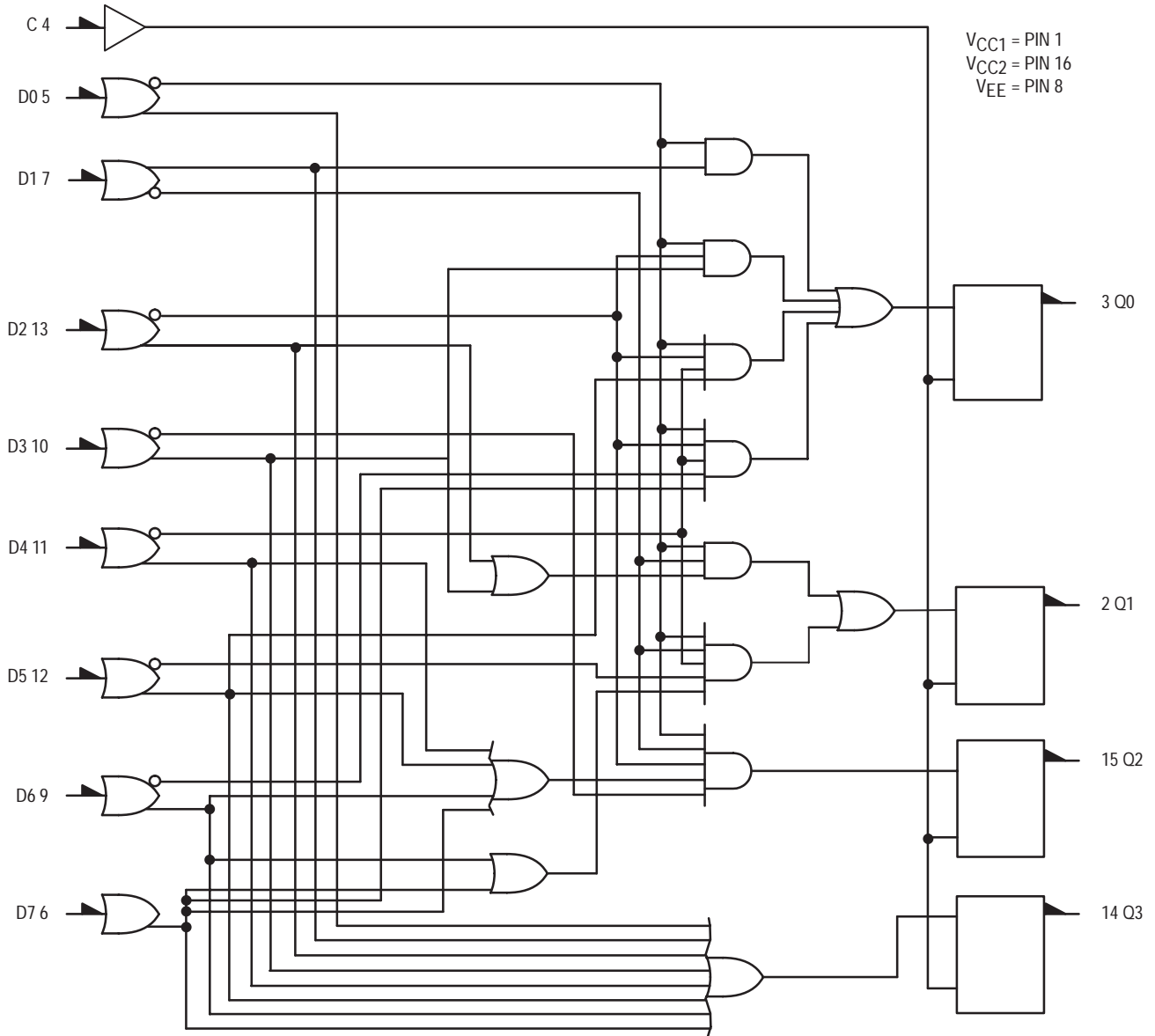


P SUFFIX
PLASTIC PACKAGE
CASE 648-08

PIN ASSIGNMENT



LOGIC DIAGRAM



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I _E	8		144		105	131		144	mAdc
Input Current	I _{inH}	4		390			245		245	μAdc
		5		350			220		220	
	I _{inL}	4	0.5		0.5			0.3		μAdc
		5	0.5		0.5			0.3		
Output Voltage Logic 1	V _{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
		14	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
		15	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Output Voltage Logic 0	V _{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
		14	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
		15	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V _{OHA}	2	-1.080		-0.980			-0.910		Vdc
		3	-1.080		-0.980			-0.910		
		14	-1.080		-0.980			-0.910		
		15	-1.080		-0.980			-0.910		
Threshold Voltage Logic 0	V _{OLA}	2		-1.655			-1.630		-1.595	Vdc
		3		-1.655			-1.630		-1.595	
		14		-1.655			-1.630		-1.595	
		15		-1.655			-1.630		-1.595	
Switching Times (50Ω Load)									ns	
Propagation Delay Data Input	t ₅₊₁₄₊ t ₅₋₁₄₋ t ₇₊₃₊ t ₁₁₊₁₅₊ t ₁₃₊₂₊	14	2.0	7.0	3.0		7.0	2.0	8.0	
		14	2.0	7.0	3.0		7.0	2.0	8.0	
		3	2.0	7.0	3.0		7.0	2.0	8.0	
		15	2.0	7.0	3.0		7.0	2.0	8.0	
		2	2.0	7.0	3.0		7.0	2.0	8.0	
Clock Input	t ₄₋₃₊ t ₄₋₃₋ t ₄₋₁₄₊ t ₄₋₁₄₋	3 (2.)	1.5	4.5	2.0		4.0	1.5	4.5	
		3 (3.)	1.5	4.5	2.0		4.0	1.5	4.5	
		14 (2.)	1.5	4.5	2.0		4.0	1.5	4.5	
		14 (3.)	1.5	4.5	2.0		4.0	1.5	4.5	
Setup Time	t _{setupH} t _{setupL}	3	6.0		6.0	3.4		6.0		
		3	6.0		6.0	3.0		6.0		
Hold Time	t _{holdH} t _{holdL}	3	1.0		1.0	-2.3		1.0		
		3	1.0		1.0	-2.7		1.0		
Rise Time (20 to 80%)	t ₃₊	3	1.1	3.5	1.1	2.0	3.3	1.1	3.5	
Fall Time (20 to 80%)	t ₃₋	3	1.1	3.5	1.1	2.0	3.3	1.1	3.5	

1. The same limit applies for all D type input pins. To test input currents for other D inputs, individually apply proper voltage to pin under test.

2. Output latched to low state prior to test.

3. Output latched to high state prior to test.

* To preserve reliable performance, the MC10165P (plastic packaged device only) is to be operated in ambient temperatures above 70°C only when 500 lfm blown air or equivalent heat sinking is provided.

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					V_{CC} Gnd	
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}		
Power Supply Drain Current	I_E	8					8	1, 16	
Input Current	I_{inH}	4	4				8	1, 16	
		5	5 (1.)				8	1, 16	
	I_{inL}	4		4			8	1, 16	
		5		5 (1.)			8	1, 16	
Output Voltage Logic 1	V_{OH}	2	6	4			8	1, 16	
		3	6	4			8	1, 16	
		14	6	4			8	1, 16	
		15	6	4			8	1, 16	
Output Voltage Logic 0	V_{OL}	2		4			8	1, 16	
		3		4			8	1, 16	
		14		4			8	1, 16	
		15		4			8	1, 16	
Threshold Voltage Logic 1	V_{OHA}	2		4	6		8	1, 16	
		3		4	6		8	1, 16	
		14		4	6		8	1, 16	
		15		4	6		8	1, 16	
Threshold Voltage Logic 0	V_{OLA}	2		4		6	8	1, 16	
		3		4		6	8	1, 16	
		14		4		6	8	1, 16	
		15		4		6	8	1, 16	
Switching Times (50Ω Load)				+1.11V	+0.31V	Pulse In	Pulse Out	-3.2 V	+2.0
Propagation Delay Data Input	t_{5+14+} t_{5-14-} t_{7+3+} t_{11+15+} t_{13+2+}	14		4	5	14	8	1, 16	
		14		4	5	14	8	1, 16	
		3		4	7	3	8	1, 16	
		15		4	11	15	8	1, 16	
		2		4	13	2	8	1, 16	
		Clock Input	t_{4-3+} t_{4-3-} t_{4-14+} t_{4-14-}	3 (2.)	7	4	4	3	8
3 (3.)				4	4	3	8	1, 16	
14 (2.)	7			4	4	14	8	1, 16	
14 (3.)				4	4	14	8	1, 16	
Setup Time	t_{setupH} t_{setupL}	3			4,7	3	8	1, 16	
		3			4,7	3	8	1, 16	
Hold Time	t_{holdH} t_{holdL}	3			4,7	3	8	1, 16	
		3			4,7	3	8	1, 16	
Rise Time (20 to 80%)	t_{3+}	3		4	7	3	8	1, 16	
Fall Time (20 to 80%)	t_{3-}	3		4	7	3	8	1, 16	

1. The same limit applies for all D type input pins. To test input currents for other D inputs, individually apply proper voltage to pin under test.
 2. Output latched to low state prior to test.
 3. Output latched to high state prior to test.
 * To preserve reliable performance, the MC10165P (plastic packaged device only) is to be operated in ambient temperatures above 70°C only when 500 lfpm blown air or equivalent heat sinking is provided.

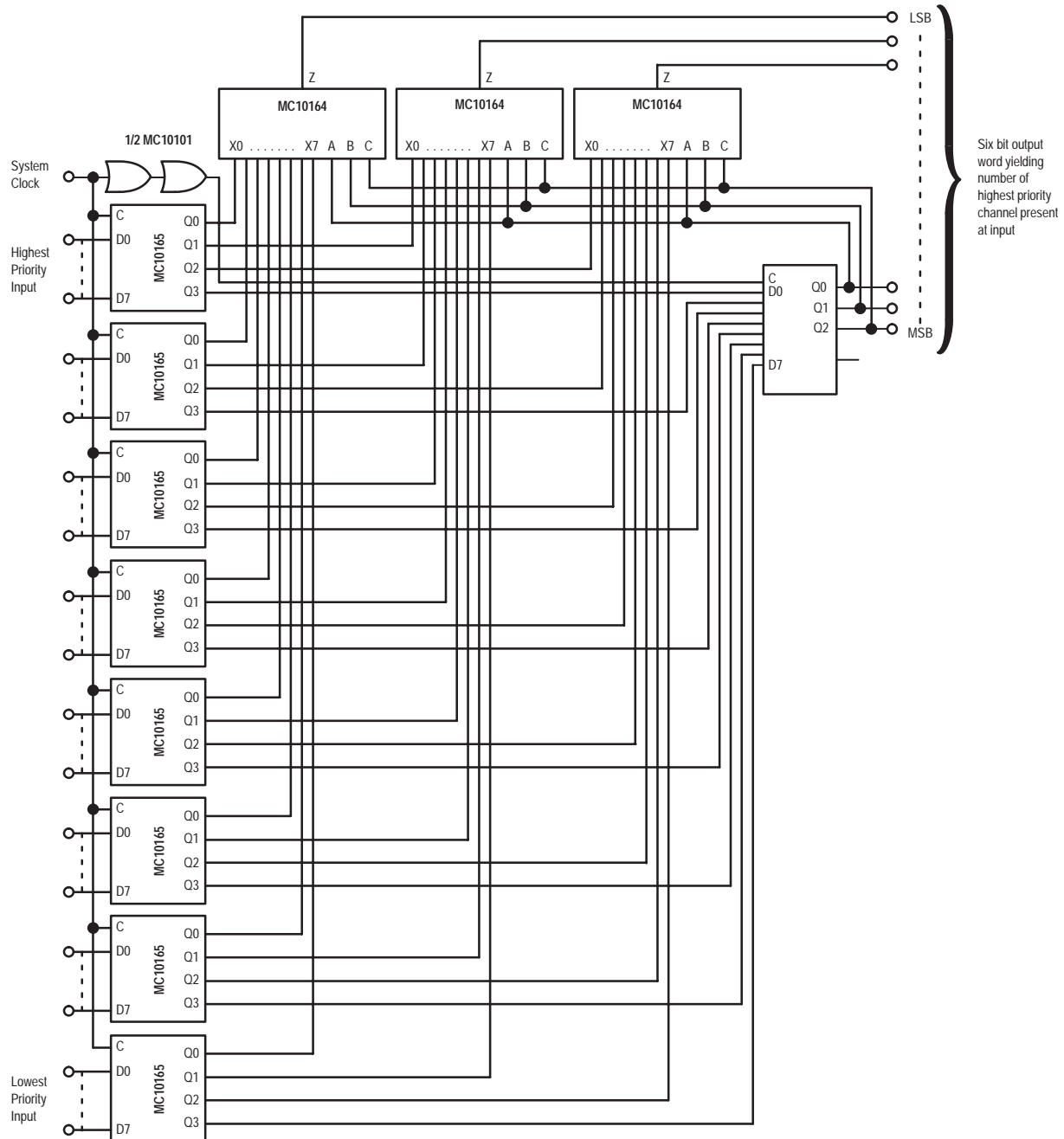
Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

APPLICATION INFORMATION

A typical application of the MC10165 is the decoding of system status on a priority basis. A 64 line priority encoder is shown in the figure below. System status lines are

connected to this encoder such that, when a given condition exists, the respective input will be at a logic high level. This scheme will select the one of 64 different system conditions, as represented at the encoder inputs, which has priority in determining the next system operation to be performed. The binary code showing the address of the highest priority input present will appear at the encoder outputs to control other system logic functions.

64-LINE PRIORITY ENCODER

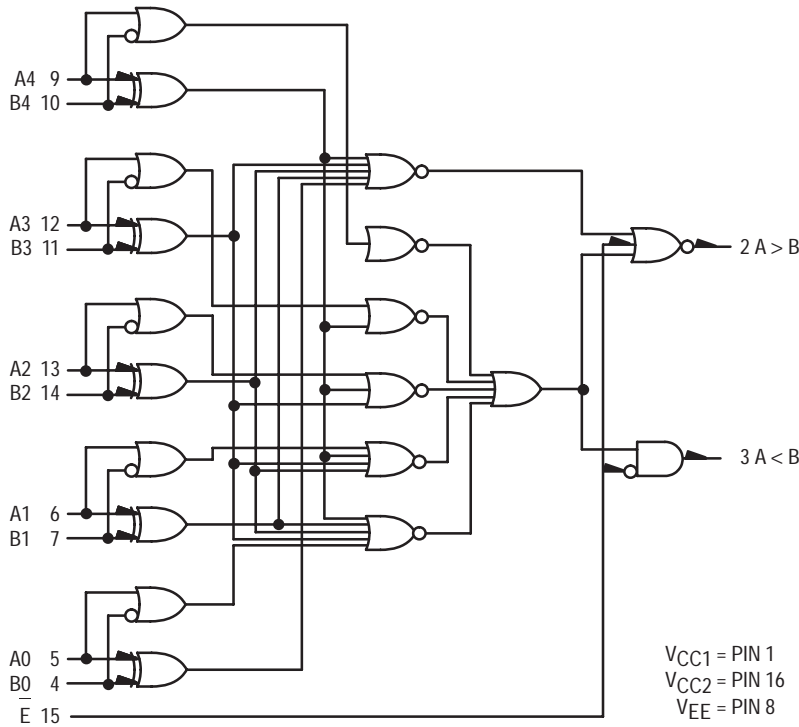


5-Bit Magnitude Comparator

The MC10166 is a high speed expandable 5-bit comparator for comparing the magnitude of two binary words. Two outputs are provided: $A < B$ and $A > B$. $A = B$ can be obtained by NORing the two outputs with an additional gate. A high level on the enable function forces both outputs low. Multiple MC10166s may be used for larger word comparisons.

$P_D = 440$ mW typ/pkg (No Load)
 $t_{pd} =$ Data to output 6.0 ns typ
 E to output 2.5 ns typ
 $t_r, t_f = 2.0$ ns typ (20%–80%)

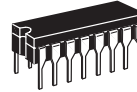
LOGIC DIAGRAM



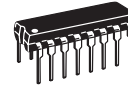
TRUTH TABLE

Inputs			Outputs	
E	A	B	A < B	A > B
H	X	X	L	L
L	Word A = Word B		L	L
L	Word A > Word B		L	H
L	Word A < Word B		H	L

MC10166



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

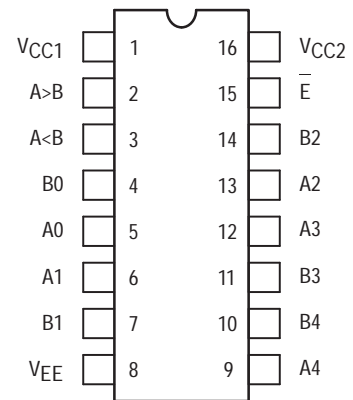


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

**DIP
PIN ASSIGNMENT**



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits						Unit	
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min		Max
Power Supply Drain Current	I _E	8		117		85	106		117	mAdc
Input Current	I _{inH}	5		350			220		220	μAdc
	I _{inL}	5	0.5		0.5			0.3		μAdc
Output Voltage Logic 1	V _{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Output Voltage Logic 0	V _{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V _{OHA}	2	-1.080		-0.980			-0.910		Vdc
		3	-1.080		-0.980			-0.910		
Threshold Voltage Logic 0	V _{OLA}	2		-1.655			-1.630		-1.595	Vdc
		3		-1.655			-1.630		-1.595	
Switching Times (50Ω Load)										ns
Propagation Delay Data to Output	t ₉₊₂₊	2	1.0	8.0	1.0	6.0	7.6	1.0	8.4	
	t ₉₋₂₋	2	1.0	8.0	1.0	6.0	7.6	1.0	8.4	
	t ₁₁₋₂₊	2	1.0	8.0	1.0	6.0	7.6	1.0	8.4	
	t ₁₁₊₂₋	2	1.0	8.0	1.0	6.0	7.6	1.0	8.4	
	t ₇₊₃₊	3	1.0	8.0	1.0	6.0	7.6	1.0	8.4	
	t ₇₋₃₋	3	1.0	8.0	1.0	6.0	7.6	1.0	8.4	
Enable to Output	t ₁₅₋₃₊	3	1.0	3.8	1.0	2.5	3.6	1.0	4.0	
	t ₁₅₊₃₋	3	1.0	3.8	1.0	2.5	3.6	1.0	4.0	
Rise Time (20 to 80%)	t ₂₊	2	1.0	3.6	1.1	2.0	3.5	1.1	3.8	
Fall Time (20 to 80%)	t ₂₋	2	1.0	3.6	1.1	2.0	3.5	1.1	3.8	

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
@ Test Temperature								
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2	
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2	
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2	
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					(V _{CC}) Gnd
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
Power Supply Drain Current	I _E	8		4,7,10,11,14			8	1, 16
Input Current	I _{inH}	5	5				8	1, 16
	I _{inL}	5		5			8	1, 16
Output Voltage Logic 1	V _{OH}	2	5				8	1, 16
		3	4				8	1, 16
Output Voltage Logic 0	V _{OL}	2	5, 15				8	1, 16
		3	4, 15				8	1, 16
Threshold Voltage Logic 1	V _{OHA}	2	5			15	8	1, 16
		3	4			15	8	1, 16
Threshold Voltage Logic 0	V _{OLA}	2	5		15		8	1, 16
		3	4		15		8	1, 16
Switching Times (50Ω Load)			+1.11V		Pulse In	Pulse Out	-3.2 V	+2.0
Propagation Delay Data to Output	t ₉₊₂₊	2			9	2	8	1, 16
	t ₉₋₂₋	2			9	2	8	1, 16
	t ₁₁₋₂₊	2	12		11	2	8	1, 16
	t ₁₁₊₂₋	2	12		11	2	8	1, 16
	t ₇₊₃₊	3	6		7	3	8	1, 16
	t ₇₋₃₋	3	6		7	3	8	1, 16
	Enable to Output	t ₁₅₋₃₊	3	10		15	3	8
t ₁₅₊₃₋		3	10		15	3	8	1, 16
Rise Time (20 to 80%)	t ₂₊	2			9	2	8	1, 16
Fall Time (20 to 80%)	t ₂₋	2			9	2	8	1, 16

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

APPLICATION INFORMATION

FIGURE 1 — 9-BIT MAGNITUDE COMPARATOR

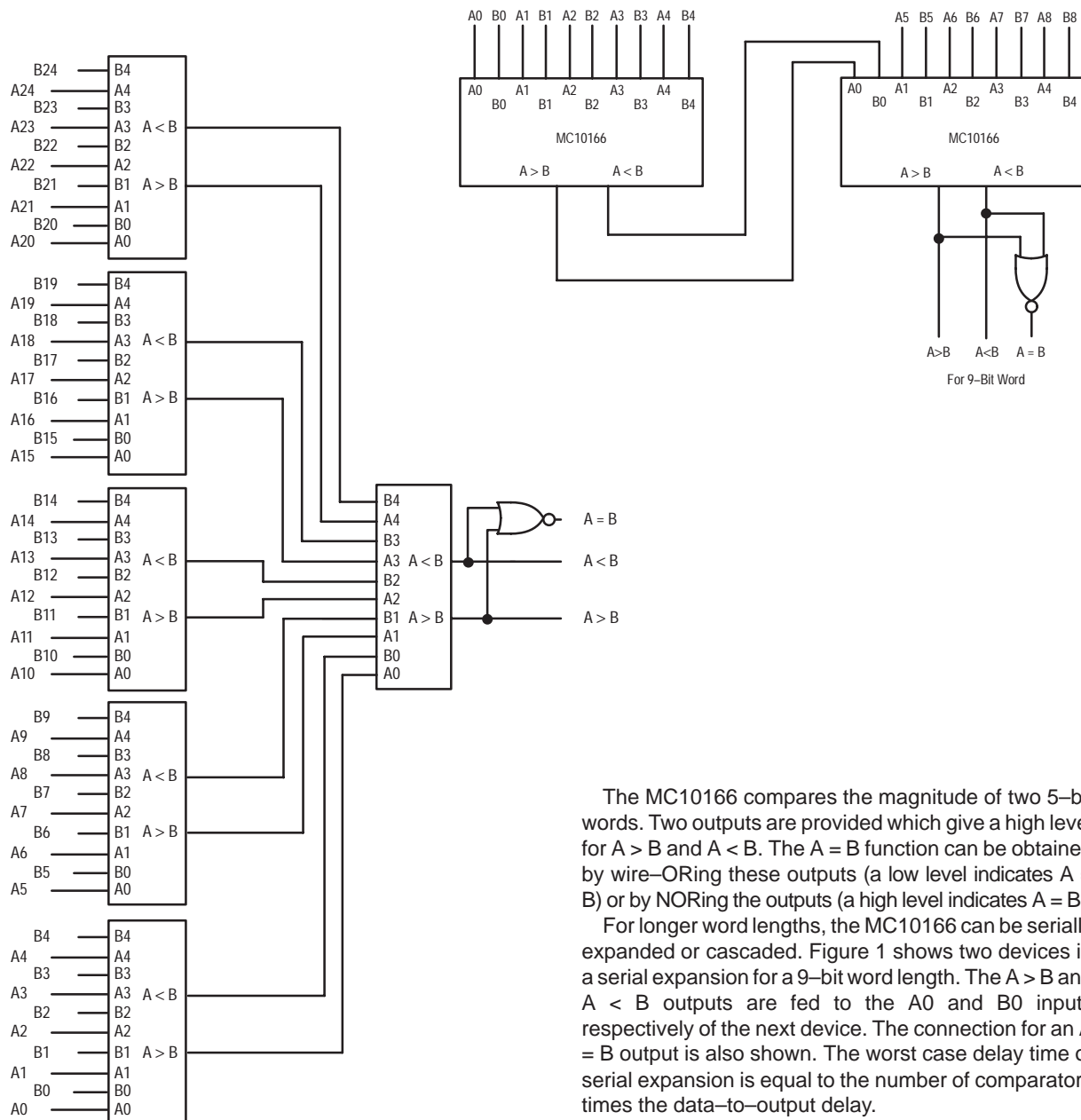


FIGURE 2 — 25-BIT MAGNITUDE COMPARATOR

The MC10166 compares the magnitude of two 5-bit words. Two outputs are provided which give a high level for A > B and A < B. The A = B function can be obtained by wire-ORing these outputs (a low level indicates A = B) or by NORing the outputs (a high level indicates A = B).

For longer word lengths, the MC10166 can be serially expanded or cascaded. Figure 1 shows two devices in a serial expansion for a 9-bit word length. The A > B and A < B outputs are fed to the A0 and B0 inputs respectively of the next device. The connection for an A = B output is also shown. The worst case delay time of serial expansion is equal to the number of comparators times the data-to-output delay.

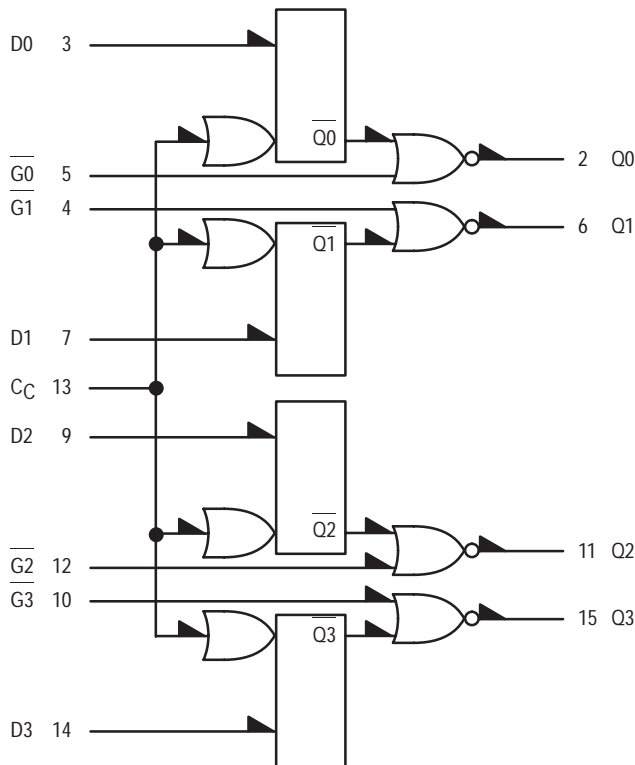
For shorter delay times than possible with serial expansion, devices can be cascaded. Figure 2 shows a 25-bit cascaded comparator whose worst case delay is two data-to-output delays. The cascaded scheme can be extended to longer word lengths.

Quad Latch

The MC10168 is a Quad Latch with common clocking to all four latches. Separate output enabling gates are provided for each latch, allowing direct wiring to a bus. When the clock is high, outputs will follow the D inputs. Information is latched on the negative-going transition of the clock.

$P_D = 310$ mW typ/pkg (No Load)
 $t_{pd} = \overline{G}$ to Q = 2 ns typ
 D to Q = 3 ns typ
 C to Q = 4 ns typ
 $t_r, t_f = 2.0$ ns typ (20%–80%)

LOGIC DIAGRAM

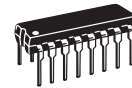


$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

TRUTH TABLE

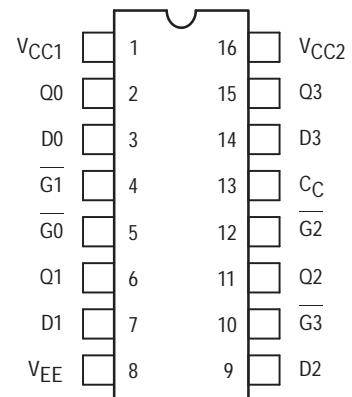
G	C	D	Q_{n+1}
H	X	X	L
L	L	X	Q_n
L	H	L	L
L	H	H	H

MC10168



P SUFFIX
 PLASTIC PACKAGE
 CASE 648-08

PIN ASSIGNMENT



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I_E	8		82		60	75		82	mA _{dc}
Input Current	I_{inH}	3,7,9,14 4,5,10,12 13		390 425 460			245 265 290		245 265 290	μA _{dc}
	I_{inL}	*	0.5		0.5			0.3		μA _{dc}
Output Voltage Logic 1	V_{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	V _{dc}
		6	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Output Voltage Logic 0	V_{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	V _{dc}
		6	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V_{OHA}	2	-1.080		-0.980			-0.910		V _{dc}
		6	-1.080		-0.980			-0.910		
Threshold Voltage Logic 0	V_{OLA}	2		-1.655			-1.630		-1.595	V _{dc}
		6		-1.655			-1.630		-1.595	
Switching Times (50Ω Load)										ns
Propagation Delay	Data	t_{3+2+}	2	1.0	5.6	1.0	3.0	5.4	1.1	5.9
	Gate	t_{5-2+}	2	1.0	3.2	1.0	2.0	3.1	1.0	3.4
	Clock	t_{13+2+}	2	1.0	5.8	1.0	4.0	5.6	1.2	6.2
Setup Time		t_{3+13+}	2	2.5		2.5			2.5	
Hold Time		t_{13+3+}	2	1.0		1.0			1.0	
Rise Time (20 to 80%)		t_{2+}	2	1.0	3.6	1.1	2.0	3.5	1.1	3.8
Fall Time (20 to 80%)		t_{2-}	2	1.0	3.6	1.1	2.0	3.5	1.1	3.8

* Individually test each input applying V_{IH} or V_{IL} to input under test.

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
@ Test Temperature								
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2	
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2	
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2	
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
Power Supply Drain Current	I _E	8					8	1, 16
Input Current	I _{inH}	3,7,9,14	*				8	1, 16
		4,5,10,12	*				8	1, 16
		13	13				8	1, 16
Output Voltage	Logic 1	V _{OH}	2	3, 13			8	1, 16
			6	7, 13			8	1, 16
Output Voltage	Logic 0	V _{OL}	2	3, 5			8	1, 16
			6	4, 7			8	1, 16
Threshold Voltage	Logic 1	V _{OHA}	2	13		3	8	1, 16
			6	13		7	8	1, 16
Threshold Voltage	Logic 0	V _{OLA}	2	13			3	1, 16
			6	13		7	8	1, 16
Switching Times	(50Ω Load)		+1.11V		Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	Data	t ₃₊₂₊	2		3	2	8	1, 16
	Gate	t ₅₋₂₊	2		5	2	8	1, 16
	Clock	t ₁₃₊₂₊	2		13	2	8	1, 16
Setup Time		t ₃₊₁₃₊	2				8	1, 16
Hold Time		t ₁₃₊₃₊	2				8	1, 16
Rise Time	(20 to 80%)	t ₂₊	2		3	2	8	1, 16
Fall Time	(20 to 80%)	t ₂₋	2		3	2	8	1, 16

* Individually test each input applying V_{IH} or V_{IL} to input under test.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

9+2-Bit Parity Generator/ Checker

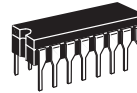
The MC10170 is a 11-bit parity circuit, which is segmented into 9 data bits and 2 control bits.

Output A generates odd parity on 9 bits; that is, Output A goes high for an odd number of high logic levels on the bit inputs in only 2 gate delays.

The Control Inputs can be used to expand parity to larger numbers of bits with minimal delay or can be used to generate even parity. To expand parity to larger words, the MC10170 can be used with the MC10160 or other MC10170's. The MC10170 can generate both even and odd parity.

$P_D = 300 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 2.5 \text{ ns typ (Control Inputs to B Output)}$
 $4.0 \text{ ns typ (Data Inputs to A Output)}$
 $6.0 \text{ ns typ (Data Inputs to B Output)}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

MC10170

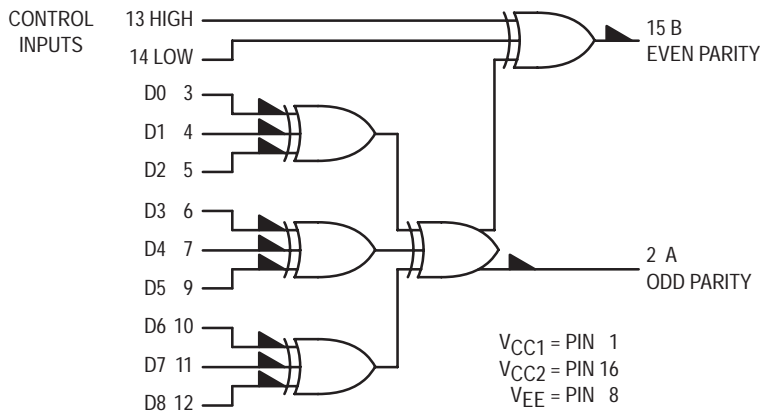


L SUFFIX
CERAMIC PACKAGE
CASE 620-10

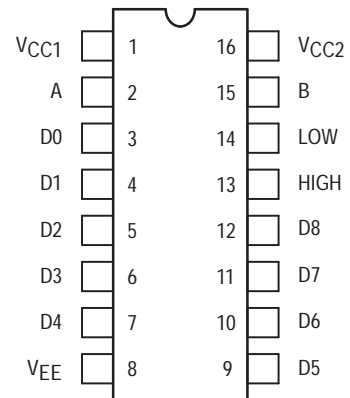


P SUFFIX
PLASTIC PACKAGE
CASE 648-08

LOGIC DIAGRAM



PIN ASSIGNMENT



INPUTS	OUTPUTS	
	Odd Parity	Even Parity
Sum of D Inputs at High Level	Output A	Output B
Even	Low	High
Odd	High	Low



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I _E	8		78		57	71		78	mAdc
Input Current	I _{inH}	3		350			200		220	μAdc
		5		350			220		220	
	I _{inL}	3	0.5		0.5			0.3		μAdc
Output Voltage Logic 1	V _{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		15	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Output Voltage Logic 0	V _{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		15	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V _{OHA}	2	-1.080		-0.980			-0.910		Vdc
		15	-1.080		-0.980			-0.910		
Threshold Voltage Logic 0	V _{OLA}	2		-1.655			-1.630		-1.595	Vdc
		15		-1.655			-1.630		-1.595	
Switching Times (50Ω Load)										ns
Propagation Delay	t ₁₃₊₁₅₊ t ₁₄₋₁₅₋ t ₃₊₂₋ t ₃₋₁₅₊	15	1.5	4.2	1.5	2.5	4.0	1.5	4.4	
		15	1.5	4.2	1.5	2.5	4.0	1.5	4.4	
		2	2.0	6.6	2.0	4.0	6.0	2.0	6.6	
		15	4.0	9.5	4.0	6.0	8.8	4.0	9.5	
Rise Time (20 to 80%)	t ₂₊	2	1.5	4.3	1.5	2.0	3.9	1.5	4.3	
Fall Time (20 to 80%)	t ₂₋	2	1.5	4.3	1.5	2.0	3.9	1.5	4.3	

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd						
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}							
@ Test Temperature														
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2							
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2							
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2							
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW											
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}							
Power Supply Drain Current	I _E	8						1, 16						
Input Current	I _{inH}	3	3				8	1, 16						
		5	5				8	1, 16						
Output Voltage	Logic 1	V _{OH}	2 15	3, 4, 5 14			8 8	1, 16						
								1, 16						
Output Voltage	Logic 0	V _{OL}	2 15	4, 5 13, 14			8 8	1, 16						
								1, 16						
Threshold Voltage	Logic 1	V _{OHA}	2 15			5 13	8 8	1, 16						
								1, 16						
Threshold Voltage	Logic 0	V _{OLA}	2 15			5 13	8 8	1, 16						
								1, 16						
Switching Times	(50Ω Load)					Pulse In	Pulse Out	-3.2 V	+2.0					
Propagation Delay									1, 16					
									t ₁₃₊₁₅₊	15	13	15	8	1, 16
									t ₁₄₋₁₅₋	15	14	15	8	1, 16
									t ₃₊₂₋	2	3	2	8	1, 16
Rise Time	(20 to 80%)	t ₂₊	2					8	1, 16					
									1, 16					
Fall Time	(20 to 80%)	t ₂₋	2					8	1, 16					

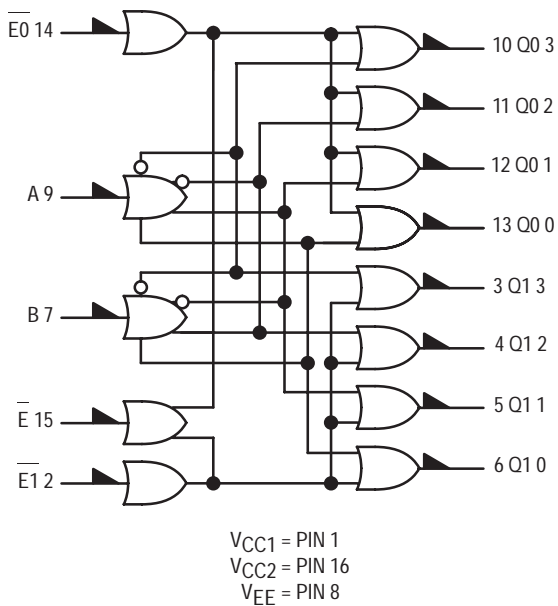
Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Dual Binary to 1-4 Decoder (Low)

The MC10171 is a binary coded 2 line to dual 4 line decoder with selected outputs low. With either E0 or E1 high, the corresponding selected 4 outputs are high. The common enable E, when high, forces all outputs high.

$P_D = 325 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 4.0 \text{ ns typ}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

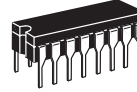
LOGIC DIAGRAM



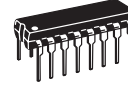
TRUTH TABLE

ENABLE INPUTS			INPUTS		OUTPUTS							
E	E0	E1	A	B	Q10	Q11	Q12	Q13	Q00	Q01	Q02	Q03
L	L	L	L	L	L	H	H	H	L	H	H	H
L	L	L	L	H	H	L	H	H	H	L	H	H
L	L	L	H	L	H	H	L	H	H	H	L	H
L	L	L	H	H	H	H	H	L	H	H	H	L
L	L	H	L	L	H	H	H	H	L	H	H	H
L	L	H	L	L	L	H	H	H	H	H	H	H
L	H	L	L	L	L	H	H	H	H	H	H	H
H	X	X	X	X	H	H	H	H	H	H	H	H

MC10171



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

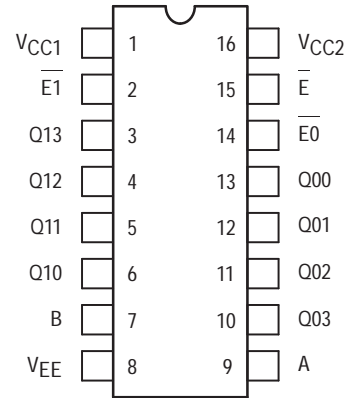


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

**DIP
PIN ASSIGNMENT**



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I _E	8		85		65	77		85	mAdc
Input Current	I _{inH}	14		350			220		220	μAdc
	I _{inL}	14	0.5		0.5			0.3		μAdc
Output Voltage Logic 1	V _{OH}	6	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		13	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Output Voltage Logic 0	V _{OL}	13	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
Threshold Voltage Logic 1	V _{OHA}	6	-1.080		-0.980			-0.910		Vdc
		13	-1.080		-0.980			-0.910		
Threshold Voltage Logic 0	V _{OLA}	6		-1.655			-1.630		-1.595	Vdc
		13		-1.655			-1.630		-1.595	
Switching Times (50Ω Load)										ns
Propagation Delay	t ₇₊₆₊	6	1.5	6.2	1.5	4.0	6.0	1.5	6.4	
	t ₇₋₆₋	6	1.5	6.2	1.5	4.0	6.0	1.5	6.4	
	t ₇₊₁₃₊	13	1.5	6.2	1.5	4.0	6.0	1.5	6.4	
	t ₇₋₁₃₋	13	1.5	6.2	1.5	4.0	6.0	1.5	6.4	
Rise Time (20 to 80%)	t ₆₊	6	1.0	3.3	1.1	2.0	3.3	1.1	3.4	
	t ₁₃₊	13	1.0	3.3	1.1	2.0	3.3	1.1	3.4	
Fall Time (20 to 80%)	t ₆₋	6	1.0	3.3	1.1	2.0	3.3	1.1	3.4	
	t ₁₃₋	13	1.0	3.3	1.1	2.0	3.3	1.1	3.4	

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
@ Test Temperature								
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2	
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2	
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2	
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
Power Supply Drain Current	I _E	8	2,7,9,14,15				8	1, 16
Input Current	I _{inH}	14	14				8	1, 16
	I _{inL}	14		14			8	1, 16
Output Voltage Logic 1	V _{OH}	6	15				8	1, 16
		13	15				8	1, 16
Output Voltage Logic 0	V _{OL}	13		2,7,9,14,15			8	1, 16
Threshold Voltage Logic 1	V _{OHA}	6			15		8	1, 16
		13			15		8	1, 16
Threshold Voltage Logic 0	V _{OLA}	6		2,9,14,15		7	8	1, 16
		13		2,7,14,15		9	8	1, 16
Switching Times (50Ω Load)				+0.31V	Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	t ₇₊₆₊	6		2,9,14,15	7	6	8	1, 16
	t ₇₋₆₋	6		2,9,14,15	7	6	8	1, 16
	t ₇₊₁₃₊	13		2,9,14,15	7	13	8	1, 16
	t ₇₋₁₃₋	13		2,9,14,15	7	13	8	1, 16
Rise Time (20 to 80%)	t ₆₊	6			7	6	8	1, 16
	t ₁₃₊	13			7	13	8	1, 16
Fall Time (20 to 80%)	t ₆₋	6			7	6	8	1, 16
	t ₁₃₋	13			7	13	8	1, 16

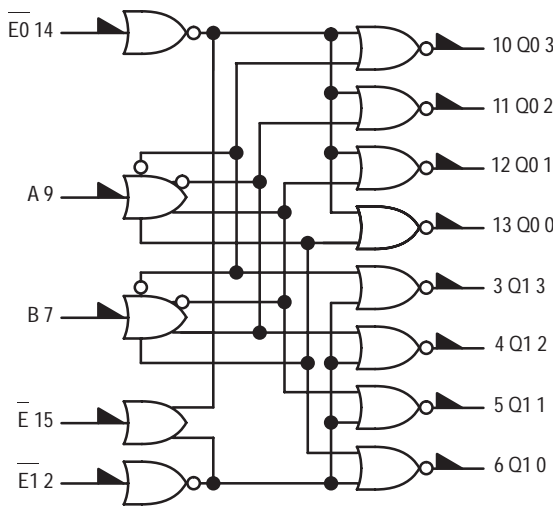
Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Dual Binary to 1-4 Decoder (High)

The MC10172 is a binary-coded 2 line to dual 4 line decoder with selected outputs high. With either $\overline{E0}$ or $\overline{E1}$ low, the corresponding selected 4 outputs are low. The common enable \overline{E} , when high, forces all outputs low.

$P_D = 325 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 4.0 \text{ ns typ}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

LOGIC DIAGRAM

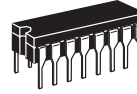


$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

TRUTH TABLE

E	E1	E0	A	B	Q10	Q11	Q12	Q13	Q00	Q01	Q02	Q03
L	H	H	L	L	H	L	L	L	H	L	L	L
L	H	H	L	H	L	H	L	L	L	H	L	L
L	H	H	H	L	L	L	H	L	L	L	H	L
L	H	H	H	H	L	L	L	H	L	L	L	H
L	L	H	L	L	L	L	L	L	H	L	L	L
L	L	H	L	L	L	L	L	L	L	L	L	L
L	H	L	L	L	H	L	L	L	L	L	L	L
H	X	X	X	X	L	L	L	L	L	L	L	L

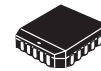
MC10172



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

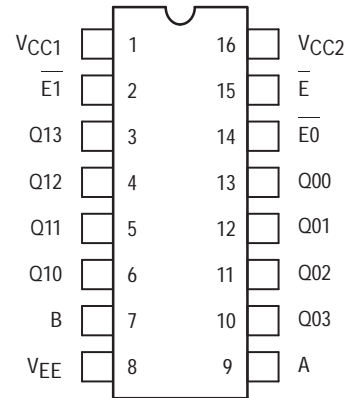


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

**DIP
PIN ASSIGNMENT**



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits						Unit	
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min		Max
Power Supply Drain Current	I_E	8		85		65	77		85	mA _{dc}
Input Current	I_{inH}	14		350			220		220	μA _{dc}
	I_{inL}	14	0.5		0.5			0.3		μA _{dc}
Output Voltage Logic 1	V_{OH}	6	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	V _{dc}
		13	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	V _{dc}
Output Voltage Logic 0	V_{OL}	13	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	V _{dc}
Threshold Voltage Logic 1	V_{OHA}	6	-1.080		-0.980			-0.910		V _{dc}
		13	-1.080		-0.980			-0.910		V _{dc}
Threshold Voltage Logic 0	V_{OLA}	6		-1.655			-1.630		-1.595	V _{dc}
		13		-1.655			-1.630		-1.595	V _{dc}
Switching Times (50Ω Load)										ns
Propagation Delay	t_{7+6-}	6	1.5	6.2	1.5	4.0	6.0	1.5	6.4	
	t_{7-6+}	6	1.5	6.2	1.5	4.0	6.0	1.5	6.4	
	t_{7+13-}	13	1.5	6.2	1.5	4.0	6.0	1.5	6.4	
	t_{7-13+}	13	1.5	6.2	1.5	4.0	6.0	1.5	6.4	
Rise Time (20 to 80%)	t_{6+}	6	1.0	3.3	1.1	2.0	3.3	1.1	3.4	
	t_{13+}	13	1.0	3.3	1.1	2.0	3.3	1.1	3.4	
Fall Time (20 to 80%)	t_{6-}	6	1.0	3.3	1.1	2.0	3.3	1.1	3.4	
	t_{13-}	13	1.0	3.3	1.1	2.0	3.3	1.1	3.4	

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}	
@ Test Temperature								
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2	
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2	
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2	
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					(V_{CC}) Gnd
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}	
Power Supply Drain Current	I_E	8					8	1, 16
Input Current	I_{inH}	14	14				8	1, 16
	I_{inL}	14		14			8	1, 16
Output Voltage Logic 1	V_{OH}	6	2				8	1, 16
		13	14				8	1, 16
Output Voltage Logic 0	V_{OL}	13	15	2,7,9,14			8	1, 16
Threshold Voltage Logic 1	V_{OHA}	6			2		8	1, 16
		13			14		8	1, 16
Threshold Voltage Logic 0	V_{OLA}	6		2,9,14		7	8	1, 16
		13		2,7,14		9	8	1, 16
Switching Times (50Ω Load)			+1.11V	+0.31V	Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	t_{7+6-}	6	2	9, 14	7	6	8	1, 16
	t_{7-6+}	6	2	9, 14	7	6	8	1, 16
	t_{7+13-}	13	14	2, 9	7	13	8	1, 16
	t_{7-13+}	13	14	2,9	7	13	8	1, 16
Rise Time (20 to 80%)	t_{6+}	6	2	9, 14	7	6	8	1, 16
	t_{13+}	13	14	2, 9	7	13	8	1, 16
Fall Time (20 to 80%)	t_{6-}	6	2	9, 14	7	6	8	1, 16
	t_{13-}	13	14	2, 9	7	13	8	1, 16

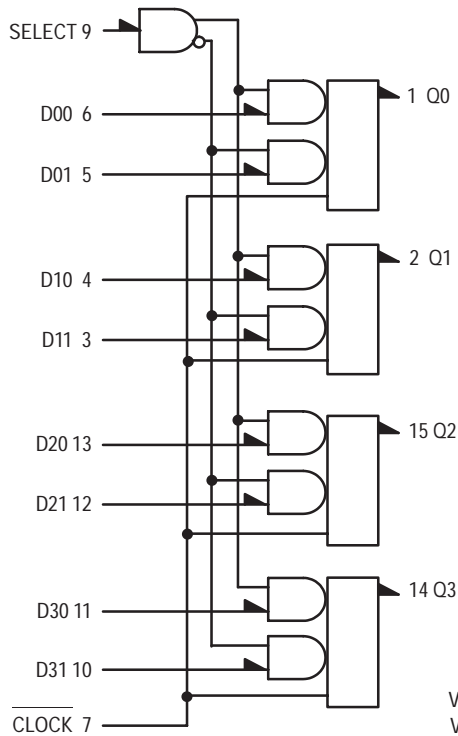
Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Quad 2-Input Multiplexer/ Latch

The MC10173 is a quad two channel multiplexer with latch. It incorporates common clock and common data select inputs. The select input determines which data input is enabled. A high (H) level enables data inputs D00, D10, D20, and D30 and a low (L) level enables data inputs D01, D11, D21, D31. Any change on the data input will be reflected at the outputs while the clock is low. The outputs are latched on the positive transition of the clock. While the clock is in the high state, a change in the information present at the data inputs will not affect the output information.

$P_D = 275 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 2.5 \text{ ns typ}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

LOGIC DIAGRAM

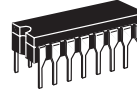


VCC = PIN 16
VEE = PIN 8

TRUTH TABLE

SELECT	CLOCK	Q0 _{n+1}
H	L	D00
L	L	D01
X	H	Q0 _n

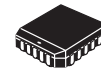
MC10173



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

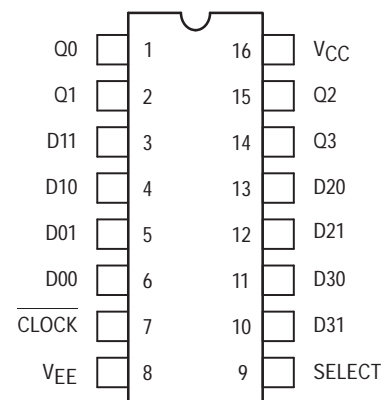


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I_E	8		73			66		73	mAdc
Input Current	I_{inH}	5		470			295		295	μ Adc
		6		470			295		295	
7			400			250		250		
9			400			250		250		
	I_{inL}	All	0.5		0.5			0.3		μ Adc
Output Voltage Logic 1	V_{OH}	1	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Output Voltage Logic 0	V_{OL}	1	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V_{OHA}	1	-1.080		-0.980			-0.910		Vdc
		2	-1.080		-0.980			-0.910		
Threshold Voltage Logic 0	V_{OLA}	1		-1.655			-1.630		-1.595	Vdc
		2		-1.655			-1.630		-1.595	
Switching Times (50 Ω Load)										ns
Propagation Delay	Data Input	t_{6+1+}	1	0.8	3.7	1.0	2.5	3.5	1.1	5.3
		t_{6-1-}	1	0.8	3.7	1.0	2.5	3.5	1.1	5.3
		t_{5+1+}	1	0.8	3.7	1.0	2.5	3.5	1.1	5.3
		t_{5-1-}	1	0.8	3.7	1.0	2.5	3.5	1.1	5.3
Clock Input	t_{7-1+}	1	1.6	7.2	1.6	4.5	6.8	1.4	6.8	
	t_{7-1-}	1	1.6	7.2	1.6	4.5	6.8	1.4	6.8	
Select Input	t_{9+1+}	1	1.1	6.2	1.3	3.5	5.7	1.2	6.7	
	t_{9+1-}	1	1.1	6.2	1.3	3.5	5.7	1.2	6.7	
	t_{9-1+}	1	1.1	6.2	1.3	3.5	5.7	1.2	6.7	
	t_{9-1-}	1	1.1	6.2	1.3	3.5	5.7	1.2	6.7	
Setup Time	Data Input	t_{setup}	1	2.0		2.0	1.5		2.0	
	Select Input	t_{setup}	1	3.0		3.0	2.5		3.0	
Hold Time	Data Input	t_{hold}	1	2.5		2.5	0.0		2.5	
	Select Input	t_{hold}	1	1.5		1.5	-0.5		1.5	
Rise Time (20 to 80%)		t_+	1	1.2	4.0	1.5	2.0	3.5	1.4	4.0
Fall Time (20 to 80%)		t_-	1	1.2	4.0	1.5	2.0	3.5	1.4	4.0

* V_{ILmin} applied to each input pin, one at a time.

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					V_{CC} Gnd		
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}			
@ Test Temperature										
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2			
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2			
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2			
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW							
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}			
Power Supply Drain Current	I_E	8					8	16		
Input Current		5	5				8	16		
		6	6				8	16		
		7	7				8	16		
		9	9				8	16		
	I_{inL}	All		*			8	16		
Output Voltage	Logic 1	V_{OH}	1	6, 9	7			8	16	
			2	5	7			8	16	
Output Voltage	Logic 0	V_{OL}	1	9	7			8	16	
			2		7			8	16	
Threshold Voltage	Logic 1	V_{OHA}	1	9	7	6		8	16	
			2		7	5		8	16	
Threshold Voltage	Logic 0	V_{OLA}	1	9	7		6	8	16	
			2		7		5	8	16	
Switching Times	(50Ω Load)		+1.11V	+0.31V	Pulse In	Pulse Out	-3.2 V	+2.0 V		
Propagation Delay	Data Input	t_{6+1+}	1	9	7	6	1	8	16	
		t_{6-1-}	1	9	7	6	1	8	16	
		t_{5+1+}	1		7	5	1	8	16	
		t_{5-1-}	1		7	5	1	8	16	
	Clock Input	t_{7-1+}	1			5, 7	1	8	16	
		t_{7-1-}	1			5, 7	1	8	16	
	Select Input	t_{9+1+}	1	6	7	9	1	8	16	
		t_{9+1-}	1	5	7	9	1	8	16	
		t_{9-1+}	1	5	7	9	1	8	16	
		t_{9-1-}	1	6	7	9	1	8	16	
	Setup Time	Data Input	t_{setup}	1			5, 7	1	8	16
		Select Input	t_{setup}	1	6		7, 9	1	8	16
Hold Time	Data Input	t_{hold}	1			5, 7	1	8	16	
	Select Input	t_{hold}	1	6		7, 9	1	8	16	
Rise Time	(20 to 80%)	t_+	1	5		7	1	8	16	
Fall Time	(20 to 80%)	t_-	1			7	1	8	16	

* V_{ILmin} applied to each input pin, one at a time.

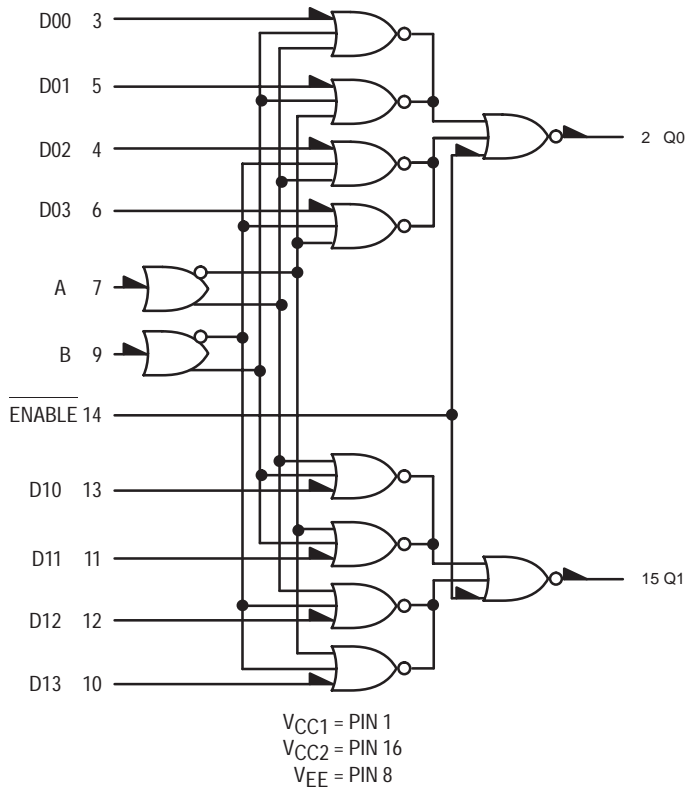
Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Dual 4 to 1 Multiplexer

The MC10174 is a high speed dual channel multiplexer with output enable capability. The select inputs determine one of four active data inputs for each multiplexer. An output enable forces both outputs low when in the high state.

$P_D = 305 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 3.5 \text{ ns typ (Data to output)}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

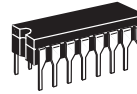
LOGIC DIAGRAM



TRUTH TABLE

ENABLE	ADDRESS INPUTS		OUTPUTS	
	B	A	Q0	Q1
H	X	X	L	L
L	L	L	D00	D10
L	L	H	D01	D11
L	H	L	D02	D12
L	H	H	D03	D13

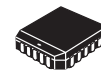
MC10174



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

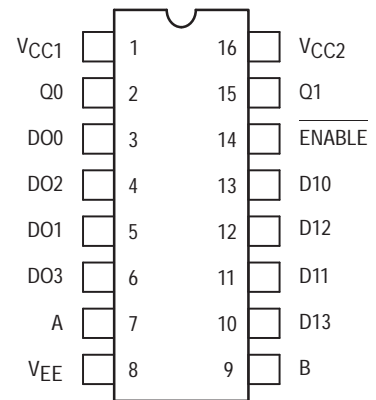


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits						Unit		
			-30°C		+25°C			+85°C			
			Min	Max	Min	Typ	Max	Min		Max	
Power Supply Drain Current	I _E	8		80		58	73	80		mAdc	
Input Current	I _{inH}	4		350			220		220	μAdc	
		14		525			330		330		
	I _{inL}	4	0.5		0.5			0.3		μAdc	
Output Voltage	Logic 1	V _{OH}	15	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
Output Voltage	Logic 0	V _{OL}	15	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
Threshold Voltage	Logic 1	V _{OHA}	15	-1.080		-0.980			-0.910		Vdc
Threshold Voltage	Logic 0	V _{OLA}	15		-1.655			-1.630		-1.595	Vdc
Switching Times (50Ω Load)										ns	
Propagation Delay	t ₁₃₊₁₅₊	15	1.4	5.0	1.5	3.5	4.7	1.4	5.0		
	t ₁₃₋₁₅₋	15	1.4	5.0	1.5	3.5	4.7	1.4	5.0		
	t ₇₊₁₅₋	15	1.9	6.6	2.0	5.0	6.2	2.1	6.6		
	t ₇₋₁₅₊	15	1.9	6.6	2.0	5.0	6.2	2.1	6.6		
	t ₁₄₊₁₅₋	15	1.0	3.3	1.0	2.0	3.1	0.9	3.4		
	t ₁₄₋₁₅₊	15	1.0	3.3	1.0	2.0	3.1	0.9	3.4		
Rise Time (20 to 80%)	t ₊	15	1.0	3.4	1.1	2.0	3.3	1.1	3.6		
Fall Time (20 to 80%)	t ₋	15	1.0	3.4	1.1	2.0	3.3	1.1	3.6		

ELECTRICAL CHARACTERISTICS (continued)

Characteristic	Symbol	Pin Under Test	TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd	
			@ Test Temperature						
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
			-30°C	-1.890	-1.850	-1.205	-1.500		-5.2
			+25°C	-0.810	-1.850	-1.105	-1.475		-5.2
			+85°C	-0.700	-1.825	-1.035	-1.440	-5.2	
			TEST VOLTAGE APPLIED TO PINS LISTED BELOW						
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
Power Supply Drain Current	I _E	8					8	1, 16	
Input Current	I _{inH}	4	4				8	1, 16	
		14	14				8	1, 16	
	I _{inL}	4		4			8	1, 16	
Output Voltage	Logic 1	V _{OH}	15	13			8	1, 16	
Output Voltage	Logic 0	V _{OL}	15	14			8	1, 16	
Threshold Voltage	Logic 1	V _{OHA}	15		13		8	1, 16	
Threshold Voltage	Logic 0	V _{OLA}	15		14		8	1, 16	
Switching Times (50Ω Load)				+1.11V		Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	t ₁₃₊₁₅₊	15				13	15	8	1, 16
	t ₁₃₋₁₅₋	15				13	15	8	1, 16
	t ₇₊₁₅₋	15	11			7	15	8	1, 16
	t ₇₋₁₅₊	15	11			7	15	8	1, 16
	t ₁₄₊₁₅₋	15	13			14	15	8	1, 16
	t ₁₄₋₁₅₊	15	13			14	15	8	1, 16
Rise Time (20 to 80%)	t ₊	15	13			14	15	8	1, 16
Fall Time (20 to 80%)	t ₋	15	13			14	15	8	1, 16

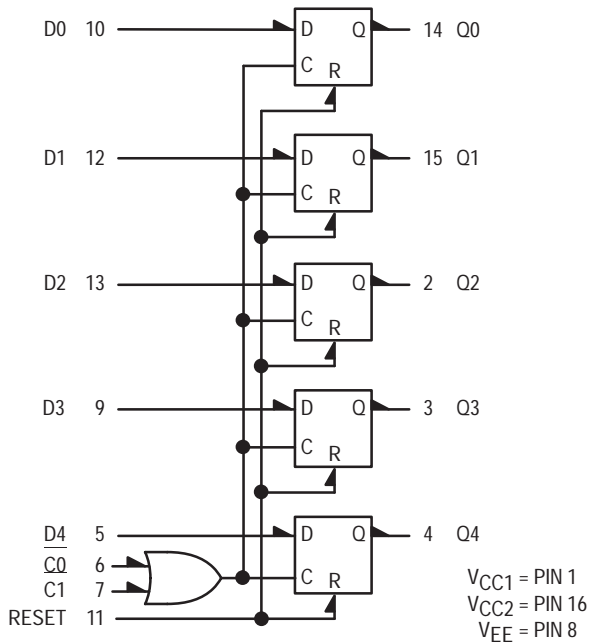
Quint Latch

The MC10175 is a high speed, low power quint latch. It features five D type latches with common reset and a common two-input clock. Data is transferred on the negative edge of the clock and latched on the positive edge. The two clock inputs are "OR"ed together.

Any change on the data input will be reflected at the outputs while the clock is low. The outputs are latched on the positive transition of the clock. While the clock is in the high state, a change in the information present at the data inputs will not affect the output information. The reset input is enabled only when the clock is in the high state.

$P_D = 400 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 2.5 \text{ ns typ (Data to Output)}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

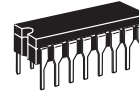
LOGIC DIAGRAM



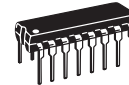
TRUTH TABLE

D	C0	C1	Reset	Q_{n+1}
L	L	L	X	L
H	L	L	X	H
X	H	X	L	Q_n
X	X	H	L	Q_n
X	H	X	H	L
X	X	H	H	L

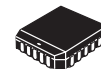
MC10175



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

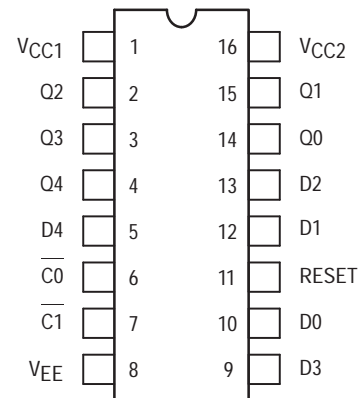


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits						Unit	
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min		Max
Power Supply Drain Current	I _E	8		107		78	97		107	mAdc
Input Current	I _{inH}	6		460			290		290	μAdc
		7		460			290		290	
10			460			290		290		
11			1000			650		650		
	I _{inL}	All	0.5		0.5			0.3		μAdc
Output Voltage Logic 1	V _{OH}	14	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		15	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Output Voltage Logic 0	V _{OL}	14	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		15	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V _{OHA}	14	-1.080		-0.980			-0.910		Vdc
		15	-1.080		-0.980			-0.910		
Threshold Voltage Logic 0	V _{OLA}	14		-1.655			-1.630		-1.595	Vdc
		15		-1.655			-1.630		-1.595	
Switching Times (50Ω Load)										ns
Data Input	t ₁₀₊₁₄₊ t ₁₀₋₁₄₋	14	1.0	3.6	1.0		3.5	1.0	3.6	
		14	1.0	3.6	1.0		3.5	1.0	3.6	
Clock Input	t ₆₋₁₄₊ t ₆₋₁₄₋	14	1.0	4.7	1.0		4.3	1.0	4.4	
		14	1.0	4.7	1.0		4.3	1.0	4.4	
Reset Input	t ₁₁₊₄₋ t ₁₁₊₁₄₋	4	1.0	4.0	1.0		3.9	1.0	4.2	
		14	1.0	4.0	1.0		3.9	1.0	4.2	
Setup Time	t _{setup}	14	2.5		2.5			2.5		
Hold Time	t _{hold}	14	1.5		1.5			1.5		
Rise Time (20 to 80%)	t ₊	14	1.0	3.6	1.1		3.5	1.1	3.7	
Fall Time (20 to 80%)	t ₋	14	1.0	3.6	1.1		3.5	1.1	3.7	

1. Individually test each input; apply V_{ILmin} to pin under test.
2. Output latched to high logic state prior to test.

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					V_{CC} Gnd	
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}		
Power Supply Drain Current	I_E	8					8	1, 16	
Input Current	I_{inH}	6	6				8	1, 16	
		7	7				8	1, 16	
		10	10				8	1, 16	
		11	11				8	1, 16	
	I_{inL}	All		Note 1.			8	1, 16	
Output Voltage	Logic 1	V_{OH}	14	10	6		8	1, 16	
			15	12	6		8	1, 16	
Output Voltage	Logic 0	V_{OL}	14		6, 10		8	1, 16	
			15		6, 12		8	1, 16	
Threshold Voltage	Logic 1	V_{OHA}	14		6	10	8	1, 16	
			15		6	12	8	1, 16	
Threshold Voltage	Logic 0	V_{OLA}	14		6		10	1, 16	
			15		6		12	8	1, 16
Switching Times	(50Ω Load)		+1.11V	+0.31V	Pulse In	Pulse Out	-3.2 V	+2.0 V	
Data Input	t_{10+14+} t_{10-14-}	14		6, 7	10	14	8	1, 16	
		14		6, 7	10	14	8	1, 16	
Clock Input	t_{6-14+} t_{6-14-}	14		7	10, 6	14	8	1, 16	
		14		7	10, 6	14	8	1, 16	
Reset Input	t_{11+4-} t_{11+14-}	4	5	6	7, 11	4 (2.)	8	1, 16	
		14	10	6	7, 11	14 (2.)	8	1, 16	
Setup Time	t_{setup}	14		7	6, 10	14	8	1, 16	
Hold Time	t_{hold}	14		7	6, 10	14	8	1, 16	
Rise Time	(20 to 80%)	t_+	14		6, 7	10	14	8	1, 16
Fall Time	(20 to 80%)	t_-	14		6, 7	10	14	8	1, 16

1. Individually test each input; apply V_{ILmin} to pin under test.
2. Output latched to high logic state prior to test.

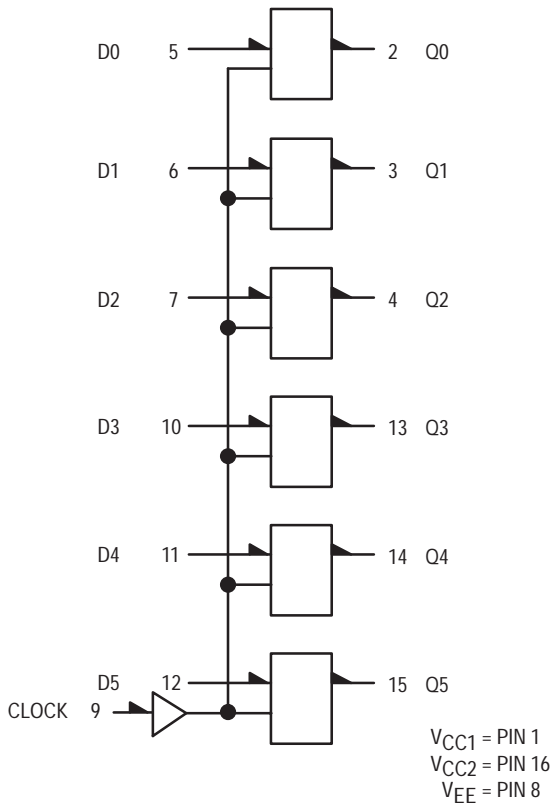
Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Hex D Master/Slave Flip-Flop

The MC10176 contains six high-speed, master slave type "D" flip-flops. Clocking is common to all six flip-flops. Data is entered into the master when the clock is low. Master to slave data transfer takes place on the positive-going Clock transition. Thus, outputs may change only on a positive-going Clock transition. A change in the information present at the data (D) input will not affect the output information any other time due to the master-slave construction of this device.

$P_D = 460 \text{ mW typ/pkg (No Load)}$
 $f_{\text{toggle}} = 150 \text{ MHz (typ)}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

LOGIC DIAGRAM

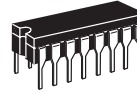


CLOCKED TRUTH TABLE

C	D	Q_{n+1}
L	X	Q_n
H*	L	L
H*	H	H

*A clock H is a clock transition from a low to a high state.

MC10176



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

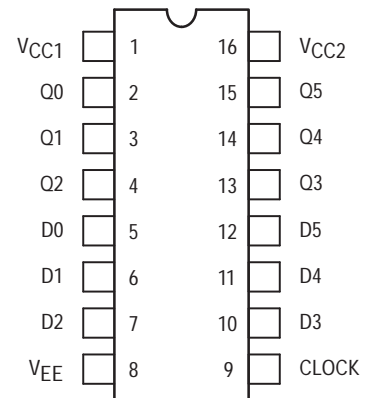


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I_E	8		121		88	110		121	mAdc
Input Current	I_{inH}	5		350			220		220	μ Adc
		9		495			310		310	
Output Voltage Logic 1	V_{OH}	2†	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		15†	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Output Voltage Logic 0	V_{OL}	2†	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		15†	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V_{OHA}	2†	-1.080		-0.980			-0.910		Vdc
		15†	-1.080		-0.980			-0.910		
Threshold Voltage Logic 0	V_{OLA}	2†		-1.655			-1.630		-1.595	Vdc
		15†		-1.655			-1.630		-1.595	
Switching Times (50 Ω Load) Clock Input										ns
Propagation Delay	t_{9+2+}	2	1.6	4.6	1.6		4.5	1.6	5.0	
		2	1.6	4.6	1.6		4.5	1.6	5.0	
Rise Time (20 to 80%)	t_{2+}	2	1.0	4.1	1.1		4.0	1.1	4.4	
Fall Time (20 to 80%)	t_{2-}	2	1.0	4.1	1.1		4.0	1.1	4.4	
Setup Time	t_{setup}	2	2.5		2.5			2.5		ns
Hold Time	t_{hold}	2	1.5		1.5			1.5		ns
Toggle Frequency (Max)	f_{tog}	2	125		125	150		125		MHz

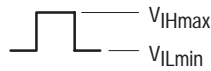
† Output level to be measured after a clock pulse has been applied to the C Input (Pin 9)



ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
@ Test Temperature								
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2	
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2	
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2	
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
Power Supply Drain Current	I _E	8					8	1, 16
Input Current	I _{inH}	5	5				8	1, 16
		9	9				8	1, 16
	I _{inL}	5		5			8	1, 16
		9		9			8	1, 16
Output Voltage	Logic 1	V _{OH}	2 [†]	5			8	1, 16
		15 [†]	12			8	1, 16	
Output Voltage	Logic 0	V _{OL}	2 [†]		5		8	1, 16
		15 [†]	12			8	1, 16	
Threshold Voltage	Logic 1	V _{OHA}	2 [†]			5	8	1, 16
		15 [†]	12			8	1, 16	
Threshold Voltage	Logic 0	V _{OLA}	2 [†]				5	8
		15 [†]	12			8	1, 16	
Switching Times (50Ω Load)			+1.11Vdc	+0.31V	Pulse In	Pulse Out	-3.2 V	+2.0 V
Clock Input	Propagation Delay	t _{g+2+}			5, 9	2	8	1, 16
		t _{g+2-}	2		5, 9	2	8	1, 16
Rise Time (20 to 80%)	t ₂₊	2			5, 9	2	8	1, 16
Fall Time (20 to 80%)	t ₂₋	2			5, 9	2	8	1, 16
Setup Time	t _{setup}	2			5, 9	2	8	1, 16
Hold Time	t _{hold}	2			5, 9	2	8	1, 16
Toggle Frequency (Max)	f _{tog}	2					8	1, 16

† Output level to be measured after a clock pulse has been applied to the C Input (Pin 9)



Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

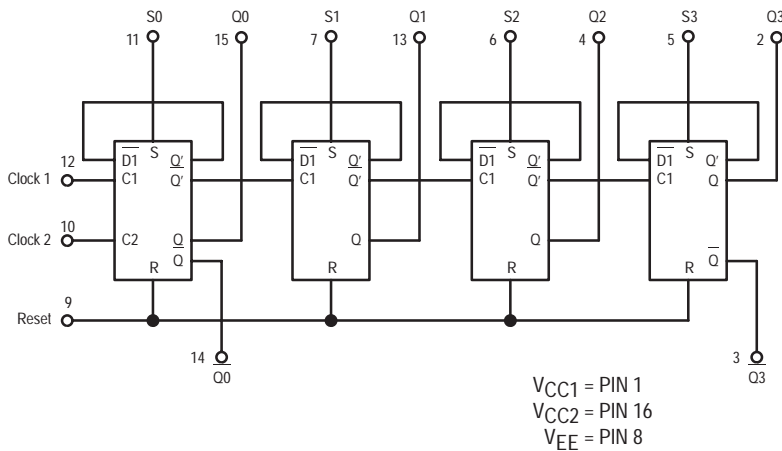
Binary Counter

The MC10178 is a four-bit counter capable of divide-by-two, divide-by-four, divide-by-eight or a divide-by-sixteen function.

Clock inputs trigger on the positive going edge of the clock pulse. Set and Reset inputs override the clock, allowing asynchronous "set" or "clear." Individual Set and common Reset inputs are provided, as well as complementary outputs for the first and fourth bits. True outputs are available at all bits.

$P_D = 370 \text{ mW typ/pkg (No Load)}$
 $f_{\text{toggle}} = 150 \text{ MHz (typ)}$
 $t_r, t_f = 2.7 \text{ ns typ (20\%–80\%)}$

LOGIC DIAGRAM

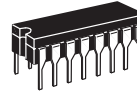


TRUTH TABLE

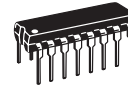
INPUTS							OUTPUTS			
R	S0	S1	S2	S3	C1	C2	Q0	Q1	Q2	Q3
H	L	L	L	L	X	X	L	L	L	L
L	H	H	H	H	X	X	H	H	H	H
L	L	L	L	L	H	X	No Count			
L	L	L	L	L	X	H	No Count			
L	L	L	L	L	**	**	L	L	L	L
L	L	L	L	L	**	**	H	L	L	L
L	L	L	L	L	**	**	L	H	L	L
L	L	L	L	L	**	**	H	H	L	L
L	L	L	L	L	**	**	L	L	H	L
L	L	L	L	L	**	**	H	L	H	L
L	L	L	L	L	**	**	L	H	H	L
L	L	L	L	L	**	**	L	L	L	H
L	L	L	L	L	**	**	H	L	L	H
L	L	L	L	L	**	**	L	H	L	H
L	L	L	L	L	**	**	H	H	L	H
L	L	L	L	L	**	**	L	L	H	H
L	L	L	L	L	**	**	H	L	H	H
L	L	L	L	L	**	**	L	H	H	H

** Clock transition from V_{IL} to V_{IH} may be applied to C1 or C2 or both for same effect.

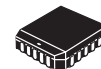
MC10178



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

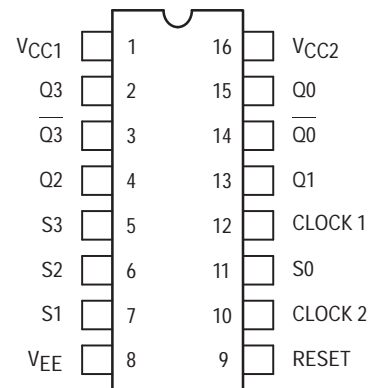


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit	
			-30°C		+25°C			+85°C			
			Min	Max	Min	Typ	Max	Min	Max		
Power Supply Drain Current	I_E	8		97			88		97	mAdc	
Input Current	I_{inH}	12		390			245		245	μ Adc	
		11		350			220		220		
		9		650			410		410		
	I_{inL}	*	0.5		0.5			0.3		μ Adc	
Output Voltage Logic 1	V_{OH}	14	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc	
		15	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700		
Output Voltage Logic 0	V_{OL}	14	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc	
		15	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615		
Threshold Voltage Logic 1	V_{OHA}	3	-1.080		-0.980			-0.910		Vdc	
		14	-1.080		-0.980			-0.910			
		15	-1.080		-0.980			-0.910			
Threshold Voltage Logic 0	V_{OLA}	3		-1.655			-1.630		-1.595	Vdc	
		14		-1.655			-1.630		-1.595		
		15		-1.655			-1.630		-1.595		
Switching Times (50 Ω Load)										ns	
Propagation Delay	Clock Input	t_{12+15+}	15	1.4	5.0	1.5	3.5	4.8	1.5	5.3	
		t_{12-13-}	13	1.9	9.4	2.0	6.0	9.2	2.0	9.8	
		t_{12+4-}	4	2.9	12.3	3.0	8.5	12.0	3.0	12.8	
		t_{12-3+}	3	3.9	14.9	4.0	11.0	14.5	4.0	15.5	
Rise Time (20 to 80%)		t_{15+}	15	1.1	4.7	1.1	2.5	4.5	1.1	5.0	
Fall Time (20 to 80%)		t_{15-}	15	1.1	4.7	1.1	2.5	4.5	1.1	5.0	
Set Input		t_{11-15+}	15	1.4	5.2	1.5		5.0	1.5	5.5	
Reset Input		t_{9-15+}	15	1.4	5.2	1.5		5.0	1.5	5.5	
Counting Frequency		f_{count}	15	125		125	150		125		MHz

* Individually test each input applying V_{IL} to input under test.

ELECTRICAL CHARACTERISTICS (continued)

@ Test Temperature			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd		
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}			
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2			
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2			
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2			
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW							
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}			
Power Supply Drain Current	I _E	8	9				8	1, 16		
Input Current	I _{inH}	12	12				8	1, 16		
		11	11				8	1, 16		
9		9				8	1, 16			
	I _{inL}	*		*			8	1, 16		
Output Voltage	Logic 1	V _{OH}	14	9				8	1, 16	
			15	11				8	1, 16	
Output Voltage	Logic 0	V _{OL}	14	11				8	1, 16	
			15	9				8	1, 16	
Threshold Voltage	Logic 1	V _{OHA}	3			5		8	1, 16	
			14			11		8	1, 16	
			15			9		8	1, 16	
Threshold Voltage	Logic 0	V _{OLA}	3				5	8	1, 16	
			14				11	8	1, 16	
			15				9	8	1, 16	
Switching Times	(50Ω Load)					Pulse In	Pulse Out	-3.2 V	+2.0 V	
Propagation Delay	Data Input	t ₁₂₊₁₅₊	15				12	15	8	1, 16
		t ₁₂₋₁₃₋	13				12	13	8	1, 16
		t ₁₂₊₄₋	4				12	4	8	1, 16
		t ₁₂₋₃₊	3				12	3	8	1, 16
Rise Time	(20 to 80%)	t ₊	15				12	15	8	1, 16
Fall Time	(20 to 80%)	t ₋	15				12	15	8	1, 16
Set Input		t ₁₁₋₁₅₊	15				11	15	8	1, 16
Reset Input		t ₉₋₁₅₊	15				9	15	8	1, 16
Counting Frequency		f _{count}	15				12	15	8	1, 16

* Individually test each input applying V_{IL} to input under test.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

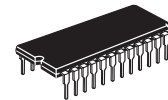
4-Bit Arithmetic Logic Unit/ Function Generator

The MC10181 is a high-speed arithmetic logic unit capable of performing 16 logic operations and 16 arithmetic operations on two four-bit words. Full internal carry is incorporated for ripple through operation.

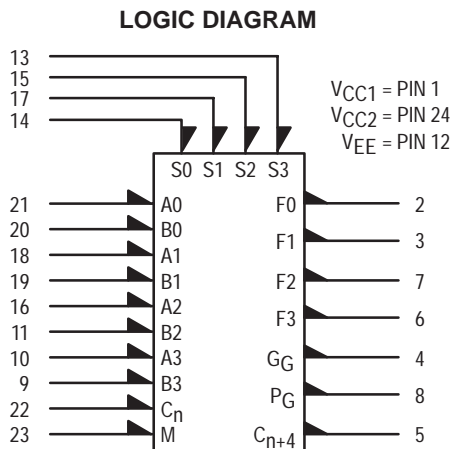
Arithmetic logic operations are selected by applying the appropriate binary word to the select inputs (S0 through S3) as indicated in the tables of arithmetic/logic functions. Group carry propagate (PG) and carry generate (GG) are provided to allow fast operations on very long words using a second order look ahead. The internal carry is enabled by applying a low level voltage to the mode control input (M).

$P_D = 600 \text{ mW typ/pkg (No Load)}$
 $t_{pd} \text{ (typ): A1 to F} = 6.5 \text{ ns}$
 $C_n \text{ to } C_{n+4} = 3.1 \text{ ns}$
 $A1 \text{ to } P_G = 5.0 \text{ ns}$
 $A1 \text{ to } G_G = 4.5 \text{ ns}$
 $A1 \text{ to } C_{n+4} = 5.0$

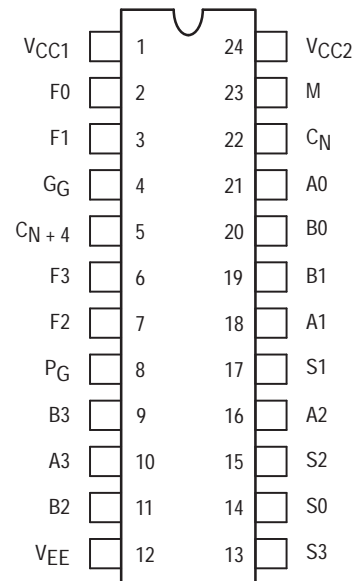
MC10181



L SUFFIX
CERAMIC PACKAGE
CASE 623-05



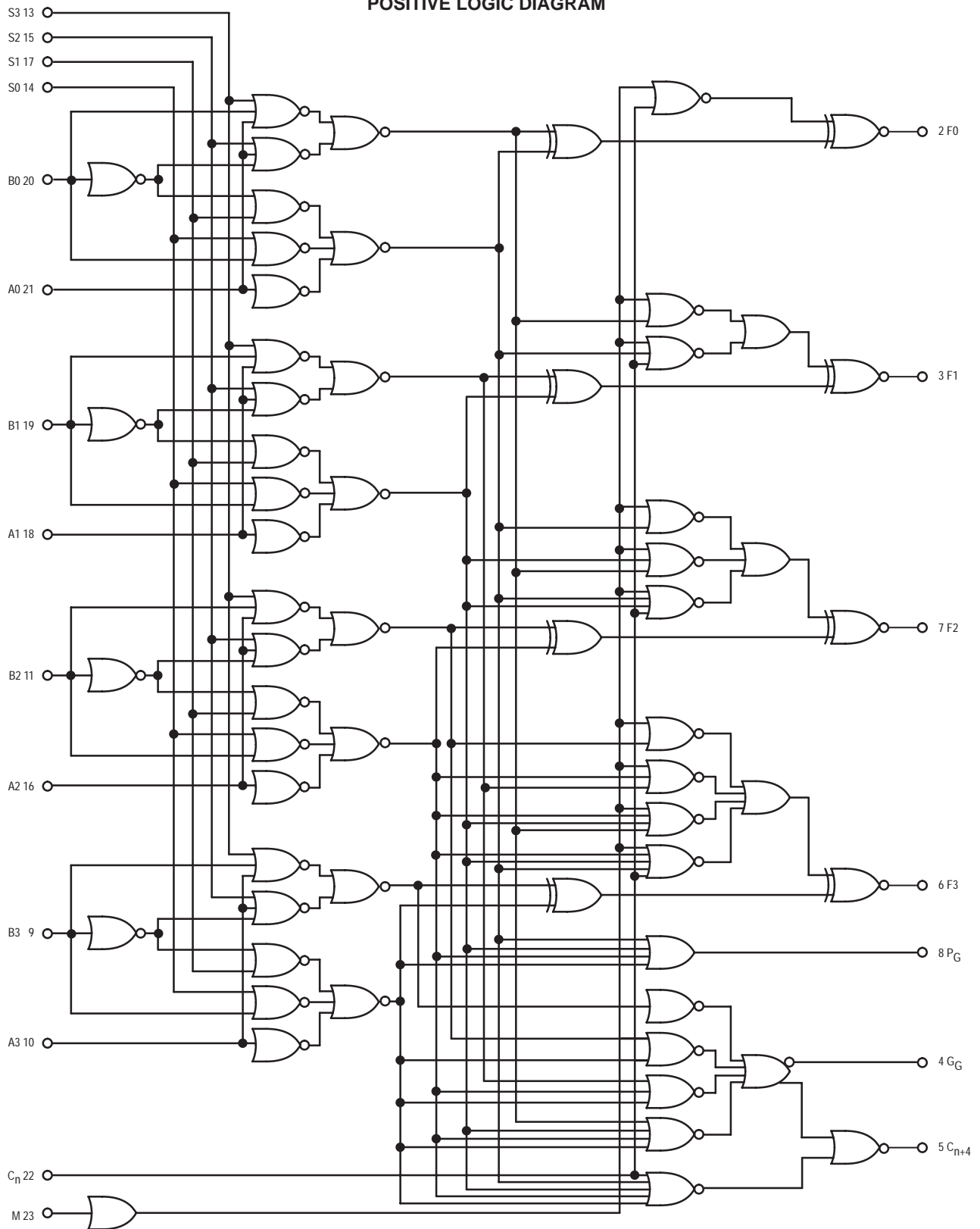
PIN ASSIGNMENT



Function Select				Logic Functions	Arithmetic Operation
S3	S2	S1	S0	M is High C = D.C. F	M is Low C _n is low F
L	L	L	L	$F \equiv A _$	$F = A _$
L	L	L	H	$F = A + B$	$F = A \text{ plus } (A \cdot B)$
L	L	H	L	$F = A + B$	$F = A \text{ plus } (A \cdot B)$
L	L	H	H	F = Logical "1"	$F = A \text{ times } 2$
L	H	L	L	$F = A \cdot B$	$F = (A + B) \text{ plus } 0 _$
L	H	L	H	$F = B$	$F = (A + B) \text{ plus } (A \cdot B)$
L	H	H	L	$F = A \odot B$	$F = A \text{ plus } B$
L	H	H	H	$F = A + B$	$F = A \text{ plus } (A + B)$
H	L	L	L	$F = A \cdot B$	$F = (A + B) \text{ plus } 0$
H	L	L	H	$F = A \oplus B$	$F = A \text{ minus } B \text{ minus } 1$
H	L	H	L	$F = B$	$F = (A + B) \text{ plus } (A \cdot B)$
H	L	H	H	$F = A + B$	$F = A \text{ plus } (A + B)$
H	H	L	L	F = Logical "0"	$F = \text{minus } 1 \text{ (two's complement)}$
H	H	L	H	$F = A \cdot B$	$F = (A \cdot B) \text{ minus } 1$
H	H	H	L	$F = A \cdot B$	$F = (A \cdot B) \text{ minus } 1$
H	H	H	H	$F = A$	$F = A \text{ minus } 1$



POSITIVE LOGIC DIAGRAM



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit	
			-30°C		+25°C			+85°C			
			Min	Max	Min	Typ	Max	Min	Max		
Power Supply Drain Current	I_E	12		159			145		159	mAdc	
Input Current	I_{inH}	9		390			245		245	μ Adc	
		10		350			220		220		
		11		390			245		245		
		13		320			200		200		
		14		425			265		265		
		15		425			265		265		
		16		350			220		220		
		17		425			265		265		
		18		350			220		220		
		19		390			245		245		
		20		390			245		245		
		21		350			220		220		
22		460			290		290				
23		320			200		200				
Input Leakage Current	I_{inL}	9	0.5		0.5			0.3		μ Adc	
		10	0.5		0.5			0.3			
		11	0.5		0.5			0.3			
		13	0.5		0.5			0.3			
		14	0.5		0.5			0.3			
		15	0.5		0.5			0.3			
		16	0.5		0.5			0.3			
		17	0.5		0.5			0.3			
		18	0.5		0.5			0.3			
		19	0.5		0.5			0.3			
		20	0.5		0.5			0.3			
		21	0.5		0.5			0.3			
22	0.5		0.5			0.3					
23	0.5		0.5			0.3					
Output Voltage	Logic 1	V_{OH}	*	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
Output Voltage	Logic 0	V_{OL}	*	-2.000	-1.675	-1.990		-1.650	-1.920	-1.615	Vdc
Threshold Voltage	Logic 1	V_{OHA}	*	-1.080		-0.980			-0.910		Vdc
Threshold Voltage	Logic 0	V_{OLA}	*		-1.655			-1.630		-1.595	Vdc

* Test all input-output combinations according to Function Table.

** For threshold level test, apply threshold input level to only one input pin at a time.

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd	
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
Power Supply Drain Current	I _E	12					12	1, 24	
Input Current	I _{inH}	9	9				12	1, 24	
		10	10				12	1, 24	
		11	11				12	1, 24	
		13	13				12	1, 24	
		14	14				12	1, 24	
		15	15				12	1, 24	
		16	16				12	1, 24	
		17	17				12	1, 24	
		18	18				12	1, 24	
		19	19				12	1, 24	
		20	20				12	1, 24	
		21	21				12	1, 24	
Input Leakage Current	I _{inL}	9		9			12	1, 24	
		10		10			12	1, 24	
		11		11			12	1, 24	
		13		13			12	1, 24	
		14		14			12	1, 24	
		15		15			12	1, 24	
		16		16			12	1, 24	
		17		17			12	1, 24	
		18		18			12	1, 24	
		19		19			12	1, 24	
		20		20			12	1, 24	
		21		21			12	1, 24	
22		22			12	1, 24			
23		23			12	1, 24			
Output Voltage	Logic 1	V _{OH}	*	*	*		12	1, 24	
Output Voltage	Logic 0	V _{OL}	*	*	*		12	1, 24	
Threshold Voltage	Logic 1	V _{OHA}	*			**	**	12	1, 24
Threshold Voltage	Logic 0	V _{OLA}	*			**	**	12	1, 24

* Test all input-output combinations according to Function Table.

** For threshold level test, apply threshold input level to only one input pin at a time.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Characteristic	Symbol	Input	Output	Conditions†	AC Switching Characteristics							Unit
					-30°C *		+25°C			+85°C *		
					Min	Max	Min	Typ	Max	Min	Max	
Propagation Delay Rise Time, Fall Time	t ₊₊ , t ₋₋ t ₊ , t ₋	C _n C _n	C _{n+4} C _{n+4}	A0,A1,A2,A3	1.0	5.1	1.1	3.1	5.0	1.1	5.4	ns
				A0,A1,A2,A3	1.0	3.2	1.0	2.0	3.0	1.0	3.2	
Propagation Delay Rise Time, Fall Time	t ₊₊ , t ₊₋ t ₋₊ , t ₋₋ t ₊ , t ₋	C _n C _n C _n	F1 F1 F1	A0	1.7	7.2	2.0	4.5	7.0	2.0	7.5	ns
				A0	1.7	7.2	2.0	4.5	7.0	2.0	7.5	
				A0	1.3	5.3	1.5	3.0	5.0	1.5	5.3	
Propagation Delay Rise Time, Fall Time	t ₊₊ , t ₊₋ t ₋₊ , t ₋₋ t ₊ , t ₋	A1 A1 A1	F1 F1 F1	—	2.6	10.4	3.0	6.5	10	3.0	10.8	ns
				—	2.6	10.4	3.0	6.5	10	3.0	10.8	
				—	1.3	5.4	1.5	3.0	5.0	1.5	5.3	
Propagation Delay Rise Time, Fall Time	t ₊₊ , t ₋₋ t ₊ , t ₋	A1 A1	P _G P _G	S0,S3	1.6	7.0	2.0	5.0	6.5	2.0	7.0	ns
				S0,S3	0.8	3.7	1.1	2.0	3.5	1.1	3.8	
Propagation Delay Rise Time, Fall Time	t ₊₊ , t ₋₋ t ₊ , t ₋	A1 A1	G _G G _G	A0,A2,A3,C _n	1.1	7.4	2.0	4.5	7.0	1.3	7.7	ns
				A0,A2,A3,C _n	1.2	5.1	1.5	4.0	5.0	1.2	5.3	
Propagation Delay Rise Time, Fall Time	t ₋₊ , t ₊₋ t ₊ , t ₋	A1 A1	C _{n+4} C _{n+4}	A0,A2,A3,C _n	1.7	7.3	2.0	5.0	7.0	2.0	7.8	ns
				A0,A2,A3,C _n	1.0	3.1	1.0	2.0	3.0	1.0	3.2	
Propagation Delay Rise Time, Fall Time	t ₊₊ , t ₊₋ t ₊ , t ₋	B1 B1	F1 F1	S3,C _n	2.7	11.3	3.0	8.0	11	3.0	11.9	ns
				S3,C _n	1.2	5.3	1.5	3.5	5.0	1.5	5.3	
Propagation Delay Rise Time, Fall Time	t ₊₊ , t ₋₋ t ₊ , t ₋	B1 B1	P _G P _G	S0,A1	1.6	7.7	2.0	6.0	7.5	2.0	8.0	ns
				S0,A1	1.0	3.6	1.1	2.0	3.5	1.1	3.9	
Propagation Delay Rise Time, Fall Time	t ₊₊ , t ₋₋ t ₊ , t ₋	B1 B1	G _G G _G	S3,C _n	1.7	8.2	2.0	6.0	8.0	2.0	8.6	ns
				S3,C _n	1.4	5.2	1.5	3.0	5.0	1.2	5.4	
Propagation Delay Rise Time, Fall Time	t ₋₊ , t ₊₋ t ₊ , t ₋	B1 B1	C _{n+4} C _{n+4}	S3,C _n	1.8	8.2	2.0	6.0	8.0	2.0	8.7	ns
				S3,C _n	0.9	3.1	1.0	2.0	3.0	1.0	3.2	
Propagation Delay Rise Time, Fall Time	t ₊₊ , t ₊₋ t ₊ , t ₋	M M	F1 F1	—	2.4	10.3	3.0	6.5	10	3.0	10.8	ns
				—	1.1	5.1	1.5	4.0	5.0	1.5	5.3	
Propagation Delay Rise Time, Fall Time	t ₋₊ , t ₊₋ t ₊ , t ₋	S1 S1	F1 F1	A1,B1	2.5	10.7	3.0	6.5	10	3.0	10.8	ns
				A1,B1	1.0	5.4	1.5	3.0	5.0	1.5	5.4	
Propagation Delay Rise Time, Fall Time	t ₋₊ , t ₊₋ t ₊ , t ₋	S1 S1	P _G P _G	A3,B3	1.7	8.3	2.0	6.0	8.0	2.0	8.4	ns
				A3,B3	0.8	5.1	1.1	3.0	5.0	1.1	5.2	
Propagation Delay Rise Time, Fall Time	t ₋₊ , t ₊₋ t ₊ , t ₋	S1 S1	C _{n+4} C _{n+4}	A3,B3	1.6	9.3	2.0	6.0	9.0	2.0	9.9	ns
				A3,B3	0.9	5.3	1.1	3.0	5.0	1.0	5.2	
Propagation Delay Rise Time, Fall Time	t ₋₊ , t ₊₋ t ₊ , t ₋	S1 S1	G _G G _G	A3,B3	1.5	9.6	2.0	6.0	9.0	1.9	9.7	ns
				A3,B3	0.8	6.2	0.8	3.0	6.0	0.8	6.5	

† Logic high level (+1.11 Vdc) applied to pins listed. All other input pins are left floating or tied to +0.31 Vdc.
VCC1 = VCC2 = +2.0 Vdc, VEE = -3.2 Vdc

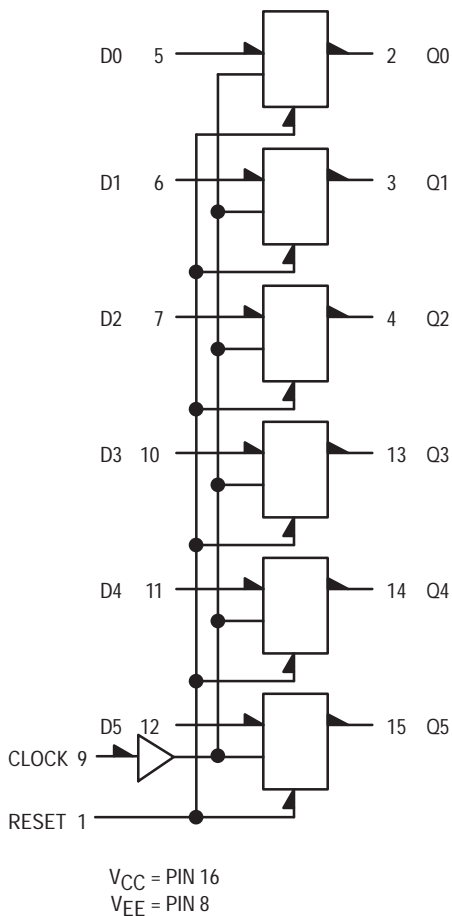
* L Suffix Only

Hex D Master-Slave Flip-Flop With Reset

The MC10186 contains six high-speed, master slave type "D" flip-flops. Clocking is common to all six flip-flops. Data is entered into the master when the clock is low. Master to slave data transfer takes place on the positive-going Clock transition. Thus, outputs may change only on a positive-going Clock transition. A change in the information present at the data (D) input will not affect the output information any other time due to the master-slave construction of this device. **A COMMON RESET IS INCLUDED IN THIS CIRCUIT. RESET ONLY FUNCTIONS WHEN CLOCK IS LOW.**

$P_D = 460 \text{ mW typ/pkg (No Load)}$
 $f_{\text{toggle}} = 150 \text{ MHz (typ)}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

LOGIC DIAGRAM

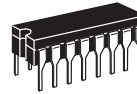


CLOCKED TRUTH TABLE

R	C	D	$Q_n + 1$
L	L	X	Q_n
L	H*	L	L
L	H*	H	H
H	L	X	L

*A clock H is a clock transition from a low to a high state.

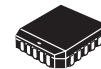
MC10186



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

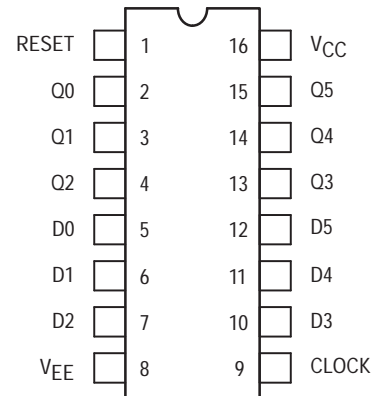


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I _E	8		121		88	110		121	mAdc
Input Current	I _{inH}	5		350			220		220	μAdc
		9		495			310		310	
1			920			575		575		
Output Voltage Logic 1	V _{OH}	2†	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		15†	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Output Voltage Logic 0	V _{OL}	2†	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		15†	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V _{OHA}	2†	-1.080		-0.980			-0.910		Vdc
		15†	-1.080		-0.980			-0.910		
Threshold Voltage Logic 0	V _{OLA}	2†		-1.655			-1.630		-1.595	Vdc
		15†		-1.655			-1.630		-1.595	
Switching Times (50Ω Load)										ns
Propagation Delay	t ₁₊₃₋ t ₁₊₄₋ t ₉₊₂₊ t ₉₊₂₋	3	1.6	4.6	1.6	2.5	4.5	1.6	5.0	
		4	1.6	4.6	1.6	2.5	4.5	1.6	5.0	
		2	1.6	4.6	1.6	3.5	4.5	1.6	5.0	
		2	1.6	4.6	1.6	3.5	4.5	1.6	5.0	
Rise Time (20 to 80%)	t ₂₊	2	1.0	4.1	1.1	1.8	4.0	1.1	4.4	
Fall Time (20 to 80%)	t ₂₋	2	1.0	4.1	1.1	1.8	4.0	1.1	4.4	
Setup Time	t _{setup}	2	2.5		2.5	2.5		2.5		ns
Hold Time	t _{hold}	2	1.5		1.5	-1.5		1.5		ns
Toggle Frequency (Max)	f _{tog}	2	125		125	150		125		MHz

† Output level to be measured after clock pulse.  V_{IH} appears at clock input (Pin 9).

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}	
@ Test Temperature								
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2	
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2	
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2	
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					(V_{CC}) Gnd
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}	
Power Supply Drain Current	I_E	8					8	16
Input Current	I_{inH}	5	5				8	16
		9	9				8	16
		1	1				8	16
	I_{inL}	5		5			8	16
Output Voltage Logic 1	V_{OH}	2†	5				8	16
		15†	12				8	16
Output Voltage Logic 0	V_{OL}	2†		5			8	16
		15†		12			8	16
Threshold Voltage Logic 1	V_{OHA}	2†			5		8	16
		15†			12		8	16
Threshold Voltage Logic 0	V_{OLA}	2†				5	8	16
		15†				12	8	16
Switching Times (50Ω Load)			+1.11Vdc	+0.31V	Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	t_{1+3-}	3	6		1, 9	3	8	16
	t_{1+4-}	4	7		1, 9	4	8	16
	t_{9+2+}	2			5, 9	2	8	16
	t_{9+2-}	2			5, 9	2	8	16
Rise Time (20 to 80%)	t_{2+}	2			5, 9	2	8	16
Fall Time (20 to 80%)	t_{2-}	2			5, 9	2	8	16
Setup Time	t_{setup}	2			5, 9	2	8	16
Hold Time	t_{hold}	2			5, 9	2	8	16
Toggle Frequency (Max)	f_{tog}	2					8	16

† Output level to be measured after clock pulse.  V_{IH} appears at clock input (Pin 9).

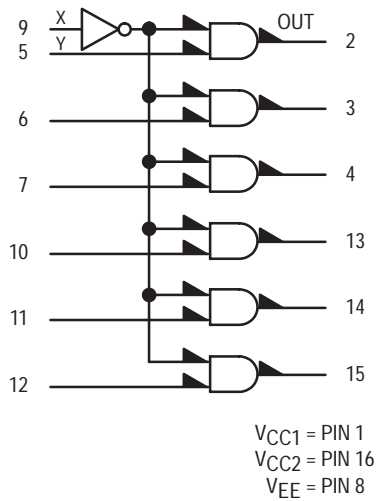
Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Hex Buffer With Enable

The MC10188 is a high-speed hex buffer with a common Enable input. When Enable is in the high state, all outputs are in the low state. When Enable is in the low state, the outputs take the same state as the inputs.

Power Dissipation = 180 mW typ/pkg (No Load)
 Propagation Delay = 2.0 ns typ (B – Q)
 2.5 ns typ (A – Q)

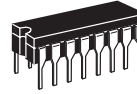
LOGIC DIAGRAM



TRUTH TABLE

Inputs		Output
X	Y	OUT
L	L	L
L	H	H
H	L	L
H	H	L

MC10188



L SUFFIX
 CERAMIC PACKAGE
 CASE 620-10

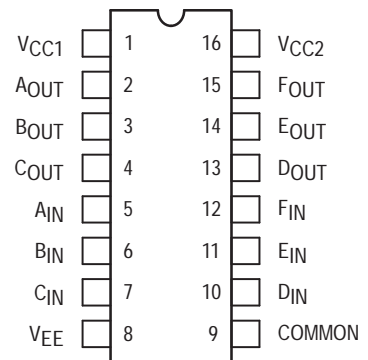


P SUFFIX
 PLASTIC PACKAGE
 CASE 648-08



FN SUFFIX
 PLCC
 CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
 For PLCC pin assignment, see the Pin Conversion
 Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits						Unit	
			-30°C		+25°C		+85°C			
			Min	Max	Min	Max	Min	Max		
Power Supply Drain Current	I _E	8		46		42		46	mAdc	
Input Current	I _{inH}	5		425		265		265	μAdc	
	I _{inH}	9		460		290		290	μAdc	
Output Voltage	Logic 1	V _{OH}	2	-1.060	-0.890	-0.960	-0.810	-0.890	-0.700	Vdc
Output Voltage	Logic 0	V _{OL}	2	-1.890	-1.675	-1.850	-1.650	-1.825	-1.615	Vdc
Threshold Voltage	Logic 1	V _{OHA}	2	-1.080		-0.980		-0.910		Vdc
Threshold Voltage	Logic 0	V _{OLA}	2		-1.655		-1.630		-1.595	Vdc
Switching Times (50Ω Load)										ns
Propagation Delay	Enable	t _{PHL}	2	1.1	3.9	1.1	3.5	1.1	3.9	
	Data	t _{PLH}	2	1.0	3.3	1.0	2.9	1.0	3.3	
Rise/Fall Time (20 to 80%)		t _{TLH} t _{THL}	2	1.1	3.7	1.1	3.3	1.1	3.7	

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd	
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
Power Supply Drain Current	I _E	8					8	1, 16	
Input Current	I _{inH}	5	5				8	1, 16	
	I _{inH}	9	9				8	1, 16	
Output Voltage	Logic 1	V _{OH}	2	5			8	1, 16	
Output Voltage	Logic 0	V _{OL}	2		9		8	1, 16	
Threshold Voltage	Logic 1	V _{OHA}	2			5	8	1, 16	
Threshold Voltage	Logic 0	V _{OLA}	2				5	8	1, 16
Switching Times (50Ω Load)						Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	Enable	t _{PHL}	2			9	2	8	1, 16
	Data	t _{PLH}	2			5	2	8	1, 16
Rise/Fall Time (20 to 80%)		t _{TLH} t _{THL}	2			5	2	8	1, 16

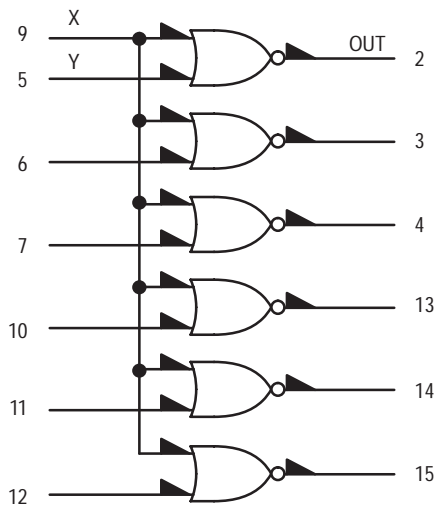
Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Hex Inverter With Enable

The MC10189 provides a high-speed Hex Inverter with a common Enable input. The hex inverting function is provided when Enable is in the low state. When Enable is in the high state all outputs are low.

$P_D = 200 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 2.0 \text{ ns (Y-Q)}$
 $= 2.5 \text{ ns (X-Q)}$

LOGIC DIAGRAM

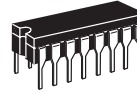


$V_{CC1} = \text{PIN 1}$
 $V_{CC2} = \text{PIN 16}$
 $V_{EE} = \text{PIN 8}$

TRUTH TABLE

Inputs		Output
X	Y	OUT
L	L	H
L	H	L
H	L	L
H	H	L

MC10189



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

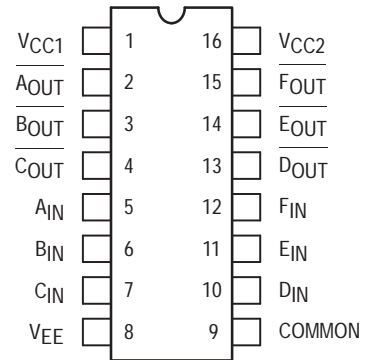


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits						Unit	
			-30°C		+25°C		+85°C			
			Min	Max	Min	Max	Min	Max		
Power Supply Drain Current	I_E	8		44		40		44	mAdc	
Input Current	I_{inH}	5		425		265		265	μ Adc	
	I_{inL}	9		890		555		555	μ Adc	
Output Voltage	Logic 1	V_{OH}	2	-1.060	-0.890	-0.960	-0.810	-0.890	-0.700	Vdc
Output Voltage	Logic 0	V_{OL}	2	-1.890	-1.675	-1.850	-1.650	-1.825	-1.615	Vdc
Threshold Voltage	Logic 1	V_{OHA}	2	-1.080		-0.980		-0.910		Vdc
Threshold Voltage	Logic 0	V_{OLA}	2		-1.655		-1.630		-1.595	Vdc
Switching Times	(50 Ω Load)									ns
Propagation Delay	Enable	t_{PHL}	2	1.1	3.9	1.1	3.5	1.1	3.9	
	Data	t_{PLH}	2	1.0	3.3	1.0	2.9	1.0	3.3	
Rise/Fall Time	(20 to 80%)	t_{TLH} t_{THL}	2	1.1	3.7	1.1	3.3	1.1	3.7	

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V_{CC}) Gnd	
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}		
Power Supply Drain Current	I_E	8					8	1, 16	
Input Current	I_{inH}	5	5				8	1, 16	
	I_{inL}	9	9				8	1, 16	
Output Voltage	Logic 1	V_{OH}		5			8	1, 16	
Output Voltage	Logic 0	V_{OL}		9			8	1, 16	
Threshold Voltage	Logic 1	V_{OHA}				5	8	1, 16	
Threshold Voltage	Logic 0	V_{OLA}			5		8	1, 16	
Switching Times	(50 Ω Load)					Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	Enable	t_{PHL}	2			9	2	8	1, 16
	Data	t_{PLH}	2			5	2	8	1, 16
Rise/Fall Time	(20 to 80%)	t_{TLH} t_{THL}	2			5	2	8	1, 16

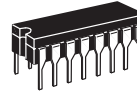
Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Quad Bus Driver

The MC10192 contains four line drivers with complementary outputs. Each driver has a Data (D) input and shares an Enable (E) input with another driver. The two driver outputs are the uncommitted collectors of a pair of NPN transistors operating as a current switch. Each driver accepts 10K MECL input signals and provides a nominal signal swing of 800 mV across a 50 Ω load at each output collector. Outputs can drive higher values of load resistance, provided that the combination of I_R drop and load return voltage V_{LR} does not cause an output collector to go more negative than -2.4 V with respect to V_{CC}. To avoid output transistor breakdown, the load return voltage should not be more positive than +5.5 V with respect to V_{CC}. When the E input is high, both output transistors of a driver are nonconducting. When not used, the E inputs, as well as the D inputs, may be left open.

- Open Collector Outputs Drive Terminated Lines or Transformers
- 50 kΩ Input Pulldown Resistors on All Inputs (Unused Inputs May Be Left Open)
- Power Dissipation = 575 mW typ/pkg (No Load)
- Propagation Delay = 3.5 ns typ (E — Output)
3.0 ns typ (D — Output)

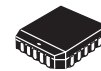
MC10192



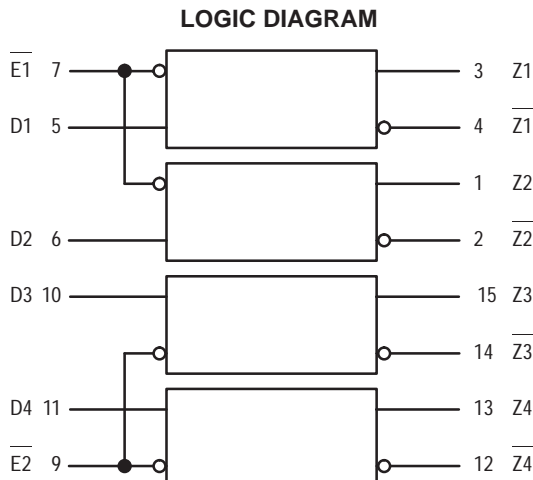
L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08

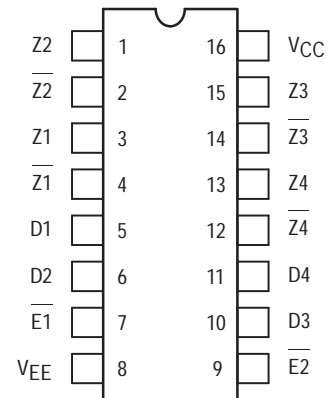


FN SUFFIX
PLCC
CASE 775-02



V_{CC} = PIN 16
V_{EE} = PIN 8

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.

TRUTH TABLE

Inputs		Output	
E	D	Z	Z̄
H	X	H	H
L	H	H	L
L	L	L	H

Note: Unused outputs must be terminated to V_{CC} for proper operation.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits						Unit	
			-30°C		+25°C		+85°C			
			Min	Max	Min	Max	Min	Max		
Power Supply Drain Current	I _E	8		154		140		154	mAdc	
Input Current	I _{inH}	5		350		220		220	μAdc	
	I _{inL}	5	0.5		0.5		0.3		μAdc	
Output Current High	Logic 1	I _{OH}	2			2.0			mAdc	
Output Current Low	Logic 0	I _{OL}	2	13.5	18.0	14.0	18.0	14.0	19.0	mAdc
Threshold Current High	Logic 1	I _{OHC}	2		2.0		2.0		2.0	mAdc
Threshold Current Low	Logic 0	I _{OLC}	2	13.5		14.0		14.0		mAdc
Output Sink Current Low	Logic 0	I _{OS}	2	13.3		13.9		13.3		mAdc
Load Return Voltage Absolute Max Rating (Note 1.)	V _{LR}			5.5		5.5		5.5	V	
Output Voltage Low (Note 2.)	V _{OLS}					-2.4			V	
Switching Times (50Ω Load)									ns	
Propagation Delay	E to Output	t _{PHL}			2.0	6.0				
	D to Output	t _{PLH}			1.5	4.5				
Rise/Fall Time (20 to 80%)		t _{TLH} t _{THL}				3.3				

1. The 5.5V value is a maximum rating, do not exceed. A 270Ω resistor will prevent output transistor breakdown.
2. Limitations of load resistor and load return voltage combinations. Refer to page 3-166 description.

ELECTRICAL CHARACTERISTICS (continued)

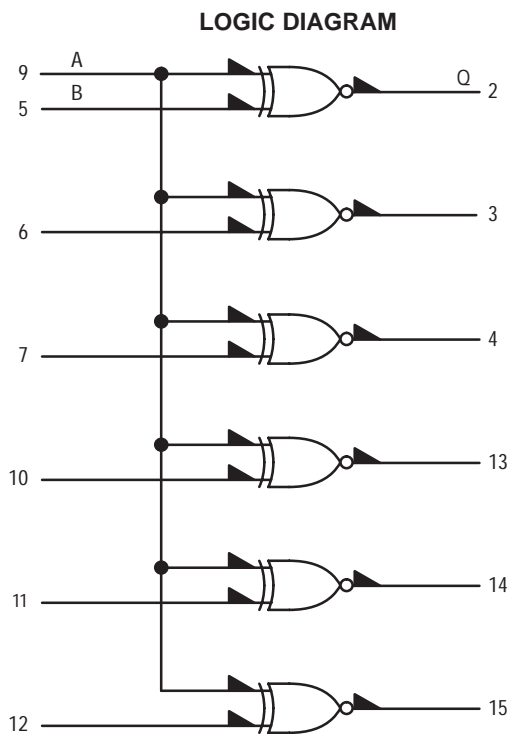
@ Test Temperature			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd	
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmx}	V _{VEE}		
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmx}	V _{VEE}		
Power Supply Drain Current	I _E	8					8	16	
Input Current	I _{inH}	5	5				8	16	
	I _{inL}	5		5			8	16	
Output Current High	Logic 1	I _{OH}	2		5,6,10,11		8	16	
Output Current Low	Logic 0	I _{OL}	2	5,6,10,11			8	16	
Threshold Current High	Logic 1	I _{OHC}	2		5,7,9,10,11		6	8	16
Threshold Current Low	Logic 0	I _{OLC}		5,10,11	7,9	6	8	16	
Output Sink Current Low	Logic 0	I _{OS}	2	5,6,10,11			8	16	
Load Return Voltage Absolute Max Rating (Note 1.)	V _{LR}						8	16	
Output Voltage Low (Note 2.)	V _{OLS}						8	16	

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Hex Inverter/Buffer

The MC10195 is a Hex Buffer Inverter which is built using six EXCLUSIVE NOR gates. There is a common input to these gates which when placed low or left open allows them to act as inverters. With the common input connected to a high logic level the MC10195 is a hex buffer, useful for high fanout clock driving and reducing stub lengths on long bus lines.

$P_D = 200 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 2.8 \text{ ns typ (B-Q)}$
 $t_{pd} = 3.8 \text{ ns typ (A-Q)}$
 $t_r, t_f = 2.5 \text{ ns typ (20\%-80\%)}$

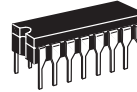


$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

TRUTH TABLE

Inputs		Output
A	B	Q
L	L	H
L	H	L
H	L	L
H	H	H

MC10195



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

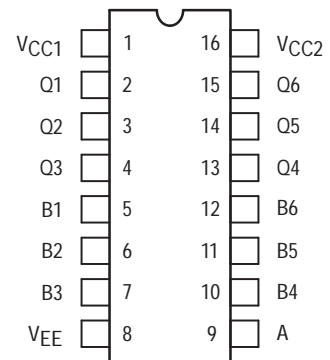


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

**DIP
PIN ASSIGNMENT**



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits						Unit	
			-30°C		+25°C		+85°C			
			Min	Max	Min	Typ	Max	Min		Max
Power Supply Drain Current	I _E	8		54		39	49		54	mAdc
Input Current	I _{inH}	5		425			265		265	μAdc
		9		460			290		290	
	I _{inL}	5	0.5		0.5			0.3		μAdc
Output Voltage Logic 1	V _{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
Output Voltage Logic 0	V _{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
Threshold Voltage Logic 1	V _{OHA}	2	-1.080		-0.980			-0.910		Vdc
Threshold Voltage Logic 0	V _{OLA}	2		-1.655			-1.630		-1.595	Vdc
Switching Times (50Ω Load)										ns
Propagation Delay	t ₅₊₂₋	2	1.1	4.2	1.1	2.8	4.0	1.1	4.4	
	t ₇₋₄₊	4	1.1	4.2	1.1	2.8	4.0	1.1	4.4	
	t ₁₀₊₁₃₊	13	1.1	4.2	1.1	2.8	4.0	1.1	4.4	
	t ₁₁₋₁₄₋	14	1.1	4.2	1.1	2.8	4.0	1.1	4.4	
	t ₉₋₁₄₋	14	1.1	5.2	1.1	3.8	5.0	1.1	5.4	
Rise Time (20 to 80%)	t ₂₊	2	1.1	4.7	1.1	2.5	4.5	1.1	5.0	
Fall Time (20 to 80%)	t ₂₋	2	1.1	4.7	1.1	2.5	4.5	1.1	5.0	

ELECTRICAL CHARACTERISTICS (continued)

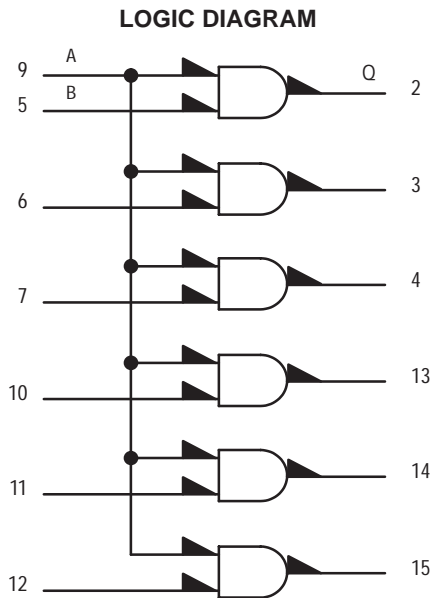
			TEST VOLTAGE VALUES (Volts)						
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmx}	V _{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					(V _{CC}) Gnd	
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmx}	V _{EE}		
Power Supply Drain Current	I _E	8					8	1, 16	
Input Current	I _{inH}	5	5				8	1, 16	
		9	9				8	1, 16	
	I _{inL}	5		5			8	1, 16	
Output Voltage Logic 1	V _{OH}	2					8	1, 16	
Output Voltage Logic 0	V _{OL}	2	9				8	1, 16	
Threshold Voltage Logic 1	V _{OHA}	2				5	8	1, 16	
Threshold Voltage Logic 0	V _{OLA}	2			5		8	1, 16	
Switching Times (50Ω Load)						Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	t ₅₊₂₋	2				5	2	8	1, 16
	t ₇₋₄₊	4				7	4	8	1, 16
	t ₁₀₊₁₃₊	13				10	13	8	1, 16
	t ₁₁₋₁₄₋	14				11	14	8	1, 16
	t ₉₋₁₄₋	14				9	14	8	1, 16
Rise Time (20 to 80%)	t ₂₊	2				5	2	8	1, 16
Fall Time (20 to 80%)	t ₂₋	2				5	2	8	1, 16

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Hex AND Gate

The MC10197 provides a high speed hex AND function with strobe capability.

$P_D = 200 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 2.8 \text{ ns typ (B-Q)}$
 $t_{pd} = 3.8 \text{ ns typ (A-Q)}$
 $t_r, t_f = 2.5 \text{ ns typ (20\%–80\%)}$

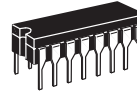


$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $VEE = \text{PIN } 8$

TRUTH TABLE

Inputs		Output
A	B	Q
L	L	L
L	H	L
H	L	L
H	H	H

MC10197



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

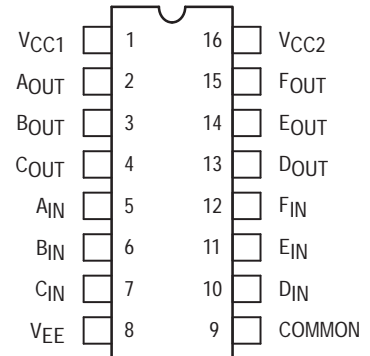


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

**DIP
PIN ASSIGNMENT**



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits						Unit	
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min		Max
Power Supply Drain Current	I _E	8		54		39	49		54	mAdc
Input Current	I _{inH}	5		425			265		265	μAdc
		9		460			290		290	
	I _{inL}	5	0.5		0.5		0.3			μAdc
Output Voltage Logic 1	V _{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
Output Voltage Logic 0	V _{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
Threshold Voltage Logic 1	V _{OHA}	2	-1.080		-0.980			-0.910		Vdc
Threshold Voltage Logic 0	V _{OLA}	2		-1.655			-1.630		-1.595	Vdc
Switching Times (50Ω Load)										ns
Propagation Delay	t ₅₊₂₊	2	1.1	4.2	1.1	2.8	4.0	1.1	4.4	
	t ₉₊₂₊	2	1.1	5.3	1.1	3.5	5.0	1.1	5.5	
Rise Time (20 to 80%)	t ₂₊	2	1.1	4.7	1.1	2.5	4.5	1.1	5.0	
Fall Time (20 to 80%)	t ₂₋	2	1.1	4.7	1.1	2.5	4.5	1.1	5.0	

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
@ Test Temperature								
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2	
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2	
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2	
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
Power Supply Drain Current	I _E	8					8	1, 16
Input Current	I _{inH}	5	5				8	1, 16
		9	9				8	1, 16
	I _{inL}	5		5			8	1, 16
Output Voltage Logic 1	V _{OH}	2	5, 9				8	1, 16
Output Voltage Logic 0	V _{OL}	2					8	1, 16
Threshold Voltage Logic 1	V _{OHA}	2	9		5		8	1, 16
Threshold Voltage Logic 0	V _{OLA}	2	9			5	8	1, 16
Switching Times (50Ω Load)								
Propagation Delay	t ₅₊₂₊	2		+1.11V	Pulse In	Pulse Out	-3.2 V	+2.0 V
				9	5	2	8	1, 16
	t ₉₊₂₊	2		5	9	2	8	1, 16
Rise Time (20 to 80%)	t ₂₊	2		9	5	2	8	1, 16
Fall Time (20 to 80%)	t ₂₋	2		9	5	2	8	1, 16

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

Monostable Multivibrator

The MC10198 is a retriggerable monostable multivibrator. Two enable inputs permit triggering on any combination of positive or negative edges as shown in the accompanying table. The trigger input is buffered by Schmitt triggers making it insensitive to input rise and fall times.

The pulse width is controlled by an external capacitor and resistor. The resistor sets a current which is the linear discharge rate of the capacitor. Also, the pulse width can be controlled by an external current source or voltage (see applications information).

For high-speed response with minimum delay, a hi-speed input is also provided. This input bypasses the internal Schmitt triggers and the output responds within 2 nanoseconds typically.

Output logic and threshold levels are standard MECL 10,000. Test conditions are per Table 2. Each "Precondition" referred to in Table 2 is per the sequence of Table 1.

$$P_D = 415 \text{ mW typ/pkg (No Load)}$$

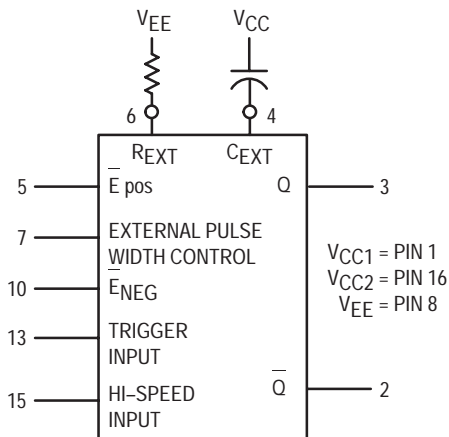
$$t_{pd} = 4.0 \text{ ns typ Trigger Inpt to Q}$$

$$2.0 \text{ ns typ Hi-Speed Input to Q}$$

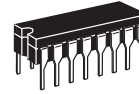
Min Timing Pulse Width	PW _{Qmin}	10 ns typ ¹
Max Timing Pulse Width	PW _{Qmax}	>10 ms typ ²
Min Trigger Pulse Width	PW _T	2.0 ns typ
Min Hi-Speed	PW _{HS}	3.0 ns typ
Trigger Pulse Width		
Enable Setup Time	t _{set}	1.0 ns typ
Enable Hold Time	t _{hold}	1.0 ns typ

- ¹ C_{Ext} = 0 (Pin 4 open), R_{Ext} = 0 (Pin 6 to V_{EE})
- ² C_{Ext} = 10 μF, R_{Ext} = 2.7 kΩ

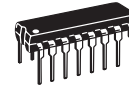
LOGIC DIAGRAM



MC10198



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

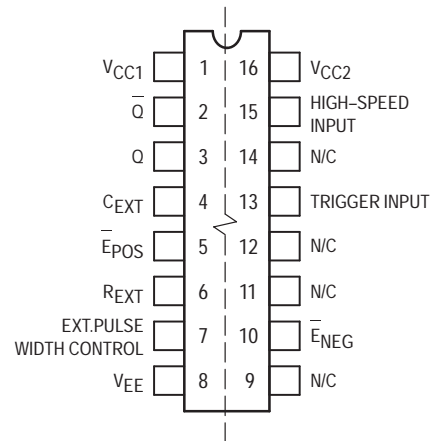


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



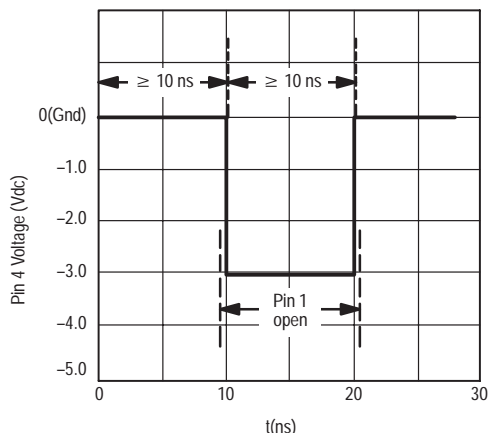
Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.

TRUTH TABLE

INPUT		OUTPUT
E _{Pos}	E _{Neg}	
L	L	Triggers on both positive & negative input slopes
L	H	Triggers on positive input slope
H	L	Triggers on negative input slope
H	H	Trigger is disabled

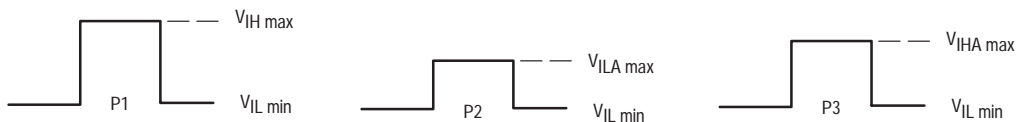


TABLE 1 — PRECONDITION SEQUENCE



1. At $t = 0$
 - a.) Apply V_{IHmax} to Pin 5 and 10.
 - b.) Apply V_{ILmin} to Pin 15.
 - c.) Ground Pin 4.
2. At $t \geq 10$ ns
 - a.) Open Pin 1.
 - b.) Apply -3.0 Vdc to Pin 4. Hold these conditions for ≥ 10 ns.
3. Return Pin 4 to Ground and perform test as indicated in Table 2.

TABLE 2 — CONDITIONS FOR TESTING OUTPUT LEVELS
(See Table 1 for Precondition Sequence)



Pins 1, 16 = $V_{CC} =$ Ground
 Pins 6, 8 = $V_{EE} = -5.2$ Vdc
 Outputs loaded 50Ω to -2.0 Vdc

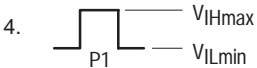
Test	P.U.T.	Pin Conditions			
		5	10	13	15
Precondition					
V_{OH}	2			$V_{IL min}$	
V_{OH}	3			P1	
Precondition					
V_{OL}	3			$V_{IL min}$	
V_{OL}	2			P1	
Precondition					
V_{OHA}	2				$V_{ILA max}$
V_{OHA}	3				$V_{IHA min}$
Precondition					
V_{OHA}	2			$V_{IL min}$	
V_{OHA}	3			P3	
Precondition					
V_{OHA}	2			P2	
V_{OHA}	3			P3	
Precondition					
V_{OHA}	2		$V_{IH max}$	P2	
V_{OHA}	3		$V_{IH max}$	P3	
Precondition					
V_{OHA}	2		$V_{IH max}$	P1	
V_{OHA}	3		$V_{IH max}$	P1	

Test	P.U.T.	Pin Conditions			
		5	10	13	15
Precondition					
V_{OHA}	2		$V_{IHA min}$	P1	
V_{OHA}	3		$V_{ILA max}$	P1	
Precondition					
V_{OLA}	3				$V_{ILA max}$
V_{OLA}	2				$V_{IHA min}$
Precondition					
V_{OLA}	2			$V_{IL min}$	
V_{OLA}	3			$V_{IL min}$	
Precondition					
V_{OLA}	3			P2	
V_{OLA}	2			P3	
Precondition					
V_{OLA}	3		$V_{IH max}$	P2	
V_{OLA}	2		$V_{IH max}$	P3	
Precondition					
V_{OLA}	3	$V_{IHA min}$	$V_{IH max}$	P1	
V_{OLA}	2	$V_{ILA max}$	$V_{IH max}$	P1	
Precondition					
V_{OLA}	3	$V_{IH max}$	$V_{IHA min}$	P1	
V_{OLA}	2	$V_{IH max}$	$V_{ILA max}$	P1	

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I_E	8		110		80	100		110	mAdc
Input Current	I_{inH}	5, 10		415			260		260	μ Adc
		13		350			220		220	
15			560			350		350		
	I_{inL}	5	0.5		0.5			0.3		μ Adc
Output Voltage Logic 1	V_{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Output Voltage Logic 0	V_{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V_{OHA}	2	-1.080		-0.980			-0.910		Vdc
		3	-1.080		-0.980			-0.910		
Threshold Voltage Logic 0	V_{OLA}	2		-1.655			-1.630		-1.595	Vdc
		3		-1.655			-1.630		-1.595	
Switching Times (50Ω Load)										
Trigger Input	t_{T+Q+}	3	2.5	6.5	2.5	4.0	5.5	2.5	6.5	ns
	t_{T-Q+}	3	2.5	6.5	2.5	4.0	5.5	2.5	6.5	
High Speed Trigger Input	t_{HS+Q+}	3	1.5	3.2	1.5	2.0	2.8	1.5	3.2	ns
Minimum Timing Pulse Width	PW_{Qmin}	3				10.0				ns
Maximum Timing Pulse Width	PW_{Qmax}	3				>10				ms
Min Trigger Pulse Width	PW_T	3				2.0				ns
Min Hi-Spd Trig Pulse Width	PW_{HS}	3				3.0				ns
Rise Time (20 to 80%)		3	1.5	4.0	1.5		3.5	1.5	4.0	ns
Fall Time (20 to 80%)		3	1.5	4.0	1.5		3.5	1.5	4.0	ns
Enable Setup Time	$t_{setup}(E)$	3				1.0				ns
Enable Hold Time	$t_{hold}(E)$	3				1.0				ns

1. The monostable is in the timing mode at the time of this test.
2. $C_{EXT} = 0$ (Pin 4 Open); $R_{EXT} = 0$ (Pin 6 tied to V_{EE}).
3. $C_{EXT} = 10\mu F$ (Pin); $R_{EXT} = 2.7k$ (Pin 6).




ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V_{CC}) Gnd
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}	
@ Test Temperature								
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2	
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2	
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2	
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}	
Power Supply Drain Current	I_E	8					6, 8	1, 4, 16
Input Current	I_{inH}	5, 10	5, 10				6, 8	1, 4, 16
		13 15	13 15				6, 8 6, 8	1, 4, 16 1, 4, 16
Output Voltage Logic 1	V_{OH}	2		13			6, 8	1, 4, 16
		3	13 (4.)				6, 8	1, 4, 16
Output Voltage Logic 0	V_{OL}	2					6, 8	1, 4, 16
		3	13 (4.)	13			6, 8	1, 4, 16
Threshold Voltage Logic 1	V_{OHA}	2				15	6, 8	1, 16, 4
		3				15	6, 8	1, 16, 4
Threshold Voltage Logic 0	V_{OLA}	2				15	6, 8	1, 16, 4
		3				15	6, 8	1, 16, 4
Switching Times (50Ω Load)			+1.11V		Pulse In	Pulse Out	-3.2 V	+2.0 V
Trigger Input	t_{T+Q+}	3	10		13	3	6, 8	1, 16, 4
	t_{T-Q+}	3	5		13	3	6, 8	1, 16, 4
High Speed Trigger Input	t_{HS+Q+}	3			15	3	6, 8	1, 16, 4
Minimum Timing Pulse Width	PW_{Qmin}	3				Note 2.	6, 8	1, 16, 4
Maximum Timing Pulse Width	PW_{Qmax}	3				Note 3.	6, 8	1, 16, 4
Minimum Trigger Pulse Width	PW_T	3			13	3	6, 8	1, 16, 4
Minimum Hi-Spd Trigger Pulse Width	PW_{HS}	3			15	3	6, 8	1, 16, 4
Rise Time (20 to 80%)		3					6, 8	1, 16, 4
Fall Time (20 to 80%)		3					6, 8	1, 16, 4
Enable Setup Time	$t_{setup}(E)$	3			5	3	6, 8	1, 16, 4
Enable Hold Time	$t_{hold}(E)$	3			5	3	6, 8	1, 16, 4

1. The monostable is in the timing mode at the time of this test.

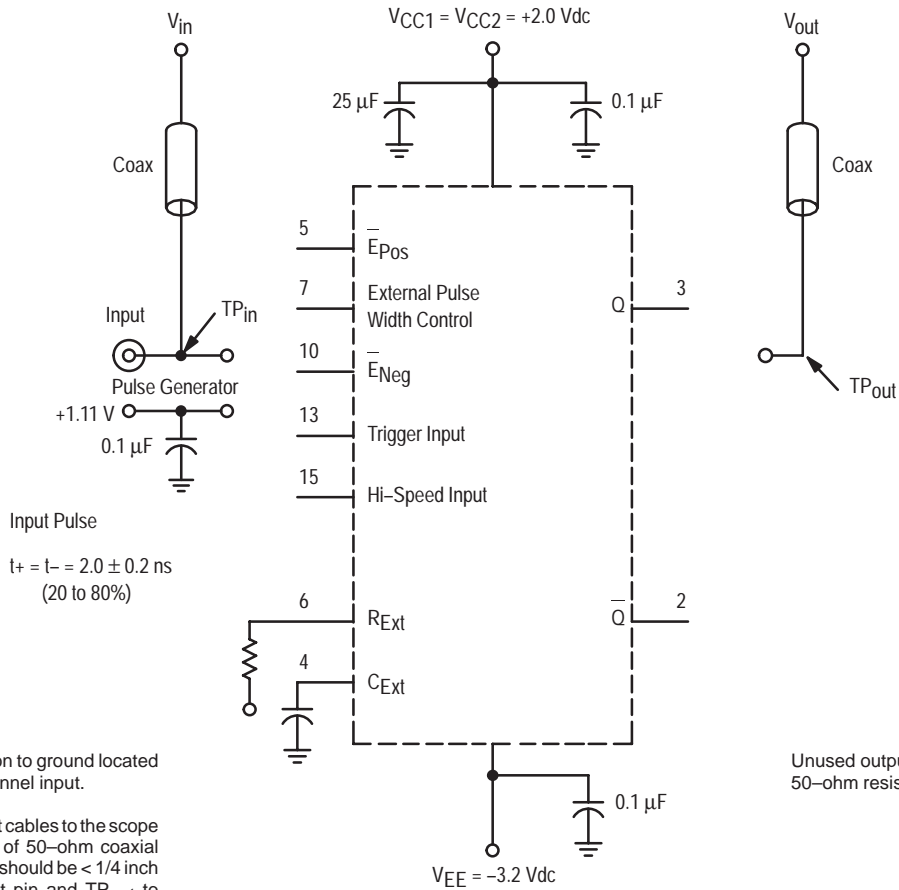
2. $C_{EXT} = 0$ (Pin 4 Open); $R_{EXT} = 0$ (Pin 6 tied to V_{EE}).

3. $C_{EXT} = 10\mu F$ (Pin); $R_{EXT} = 2.7k$ (Pin 6).

4. 

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

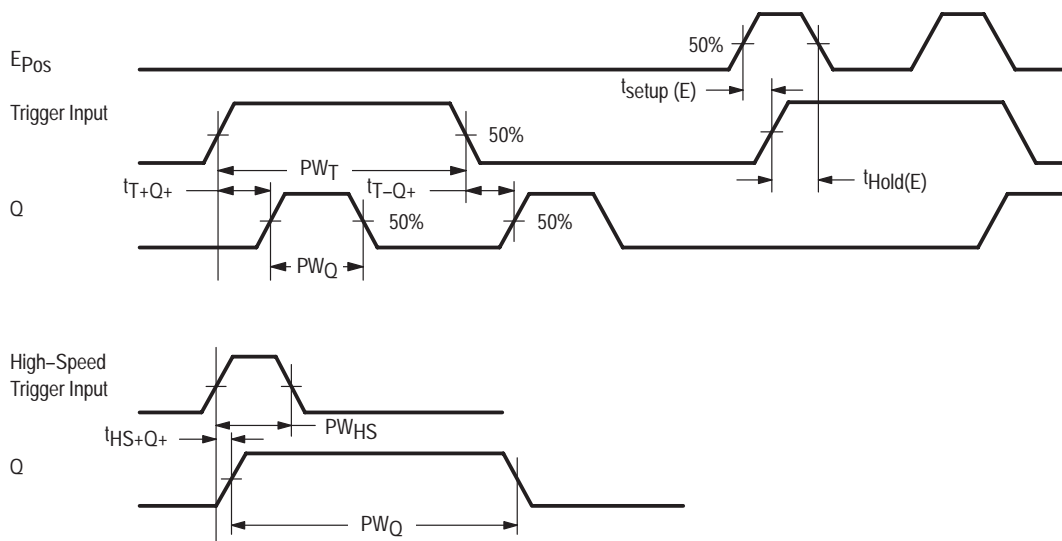
SWITCHING TIME TEST CIRCUIT AND WAVEFORMS @ 25°C



50-ohm termination to ground located in each scope channel input.

All input and output cables to the scope are equal lengths of 50-ohm coaxial cable. Wire length should be < 1/4 inch from TP_{in} to input pin and TP_{out} to output pin.

Unused outputs are tied to a 50-ohm resistor to ground.



APPLICATIONS INFORMATION

Circuit Operation:

1. PULSE WIDTH TIMING — The pulse width is determined by the external resistor and capacitor. The MC10198 also has an internal resistor (nominally 284 ohms) that can be used in series with R_{Ext}. Pin 7, the external pulse width control, is a constant voltage node (-3.60 V nominally). A resistance connected in series from this node to V_{EE} sets a constant timing current I_T. This current determines the discharge rate of the capacitor:

$$I_T = C_{Ext} \frac{\Delta V}{\Delta T}$$

where

ΔT = pulse width

ΔV = 1.9 V change in capacitor voltage

Then:

$$\Delta T = C_{Ext} \frac{1.9 V}{I_T}$$

If R_{Ext} + R_{Int} are in series to V_{EE}:

$$I_T = [(-3.60 V) - (-5.2 V)] \div [R_{Ext} + 284 \Omega]$$

$$I_T = 1.6 V / (R_{Ext} + 284)$$

The timing equation becomes:

$$\Delta T = [(C_{Ext})(1.9 V)] \div [1.6 V / (R_{Ext} + 284)]$$

$$\Delta T = C_{Ext} (R_{Ext} + 284) 1.19$$

where ΔT = Sec

R_{Ext} = Ohms

C_{Ext} = Farads

FIGURE 1 —

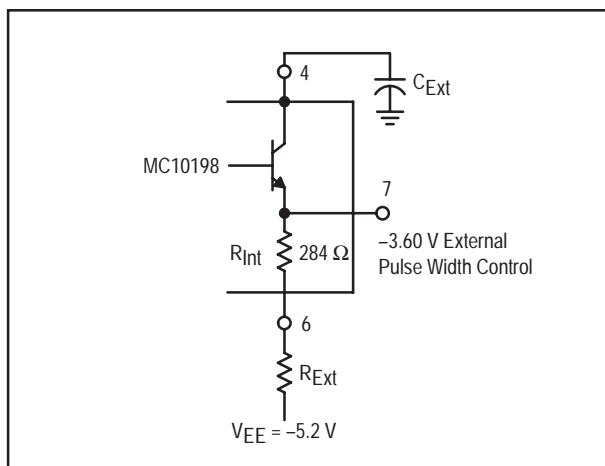


Figure 2 shows typical curves for pulse width versus C_{Ext} and R_{Ext} (total resistance includes R_{Int}). Any low leakage capacitor can be used and R_{Ext} can vary from 0 to 16 k-ohms.

2. TRIGGERING — The \bar{E}_{Pos} and \bar{E}_{Neg} inputs control the trigger input. The MC10198 can be programmed to trigger on the positive edge, negative edge, or both. Also, the trigger input can be totally disabled. The truth table is shown on the first page of the data sheet.

The device is totally retriggerable. However, as duty cycle approaches 100%, pulse width jitter can occur due to the recovery time of the circuit. Recovery time is basically dependent on capacitance C_{Ext}. Figure 3 shows typical recovery time versus capacitance at I_T = 5 mA.

FIGURE 2 — TIMING PULSE WIDTH versus C_{Ext} and R_{Ext}

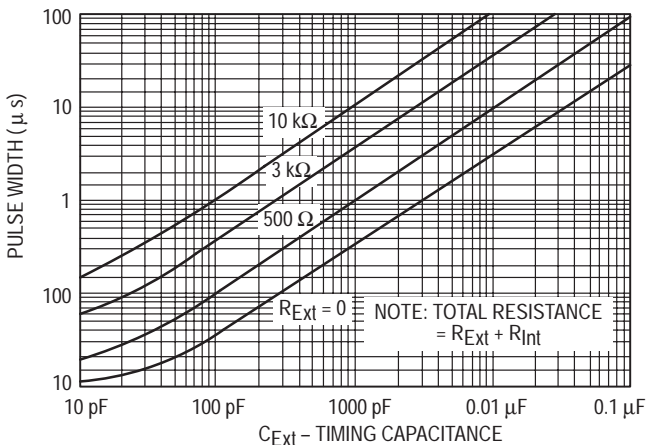
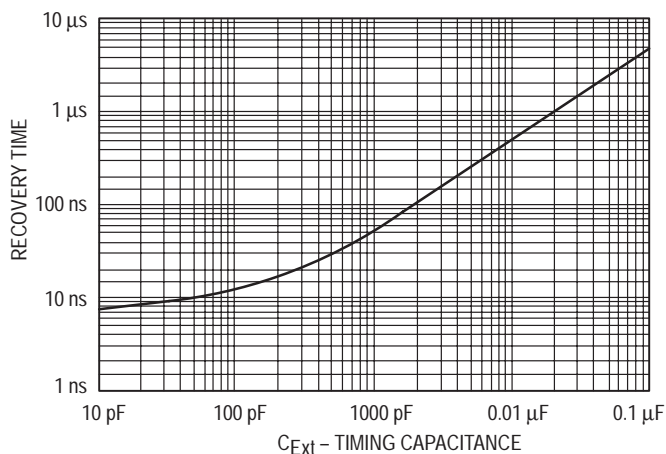


FIGURE 3 — RECOVERY TIME versus C_{Ext} @ I_T = 5 mA

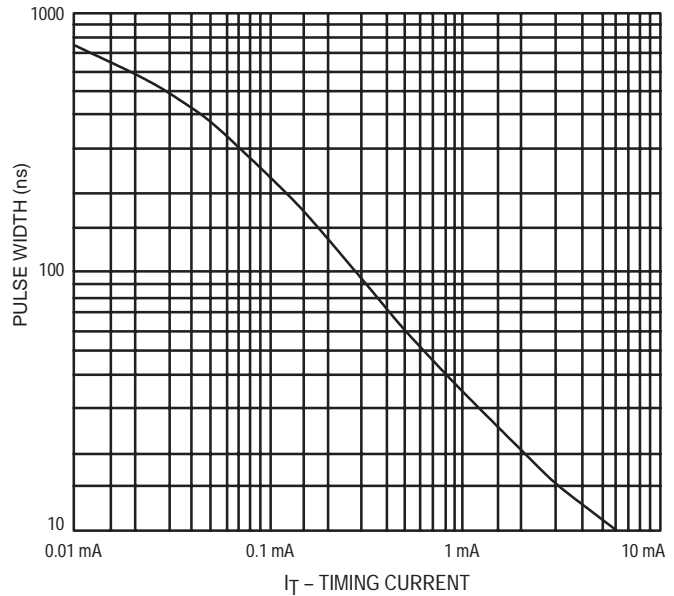


3. HI-SPEED INPUT — This input is used for stretching very narrow pulses with minimum delay between the output pulse and the trigger pulse. The trigger input should be disabled when using the high-speed input. The MC10198 triggers on the rising edge, using this input, and input pulse width should narrow, typically less than 10 nanoseconds.

USAGE RULES:

1. Capacitor lead lengths should be kept very short to minimize ringing due to fast recovery rise times.
2. The E inputs should not be tied to ground to establish a high logic level. A resistor divider or diode can be used to establish a -0.7 to -0.9 voltage level.
3. For optimum temperature stability; 0.5 mA is the best timing current I_T . The device is designed to have a constant voltage at the EXTERNAL PULSE WIDTH CONTROL over temperature at this current value.
4. Pulse Width modulation can be attained with the EXTERNAL PULSE WIDTH CONTROL. The timing current can be altered to vary the pulse width. Two schemes are:
 - a. The internal resistor is not used. A dependent current source is used to set the timing current as shown in Figure 4. A graph of pulse width versus timing current ($C_{Ext} = 13$ pF) is shown in Figure 5.

FIGURE 5 — PULSE WIDTH versus I_T @ $C_{Ext} = 13$ pF



- b. A control voltage can also be used to vary the pulse width using an additional resistor (Figure 6). The current ($I_T + I_C$) is set by the voltage drop across $R_{Int} + R_{Ext}$. The control current I_C modifies I_T and alters the pulse width. Current I_C should never force I_T to zero. R_C typically 1 k Ω .

FIGURE 4 —

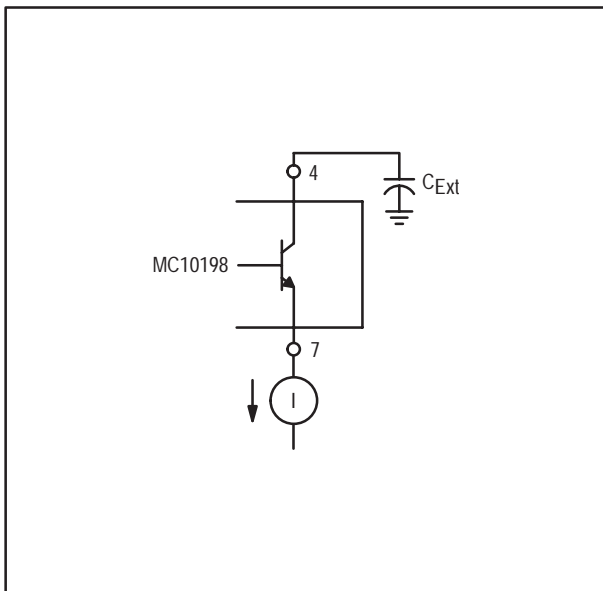
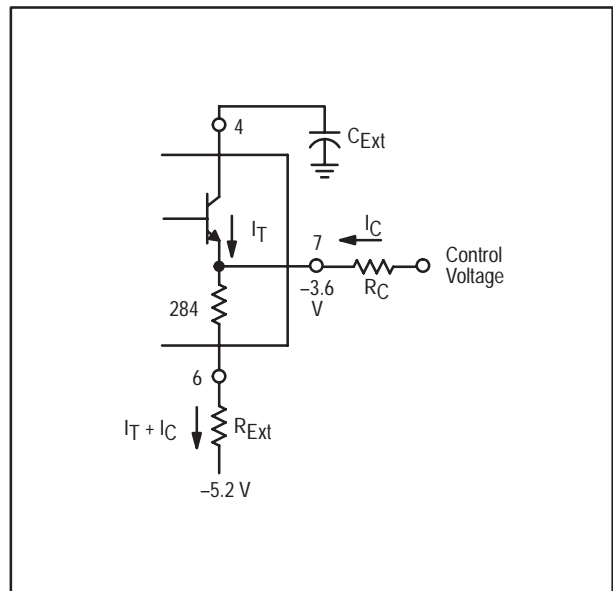
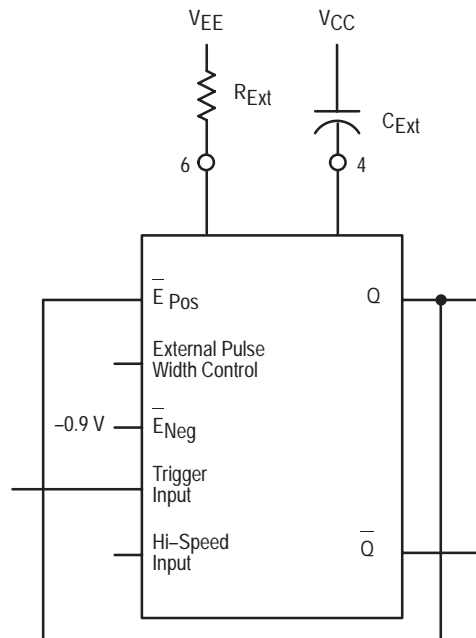


FIGURE 6 —



5. The MC10198 can be made non-retriggerable. The Q output is fed back to disable the trigger input during the triggered state (Logic Diagram). Figure 7 shows a positive triggered configuration; a similar configuration can be made for negative triggering.

FIGURE 7 —



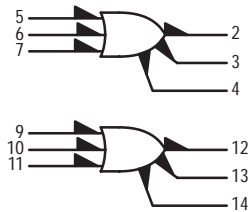
Dual 3-Input/3-Output OR Gate

The MC10210 is designed to drive up to six transmission lines simultaneously. The multiple outputs of this device also allow the wire "OR"-ing of several levels of gating for minimization of gate and package count.

The ability to control three parallel lines with minimum propagation delay from a single point makes the MC10210 particularly useful in clock distribution applications where minimum clock skew is desired.

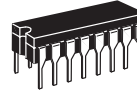
$P_D = 160 \text{ mW typ/pkg (No Loads)}$
 $t_{pd} = 1.5 \text{ ns typ (All Output Loaded)}$
 $t_r, t_f = 1.5 \text{ ns typ (20\%–80\%)}$

LOGIC DIAGRAM

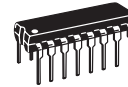


$V_{CC1} = \text{PIN } 1, 15$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

MC10210



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

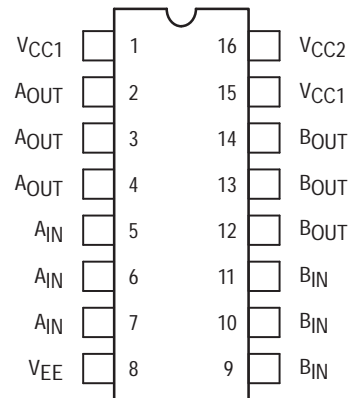


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit	
			-30°C		+25°C			+85°C			
			Min	Max	Min	Typ	Max	Min	Max		
Power Supply Drain Current	I_E	8		42			38		42	mAdc	
Input Current	I_{inH}	5, 6, 7		650			410		410	μ Adc	
	I_{inL}	5, 6, 7	0.5		0.5			0.3		μ Adc	
Output Voltage Logic 1	V_{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc	
		3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700		
		4	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700		
Output Voltage Logic 0	V_{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc	
		3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615		
		4	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615		
Threshold Voltage Logic 1	V_{OHA}	2	-1.080		-0.980			-0.910		Vdc	
		3	-1.080		-0.980			-0.910			
		4	-1.080		-0.980			-0.910			
Threshold Voltage Logic 0	V_{OLA}	2		-1.655			-1.630		-1.595	Vdc	
		3		-1.655			-1.630		-1.595		
		4		-1.655			-1.630		-1.595		
Switching Times (50 Ω Load)										ns	
Propagation Delay	t_{5+2+}	2	1.0	2.6	1.0	1.5	2.5	1.0	2.8		
		t_{5-2-}	2	1.0	2.6	1.0	1.5	2.5	1.0		2.8
		t_{5+3+}	3	1.0	2.6	1.0	1.5	2.5	1.0		2.8
		t_{5-3-}	3	1.0	2.6	1.0	1.5	2.5	1.0		2.8
		t_{5+4+}	4	1.0	2.6	1.0	1.5	2.5	1.0		2.8
		t_{5-4-}	4	1.0	2.6	1.0	1.5	2.5	1.0		2.8
Rise Time (20 to 80%)	t_{2+}	2	1.0	2.6	1.0	1.5	2.5	1.0	2.8		
		t_{3+}	3	1.0	2.6	1.0	1.5	2.5	1.0		2.8
		t_{4+}	4	1.0	2.6	1.0	1.5	2.5	1.0		2.8
Fall Time (20 to 80%)	t_{2-}	2	1.0	2.6	1.0	1.5	2.5	1.0	2.8		
		t_{3-}	3	1.0	2.6	1.0	1.5	2.5	1.0		2.8
		t_{4-}	4	1.0	2.6	1.0	1.5	2.5	1.0		2.8

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd	
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
Power Supply Drain Current	I _E	8					8	1, 15, 16	
Input Current	I _{inH}	5, 6, 7	*				8	1, 15, 16	
	I _{inL}	5, 6, 7		*			8	1, 15, 16	
Output Voltage Logic 1	V _{OH}	2	5				8	1, 15, 16	
		3	6				8	1, 15, 16	
		4	7				8	1, 15, 16	
Output Voltage Logic 0	V _{OL}	2					8	1, 15, 16	
		3					8	1, 15, 16	
		4					8	1, 15, 16	
Threshold Voltage Logic 1	V _{OHA}	2			5		8	1, 15, 16	
		3			6		8	1, 15, 16	
		4			7		8	1, 15, 16	
Threshold Voltage Logic 0	V _{OLA}	2				5	8	1, 15, 16	
		3				6	8	1, 15, 16	
		4				7	8	1, 15, 16	
Switching Times (50Ω Load)					Pulse In	Pulse Out	-3.2 V	+2.0 V	
Propagation Delay	t ₅₊₂₊	2				5	2	8	1, 15, 16
	t ₅₋₂₋	2				5	2	8	1, 15, 16
	t ₅₊₃₊	3				5	3	8	1, 15, 16
	t ₅₋₃₋	3				5	3	8	1, 15, 16
	t ₅₊₄₊	4				5	4	8	1, 15, 16
	t ₅₋₄₋	4				5	4	8	1, 15, 16
Rise Time (20 to 80%)	t ₂₊	2				5	2	8	1, 15, 16
	t ₃₊	3				5	3	8	1, 15, 16
	t ₄₊	4				5	4	8	1, 15, 16
Fall Time (20 to 80%)	t ₂₋	2				5	2	8	1, 15, 16
	t ₃₋	3				5	3	8	1, 15, 16
	t ₄₋	4				5	4	8	1, 15, 16

* Individually test each input using the pin connections shown.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

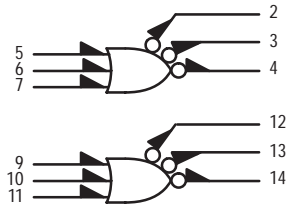
Dual 3-Input/3-Output NOR Gate

The MC10211 is designed to drive up to six transmission lines simultaneously. The multiple outputs of this device also allow the wire "OR"-ing of several levels of gating for minimization of gate and package count.

The ability to control three parallel lines with minimum propagation delay from a single point makes the MC10211 particularly useful in clock distribution applications where minimum clock skew is desired.

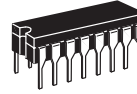
$P_D = 160 \text{ mW typ/pkg (No Loads)}$
 $t_{pd} = 1.5 \text{ ns typ (All Output Loaded)}$
 $t_r, t_f = 1.5 \text{ ns typ (20\%–80\%)}$

LOGIC DIAGRAM

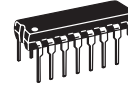


$V_{CC1} = \text{PIN } 1, 15$
 $V_{CC2} = \text{PIN } 16$
 $VEE = \text{PIN } 8$

MC10211



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

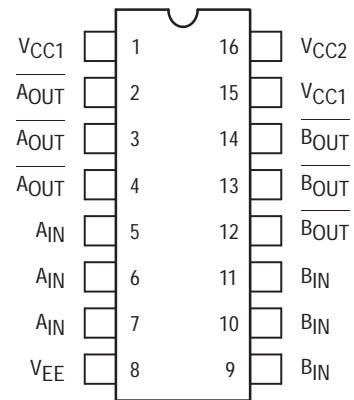


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I _E	8		42		30	38		42	mAdc
Input Current	I _{inH}	5, 6, 7		650			410		410	μAdc
	I _{inL}	5, 6, 7	0.5		0.5			0.3		μAdc
Output Voltage Logic 1	V _{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
		4	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Output Voltage Logic 0	V _{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
		4	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V _{OHA}	2	-1.080		-0.980			-0.910		Vdc
		3	-1.080		-0.980			-0.910		
		4	-1.080		-0.980			-0.910		
Threshold Voltage Logic 0	V _{OLA}	2		-1.655			-1.630		-1.595	Vdc
		3		-1.655			-1.630		-1.595	
		4		-1.655			-1.630		-1.595	
Switching Times (50Ω Load)									ns	
Propagation Delay	t ₅₊₂₋ t ₅₋₂₊ t ₅₊₃₋ t ₅₋₃₊ t ₅₊₄₋ t ₅₋₄₊	2	1.0	2.6	1.0	1.5	2.5	1.0	2.8	
		2	1.0	2.6	1.0	1.5	2.5	1.0	2.8	
		3	1.0	2.6	1.0	1.5	2.5	1.0	2.8	
		3	1.0	2.6	1.0	1.5	2.5	1.0	2.8	
		4	1.0	2.6	1.0	1.5	2.5	1.0	2.8	
		4	1.0	2.6	1.0	1.5	2.5	1.0	2.8	
Rise Time (20 to 80%)	t ₂₊ t ₃₊ t ₄₊	2	1.0	2.6	1.0	1.5	2.5	1.0	2.8	
		3	1.0	2.6	1.0	1.5	2.5	1.0	2.8	
		4	1.0	2.6	1.0	1.5	2.5	1.0	2.8	
Fall Time (20 to 80%)	t ₂₋ t ₃₋ t ₄₋	2	1.0	2.6	1.0	1.5	2.5	1.0	2.8	
		3	1.0	2.6	1.0	1.5	2.5	1.0	2.8	
		4	1.0	2.6	1.0	1.5	2.5	1.0	2.8	

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd	
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
Power Supply Drain Current	I _E	8					8	1, 15, 16	
Input Current	I _{inH}	5, 6, 7	*				8	1, 15, 16	
	I _{inL}	5, 6, 7		*			8	1, 15, 16	
Output Voltage Logic 1	V _{OH}	2					8	1, 15, 16	
		3					8	1, 15, 16	
		4					8	1, 15, 16	
Output Voltage Logic 0	V _{OL}	2	5				8	1, 15, 16	
		3	6				8	1, 15, 16	
		4	7				8	1, 15, 16	
Threshold Voltage Logic 1	V _{OHA}	2				5	8	1, 15, 16	
		3				6	8	1, 15, 16	
		4				7	8	1, 15, 16	
Threshold Voltage Logic 0	V _{OLA}	2			5		8	1, 15, 16	
		3			6		8	1, 15, 16	
		4			7		8	1, 15, 16	
Switching Times (50Ω Load)						Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	t ₅₊₂₋	2				5	2	8	1, 15, 16
	t ₅₋₂₊	2				5	2	8	1, 15, 16
	t ₅₊₃₋	3				5	3	8	1, 15, 16
	t ₅₋₃₊	3				5	3	8	1, 15, 16
	t ₅₊₄₋	4				5	4	8	1, 15, 16
	t ₅₋₄₊	4				5	4	8	1, 15, 16
Rise Time (20 to 80%)	t ₂₊	2				5	2	8	1, 15, 16
	t ₃₊	3				5	3	8	1, 15, 16
	t ₄₊	4				5	4	8	1, 15, 16
Fall Time (20 to 80%)	t ₂₋	2				5	2	8	1, 15, 16
	t ₃₋	3				5	3	8	1, 15, 16
	t ₄₋	4				5	4	8	1, 15, 16

* Individually test each input using the pin connections shown.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

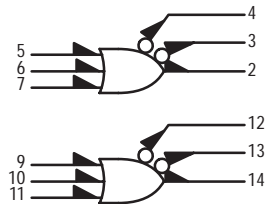
High Speed Dual 3-Input/ 3-Output OR/NOR Gate

The MC10212 is designed to drive up to six transmission lines simultaneously. The multiple outputs of this device also allow the wire "OR"-ing of several levels of gating for minimization of gate and package count.

The ability to control three parallel lines with minimum propagation delay from a single point makes the MC10212 particularly useful in clock distribution applications where minimum clock skew is desired.

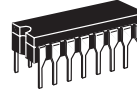
$P_D = 160 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 1.5 \text{ ns typ (All Outputs Loaded)}$
 $t_r, t_f = 1.5 \text{ ns typ (20\%–80\%)}$

LOGIC DIAGRAM



$V_{CC1} = \text{PIN } 1, 15$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

MC10212



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

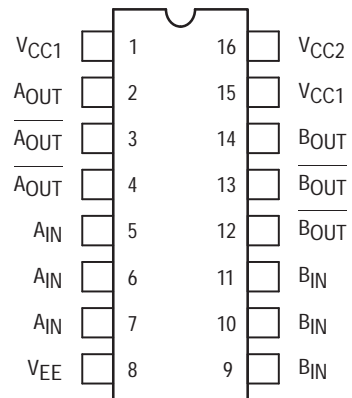


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit	
			-30°C		+25°C			+85°C			
			Min	Max	Min	Typ	Max	Min	Max		
Power Supply Drain Current	I_E	8		42		30	38		42	mAdc	
Input Current	I_{inH}	5, 6, 7		650			410		410	μ Adc	
	I_{inL}	5, 6, 7	0.5		0.5			0.3		μ Adc	
Output Voltage Logic 1	V_{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc	
		3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700		
		4	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700		
Output Voltage Logic 0	V_{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc	
		3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615		
		4	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615		
Threshold Voltage Logic 1	V_{OHA}	2	-1.080		-0.980			-0.910		Vdc	
		3	-1.080		-0.980			-0.910			
		4	-1.080		-0.980			-0.910			
Threshold Voltage Logic 0	V_{OLA}	2		-1.655			-1.630		-1.595	Vdc	
		3		-1.655			-1.630		-1.595		
		4		-1.655			-1.630		-1.595		
Switching Times (50 Ω Load)										ns	
Propagation Delay	t_{5+2+}	2	1.0	2.6	1.0	1.5	2.5	1.0	2.8		
		t_{5-2-}	2	1.0	2.6	1.0	1.5	2.5	1.0		2.8
		t_{5+3-}	3	1.0	2.6	1.0	1.5	2.5	1.0		2.8
		t_{5-3+}	3	1.0	2.6	1.0	1.5	2.5	1.0		2.8
		t_{5+4-}	4	1.0	2.6	1.0	1.5	2.5	1.0		2.8
		t_{5-4+}	4	1.0	2.6	1.0	1.5	2.5	1.0		2.8
Rise Time (20 to 80%)	t_{2+}	2	1.0	2.6	1.0	1.5	2.5	1.0	2.8		
		t_{3+}	3	1.0	2.6	1.0	1.5	2.5	1.0		2.8
		t_{4+}	4	1.0	2.6	1.0	1.5	2.5	1.0		2.8
Fall Time (20 to 80%)	t_{2-}	2	1.0	2.6	1.0	1.5	2.5	1.0	2.8		
		t_{3-}	3	1.0	2.6	1.0	1.5	2.5	1.0		2.8
		t_{4-}	4	1.0	2.6	1.0	1.5	2.5	1.0		2.8

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd	
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
@ Test Temperature									
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2		
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2		
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2		
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}		
Power Supply Drain Current	I _E	8					8	1, 15, 16	
Input Current	I _{inH}	5, 6, 7	5, 6, 7*				8	1, 15, 16	
	I _{inL}	5, 6, 7		5, 6, 7*			8	1, 15, 16	
Output Voltage Logic 1	V _{OH}	2	5				8	1, 15, 16	
		3					8	1, 15, 16	
		4					8	1, 15, 16	
Output Voltage Logic 0	V _{OL}	2					8	1, 15, 16	
		3	5				8	1, 15, 16	
		4	5				8	1, 15, 16	
Threshold Voltage Logic 1	V _{OHA}	2			5		8	1, 15, 16	
		3				5	8	1, 15, 16	
		4				5	8	1, 15, 16	
Threshold Voltage Logic 0	V _{OLA}	2				5	8	1, 15, 16	
		3			5		8	1, 15, 16	
		4			5		8	1, 15, 16	
Switching Times (50Ω Load)						Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	t ₅₊₂₊	2				5	2	8	1, 15, 16
	t ₅₋₂₋	2				5	2	8	1, 15, 16
	t ₅₊₃₋	3				5	3	8	1, 15, 16
	t ₅₋₃₊	3				5	3	8	1, 15, 16
	t ₅₊₄₋	4				5	4	8	1, 15, 16
	t ₅₋₄₊	4				5	4	8	1, 15, 16
Rise Time (20 to 80%)	t ₂₊	2				5	2	8	1, 15, 16
	t ₃₊	3				5	3	8	1, 15, 16
	t ₄₊	4				5	4	8	1, 15, 16
Fall Time (20 to 80%)	t ₂₋	2				5	2	8	1, 15, 16
	t ₃₋	3				5	3	8	1, 15, 16
	t ₄₋	4				5	4	8	1, 15, 16

* Individually test each input using the pin connections shown.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

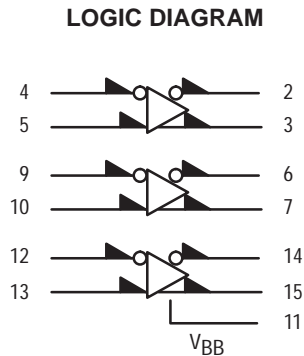
High Speed Triple Line Receiver

The MC10216 is a high speed triple differential amplifier designed for use in sensing differential signals over long lines. The base bias supply (V_{BB}) is made available at pin 11 to make the device useful as a Schmitt trigger, or in other applications where a stable reference voltage is necessary.

Active current sources provide the MC10216 with excellent common mode noise rejection. If any amplifier in a package is not used, one input of that amplifier must be connected to V_{BB} (pin 11) to prevent upsetting the current source bias network.

Complementary outputs are provided to allow driving twisted pair lines, to enable cascading of several amplifiers in a chain, or simply to provide complement outputs of the input logic function.

$P_D = 100$ mW typ/pkg (No Load)
 $t_{pd} = 1.8$ ns typ (Single ended)
 $= 1.5$ ns typ (Differential)
 $t_r, t_f = 1.5$ ns typ (20%–80%)

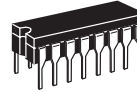


$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

* V_{BB} to be used to supply bias to the MC10216 only and bypassed (when used) with 0.01 μF to 0.1 μF capacitor.

When the input pin with bubble goes positive, it's respective output pin with bubble goes positive.

MC10216



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

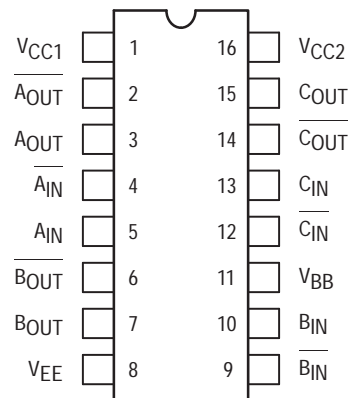


P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits						Unit	
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min		Max
Power Supply Drain Current	I_E	8		27		20	25		27	mAdc
Input Current	I_{inH}	4		180			115		115	μ Adc
	I_{CBO}	4 9		1.5 1.5			1.0 1.0		1.0 1.0	μ Adc
Output Voltage Logic 1	V_{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	
Output Voltage Logic 0	V_{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V_{OHA}	2	-1.080		-0.980			-0.910		Vdc
		3	-1.080		-0.980			-0.910		
Threshold Voltage Logic 0	V_{OLA}	2		-1.655			-1.630		-1.595	Vdc
		3		-1.655			-1.630		-1.595	
Reference Voltage	V_{BB}	11	-1.420	-1.280	-1.350		-1.230	-1.295	-1.150	Vdc
Switching Times (50 Ω Load)										ns
Propagation Delay	t_{4+2+} t_{4-2-} t_{4+3-} t_{4-3+}	2	1.0	2.6	1.0	1.8*	2.5	1.0	2.8	
		2	1.0	2.6	1.0	1.8*	2.5	1.0	2.8	
		3	1.0	2.6	1.0	1.8*	2.5	1.0	2.8	
		3	1.0	2.6	1.0	1.8*	2.5	1.0	2.8	
Rise Time (20 to 80%)	t_{2+} t_{3+}	2	1.0	2.6	1.0	1.5	2.5	1.0	2.8	
		3	1.0	2.6	1.0	1.5	2.5	1.0	2.8	
Fall Time (20 to 80%)	t_{2-} t_{3-}	2	1.0	2.6	1.0	1.5	2.5	1.0	2.8	
		3	1.0	2.6	1.0	1.5	2.5	1.0	2.8	

* Delay is 1.5ns when inputs are driven differentially.
Delay is 1.8ns when inputs are driven single ended.

ELECTRICAL CHARACTERISTICS (continued)

@ Test Temperature			TEST VOLTAGE VALUES (Volts)						(V _{CC}) Gnd		
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{BB}	V _{EE}			
			-30°C	-0.890	-1.890	-1.205	-1.500	From Pin 11			-5.2
			+25°C	-0.810	-1.850	-1.105	-1.475				-5.2
+85°C	-0.700	-1.825	-1.035	-1.440	-5.2						
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						V _{CC}	Gnd	
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{BB}	V _{EE}			
Power Supply Drain Current	I _E	8	4, 9, 12					5, 10, 13	8	1, 16	
Input Current	I _{inH}	4	4	9, 12				5, 10, 13	8	1, 16	
	I _{CBO}	4 9		9, 12 4, 12				5, 10, 13 5, 10, 13	8, 4 8, 9	1, 16	
Output Voltage	Logic 1	V _{OH}	2	4	9, 12			5, 10, 13	8	1, 16	
			3	9, 12	4			5, 10, 13	8	1, 16	
Output Voltage	Logic 0	V _{OL}	2	9, 12	4			5, 10, 13	8	1, 16	
			3	4	9, 12			5, 10, 13	8	1, 16	
Threshold Voltage	Logic 1	V _{OHA}	2		9, 12	4		5, 10, 13	8	1, 16	
			3	9, 12		4		5, 10, 13	8	1, 16	
Threshold Voltage	Logic 0	V _{OLA}	2		9, 12		4	5, 10, 13	8	1, 16	
			3	9, 12		4		5, 10, 13	8	1, 16	
Reference Voltage	V _{BB}	11						5, 10, 13	8	1, 16	
Switching Times	(50Ω Load)					Pulse In	Pulse Out		-3.2 V	+2.0 V	
Propagation Delay	t ₄₊₂₊ t ₄₋₂₋ t ₄₊₃₋ t ₄₋₃₊	2 2 3 3				4	2	5, 10, 13	8	1, 16	
						4	2	5, 10, 13	8	1, 16	
						4	3	5, 10, 13	8	1, 16	
						4	3	5, 10, 13	8	1, 16	
Rise Time	(20 to 80%)	t ₂₊ t ₃₊	2 3			4	2	5, 10, 13	8	1, 16	
						4	3	5, 10, 13	8	1, 16	
Fall Time	(20 to 80%)	t ₂₋ t ₃₋	2 3			4	2	5, 10, 13	8	1, 16	
						4	3	5, 10, 13	8	1, 16	

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

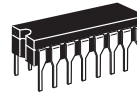
High Speed Dual Type D Master-Slave Flip-Flop

The MC10231 is a dual master-slave type D flip-flop. Asynchronous Set (S) and Reset (R) override Clock (C_C) and Clock Enable (C_E) inputs. Each flip-flop may be clocked separately by holding the common clock in the low state and using the enable inputs for the clocking function. If the common clock is to be used to clock the flip-flop, the Clock Enable inputs must be in the low state. In this case, the enable inputs perform the function of controlling the common clock.

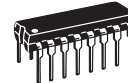
The output states of the flip-flop change on the positive transition of the clock. A change in the information present at the data (D) input will not affect the output information at any other time due to master-slave construction.

$P_D = 270 \text{ mW typ/pkg (No Load)}$
 $t_{pd} = 2 \text{ ns typ}$
 $f_{Tog} = 225 \text{ MHz typ}$
 $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

MC10231



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

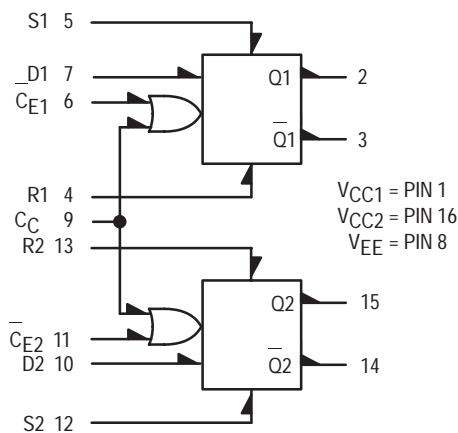


P SUFFIX
PLASTIC PACKAGE
CASE 648-08

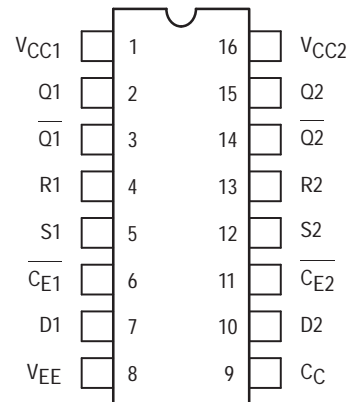


FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM



DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.

CLOCKED TRUTH TABLE

C	D	Q _{n+1}
L	X	Q _n
H	L	L
H	H	H

$C = \overline{C_E} + C_C$. A clock H is a clock transition from a low to a high state.

R-S TRUTH TABLE

R	S	Q _{n+1}
L	L	Q _n
L	H	H
H	L	L
H	H	N.D.

N.D. = Not Defined



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit	
			-30°C		+25°C			+85°C			
			Min	Max	Min	Typ	Max	Min	Max		
Power Supply Drain Current	I_E	8		72		52	65		72	mA _{dc}	
Input Current	I_{inH}	4		650			410		410	μ A _{dc}	
		5		650			410		410		
6			350			220		220			
7			350			220		220			
9			460			290		290			
	I_{inL}	4, 5* 6, 7, 9*			0.5 0.5					μ A _{dc}	
Output Voltage Logic 1	V_{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	V _{dc}	
		2†	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700		
Output Voltage Logic 0	V_{OL}	3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	V _{dc}	
		3†	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615		
Threshold Voltage Logic 1	V_{OHA}	2	-1.080		-0.980			-0.910		V _{dc}	
		2†	-1.080		-0.980			-0.910			
Threshold Voltage Logic 0	V_{OLA}	3		-1.655			-1.630		-1.595	V _{dc}	
		3†		-1.655			-1.630		-1.595		
Switching Times (50Ω Load) Clock Input										ns	
Propagation Delay	t_{9+2-} t_{6+2+}	2	1.5	3.4	1.5	2.0	3.3	1.6	3.7		
		2	1.5	3.4	1.5	2.0	3.3	1.6	3.7		
Rise Time (20 to 80%)	t_{2+}	2	0.9	3.3	1.0	1.3	3.1	1.0	3.6		
Fall Time (20 to 80%)	t_{2-}	2	0.9	3.3	1.0	1.3	3.1	1.0	3.6		
Set Input	Propagation Delay	t_{5+2+}	2	1.1	3.4	1.1	2.0	3.3	1.2	3.7	ns
		t_{12+15+}	15	1.1	3.4	1.1	2.0	3.3	1.2	3.7	
		t_{5+3-}	3	1.1	3.4	1.1	2.0	3.3	1.2	3.7	
		t_{12+14-}	14	1.1	3.4	1.1	2.0	3.3	1.2	3.7	
Reset Input	Propagation Delay	t_{4+2-}	2	1.1	3.4	1.1	2.0	3.3	1.2	3.7	ns
		t_{13+15-}	15	1.1	3.4	1.1	2.0	3.3	1.2	3.7	
		t_{4+3-}	3	1.1	3.4	1.1	2.0	3.3	1.2	3.7	
		t_{13+14+}	14	1.1	3.4	1.1	2.0	3.3	1.2	3.7	
Setup Time	t_{setup}	7	1.5		1.0			1.5		ns	
Hold Time	t_{hold}	7	0.9		0.75			0.9		ns	
Toggle Frequency (Max)	f_{tog}	2	200		200	225		200		MHz	


* Individually test each input; apply V_{ILmin} to pin under test.

† Output level to be measured after a clock pulse has been applied to the $\overline{C_E}$ Input (Pin 6) 

ELECTRICAL CHARACTERISTICS (continued)

			TEST VOLTAGE VALUES (Volts)					V_{CC} Gnd
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}	
@ Test Temperature								
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2	
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2	
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2	
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					
			V_{IHmax}	V_{ILmin}	V_{IHmin}	V_{ILmax}	V_{EE}	
Power Supply Drain Current	I_E	8					8	1, 16
Input Current	I_{inH}	4	4				8	1, 16
		5	5				8	1, 16
		6	6				8	1, 16
		7	7				8	1, 16
		9	9				8	1, 16
	I_{inL}	4, 5* 6, 7, 9*		*			8	1, 16
Output Voltage	Logic 1	V_{OH}	2	5			8	1, 16
			2†	7			8	1, 16
Output Voltage	Logic 0	V_{OL}	3	5			8	1, 16
			3†	7			8	1, 16
Threshold Voltage	Logic 1	V_{OHA}	2		5		8	1, 16
			2†		7	9	8	1, 16
Threshold Voltage	Logic 0	V_{OLA}	3		5		8	1, 16
			3†		7	9	8	1, 16
Switching Times (50Ω Load)			+1.11Vdc		Pulse In	Pulse Out	-3.2 V	+2.0 V
Clock Input	Propagation Delay	t_{9+2-}		2	9	2	8	1, 16
		t_{6+2+}		2	6	2	8	1, 16
Rise Time (20 to 80%)		t_{2+}		2	9	2	8	1, 16
Fall Time (20 to 80%)		t_{2-}		2	9	2	8	1, 16
Set Input	Propagation Delay	t_{5+2+}	2	5	2	8	1, 16	
		t_{12+15+}	15	12	15	8	1, 16	
		t_{5+3-}	3	5	3	8	1, 16	
		t_{12+14-}	14	12	14	8	1, 16	
Reset Input	Propagation Delay	t_{4+2-}	2	4	2	8	1, 16	
		t_{13+15-}	15	13	15	8	1, 16	
		t_{4+3-}	3	4	3	8	1, 16	
		t_{13+14+}	14	13	14	8	1, 16	
Setup Time		t_{setup}	7		6, 7	2	8	1, 16
Hold Time		t_{hold}	7		6, 7	2	8	1, 16
Toggle Frequency (Max)		f_{tog}	2	* *	6	2	8	1, 16

* Individually test each input applying V_{IH} or V_{IL} to input under test.

† Output level to be measured after a clock pulse has been applied to the $\overline{C_E}$ Input (Pin 6) 

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

For:colleen

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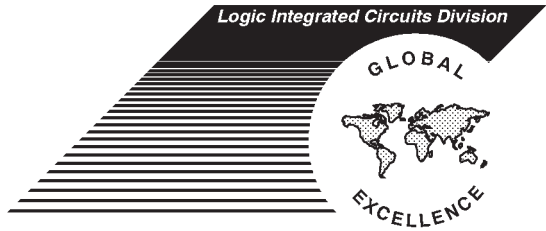
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MECL Data



MECL III **4**

MECL III INTEGRATED CIRCUITS

MC1600 Series (- 30 to + 85°C)

Function Selection — (- 30 to + 85°C)

Function	Device	Case
----------	--------	------

Gates

Dual 4-Input OR/NOR	MC1660	620
Quad 2-Input NOR	MC1662	620

Flip-Flops

Master-Slave Type D	MC1670	620
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Multivibrator

Voltage-Controlled	MC1658	620, 648 751B, 775
--------------------	--------	-----------------------

Function	Device	Case
----------	--------	------

Oscillator

Emitter Coupled Voltage- Controlled	MC1648	632, 646 751, 775
--	--------	----------------------

Comparator

Dual A/D	MC1650/ MC1651	620
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Receiver

Quad-Line	MC1692	620
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Voltage Controlled Oscillator

Consider MC12148 for New Designs

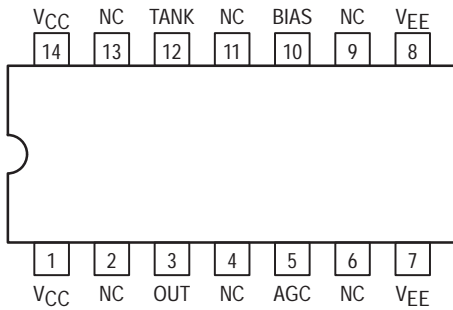
The MC1648 requires an external parallel tank circuit consisting of the inductor (L) and capacitor (C). **For Maximum Performance $Q_L \geq 100$ at Frequency of Operation.**

A varactor diode may be incorporated into the tank circuit to provide a voltage variable input for the oscillator (VCO). The MC1648 was designed for use in the Motorola Phase-Locked Loop shown in Figure 11. This device may also be used in many other applications requiring a fixed or variable frequency clock source of high spectral purity. (See Figure 4)

The MC1648 may be operated from a +5.0Vdc supply or a -5.2Vdc supply, depending upon system requirements.

NOTE: The MC1648 is NOT useable as a crystal oscillator.

Pinout: 14-Lead Package (Top View)



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 6-11.

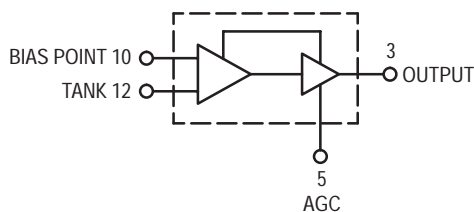
Supply Voltage	GND Pins	Supply Pins
+5.0Vdc	7,8	1,14
-5.2Vdc	1,14	7,8

MC1648 NON-STANDARD PIN CONVERSION DATA

Package	TANK	VCC	VCC	OUT	AGC	VEE	VEE	BIAS
8 D	1	2	3	4	5	6	7	8
14 L,P	12	14	1	3	5	7	8	10
20FN	18	20	2	4	8	10	12	14

*NOTE - All unused pins are not connected.

LOGIC DIAGRAM

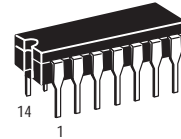


- Input Capacitance = 6.0pF (TYP)
- Maximum Series Resistance for L (External Inductance) = 50Ω (TYP)
- Power Dissipation = 150mW (TYP)/Pkg (+5.0Vdc Supply)
- Maximum Output Frequency = 225MHz (TYP)

VCC1 = Pin 1
VCC2 = Pin 14
VEE = Pin 7

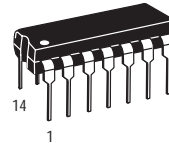
MC1648

VOLTAGE CONTROLLED OSCILLATOR



L SUFFIX
CERAMIC PACKAGE
CASE 632-08

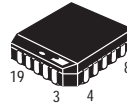
Not Recommended for New Designs



P SUFFIX
PLASTIC PACKAGE
CASE 646-06



D SUFFIX
PLASTIC SOIC PACKAGE
CASE 751-05



FN SUFFIX
PLCC PACKAGE
CASE 775-02



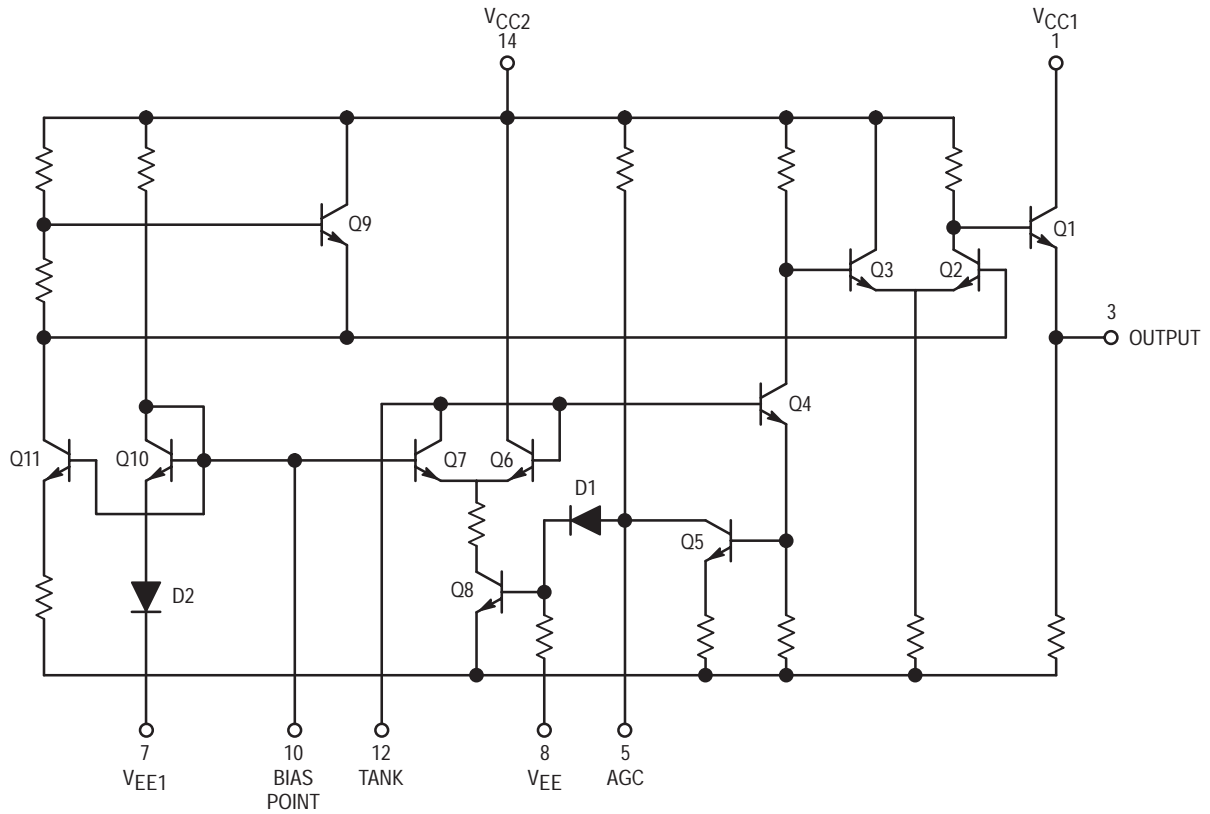


Figure 3. Circuit Schematic

TEST VOLTAGE/CURRENT VALUES

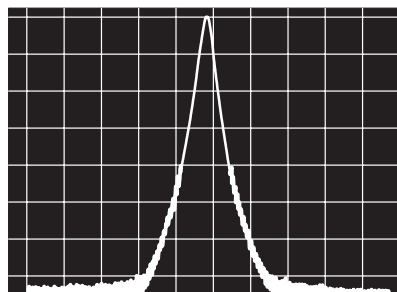
@ Test Temperature	(Volts)			mAdc
	V _{IHmax}	V _{ILmin}	V _{CC}	I _L
MC1648				
-30°C	+2.0	+1.5	+5.0	-5.0
+25°C	+1.85	+1.35	+5.0	-5.0
+85°C	+1.7	+1.2	+5.0	-5.0

Note: SOIC "D" package guaranteed -30°C to +70°C only

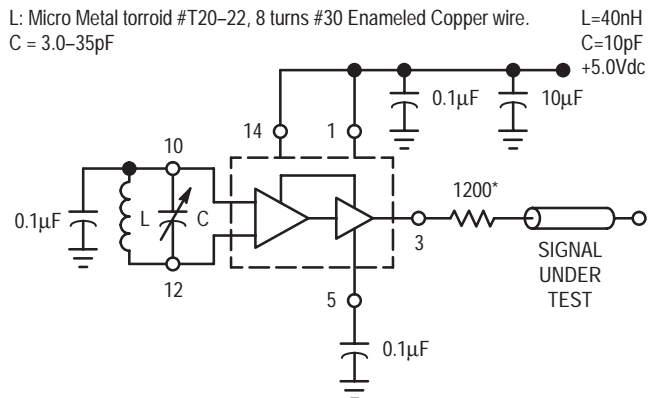
ELECTRICAL CHARACTERISTICS (Supply Voltage = +5.0V)

Symbol	Characteristic	-30°C		+25°C		+85°C		Unit	Condition			
		Min	Max	Min	Max	Min	Max					
I _E	Power Supply Drain Current	-	-	-	41	-	-	mAdc	Inputs and outputs open			
V _{OH}	Logic "1" Output Voltage	3.955	4.185	4.04	4.25	4.11	4.36	Vdc	V _{ILmin} to Pin 12, I _L @ Pin 3			
V _{OL}	Logic "0" Output Voltage	3.16	3.4	3.2	3.43	3.22	3.475	Vdc	V _{IHmax} to Pin 12, I _L @ Pin 3			
V _{BIAS} ¹	Bias Voltage	1.6	1.9	1.45	1.75	1.3	1.6	Vdc	V _{ILmin} to Pin 12			
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Unit	Condition
V _{P-P}	Peak-to-Peak Tank Voltage	-	-	-	-	400	-	-	-	-	mV	See Figure 5
V _{dc}	Output Duty Cycle	-	-	-	-	50	-	-	-	-	%	
f _{max} ²	Oscillation Frequency	-	225	-	200	225	-	-	225	-	MHz	

1. This measurement guarantees the dc potential at the bias point for purposes of incorporating a varactor tuning diode at this point.
 2. Frequency variation over temperature is a direct function of the ΔC/Δ Temperature and ΔL/Δ Temperature.



B.W. = 10 kHz
 Center Frequency = 100 MHz
 Scan Width = 50 kHz/div
 Vertical Scale = 10 dB/div



* The 1200 ohm resistor and the scope termination impedance constitute a 25:1 attenuator probe. Coax shall be CT-075-50 or equivalent.

Figure 4. Spectral Purity of Signal Output for 200MHz Testing

TEST VOLTAGE/CURRENT VALUES

@ Test Temperature	(Volts)			mAdc
	V _{IHmax}	V _{ILmin}	V _{EE}	I _L
MC1648				
-30°C	-3.2	-3.7	-5.2	-5.0
+25°C	-3.35	-3.85	-5.2	-5.0
+85°C	-3.5	-4.0	-5.2	-5.0

Note: SOIC "D" package guaranteed -30°C to +70°C only

ELECTRICAL CHARACTERISTICS (Supply Voltage = -5.2V)

Symbol	Characteristic	-30°C		+25°C		+85°C		Unit	Condition			
		Min	Max	Min	Max	Min	Max					
I _E	Power Supply Drain Current	-	-	-	41	-	-	mAdc	Inputs and outputs open			
V _{OH}	Logic "1" Output Voltage	-1.045	-0.815	-0.96	-0.75	-0.89	-0.64	Vdc	V _{ILmin} to Pin 12, I _L @ Pin 3			
V _{OL}	Logic "0" Output Voltage	-1.89	-1.65	-1.85	-1.62	-1.83	-1.575	Vdc	V _{IHmax} to Pin 12, I _L @ Pin 3			
V _{BIAS} ¹	Bias Voltage	-3.6	-3.3	-3.75	-3.45	-3.9	-3.6	Vdc	V _{ILmin} to Pin 12			
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Unit	Condition
V _{P-P}	Peak-to-Peak Tank Voltage	-	-	-	-	400	-	-	-	-	mV	See Figure 5
V _{dc}	Output Duty Cycle	-	-	-	-	50	-	-	-	-	%	
f _{max} ²	Oscillation Frequency	-	225	-	200	225	-	-	225	-	MHz	

1. This measurement guarantees the dc potential at the bias point for purposes of incorporating a varactor tuning diode at this point.
 2. Frequency variation over temperature is a direct function of the ΔC/Δ Temperature and ΔL/Δ Temperature.

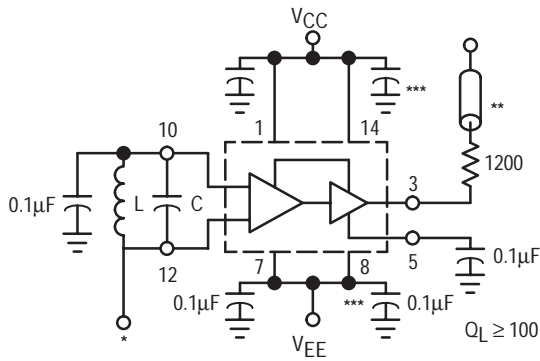


Figure 5. Test Circuit and Waveforms

- * Use high impedance probe (>1.0 Megohm must be used).
- ** The 1200 ohm resistor and the scope termination impedance constitute a 25:1 attenuator probe. Coax shall be CT-070-50 or equivalent.
- *** Bypass only that supply opposite ground.

OPERATING CHARACTERISTICS

Figure 3 illustrates the circuit schematic for the MC1648. The oscillator incorporates positive feedback by coupling the base of transistor Q6 to the collector of Q7. An automatic gain control (AGC) is incorporated to limit the current through the emitter-coupled pair of transistors (Q7 and Q6) and allow optimum frequency response of the oscillator.

In order to maintain the high Q of the oscillator, and provide high spectral purity at the output, transistor Q4 is used to translate the oscillator signal to the output differential pair Q2 and Q3. Q2 and Q3, in conjunction with output transistor Q1, provides a highly buffered output which produces a square wave. Transistors Q9 and Q11 provide the bias drive for the oscillator and output buffer. Figure 4 indicates the high spectral purity of the oscillator output (pin 3).

When operating the oscillator in the voltage controlled mode (Figure 6), it should be noted that the cathode of the varactor diode (D) should be biased at least "2" V_{BE} above

V_{EE} (≈1.4V for positive supply operation).

When the MC1648 is used with a constant dc voltage to the varactor diode, the output frequency will vary slightly because of internal noise. This variation is plotted versus operating frequency in Figure 7.

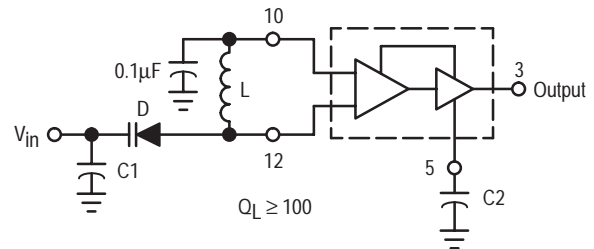
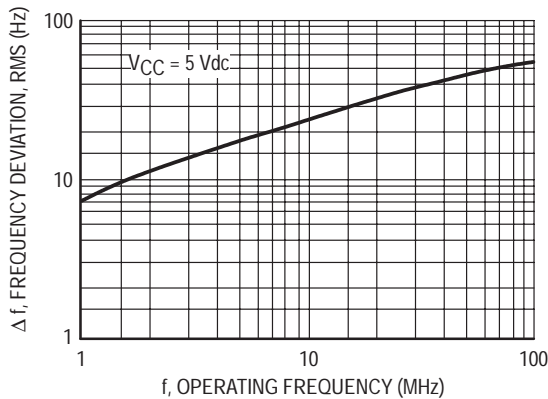
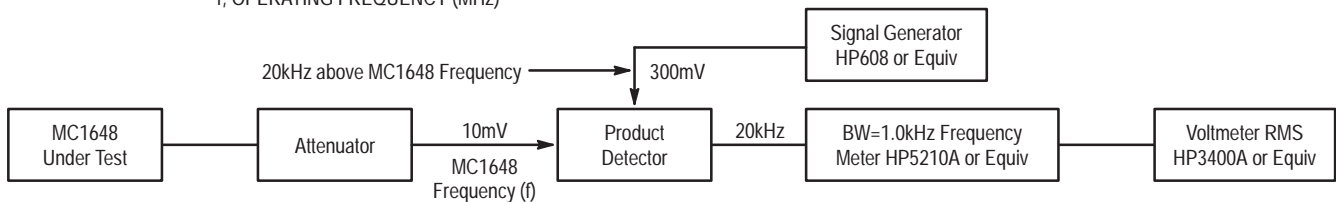


Figure 6. The MC1648 Operating in the Voltage Controlled Mode



Oscillator Tank Components (Circuit of Figure 6)

f MHz	D	L µH
1.0-10	MV2115	100
10-60	MV2115	2.3
60-100	MV2106	0.15



$$\text{Frequency Deviation} = \frac{(\text{HP5210A output voltage}) (\text{Full Scale Frequency})}{1.0\text{Volt}}$$

Figure 7. Noise Deviation Test Circuit and Waveform

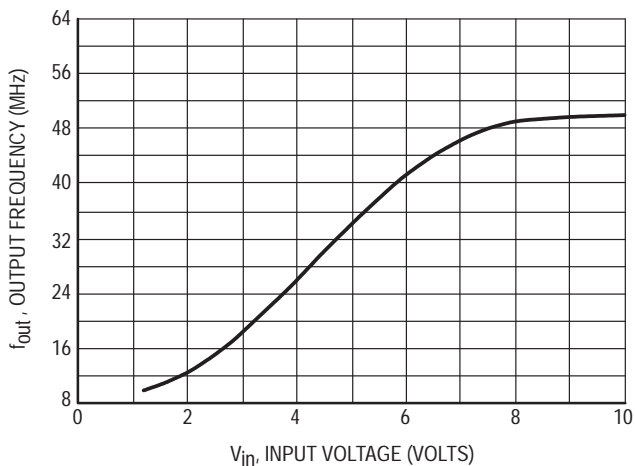
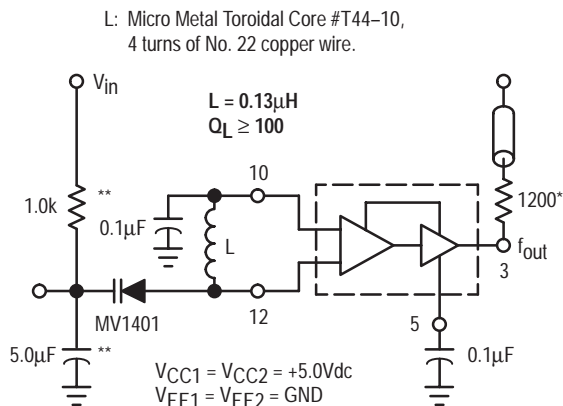


Figure 8



* The 1200 ohm resistor and the scope termination impedance constitute a 25:1 attenuator probe. Coax shall be CT-070-50 or equivalent. NOT used in normal operation.

** Input resistor and cap are for test only. They are NOT necessary for normal operation.

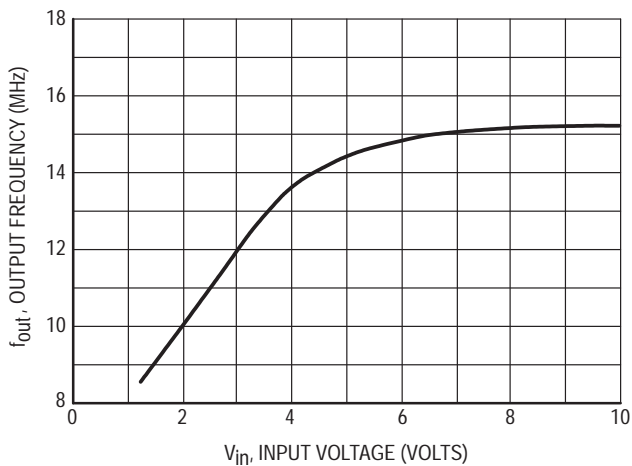
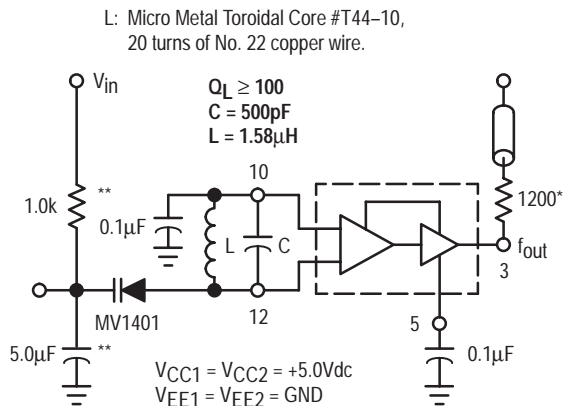


Figure 9



* The 1200 ohm resistor and the scope termination impedance constitute a 25:1 attenuator probe. Coax shall be CT-070-50 or equivalent. NOT used in normal operation.

** Input resistor and cap are for test only. They are NOT necessary for normal operation.

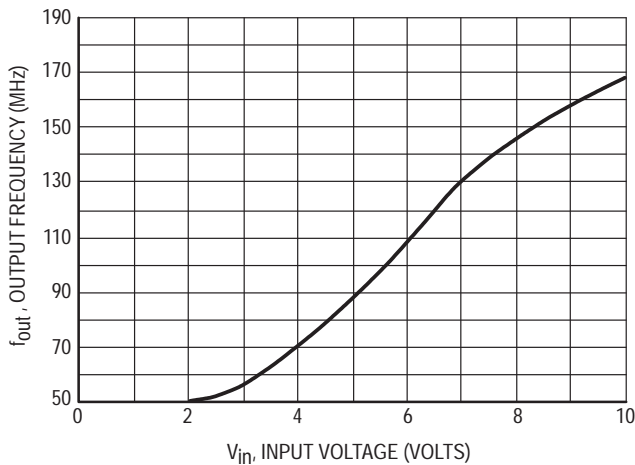
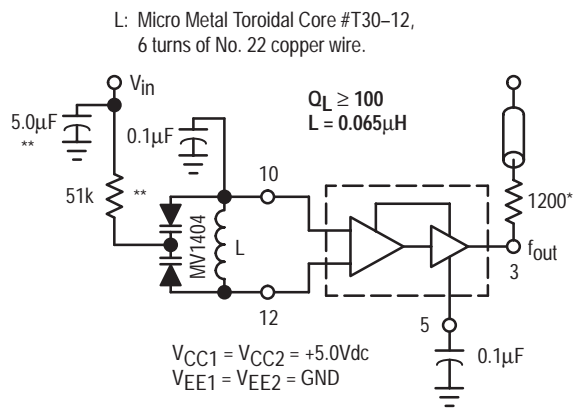


Figure 10



* The 1200 ohm resistor and the scope termination impedance constitute a 25:1 attenuator probe. Coax shall be CT-070-50 or equivalent. NOT used in normal operation.

** Input resistor and cap are for test only. They are NOT necessary for normal operation.

Typical transfer characteristics for the oscillator in the voltage controlled mode are shown in Figure 8, Figure 9 and Figure 10. Figure 8 and Figure 10 show transfer characteristics employing only the capacitance of the varactor diode (plus the input capacitance of the oscillator, 6.0pF typical). Figure 9 illustrates the oscillator operating in a voltage controlled mode with the output frequency range limited. This is achieved by adding a capacitor in parallel with the tank circuit as shown. The 1.0k Ω resistor in Figure 8 and Figure 9 is used to protect the varactor diode during testing. It is not necessary as long as the dc input voltage does not cause the diode to become forward biased. The larger-valued resistor (51k Ω) in Figure 10 is required to provide isolation for the high-impedance junctions of the two varactor diodes.

The tuning range of the oscillator in the voltage controlled mode may be calculated as:

$$\frac{f_{\max}}{f_{\min}} = \frac{\sqrt{C_D(\max) + C_S}}{\sqrt{C_D(\min) + C_S}}$$

$$\text{where } f_{\min} = \frac{1}{2\pi\sqrt{L(C_D(\max) + C_S)}}$$

CS = shunt capacitance (input plus external capacitance)

CD = varactor capacitance as a function of bias voltage

Good RF and low-frequency bypassing is necessary on the power supply pins. (See Figure 4)

Capacitors (C1 and C2 of Figure 6) should be used to bypass the AGC point and the VCO input (varactor diode), guaranteeing only dc levels at these points.

For output frequency operation between 1.0MHz and 50MHz a 0.1 μ F capacitor is sufficient for C1 and C2. At higher frequencies, smaller values of capacitance should be used; at lower frequencies, larger values of capacitance. At high frequencies the value of bypass capacitors depends directly upon the physical layout of the system. All bypassing should be as close to the package pins as possible to minimize unwanted lead inductance.

The peak-to-peak swing of the tank circuit is set internally by the AGC circuitry. Since voltage swing of the tank circuit provides the drive for the output buffer, the AGC potential directly affects the output waveform. If it is desired to have a sine wave at the output of the MC1648, a series resistor is tied from the AGC point to the most negative power potential (ground if +5.0 volt supply is used, -5.2 volts if a negative supply is used) as shown in Figure 10.

At frequencies above 100 MHz typ, it may be desirable to increase the tank circuit peak-to-peak voltage in order to shape the signal at the output of the MC1648. This is accomplished by tying a series resistor (1.0k Ω minimum) from the AGC to the most positive power potential (+5.0 volts if a +5.0 volt supply is used, ground if a -5.2 volt supply is used). Figure 13 illustrates this principle.

APPLICATIONS INFORMATION

The phase locked loop shown in Figure 11 illustrates the use of the MC1648 as a voltage controlled oscillator. The figure illustrates a frequency synthesizer useful in tuners for FM broadcast, general aviation, maritime and landmobile communications, amateur and CB receivers. The system operates from a single +5.0Vdc supply, and requires no internal translations, since all components are compatible.

Frequency generation of this type offers the advantages of single crystal operation, simple channel selection, and elimination of special circuitry to prevent harmonic lockup. Additional features include dc digital switching (preferable over RF switching with a multiple crystal system), and a broad range of tuning (up to 150MHz, the range being set by the varactor diode).

The output frequency of the synthesizer loop is determined by the reference frequency and the number programmed at the programmable counter; $f_{\text{out}} = Nf_{\text{ref}}$. The channel spacing is equal to frequency (f_{ref}).

For additional information on applications and designs for phase locked-loops and digital frequency synthesizers, see

Motorola Brochure BR504/D, Electronic Tuning Address Systems, (ETAS).

Figure 12 shows the MC1648 in the variable frequency mode operating from a +5.0Vdc supply. To obtain a sine wave at the output, a resistor is added from the AGC circuit (pin 5) to V_{EE} .

Figure 13 shows the MC1648 in the variable frequency mode operating from a +5.0Vdc supply. To extend the useful range of the device (maintain a square wave output above 175MHz), a resistor is added to the AGC circuit at pin 5 (1.0 kohm minimum).

Figure 14 shows the MC1648 operating from +5.0Vdc and +9.0Vdc power supplies. This permits a higher voltage swing and higher output power than is possible from the MECL output (pin 3). Plots of output power versus total collector load resistance at pin 1 are given in Figure 15 and Figure 16 for 100MHz and 10MHz operation. The total collector load includes R in parallel with R_p of L1 and C1 at resonance. The optimum value for R at 100MHz is approximately 850 ohms.

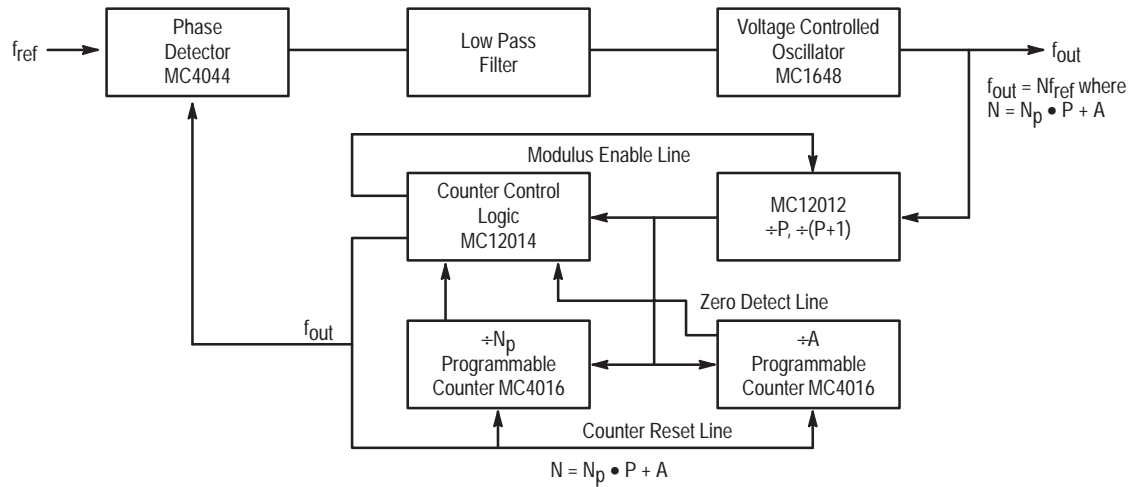


Figure 11. Typical Frequency Synthesizer Application

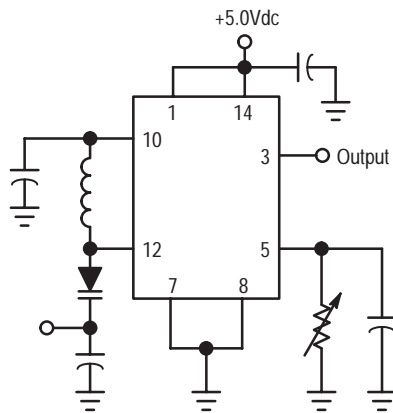


Figure 12. Method of Obtaining a Sine-Wave Output

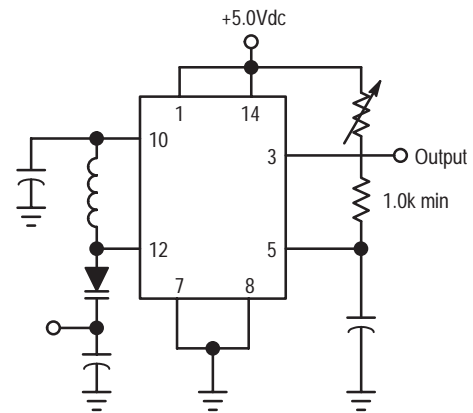


Figure 13. Method of Extending the Useful Range of the MC1648 (Square Wave Output)

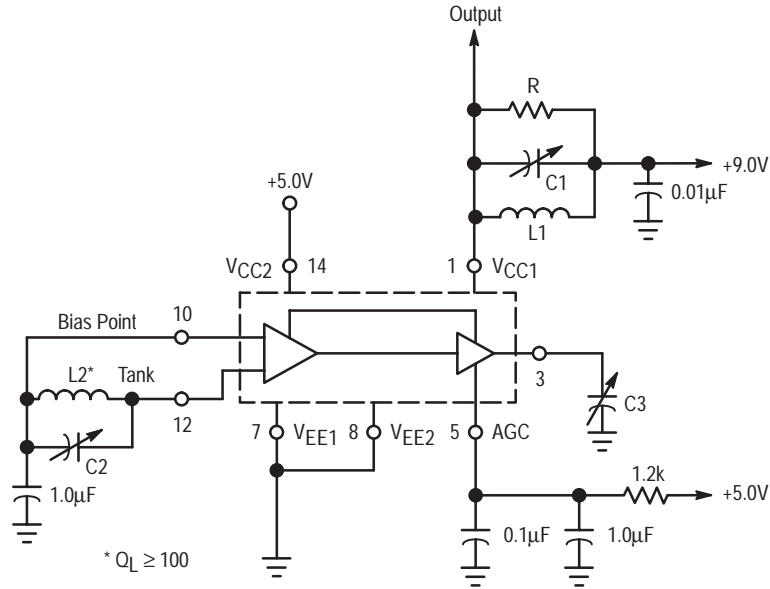
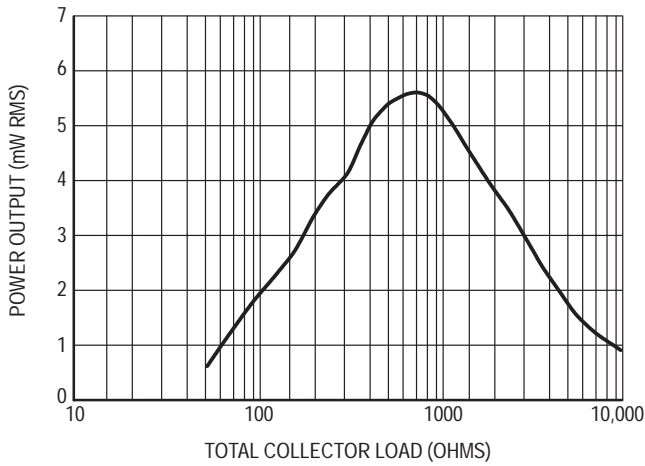
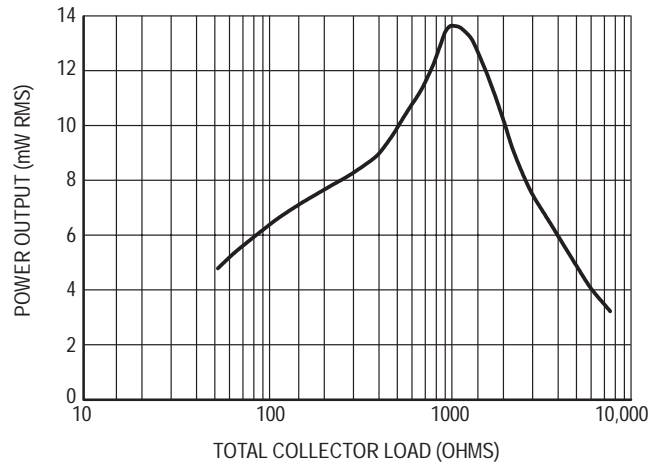


Figure 14. Circuit Used for Collector Output Operation



See test circuit, Figure 14, $f = 100\text{MHz}$
 $C3 = 3.0\text{--}35\text{pF}$
 Collector Tank
 $L1 = 0.22\mu\text{H}$ $C1 = 1.0\text{--}7.0\text{pF}$
 $R = 50\Omega\text{--}10\text{k}\Omega$
 R_p of L1 and C1 = $11\text{k}\Omega$ @ 100MHz Resonance
 Oscillator Tank
 $L2 = 4$ turns #20 AWG 3/16" ID
 $C2 = 1.0\text{--}7.0\text{pF}$

Figure 15. Power Output versus Collector Load



See test circuit, Figure 14, $f = 10\text{MHz}$
 $C3 = 470\text{pF}$
 Collector Tank
 $L1 = 2.7\mu\text{H}$ $C1 = 24\text{--}200\text{pF}$
 $R = 50\Omega\text{--}10\text{k}\Omega$
 R_p of L1 and C1 = $6.8\text{k}\Omega$ @ 10MHz Resonance
 Oscillator Tank
 $L2 = 2.7\mu\text{H}$
 $C2 = 16\text{--}150\text{pF}$

Figure 16. Power Output versus Collector Load

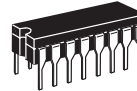
Dual A/D Converter

The MC1650 and the MC1651 are very high speed comparators utilizing differential amplifier inputs to sense analog signals above or below a reference level. An output latch provides a unique sample-hold feature. The MC1650 provides high impedance Darlington inputs, while the MC1651 is a lower impedance option, with higher input slew rate and higher speed capability.

The clock inputs (C_A and C_B) operate from MECL III or MECL 10,000 digital levels. When C_A is at a logic high level, Q_0 will be at a logic high level provided that $V_1 > V_2$ (V_1 is more positive than V_2). Q_0 is the logic complement of \bar{Q}_0 . When the clock input goes to a low logic level, the outputs are latched in their present state.

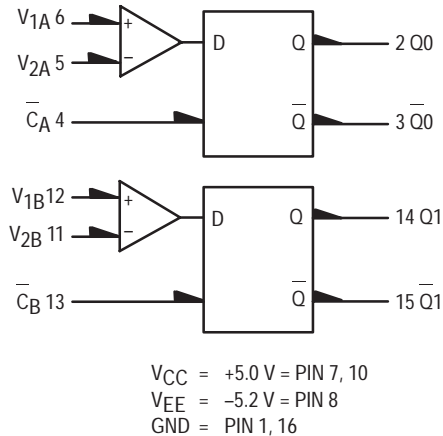
Assessment of the performance differences between the MC1650 and the MC1651 may be based upon the relative behaviors shown in Figures 4 and 7.

MC1650 MC1651

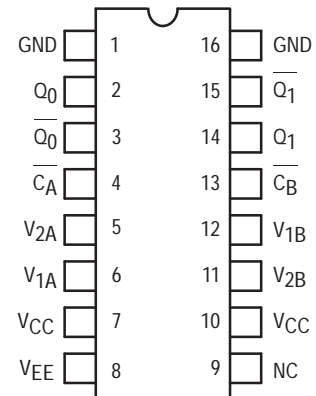


L SUFFIX
CERAMIC PACKAGE
CASE 620-10

LOGIC DIAGRAM



PIN ASSIGNMENT



- $P_D = 330\text{ mW typ/pkg (No Load)}$
- $t_{pd} = 3.5\text{ ns typ (MC1650)}$
 $= 3.0\text{ ns typ (MC1651)}$
- Input Slew Rate = $350\text{ V}/\mu\text{s (MC1650)}$
 $= 500\text{ V}/\mu\text{s (MC1651)}$
- Differential Input Voltage: $5.0\text{ V (-30}^\circ\text{C to +85}^\circ\text{C)}$
- Common Mode Range:
 $-3.0\text{ V to +2.5 V (-30}^\circ\text{C to +85}^\circ\text{C) (MC1651)}$
 $-2.5\text{ V to +3.0 V (-30}^\circ\text{C to +85}^\circ\text{C) (MC1650)}$
- Resolution: $\leq 20\text{ mV (-30}^\circ\text{C to +85}^\circ\text{C)}$
- Drives $50\ \Omega$ lines

Number at end of terminal denotes pin number for L package (Case 620).

TRUTH TABLE

C	V_1, V_2	Q_{0n+1}	Q_{0n+1}
H	$V_1 > V_2$	H	L
H	$V_1 < V_2$	L	H
L	X X	Q_{0n}	Q_{0n}



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Test Limits						Unit	
		-30°C		+25°C		+85°C			
		Min	Max	Min	Max	Min	Max		
Power Supply Drain Current	Positive Negative	I_{CC} I_E				25* 55*			mAdc
Input Current	MC1650 MC1651	I_{in}				10 40			μ Adc
Input Leakage Current	MC1650 MC1651	I_R				7.0 10.0			μ Adc
Clock Input Current		I_{inH}				350			
Output Voltage	Logic 1	V_{OH}	-1.045	-0.875	-0.960	-0.810	-0.890	-0.700	Vdc
Output Voltage	Logic 0	V_{OL}	-1.890	-1.650	-1.850	-1.620	-1.830	-1.575	Vdc
Threshold Voltage (Note 2.)	Logic 1	V_{OHA}	-1.065		-0.980		-0.910		Vdc
Threshold Voltage (Note 2.)	Logic 0	V_{OLA}		-1.630		-1.600		-1.555	Vdc

1. All data is for 1/2 MC1650 or MC1651, except data marked (*) which refers to the entire package.
2. These tests are done in order indicated. See Figure 5.
3. Maximum Power Supply Voltages (beyond which device life may be impaired): $|V_{EE}| + |V_{CC}| \geq 12$ Vdc.

4.

All Temperature	V_{A3}	V_{A4}	V_{A5}	V_{A6}
MC1650	+3.0	+2.98	-2.5	-2.48
MC1651	+2.5	+2.48	-3.0	-2.98

ELECTRICAL CHARACTERISTICS (continued)

@ Test Temperature		TEST VOLTAGE VALUES (Volts)											V _{CC} ^{3.}	V _{EE} ^{3.}
		V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmx}	V _{A1}	V _{A2}	V _{A3}	V _{A4}	V _{A5}	V _{A6}			
-30°C		-0.875	-1.890	-1.180	-1.515	+0.02	+0.02	See Note 4.				+5.0	-5.2	
+25°C		-0.810	-1.850	-1.095	-1.485	+0.02	+0.02	See Note 4.				+5.0	-5.2	
+85°C		-0.700	-1.830	-1.025	-1.440	+0.02	+0.02	See Note 4.				+5.0	-5.2	
Characteristic	Symbol	TEST VOLTAGE APPLIED TO PINS LISTED BELOW										(V _{CC}) Gnd		
		V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmx}	V _{A1}	V _{A2}	V _{A3}	V _{A4}	V _{A5}	V _{A6}			
Power Supply Drain Current	Pos Neg	I _{CC} I _E	4,13	4,13			6,12 6,12						1,5,11,16 1,5,11,16	
Input Current	MC1650 MC1651	I _{in}	4	13			12		6				1,5,11,16	
Input Leakage Current	MC1650 MC1651	I _R	4	13			12			6			1,5,11,16	
Clock Input Current		I _{inH}	4	13			6,12						1,5,11,16	
Output Voltage	Logic 1	V _{OH}	4,13				6,12 5,11 6,12 5,11	5,11 6,12	6,12 5,11	5,11 6,12	5,11 6,12	6,12 5,11	1,5,11,16 1,6,12,16 1,16 1,16 1,5,11,16 1,6,12,16 1,16 1,16	
Output Voltage	Logic 0	V _{OL}	4,13				5,11 6,12	6,12 5,11	5,11 6,12	6,12 5,11	6,12 5,11	5,11 6,12	1,5,11,16 1,6,12,16 1,16 1,16 1,5,11,16 1,6,12,16 1,16 1,16	
Threshold Voltage Note 2.	Logic 1	V _{OHA}		13	4 4	4 4	6 6	6 6					1,5,16	
Threshold Voltage Note 2.	Logic 0	V _{OLA}		13	4 4	4 4	6 6	6 6					1,5,16	

1. All data is for 1/2 MC1650 or MC1651, except data marked (*) which refers to the entire package.

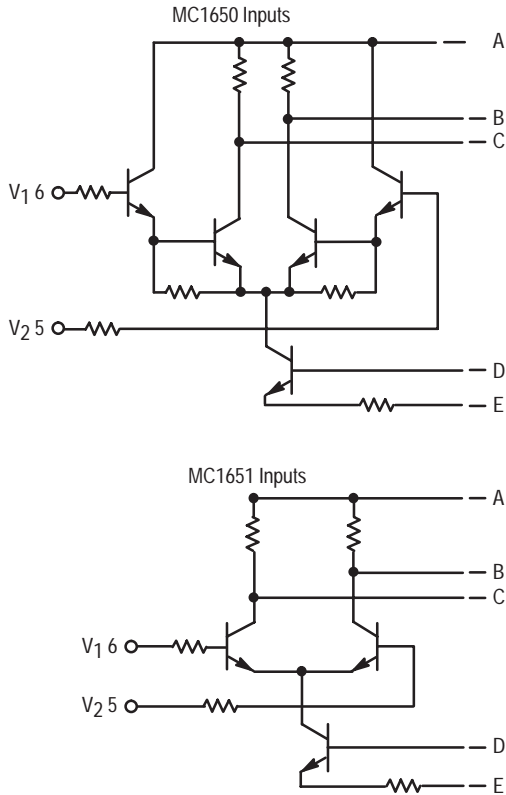
2. These tests are done in order indicated. See Figure 5.

3. Maximum Power Supply Voltages (beyond which device life may be impaired): |V_{EE}| + |V_{CC}| ≥ 12 Vdc.

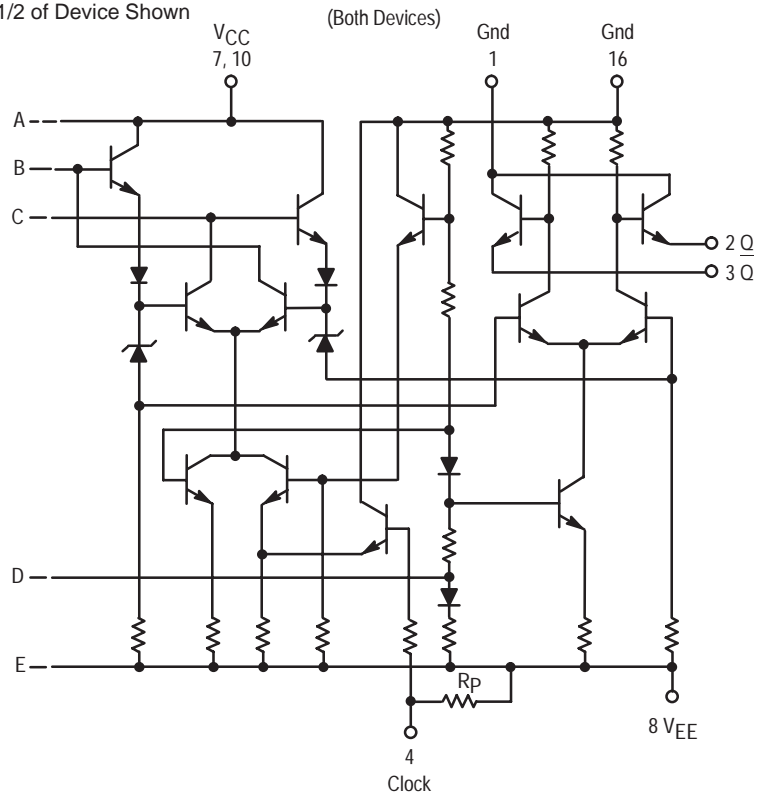
All Temperature	V _{A3}	V _{A4}	V _{A5}	V _{A6}
MC1650	+3.0	+2.98	-2.5	-2.48
MC1651	+2.5	+2.48	-3.0	-2.98

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

MC1650 MC1651



CIRCUIT SCHEMATIC
1/2 of Device Shown



SWITCHING TEST VOLTAGE VALUES

@ Test Temperature	(Volts)						
	V _{R1}	V _{R2}	V _{R3}	V _X	V _{XX}	V _{CC} ¹	V _{EE} ¹
-30°C	+2.0	See Note 4		+1.04	+2.0	+7.0	-3.2
+25°C	+2.0			+1.11	+2.0	+7.0	-3.2
+85°C	+2.0			+1.19	+2.0	+7.0	-3.2

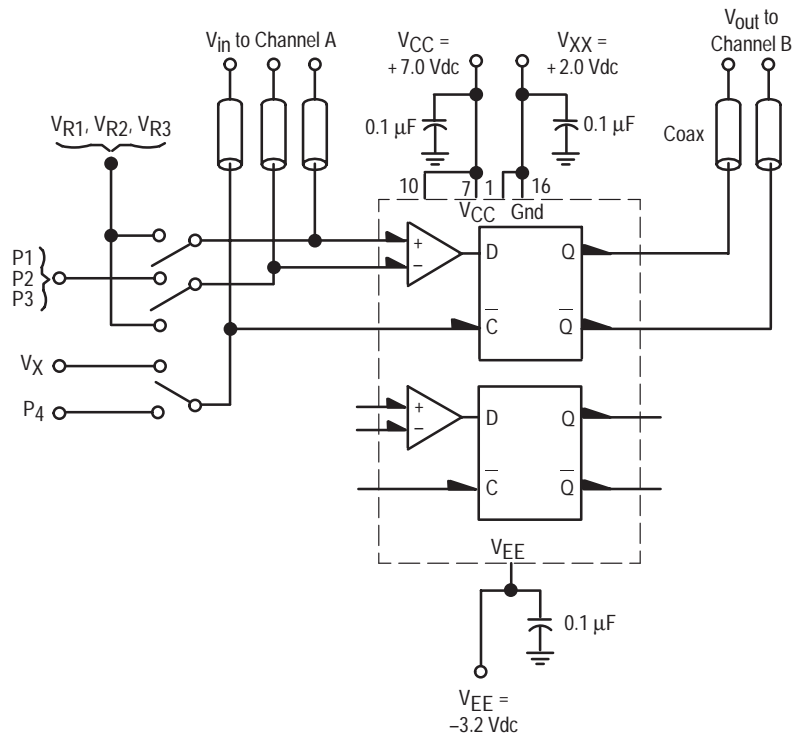
Characteristic	Symbol	-30°C		+25°C		+85°C		Unit	Conditions (See Figures 1-3)
		Min	Max	Min	Max	Min	Max		
Switching Times Propagation Delay (50% to 50%) V-Input Clock ²	t _{pd}	2.0	5.0	2.0	5.0	2.0	5.7	ns	V _{R1} to V ₂ , V _X to Clock, P ₁ to V ₁ , or, V _{R2} to V ₂ , V _X to Clock, P ₂ to V ₁ , or, V _{R3} to V ₂ , V _X to Clock, P ₃ to V ₁ .
		2.0	4.7	2.0	4.7	2.0	5.2		V _{R1} to V ₂ , P ₁ to V ₁ and P ₄ to Clock, or, V _{R1} to V ₁ , P ₁ to V ₂ and P ₄ to Clock.
Clock Enable ³	t _{setup}	—	—	2.5	—	—	—	ns	V _{R1} to V ₂ , P ₁ to V ₁ , P ₄ to Clock
Clock Aperture ³	t _{ap}	—	—	1.5	—	—	—	ns	
Rise Time (10% to 90%)	t ₊	1.0	3.5	1.0	3.5	1.0	3.8	ns	V _R to V ₂ , V _X to Clock, P ₁ to V ₁ .
Fall Time (10% to 90%)	t ₋	1.0	3.0	1.0	3.0	1.0	3.3	ns	

NOTES:

- Maximum Power Supply Voltages (beyond which device life may be impaired:
 $|V_{CC}| + |V_{EE}| \geq 12 \text{ Vdc}$.)
- Unused clock inputs may be tied to ground.
- See Figure 3.

4.	All Temperatures	V _{R2}	V _{R3}
	MC1650	+4.9	-0.4
	MC1651	+4.4	-0.9

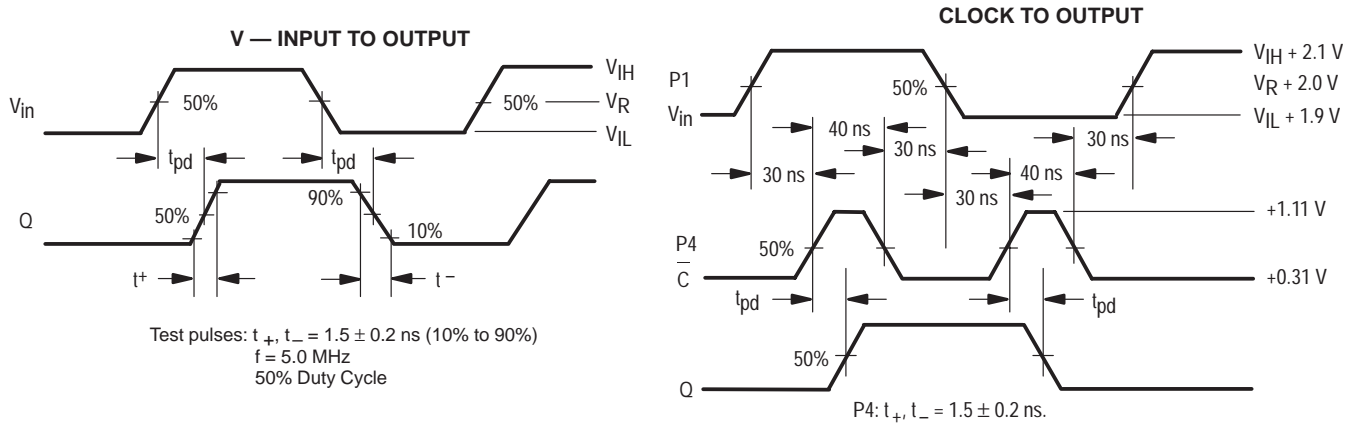
FIGURE 1 — SWITCHING TIME TEST CIRCUIT @ 25°C



Note: All power supply and logic levels are shown shifted 2.0 volts positive.
 50 ohm termination to ground located in each scope channel input.
 All input and output cables to the scope are equal lengths of 50 ohm coaxial cable.

FIGURE 2 — SWITCHING AND PROPAGATION WAVEFORMS @ 25°C

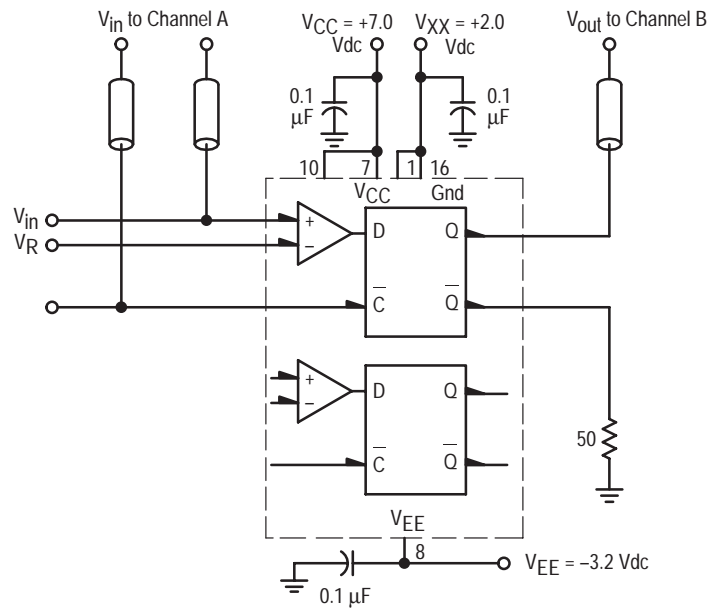
The pulse levels shown are used to check ac parameters over the full common-mode range.



TEST PULSE LEVELS

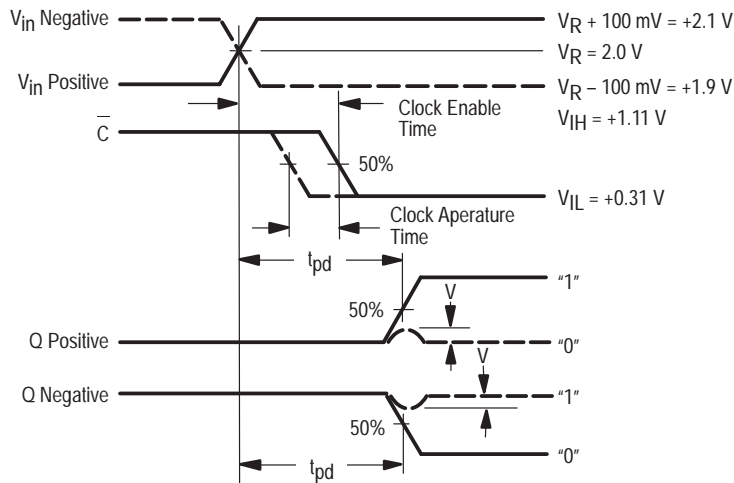
	P1		P2		P3	
	MC1650	MC1651	MC1650	MC1651	MC1650	MC1651
V_{IH}	+2.1 V	+2.1 V	+5.0 V	+4.5 V	-0.3 V	-0.8 V
V_R	+2.0 V	+2.0 V	+4.9 V	+4.4 V	-0.4 V	-0.9 V
V_{IL}	+1.9 V	+1.9 V	+4.8 V	+4.3 V	-0.5 V	-1.0 V

FIGURE 3 — CLOCK ENABLE AND APERTURE TIME TEST CIRCUIT AND WAVEFORMS @ 25°C



50 ohm termination to ground located in each scope channel input.
 All input and output cables to the scope are equal lengths of 50 ohms coaxial cable.

ANALOG SIGNAL POSITIVE AND NEGATIVE SLEW CASE

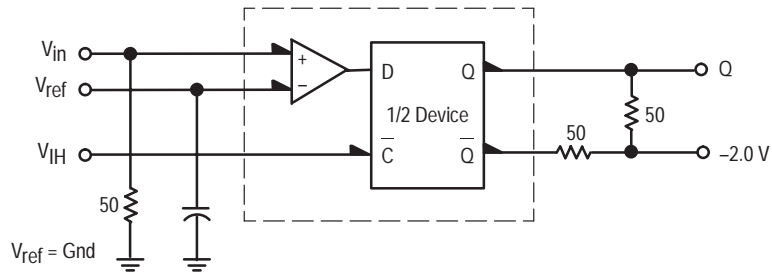


- Clock enable time = minimum time between analog and clock signal such that output switches, and t_{pd} (analog to Q) is not degraded by more than 200 ps.
- - - - - Clock aperture time = time difference between clock enable time and time that output does not switch and V is less than 150 mV.

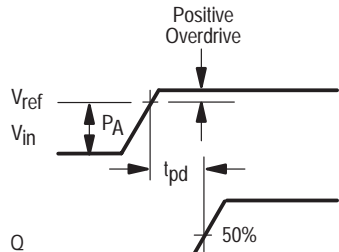
Note: All power supply and logic levels are shown shifted 2.0 volts positive.

FIGURE 4 — PROPAGATION DELAY (t_{pd}) versus INPUT PULSE AMPLITUDE AND CONSTANT OVERDRIVE

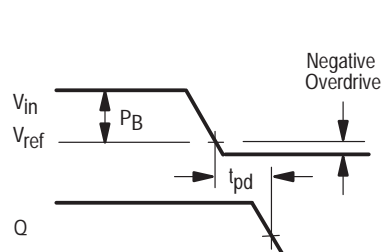
TEST CIRCUIT



POSITIVE PULSE DIAGRAM

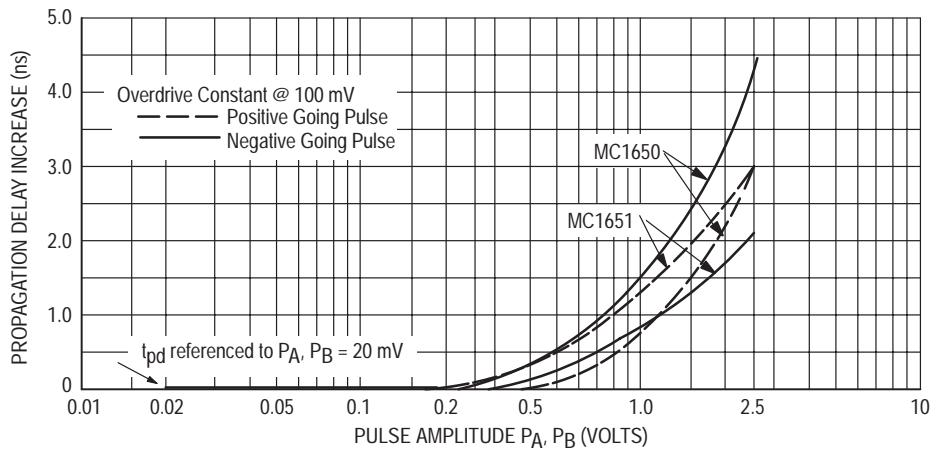


NEGATIVE PULSE DIAGRAM



Input switching time is constant at 1.5 ns (10% to 90%).

PROPAGATION DELAY versus PULSE AMPLITUDE



PROPAGATION DELAY versus OVERDRIVE

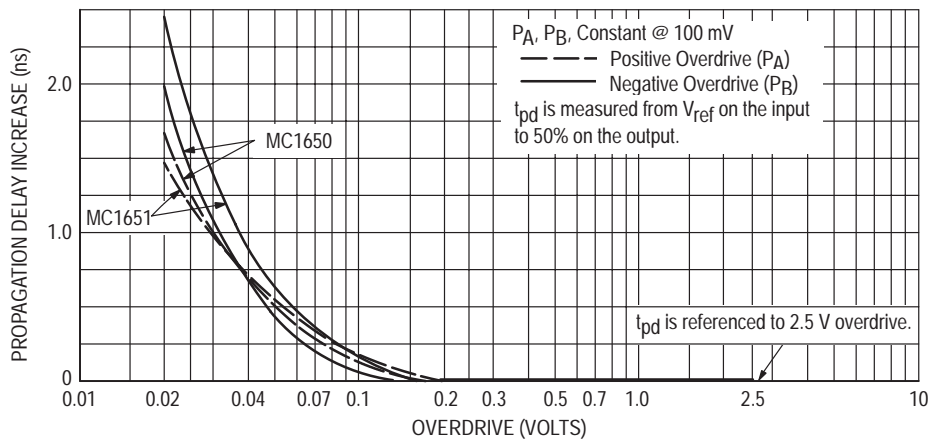


FIGURE 5 — LOGIC THRESHOLD TESTS (WAVEFORM SEQUENCE DIAGRAM)

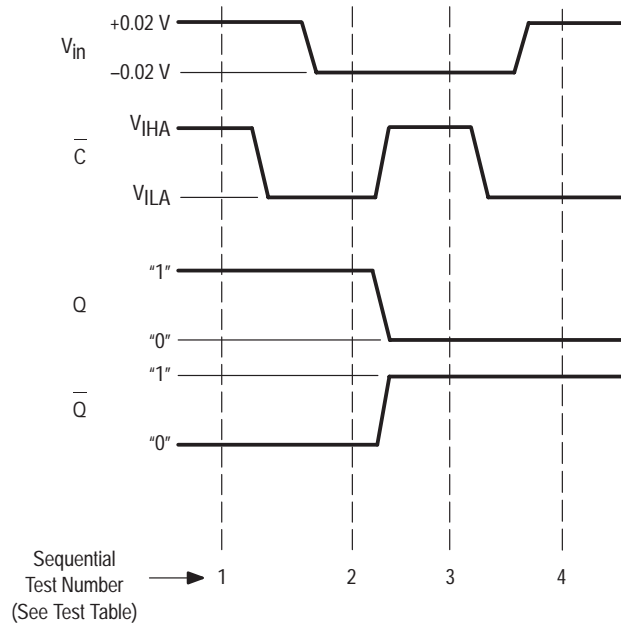
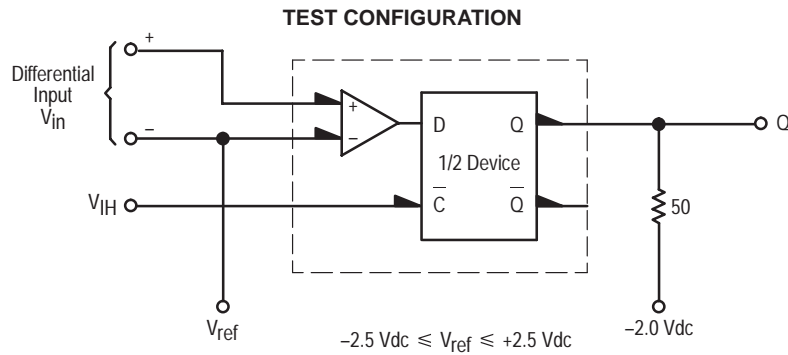


FIGURE 6 — TRANSFER CHARACTERISTICS (Q versus V_{in})



TYPICAL TRANSFER CURVES

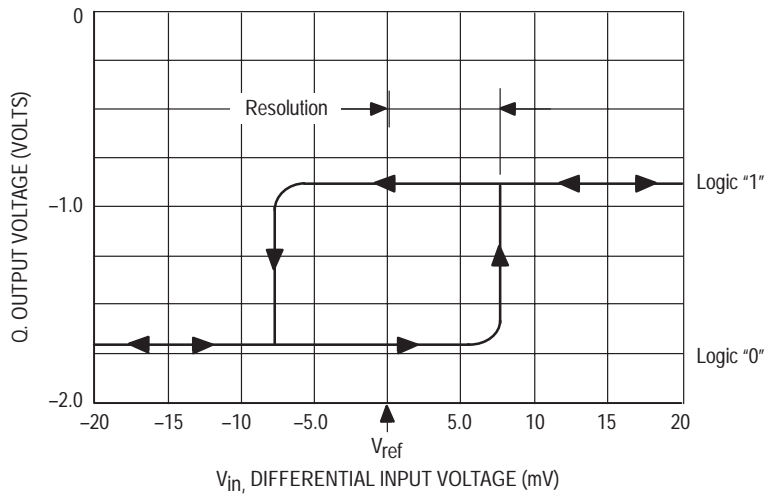
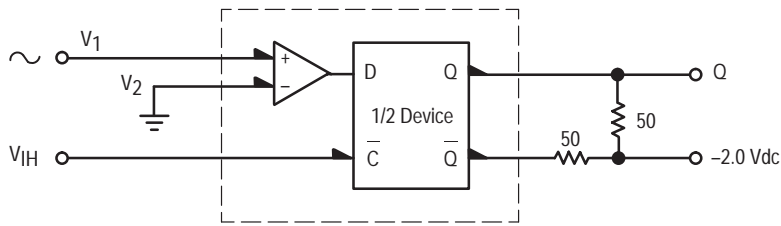


FIGURE 7 — OUTPUT VOLTAGE SWING versus FREQUENCY

(A) TEST CIRCUIT



(B) TYPICAL OUTPUT LOGIC SWING versus FREQUENCY

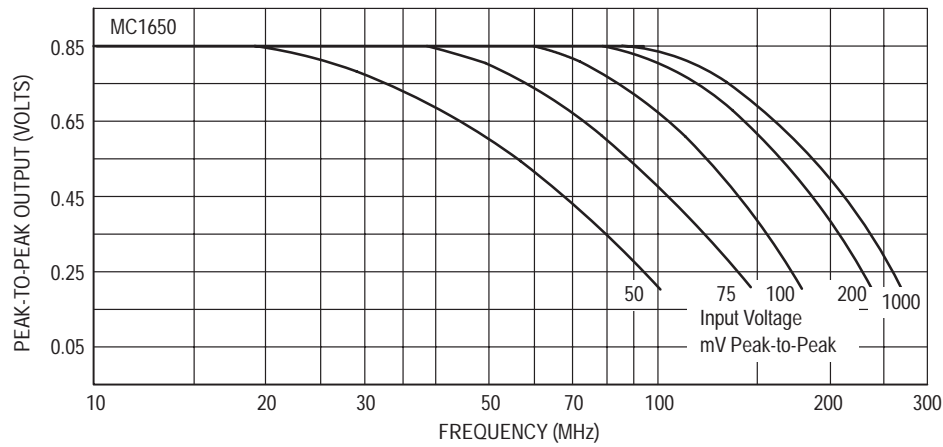
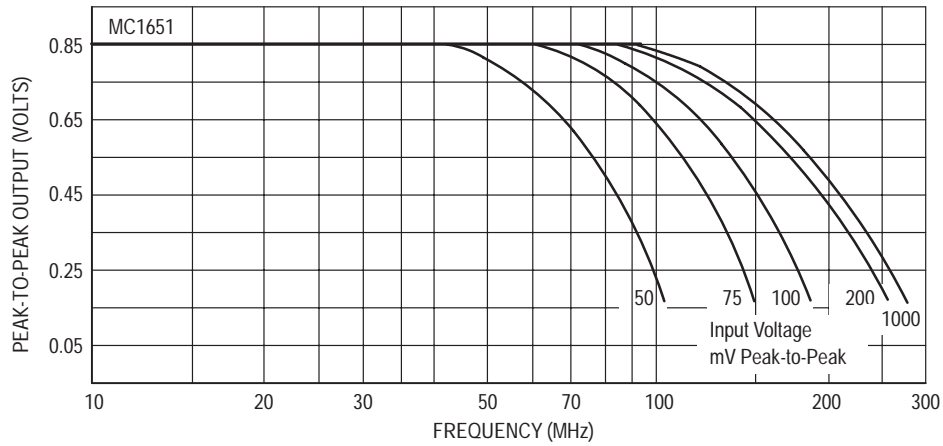
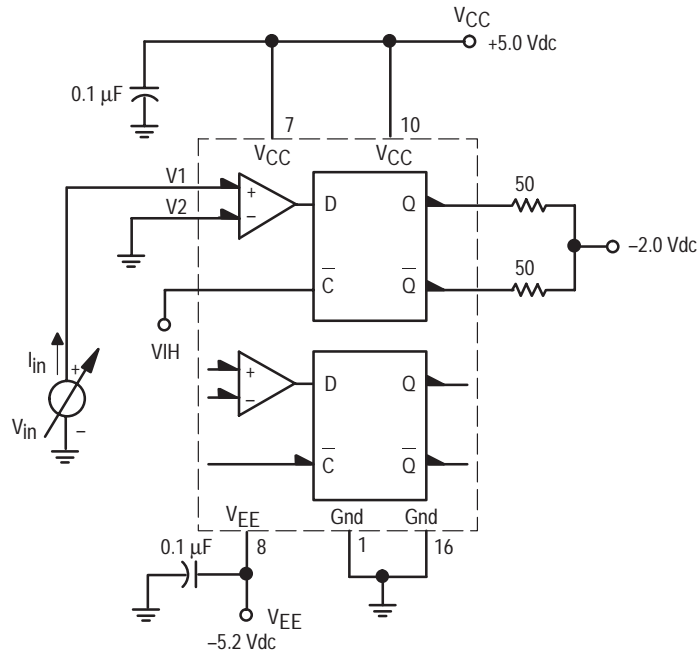
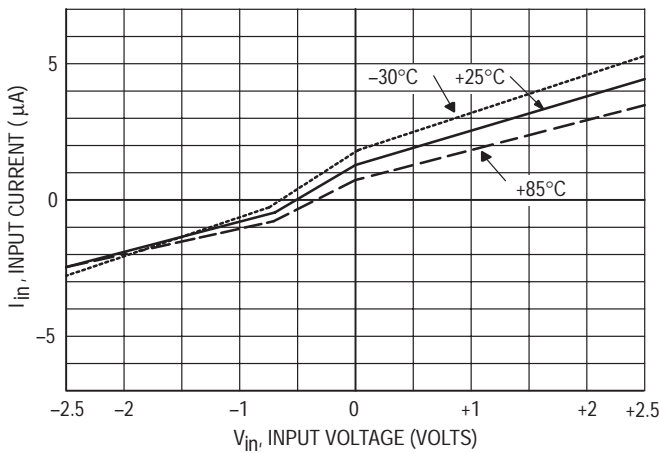


FIGURE 8 — INPUT CURRENT versus INPUT VOLTAGE

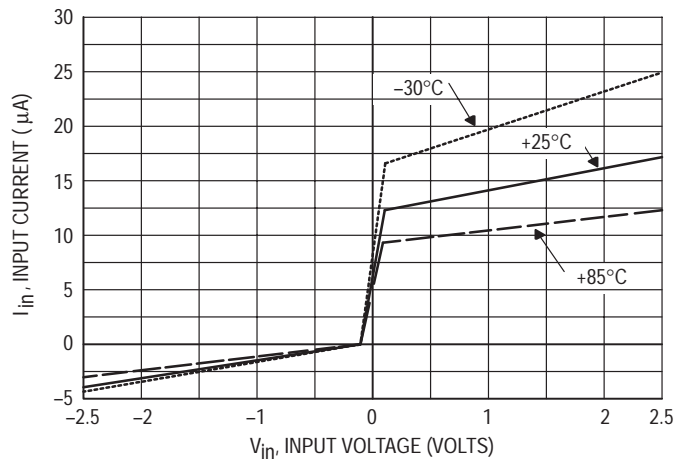
TEST CIRCUIT



Typical MC1650 (Complementary Input Grounded)



Typical MC1651 (Complementary Input Grounded)

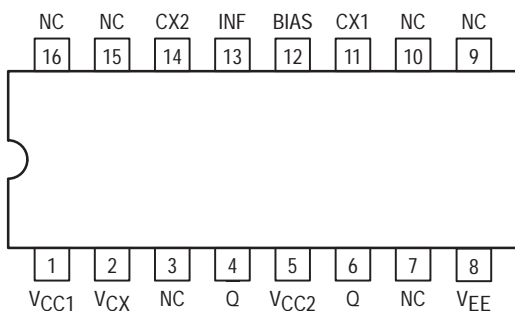


Voltage Controlled Multivibrator

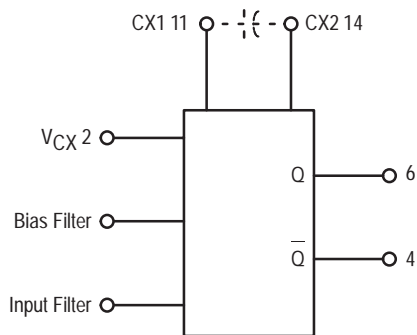
The MC1658 is a voltage-controlled multivibrator which provides appropriate level shifting to produce an output compatible with MECL III and MECL 10,000 logic levels. Frequency control is accomplished through the use of voltage-variable current sources which control the slew rate of a single external capacitor.

The bias filter may be used to help eliminate ripple on the output voltage levels at high frequencies and the input filter may be used to decouple noise from the analog input signal.

Pinout: 16-Lead Package (Top View)



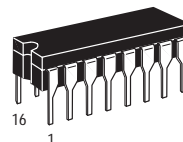
LOGIC DIAGRAM



VCC1 = Pin 1
VCC2 = Pin 5
VEE = Pin 8

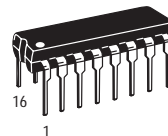
MC1658

VOLTAGE CONTROLLED MULTIVIBRATOR

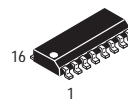


L SUFFIX
CERAMIC PACKAGE
CASE 620-10

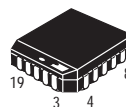
Not Recommended for New Designs



P SUFFIX
PLASTIC PACKAGE
CASE 648-08



D SUFFIX
PLASTIC SOIC PACKAGE
CASE 751B-05



FN SUFFIX
PLCC PACKAGE
CASE 775-02



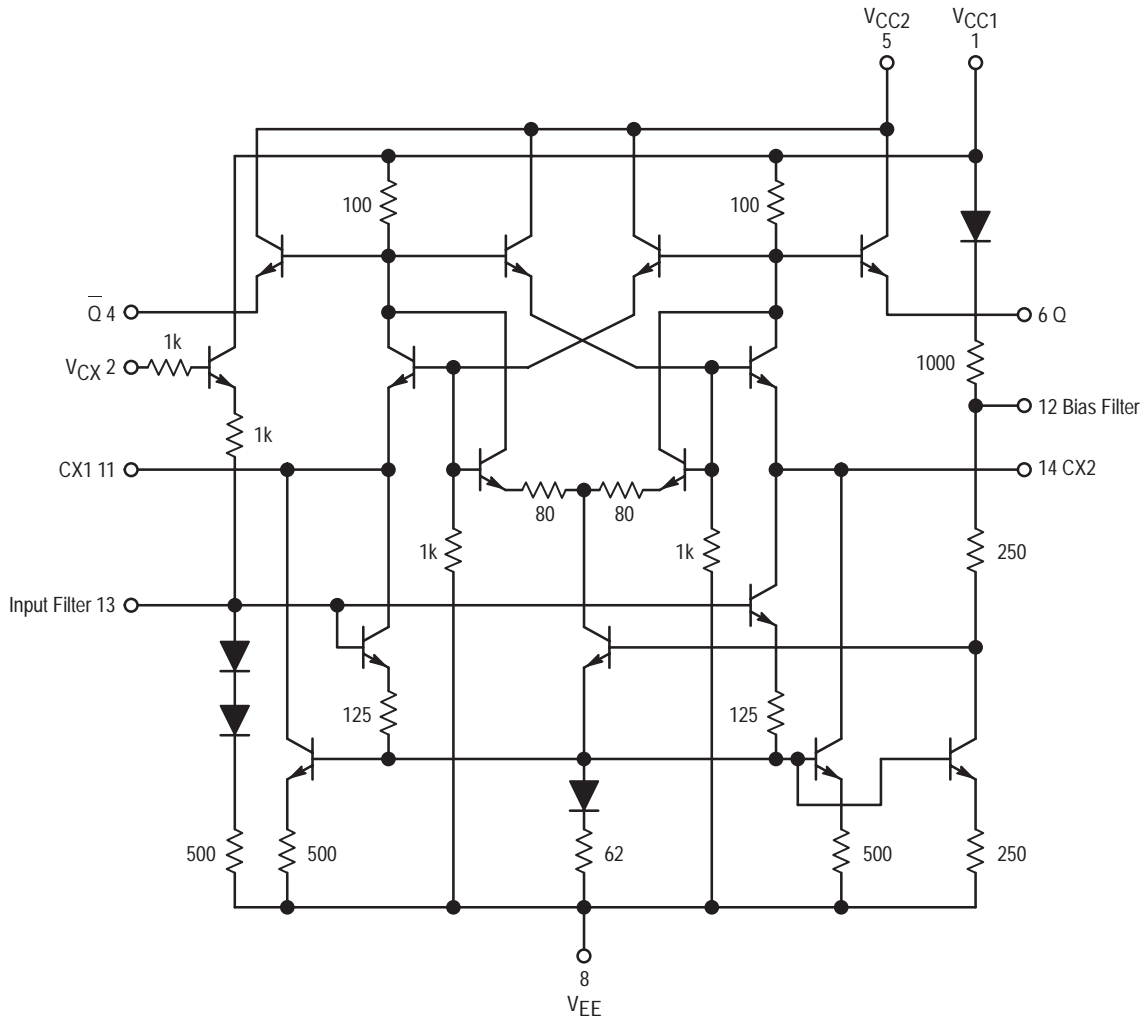


Figure 1. Circuit Schematic

TEST VOLTAGE VALUES

@ Test Temperature	Vdc ±1%			
	V _{IH}	V _{IL}	V ₃	I _{IHA}
-30°C	0	-2.0	-1.0	+2.0
+25°C	0	-2.0	-1.0	+2.0
+85°C	0	-2.0	-1.0	+2.0

Note: SOIC "D" package guaranteed -30°C to +70°C only

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2V$, $V_{CC} = 0V$ [GND])

Symbol	Characteristic	-30°C		+25°C		+85°C		Unit	Condition
		Min	Max	Min	Max	Min	Max		
I_E	Power Supply Drain Current	-	-	-	32	-	-	mAdc	V_{IH} to V_{CX} Limit Applies for 1 or 2
I_{inH}	Input Current	-	-	-	350	-	-	μ Adc	V_{IH} to V_{CX} ¹
V_{OH}	Output Voltage "Q" HIGH	-1.045	-0.875	-0.96	-0.81	-0.89	-0.7	Vdc	V_3 to V_{CX} . Limits Apply for 1 or 2
V_{OL}	Output Voltage "Q" LOW	-1.89	-1.65	-1.85	-1.62	-1.83	-1.575	Vdc	

AC CHARACTERISTICS ($V_{EE} = -3.2V$, $V_{CC} = +2.0V$)

Symbol	Characteristic	-30°C		+25°C			+85°C		Unit	Condition (See Figure 2)
		Min	Max	Min	Typ	Max	Min	Max		
t^+	Rise Time (10% to 90%)	-	2.7	-	1.6	2.7	-	3.0	ns	V_{IHA} to V_{CX} , CX1 ⁴ from Pin 11 to Pin 14
t^-	Fall Time (10% to 90%)	-	2.7	-	1.4	2.7	-	3.0	ns	
f_{osc1}	Oscillator Frequency	130	-	130	155	175	110	-	MHz	V_{IHA} to V_{CX} , CX2 ⁵ from Pin 11 to Pin 14
f_{osc2}		-	-	78	100	120	-	-		
TR ³	Tuning Ratio Test	-	-	3.1	4.5	-	-	-	-	CX2 ⁵ from Pin 11 to Pin 14

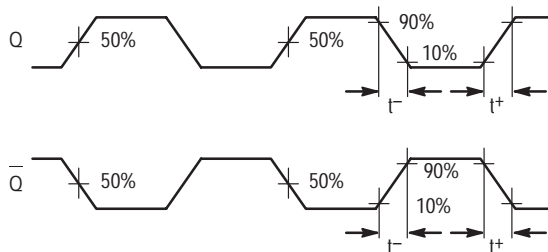
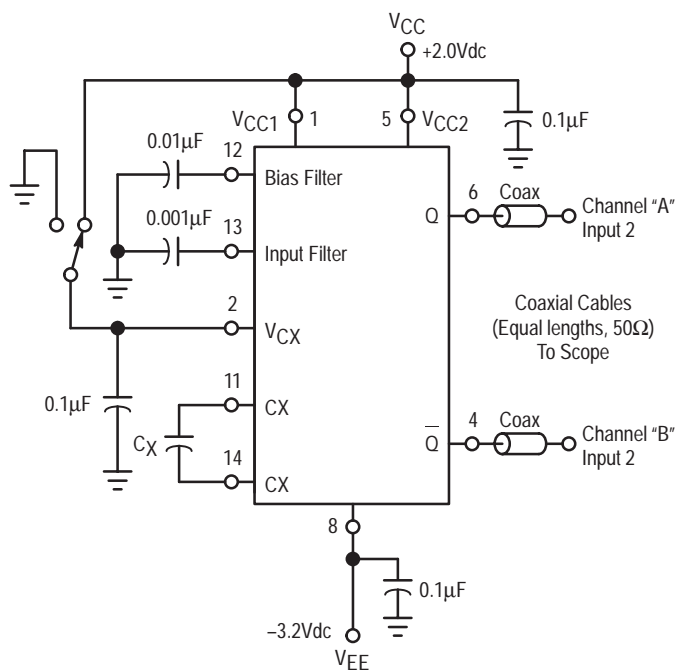
1 Germanium diode (0.4 drop) forward biased from 11 to 14 (11 → 14).

2 Germanium diode (0.4 drop) forward biased from 14 to 11 (11 ← 14).

3 $TR = \frac{\text{Output frequency at } V_{CX} = GND}{\text{Output frequency at } V_{CX} = -2.0V}$

4 CX1 = 5.0pF connected from pin 11 to pin 14.

5 CX2 = 10pF connected from pin 11 to pin 14.



50 ohm termination to ground located in each scope channel input. All input and output cables to the scope are equal lengths of 50 ohm coaxial cable. Wire length should be < 1/4 inch from TP_{in} to input pin and TP_{out} to output pin. Note: All power supply and logic levels are shown shifted 2.0V positive.

Figure 2. AC Test Circuit and Waveforms

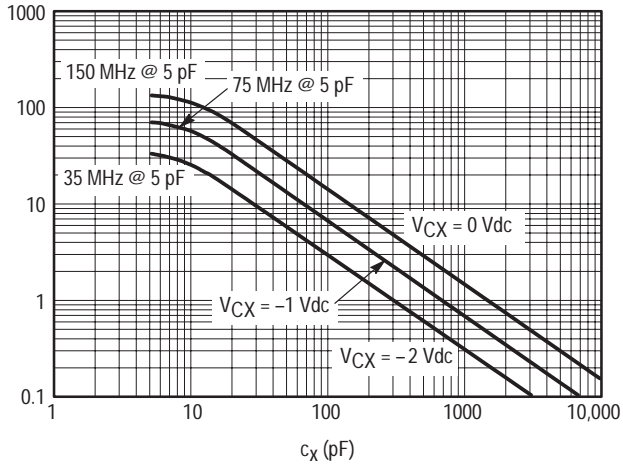


Figure 3. Output Frequency versus Capacitance for Various Values of Input Voltage

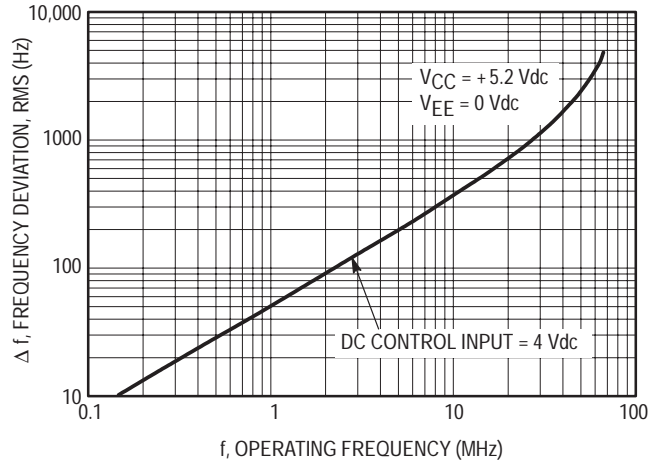
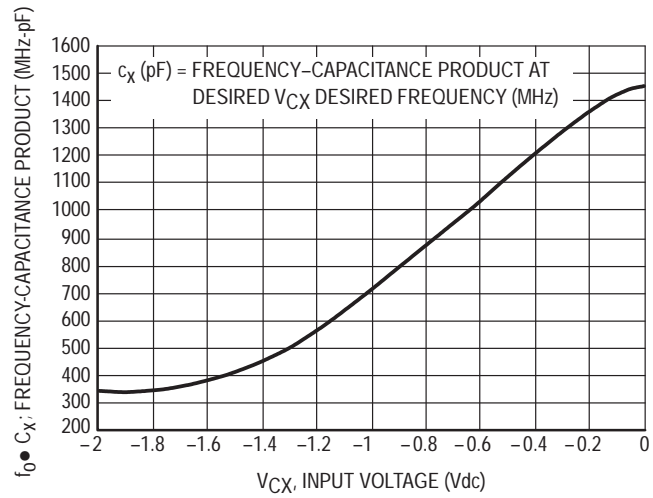


Figure 4. RMS Noise Deviation versus Operating Frequency



$f_0 \bullet C_X$: FREQUENCY-CAPACITANCE PRODUCT (MHz-pF)
 c_X (pF) = FREQUENCY-CAPACITANCE PRODUCT AT DESIRED V_{CX} DESIRED FREQUENCY (MHz)
 $V_{EE} = -5.2V, V_{CC} = 0V.$
 For Use at $V_{EE} = 0V, V_{CC} = +5V$ ($V_{CXP} = +5V - V_{CX}$)
 V_{CXP} = Positive Input Voltage

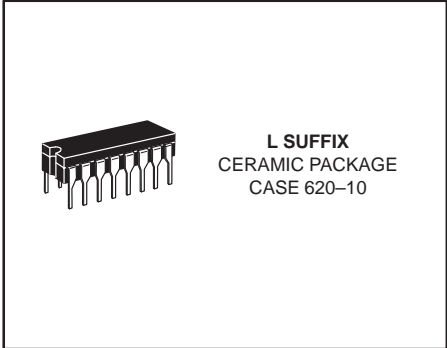
Figure 5. Frequency Capacitance Product versus Control Voltage (V_{CX})

Dual 4-Input OR/NOR Gate

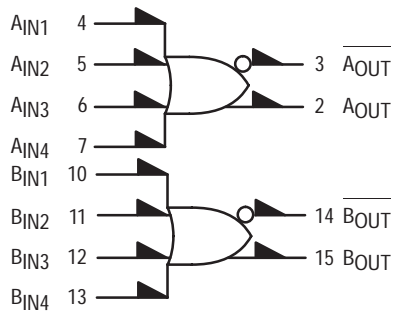
MC1660

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	-30°C		+25°C		+85°C		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Drain Current	I_E	—	—	—	28	—	—	mAdc
Input Current	I_{inH}	—	—	—	350	—	—	μ Adc
Switching Times								ns
Propagation Delay	t_{+-}	0.6	1.8	0.6	1.7	0.6	1.9	
	t_{-+}	0.6	1.6	0.6	1.5	0.6	1.7	
Rise Time, Fall Time (10% to 90%)	t^+, t^-	0.6	2.2	0.6	2.1	0.6	2.3	ns



LOGIC DIAGRAM



$$\overline{OUT} = \overline{IN1 + IN2 + IN3 + IN4}$$

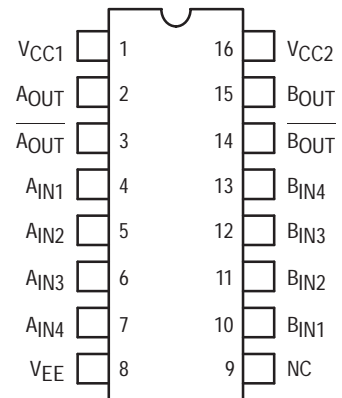
$$OUT = IN1 + IN2 + IN3 + IN4$$

$V_{CC1} = \text{PIN } 1$
 $V_{CC2} = \text{PIN } 16$
 $V_{EE} = \text{PIN } 8$

$t_{pd} = 0.9 \text{ ns typ (510 ohm load)}$
 $= 1.1 \text{ ns typ (50 ohm load)}$

$P_D = 120 \text{ mW typ/pkg (No load)}$
Full Load Current, $I_L = -25 \text{ mAdc max}$

PIN ASSIGNMENT



Quad 2-Input NOR Gate

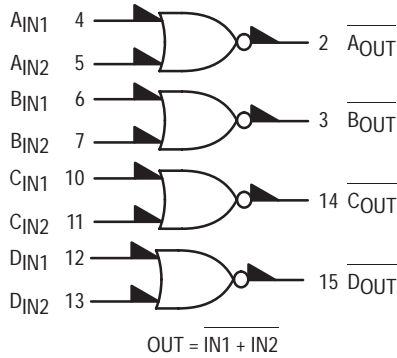
MC1662

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	-30°C		+25°C		+85°C		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Drain Current	I_E	—	—	—	56	—	—	mAdc
Input Current	I_{inH}	—	—	—	350	—	—	μ Adc
Switching Times								ns
Propagation Delay	t_{-+}	0.6	1.6	0.6	1.5	0.6	1.7	
	t_{+-}	0.6	1.8	0.6	1.7	0.6	1.9	
Rise Time, Fall Time (10% to 90%)	t_{+}, t_{-}	0.6	2.2	0.6	2.1	0.6	2.3	ns



LOGIC DIAGRAM

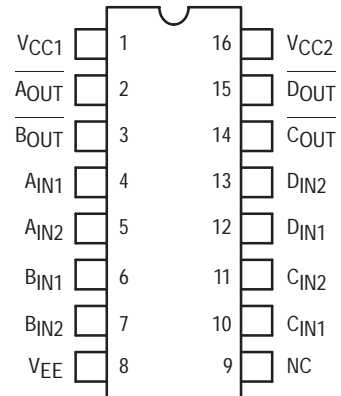


V_{CC1} = PIN 1
 V_{CC2} = PIN 16
 V_{EE} = PIN 8

t_{pd} = 0.9 ns typ (510 ohm load)
= 1.1 ns typ (50 ohm load)

P_D = 240 mW typ/pkg (No load)
Full Load Current, I_L = -25 mAdc max

PIN ASSIGNMENT



Master-Slave Flip-Flop

Master slave construction renders the MC1670 relatively insensitive to the shape of the clock waveform, since only the voltage levels at the clock inputs control the transfer of information from data input (D) to output.

When both clock inputs (C1 and C2) are in the low state, the data input affects only the "Master" portion of the flip-flop. The data present in the "Master" is transferred to the "Slave" when clock inputs (C1 "OR" C2) are taken from a low to a high level. In other words, the output state of the flip-flop changes on the positive transition of the clock pulse.

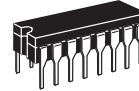
While either C1 "OR" C2 is in the high state, the "Master" (and data input) is disabled.

Asynchronous Set (S) and Reset (R) override Clock (C) and Data (D) inputs.

Power Dissipation = 220 mW typ (No Load)

f_{Tog} = 350 MHz typ

MC1670



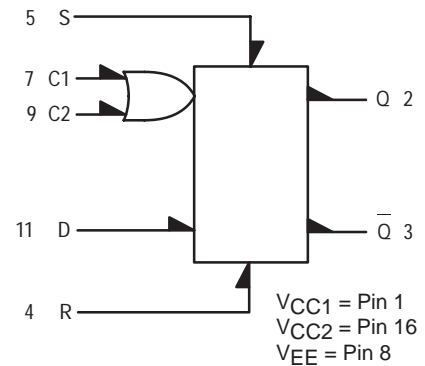
L SUFFIX
CERAMIC PACKAGE
CASE 620-10

TRUTH TABLE

R	S	D	C	Q_{n+1}
L	H	X	X	H
H	L	X	X	L
H	H	X	X	N.D.
L	L	L	L	Q_n
L	L	L	H	L
L	L	L	L	Q_n
L	L	H	L	Q_n
L	L	H	H	H
L	L	H	H	Q_n

ND = Not Defined
C = C1 + C2

LOGIC DIAGRAM



ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	-30°C		+25°C		+85°C		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Drain Current	I_E	—	—	—	48	—	—	mAdc
Input Current Set, Reset Clock Data	I_{inH}	—	—	—	550	—	—	μ Adc
Switching Times								ns
Propagation Delay	t_{pd}	1.0	2.7	1.1	2.5	1.1	2.9	
Rise Time (10% to 90%)	t^+	0.9	2.7	1.0	2.5	1.0	2.9	ns
Fall Time (10% to 90%)	t^-	0.5	2.1	0.6	1.9	0.6	2.3	ns
Setup Time	$t_{S"1"}$ $t_{S"0"}$	—	—	0.4	—	—	—	ns
Hold Time	$t_{H"1"}$ $t_{H"0"}$	—	—	0.3	—	—	—	ns
Toggle Frequency	f_{Tog}	270	—	300	—	270	—	MHz

PIN ASSIGNMENT

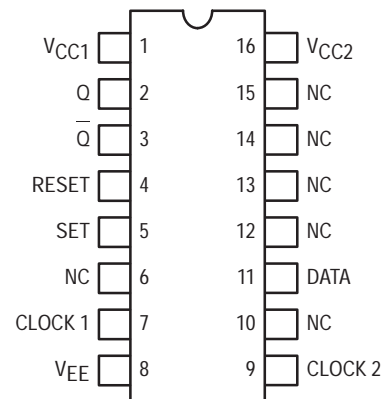
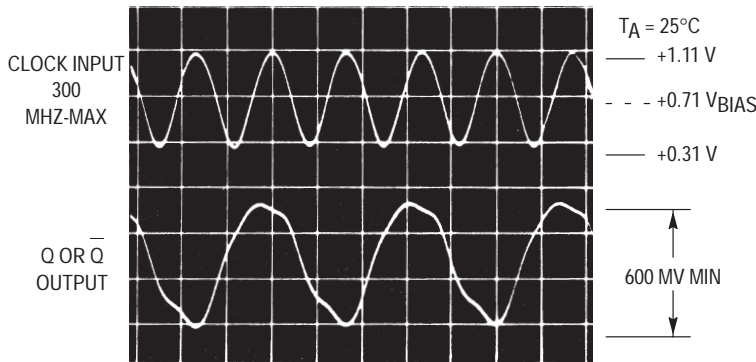


FIGURE 1 — TOGGLE FREQUENCY WAVEFORMS



The maximum toggle frequency of the MC1670 has been exceeded when either:

1. The output peak-to-peak voltage swing falls below 600 millivolts, OR
2. The device ceases to toggle (divide by two).

FIGURE 2 — MAXIMUM TOGGLE FREQUENCY (TYPICAL)

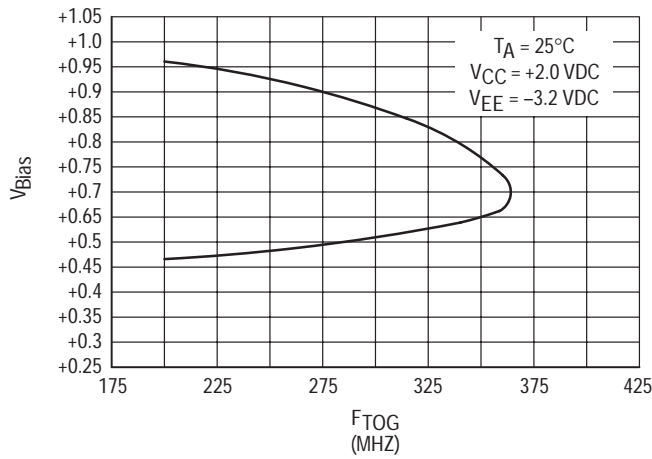
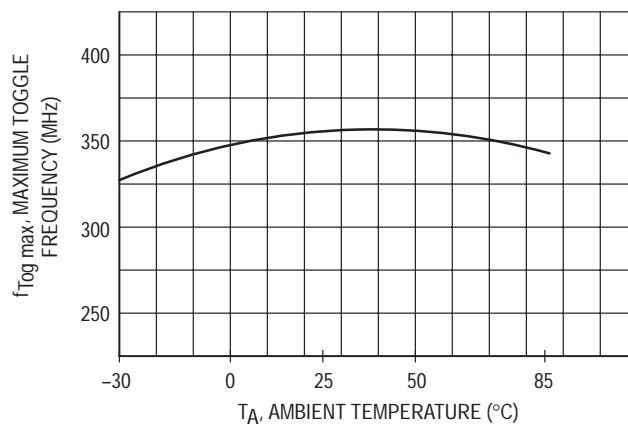


Figure 2 illustrates the variation in toggle frequency with the dc offset voltage (V_{Bias}) of the input clock signal. Figures 4 and 5 illustrate minimum clock pulse width recommended for reliable operation of the MC1670.

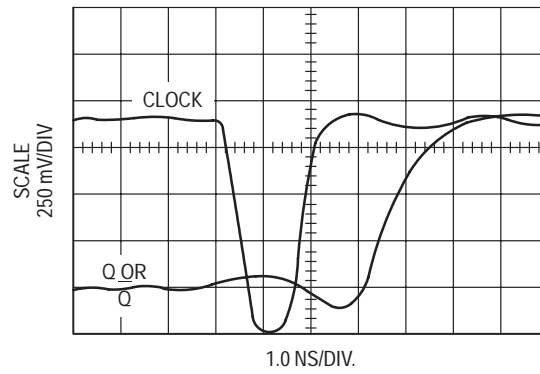
FIGURE 3 — TYPICAL MAXIMUM TOGGLE FREQUENCY versus TEMPERATURE



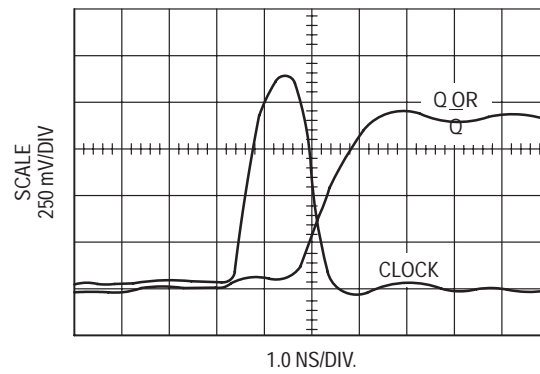
Temperature	-30°C	+25°C	+85°C
V_{Bias}	+0.66 Vdc	+0.71 Vdc	+0.765 Vdc

Note: All power supply and logic levels are shown shifted 2.0 volts positive.

**FIGURE 4 — MINIMUM “DOWN TIME” TO CLOCK
OUTPUT LOAD = 50 Ω**



**FIGURE 5 — MINIMUM “UP TIME” TO CLOCK
OUTPUT LOAD = 50 Ω**

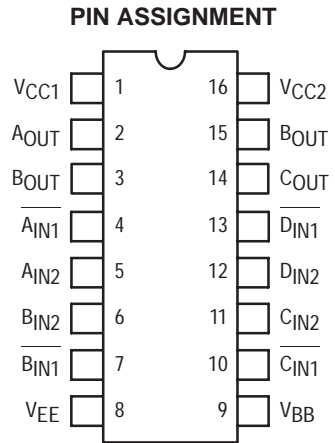
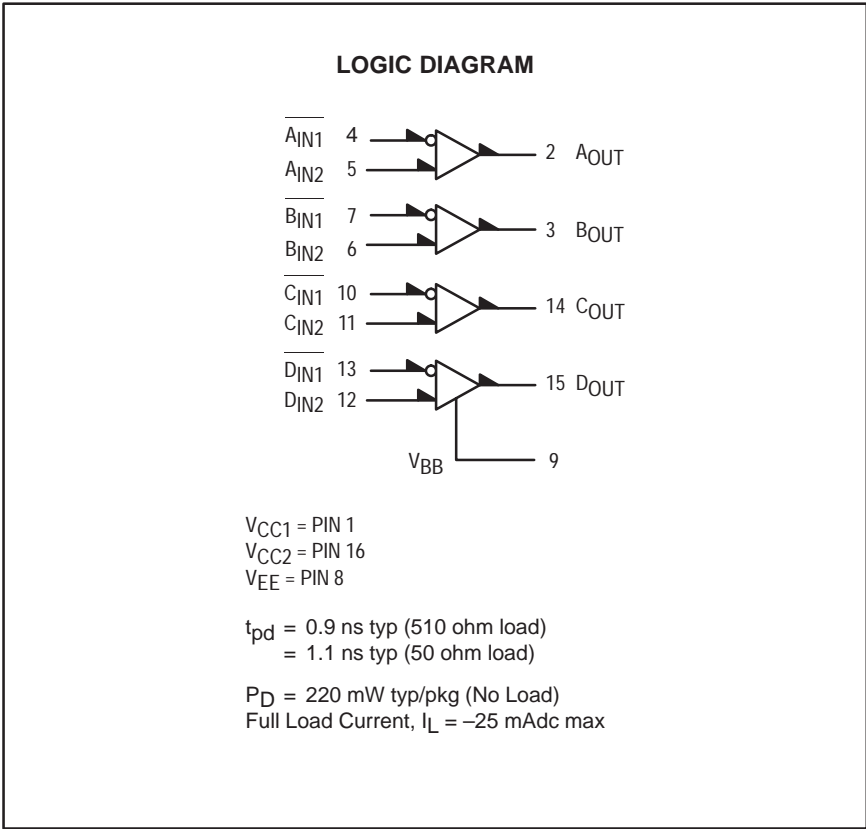


Quad Line Receiver

MC1692

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	-30°C		+25°C		+85°C		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Drain Current	I_E	—	—	—	50	—	—	mAdc
Input Current	I_{in}	—	—	—	250	—	—	μ Adc
Input Leakage Current	I_R	—	—	—	100	—	—	μ Adc
Reference Voltage	V_{BB}	-1.375	-1.275	-1.35	-1.25	-1.3	-1.2	Vdc
Switching Times Propagation Delay	t_{-+}	0.6	1.6	0.6	1.5	0.6	1.7	ns
	t_{+-}	0.6	1.8	0.6	1.7	0.6	1.9	
Rise Time, Fall Time (10% to 90%)	t^+, t^-	0.6	2.2	0.6	2.1	0.6	2.3	ns



APPLICATION INFORMATION

The MC1692 quad line receiver is used primarily to receive data from balanced twisted pair lines, as indicated in Figure 1. The line is driven with a MC1660 OR/NOR gate. The MC1660 is terminated with 50 ohm resistors to -2.0 volts. At the end of the twisted pair a 100 ohm termination resistor is placed across the differential line receiver inputs of the MC1692. Illustrated in Figure 2 is the sending and receiving waveforms at a data rate of 400 megabits per second over an 18 foot twisted pair cable.

The waveform picture of Figure 3 shows a 5.0 nanosecond pulse being propagated down the 18 foot line. The delay time for the line is 1.68 ns/foot.

The MC1692 may also be applied as a high frequency schmitt trigger as illustrated in Figure 4. This circuit has been used in excess of 200 MHz. The MC1692 when loaded into 50 ohms will produce an output rising edge of about 1.5 nanoseconds.

FIGURE 1 — LINE DRIVER/RECEIVER

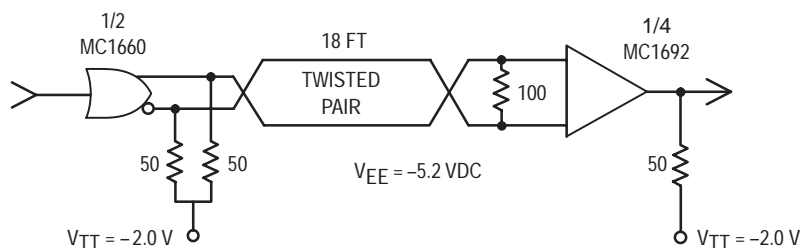


FIGURE 2 — 400 MBS WAVEFORMS

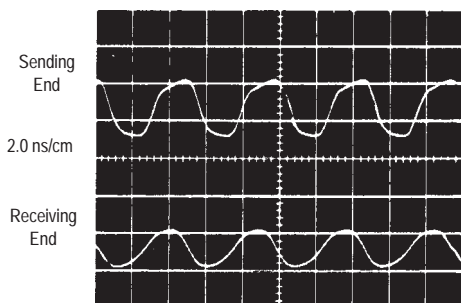


FIGURE 3 — PULSE PROPAGATION WAVEFORMS

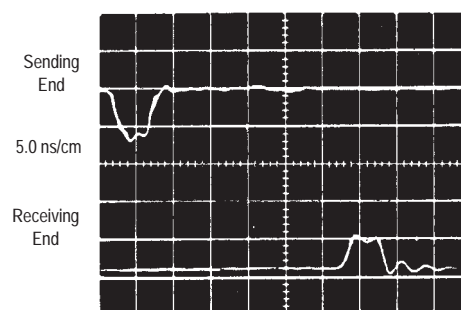
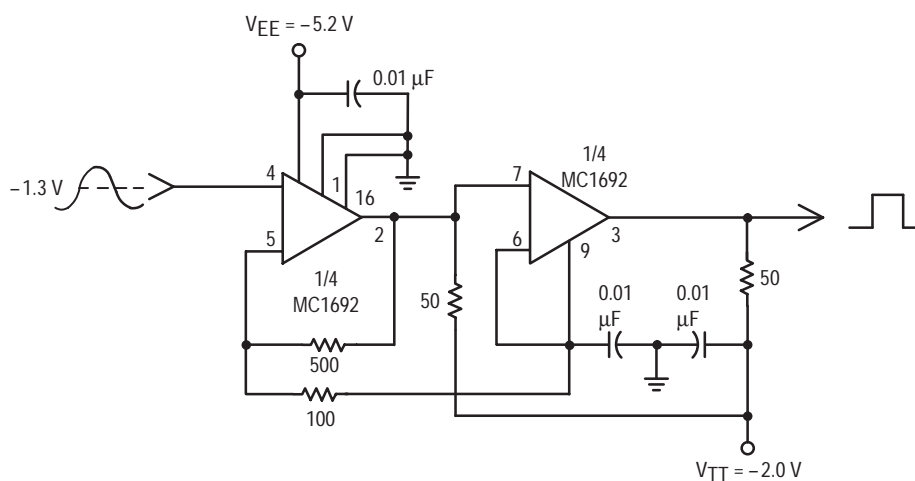


FIGURE 4 — 200 MHz SCHMITT TRIGGER



MECL Data



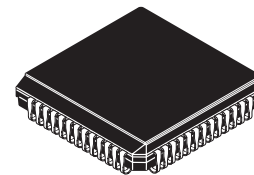
Carrier Band Modem **5**

Carrier Band Modem (CBM)

The bipolar LSI MC68194 Carrier Band Modem (CBM) when combined with the MC68824 Token Bus Controller provides an IEEE 802.4 single channel, phase-coherent carrier band Local Area Network (LAN) connection. The CBM performs the Physical Layer function including symbol encoding/decoding, signal transmission and reception, and physical management. Features include:

- Implements IEEE 802.4 single channel, phase-coherent Frequency Shift Keying (FSK) physical layer including receiver blanking.
- Provides physical layer management including local loopback mode, transmitter enable, and reset.
- Supports data rates from 1 to 10 Mbps. IEEE 802.4 standard uses 5 or 10 Mbps.
- Interfaces via standard serial interface to MC68824 Token Bus Controller.
- Crystal controlled transmit clock.
- Recovery of clocked data through phase-locked loop.
- RC controlled Jabber Inhibit Timer.
- Single +5.0 volt power supply.
- Available in 52-lead Cerquad package.

MC68194



FJ SUFFIX
J-LEAD CERQUAD PACKAGE
CASE 778B-01

PIN ASSIGNMENTS

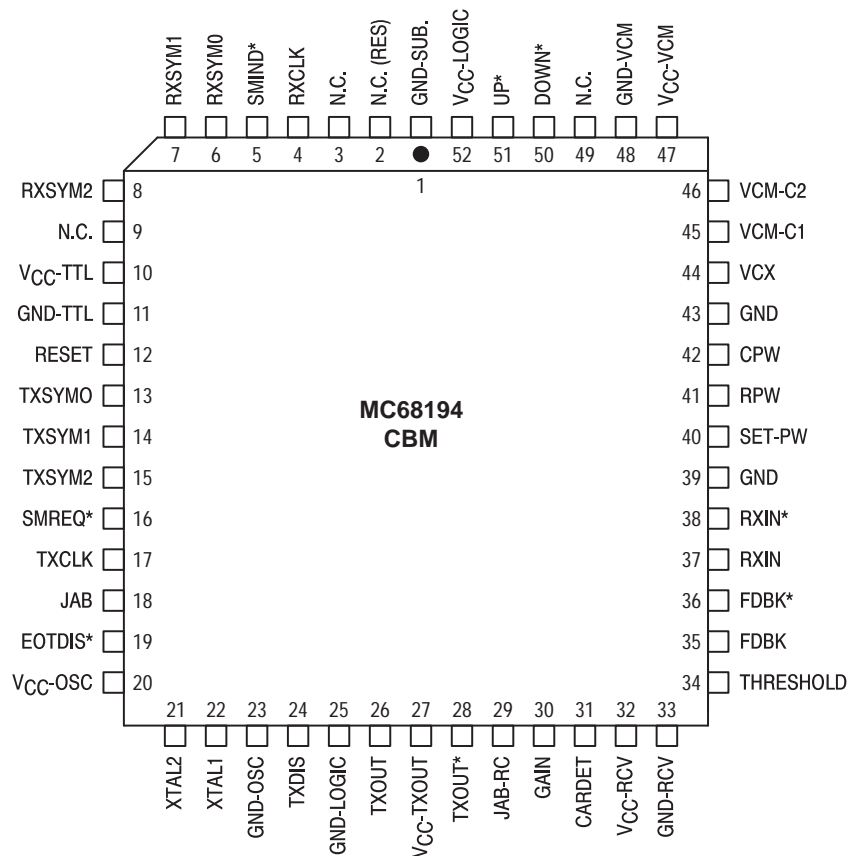


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**SECTION 1
GENERAL DESCRIPTION**

1.1 TOKEN BUS LAN CARRIER BAND NODE OVERVIEW

The MC68194 Carrier Band Modem (CBM) is part of Motorola's solution for an IEEE 802.4 token bus carrier band Local Area Network (LAN) node. The CBM integrates the function of the single-channel, phase-coherent Frequency Shift Keying (FSK) physical layer. Figure 1-1 illustrates the architecture of a token bus LAN node as commonly used in Manufacturing Automation Protocol (MAP) industrial communications. Based on the ISO-OSI model, the LLC Sublayer and additional upper layers are typically supported by a local MPU subsystem, while the IEEE 802.4 token bus MAC Sublayer and Physical Layer are implemented by the MC68824 Token Bus Controller (TBC) and MC68194 CBM respectively.

The MC68194 provides the three basic functions of the physical layer including data transmission to the coax cable, data reception from the cable, and management of the physical layer. For standard data mode (also called MAC mode), the carrier band modem receives a serial transmit data stream from the MC68824 TBC (called symbols or atomic symbols), encodes, modulates the carrier, and transmits the signal to the coaxial cable. Also in the data mode, the CBM receives a signal from the cable, demodulates the signal, recovers the data, and sends the received data symbols to the TBC. Communication between the TBC and CBM is through a standardized serial interface inconsistent with the IEEE 802.4 DTE-DCE serial interface.

The physical layer management provides the ability to reset the CBM, control the transmitter, and do loopback testing. Also, an onboard RC timer provides a "jabber" inhibit function to turn off the transmitter and report an error condition if the transmitter has been continuously on for too long. Similar to the data mode, the CBM management mode makes use of the TBC serial interface.

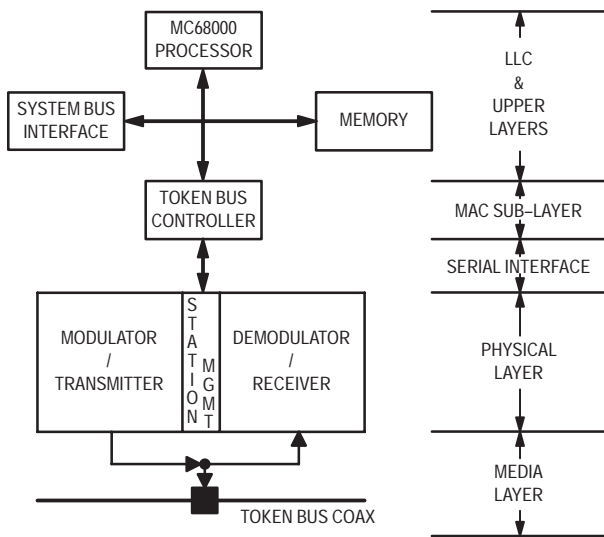


Figure 1-1. IEEE 802.4 Token Bus Carrier Band Node

1.2 CARRIER BAND MODULATION TECHNIQUE

The CBM uses phase-coherent frequency shift keying (FSK) modulation on a single channel system. In this modulation technique, the two signaling frequencies are integrally related to the data rate, and transitions between the two signaling frequencies are made at zero crossings of the carrier waveform. Figure 1-2 shows the data rate and signaling frequencies. An {L} is represented as one half cycle of a signal, starting and ending with a nominal zero amplitude, whose period is equal to the period of the data rate, with the phase of one half cycle changing at each successive {L}. An {H} is represented as one full cycle of a signal, starting and ending with a nominal zero amplitude whose period is equal to half the period of the data rate. In a 5 Mbps implementation, the frequency of {L} is 5.0 MHz and for {H} is 10 MHz. For a 10 Mbps implementation, the frequency of {L} is 10 MHz and for {H} is 20 MHz. The other possible physical symbol is when no signal occurs for a period equal to one half of the period of the data rate. This condition is represented by {off}.

Data Rate MBPS	Frequency of Lower Tone MHz {L}	Frequency of Higher Tone MHz {H}
5	5.0	10
10	10	20

Figure 1-2. Data Rate versus Signaling Frequencies

The specified physical symbols ({L}, {H} and {off}) are combined into pairs which are called MAC-symbols. The MAC-symbols are transferred across the serial link. The encodings for the five MAC-symbols are shown in Figure 1-3. Figure 1-4 shows the phase coherent FSK modulation scheme for ONE, ZERO, and NON-DATA. The IEEE 802.4 document does not specify the polarity used to transmit data on the physical cable. The receiver must operate without respect to polarity.

Mac-Symbol	Encoding
Silence	{off off}
Pad-Idle	{L L} {H H}
Pairs	{H H}
Zero	{L L}
One	{H L}
Non-Data ND1	{L H}
Non-Data ND2	

Figure 1-3. MAC Symbol Encoding

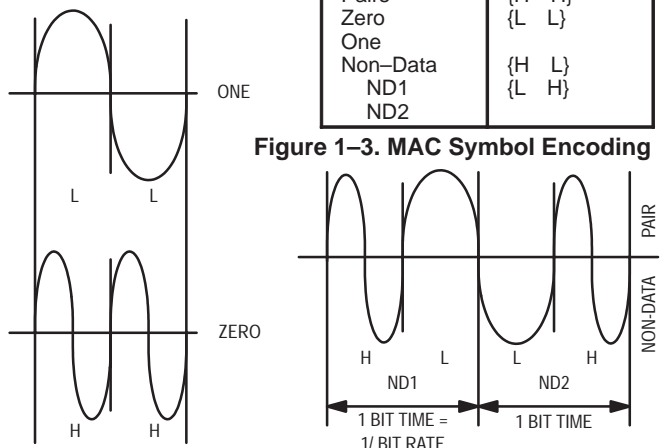


Figure 1-4. Phase-Coherent Modulation Scheme

5

1.3 MESSAGE (FRAME) FORMAT

Although the CBM only uses MAC symbols one-at-a-time, the MAC or TBC is responsible for combining the above defined MAC symbols into messages (more correctly called frames). For the purposes of the CBM, a simplified frame format can be used consisting of:

SILENCE || PAD-IDLE | START DELIMITER | DATA | END DELIMITER || SILENCE

where:

PAD-IDLE = alternating {LL} {HH} pairs which must occur in octets or groups of eight symbols. Pad-idle provides a training signal for the receiver and occurs at the beginning of every transmission (and between frames in a multiple frame transmission).

START DELIMITER = a unique pattern of eight symbols (one octet) that marks the beginning of a frame. The pattern is:

ND1 ND2 0 ND1 ND2 0 0 0

where ND1 is the first symbol transmitted.

DATA = octets of ZERO/ONE patterns that are the actual data or "information" contained within the frame.

END DELIMITER = a unique pattern of symbols that marks the end of a frame. The pattern is:

ND1 ND2 1 ND1 ND2 1 {I=0/1} {0/1}

where ND1 is the first symbol transmitted. Note that unlike the Start Delimiter, the last two bits of the End Delimiter octet are not always the same. The seventh bit of the octet is called the I Bit or Intermediate bit which = 1 when there is more to transmit and = 0 at the end of a transmission.

A single transmission can consist of one or more frames. In a multi-frame transmission, Pad-Idle is sent between consecutive frames to separate them. If an End Delimiter occurs **within** a multi-frame transmission its I Bit will = 1, and the **last** end delimiter will have its I Bit = 0.

The CBM accepts a stream of MAC symbols from the TBC and modulates the phase-coherent transmit signal accordingly. Conversely, the CBM receives a phase-coherent signal stream from the cable, decodes the MAC symbols, and reports them. On transmission there is a direct one-to-one correlation between MAC symbols requested and the modulated signal; however, during reception exceptions can occur. The CBM is allowed to report Silence or the actual Zero/One pattern during preamble which is done to allow the receiver to "train" to the incoming signal. Also, if noise in the system has corrupted the data, it may show up as an incorrect MAC symbol or the CBM can report a BAD SIGNAL symbol if an incorrect combination of ND symbols is detected (ND2 without an ND1, ND2 followed by ND2, etc.)

1.4 SYSTEM CONFIGURATION

Figure 1-5 illustrates the CBM and peripheral circuitry required for an IEEE 802.4 carrierband 5 Mbps or 10 Mbps data rate phase-coherent FSK physical layer. The CBM communicates with the MAC or TBC through a TTL compatible serial interface that is consistent with the IEEE 802.4 exposed DTE-DCE interface. Management and transmission symbol requests are accepted via the CBM physical data request channel (TXSYM0-TXSYM2, SMREQ*, and TXCLK). The physical data indication channel (RXSYM0-RXSYM2, SMIND*, and RXCLK) is used to send received symbols and management responses to the MAC.

The periphery circuitry is primarily associated with interface to the LAN coaxial cable and data recovery. An external crystal or clock source is required (20 MHz for 5 Mbps data rate or 40 MHz for 10 Mbps data rate) for onboard timing and transmit clock. Also, an RC timing network sets the jabber timeout period.

The coaxial cable interface combines the transmit and receive signal functions. For transmission, the CBM provides differential drive signals (TXOUT and TXOUT*) whose signaling is ECL levels referenced to V_{CC} (logic high $\approx +4.1$ V, logic low $\approx +3.3$ V) and a gate signal called TXDIS. The IEEE 802.4 standard puts specific requirements on the signal transmitted to the cable:

Between +63 dB and +66 dB (1.0 mV, 75 Ω) [dBmV] output voltage level.

Transmitter-off leakage not to exceed -20 dB (1.0 mV, 75 Ω) [dBmV].

Signal transition time window (eye pattern) dependent on data rate.

Because of this, an external amplifier with waveshaping is required. The CBM TXOUT/TXOUT* outputs provide complementary signals with virtually no slew, and the TXDIS is an enable signal helpful for turning the external amp off "hard" to meet the low level leakage.

On the reception side, the CBM requires a pre-amplifier to receive the low level signal from the cable. The signal available at the "F"-connector can range from +10 dB to +66 dB (1.0 mV, 75 Ω) [dBmV]. The signal required at the CBM is about 12 dB above this (net gain through the transformer, pre-amp, and any filtering). The receiver can be used in full differential or single-ended mode.

A second part of the receiver function is the signal detect or carrier detect function. The IEEE 802.4 requires that the receiver detect a signal of +10 dBmV or above (i.e., be turned "on") and report Silence for a signal of +4.0 dBmV or below (i.e., be turned "off"). Therefore, a 6.0 dB (2:1 voltage ratio) range or window is defined in which the signal detect must switch. The CBM is optimized for this range (including the pre-amp gain), although it is trimmed via an external THRESHOLD.

The remaining external components are associated with clock recovery. A capacitor and resistor (internal R also provided) set one-shot timing, and an active filter for a PLL used in clock and data recovery is required. The active filter can be implemented via an op amp, or if 5.0 volt operation is required, an alternate charge pump design can be used. The

5

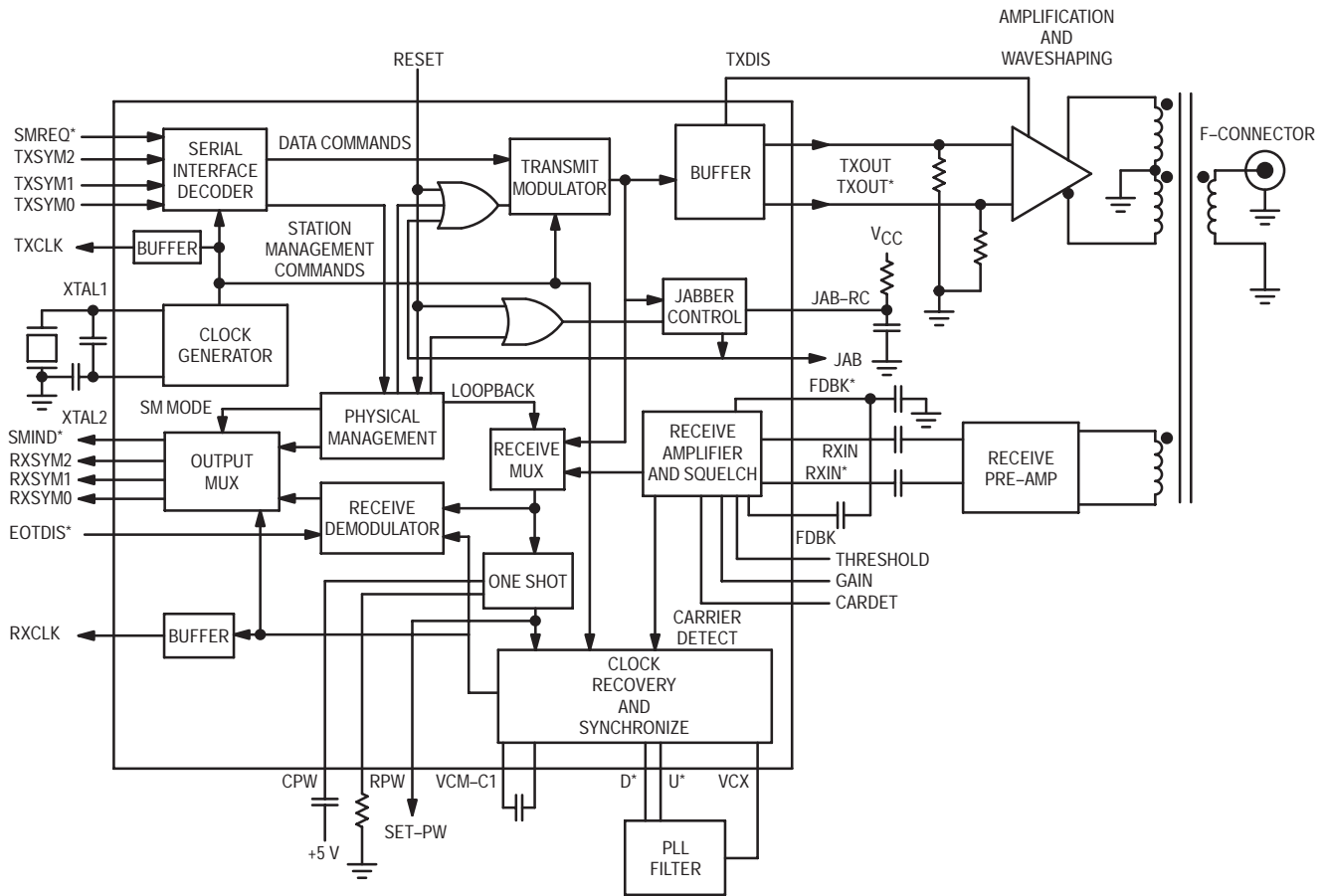


Figure 1-5. Functional Block Diagram

clock recovery and data decoder is a synchronous design which provides superior performance minimizing clock jitter.

Although primarily intended for the IEEE 802.4 carrier band, the CBM is also an excellent device for point-to-point data

links, fiberoptic modems, and proprietary LANs. The MC68194 can be used over a wide range of frequencies and interfaces easily into different kinds of media.

5

SECTION 2 SIGNAL DESCRIPTION

Symbol	Type	Name/Description
TXSYM0–TXSYM2	TTL/I*	TRANSMIT SYMBOLS — These TTL inputs are request channel signals used to send either serial transmission symbols in the MAC mode or commands in station management mode. They are synchronized to TXCLK and are normally connected to the TXSYM outputs of the MC68824. SMREQ* selects the meaning of these signals as either MAC mode or management mode.
SMREQ*	TTL/I*	STATION MANAGEMENT REQUEST — A TTL input that selects the mode of the request channel signals TXSYM. Synchronized to TXCLK, SMREQ* is equal to one for MAC mode and equal to zero for management mode. It is normally driven by the SMREQ* output of the MC68824.
TXCLK	TTL/O	TRANSMIT CLOCK — A TTL clock output generated from the crystal oscillator (it is 1/4 of the oscillator frequency) used to receive request channel symbols from the MC68824. TXCLK is equal to the data rate of the application (5.0 MHz or 10 MHz for IEEE 802.4). TXSYM and SMREQ* are synchronized to the positive edge of TXCLK which is supplied to the MC68824.
RXSYM0–RXSYM2	TTL/O	RECEIVE SYMBOLS — These TTL outputs are indication channel signals used to provide either serial receive symbols in MAC mode or command confirmation/indication in station management mode. They are synchronized to RXCLK and are normally connected to the RXSYM inputs of the MC68824. SMIND* selects the meaning of these signals as either MAC mode or management mode.
SMIND*	TTL/O	STATION MANAGEMENT INDICATION — A TTL output that indicates the mode of the CBM and RXSYM lines. Synchronized to RXCLK, SMIND* is equal to one for MAC mode and equal to zero for management mode. It is normally connected to the SMIND* input of the MC68824.
RXCLK	TTL/O	RECEIVE CLOCK — A TTL clock output used to send indication channel symbols to the MC68824. Its frequency is nominally equal to the data rate (5.0 MHz or 10 MHz for IEEE 802.4). RXCLK is generated from a PLL that is locked to the local oscillator during loopback, station management, or the absence of received data. During frame reception the PLL is locked to the incoming received data. RXSYM and SMIND* are synchronized to negative edge of RXCLK.
EOTDIS*	TTL/I*	END-OF-TRANSMISSION DISABLE — When low, this TTL input disables the end-of-transmission receiver blanking required by the IEEE 802.4 Spec, Section 12.7.6.3. When high the blanking works in accordance with the spec requirements.
TXOUT, TXOUT*	ECL/O	TRANSMIT OUTPUTS — A differential output signal pair (MECL level referenced to V _{CC}) used to drive the transmitter circuitry. The silence or “off” state is both outputs one (high). The output data stream is phase-coherent FSK encoded.
TXDIS	OC	TRANSMIT DISABLE — An open collector output used to disable transmitter circuitry. This output is high when the transmitter is off (TXOUT and TXOUT* both high).
JAB	TTL/O	JABBER — A TTL output signal generated from the jabber-inhibit timer. When equal to one, JAB indicates the timer has timed-out and an error has occurred.
RESET	TTL/I*	RESET — A TTL input signal that when high asynchronously resets the CBM.
RXIN, RXIN*	I	RECEIVER INPUTS — A differential input signal pair for the receiver amplifier/limiter. These inputs may be used differentially or single ended.
FDBK, FDBK*		DC FEEDBACK BYPASS — These two points are provided to bypass dc feedback around the receiver amplifier.

*All TTL inputs include a 15 k Ω pullup resistor to V_{CC}.

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Signal Description (Cont.)

Symbol	Type	Name/Description
THRESHOLD	I	THRESHOLD ADJUST — The receiver threshold detect is trimmed with this pin.
GAIN	O	GAIN — This output can be used to monitor the receiver amplifier output signal. Used only for test purposes.
CARDET	O	CARRIER DETECT — This output can be used to filter the internal signal that is sampled to sense carrier detect.
RPW, CPW	I	PULSE-WIDTH RESISTOR/CAPACITOR — A resistor and capacitor set a one-shot pulse width used in the clock recovery circuitry.
SET-PW	O	PULSE WIDTH TEST POINT — Output test point used for adjusting clock recovery one-shot pulse width.
UP*, DOWN*	ECL/O	PLL PHASE DETECTOR OUTPUTS — UP* and DOWN* are the pump-up and pump-down outputs, respectively, of the PLL digital phase detector. They are MECL levels referenced to +5.0 volts and are used to drive inputs to an active filter or charge pump for the PLL.
VCX	I	VCM CONTROL — The control voltage applied to the PLL voltage controlled multivibrator.
VCM-C1, VCM-C2	I	VCM CAPACITOR — VCM capacitor inputs. VCM frequency is 4X RXCLK.
JAB-RC	I	JABBER-INHIBIT RC — A resistor-capacitor network connected to this pin sets the jabber-inhibit time constant.
XTAL,1 XTAL2	I	CLOCK CRYSTAL — Oscillator circuit inputs may be used with a crystal or an external clock source. Oscillator frequency is 4X data rate.
VCC-VCM		VCM POWER — 5.0 ± 5% volts for VCM.
VCC-TXOUT		TXOUT POWER — 5.0 ± 5% volts for TXOUT/TXOUT*.
VCC-OSC		OSCILLATOR POWER — 5.0 ± 5% volts for oscillator.
VCC-RCV		RECEIVER POWER — 5.0 ± 5% volts for receiver amplifier/limiter.
VCC		LOGIC POWER — 5.0 ± 5% volts for remaining logic.
VCC-TTL		TTL POWER — 5.0 ± 5% volts for TTL output buffers.
GND-TTL, GND-VCM, GND-LOGIC, GND-OSC, GND-RCV, GND-SUBS, GND		GROUND — Reference voltage for TTL buffers, VCM, internal logic, oscillator, receiver/limiter, substrate respectively. Two additional grounds are used to isolate signals.

SECTION 3 TRANSMITTER

3.1 OVERVIEW

The transmitter function includes the serial interface decoder, transmit modulator, transmit buffer, jabber inhibit, and clock generator. (Although the clock generator is not used exclusively by the transmit function, the generator will be discussed here.) The MC68194 receives request channel symbols on the TXSYM_X pins which are synchronized to TXCLK. As is described in the Serial Interface discussion, MAC transmit symbols are input serially (CBM in MAC mode), decoded, and used to modulate an output signal. The Serial Interface Decoder is used both for MAC mode to decode data transmit commands (symbols) and management mode to decode management commands. The decoded transmit commands or symbols are used by the Transmit Modulator to generate phase-coherent signaling as discussed in the CBM General Description. The transmit buffer receives the modulated signal and drives differential output signals.

The clock generator provides TXCLK and internal clocks of 2 times (2X) and 4 times (4X) TXCLK. The 4X clock is actually the oscillator frequency. These clocks are used to receive the TX symbols and generate the modulated signal.

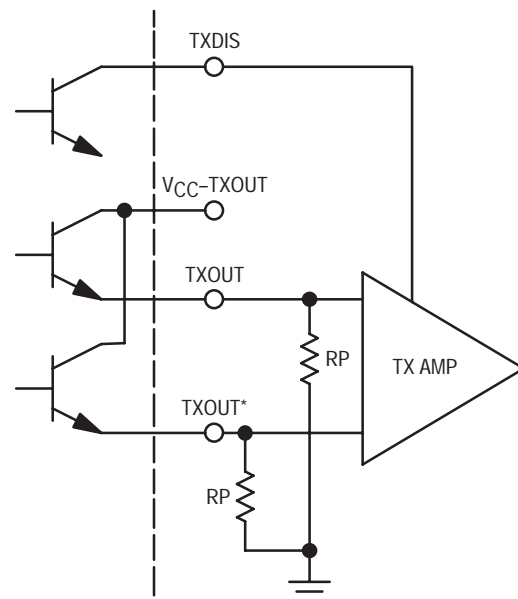


Figure 3-1. Transmitter Outputs

3.2 TRANSMIT BUFFER

The modulated transmit data stream drives the TXOUT and TXOUT* pins of the MC68194. These pins are complementary outputs with closely matched edge transitions. This is useful in helping meet the IEEE 802.4 carrierband requirement for a transmit jitter of less than $\pm 1\%$ of the data rate. TXOUT and TXOUT* are generally used to drive a differential amplifier which is used to achieve the necessary output level at the cable and meet the rise/fall time window (or “eye” pattern) of the IEEE 802.4. A third output called TXDIS is available to gate the amplifier circuitry on or off.

The TXOUT and TXOUT* have ECL levels referenced to V_{CC} (Figure 3-1). Levels are typically 4.11 V for a high and 3.25 for a low. Pulldown resistors are required with the outputs specified to drive a maximum load of 220 Ω to ground reference.

Operation of the transmit outputs is controlled in the following manner:

6. Management mode — The TX outputs are always disabled while the CBM is in management mode. When leaving management mode the TX outputs remain disabled if a RESET command has been issued and an ENABLE TRANSMITTER and DISABLE LOOPBACK commands have **not** been issued. Resetting the CBM enables internal loopback and disables the transmitter.
7. MAC (data) mode — After leaving management mode, the CBM can function in internal loopback (for test) with the transmitter disabled, out of loopback with transmitter disabled (receive only), or in standard data mode with the TX outputs controlled by the modulator.

8. Jabber inhibit activated — If the jabber inhibit fires, it forces the CBM into management mode and disables the TX outputs. This condition can only be cleared by a reset condition.

The TXDIS output is an open collector switched current source. TXDIS sinks a nominal 0.5 mA when the TXOUT/TXOUT* outputs are enabled. TXDIS is off or high impedance when the transmitter is disabled.

The signaling on the TX outputs and TXDIS is shown in Figure 3-2. The “off” or silence condition is both TXOUT outputs high and TXDIS also high. The figure shows an example of the signal pattern for both leaving and entering a silence condition.

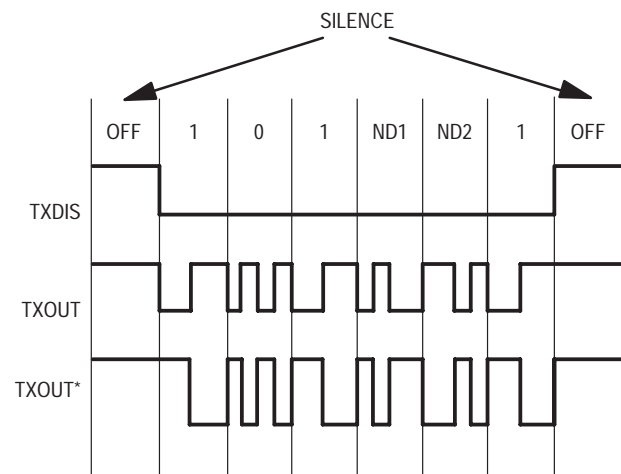


Figure 3-2. Transmitter Output Signaling

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3.3 JABBER INHIBIT

The jabber inhibit function prevents the transmitter from transmitting indefinitely. An external resistor and capacitor pair tied to the CBM JAB-RC pin set the maximum time that the transmitter is allowed to transmit. When transmission is attempted for a period longer than the specified time, the jabber inhibit function forces the transmitter to shut down and alerts the system that this has been done by generating a PHYSICAL ERROR indication on the serial interface indication channel. The error indication is removed only after a reset has occurred on the RESET pin or after a RESET command has been received on the station management interface. The ENABLE TRANSMITTER and DISABLE LOOPBACK commands can then be used to re-enable the transmitter outputs. While the PHYSICAL ERROR indication is present, the normally-low JAB pin of the MC68194 will be high. This TTL output may be used to turn off external transmitter circuitry or an isolation relay.

A block diagram of the jabber inhibit function is shown in Figure 3-3. When edges are present on the TXDATA line, the jabber capacitor is allowed to charge. When the transmitter stops transmitting, the capacitor is discharged. The circuit looks for any edges in the previous 16 TXCLKs before deciding whether to charge or discharge the capacitor. When the capacitor voltage reaches the reference threshold, the comparator switches and the jabber output is latched. The jabber output is fed back internally and disables the transmitter. This signal is also brought out to the JAB pin for use in disabling external transmitter circuitry.

For the IEEE 802.4 spec, the jabber timeout must be 0.5 sec \pm 25%. An RC time constant of 265 millsec. will give about a 0.5 sec timeout. The maximum resistor size is 125 k Ω . Components should be 10% tolerance or better. Common values are R = 120 k Ω and C = 2.2 μ F.

3.4 CLOCK GENERATOR

The clock generator is used to generate all of the transmit timing, TXCLK, and internal CBM timing for station management and loopback. The generator consists of a crystal oscillator/buffer that drives $\div 2$ and $\div 4$ stages. The

oscillator frequency must be four times (4X) the serial data rate. As an example, the IEEE 802.4 5 Mbps carrier band (TXCLK = 5.0 MHz) requires an oscillator frequency of 20 MHz. The basic circuit is a single transistor Colpitts oscillator as shown in Figure 3-4.

The oscillator is used in one of three modes depending on the data rate and the application:

1. With a parallel-resonant, fundamental mode crystal.
2. With a parallel-resonant, overtone mode crystal.
3. With an external clock source.

The fundamental mode can typically be used up to frequencies of about 20 MHz; this is crystal dependent and some crystal types can be used as high as 40 MHz. Beyond the fundamental mode upper limit, an overtone mode crystal is used. An alternative to a crystal is an external clock source such as an integrated crystal clock to drive the CBM.

3.4.1 Parallel-Resonant, Fundamental Mode Crystal

Figure 3-4 shows the external crystal and capacitors C1 and C2 used for fundamental mode operation. The crystal must be parallel resonant with a maximum series resistance of 30 Ω .

This configuration is normally used for the IEEE 802.4 5 Mbps carrierband standard. The required transmit frequency stability is \pm 100 ppm (0.01%). It is suggested that a crystal with a total frequency tolerance (calibration tolerance, temperature variation, plus aging) of \pm 50 ppm to \pm 60 ppm be used. The remaining frequency budget is reserved for the CBM and other components over temperature and power supply variation.

The series combination of C1 and C2 should be equal to the specified crystal load (typically 20 pF or 32 pF). Additionally, C1 and C2 should be large enough to swamp out the CBM device capacitance. The XTAL1 input capacitance is typically 1.5 pF to 2.0 pF, and C1 should be at least an order of magnitude greater (C1 > 20 pF). Also, C1 must be greater than the crystal load capacitance because of the series combination of C1 and C2. Generally the ratio C1:C2 is from 1:1 to 3:1.

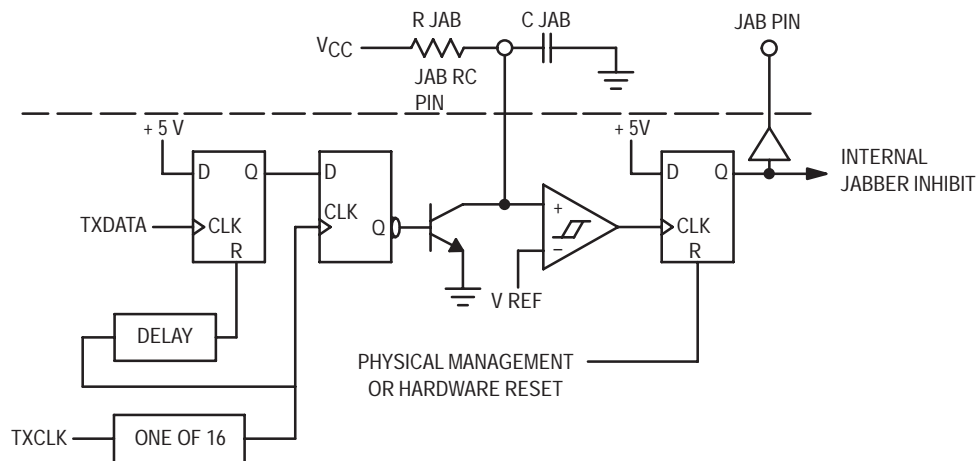


Figure 3-3. Jabber Inhibit Block Diagram

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For a 20 pF crystal load:

$$20 \text{ pF} = C1C2/(C1 + C2)$$

and

$$C2 = 20 \text{ pF} [C1/(C1 - 20 \text{ pF})]$$

Typical values are $C1 = 60 \text{ pF}$ and $C2 = 30 \text{ pF}$.

It is suggested that best results will be had with close tolerance (5%) NPO ceramic capacitors — trimming should not be required. If trimming is necessary, a third trimming capacitor $C3$ can be placed in series with the crystal. Capacitors $C1$ and $C2$ will have to be increased in value because the crystal load now becomes $C1$ and $C2$ and $C3$ in series. For help in designing the capacitor network the user is directed to *Design of Crystal and Other Harmonic Oscillators*, B. Parzen, Wiley, 1983.

3.4.2 Parallel-Resonant, Overtone Mode Crystal

Figure 3-4 also shows the network used for overtone mode operation. The crystal is still parallel resonant, but must be specified for overtone (harmonic) operation at the desired frequency. A low series resistance of less than 30Ω is recommended.

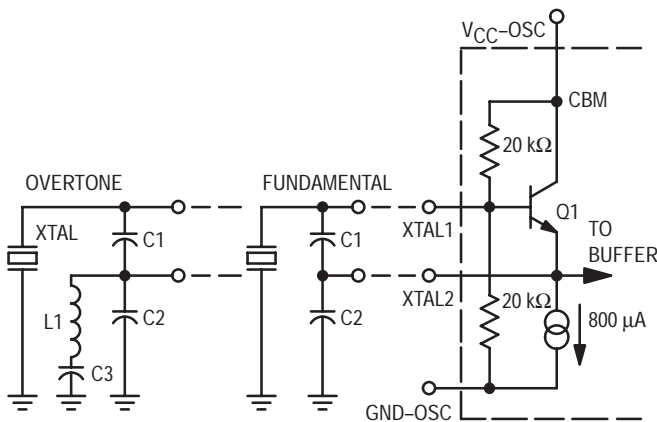


Figure 3-4. Crystal Oscillator Schematic Shows Configurations For Both Overtone and Fundamental Modes

Inductor $L1$ and capacitor $C2$ form a tank circuit that is parallel resonant at a frequency **lower** than the desired crystal harmonic but above the next lower odd harmonic. $C3 = 0.01 \mu\text{F}$ is a dc blocking capacitor to ground. At the operating

frequency the tank circuit impedance will appear capacitive; therefore, the load to the crystal is $C1$ in series with the capacitive reactance of the tank circuit.

This series combination should be equal to the desired crystal load. Typically, $C2$ will increase in value as compared to the fundamental mode situation because of the cancelling effects of $L1$. Again the user is directed to the above reference for optimum selection of components.

3.4.3 External Clock Source

Figure 3-5 shows the connection used for a TTL compatible external clock source. $XTAL1$ and $XTAL2$ are tied together defeating transistor $Q1$. External resistor $R1 = 2.0 \text{ k}\Omega$ assures a high level greater than 3.0 V at an input current of $800 \mu\text{A}$. The TTL driver must be capable of sinking 2.5 mA .

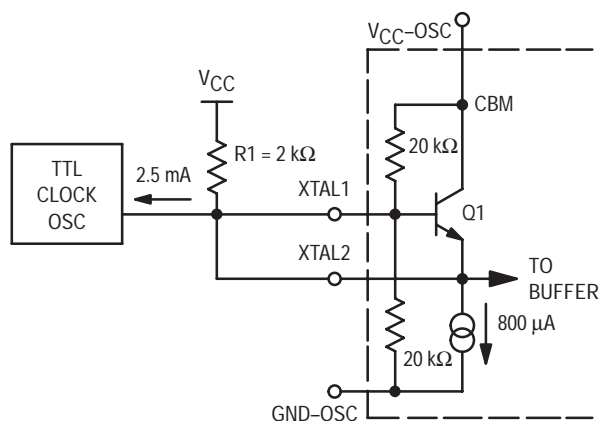


Figure 3-5. TTL Compatible Clock Source Driving CBM

The IEEE 802.4 for 5 Mbps or 10 Mbps data rate carrier band requires a transmit frequency stability of $\pm 100 \text{ ppm}$ (0.01%). The external clock source must be specified for this stability over temperature.

SECTION 4 RECEIVER AMPLIFIER/LIMITER WITH CARRIER DETECT

4.1 OVERVIEW

The IEEE 802.4 spec provides that the incoming signal range for good signal is +10 dB (1.0 mV, 75 Ω) [dBmV] to +66 dB (1.0 mV, 75 Ω) [dBmV] available at the modem connector. The IEEE 802.4 further specifies that the modem will report silence for any signal below +4.0 dB (1.0 mV, 75 Ω) [dBmV]. Therefore, the receiver function must amplify any signal of +10 dBmV and above to limiting for good data recovery, and the signal detect must switch within the +4.0 dBmV to +10 dBmV window, that is, it must be “off” for +4.0 dBmV and below, and be “on” for +10 dBmV and above. The MC68194 requires a pre-amplifier of about 12 dB in front of the onboard amplifier and carrier detect function. Clock and data recovery are extracted from the amplified/limited incoming signal, and the carrier detect is used to control the clock and data recovery function based on presence of good signal.

4.2 AMPLIFIER

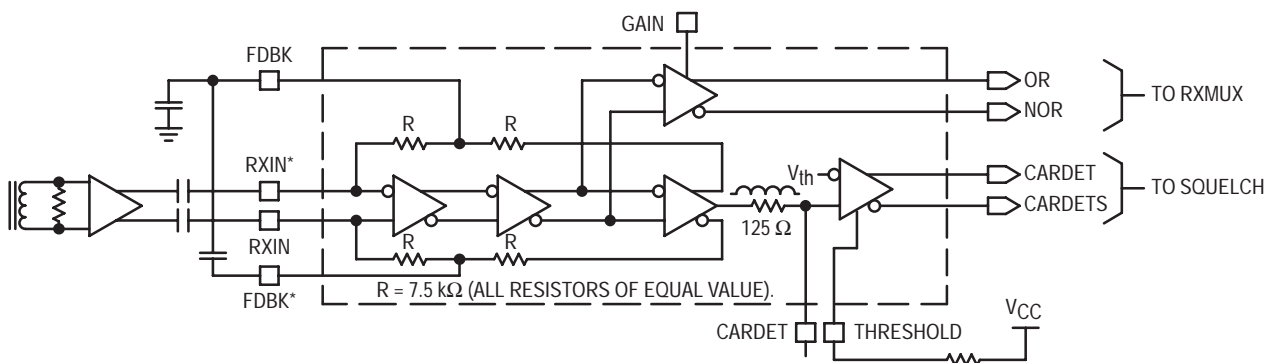
Figure 4-1 shows a simple block diagram of the receiver amplifier. Internally, dc feedback is used to bias the amplifier, and connection points FDBK and FDBK* are provided to ac bypass the feedback. With both receiver inputs RXIN and RXIN* available, the device can be wired either for differential or single-ended operation. Differential is preferred for low noise.

An external preamplifier with gain of about 12 dB is used with the onboard amplifier. The pre-amp can drive the CBM either single-ended or differentially. The onboard amplifier output signal is used in two ways. One path adds an additional limiter stage and is used to drive the clock and data recovery stages. The second path is used to develop carrier detect.

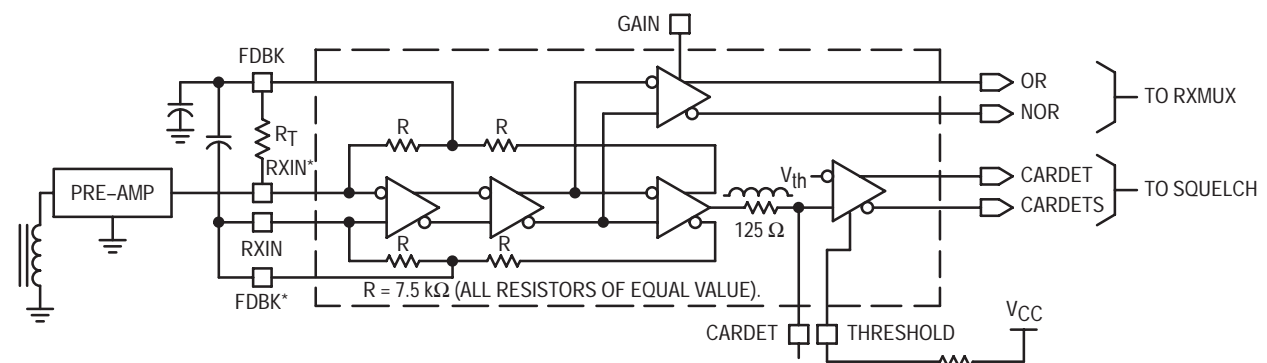
In the signal window where carrier detect must be active, the internal amplifier remains in the linear (non-limiting) range. Its output is fullwave rectified, and the rectified signal is compared to an onboard threshold that is temperature and voltage compensated. The rectified signal is also brought out to an external lead called CARDET. A capacitor can be added at this pin which combines with the series 125 Ω resistor to form a low pass filter. This filtering is used to knock any high frequency noise off of the signal. The output of the comparator is a series of pulses (when the signal amplitude is sufficiently large) which are digitally integrated in the internal squelch signal.

4.3 CARRIER DETECTION THRESHOLD

The carrier detect threshold is internally generated and compensated for power supply and temperature variation. The THRESHOLD pin is provided to adjust the threshold via an external resistor tied to V_{CC}.



(A) Receiver Used in Differential Mode



(B) Receiver Used in Single-Ended Mode

Figure 4-1. Receiver Amplifier With Carrier Detect

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SECTION 5 CLOCK RECOVERY

5.1 OVERVIEW

The clock recovery circuitry is a key part of the receive function providing RX clock, a 2 times (2X) RX clock, and a 4 times (4X) RX clock for data recovery and to send receive symbols to the MAC. Figure 5-1 is a simplified functional schematic of the clock recovery logic. The clock recovery is fed by the output stage of the receive amplifier. The phase-coherent signal contains frequency components equal to 1X and 2X the serial data rate. Figure 5-2 shows an example of timing for a 5 Mb/s serial data rate. The RXOUT signal drives a one-shot with a time period of 75% of 1/2 bit time; this locks out edges caused by the higher frequency component. The one-shot is non-retriggerable and is triggered on both positive and negative going edges. This produces a pulse for every edge of the lower frequency.

The output of the one-shot is divided by 2 to produce a 50% duty cycle signal equal in frequency to the lower frequency of the phase-coherent signal. In turn, the $\div 2$ flip-flop output runs through a multiplexer to a phase-locked loop (PLL) system. The multiplexer selects the RXOUT signal when carrier detect is present; otherwise the local oscillator divided by 4 is selected.

The PLL system consists of a digital phase detector, an active loop filter, a voltage-controlled multivibrator (VCM), and a divide-by-4 feedback counter. When in phase lock, the output of the divide-by-4 feedback counter is locked to the reference clock. In turn, the VCM 4 times clock is also aligned with the reference clock as shown in Figure 5-2.

The 4 times clock from the VCM, the 2 times clock, and the 1 times clock are all in phase (when the PLL is phase-locked) with the reference clock, and are used to do data recovery. Note that the reference clock can be 180° out of phase with the bit time boundaries (Figure 5-2). This does not affect the 2X and 4X clocks which are used to sample the data. However, RXCLK can be out of sync with the bit time boundaries and special circuitry in the data recovery logic detects and corrects this condition.

When no valid input signal is available from the receive amplifier (carrier detect is not asserted), the multiplexer selects the local clock as a reference. This has the advantages of:

1. Supply a RXCLK when no data is present.
2. Holding the PLL in frequency lock so that only phase-lock must be achieved when switching to the RX signal.
3. Providing a smooth transition for RXCLK when moving from the local oscillator (at the beginning of a frame) and vice versa (at the end of a frame). The PLL acts as an integrator.

The IEEE 802.4 provides a PAD-IDLE or training signal at the beginning of any transmission. The PAD-IDLE for phase-coherent FSK is an alternating one and zero pattern, and the PLL is capable of being locked-in well within the 24 bit times (3 octets). The design goal is to be locked-in within 12-16 bit times. Data recovered during this lockup time at the

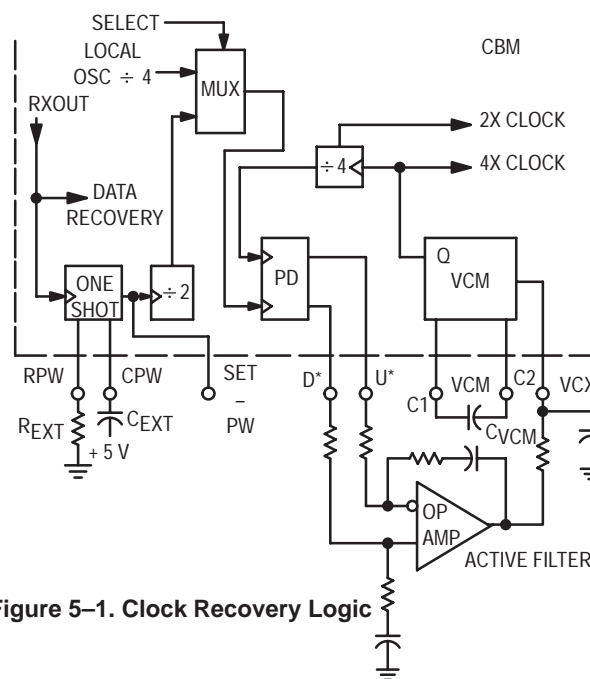


Figure 5-1. Clock Recovery Logic

beginning of a transmission can be invalid because the PLL clocks are not sync'd. As a result the data recovery logic forces silence for 17-18 bit times after the carrier detect switches the reference clock (via the multiplexer) at the beginning of a received transmission.

5.2 ONE-SHOT

As previously stated, the one-shot is used to lock out the transitions due to the higher frequency component of the phase-coherent signal. The one-shot is non-retriggerable and fires off both edges of the incoming RXOUT signal. The time period should be set to 75% of half the bit time. As an example, the 5 Mb/s data rate has a 200 nsec bit time and the one-shot period then has a period of 75 nsec.

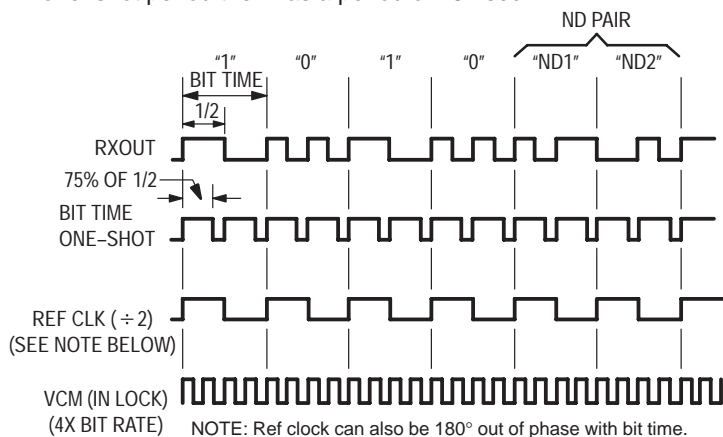


Figure 5-2. Clock Recovery Timing Signals

Figure 5-3 shows the arrangement of the external timing capacitor and resistor. The internal resistor R_{INT} may be used with or without an external resistor. A test pin is also provided (SET-PW) to monitor the pulse width.

For 5 Mbps operation, typically $R_{PW} = 1.5 \text{ k}\Omega$ and $C_{PW} = 33 \text{ pF}$.

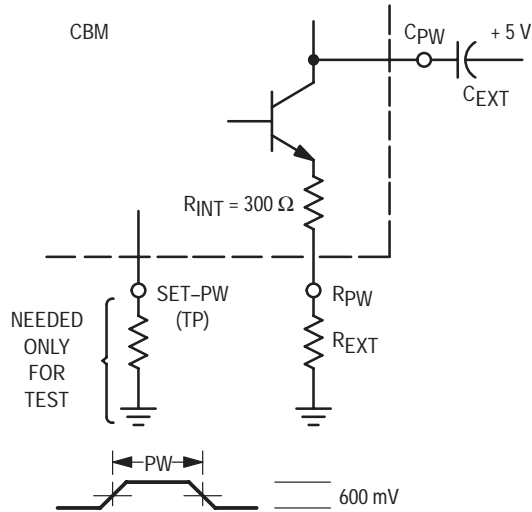


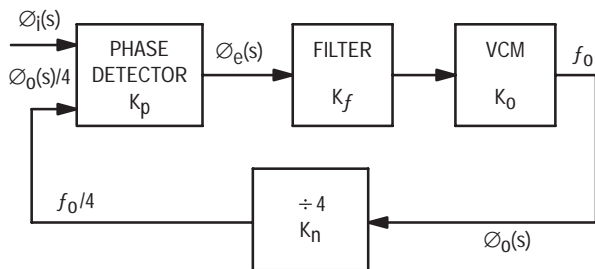
Figure 5-3. One-Shot Timing Components

5.3 PHASE-LOCKED LOOP (PLL) COMPONENTS

The PLL consists of a digital phase detector (PD), an active loop filter, a VCM, and a divide-by-4 feedback path. Figure 5-4 shows the fundamental elements of the PLL with their gain constants. The basic PLL allows the output frequency f_o to be “locked-on” to the input frequency f_i with a fixed phase relationship and to track it in frequency. When “in lock” the inputs to the phase detector have zero phase error. The input frequency is referenced to $f_o/4$.

A PLL follows classic servo theory and equations. In the following discussion a working knowledge of a PLL is assumed. For more background and applications information on PLL, the user is directed to Motorola Application Note AN535.

5



$$\phi_e(s) = (1 / [1 + G(s) H(s)]) \phi_i(s)$$

$$\phi_o(s) = (G(s) / [G(s) H(s)]) \phi_i(s)$$

where:

$$G(s) = K_p K_f K_o \quad H(s) = K_n \quad K_n = 1 / N = 1/4$$

Reference: Motorola App Note AN535

Figure 5-4. PLL Elements and Loop Equations

5.3.1 Phase Detector (PD)

The phase detector produces a voltage proportional to the phase difference between $\phi_i(s)$ and $\phi_o(s)/4$. This voltage after filtering is used as the control signal for the VCM. The PD has pump-up UP^* and pump-down $DOWN^*$ outputs with a typical 800 mV logic swing. UP^* produces a low level pulse equal in width to the amount of time the positive edge of ϕ_i (REF CLOCK) leads the positive edge of $\phi_o/4$ ($V_{CM}/4$). $DOWN^*$ produces a low level pulse equal in width to the amount of time the positive edge of ϕ_i lags $\phi_o/4$. Both pulses will not occur on the same clock cycle as $\phi_o/4$ must either lead or lag ϕ_i when the PLL is out of lock. When in-lock, both outputs produce a very narrow pulse or negative spike.

The gain of the phase detector is equal to (reference Motorola app note AN532A):

$$K_p = (\text{Logic swing})/2\pi = 800 \text{ mV}/2\pi = 0.127 \text{ V/radian}$$

5.3.2 Voltage Controlled Multivibrator (VCM)

The operating frequency range of the VCM is determined by the capacitor tied to pins $V_{CM}-C1$ and $V_{CM}-C2$. The capacitor should be selected to put the desired operating frequency in the center of the VCM tuning range.

The transfer function of the VCM is given by:

$$K_o = K_v/s$$

where K_v is the sensitivity in radians per second per volt. K_v is found by:

$$K_v = \frac{[(\text{Upper frequency limit}) - (\text{Lower frequency limit})]2\pi}{(\text{Control voltage tuning range})}$$

$$= 2\pi (\Delta f)/\Delta V_{CX} \text{ rad/s/V}$$

then

$$K_o = 2\pi (\Delta f)/(\Delta V_{CX})s \text{ rad/s/V}$$

5.3.3 Loop Filter

Since a Type 2 system is required (phase coherent output, see reference AN535), the loop transfer function of Figure 5-4 takes the form:

$$G(s) H(s) = [K (s+a)] / s^2$$

Writing the loop transfer function (from Figure 5-4) and relating it to the above form:

$$G(s) H(s) = [K_p K_v K_n K_f] / s = [K (s+a)] / s^2$$

Having determined K_p , K_o , and that $K_n = 1/4$ then K_f (filter transfer function) must take the form:

$$K_f = (s+a) / s$$

An active filter of the form shown in Figure 5-5A gives the desired results, where:

$$K_f = (R2 C s + 1) / R1 C s \text{ (for large A)}$$

The active filter can also be implemented as shown in Figure 5-5B using an alternate approach of a charge pump. The advantage of the charge pump design is that it can be implemented using only a single 5.0 volt supply. Its transfer function is:

$$K_f = (RC s + 1) / C s$$

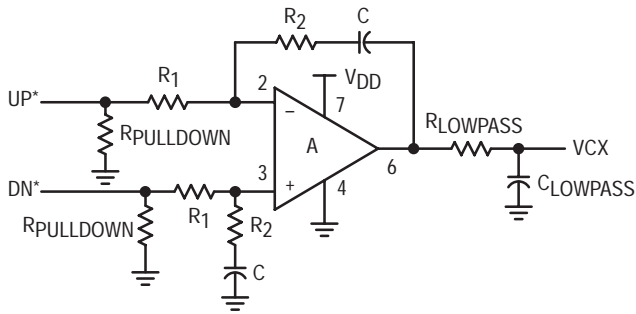


Figure 5-5A. Active Filter Using Op Amp

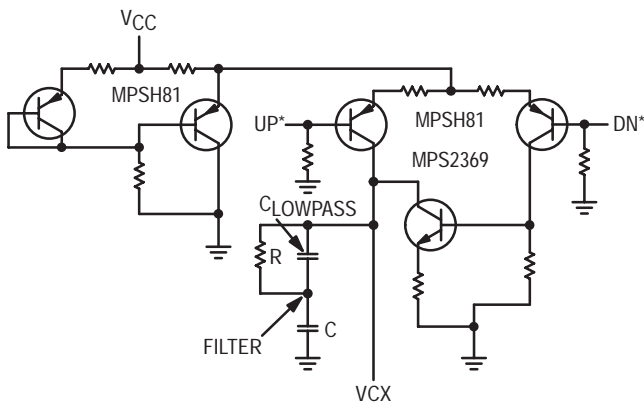


Figure 5-5B. Charge Pump/Filter

5.3.4 Loop Characteristics

If an active filter as shown with an op amp is used, the general PLL loop transfer function now becomes:

$$G(s) H(s) = K_p K_f K_o K_n = K_p [(R_2 C s + 1) / R_1 C s] (K_v / s) (1 / N)$$

Its characteristic equation is set to the form:

$$C.E. = 1 + G(s) H(s) = 0 = s^2 + (K_p K_v R_2) s / (R_1 N) + K_p K_v / (R_1 C N)$$

Relating to the standard form ($s^2 + 2\xi\omega_n s + \omega_n^2$) and solving:

$$\omega_n^2 = (K_p K_v) / R_1 C N \quad 2\xi\omega_n = (K_p K_v R_2) / R_1 N$$

where

ω_n = Natural frequency

ξ = damping factor.

If a change pump loop filter is used, the general PLL loop transfer function alternately becomes:

$$G(s) H(s) = K_p K_f K_o K_n = K_p [(R C s + 1) / C s] (K_v / s) (1 / N)$$

Its characteristics equation is set to the form:

$$C.E. = 1 + (G_s) (H_s) = 0 = s^2 + (K_p K_v R) s / (N) + (K_p K_v) / (C N)$$

Relating to the standard form ($s^2 + 2\xi\omega_n s + \omega_n^2$) and solving:

$$\omega_n^2 = (K_p K_v) / C N \quad 2\xi\omega_n = (K_p K_v R) / N$$

SECTION 6
DATA RECOVERY

6.1 OVERVIEW

The RXOUT signal from the receive amplifier and clocks generated by the clock recovery logic are used by the data recovery logic. The MC68194 recovers the data from the encoded receive signal by opening sampling windows around the 1/4 and 3/4 bit time positions and looking for edges in the received signal (refer to Figure 6-1 for the encoded data representations). A data ONE has transitions only at the 0 and 1/2 bit time positions. A data ZERO has transitions at the 0, 1/4, and 3/4 bit time positions. A NON-DATA symbol has

1/4, 1/2, and 3/4 bit time positions. A NON-DATA symbol has

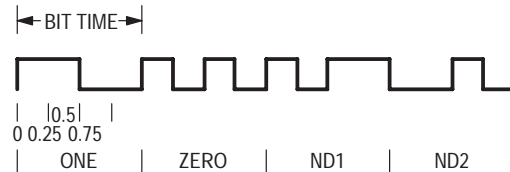


Figure 6-1. Encoded Data Representation

transitions at the 0, 1/4, and 1/2 bit time positions (ND1) or at the 0, 1/2, and 3/4 bit time positions (ND2). NON-DATA symbols should always occur in pairs; each pair is made up of one of each type of NON-DATA encoded symbols as shown in Figure 6-2 (ND1 followed by ND2).

ONEs, ZEROs, and NON-DATA pairs can be easily decoded by keeping track of the 1/4 and 3/4 bit time position transitions. The ONEs, ZEROs, and NON-DATA pairs are then reported on the RXSYMx pins as described in the serial interface discussion. Two other conditions can also be reported while receiving in MAC mode — BAD SIGNAL and SILENCE. BAD SIGNAL is reported when a ND1 symbol is not followed immediately by a ND2 symbol or when a ND2 symbol is received and not immediately preceded by a ND1 symbol.

SILENCE is reported when one of four conditions occurs:

1. When the amplitude of the received signal is not large enough to trigger the on-chip carrier detect circuit. Reporting SILENCE when the carrier detect signal is not asserted prevents the chip from responding to low level noise.
2. When in internal loopback mode and SILENCE is being requested on the TXSYMx pins, SILENCE will be reported on the RXSYMx pins. An internal digital carrier detect is used during loopback and this signal is negated when SILENCE is requested on the request channel.
3. During the PLL training period at the beginning of a transmission. When an incoming signal first triggers the carrier detect in the amplifier, the PLL must lock to the new reference clock (generated from the data stream). During the lockup time, recovered data may not be valid. The data recovery logic forces SILENCE for a fixed period of time (17–18 bit times).
4. During end-of-transmission blanking. See Section 6.2.

The PAD-IDLE at the beginning of a transmission is used as a training signal as described in the clock recovery section. After the PLL has achieved lock, the recovered clock at this point may be in phase or 180° out of phase with the bit time clock at the sending end. This creates a problem for RXCLK and the data recovery logic because symbols would be decoded as the wrong combination of 1/2 bit time transitions.

Logic in the data recovery circuitry corrects for this situation. If the clock is 180° out of phase, the PAD-IDLE sequence (ONE, ZERO, ONE, ZERO, ONE, ...) will be decoded as a sequence of NON-DATA symbols. Refer to Figure 6-2. In normal data reception, NON-DATA symbols occur only in pairs; there are never three or more in a row. Therefore, three or more NON-DATA symbols occurring in a row indicate that the bit time clock is 180° out of phase and the bit time clock

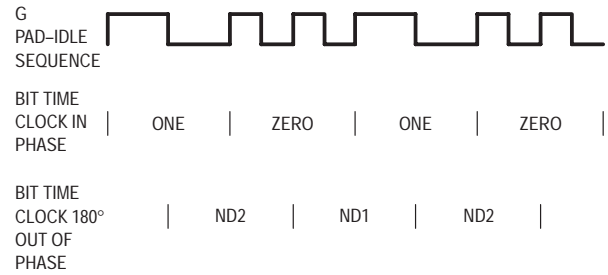


Figure 6.2 Training Sequence Decoded With In-Phase and Out-Of Phase Clocks

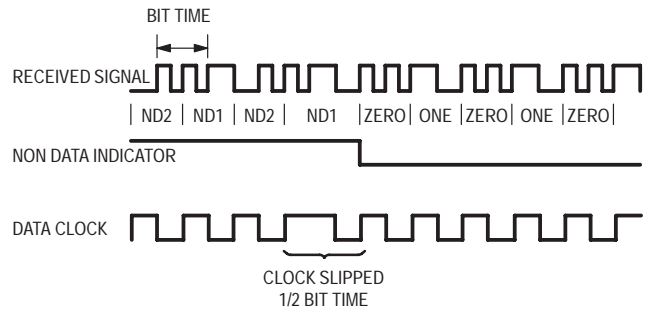


Figure 6-3. Clock Slip To Bring In Phase With Data Stream

(RXCLK) must be slipped as shown in Figure 6-3. The clock frequency and phase have now been recovered and symbol decode proceeds as described above.

6.2 RECEIVER END-OF-TRANSMISSION BLANKING

The IEEE 802.4 requires that the physical layer recognize the end of a transmission and report silence to the MAC for a period thereafter. This period of silence is referred to as blanking and must meet the following conditions:

1. Blanking must begin no later than 4 MAC-symbol times after the last MAC-symbol of the End Delimiter (i.e., the last End Delimiter of the transmission).
2. Blanking must continue to a point at least 24 MAC-symbol times but not more than 32 MAC-symbol times from the last MAC-symbol of the End Delimiter.

The MC68194 provides this function by recognizing the last End Delimiter of a transmission (I Bit = 0, see Section 1.3). The CBM reports silence for 32 symbols after the last symbol of the End Delimiter.

The blanking function can be disabled for test purposes or non-IEEE 802.4 applications via the EOTDIS* input.

5

SECTION 7 SERIAL INTERFACE

7.1 OVERVIEW

The serial interface is composed of the Physical Data Request Channel and the Physical Data Indication Channel. The serial interface is used to pass commands and data frames to and from the CBM.

7.2 PHYSICAL DATA REQUEST CHANNEL

Five signals comprise the physical data request channel. Three of these signals (TXSYM2, TXSYM1 and TXSYM0) are multiplexed and have different meanings depending on the mode of SMREQ*. When SMREQ* is equal to one, the MAC mode is selected. When SMREQ* is equal to zero, the physical layer management mode is selected.

7.2.1 TXCLK — Transmit Clock

The transmit clock can be from 1.0 to 10 MHz. TXSYM2, TXSYM1, TXSYM0 and SMREQ* are synchronized to TXCLK. The IEEE 802.4 standard for carrier band allows for 5.0 or 10 MHz clocks.

7.2.2 SMREQ* — Station Management Request

SMREQ* directs the physical layer to be in MAC or physical layer management mode. In MAC mode SMREQ* = 1 and in management mode SMREQ* = 0.

7.2.3 TXSYM0, TXSYM1, and TXSYM2 — Transmit Symbols

In physical layer management mode TXSYM2, TXSYM1 and TXSYM0 have the meanings shown in Figure 7–1.

State	TXSYM2	TXSYM1	TXSYM0
RESET	1	1	1
DISABLE LOOPBACK	1	0	1
ENABLE TRANSMITTER	0	1	1
SERIAL SM DATA/IDLE	0	0	0/1

Figure 7–1. Request Channel Encoding for Physical Management Mode (SMREQ* = 0)

The CBM supports only four station management commands (RESET, LOOPBACK DISABLE, ENABLE TRANSMITTER and IDLE) encoded on lines TXSYM2, TXSYM1 and TXSYM0. The CBM does not support the SMDATA commands, but responds with a “NACK”. In MAC mode, the encoding for TXSYM2, TXSYM1, and TXSYM0 are shown in Figure 7–2.

Symbol	TXSYM2	TXSYM1	TXSYM0
ZERO	0	0	0
ONE	0	0	1
NON-DATA	1	0	X
PAD-IDLE	0	1	X
SILENCE	1	1	X

Where:

- ZERO is binary zero.
- ONE is binary one.
- NON-DATA is a delimiter flag and is always present in pairs.
- PAD-IDLE is one symbol of preamble/interframe idle.
- SILENCE is silence or no signal.

Figure 7–2. Request Channel Encoding For MAC Mode (SMREQ* = 1)

7.3 PHYSICAL DATA INDICATION CHANNEL

Five signals comprise the physical data indication channel. Three of these signals (RXSYM2, RXSYM1 and RXSYM0) are multiplexed and have different meanings depending on the state of SMIND*. When SMIND* is equal to one, the physical layer is in MAC mode and when SMIND* is equal to zero, the physical layer is in management mode or an error has occurred.

7.3.1 RCCLK — Receive Clock

The receive clock can be from 1.0 to 10 MHz. RXSYM2, RXSYM1, RXSYM0, and SMIND* are synchronized to RXCLK. The IEEE 802.4 standard for carrier band networks allows 5.0 or 10 MHz clocks.

7.3.2 SMIND* — Station Management Indication

SMIND* indicates whether the physical layer is in MAC mode (SMIND* = 1) or management mode (SMIND* = 0) of operation. When in MAC mode of operation, the physical layer has RXSYM2, RXSYM1, and RXSYM0 encoded indicating data reception. When in management mode of operation, the physical layer RXSYM2, RXSYM1 and RXSYM0 are encoded to confirm response to received commands or to indicate a physical error (jabber inhibit).

7.3.3 RXSYM0, RXSYM1 and RXSYM2 — Receive Symbols

The encoding for RXSYM2, RXSYM1, and RXSYM0 in physical management mode is shown in Figure 7–3:

State	RXSYM2	RXSYM1	RXSYM0
NACK (non-acknowledgement)	1	0	*
ACK (acknowledgement)	0	1	*
IDLE	0	0	1
Physical Layer Error	1	1	1

*Indicates RXSYM0 contains the SM RX data when responding to a serial data command.

Figure 7–3. Indication Channel Encoding For Physical Management Mode (SMIND* = 0)

The encoding of RXSYM2, RXSYM1, and RXSYM0 in MAC mode is shown in Figure 7–4.

Symbol	RXSYM2	RXSYM1	RXSYM0
ZERO	0	0	0
ONE	0	0	1
NON-DATA	1	0	X
SILENCE	1	1	X
BAD SIGNAL	0	1	X

Where:

- ZERO is the received data zero.
- ONE is the received data one.
- NON-DATA is a delimiter flag and is always present in pairs.
- SILENCE is silence or no signal.
- BAD SIGNAL is received bad signal.
- X = Don't care.

Figure 7–4. Indication Channel Encoding For MAC Mode (SMIND* = 1)

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SECTION 8 PHYSICAL MANAGEMENT

8.1 OVERVIEW

The MC68194 supports four physical management commands on the request channel: RESET, DISABLE LOOPBACK, ENABLE TRANSMITTER, and IDLE. The serial data station management commands are not implemented in the MC68194. These unimplemented commands are typically used to set up and read registers or control bits within a more complex modem. The CBM does not have registers and does not require the SMDATA commands. Upon reception of a SMDATA command, the CBM will respond with a NONACKNOWLEDGEMENT (NACK) and a response byte in accordance with the IEEE DTE–DCE Interface Standard. The data in the response byte is all ZEROs. Receipt of a RESET, DISABLE LOOPBACK, or ENABLE TRANSMITTER command will abort the SMDATA response.

8.2 RESET

The RESET command performs the same function as the RESET pin; the internal loopback mode is enabled, the transmitter outputs are disabled and TXDIS is enabled, and the jabber inhibit timeout is cleared. In addition the RESET command will generate an ACKNOWLEDGEMENT response (ACK) on the RXSYMx pins.

The RESET pin is an asynchronous function. When taken high it resets the CBM as described above leaving the CBM ready to respond to the physical data request channel.

NOTE: For the MC68194 to respond properly to commands after a hardware reset, the request channel must either be in MAC mode upon exiting the hardware reset or the request channel must go to MAC mode briefly before going to management mode. If the MC68194 is in management mode upon exiting the hardware reset, it remains reset and does not recognize the command because it is waiting for a MAC mode to management mode transition. This situation can be corrected by either exiting hardware reset with the request channel in MAC mode or putting the request channel in MAC mode briefly before issuing any management commands. See Section 8.6 for command response timing.

8.3 INTERNAL LOOPBACK

The internal loopback mode is provided for testing the CBM. In this mode a multiplexer selects the internal transmitter signal to drive the clock recovery and data recovery portions of the receive circuitry. This transmit signal is taken just prior to the output buffer stages of the transmitter circuit.

The loopback mode can only be selected via RESET (management command or external pin). Loopback mode is exited upon receipt of the management command DISABLE LOOPBACK. The CBM will respond with ACK to this command.

A normal sequence of events to test the CBM then would be:

1. Initialize the CBM via a RESET command or hardware reset.

2. Return to MAC mode and send test data. The CBM is full duplex.
3. In management mode, send DISABLE LOOPBACK command to exit loopback.

Following the test the modem can be setup for standard operation.

8.4 STANDARD OPERATION

Standard operation requires that the transmitter be enabled as well as disabling loopback. The transmitter is automatically disabled on RESET. Three things must happen after a RESET before transmissions can begin:

1. Loopback mode must be exited with the DISABLE LOOPBACK command. The MC68194 responds to this command with the ACK management response.
2. The transmitter must be activated with the ENABLE TRANSMITTER command. The MC68194 responds to this command with the ACK management response.
3. The MC68194 must exit the management mode and enter the MAC data mode.

The CBM is now ready to send and receive data, i.e., the CBM is in MAC or data mode, loopback is disabled, and the transmitter is enabled.

8.5 IDLE

The CBM provides the IDLE response when an IDLE management command is received. In addition, the IDLE response is returned for all invalid, as opposed to unimplemented (SMDATA) commands.

8.6 COMMAND RESPONSE TIMING

The MC68194's management command/response operation is:

1. ACK response to RESET, DISABLE LOOPBACK, and ENABLE TRANSMITTER within 2 clock periods. As shown in Figure 8–1, the precise response time depends on the relative phase of the TXCLK and the RXCLK signals. If they are in phase, the response will be available at the RXSYMx pins 1.5 clocks after the command is latched. If the clocks are 180° out of phase, the delay will be 2 clocks. The command should be held on the TXSYMx pins until the response is received on the RXSYMx pins.
2. The IDLE command and all invalid commands will produce the IDLE response with the same delay as described above.
3. The SMDATA command response timing is shown in Figure 8–2. The NACK response to the SMDATA command is available on the RXSYMx pins in 2.5 or 3 clock periods depending on the relative phases of the TXCLK and RXCLK signals. When NACK becomes valid, RXSYM0 is low creating a start bit for the response byte. NACK is held for 9 clock periods with RXSYM0 low (start bit plus 8 ZERO data bits). NACK is held for one additional clock with RXSYM0 high. This is the stop bit and mark the end of the SMDATA response byte. 12.5 or 13 clock periods after receiving

the SMDATA command the NACK response is removed.

In management mode, RXCLK is always locked to TXCLK. These clocks may be in phase or 180° out of phase as discussed above. This uncertainty exists because the clock recovery PLL can lock to either phase of the local clock. The response delays relative to TXCLK may therefore differ by 1/2 clock period. The MC68194 must leave management mode, enter MAC mode, and return to management mode for a phase change to occur. The relative phase of the two clocks will not change while in management mode.

Because the clock recovery PLL requires a training period when first entering management mode, the PLL must have sufficient time to lock to the new clock source (TXCLK) before being required to provide a response. To provide enough time

for the PLL to lock up, the MC68194 delays 16.5 to 17 clock periods before entering station management mode (SMIND* = 0) after the station management mode is selected (SMREQ* = 0). Refer to Figure 8-3 for the timing diagram. During this delay, the MAC mode SILENCE response will be present on the RXSYMx pins.

Users must be aware that when first requesting management mode there will be this added delay before the mode is entered and a response is available. If a management command is sent along with the station management mode request (SMREQ* = 0) and held on the TXSYMx pins until the CBM enters station management mode, the proper response will be available on the RXSYMx pins immediately except in the case of SMDATA commands. SMDATA commands must not be requested on the TXSYMx pins until after SMIND* indicates that station management mode has been entered.

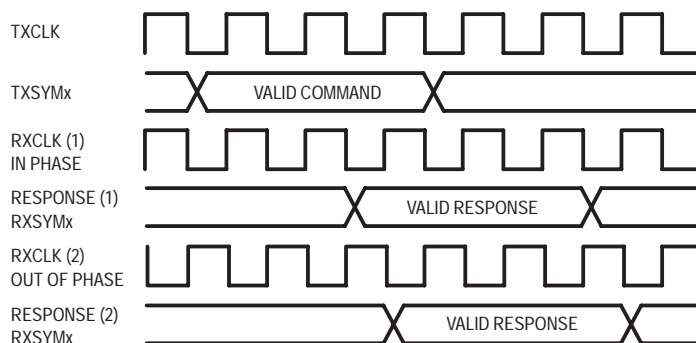


Figure 8-1. Parallel Command Response Time

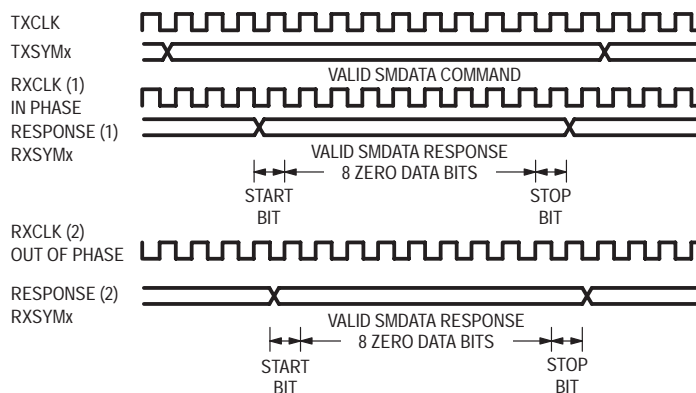


Figure 8-2. SMDATA Command Response Time

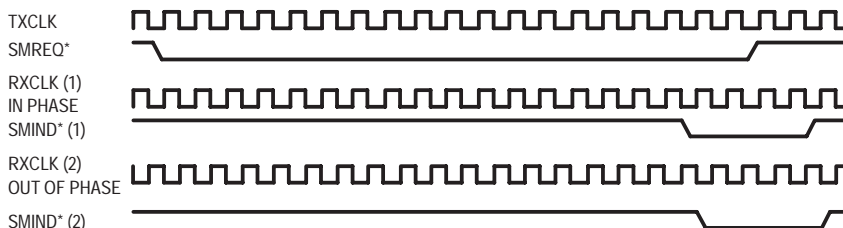


Figure 8-3. Station Management Request Response Time

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SECTION 9
MC68194 CARRIER BAND MODEM
ELECTRICAL SPECIFICATIONS

MAXIMUM RATINGS (Limits Beyond Which Device Life May Be Impaired)

Characteristic	Symbol	Value	Unit
Supply Voltage	V_{CC}	0 to +7.0	Vdc
TTL Input Voltage	V_{IN}	0 to +5.5	Vdc
TTL Output Voltage (Applied to output HIGH)	V_{OUT}	0 to +5.5	Vdc
ECL Output Source Current	I_{out}	50	mAdc
Storage Temperature Cerquad	T_{stg}	-55 to +165	°C
Junction Temperature Cerquad	T_J	165	°C

GUARANTEED OPERATING RANGES

Characteristic	Symbol	Value			Unit
		Min	Typ	Max	
Supply Voltage	V_{CC}	4.75	5.0	5.25	Vdc
Operating Temperature (Cerquad in still air)	T_A	0	25	70	°C

DC ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Limits			Unit	Test Conditions
		Min	Typ	Max		

TTL INPUTS (TXSYM0–TXSYM2, SMREQ*, RESET, EOTDIS)† $(T_A = 0-70^\circ\text{C}, V_{CC} = 5.0 \text{ Vdc} \pm 5\%)$

Input HIGH Voltage	V_{IH}	2.0			Vdc	
Input LOW Voltage	V_{IL}			0.8	Vdc	
Input HIGH Current	I_{IH}			20	μA	$V_{CC} = \text{MAX}, V_{IN} = 2.7 \text{ Vdc}$
Input LOW Current	I_{IL}			-0.7	mA	$V_{CC} = \text{MAX}, V_{IN} = 0.4 \text{ Vdc}$

†All TTL inputs include a 15 k-ohm pullup resistor to V_{CC} .**TTL OUTPUTS (TXCLK, RXSYM0–RXSYM2, SMIND*, RXCLK, JAB)** $(T_A = 0-70^\circ\text{C}, V_{CC} = 5.0 \text{ Vdc} \pm 5\%)$

Output HIGH Voltage	V_{OH}	2.7			Vdc	$V_{CC} = \text{MIN}, I_{OH} = \text{MAX}$
Output LOW Voltage	V_{OL}			0.5	Vdc	$V_{CC} = \text{MIN}, I_{OL} = \text{MAX}$
Output HIGH Current	I_{OH}			-0.4	mA	
Output LOW Current	I_{OL}			8.0	mA	

ECL OUTPUTS (TXOUT, TXOUT*) $(T_A = 25^\circ\text{C}, V_{CC} = 5.0 \text{ Vdc})$

Output HIGH Voltage	V_{OH}		4.10		Vdc	$R_{pulldown} = 220 \Omega$
Output LOW Voltage	V_{OL}		3.28		Vdc	$R_{pulldown} = 220 \Omega$

OPEN COLLECTOR OUTPUT (TXDIS) $(T_A = 25^\circ\text{C}, V_{CC} = 5.0 \text{ Vdc})$

Output LOW Current	I_{OL}	450		550	μA	$V_{OL} = 3.0 \text{ Vdc}$
Output HIGH Leakage Current	I_{OH}			50	μA	$V_{OH} = 5.0 \text{ Vdc}$

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DC ELECTRICAL CHARACTERISTICS — continued**OTHER PARAMETERS**(T_A = 25°C, V_{CC} = 5.0 Vdc)**POWER SUPPLY DRAIN CURRENT**

Characteristic	Symbol	Limits			Unit	Test Conditions
		Min	Typ	Max		
Power Supply Drain Current	I _{CC}		220	270	mA	No outputs loaded, TTL inputs open.

RECEIVER (SINGLE-ENDED OPERATION)

GAIN Output Voltage HIGH	G _{VOH}		4.2		Vdc	I _{OH} = 5.0 mA
GAIN Output Voltage LOW	G _{VOL}		3.6		Vdc	I _{OL} = 5.0 mA
Input Signal (for limiting)	R _{VIN}		+17		dBmV	GAIN output = 600 mV
Detected Threshold	V _{thres}		+18		dBmV	R _{THRES} = 120 kΩ to V _{CC}

PHASE DETECTOR OUTPUTS (UP*, DOWN*)

Phase Detector Output Voltage HIGH	PD _{VOH}		4.0		Vdc	I _{OH} = 10 mA
Phase Detector Output Voltage LOW	PD _{VOL}		3.3		Vdc	I _{OL} = 10 mA

VCM

VCM Oscillator	F _{osc1}		40		MHz	C _{vcm} = 24 pF, RXCLK = 5.0 MHz, VCX = 3.6 Vdc
Frequency	F _{osc2}		20		MHz	C _{vcm} = 68 pF, RXCLK = 10 MHz, VCX = 3.6 Vdc
VCM Tuning Ratio	TR		4.0			
VCX Tuning Range	V _{CX} V _{CX}	2.6		4.6	Vdc	

ONE-SHOT

SET-PW Output Voltage HIGH	PW _{VOH}		4.2		Vdc	I _{OH} = 5.0 mA
SET-PW Output Voltage LOW	PW _{VOL}		3.6		Vdc	I _{OL} = 5.0 mA
Timing Current	I _T		0.8	4.0	mA	
Internal Resistor	R _{int}		300		Ohms	
Timing Reference Voltage (measured at RPW pin)	V _{ref}	1.2	1.3	1.4	Vdc	I _T = 0.8 mA
External Timing Resistor	R _{EXT}		1.5		kΩ	For 5.0 Mb/s data rate.
External Timing Capacitor	C _{EXT}		33		pF	For 5.0 Mb/s data rate.

JABBER TIMER

RC Threshold High	JAB _{VIH}		4.25		Vdc	I _{IN} = 5.0 μA Max
RC Output V _{OL}	JAB _{VOL}		0.4		Vdc	I _{OL} = 10 mA
Jabber Resistor	R _{JAB}		120	125	kΩ	For 0.5 sec timing
Jabber Capacitor	C _{JAB}		2.2		μF	For 0.5 sec timing

CRYSTAL OSCILLATOR

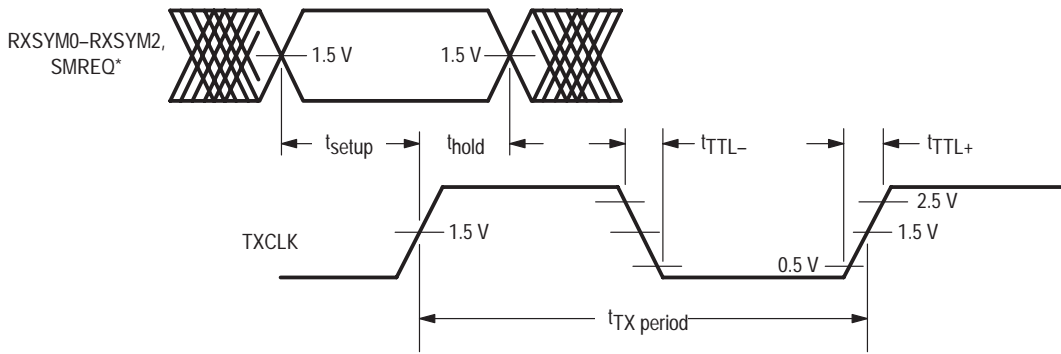
Input HIGH Voltage	V _{IH}	3.0			Vdc	XTAL1 & XTAL2 tied together
Input LOW Voltage	V _{IL}			2.0	Vdc	XTAL1 & XTAL2 tied together

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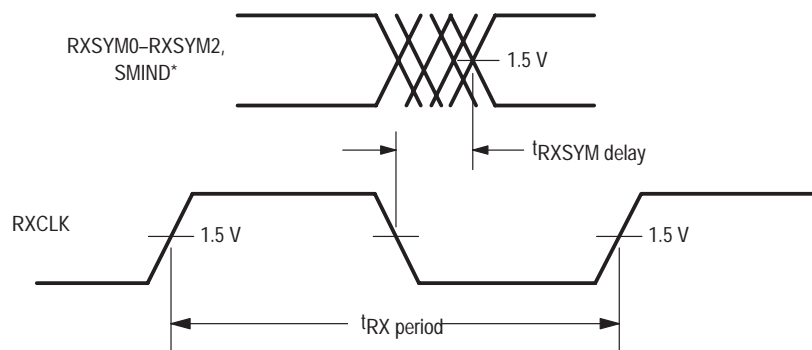
AC ELECTRICAL CHARACTERISTICS††(T_A = 0–70°C, V_{CC} = 5.0 Vdc ±5%)

Characteristic	Symbol	Limits			Unit	Test Conditions
		Min	Typ	Max		
TXCLK Period	t _{TXperiod}	180	200	220		@ 5.0 MHz, Figure 9–1A.
RXCLK Period	t _{RXperiod}	180	200	220		@ 5.0 MHz, PLL locked to TXCLK, Figure 9–1B.
TTL Rise/Fall Time	t _{TTL±}		4.0		ns	Figure 9–1A.
TXSYM _X , SMREQ* Setup Time (to TXCLK)	t _{setup}		15	25	ns	Figure 9–1A.
TXSYM _X , SMREQ* Hold Time (to TXCLK)	t _{hold}		–9.0	0	ns	Figure 9–1A.
RXSYM _X , SMIND* Delay Time (to RXCLK)	t _{RXSYM delay}	0	2.5	5.0	ns	Figure 9–1B.
XTAL1,2 to TXCLK Delay	t _{TXCLK delay}		18		ns	Figure 9–1C. XTAL1 and XTAL2 tied together and driven with external source.
TXOUT, TXOUT* Rise/Fall Time	t _{TXOUT±}		1.5		ns	R _{pulldown} = 500 Ω
UP*, DOWN* Rise/Fall Time	t _{PD±}		1.5		ns	R _{pulldown} = 500 Ω
TXDIS Rise/Fall Time	t _{TXDIS±}		35		ns	2.0 kΩ pullup to V _{CC} . Do not use Figure 9–2 test load.

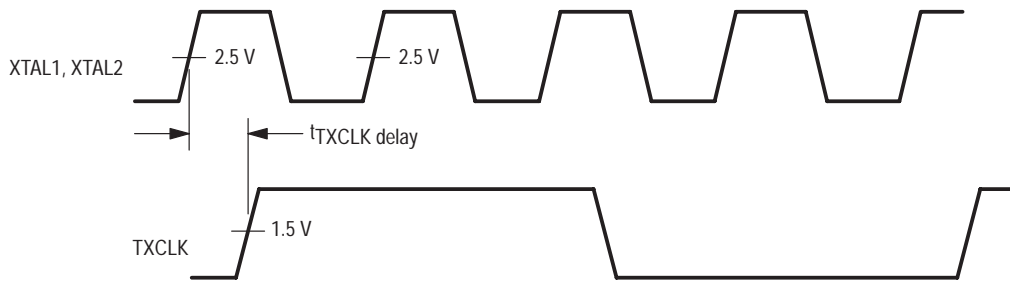
†† See Figure 9–2 for AC test load.



(A) TXSYM_X, SMREQ* Setup and Hold Timing to TXCLK



(B) RXSYM_X, SMIND* Delay Timing to RXCLK



(C) TXCLK Delay Timing to XTAL1, XTAL2

Figure 9-1. AC Test Waveforms

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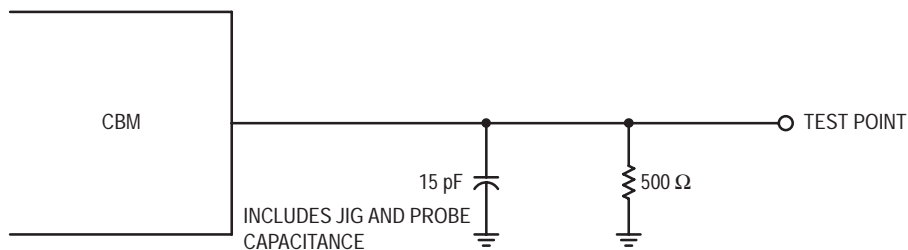


Figure 9-2. TTL, TXOUT, TXOUT*, Up* & Down* AC Test Load

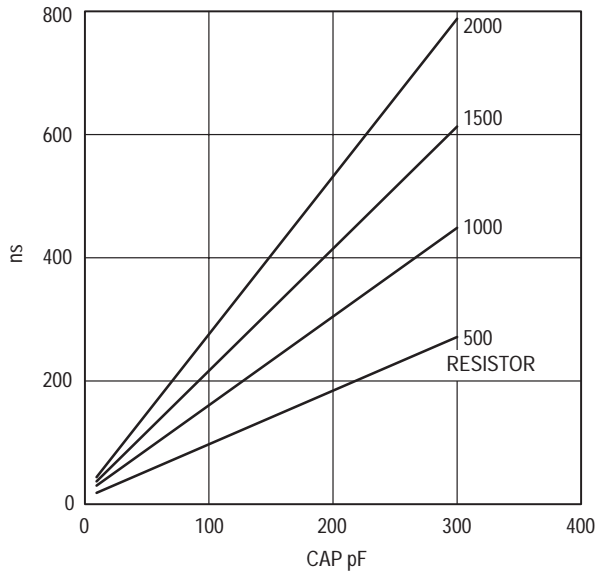


Figure 9-3. One Shot Pulse Width versus Rext/Cext

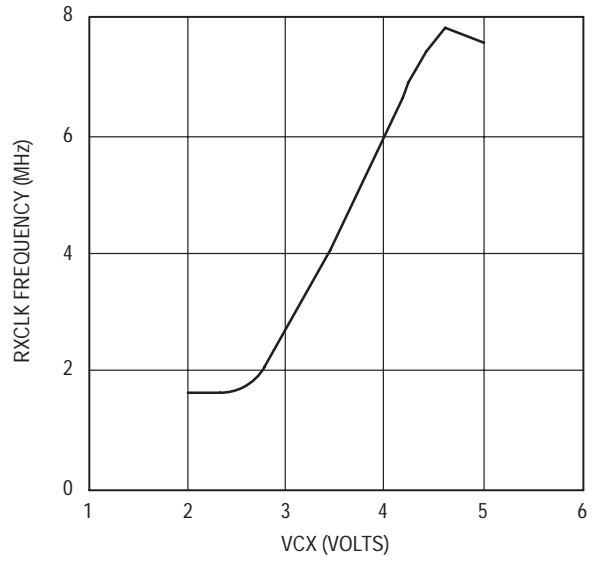


Figure 9-4. VCM Frequency versus Control Voltage (VCC = 5.0 Vdc & C = 68 pF)

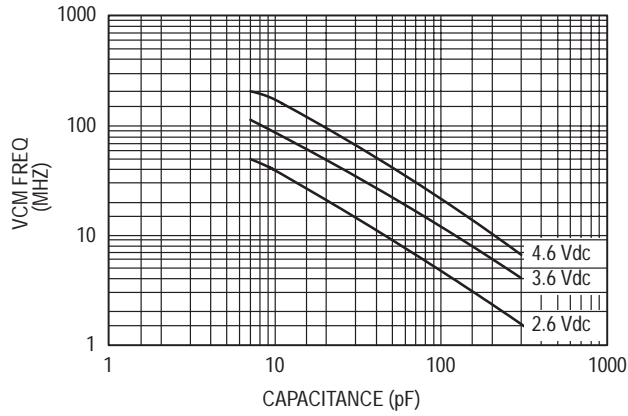


Figure 9-5. VCM Frequency versus Capacitance

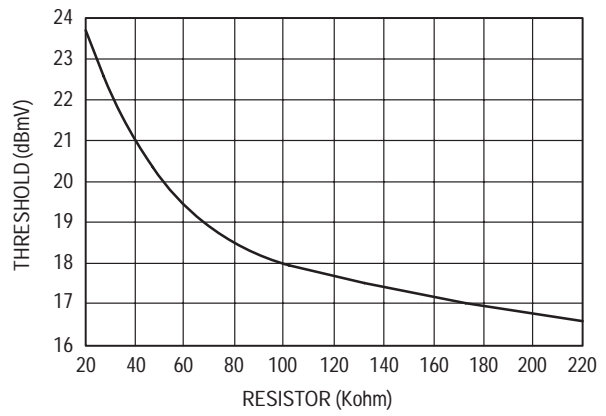


Figure 9-6. Detected Threshold versus Threshold Resistor

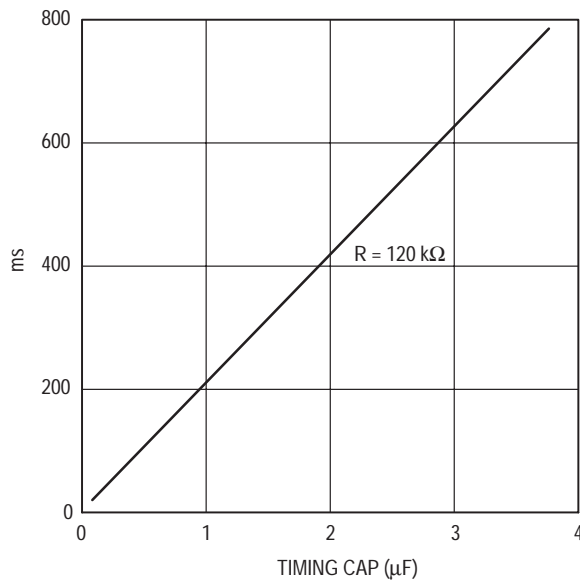


Figure 9-7. Jabber Time Constant versus Capacitance

5

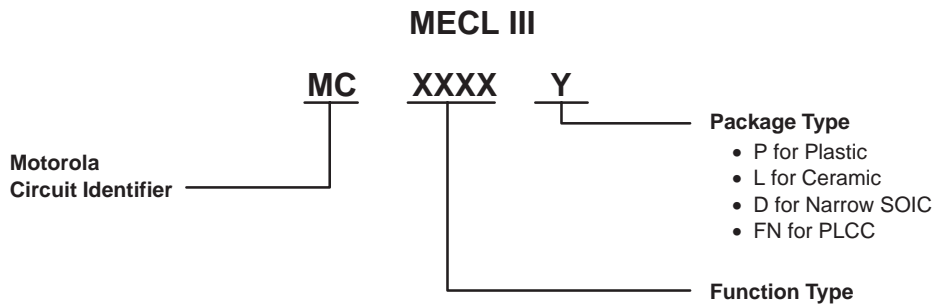
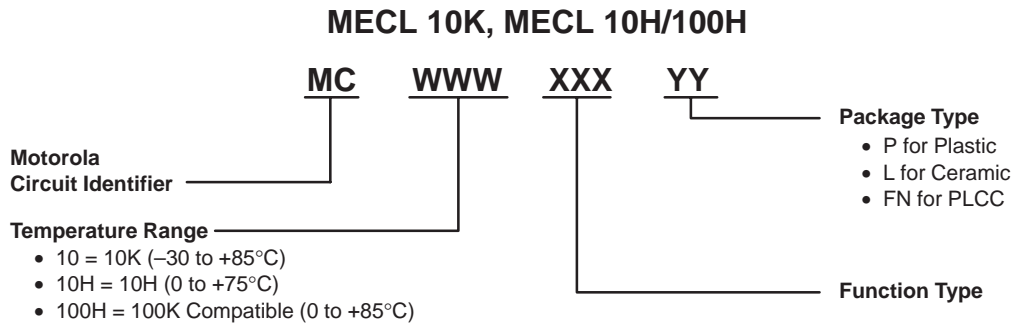
MECL Data



Ordering Information

6

MECL Family Device Nomenclatures



Case Outlines

A letter suffix to the MECL logic function part number is used to specify the package style (see drawings below). See appropriate selector guide for specific packaging available for a given device type.

8-Pin Package

D SUFFIX
PLASTIC SOIC PACKAGE
CASE 751-05
ISSUE M

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.80	5.00	0.189	0.196
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.18	0.25	0.007	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

14-Pin Packages

L SUFFIX
CERAMIC PACKAGE
CASE 632-08
ISSUE Y

NOTES:

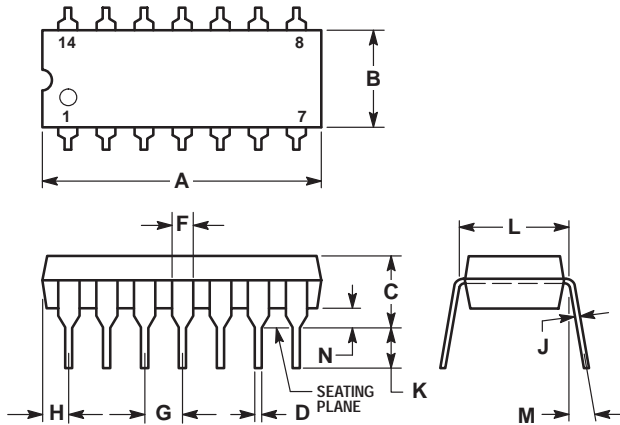
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.94
B	0.245	0.280	6.23	7.11
C	0.155	0.200	3.94	5.08
D	0.015	0.020	0.39	0.50
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
J	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01

6

14-Pin Packages (continued)

P SUFFIX
PLASTIC PACKAGE
 CASE 646-06
 ISSUE L

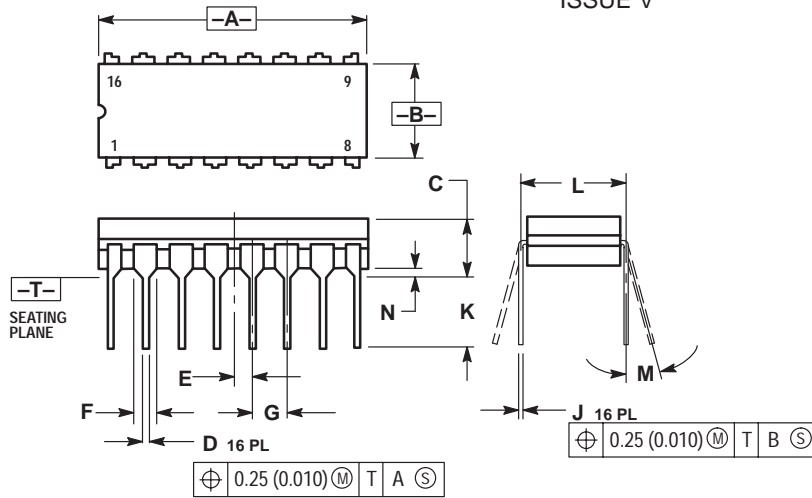


- NOTES:
- LEADS WITHIN 0.13 (0.005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.
 - DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
 - DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 - ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.715	0.770	18.16	19.56
B	0.240	0.260	6.10	6.60
C	0.145	0.185	3.69	4.69
D	0.015	0.021	0.38	0.53
F	0.040	0.070	1.02	1.78
G	0.100 BSC		2.54 BSC	
H	0.052	0.095	1.32	2.41
J	0.008	0.015	0.20	0.38
K	0.115	0.135	2.92	3.43
L	0.300 BSC		7.62 BSC	
M	0°	10°	0°	10°
N	0.015	0.039	0.39	1.01

16-Pin Packages

L SUFFIX
CERAMIC DIP PACKAGE
 CASE 620-10
 ISSUE V



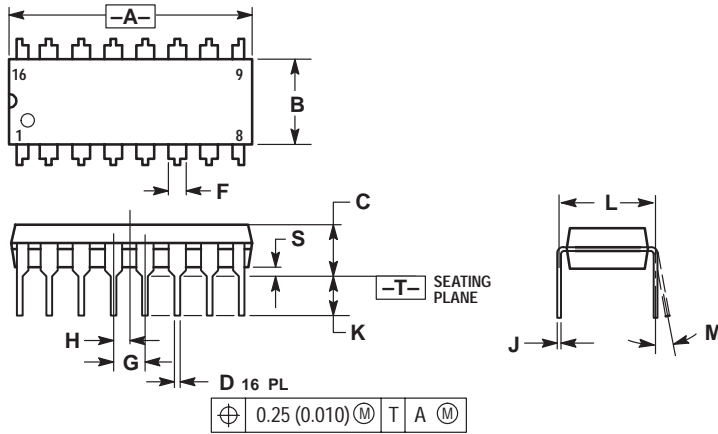
- NOTES:
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 - CONTROLLING DIMENSION: INCH.
 - DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
 - DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.93
B	0.240	0.295	6.10	7.49
C	—	0.200	—	5.08
D	0.015	0.020	0.39	0.50
E	0.050 BSC		1.27 BSC	
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
H	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01

6

16-Pin Packages (continued)

P SUFFIX
PLASTIC DIP PACKAGE
 CASE 648-08
 ISSUE R

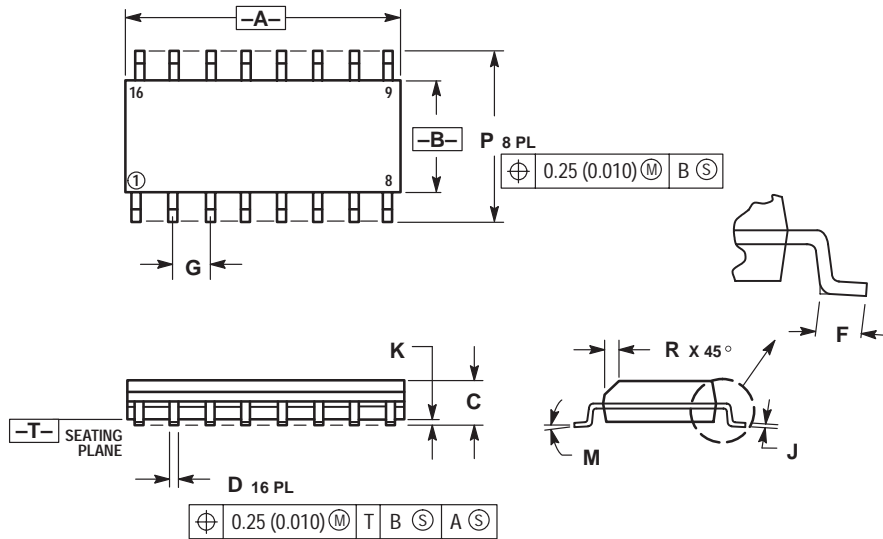


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01

D SUFFIX
PLASTIC SOIC PACKAGE
 CASE 751B-05
 ISSUE J



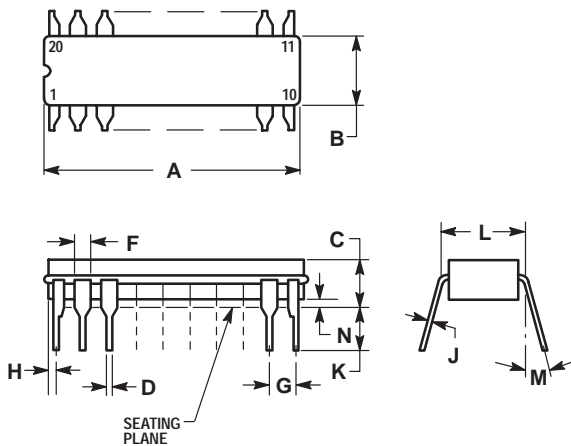
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.80	10.00	0.386	0.393
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

20-Pin Packages

L SUFFIX CERAMIC DIP PACKAGE CASE 732-03 ISSUE E

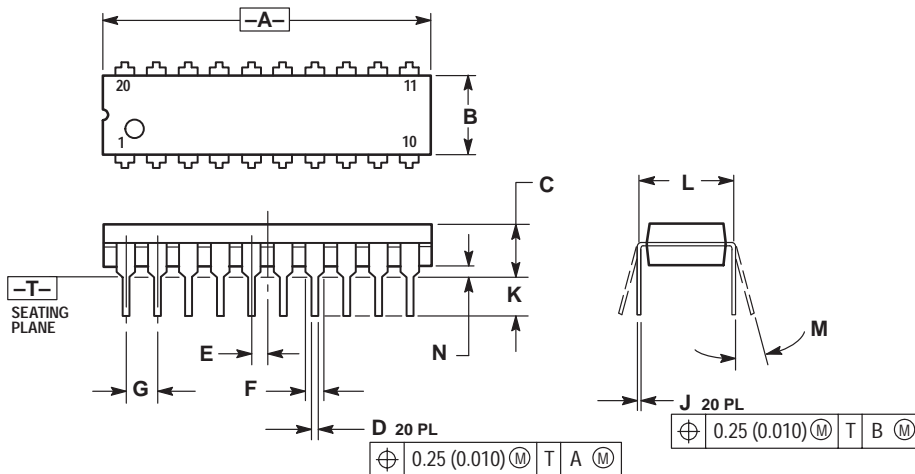


NOTES:

- LEADS WITHIN 0.010 DIAMETER, TRUE POSITION AT SEATING PLANE, AT MAXIMUM MATERIAL CONDITION.
- DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
- DIMENSIONS A AND B INCLUDE MENISCUS.

DIM	INCHES	
	MIN	MAX
A	0.940	0.990
B	0.260	0.295
C	0.150	0.200
D	0.015	0.022
F	0.055	0.065
G	0.100 BSC	
H	0.020	0.050
J	0.008	0.012
K	0.125	0.160
L	0.300 BSC	
M	0° 15°	
N	0.010	0.040

P SUFFIX PLASTIC DIP PACKAGE CASE 738-03 ISSUE E



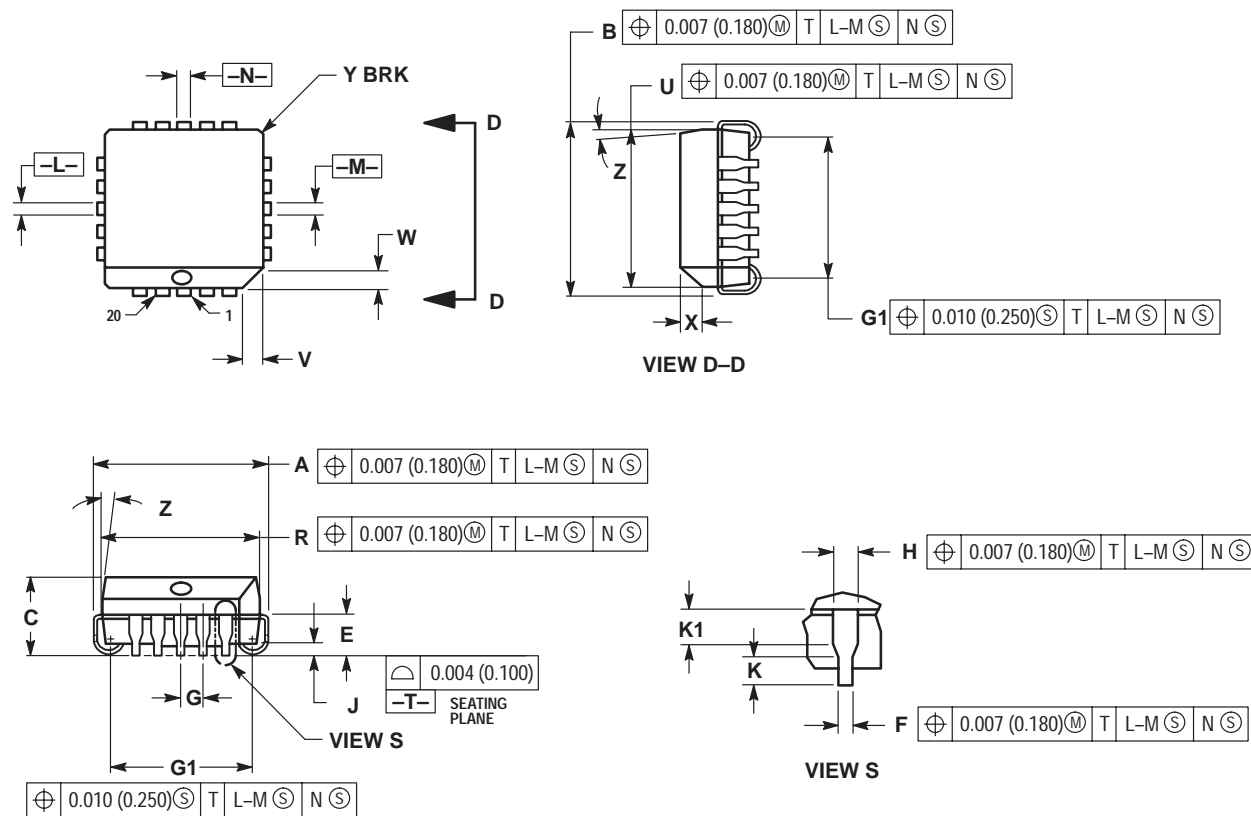
NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
- DIMENSION B DOES NOT INCLUDE MOLD FLASH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	1.010	1.070	25.66	27.17
B	0.240	0.260	6.10	6.60
C	0.150	0.180	3.81	4.57
D	0.015	0.022	0.39	0.55
E	0.050 BSC		1.27 BSC	
F	0.050	0.070	1.27	1.77
G	0.100 BSC		2.54 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.140	2.80	3.55
L	0.300 BSC		7.62 BSC	
M	0° 15°		0° 15°	
N	0.020	0.040	0.51	1.01

20-Pin Packages (continued)

FN SUFFIX
PLASTIC PLCC PACKAGE
CASE 775-02
ISSUE C



NOTES:

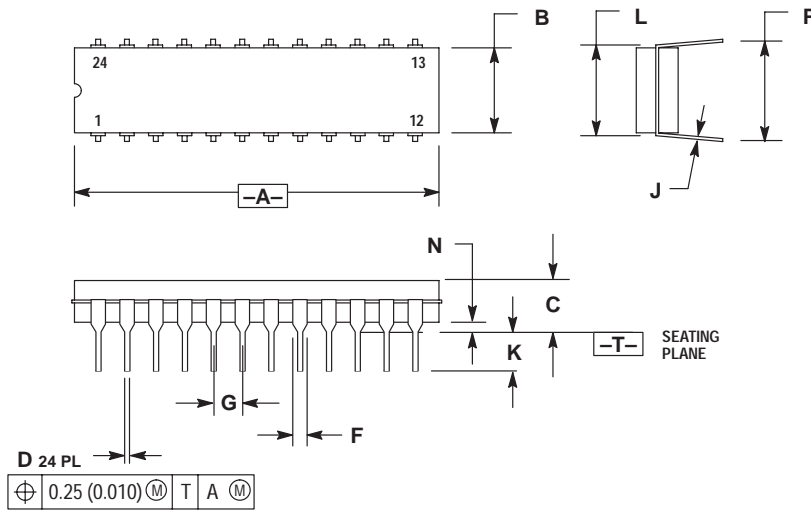
- DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
- DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
- DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.385	0.395	9.78	10.03
B	0.385	0.395	9.78	10.03
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	---	0.51	---
K	0.025	---	0.64	---
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	---	0.020	---	0.50
Z	2° 10°		2° 10°	
G1	0.310	0.330	7.88	8.38
K1	0.040	---	1.02	---

6

24-Pin Packages

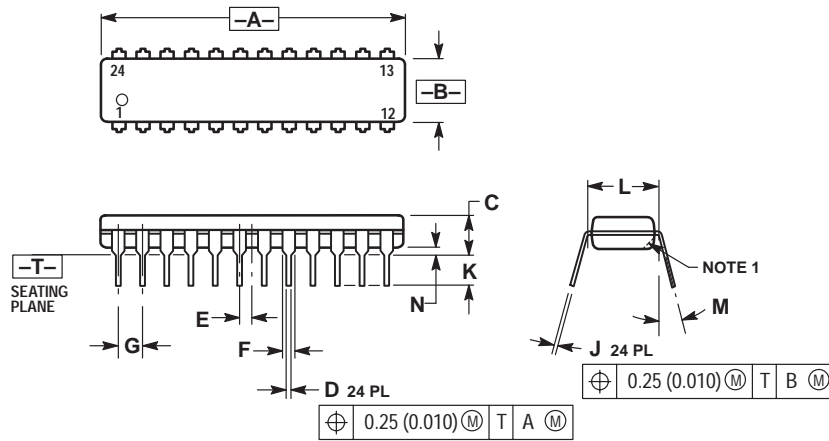
L SUFFIX CERAMIC DIP PACKAGE CASE 758-02 ISSUE A



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	1.240	1.285	31.50	32.64
B	0.285	0.305	7.24	7.75
C	0.160	0.200	4.07	5.08
D	0.015	0.021	0.38	0.53
F	0.045	0.062	1.14	1.57
G	0.100 BSC		2.54 BSC	
J	0.008	0.013	0.20	0.33
K	0.100	0.165	2.54	4.19
L	0.300	0.310	7.62	7.87
N	0.020	0.050	0.51	1.27
P	0.360	0.400	9.14	10.16

P SUFFIX PLASTIC DIP PACKAGE CASE 724-03 ISSUE D

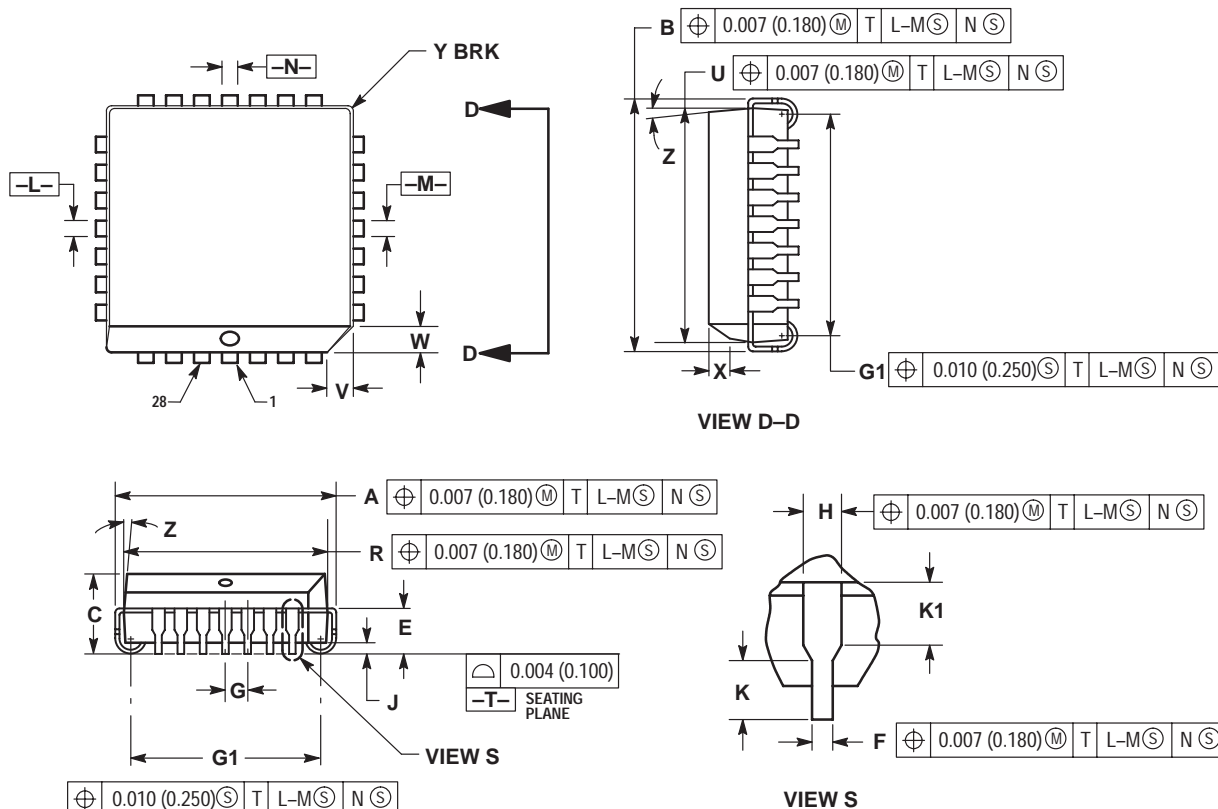


- NOTES:
1. CHAMFERED CONTOUR OPTIONAL.
 2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
 3. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 4. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	1.230	1.265	31.25	32.13
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.020	0.38	0.51
E	0.050 BSC		1.27 BSC	
F	0.040	0.060	1.02	1.52
G	0.100 BSC		2.54 BSC	
J	0.007	0.012	0.18	0.30
K	0.110	0.140	2.80	3.55
L	0.300 BSC		7.62 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01

28-Pin Package

FN SUFFIX
PLASTIC PLCC PACKAGE
CASE 776-02
ISSUE D



NOTES:

- DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
- DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
- DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.485	0.495	12.32	12.57
B	0.485	0.495	12.32	12.57
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	---	0.51	---
K	0.025	---	0.64	---
R	0.450	0.456	11.43	11.58
U	0.450	0.456	11.43	11.58
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	---	0.020	---	0.50
Z	2°		10°	
G1	0.410	0.430	10.42	10.92
K1	0.040	---	1.02	---

6

MECL Logic Surface Mount

WHY SURFACE MOUNT?

Surface Mount Technology is now being utilized to offer answers to many problems that have been created in the use of insertion technology.

Limitations have been reached with insertion packages and PC board technology. Surface Mount Technology offers the opportunity to continue to advance the State-of-the-Art designs that cannot be accomplished with Insertion Technology.

Surface Mount Packages allow more optimum device performance with the smaller Surface Mount configuration. Internal lead lengths, parasitic capacitance and inductance that placed limitations on chip performance have been reduced.

The lower profile of Surface Mount Packages allows more boards to be utilized in a given amount of space. They are stacked closer together and utilize less total volume than insertion populated PC boards.

Printed circuit costs are lowered with the reduction of the number of board layers required. The elimination or reduction of the number of plated through holes in the board, contribute significantly to lower PC board prices.

Surface Mount assembly does not require the preparation of components that are common on insertion technology lines. Surface Mount components are sent directly to the assembly line, eliminating an intermediate step.

Automatic placement equipment is available that can place Surface Mount components at the rate of a few thousand per hour to hundreds of thousands of components per hour.

Surface Mount Technology is cost effective, allowing the manufacturer the opportunity to produce smaller units and offer increased functions with the same size product.

MECL AVAILABILITY IN SURFACE MOUNT

Motorola is now offering MECL 10K and MECL 10H in the PLCC (Plastic Leaded Chip Carrier) packages.

MECL in PLCC may be ordered in conventional plastic rails or on Tape and Reel. Refer to the Tape and Reel section for ordering details.

TAPE AND REEL

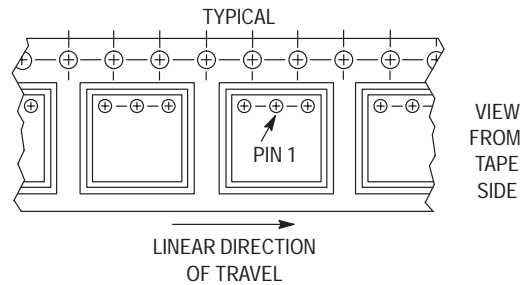
Motorola has now added the convenience of Tape and Reel packaging for our growing family of standard Integrated Circuit products. The packaging fully conforms to the latest EIA

RS-481A specification. The antistatic embossed tape provides a secure cavity sealed with a peel-back cover tape.

GENERAL INFORMATION

- Reel Size 13 inch (330 mm) Suffix: R2
- Tape Width 16 mm
- Units/Reel 1000

MECHANICAL POLARIZATION



ORDERING INFORMATION

- Minimum Lot Size/Device Type = 3000 Pieces.
- No Partial Reel Counts Available.
- To order devices which are to be delivered in Tape and Reel, add the appropriate suffix to the device number being ordered.

EXAMPLE:

ORDERING CODE	SHIPMENT METHOD
MC10101FN	Magazines (Rails)
MC10101FNR2	13 inch Tape and Reel
MC10H101FN	Magazines (Rails)
MC10H101FNR2	13 inch Tape and Reel
MC12015D	Magazines (Rails)
MC12015DR2	13 inch Tape and Reel

DUAL-IN-LINE PACKAGE TO PLCC PIN CONVERSION DATA

The following tables give the equivalent I/O pinouts of Dual-In-Line (DIL) packages and Plastic Leaded Chip Carrier (PLCC) packages.

Pin Conversion Tables

8-Pin DIL to 20-Pin PLCC

8 PIN DIL	1	2	3	4	5	6	7	8											
20 PIN PLCC	2	5	7	10	12	15	17	20											

14-Pin DIL to 20-Pin PLCC

14 PIN DIL	1	2	3	4	5	6	7	8	9	10	11	12	13	14					
20 PIN PLCC	2	3	4	6	8	9	10	12	13	14	16	18	19	20					

16-Pin DIL to 20-Pin PLCC

16 PIN DIL	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16			
20 PIN PLCC	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20			

20-Pin DIL to 20-Pin PLCC

20 PIN DIL	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20
20 PIN PLCC	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20

24-Pin DIL to 28-Pin PLCC

24 PIN DIL	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24
28 PIN PLCC	2	3	4	5	6	7	9	10	11	12	13	14	16	17	18	19	20	21	23	24	25	26	27	28

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Future Electronics (205)830-2322		PENSTOCK (818)355-6775	Duluth
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Wyle Electronics (205)830-1119		Time Electronics 1-800-789-TIME	Future Electronics (770)441-7676
ARIZONA		Thousand Oaks	Newark (770)448-1300
Phoenix		Newark (805)449-1480	PENSTOCK (770)734-9990
FAI (602)731-4661		Torrance	Wyle Electronics (770)441-9045
Future Electronics (602)968-7140		Time Electronics 1-800-789-TIME	IDAHO
Hamilton/Hallmark (602)414-3000		Tustin	Boise
Wyle Electronics (602)804-7000		Time Electronics 1-800-789-TIME	FAI (208)376-8080
Scottsdale		Woodland Hills	ILLINOIS
Alliance Electronics (602)483-9400		Hamilton/Hallmark (818)594-0404	Addison
Tempe		COLORADO	Wyle Laboratories (708)620-0969
Arrow/Schweber Electronics ... (602)431-0030		Lakewood	Bensenville
Newark (602)966-6340		FAI (303)237-1400	Hamilton/Hallmark (708)797-7322
PENSTOCK (602)967-1620		Future Electronics (303)232-2008	Chicago
Time Electronics 1-800-789-TIME		Denver	FAI (708)843-0034
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